



MODULAR & MAGNETIC JACKS

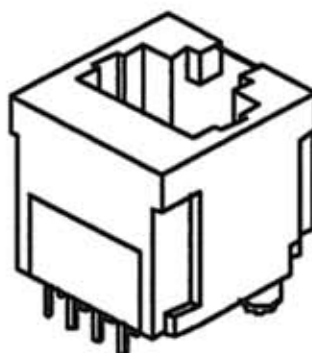
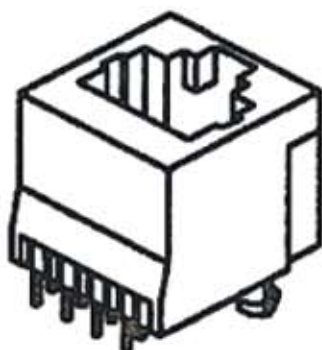
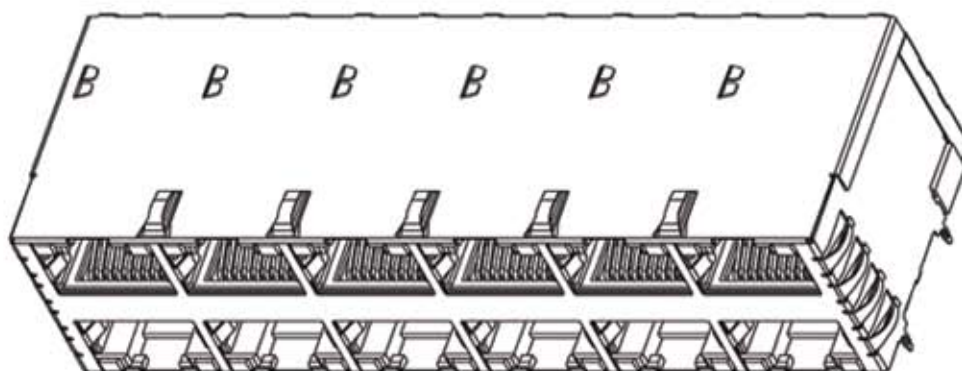
SIDE ENTRY DOUBLE LEVEL MODULAR PCB JACKS

TOP ENTRY DOUBLE LEVEL MODULAR PCB JACKS

10/100 & 10/100/1000 BASE-TX MAGNETIC JACKS

TOP & BOTTOM ENTRY MODULAR PCB JACKS

45° & 70° ENTRY MODULAR PCB JACKS



CAT. LAN-N-2

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- TECHNICAL ALTERNATIONS ARE SUBJECT TO CHANGE WITHOUT NOTICE.
- ALL ARTICLES ARE RoHS & REACH/SVHC COMPLIANT.

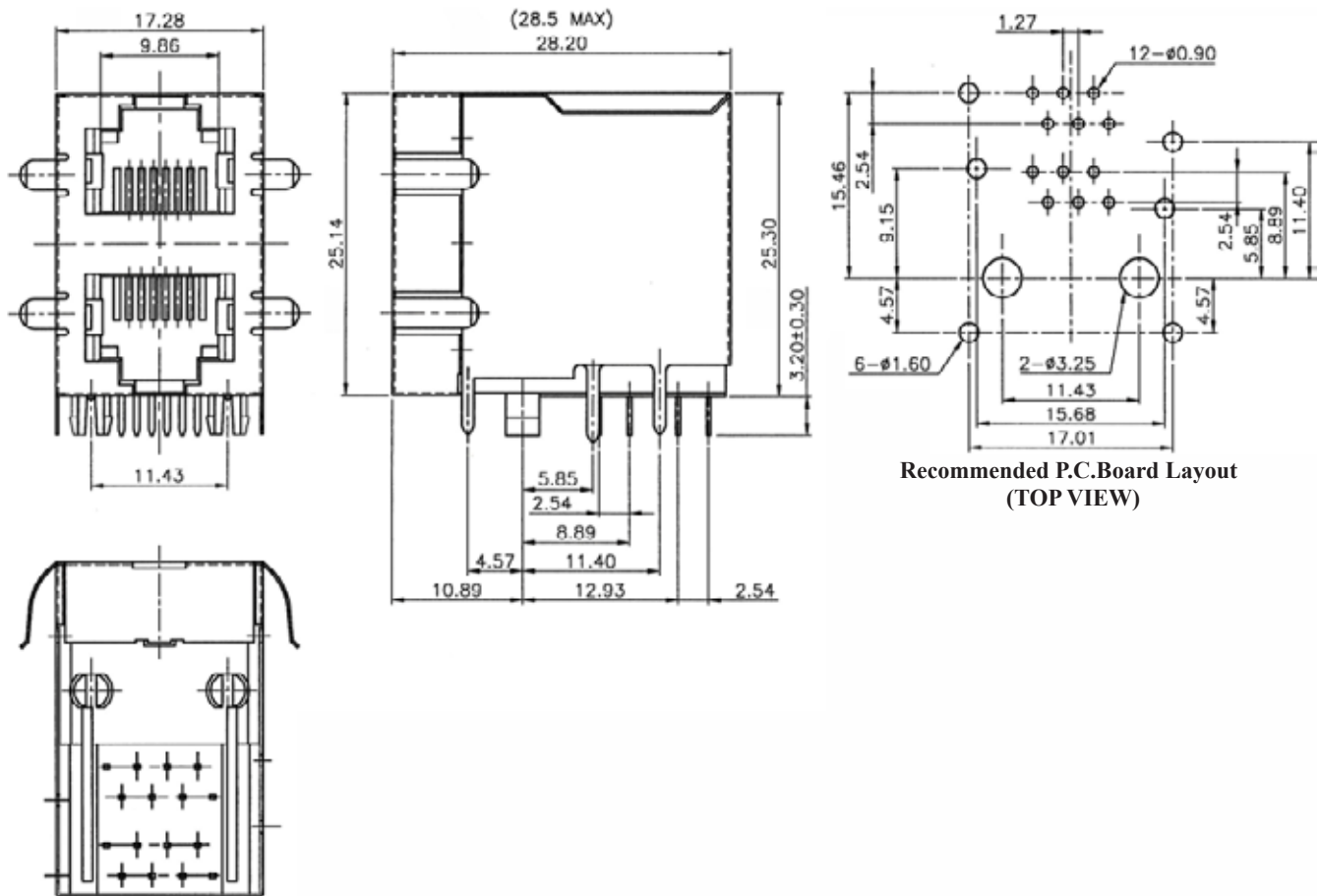
SIDE ENTRY 2-PORT DOUBLE LEVEL MODULAR PCB JACK 6P PROFILE=25.14MM (FULLY SHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Black
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
Shield: Brass plating Nickel Alloy
***RoHS & REACH compliant.**



Recommended P.C.Board Layout
(TOP VIEW)

ORDERING INFORMATION:

P/N M J 4 6 - $\frac{x}{1} \frac{x}{2} \frac{x}{3} B \frac{0}{2}$

1. NO. OF POSITIONS & CONTACTS:
 "66" 6P6C
 "64" 6P4C
2. CONTACT FINISH:
 "A" 6 MICROINCH GOLD
 "B" 15 MICROINCH GOLD
 "C" 30 MICROINCH GOLD
 "D" 50 MICROINCH GOLD
3. NO. OF PORTS:
 02

NOTE: WITH SIDE PANEL GROUNDS

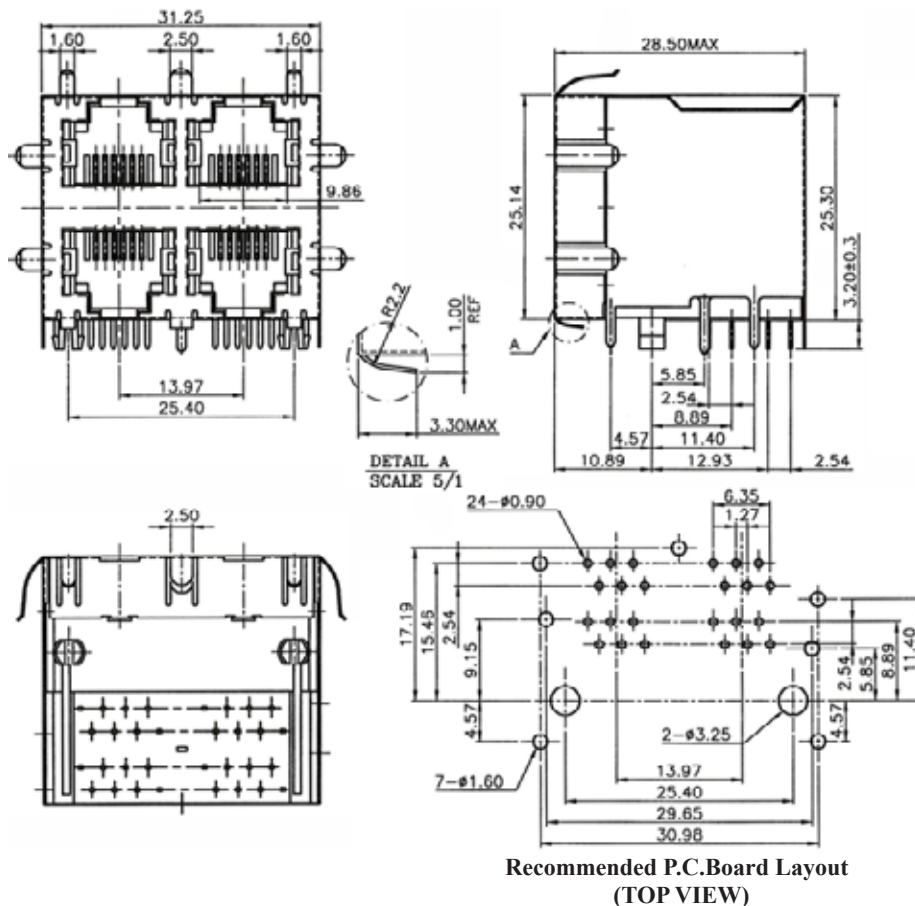
SIDE ENTRY 4-PORT DOUBLE LEVEL MODULAR PCB JACK 6P PROFILE=25.30MM (FULLY SHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Black
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
Shield: Brass plating Nickel Alloy
***RoHS & REACH compliant.**



ORDERING INFORMATION:

P/N M J 2 8 - $\frac{x}{1} \frac{x}{2} \frac{x}{3} B \frac{0}{3} \frac{4}{3}$

1. NO. OF POSITIONS & CONTACTS:
 "66" 6P6C
 "64" 6P4C
2. CONTACT FINISH:
 "A" 6 MICROINCH GOLD
 "B" 15 MICROINCH GOLD
 "C" 30 MICROINCH GOLD
 "D" 50 MICROINCH GOLD
3. NO. OF PORTS:
 04

NOTE: WITH TOP & SIDE PANEL GROUNDS

SIDE ENTRY 6-PORT DOUBLE LEVEL MODULAR PCB JACK 6P PROFILE=25.30MM (FULLY SHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)

Soldering Temperature: 235°C

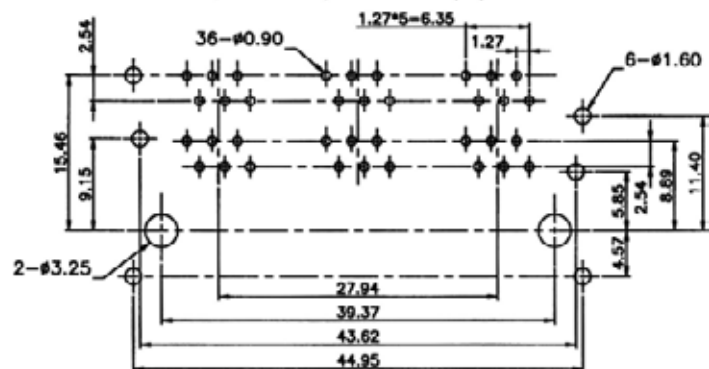
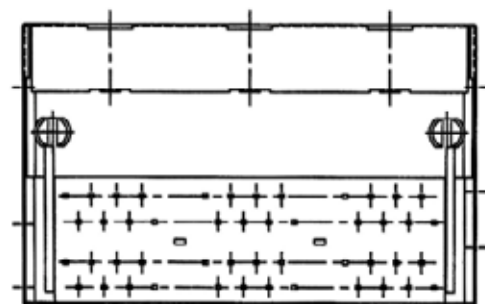
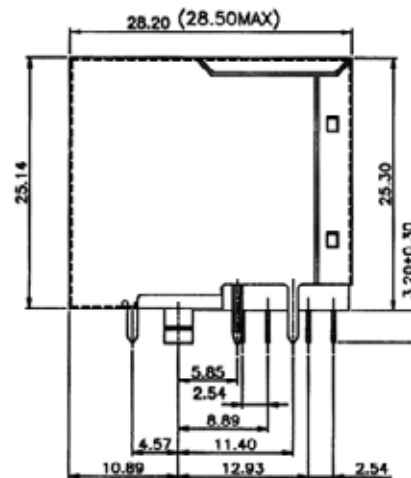
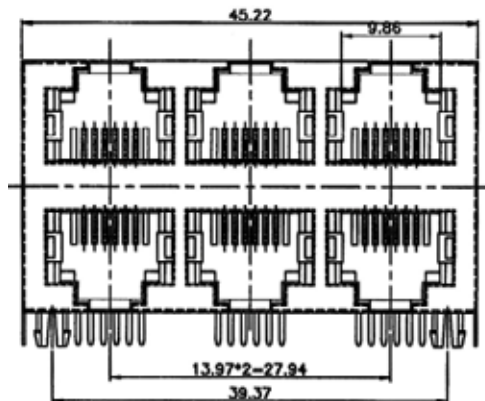
Color: Black

Spring Wire: Phosphor Bronze

Gold plating Over Nickel

Shield: Brass plating Nickel Alloy

*RoHS & REACH compliant.



Recommended P.C.Board Layout
(TOP VIEW)

ORDERING INFORMATION:

P/N M J A 2 - $\frac{x}{1} \frac{x}{2} \frac{x}{3}$ B $\frac{0}{1} \frac{6}{3}$

1. NO. OF POSITIONS & CONTACTS:

"66" 6P6C

"64" 6P4C

2. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

3. NO. OF PORTS:

06

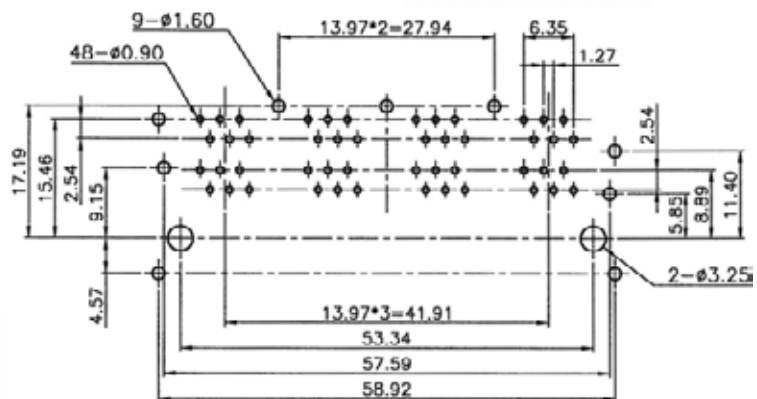
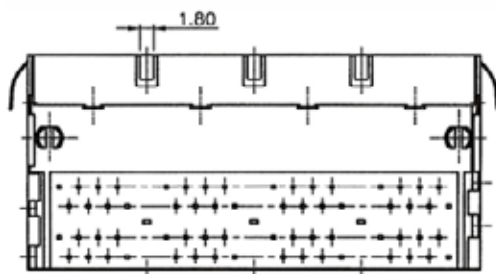
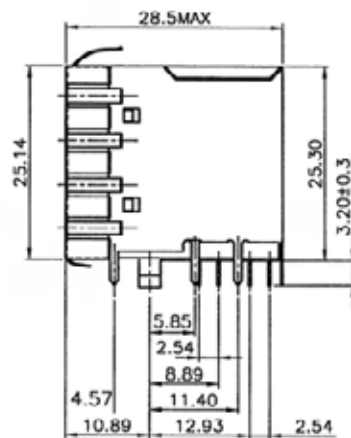
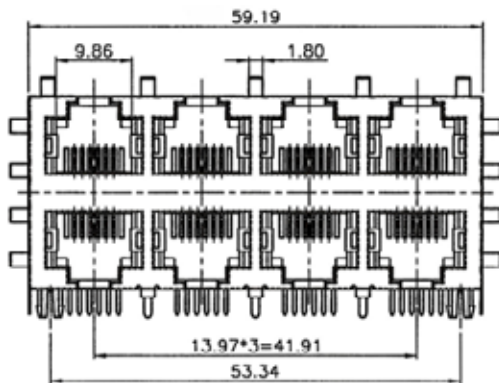
SIDE ENTRY 8-PORT DOUBLE LEVEL MODULAR PCB JACK 6P PROFILE=25.30MM (FULLY SHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Black
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
Shield: Brass plating Nickel Alloy
***RoHS & REACH compliant.**



Recommended P.C.Board Layout
(TOP VIEW)

ORDERING INFORMATION:

P/N M J 2 8 - $\frac{x}{1} \frac{x}{2} \frac{x}{3} B 0 8$

1. NO. OF POSITIONS & CONTACTS:
 "66" 6P6C
 "64" 6P4C
2. CONTACT FINISH:
 "A" 6 MICROINCH GOLD
 "B" 15 MICROINCH GOLD
 "C" 30 MICROINCH GOLD
 "D" 50 MICROINCH GOLD
3. NO. OF PORTS:
 08

NOTE: WITH TOP & SIDE PANEL GROUNDS

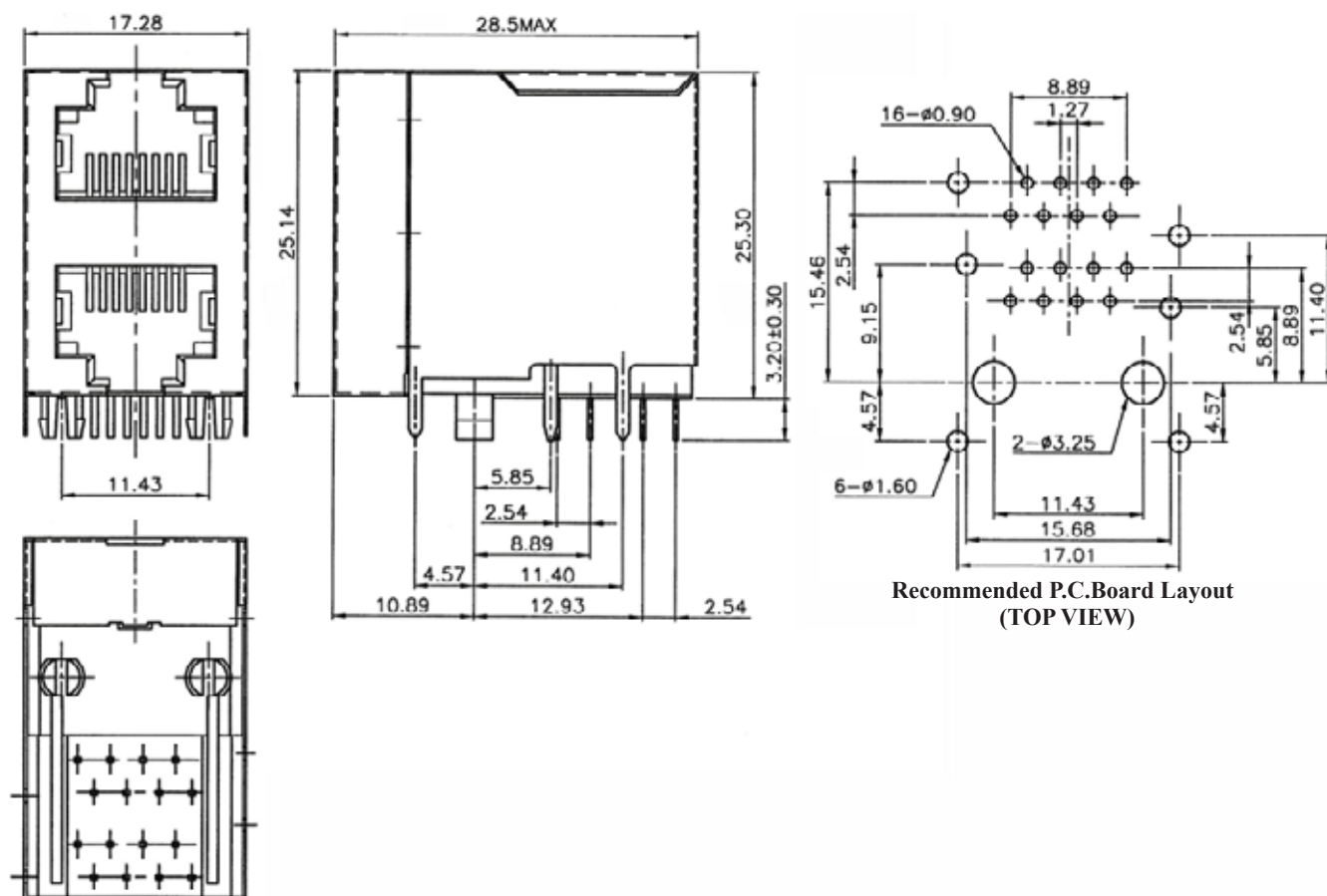
SIDE ENTRY 2-PORT DOUBLE LEVEL MODULAR PCB JACK 8P PROFILE=25.30MM (FULLY SHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Black
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
Shield: Brass plating Nickel Alloy
***RoHS & REACH compliant.**



ORDERING INFORMATION:

P/N MJ $\frac{XX}{1}$ - $\frac{88}{2}$ $\frac{X}{3}$ B $\frac{02}{4}$

- CATEGORY TYPE:
"A2" CAT. 3
"59" CAT. 5
- NO. OF POSITIONS & CONTACTS:
"88" 8P8C
- CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD
- NO. OF PORTS:
02

NOTE: FOR CAT. 5 ONLY MJ59-88CB02 AVAILABLE

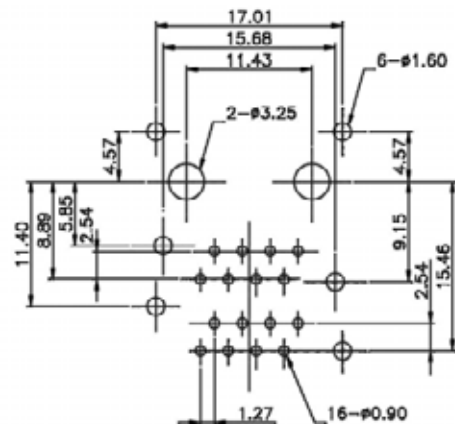
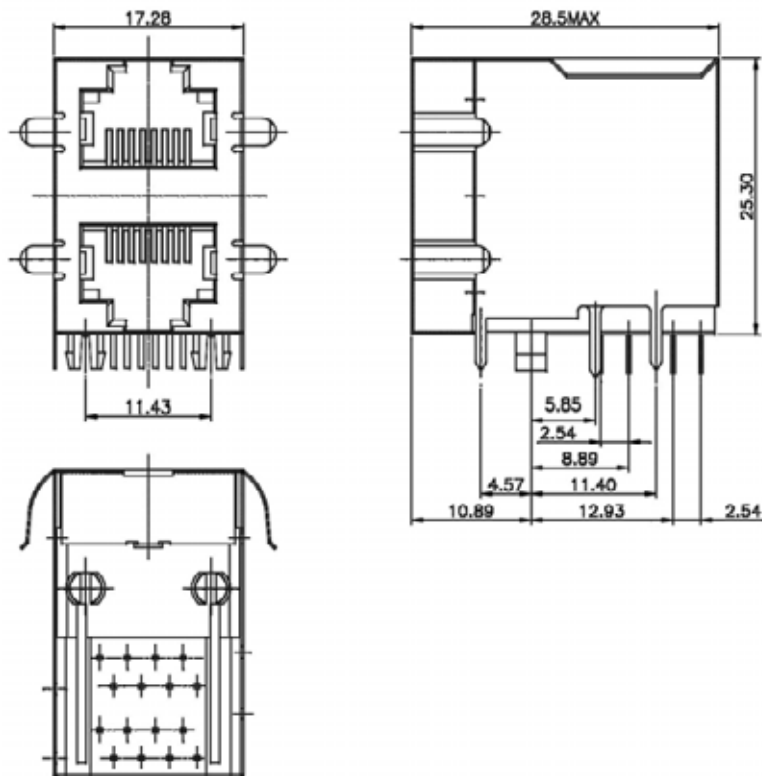
SIDE ENTRY DOUBLE LEVEL MODULAR PCB JACK 8P PROFILE=25.30MM (FULLY SHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Black
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
Shield: Brass plating Nickel Alloy
***RoHS & REACH compliant.**



Recommended P.C. Board Layout
(Top View)

ORDERING INFORMATION:

P/N M J 5 8 - $\frac{x}{1} \frac{x}{2} \frac{B}{3} \frac{0}{3}$

1. NO. OF POSITIONS & CONTACTS:
"88" 8P8C
2. CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD
3. NO. OF PORTS:
02

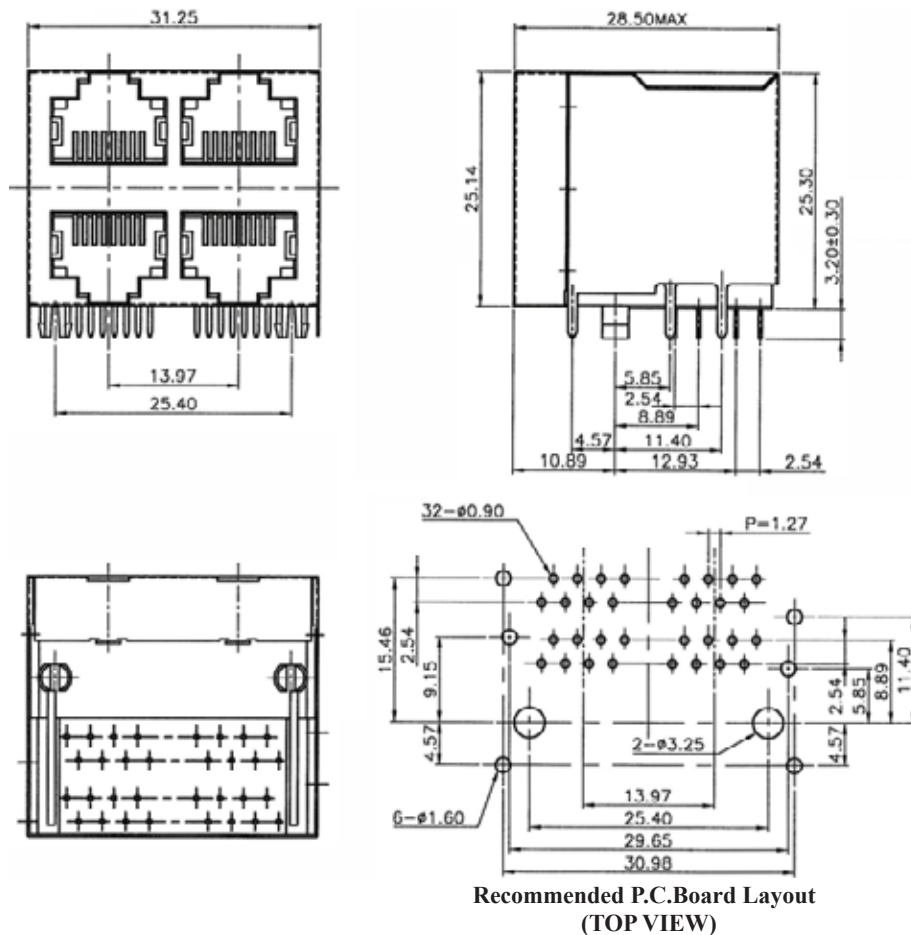
SIDE ENTRY 4-PORT DOUBLE LEVEL MODULAR PCB JACK 8P PROFILE=25.30MM (FULLY SHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Black
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
Shield: Brass plating Nickel Alloy
***RoHS & REACH compliant.**



ORDERING INFORMATION:

P/N M J $\frac{xx}{1}$ - $\frac{88}{2}$ $\frac{x}{3}$ B $\frac{04}{4}$

- CATEGORY TYPE:
 "A2" CAT. 3
 "59" CAT. 5
- NO. OF POSITIONS & CONTACTS:
 "88" 8P8C
- CONTACT FINISH:
 "A" 6 MICROINCH GOLD
 "B" 15 MICROINCH GOLD
 "C" 30 MICROINCH GOLD
 "D" 50 MICROINCH GOLD
- NO. OF PORTS:
 04

NOTE: FOR CAT. 5 ONLY MJ59-88CB04 AVAILABLE

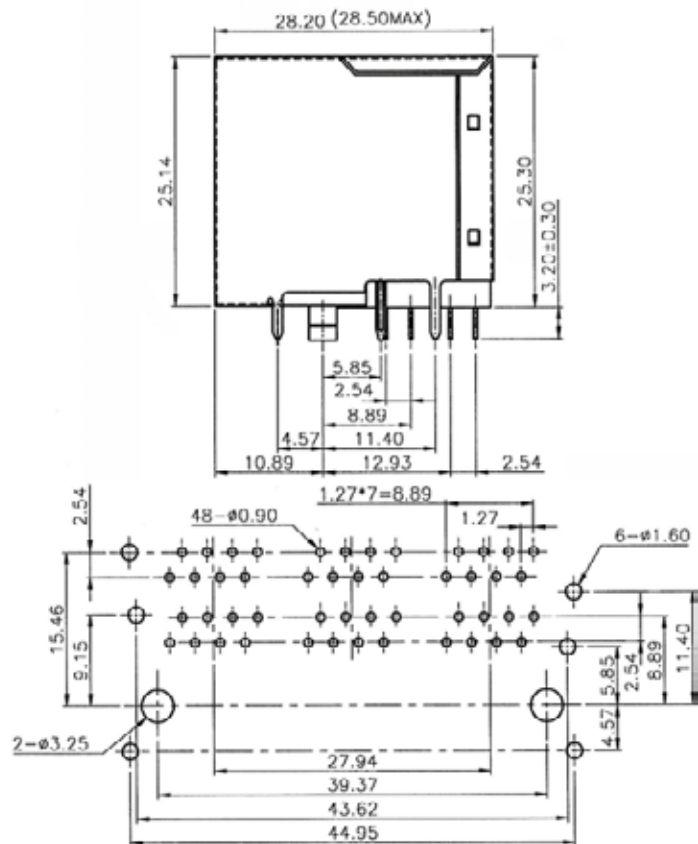
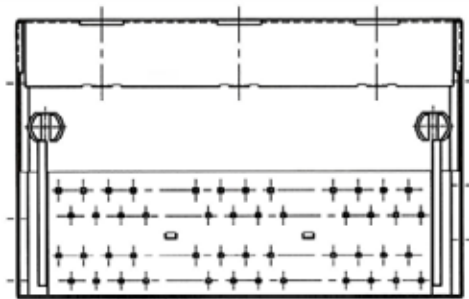
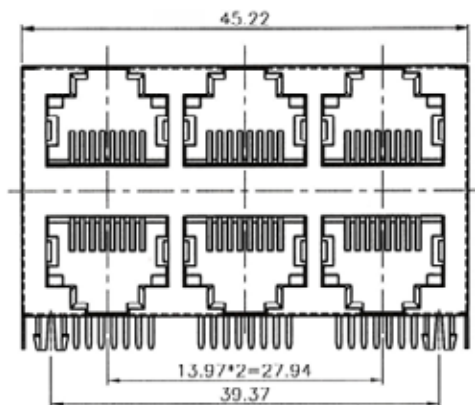
SIDE ENTRY 6-PORT DOUBLE LEVEL MODULAR PCB JACK 8P PROFILE=25.30MM (FULLY SHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Black
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
Shield: Brass plating Nickel Alloy
***RoHS & REACH compliant.**



Recommended P.C.Board Layout
(TOP VIEW)

ORDERING INFORMATION:

P/N M J $\frac{x}{1}$ - $\frac{88}{2}$ $\frac{x}{3}$ B $\frac{06}{4}$

- CATEGORY TYPE:
 "A2" CAT. 3
 "59" CAT. 5
- NO. OF POSITIONS & CONTACTS:
 "88" 8P8C
- CONTACT FINISH:
 "A" 6 MICROINCH GOLD
 "B" 15 MICROINCH GOLD
 "C" 30 MICROINCH GOLD
 "D" 50 MICROINCH GOLD
- NO. OF PORTS:
 06

NOTE: FOR CAT. 5 ONLY MJ59-88CB06 AVAILABLE

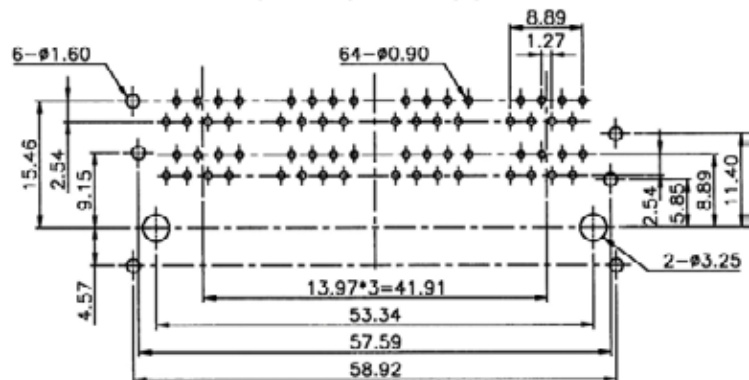
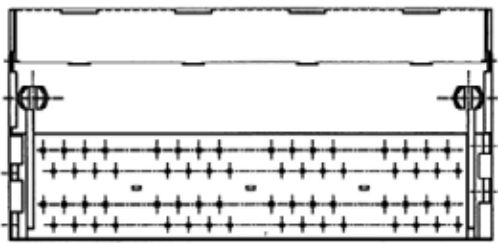
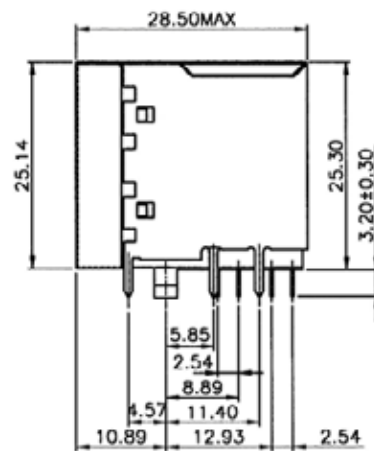
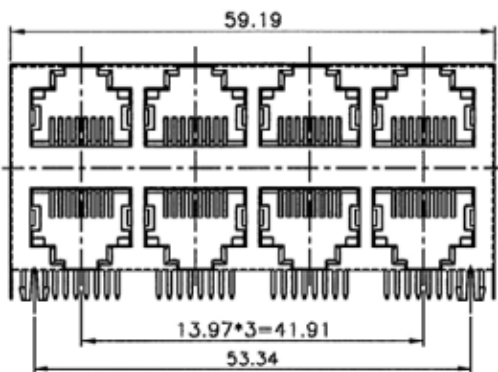
SIDE ENTRY 8-PORT DOUBLE LEVEL MODULAR PCB JACK 8P PROFILE=25.30MM (FULLY SHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Black
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
Shield: Brass plating Nickel Alloy
***RoHS & REACH compliant.**



Recommended P.C.Board Layout
(TOP VIEW)

ORDERING INFORMATION:

P/N M J $\frac{xx}{1}$ - $\frac{88}{2}$ $\frac{x}{3}$ B $\frac{08}{4}$

- CATEGORY TYPE:
 "A2" CAT. 3
 "59" CAT. 5
- NO. OF POSITIONS & CONTACTS:
 "88" 8P8C
- CONTACT FINISH:
 "A" 6 MICROINCH GOLD
 "B" 15 MICROINCH GOLD
 "C" 30 MICROINCH GOLD
 "D" 50 MICROINCH GOLD
- NO. OF PORTS:
 08

NOTE: FOR CAT. 5 ONLY MJ59-88CB08 AVAILABLE

SIDE ENTRY 10-PORT DOUBLE LEVEL MODULAR PCB JACK 8P PROFILE=25.30MM (FULLY SHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)

Soldering Temperature: 235°C

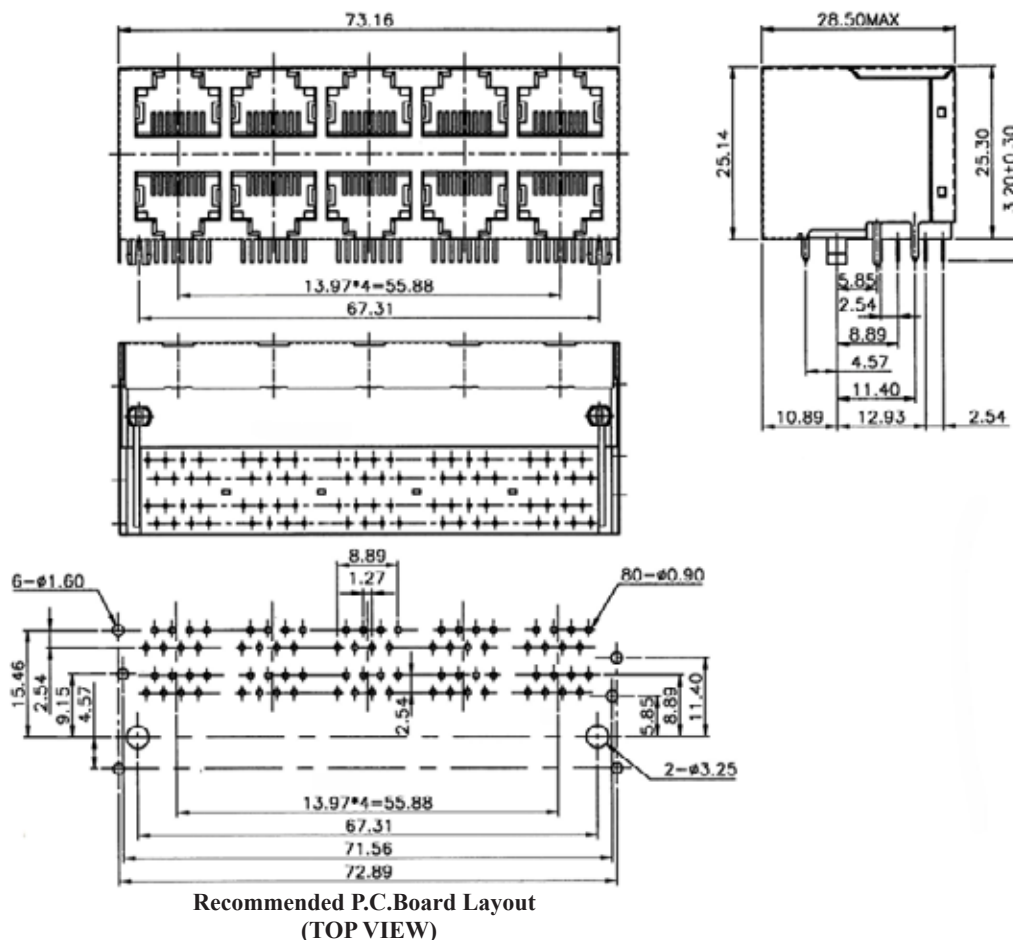
Color: Black

Spring Wire: Phosphor Bronze

Gold plating Over Nickel

Shield: Brass plating Nickel Alloy

*RoHS & REACH compliant.



ORDERING INFORMATION:

P/N M J $\frac{x}{1}$ - $\frac{88}{23}$ B $\frac{10}{4}$

1. CATEGORY TYPE:

"A2" CAT. 3

"59" CAT. 5

2. NO. OF POSITIONS & CONTACTS:

"88" 8P8C

3. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

4. NO. OF PORTS:

10

NOTE: FOR CAT. 5 ONLY MJ59-88CB10 AVAILABLE

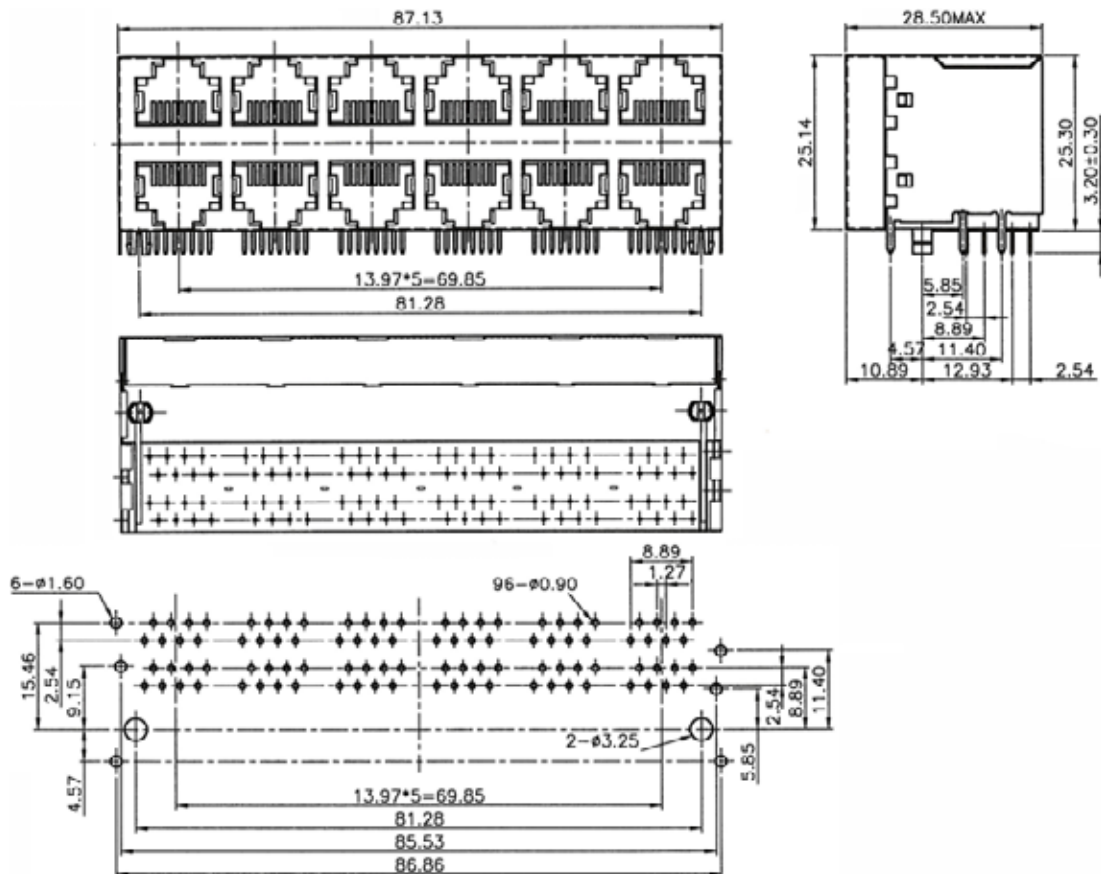
SIDE ENTRY 12-PORT DOUBLE LEVEL MODULAR PCB JACK 8P PROFILE=25.30MM (FULLY SHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Black
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
Shield: Brass plating Nickel Alloy
***RoHS & REACH compliant.**



Recommended P.C.Board Layout
(TOP VIEW)

ORDERING INFORMATION:

P/N M J $\frac{x}{1}$ - $\frac{88}{2}$ $\frac{x}{3}$ B $\frac{12}{4}$

- CATEGORY TYPE:
 "A2" CAT. 3
 "59" CAT. 5
- NO. OF POSITIONS & CONTACTS:
 "88" 8P8C
- CONTACT FINISH:
 "A" 6 MICROINCH GOLD
 "B" 15 MICROINCH GOLD
 "C" 30 MICROINCH GOLD
 "D" 50 MICROINCH GOLD
- NO. OF PORTS:
 12

NOTE: FOR CAT. 5 ONLY MJ59-88CB12 AVAILABLE

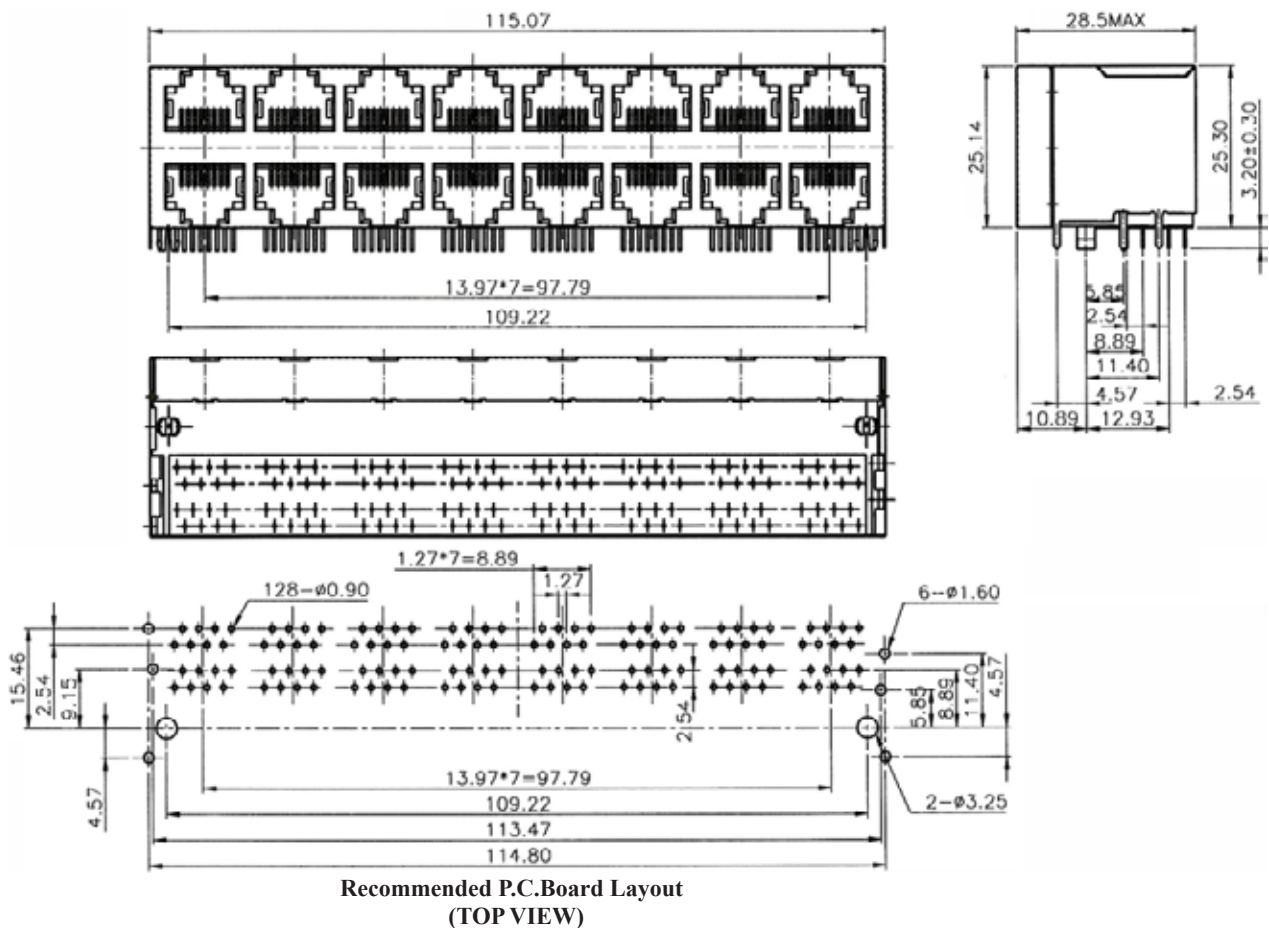
SIDE ENTRY 16-PORT DOUBLE LEVEL MODULAR PCB JACK 8P PROFILE=25.30MM (FULLY SHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Black
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
Shield: Brass plating Nickel Alloy
***RoHS & REACH compliant.**



ORDERING INFORMATION:

P/N M J $\frac{x}{1}$ - $\frac{88}{2}$ $\frac{x}{3}$ B $\frac{16}{4}$

- CATEGORY TYPE:
 "A2" CAT. 3
 "59" CAT. 5
- NO. OF POSITIONS & CONTACTS:
 "88" 8P8C
- CONTACT FINISH:
 "A" 6 MICROINCH GOLD
 "B" 15 MICROINCH GOLD
 "C" 30 MICROINCH GOLD
 "D" 50 MICROINCH GOLD
- NO. OF PORTS:
 16

NOTE: FOR CAT. 5 ONLY MJ59-88CB16 AVAILABLE

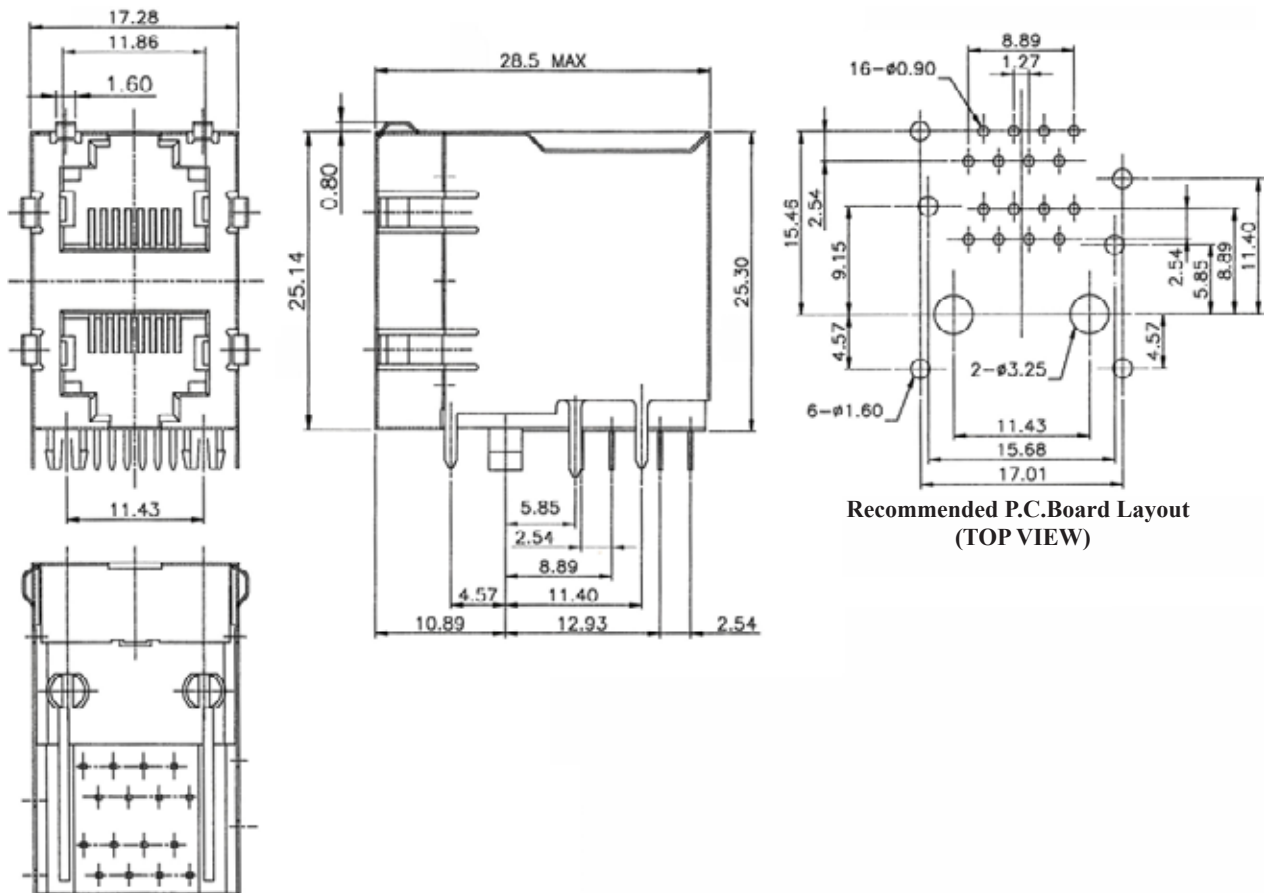
SIDE ENTRY 2-PORT DOUBLE LEVEL MODULAR PCB JACK 8P PROFILE=25.30MM (FULLY SHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Black
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
Shield: Brass plating Nickel Alloy
***RoHS & REACH compliant.**



ORDERING INFORMATION:

P/N M J 4 6 - $\frac{88}{1} \times \frac{B}{2} \frac{02}{3}$

1. NO. OF POSITIONS & CONTACTS:
"88" 8P8C
2. CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD
3. NO. OF PORTS:
02

NOTE: WITH SIDE PANEL GROUNDS

SIDE ENTRY 4-PORT DOUBLE LEVEL MODULAR PCB JACK 8P PROFILE=25.30MM (FULLY SHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)

Soldering Temperature: 235°C

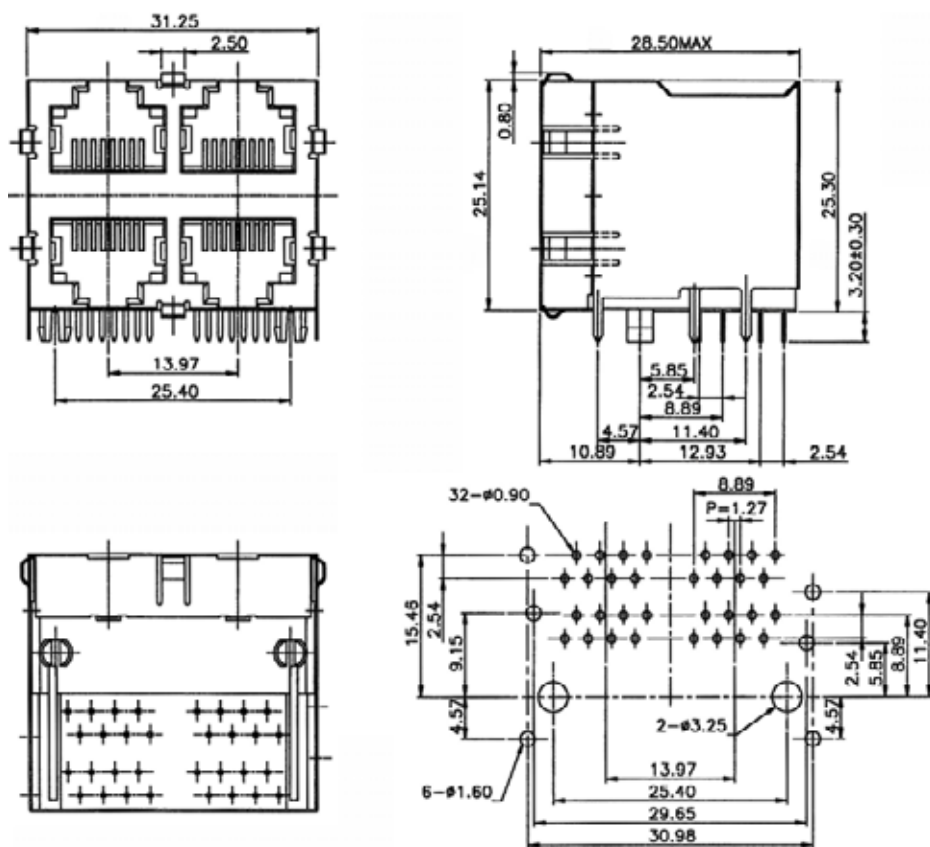
Color: Black

Spring Wire: Phosphor Bronze

Gold plating Over Nickel

Shield: Brass plating Nickel Alloy

*RoHS & REACH compliant.



Recommended P.C.Board Layout
(TOP VIEW)

ORDERING INFORMATION:

P/N M J 4 6 - $\frac{88}{1} \times \frac{B}{2} \frac{04}{3}$

1. NO. OF POSITIONS & CONTACTS:

"88" 8P8C

2. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

3. NO. OF PORTS:

04

NOTE: WITH SIDE PANEL GROUNDS

SIDE ENTRY 6-PORT DOUBLE LEVEL MODULAR PCB JACK 8P PROFILE=25.30MM (FULLY SHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)

Soldering Temperature: 235°C

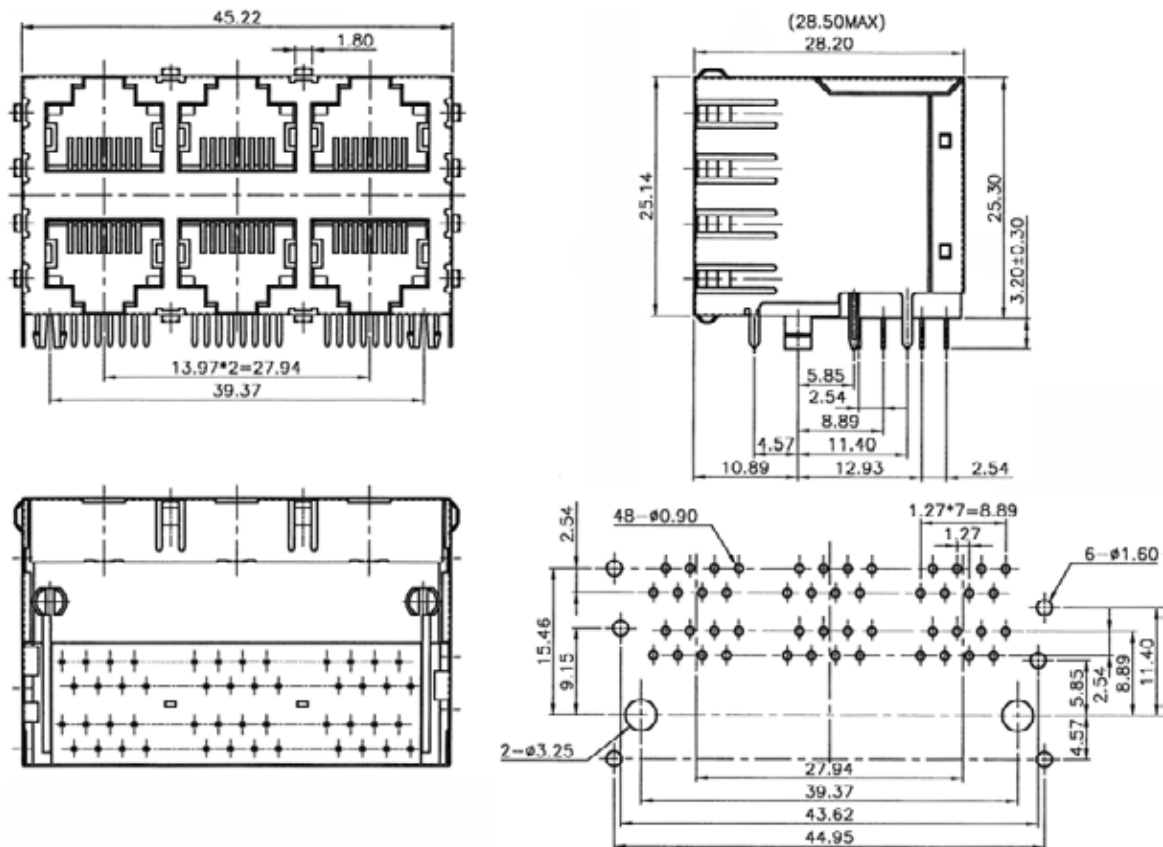
Color: Black

Spring Wire: Phosphor Bronze

Gold plating Over Nickel

Shield: Brass plating Nickel Alloy

*RoHS & REACH compliant.



Recommended P.C.Board Layout
(TOP VIEW)

ORDERING INFORMATION:

P/N M J 4 6 - $\frac{88}{1} \times \frac{B}{2} \frac{0.6}{3}$

1. NO. OF POSITIONS & CONTACTS:

"88" 8P8C

2. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

3. NO. OF PORTS:

06

NOTE: WITH SIDE PANEL GROUNDS

SIDE ENTRY 8-PORT DOUBLE LEVEL MODULAR PCB JACK 8P PROFILE=25.30MM (FULLY SHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: Nylon (UL 94V-0)

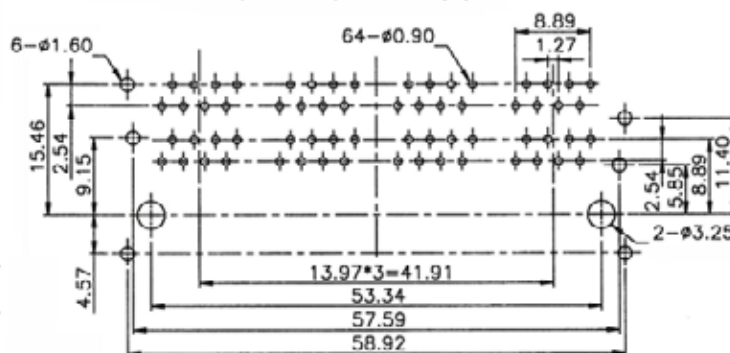
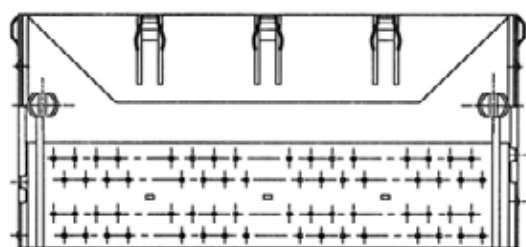
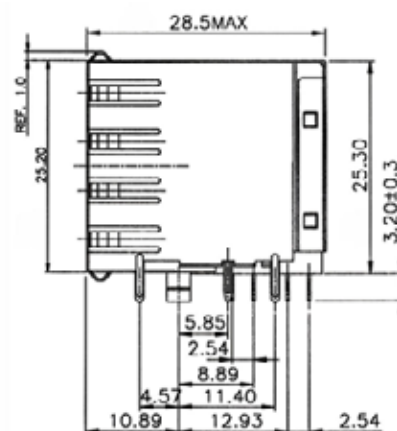
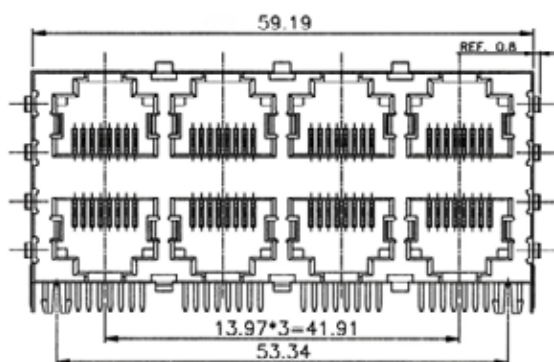
Soldering Temperature: 260°C

Color: Black

Spring Wire: Phosphor Bronze

Gold plating Over Nickel

*RoHS & REACH compliant.



Recommended P.C.Board Layout
(TOP VIEW)

ORDERING INFORMATION:

P/N M J 4 6 - $\frac{x}{1} \frac{x}{2} \frac{x}{3}$ B $\frac{0}{2} \frac{8}{3}$

1. NO. OF POSITIONS & CONTACTS:

"88" 8P8C

2. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

3. NO. OF PORTS:

08

NOTE: WITH SIDE PANEL GROUNDS

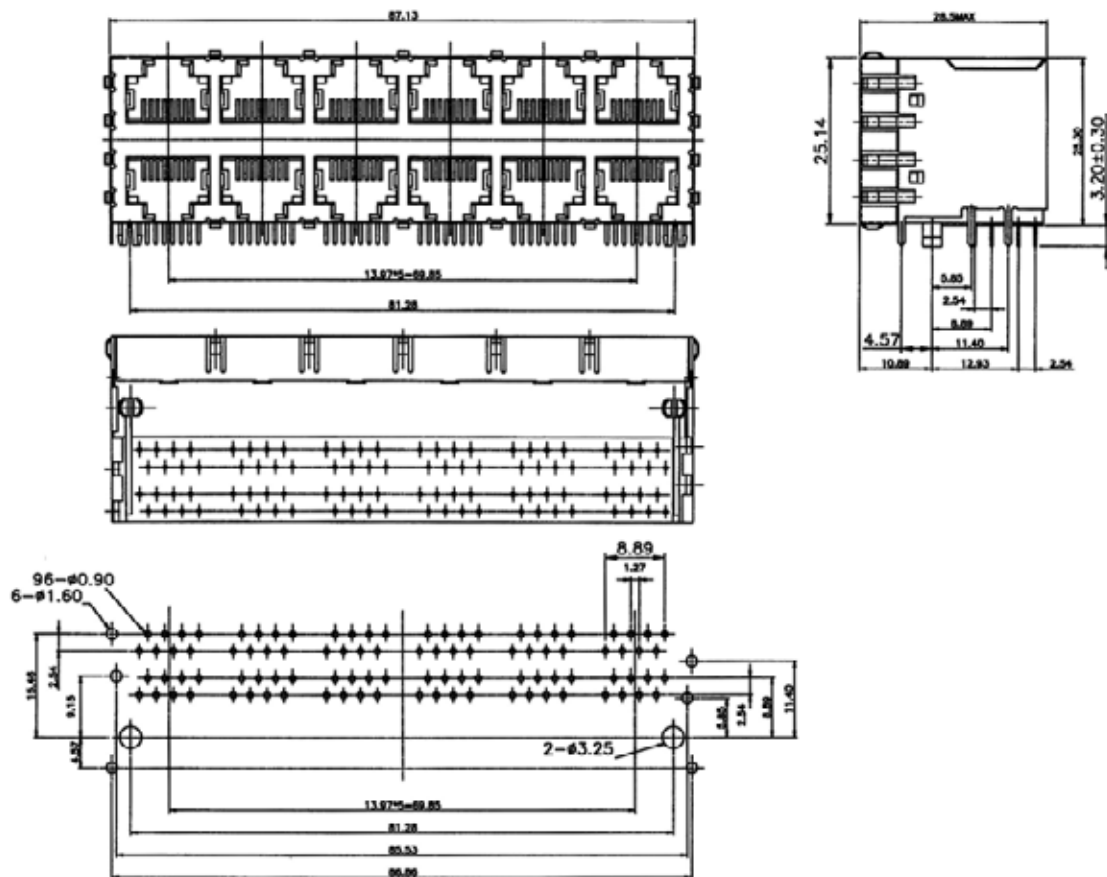
SIDE ENTRY 12-PORT MODULAR PCB JACK 8P PROFILE=25.30MM (FULLY SHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Black
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
Shield: Brass plating Nickel Alloy
***RoHS & REACH compliant.**



Recommended P.C.Board Layout

ORDERING INFORMATION:

P/N M J $\frac{xx}{1}$ - $\frac{88}{2}$ $\frac{x}{3}$ B $\frac{12}{4}$

- CATEGORY TYPE:
 "46" CAT. 3
 "54" CAT. 5
- NO. OF POSITIONS & CONTACTS:
 "88" 8P8C
- CONTACT FINISH:
 "A" 6 MICROINCH GOLD
 "B" 15 MICROINCH GOLD
 "C" 30 MICROINCH GOLD
 "D" 50 MICROINCH GOLD
- NO. OF PORTS:
 12

NOTE: WITH SIDE PANEL GROUNDS

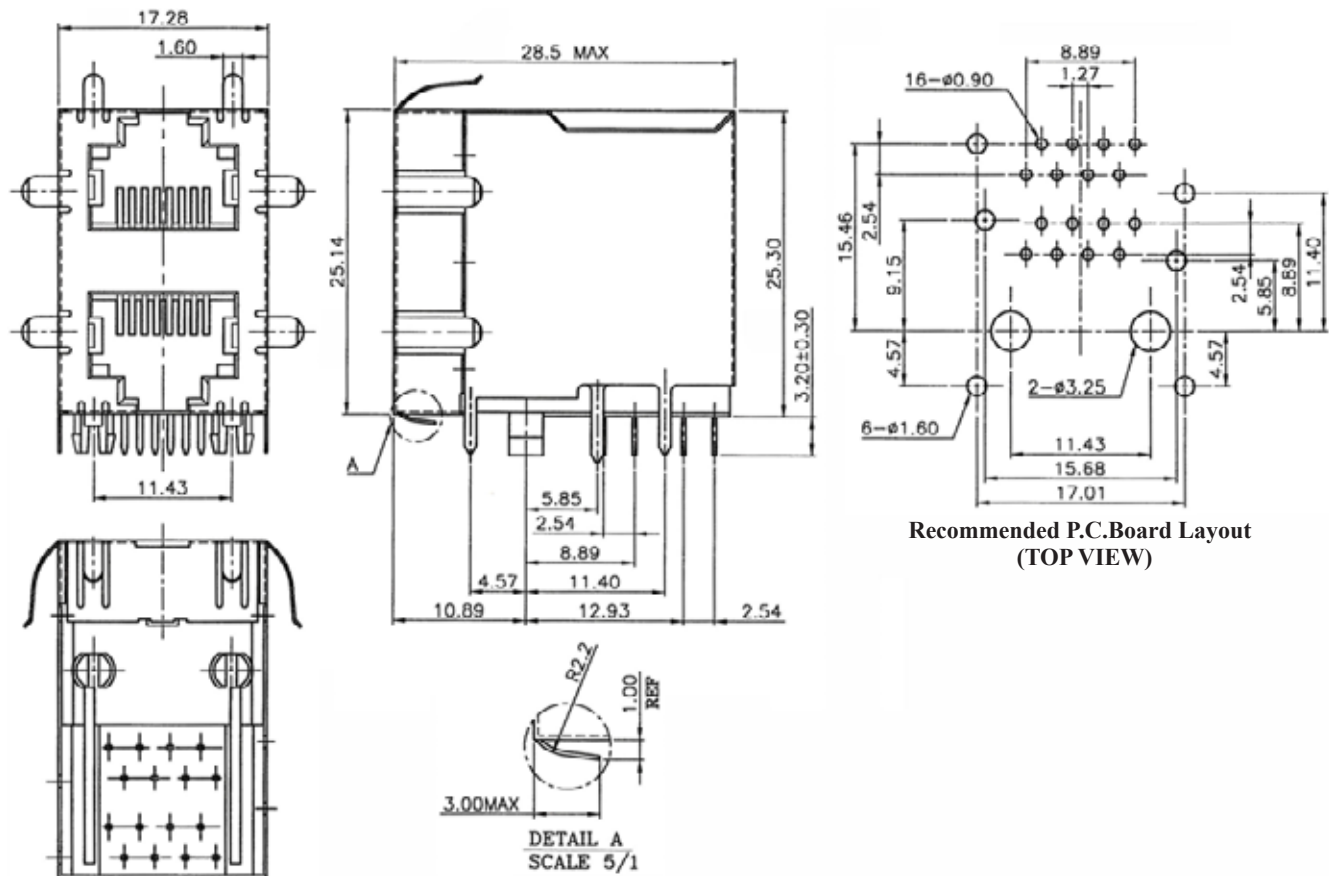
SIDE ENTRY 2-PORT DOUBLE LEVEL MODULAR PCB JACK 8P PROFILE=25.30MM (FULLY SHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Black
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
Shield: Brass plating Nickel Alloy
***RoHS & REACH compliant.**



ORDERING INFORMATION:

P/N MJ 28 - 88 x B 02
1 2 3

1. NO. OF POSITIONS & CONTACTS:
"88" 8P8C
2. CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD
3. NO. OF PORTS:
02

NOTE: WITH TOP & SIDE PANEL GROUNDS

SIDE ENTRY 4-PORT DOUBLE LEVEL MODULAR PCB JACK 8P PROFILE=25.30MM (FULLY SHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)

Soldering Temperature: 235°C

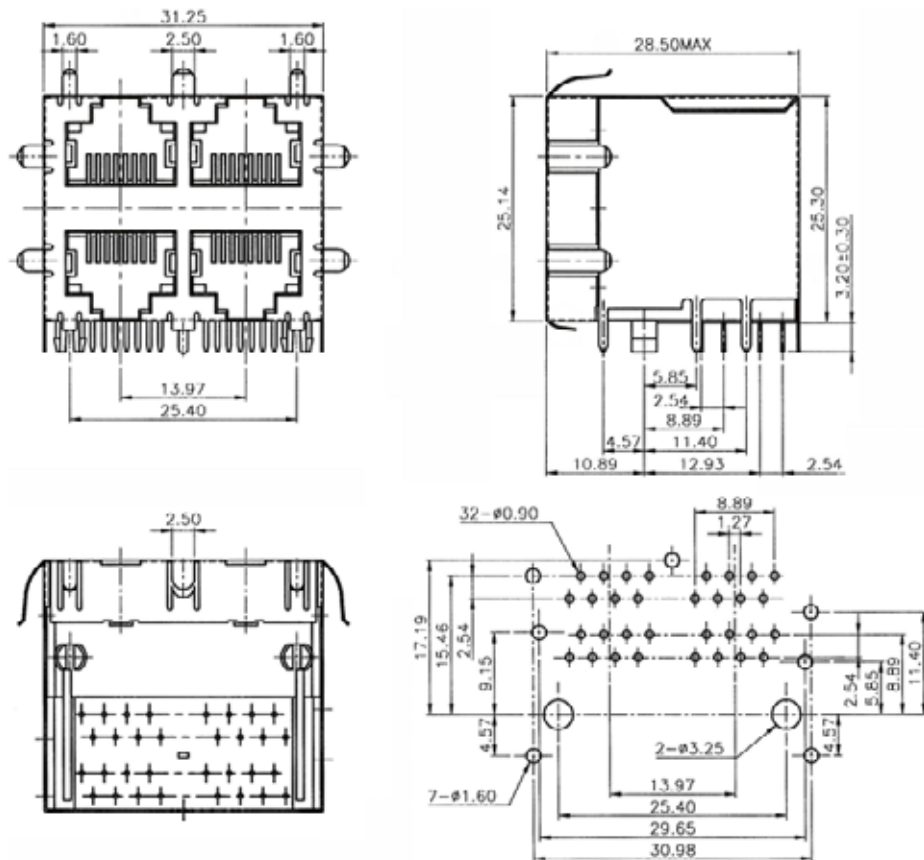
Color: Black

Spring Wire: Phosphor Bronze

Gold plating Over Nickel

Shield: Brass plating Nickel Alloy

***RoHS & REACH compliant.**



Recommended P.C.Board Layout
(TOP VIEW)

ORDERING INFORMATION:

P/N M J 2 8 - $\frac{88}{1} \times \frac{B}{2} \frac{04}{3}$

1. NO. OF POSITIONS & CONTACTS:

"88" 8P8C

2. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

3. NO. OF PORTS:

04

NOTE: WITH TOP & SIDE PANEL GROUNDS

SIDE ENTRY 6-PORT DOUBLE LEVEL MODULAR PCB JACK 8P PROFILE=25.30MM (FULLY SHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)

Soldering Temperature: 235°C

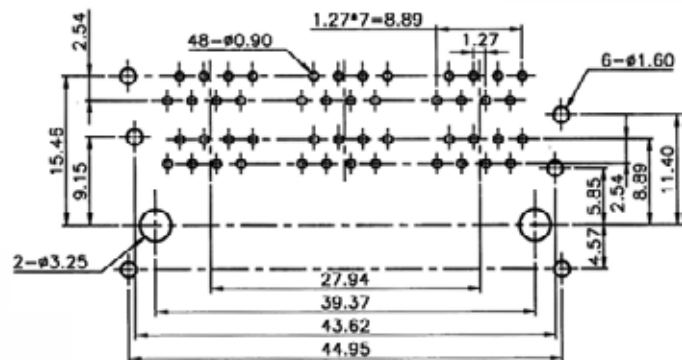
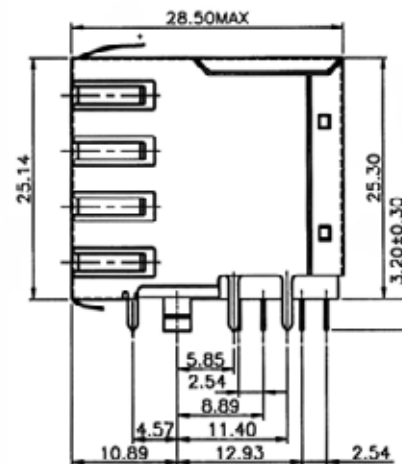
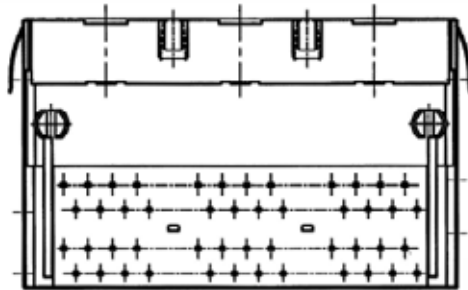
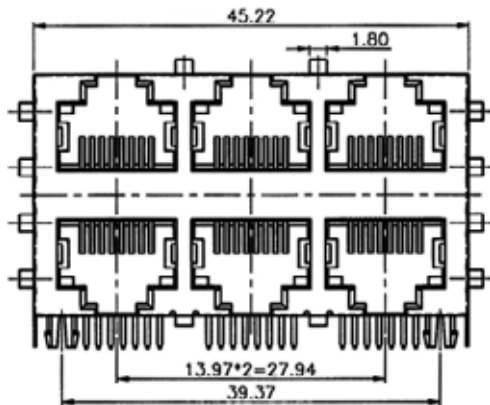
Color: Black

Spring Wire: Phosphor Bronze

Gold plating Over Nickel

Shield: Brass plating Nickel Alloy

*RoHS & REACH compliant.



Recommended P.C.Board Layout
(TOP VIEW)

ORDERING INFORMATION:

P/N M J 2 8 - $\frac{88}{1} \times \frac{B}{2} \frac{06}{3}$

1. NO. OF POSITIONS & CONTACTS:

"88" 8P8C

2. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

3. NO. OF PORTS:

06

NOTE: WITH TOP & SIDE PANEL GROUNDS

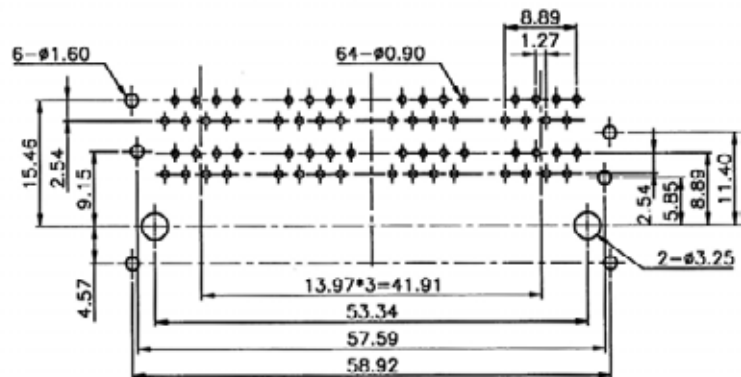
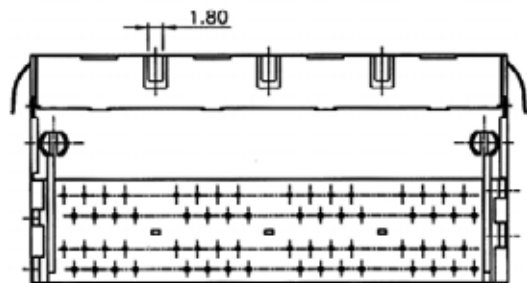
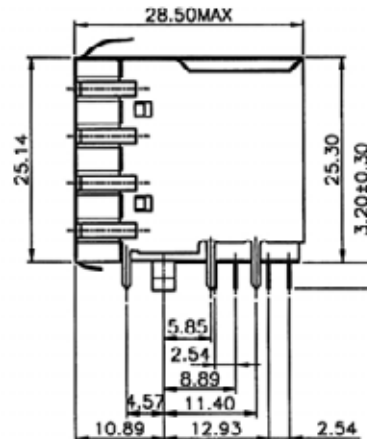
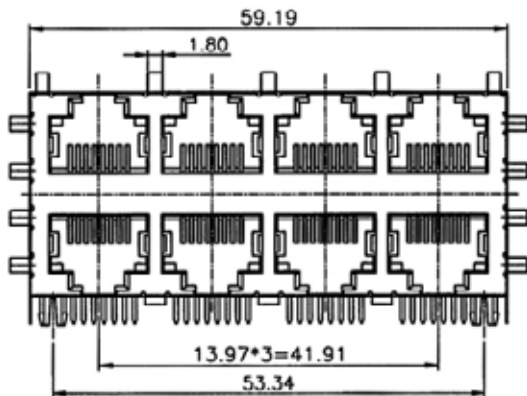
SIDE ENTRY 8-PORT DOUBLE LEVEL MODULAR PCB JACK 8P PROFILE=25.30MM (FULLY SHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Black
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
Shield: Brass plating Nickel Alloy
***RoHS & REACH compliant.**



Recommended P.C.Board Layout
(TOP VIEW)

ORDERING INFORMATION:

P/N M J 2 8 - $\frac{88}{1} \times \frac{B}{2} \frac{08}{3}$

1. NO. OF POSITIONS & CONTACTS:
"88" 8P8C
2. CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD
3. NO. OF PORTS:
08

NOTE: WITH TOP & SIDE PANEL GROUNDS

SIDE ENTRY 10-PORT DOUBLE LEVEL MODULAR PCB JACK 8P PROFILE=25.30MM (FULLY SHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)

Soldering Temperature: 235°C

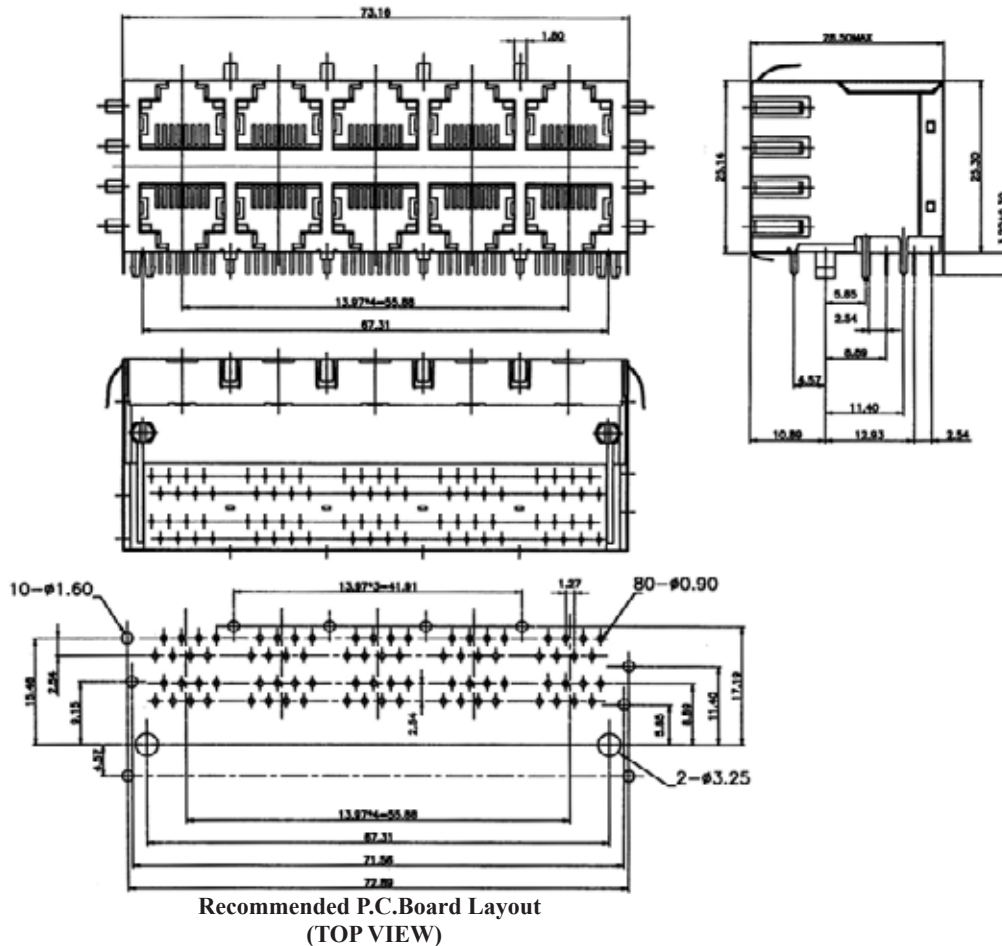
Color: Black

Spring Wire: Phosphor Bronze

Gold plating Over Nickel

Shield: Brass plating Nickel Alloy

*RoHS & REACH compliant.



ORDERING INFORMATION:

P/N M J 2 8 - $\frac{88}{1} \times \frac{B}{2} \frac{10}{3}$

1. NO. OF POSITIONS & CONTACTS:

"88" 8P8C

2. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

3. NO. OF PORTS:

10

NOTE: WITH TOP & SIDE PANEL GROUNDS

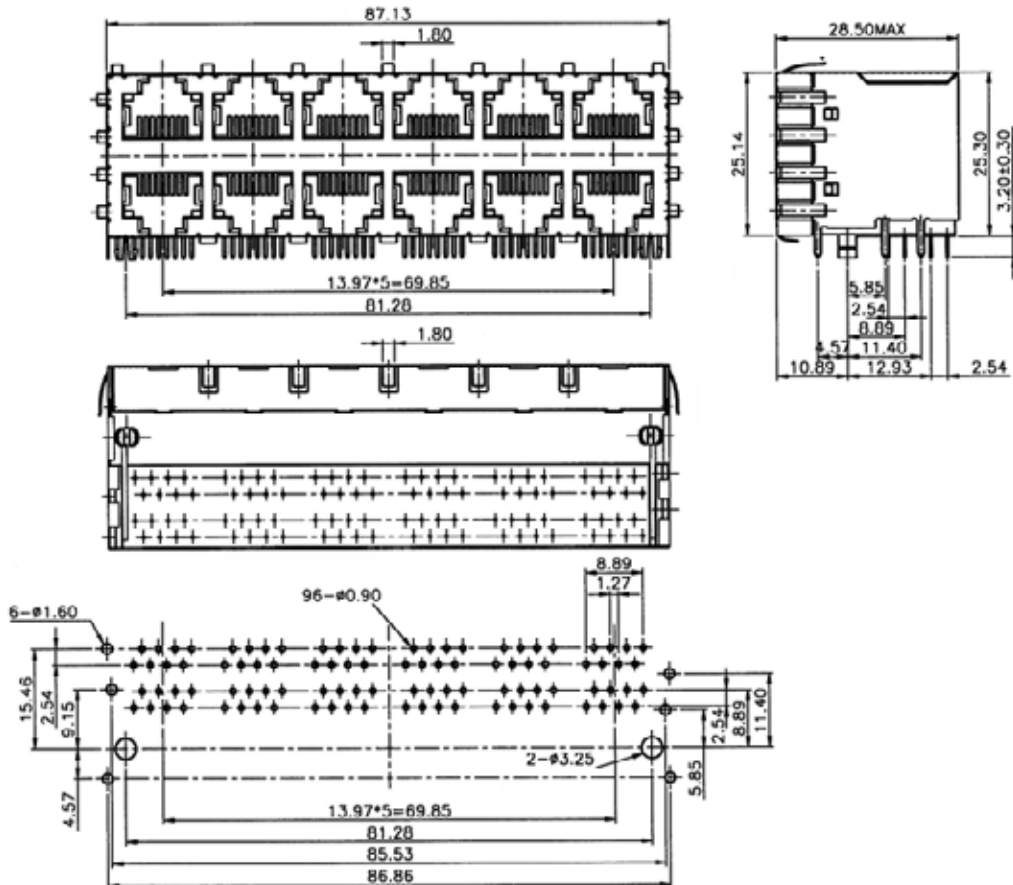
SIDE ENTRY 12-PORT DOUBLE LEVEL MODULAR PCB JACK 8P PROFILE=25.30MM (FULLY SHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Black
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
Shield: Brass plating Nickel Alloy
***RoHS & REACH compliant.**



Recommended P.C.Board Layout
(TOP VIEW)

ORDERING INFORMATION:

P/N M J 2 8 - $\frac{88}{1} \times \frac{B}{2} \frac{12}{3}$

1. NO. OF POSITIONS & CONTACTS:
"88" 8P8C
2. CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD
3. NO. OF PORTS:
12

NOTE: WITH TOP & SIDE PANEL GROUNDS

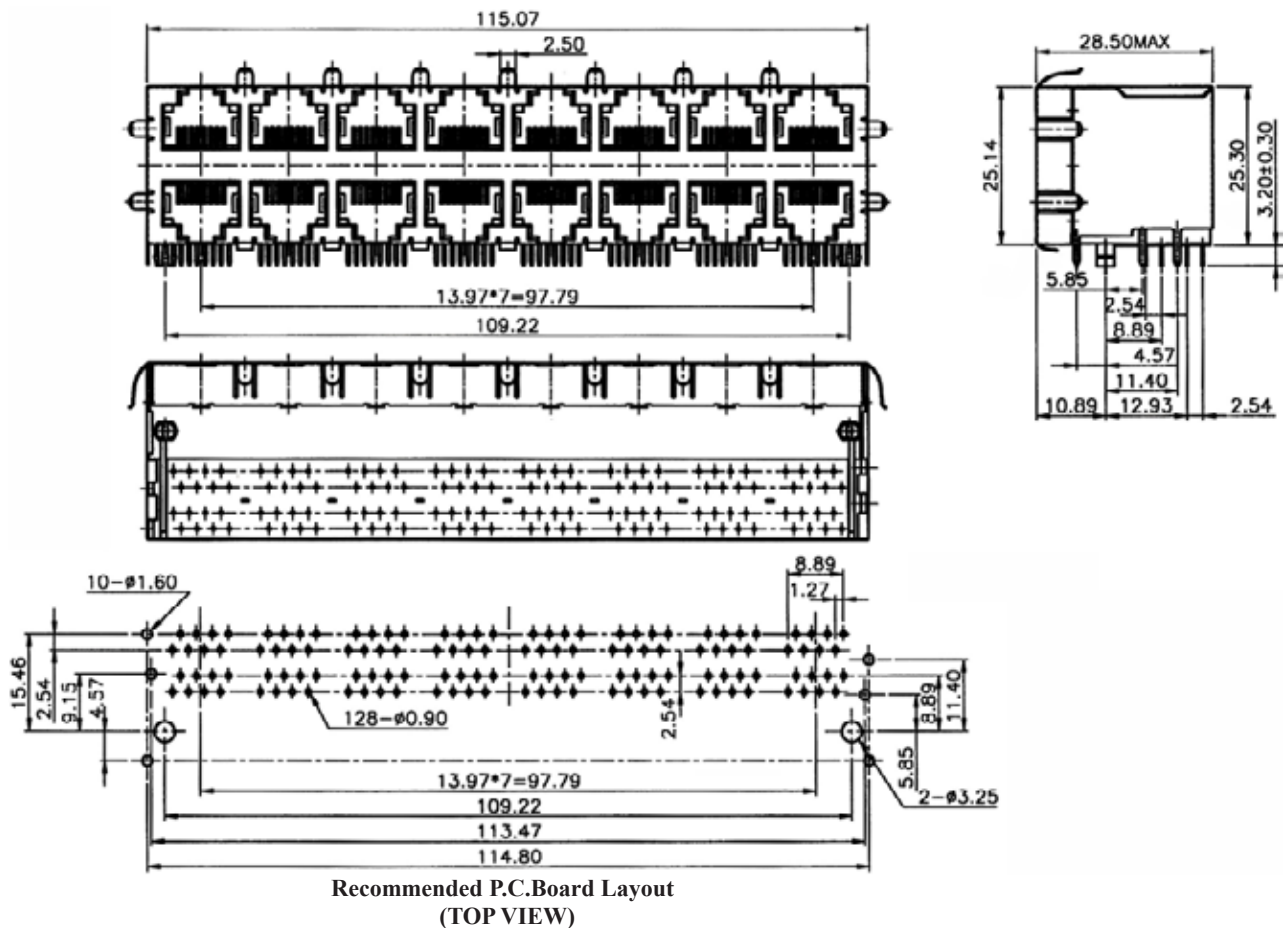
SIDE ENTRY 16-PORT DOUBLE LEVEL MODULAR PCB JACK 8P PROFILE=25.30MM (FULLY SHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Black
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
Shield: Brass plating Nickel Alloy
***RoHS & REACH compliant.**



ORDERING INFORMATION:

P/N M J 2 8 - $\frac{88}{1} \times \frac{B}{2} \frac{16}{3}$

1. NO. OF POSITIONS & CONTACTS:
"88" 8P8C
2. CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD
"E" GOLD FLASH
3. NO. OF PORTS:
16

NOTE: WITH TOP & SIDE PANEL GROUNDS

SIDE ENTRY 2-PORT DOUBLE LEVEL MODULAR PCB JACK WITH INNER SHIELD 8P PROFILE=25.30MM (FULLY SHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)

Soldering Temperature: 235°C

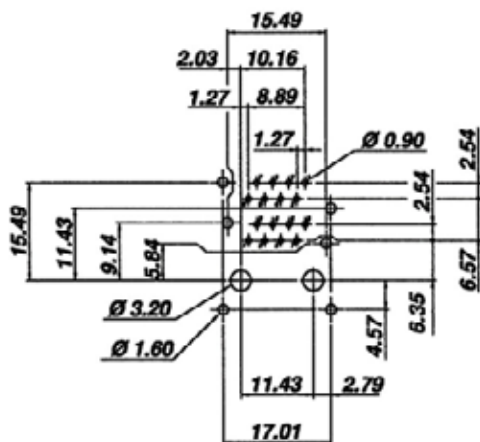
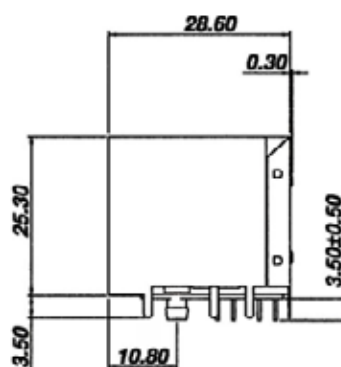
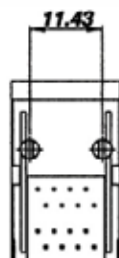
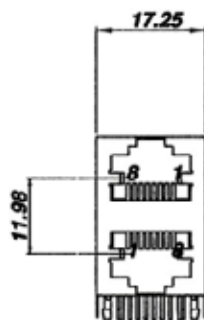
Color: Black

Spring Wire: Phosphor Bronze

Gold plating Over Nickel

Shield: Brass plating Nickel Alloy

*RoHS & REACH compliant.



Recommended P.C.Board Layout
(TOP VIEW)

ORDERING INFORMATION:

P/N MJDF - $\frac{88}{1} \times \frac{B}{2} \frac{02}{3}$

1. NO. OF POSITIONS & CONTACTS:

"88" 8P8C

2. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

3. NO. OF PORTS:

02

NOTE: P/N MJDFHT-88xB02 FOR HIGH TEMP. VERSION

SIDE ENTRY 4-PORT DOUBLE LEVEL MODULAR PCB JACK WITH INNER SHIELD 8P PROFILE=25.30MM (FULLY SHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)

Soldering Temperature: 235°C

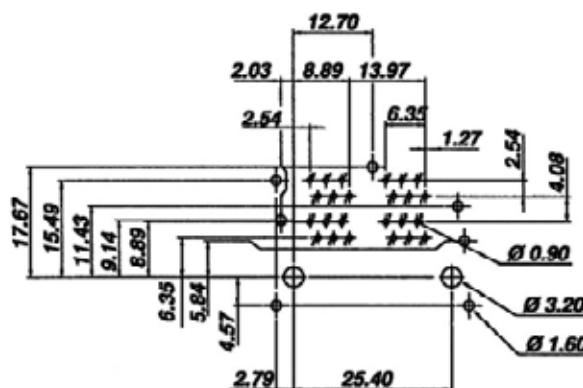
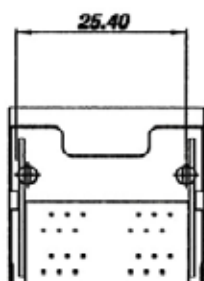
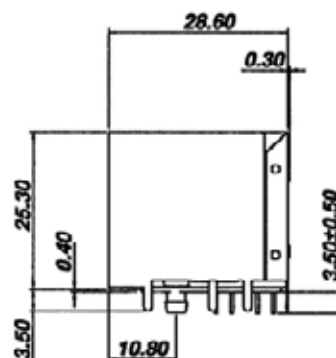
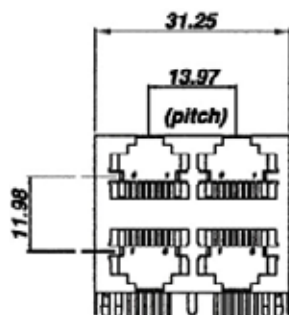
Color: Black

Spring Wire: Phosphor Bronze

Gold plating Over Nickel

Shield: Brass plating Nickel Alloy

*RoHS & REACH compliant.



Recommended P.C.Board Layout
(TOP VIEW)

ORDERING INFORMATION:

P/N MJDF - $\frac{88}{1} \times \frac{B}{2} \frac{04}{3}$

1. NO. OF POSITIONS & CONTACTS:
"88" 8P8C
2. CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD
3. NO. OF PORTS:
04

NOTE: P/N MJDFHT-88xB04 FOR HIGH TEMP. VERSION

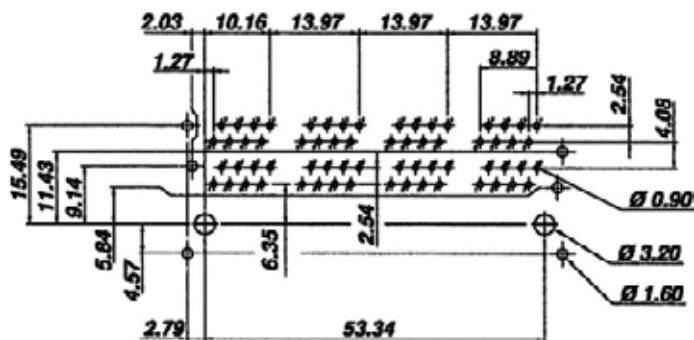
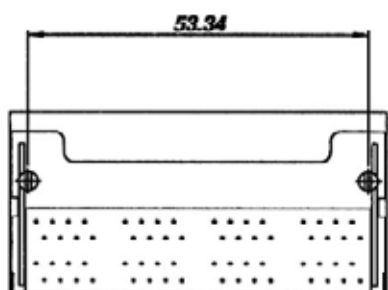
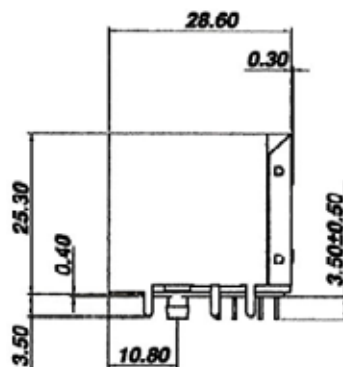
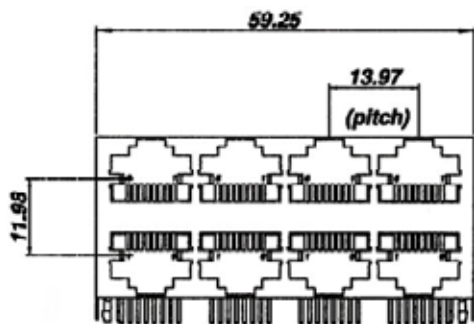
SIDE ENTRY 8-PORT DOUBLE LEVEL MODULAR PCB JACK WITH INNER SHIELD 8P PROFILE=25.30MM (FULLY SHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Black
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
Shield: Brass plating Nickel Alloy
***RoHS & REACH compliant.**



Recommended P.C.Board Layout
(TOP VIEW)

ORDERING INFORMATION:

P/N MJDF - $\frac{88}{1} \times \frac{B}{2} \frac{08}{3}$

1. NO. OF POSITIONS & CONTACTS:
"88" 8P8C
2. CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD
3. NO. OF PORTS:
08

NOTE: P/N MJDFHT-88xB08 FOR HIGH TEMP. VERSION

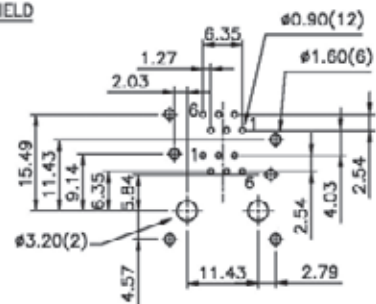
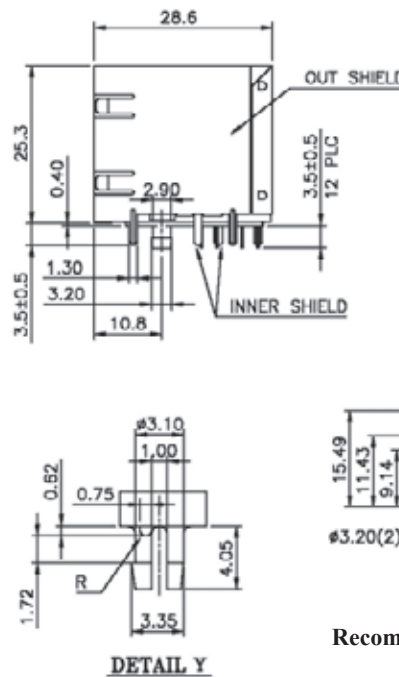
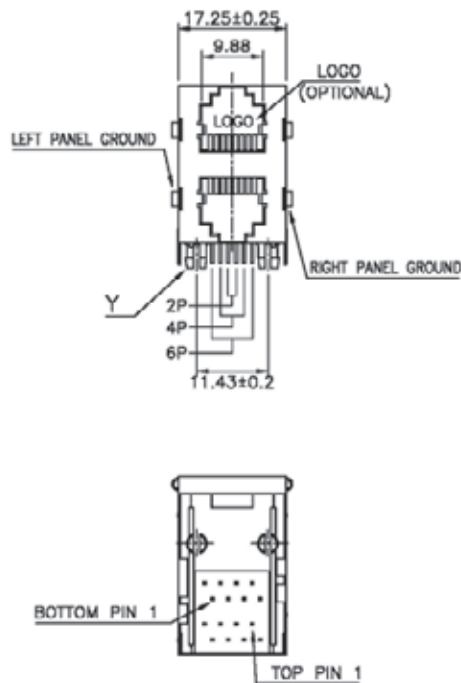
SIDE ENTRY 2-PORT DOUBLE LEVEL MODULAR PCB JACK 6P PROFILE=25.30MM (FULLY SHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Black
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
Shield: Brass plating Nickel Alloy
***RoHS & REACH compliant.**



Recommended P.C. Board Layout

ORDERING INFORMATION:

P/N M J D E - x x x B 0 2
1 2 3 4 5

- MODULAR JACK TYPE:
"DE" WITH LEFT & RIGHT PANEL GROUNDS
- NO. OF POSITIONS & CONTACTS:
"64" 6P4C
"66" 6P6C
- CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD
- HOUSING COLOR:
"B" BLACK

- NO. OF PORTS:
02

tel. 02.3361.1626 info@elitaliaweb.it
fax 02.2626.1009 www.elitaliaweb.it

SIDE ENTRY 4-PORT DOUBLE LEVEL MODULAR PCB JACK 6P PROFILE=25.30MM (FULLY SHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)

Soldering Temperature: 235°C

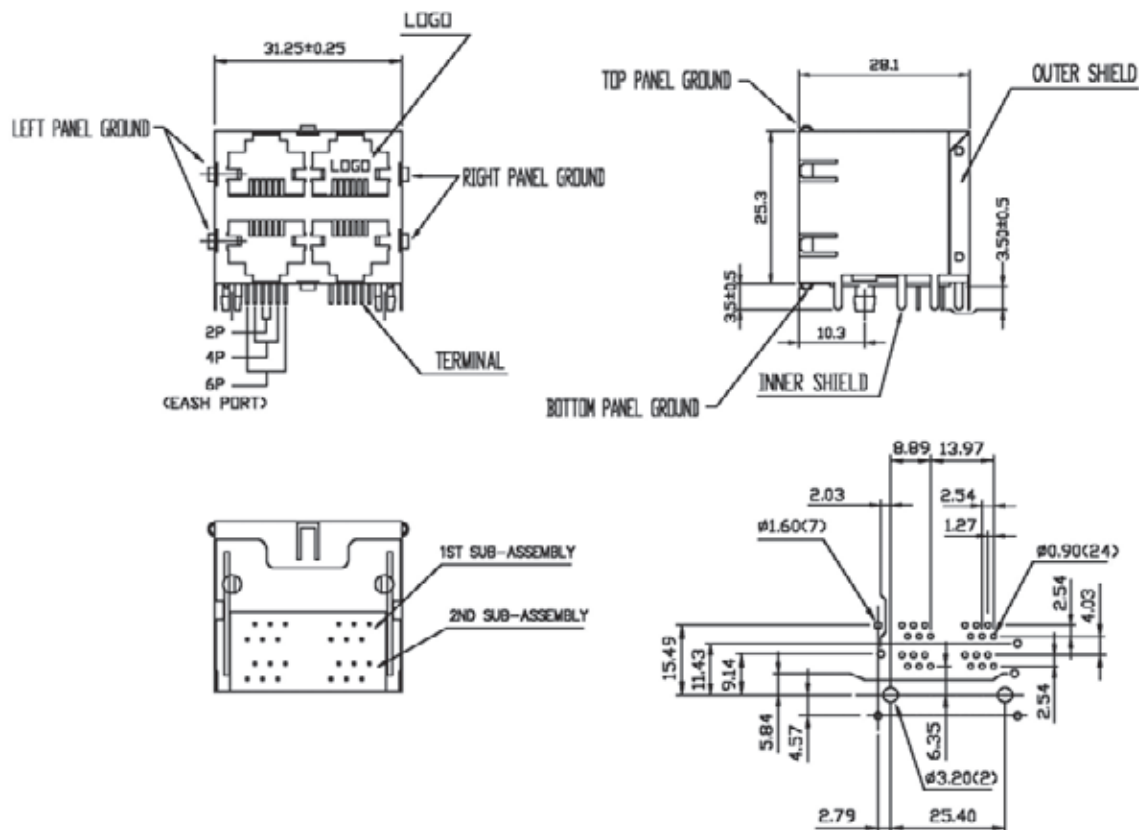
Color: Black

Spring Wire: Phosphor Bronze

Gold plating Over Nickel

Shield: Brass plating Nickel Alloy

*RoHS & REACH compliant.



Recommended P.C.Board Layout

ORDERING INFORMATION:

P/N M J J V - x x x B 0 4
 1 2 3 4 5

- MODULAR JACK TYPE:
"JV" 6 POSITION TYPE
- NO. OF POSITIONS & CONTACTS:
"66" 6P6C
"64" 6P4C
- CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD
- HOUSING COLOR:
"B" BLACK

- NO. OF PORTS:
04

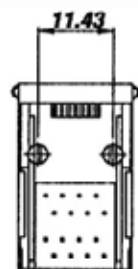
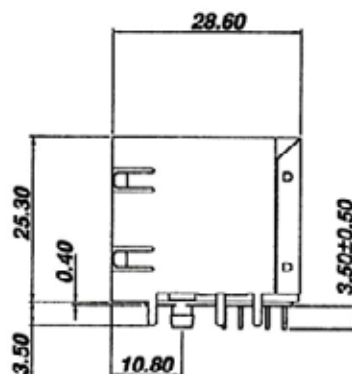
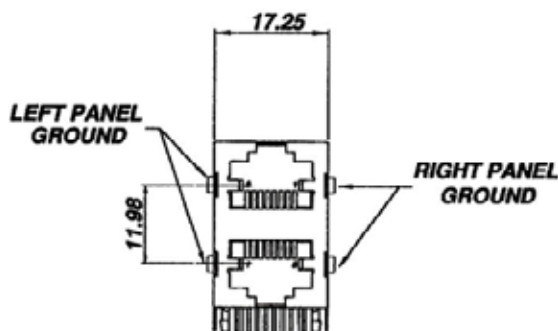
SIDE ENTRY 2-PORT DOUBLE LEVEL MODULAR PCB JACK WITH INNER SHIELD 8P PROFILE=25.30MM (FULLY SHIELDED)

SPECIFICATIONS

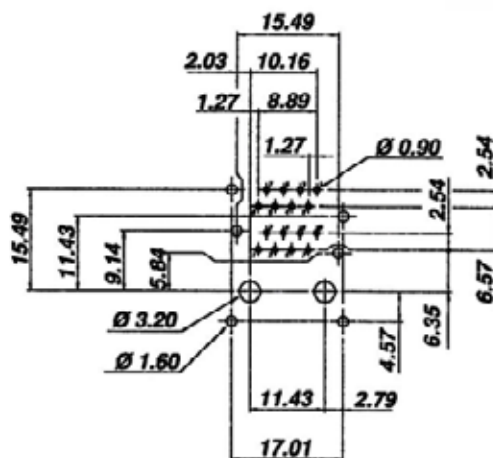
Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Black
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
Shield: Brass plating Nickel Alloy
***RoHS & REACH compliant.**



PANEL GROUND MODE



**Recommended P.C. Board Layout
(TOP VIEW)**

ORDERING INFORMATION:

P/N MJDE - $\frac{88}{1} \times \frac{B}{2} \frac{02}{3}$

1. NO. OF POSITIONS & CONTACTS:
"88" 8P8C
2. CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD
3. NO. OF PORTS:
02

NOTE: P/N MJDEHT-88xB02 FOR HIGH TEMP. VERSION

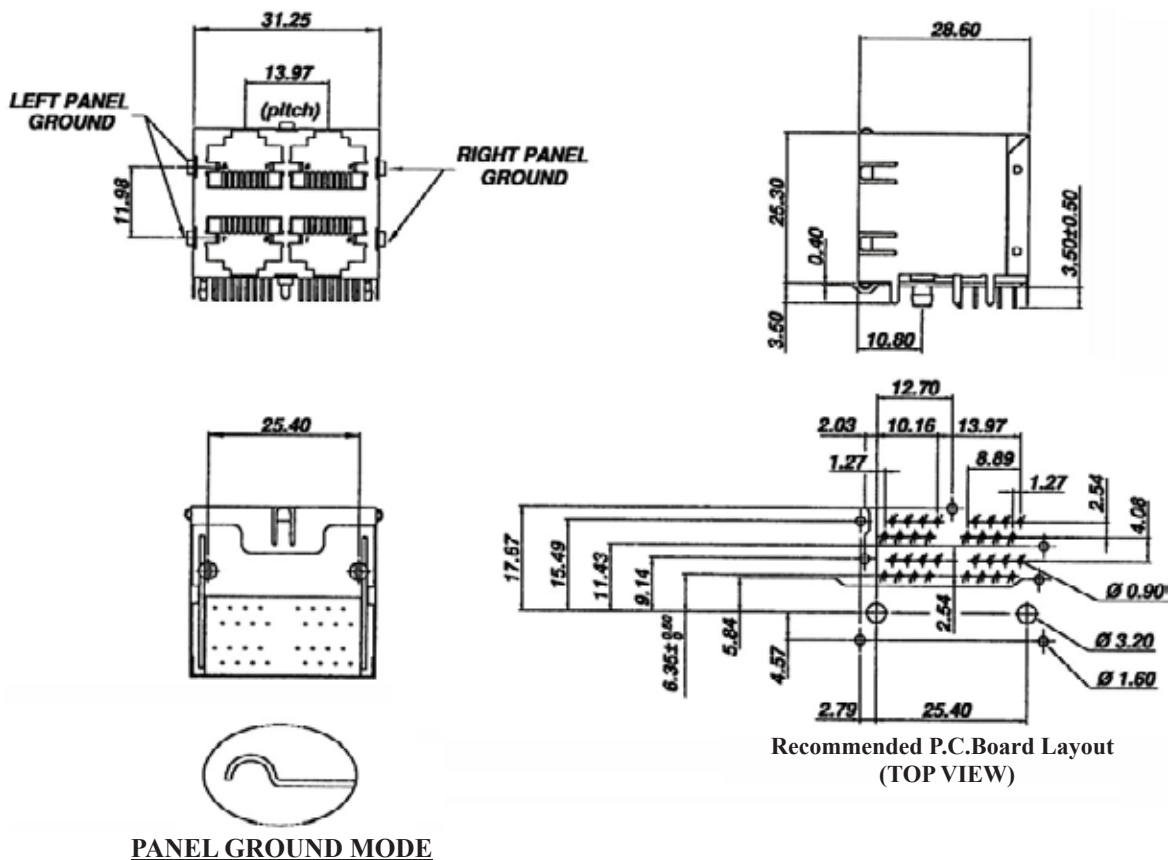
SIDE ENTRY 4-PORT DOUBLE LEVEL MODULAR PCB JACK WITH INNER SHIELD 8P PROFILE=25.30MM (FULLY SHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Black
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
Shield: Brass plating Nickel Alloy
***RoHS & REACH compliant.**



ORDERING INFORMATION:

P/N MJDE - $\frac{88}{1} \times \frac{B}{2} \frac{04}{3}$

1. NO. OF POSITIONS & CONTACTS:
"88" 8P8C
2. CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD
3. NO. OF PORTS:
04

NOTE: P/N MJDEHT-88xB04 FOR HIGH TEMP. VERSION

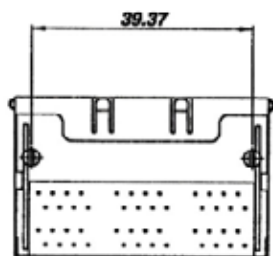
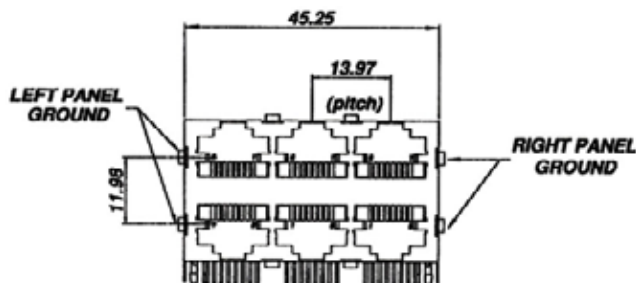
SIDE ENTRY 6-PORT DOUBLE LEVEL MODULAR PCB JACK WITH INNER SHIELD 8P PROFILE=25.30MM (FULLY SHIELDED)

SPECIFICATIONS

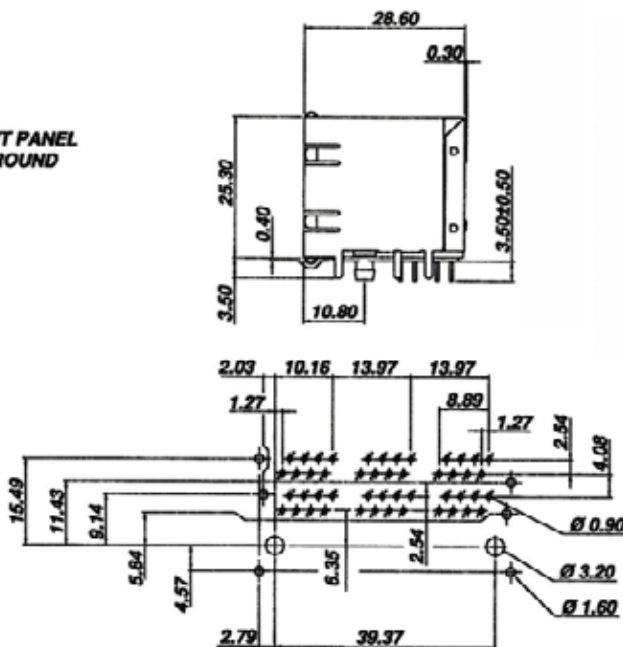
Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Black
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
Shield: Brass plating Nickel Alloy
***RoHS & REACH compliant.**



PANEL GROUND MODE



**Recommended P.C.Board Layout
(TOP VIEW)**

ORDERING INFORMATION:

P/N MJDE - $\frac{88}{1} \times \frac{B}{2} \frac{06}{3}$

1. NO. OF POSITIONS & CONTACTS:
"88" 8P8C
2. CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD
3. NO. OF PORTS:
06

NOTE: P/N MJDEHT-88xB06 FOR HIGH TEMP. VERSION

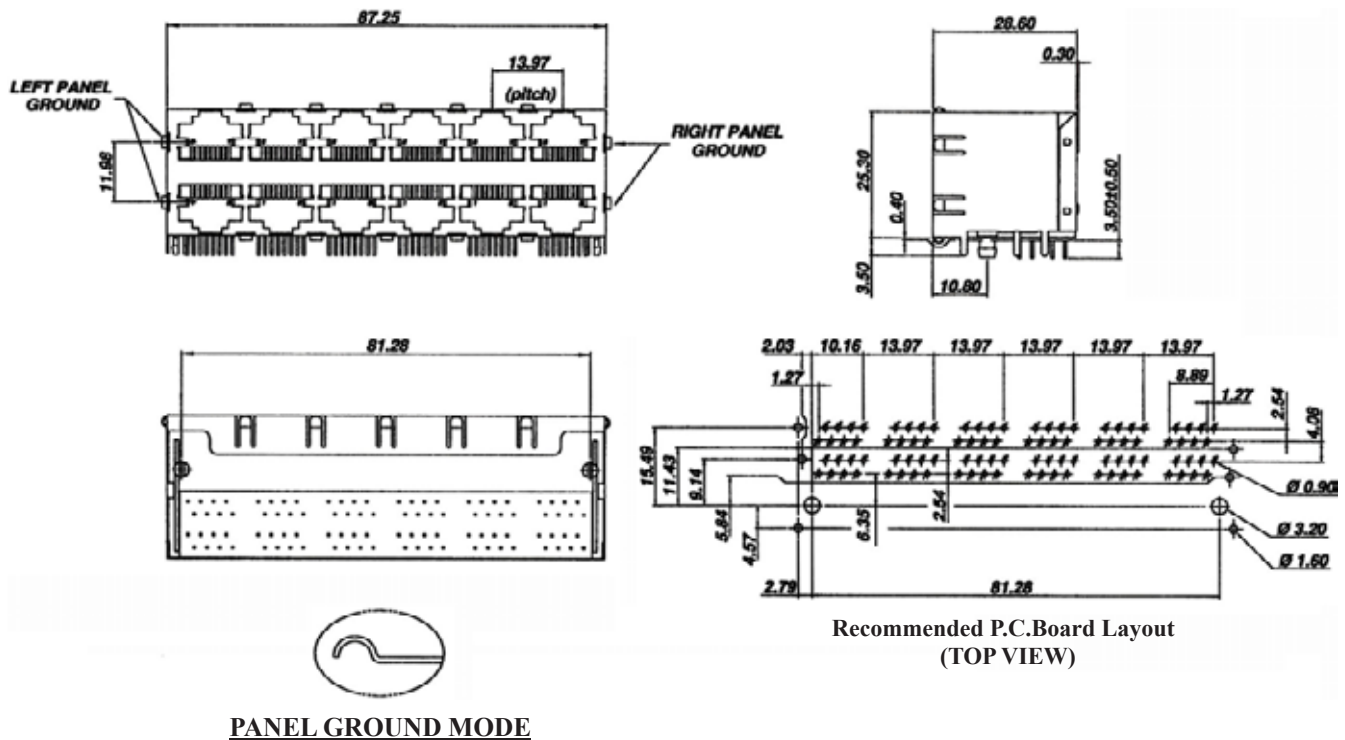
SIDE ENTRY 12-PORT DOUBLE LEVEL MODULAR PCB JACK WITH INNER SHIELD 8P PROFILE=25.30MM (FULLY SHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Black
Spring Wire: Phosphor Bronze
Gold plating Over Nickel
Shield: Brass plating Nickel Alloy
*RoHS & REACH compliant.



ORDERING INFORMATION:

P/N MJDE - $\frac{88}{1} \times \frac{B}{2} \frac{12}{3}$

1. NO. OF POSITIONS & CONTACTS:
"88" 8P8C
2. CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD
3. NO. OF PORTS:
12

NOTE: P/N MJDEHT-88xB12 FOR HIGH TEMP. VERSION

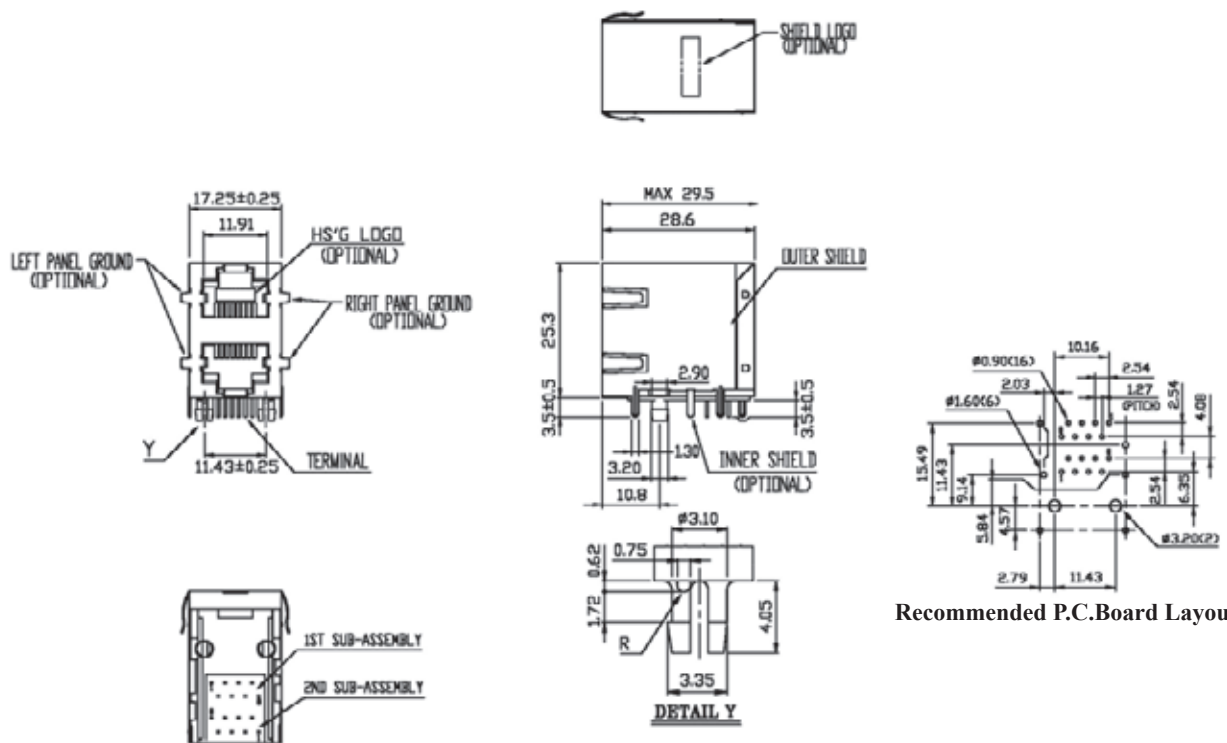
SIDE ENTRY 2-PORT MODULAR PCB JACK 8P PROFILE=25.30MM (FULLY SHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Black
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
Shield: Brass plating Nickel Alloy
***RoHS & REACH compliant.**



Recommended P.C.Board Layout

ORDERING INFORMATION:

P/N M J $\frac{X}{1}$ - $\frac{88}{2}$ $\frac{X}{3}$ $\frac{B}{4}$ $\frac{02}{5}$

- MODULAR JACK TYPE:
 "JR" WITH RIGHT/LEFT PANEL GROUNDS
 "JT" WITHOUT PANEL GROUNDS
- NO. OF POSITIONS & CONTACTS:
 "88" 8P8C
- CONTACT FINISH:
 "A" 6 MICROINCH GOLD
 "B" 15 MICROINCH GOLD
 "C" 30 MICROINCH GOLD
 "D" 50 MICROINCH GOLD
- HOUSING COLOR:
 "B" BLACK

- NO. OF PORTS:
 02

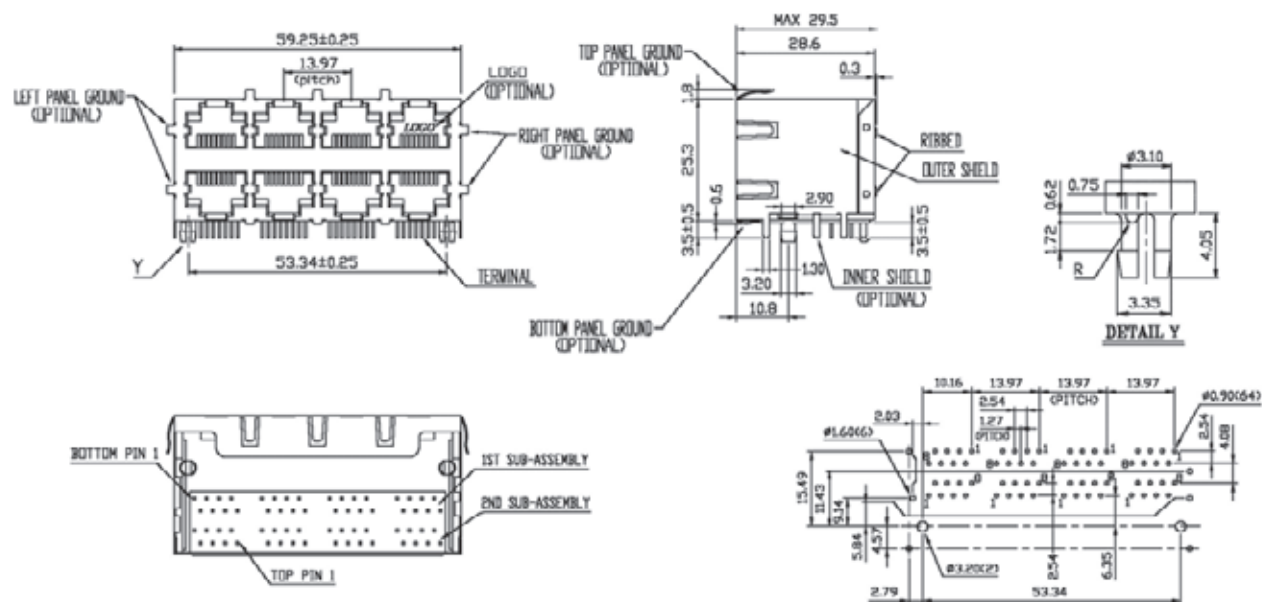
SIDE ENTRY 8-PORT DOUBLE LEVEL MODULAR PCB JACK 8P PROFILE=25.30MM (FULLY SHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Black
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
Shield: Brass plating Nickel Alloy
***RoHS & REACH compliant.**



Recommended P.C.Board Layout

ORDERING INFORMATION:

P/N M J $\frac{xx}{1}$ - $\frac{88}{2}$ $\frac{x}{3}$ $\frac{B}{4}$ $\frac{08}{5}$

- MODULAR JACK TYPE:
 "JU" WITH TOP/RIGHT/LEFT/BOTTOM SIDE TABS
 "JQ" WITH TOP/RIGHT/LEFT SIDE TABS
 "JR" WITH RIGHT/LEFT TABS
 "JS" WITH TOP/BOTTOM SIDE TABS
 "JT" WITHOUT GROUNDING TABS
- NO. OF POSITIONS & CONTACTS:
 "88" 8P8C
- CONTACT FINISH:
 "A" 6 MICROINCH GOLD
 "B" 15 MICROINCH GOLD
 "C" 30 MICROINCH GOLD
 "D" 50 MICROINCH GOLD

- HOUSING COLOR:
 "B" BLACK
- NO. OF PORTS:
 08

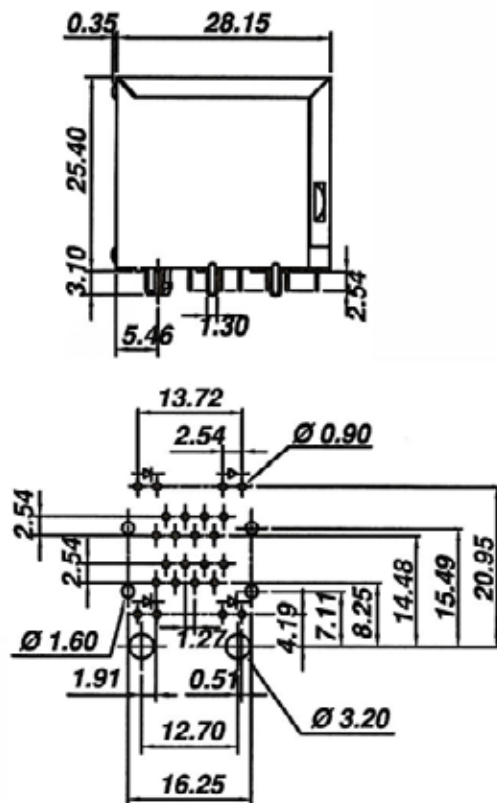
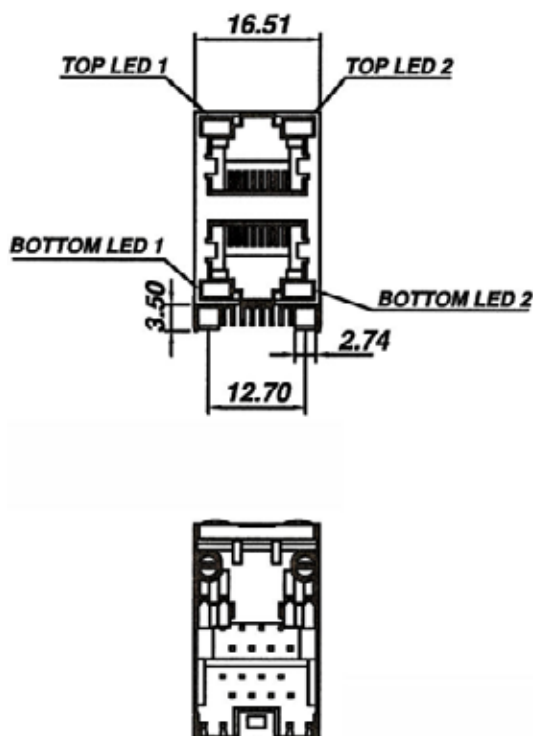
SIDE ENTRY 2-PORT DOUBLE LEVEL MODULAR PCB JACK WITH LED 8P PROFILE=25.40MM (FULLY SHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Black
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
Shield: Brass plating Nickel Alloy
***RoHS & REACH compliant.**



Recommended P.C.Board Layout
(TOP VIEW)

ORDERING INFORMATION:

P/N M J D A - $\frac{88}{12} \times \frac{B}{34} \times \frac{02}{5}$

1. NO. OF POSITIONS & CONTACTS:
"88" 8P8C
2. CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD
3. CODE OF LED1 DESIGNATION:
N, M, Y, Z, 8, Q, 1, 2, 5, 6
4. CODE OF LED2 DESIGNATION:
N, M, Y, Z, 8, Q, 1, 2, 5, 6
5. NO. OF PORTS:
02

LED Designation:

Code	+/-	-/+	Code	+/-	-/+
N	Green	—	M	—	Green
Y	Yellow	—	Z	—	Yellow
8	Orange	—	Q	—	Orange
1	Green	Orange	2	Orange	Green
5	Green	Yellow	6	Yellow	Green

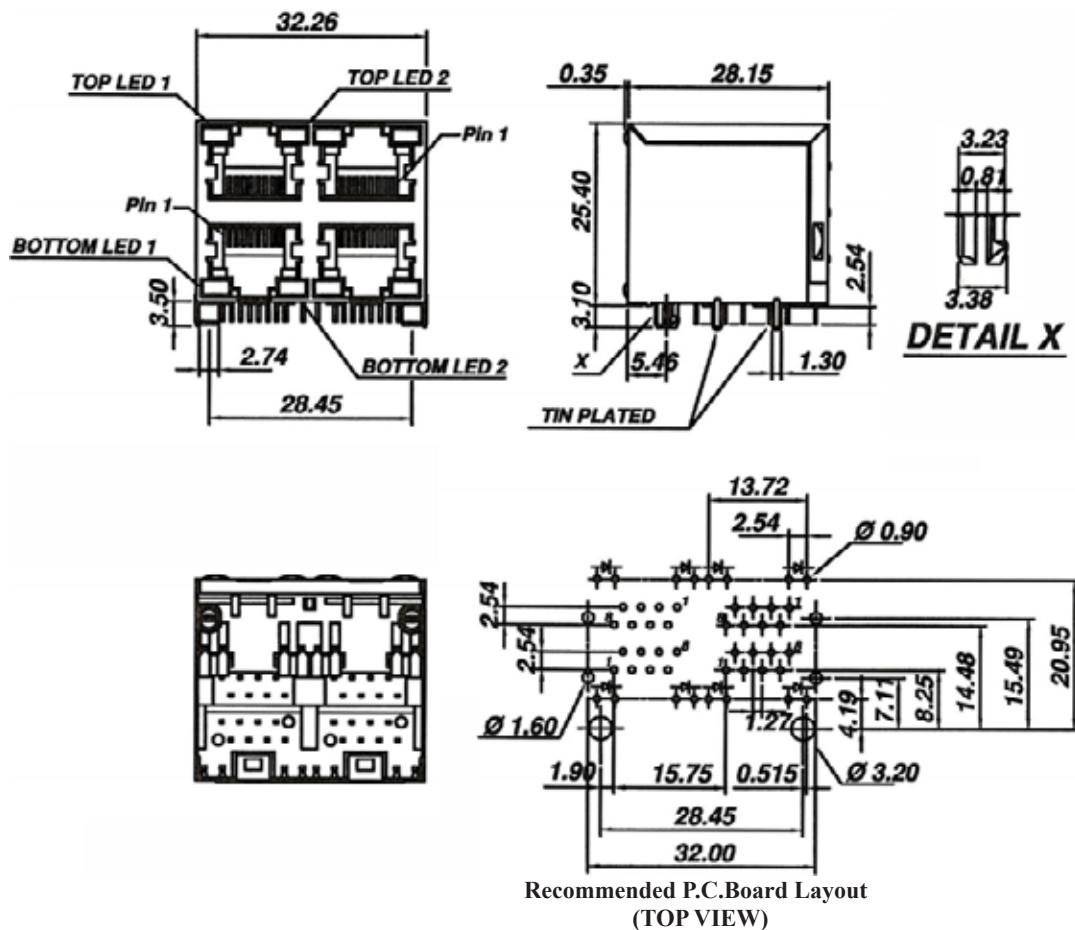
SIDE ENTRY 4-PORT DOUBLE LEVEL MODULAR PCB JACK WITH LED 8P PROFILE=25.40MM (FULLY SHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Black
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
Shield: Brass plating Nickel Alloy
 *RoHS & REACH compliant.



ORDERING INFORMATION:

P/N M J D A - $\frac{88}{12} \times \frac{B}{34} \times \frac{04}{5}$

1. NO. OF POSITIONS & CONTACTS:
"88" 8P8C
2. CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD
3. CODE OF LED1 DESIGNATION:
N, M, Y, Z, 8, Q, 1, 2, 5, 6
4. CODE OF LED2 DESIGNATION:
N, M, Y, Z, 8, Q, 1, 2, 5, 6
5. NO. OF PORTS:
04

LED Designation:

Code	+/-	-/+	Code	+/-	-/+
N	Green	—	M	—	Green
Y	Yellow	—	Z	—	Yellow
8	Orange	—	Q	—	Orange
1	Green	Orange	2	Orange	Green
5	Green	Yellow	6	Yellow	Green

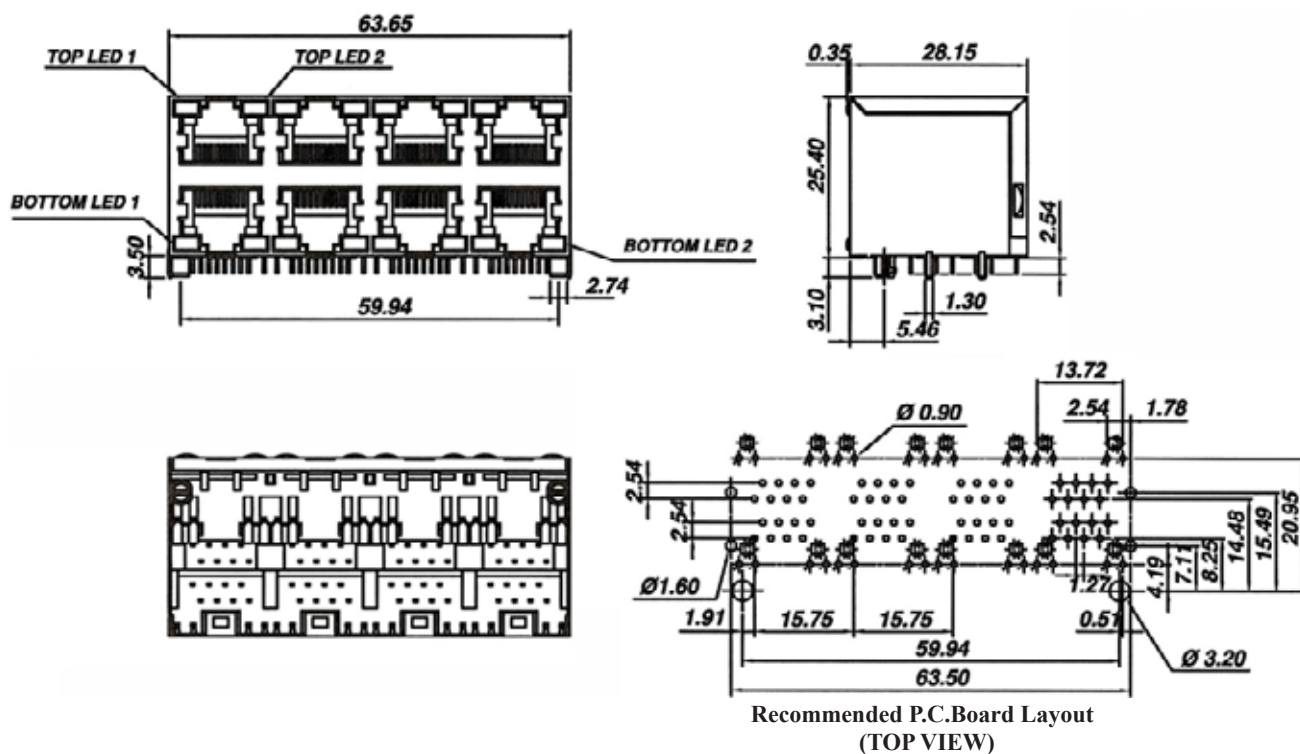
SIDE ENTRY 8-PORT DOUBLE LEVEL MODULAR PCB JACK WITH LED 8P PROFILE=25.40MM (FULLY SHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Black
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
Shield: Brass plating Nickel Alloy
***RoHS & REACH compliant.**



ORDERING INFORMATION:

P/N M J D A - $\frac{88}{12} \times \frac{B}{34} \times \frac{08}{5}$

1. NO. OF POSITIONS & CONTACTS:
"88" 8P8C
2. CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD
3. CODE OF LED1 DESIGNATION:
N, M, Y, Z, 8, Q, 1, 2, 5, 6
4. CODE OF LED2 DESIGNATION:
N, M, Y, Z, 8, Q, 1, 2, 5, 6
5. NO. OF PORTS:
08

LED Designation:

Code	+/-	-/+	Code	+/-	-/+
N	Green	—	M	—	Green
Y	Yellow	—	Z	—	Yellow
8	Orange	—	Q	—	Orange
1	Green	Orange	2	Orange	Green
5	Green	Yellow	6	Yellow	Green

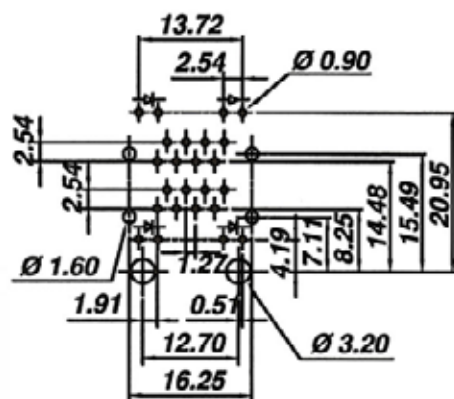
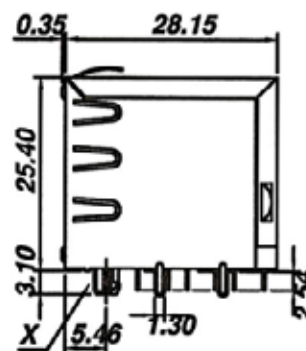
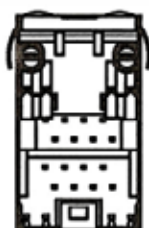
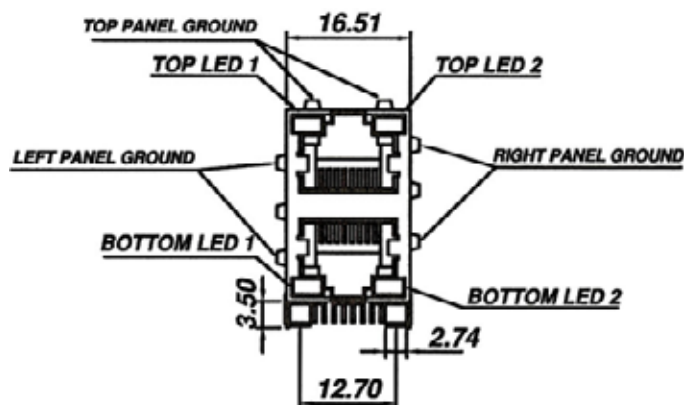
SIDE ENTRY 2-PORT DOUBLE LEVEL MODULAR PCB JACK WITH LED 8P PROFILE=25.40MM (FULLY SHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Black
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
Shield: Brass plating Nickel Alloy
***RoHS & REACH compliant.**



Recommended P.C.Board Layout
(TOP VIEW)

ORDERING INFORMATION:

P/N M J D B - $\frac{88}{12} \times \frac{B}{34} \times \frac{02}{5}$

1. NO. OF POSITIONS & CONTACTS:
"88" 8P8C
2. CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD
3. CODE OF LED1 DESIGNATION:
N, M, Y, Z, 8, Q, 1, 2, 5, 6
4. CODE OF LED2 DESIGNATION:
N, M, Y, Z, 8, Q, 1, 2, 5, 6
5. NO. OF PORTS:
02

LED Designation:

Code	+/-	-/+	Code	+/-	-/+
N	Green	—	M	—	Green
Y	Yellow	—	Z	—	Yellow
8	Orange	—	Q	—	Orange
1	Green	Orange	2	Orange	Green
5	Green	Yellow	6	Yellow	Green

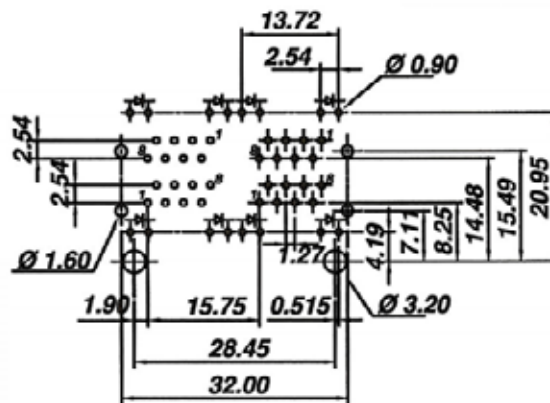
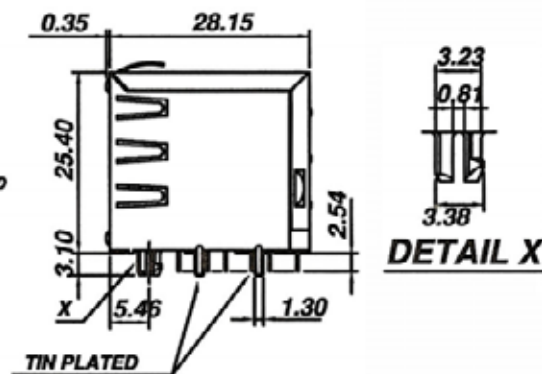
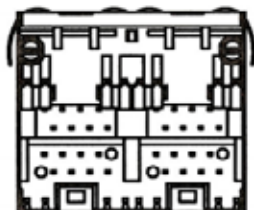
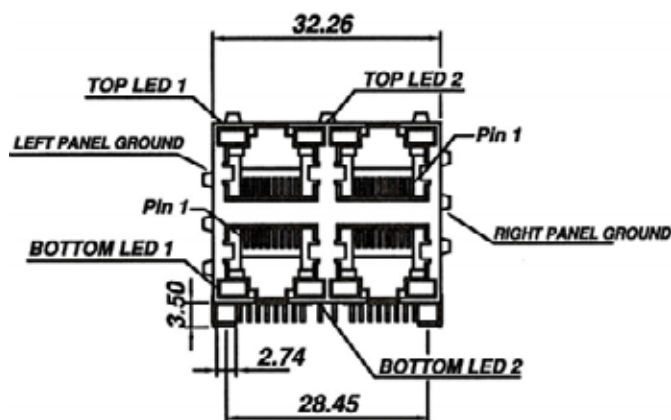
SIDE ENTRY 4-PORT DOUBLE LEVEL MODULAR PCB JACK WITH LED 8P PROFILE=25.40MM (FULLY SHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Black
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
Shield: Brass plating Nickel Alloy
***RoHS & REACH compliant.**



Recommended P.C.Board Layout
(TOP VIEW)

ORDERING INFORMATION:

P/N M J D B - $\frac{88}{1} \times \frac{B}{2} \times \frac{04}{345}$

1. NO. OF POSITIONS & CONTACTS:
"88" 8P8C
2. CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD
3. CODE OF LED1 DESIGNATION:
N, M, Y, Z, 8, Q, 1, 2, 5, 6
4. CODE OF LED2 DESIGNATION:
N, M, Y, Z, 8, Q, 1, 2, 5, 6
5. NO. OF PORTS:
04

LED Designation:

Code	+/-	-/+	Code	+/-	-/+
N	Green	—	M	—	Green
Y	Yellow	—	Z	—	Yellow
8	Orange	—	Q	—	Orange
1	Green	Orange	2	Orange	Green
5	Green	Yellow	6	Yellow	Green

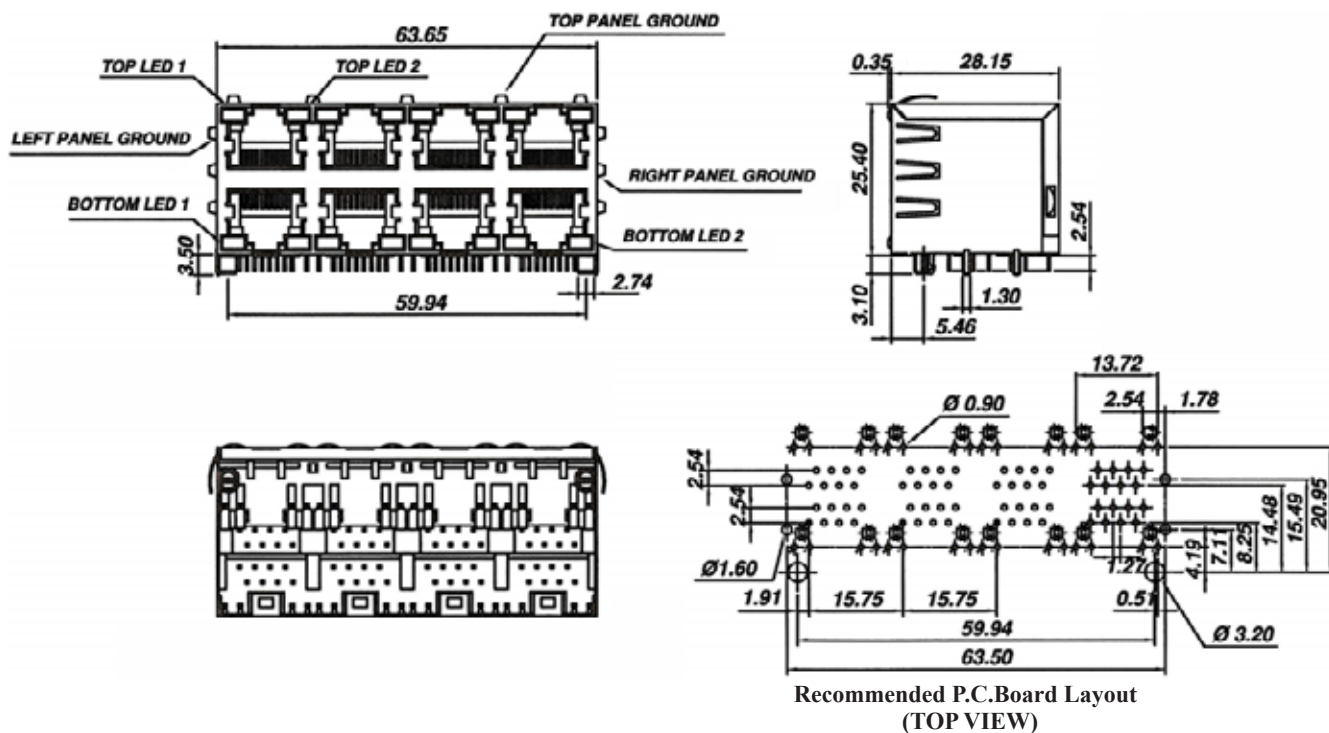
SIDE ENTRY 8-PORT DOUBLE LEVEL MODULAR PCB JACK WITH LED 8P PROFILE=25.40MM (FULLY SHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Black
Spring Wire: Phosphor Bronze
Gold plating Over Nickel
Shield: Brass plating Nickel Alloy
*RoHS & REACH compliant.



ORDERING INFORMATION:

P/N M J D B - $\frac{88}{12} \times \frac{B}{34} \times \frac{08}{5}$

1. NO. OF POSITIONS & CONTACTS:
"88" 8P8C
2. CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD
3. CODE OF LED1 DESIGNATION:
N, M, Y, Z, 8, Q, 1, 2, 5, 6
4. CODE OF LED2 DESIGNATION:
N, M, Y, Z, 8, Q, 1, 2, 5, 6
5. NO. OF PORTS:
08

LED Designation:

Code	+/-	-/+	Code	+/-	-/+
N	Green	—	M	—	Green
Y	Yellow	—	Z	—	Yellow
8	Orange	—	Q	—	Orange
1	Green	Orange	2	Orange	Green
5	Green	Yellow	6	Yellow	Green

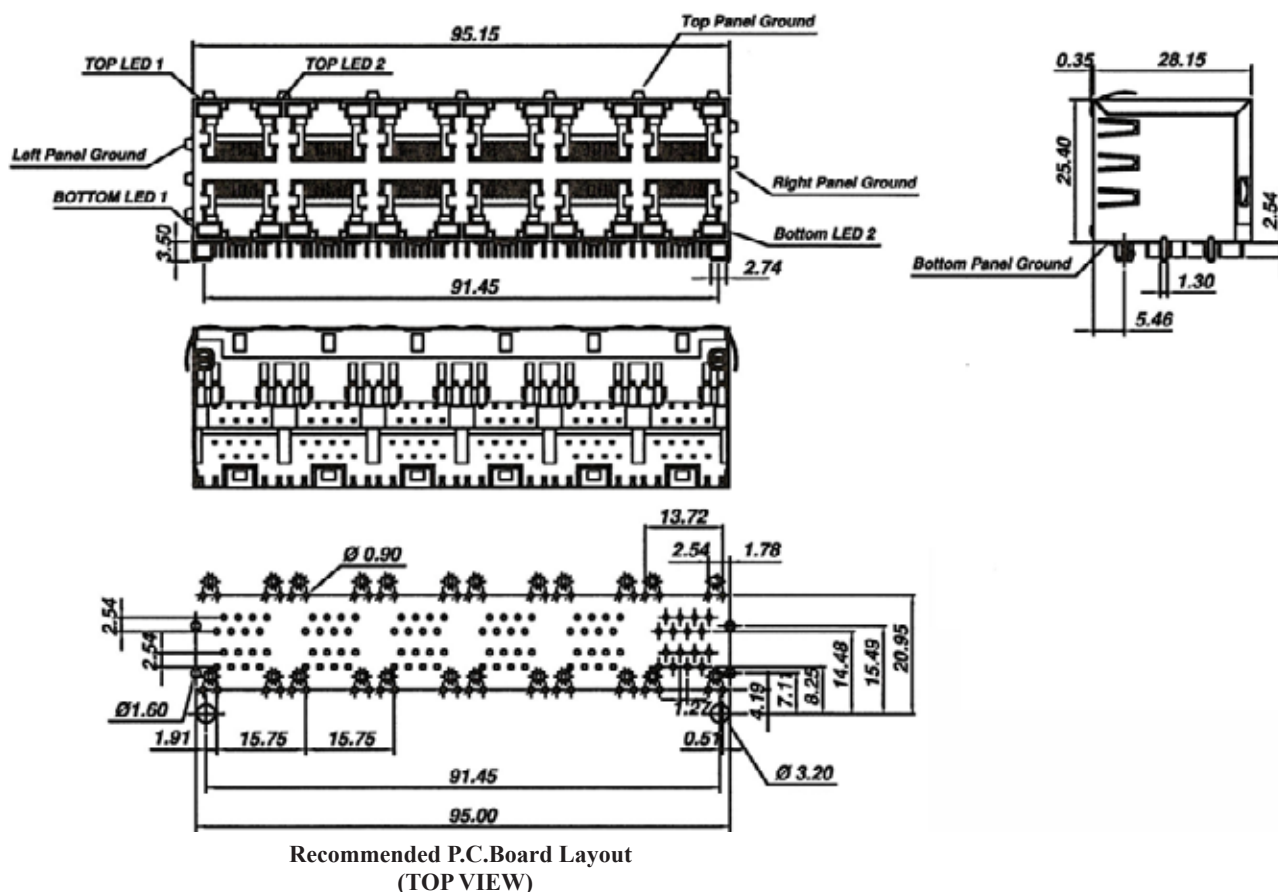
SIDE ENTRY 12-PORT DOUBLE LEVEL MODULAR PCB JACK WITH LED 8P PROFILE=25.40MM (FULLY SHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Black
Spring Wire: Phosphor Bronze
Gold plating Over Nickel
Shield: Brass plating Nickel Alloy
*RoHS & REACH compliant.



ORDERING INFORMATION:

P/N M J D B - $\frac{88}{1} \times \frac{B}{2} \times \frac{12}{345}$

1. NO. OF POSITIONS & CONTACTS:
"88" 8P8C
2. CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD
3. CODE OF LED1 DESIGNATION:
N, M, Y, Z, 8, Q, 1, 2, 5, 6
4. CODE OF LED2 DESIGNATION:
N, M, Y, Z, 8, Q, 1, 2, 5, 6
5. NO. OF PORTS:
12

LED Designation:

Code	+/-	-/+	Code	+/-	-/+
N	Green	—	M	—	Green
Y	Yellow	—	Z	—	Yellow
8	Orange	—	Q	—	Orange
1	Green	Orange	2	Orange	Green
5	Green	Yellow	6	Yellow	Green

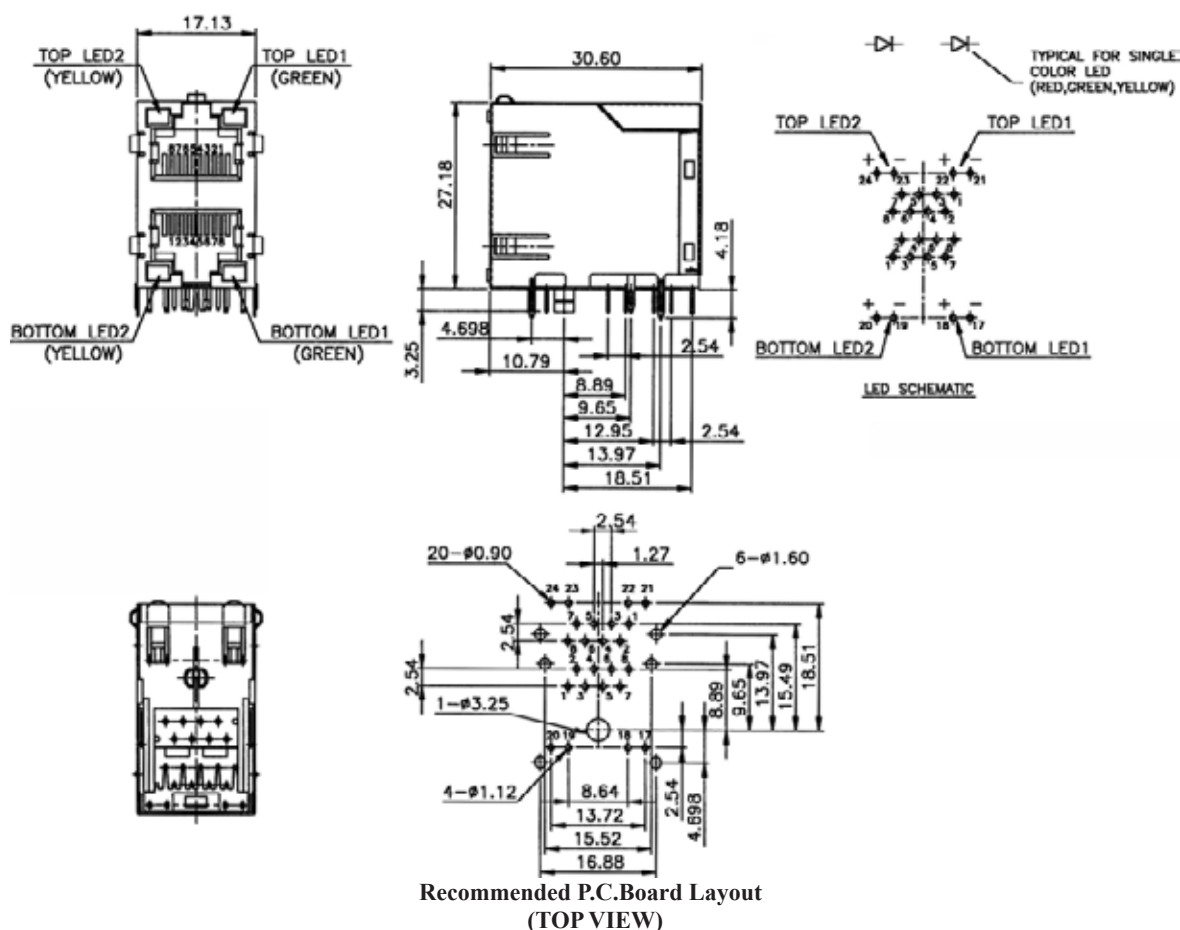
SIDE ENTRY 2-PORT DOUBLE LEVEL MODULAR PCB JACK WITH LED 8P PROFILE=27.18MM (FULLY SHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Black
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
Shield: Brass plating Nickel Alloy
***RoHS & REACH compliant.**



ORDERING INFORMATION:

P/N M J A 3 - $\frac{88}{1} \times \frac{B}{2} \times \frac{02}{345}$

1. NO. OF POSITIONS & CONTACTS:
"88" 8P8C
2. CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD
3. CODE OF LED1 DESIGNATION:
N, M, Y, Z, 8, Q, 1, 2, 5, 6
4. CODE OF LED2 DESIGNATION:
N, M, Y, Z, 8, Q, 1, 2, 5, 6
5. NO. OF PORTS:
02

LED Designation:

Code	+/-	-/+	Code	+/-	-/+
N	Green	—	M	—	Green
Y	Yellow	—	Z	—	Yellow
8	Orange	—	Q	—	Orange
1	Green	Orange	2	Orange	Green
5	Green	Yellow	6	Yellow	Green

NOTE: LED1= RIGHT LED &
LED2= LEFT LED

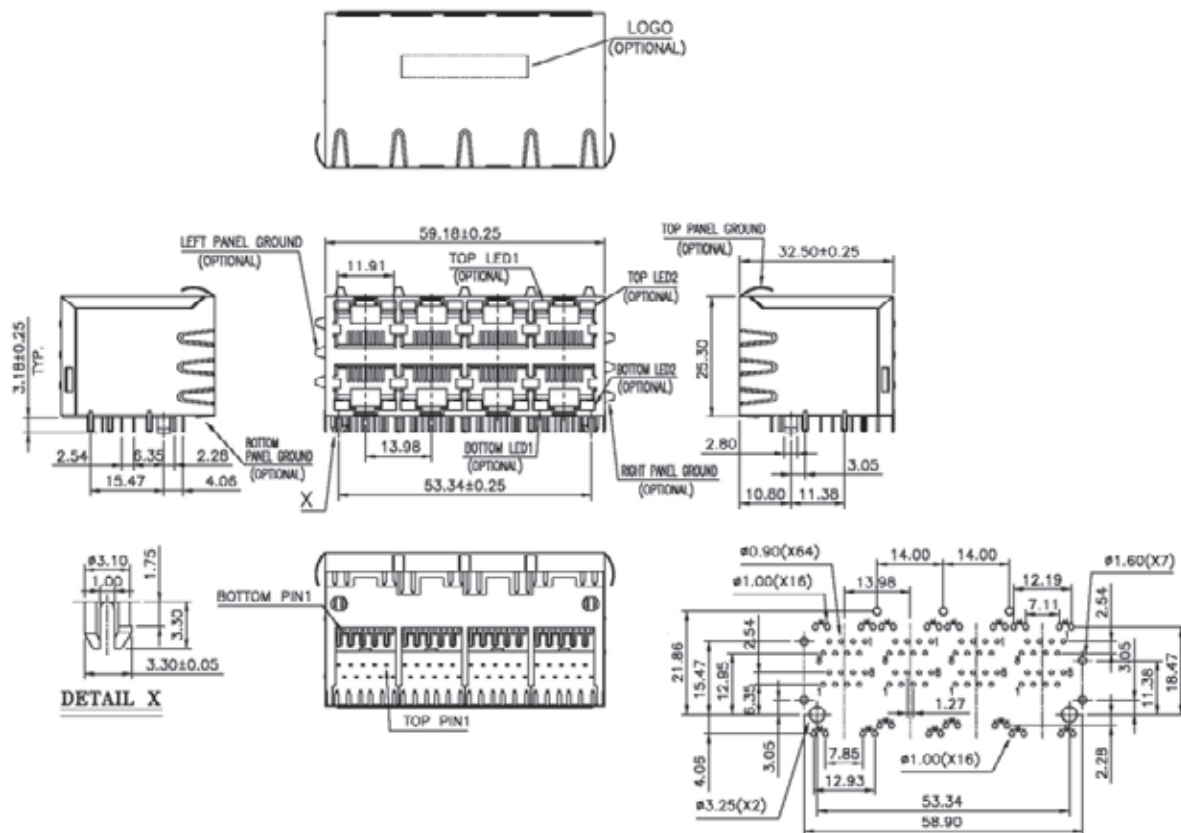
SIDE ENTRY 8-PORT DOUBLE LEVEL MODULAR PCB JACK 8P WITH LED PROFILE=25.30MM (FULLY SHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Black
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
Shield: Brass plating Nickel Alloy
***RoHS & REACH compliant.**



Recommended P.C.Board Layout

ORDERING INFORMATION:

P/N M J $\frac{XX}{1}$ - $\frac{88}{2}$ $\frac{X}{3}$ $\frac{B}{4}$ $\frac{XX}{5}$ $\frac{08}{6}$

- MODULAR JACK TYPE:
 "KA" WITH TOP/RIGHT/LEFT/BOTTOM SIDE TABS
 "KB" WITH TOP/RIGHT/LEFT SIDE TABS
 "KC" WITH RIGHT/LEFT TABS
 "KD" WITH TOP/BOTTOM SIDE TABS
 "KE" WITHOUT GROUNDING TABS
- NO. OF POSITIONS & CONTACTS:
 "88" 8P8C
- CONTACT FINISH:
 "A" 6 MICROINCH GOLD
 "B" 15 MICROINCH GOLD
 "C" 30 MICROINCH GOLD
 "D" 50 MICROINCH GOLD

- HOUSING COLOR:
 "B" BLACK
- COLORS OF LED:
 "NN" LED1/2 = GREEN/GREEN
 "NY" LED1/2 = GREEN/YELLOW
 "YN" LED1/2 = YELLOW/GREEN
 "YY" LED1/2 = YELLOW/YELLOW
 "XX" WITHOUT LED
- NO. OF PORTS:
 08

NOTE: OTHER LED COLORS UPON REQUEST!

tel. 02.3361.1626 info@elitaliaweb.it
fax 02.2626.1009 www.elitaliaweb.it

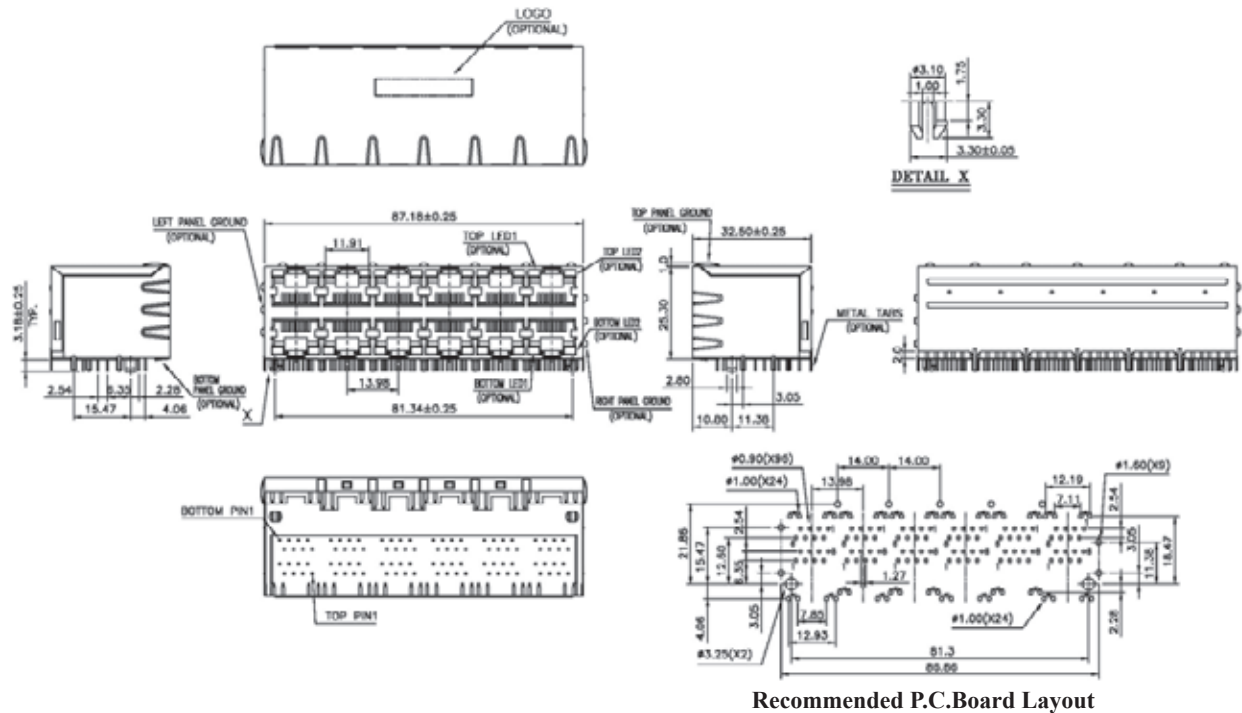
SIDE ENTRY 12-PORT DOUBLE LEVEL MODULAR PCB JACK 8P WITH LED PROFILE=25.30MM (FULLY SHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Black
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
Shield: Brass plating Nickel Alloy
***RoHS & REACH compliant.**



Recommended P.C.Board Layout

ORDERING INFORMATION:

P/N M J $\frac{xx}{1}$ - 88 $\frac{xx}{2}$ B $\frac{xx}{3}$ $\frac{12}{4}$ $\frac{1}{5}$ $\frac{6}{6}$

- MODULAR JACK TYPE:
 "KA" WITH TOP/RIGHT/LEFT/BOTTOM SIDE TABS
 "KB" WITH TOP/RIGHT/LEFT SIDE TABS
 "KC" WITH RIGHT/LEFT TABS
 "KD" WITH TOP/BOTTOM SIDE TABS
 "KE" WITHOUT GROUNDING TABS
- NO. OF POSITIONS & CONTACTS:
 "88" 8P8C
- CONTACT FINISH:
 "A" 6 MICROINCH GOLD
 "B" 15 MICROINCH GOLD
 "C" 30 MICROINCH GOLD
 "D" 50 MICROINCH GOLD

- HOUSING COLOR:
 "B" BLACK
- COLORS OF LED:
 "NN" LED1/2 = GREEN/GREEN
 "NY" LED1/2 = GREEN/YELLOW
 "YN" LED1/2 = YELLOW/GREEN
 "YY" LED1/2 = YELLOW/YELLOW
 "XX" WITHOUT LED
- NO. OF PORTS:
 12

NOTE: OTHER LED COLORS UPON REQUEST!

SIDE ENTRY 2-PORT DOUBLE LEVEL MODULAR PCB JACK 8P WITH LED PROFILE=25.40MM (FULLY SHIELDED)

SPECIFICATIONS

Insulation Resistance: 500 Megohms Min

Contact Resistance: 20 Milliohms Max.

Current Rating: 1.5 A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C To +85°C.

Operating: 500 Cycles Min.

MATERIALS

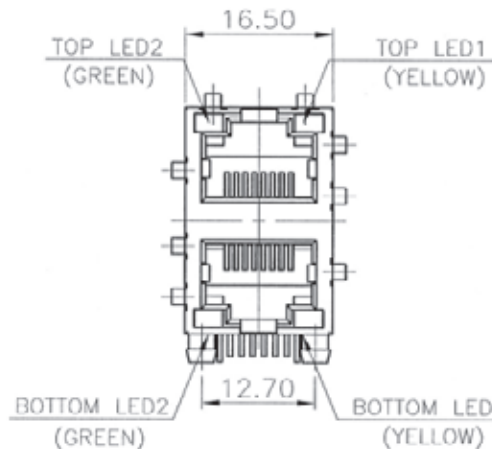
Plating Housing: Engineering Thermoplastic

Flammability Rating UL 94V-0.

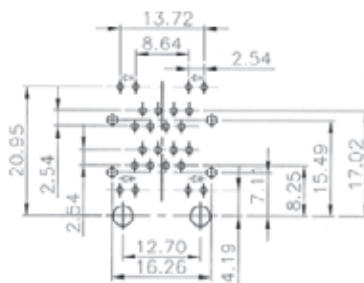
Contacts: Phosphor Bronze

Plating: Brass Plating Nickel Alloy.

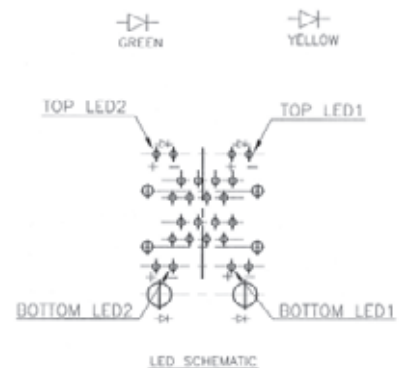
* RoHS & REACH compliant.



P/N MJA5-88xBYN02



**Recommended P.C. Board Layout
(TOP VIEW)**



ORDERING INFORMATION:

P/N MJA5-88xBxx02
1 2 3 4 5

- MODULAR JACK TYPE:
"A5" WITH TOP/RIGHT/LEFT SIDE TABS
- NO. OF POSITIONS & CONTACTS:
"88" 8P8C
- CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD

- COLORS OF LED:
"NN" LED1:GREEN & LED2:GREEN
"NY" LED1:GREEN & LED2:YELLOW
"YN" LED1:YELLOW & LED2:GREEN
"YY" LED1:YELLOW & LED2:YELLOW
"XX" W/O LED
- NO. OF PORTS:
02

NOTE: LED1= RIGHT LED &
LED2= LEFT LED

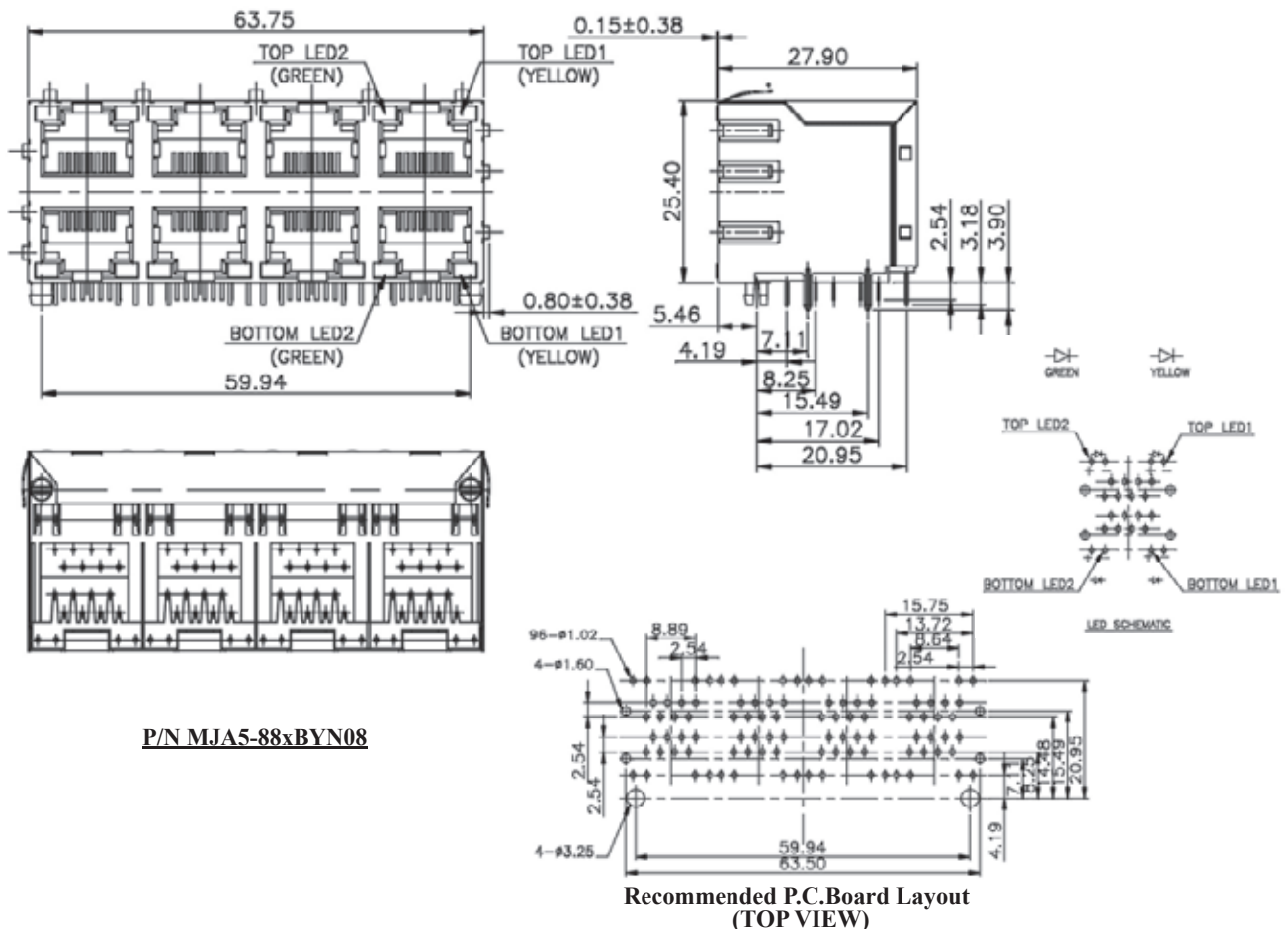
SIDE ENTRY 8-PORT DOUBLE LEVEL MODULAR PCB JACK 8P WITH LED PROFILE=25.40MM (FULLY SHIELDED)

SPECIFICATIONS

Insulation Resistance: 500 Megohms Min
Contact Resistance: 20 Milliohms Max.
Current Rating: 1.5 A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C To +85°C.
Operating: 500 Cycles Min.

MATERIALS

Plating Housing: Engineering Thermoplastic
 Flammability Rating UL 94V-0.
Contacts: Phosphor Bronze
Plating: Brass Plating Nickel Alloy.
 * RoHS & REACH compliant.



ORDERING INFORMATION:

P/N MJA5-88x B xx 08
1 2 3 4 5

- MODULAR JACK TYPE:
 "A5" WITH TOP/RIGHT/LEFT SIDE TABS
- NO. OF POSITIONS & CONTACTS:
 "88" 8P8C
- CONTACT FINISH:
 "A" 6 MICROINCH GOLD
 "B" 15 MICROINCH GOLD
 "C" 30 MICROINCH GOLD
 "D" 50 MICROINCH GOLD

- COLORS OF LED:
 "NN" LED1:GREEN & LED2:GREEN
 "NY" LED1:GREEN & LED2:YELLOW
 "YN" LED1:YELLOW & LED2:GREEN
 "YY" LED1:YELLOW & LED2:YELLOW
 "XX" W/O LED
- NO. OF PORTS:
 08

NOTE: LED1= RIGHT LED &
 LED2= LEFT LED

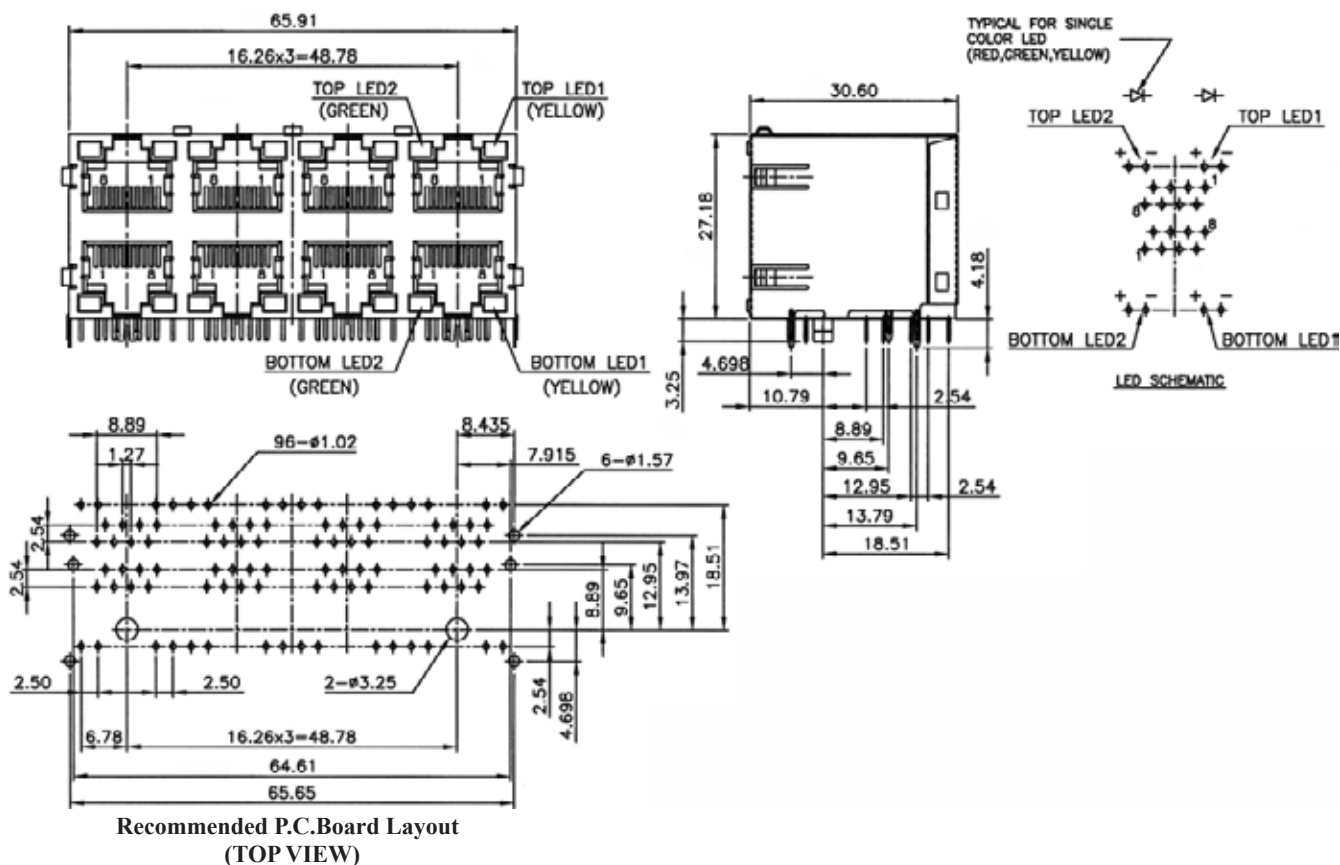
SIDE ENTRY 8-PORT DOUBLE LEVEL MODULAR PCB JACK WITH LED 8P PROFILE=27.18MM (FULLY SHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Black
Spring Wire: Phosphor Bronze
Gold plating Over Nickel
Shield: Brass plating Nickel Alloy
*RoHS & REACH compliant.



ORDERING INFORMATION:

P/N M J A 3 - $\frac{8}{1} \frac{8}{2} \times \frac{B}{3} \times \frac{0}{4} \frac{8}{5}$

1. NO. OF POSITIONS & CONTACTS:
"88" 8P8C
2. CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD
3. CODE OF LED1 DESIGNATION:
N, M, Y, Z, 8, Q, 1, 2, 5, 6
4. CODE OF LED2 DESIGNATION:
N, M, Y, Z, 8, Q, 1, 2, 5, 6
5. NO. OF PORTS:
08

LED Designation:

Code	+/-	-/+	Code	+/-	-/+
N	Green	—	M	—	Green
Y	Yellow	—	Z	—	Yellow
8	Orange	—	Q	—	Orange
1	Green	Orange	2	Orange	Green
5	Green	Yellow	6	Yellow	Green

NOTE: LED1= RIGHT LED &
LED2= LEFT LED

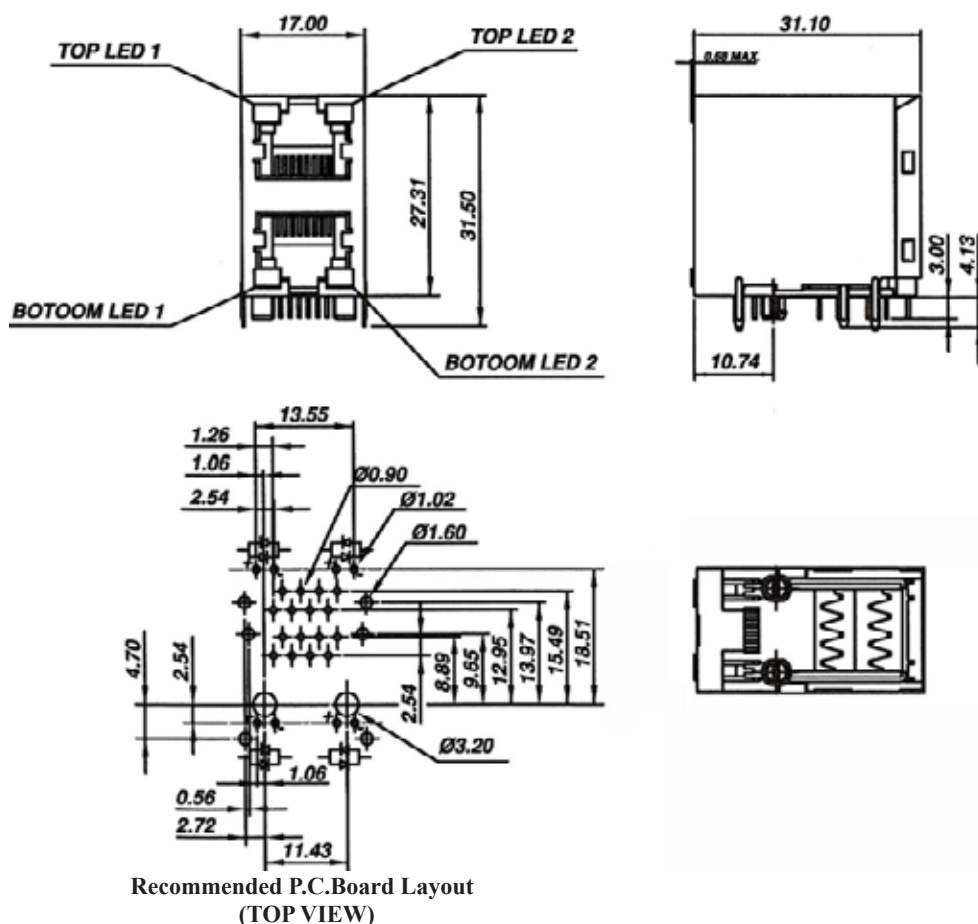
SIDE ENTRY 2-PORT DOUBLE LEVEL MODULAR PCB JACK WITH LED 8P PROFILE=27.31MM (FULLY SHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Black
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
Shield: Brass plating Nickel Alloy
 *RoHS & REACH compliant.



ORDERING INFORMATION:

P/N M J D C - $\frac{88}{1} \times \frac{B}{2} \times \frac{02}{345}$

1. NO. OF POSITIONS & CONTACTS:

"88" 8P8C

2. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

3. CODE OF LED1 DESIGNATION:

N, M, Y, Z, 8, Q, 1, 2, 5, 6

4. CODE OF LED2 DESIGNATION:

N, M, Y, Z, 8, Q, 1, 2, 5, 6

5. NO. OF PORTS:

02

NOTE: P/N MJDCHT-88xBxx02 FOR HIGH TEMP. VERSION

LED Designation:

Code	+/-	-/+	Code	+/-	-/+
N	Green	—	M	—	Green
Y	Yellow	—	Z	—	Yellow
8	Orange	—	Q	—	Orange
1	Green	Orange	2	Orange	Green
5	Green	Yellow	6	Yellow	Green

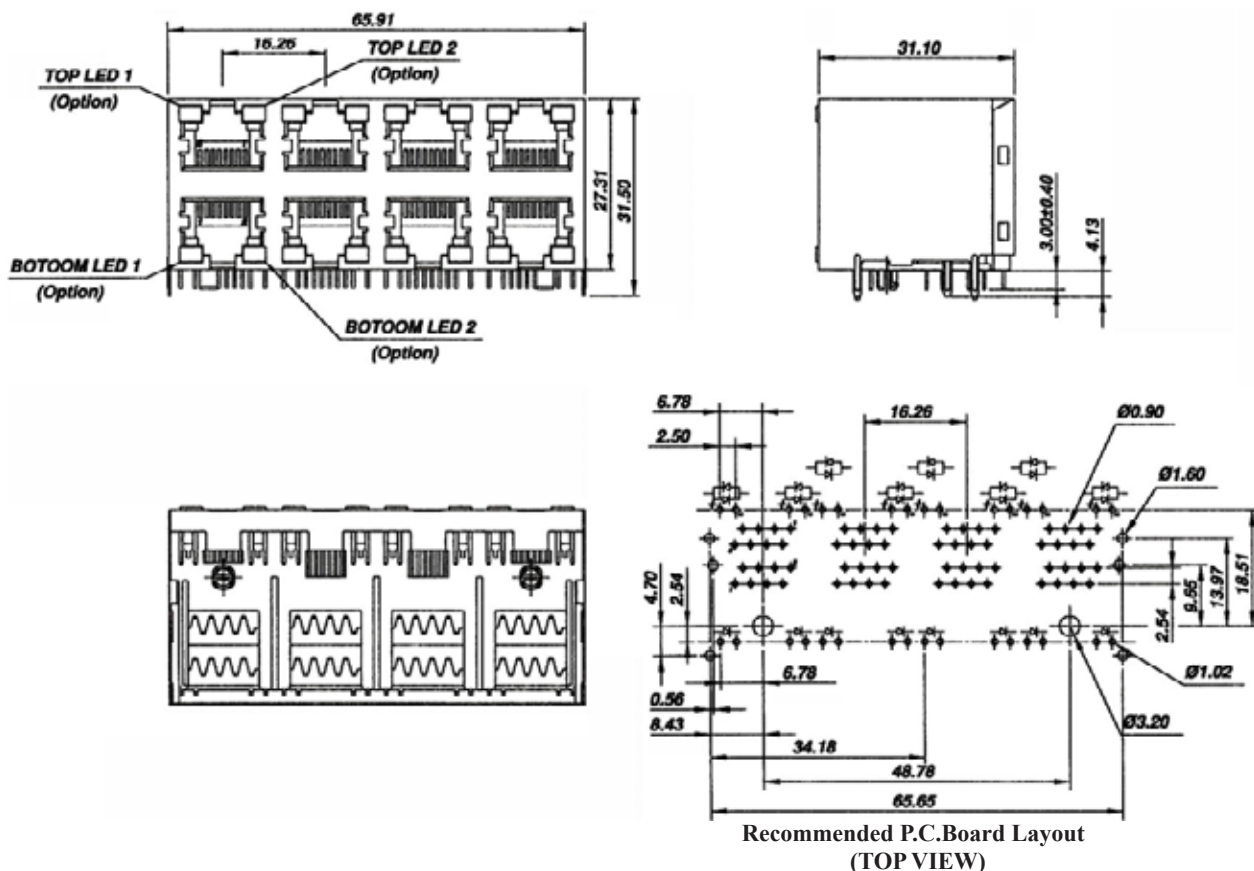
SIDE ENTRY 8-PORT DOUBLE LEVEL MODULAR PCB JACK WITH LED 8P PROFILE=27.31MM (FULLY SHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Black
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
Shield: Brass plating Nickel Alloy
***RoHS & REACH compliant.**



ORDERING INFORMATION:

P/N M J D C - $\frac{88}{1} \times \frac{B}{2} \times \frac{3}{4} \times \frac{08}{5}$

1. NO. OF POSITIONS & CONTACTS:
"88" 8P8C
2. CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD
3. CODE OF LED1 DESIGNATION:
N, M, Y, Z, 8, Q, 1, 2, 5, 6
4. CODE OF LED2 DESIGNATION:
N, M, Y, Z, 8, Q, 1, 2, 5, 6
5. NO. OF PORTS:
08

NOTE: P/N MJDCHT-88xBxx08 FOR HIGH TEMP. VERSION

LED Designation:

Code	+/-	-/+	Code	+/-	-/+
N	Green	—	M	—	Green
Y	Yellow	—	Z	—	Yellow
8	Orange	—	Q	—	Orange
1	Green	Orange	2	Orange	Green
5	Green	Yellow	6	Yellow	Green

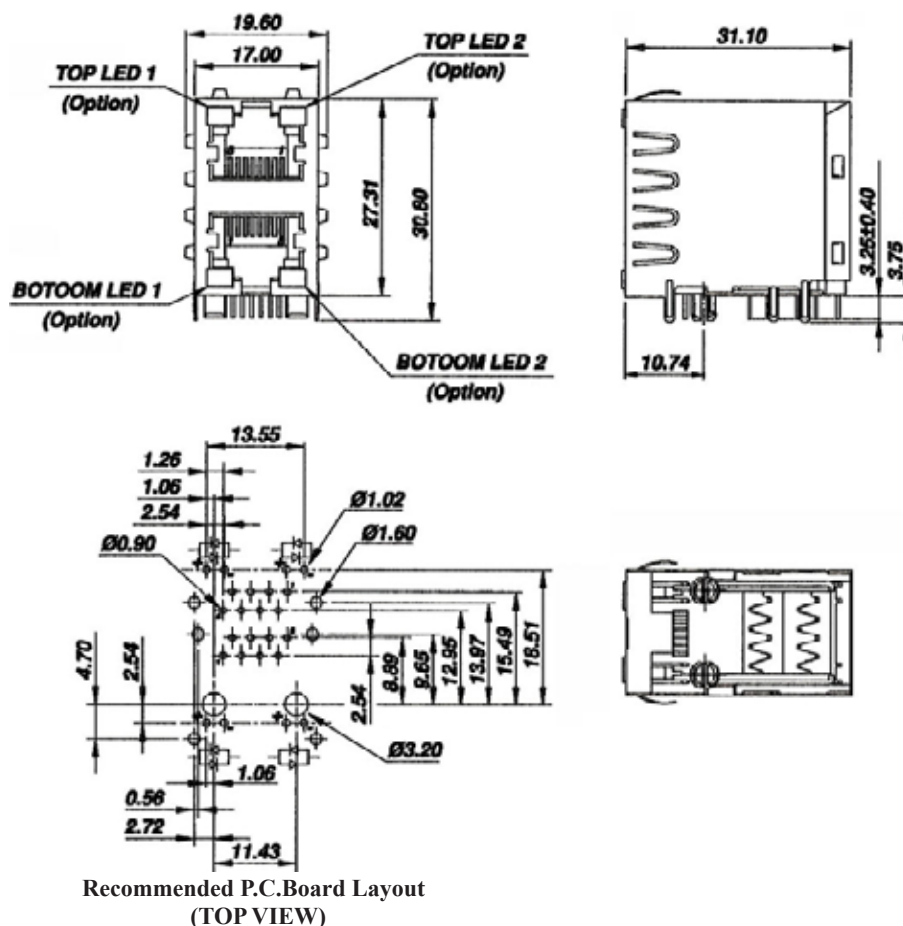
SIDE ENTRY 2-PORT DOUBLE LEVEL MODULAR PCB JACK WITH LED 8P PROFILE=27.31MM (FULLY SHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Black
Spring Wire: Phosphor Bronze
Gold plating Over Nickel
Shield: Brass plating Nickel Alloy
*RoHS & REACH compliant.



ORDERING INFORMATION:

P/N M J D D - $\frac{88}{1} \times \frac{B}{2} \times \frac{3}{4} \times \frac{02}{5}$

1. NO. OF POSITIONS & CONTACTS:

"88" 8P8C

2. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

3. CODE OF LED1 DESIGNATION:

N, M, Y, Z, 8, Q, 1, 2, 5, 6

4. CODE OF LED2 DESIGNATION:

N, M, Y, Z, 8, Q, 1, 2, 5, 6

5. NO. OF PORTS:

02

NOTE: P/N MJDDHT-88xBxx02 FOR HIGH TEMP. VERSION

LED Designation:

Code	+/-	-/+	Code	+/-	-/+
N	Green	—	M	—	Green
Y	Yellow	—	Z	—	Yellow
8	Orange	—	Q	—	Orange
1	Green	Orange	2	Orange	Green
5	Green	Yellow	6	Yellow	Green

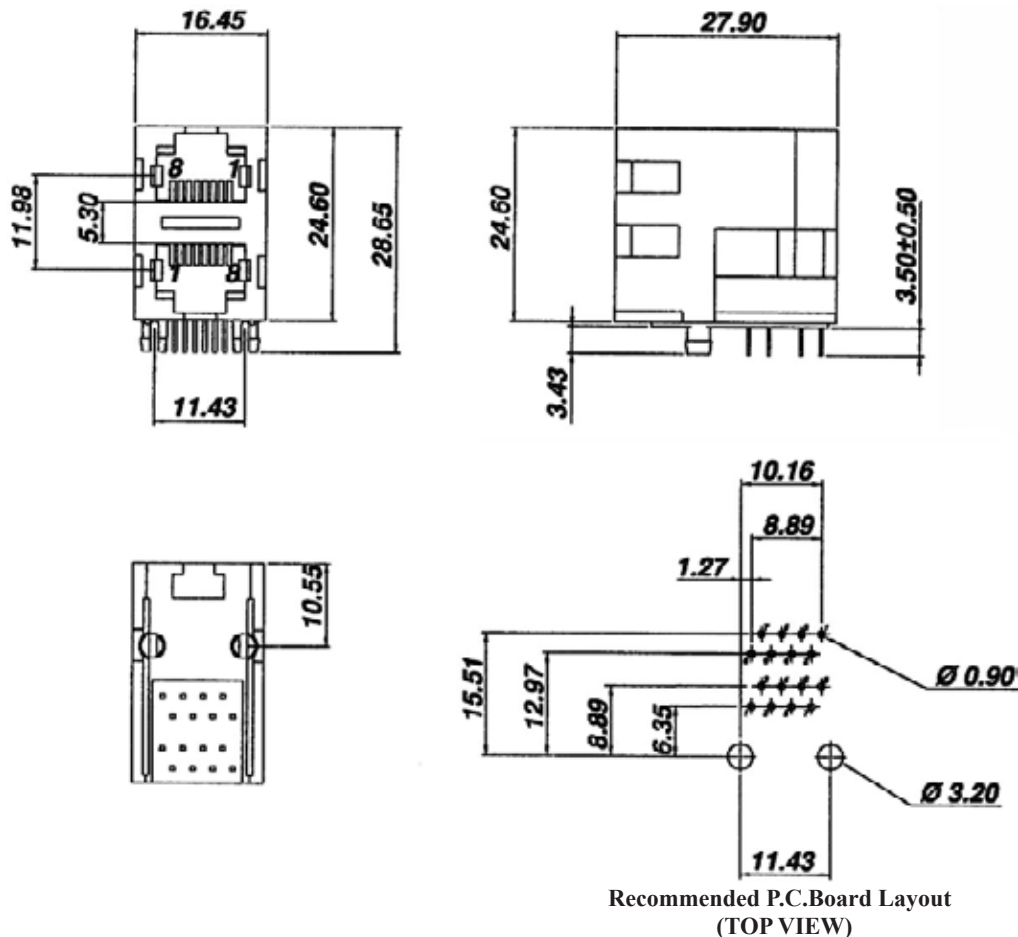
SIDE ENTRY 2-PORT DOUBLE LEVEL MODULAR PCB JACK 8P PROFILE=24.60MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Black
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
***RoHS & REACH compliant.**



ORDERING INFORMATION:

P/N M J D U - $\frac{88}{1} \times \frac{B}{2} \frac{02}{3}$

1. NO. OF POSITIONS & CONTACTS:
"88" 8P8C
2. CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD
3. NO. OF PORTS:
02

NOTE: P/N MJDUHT-88xB02 FOR HIGH TEMP. VERSION

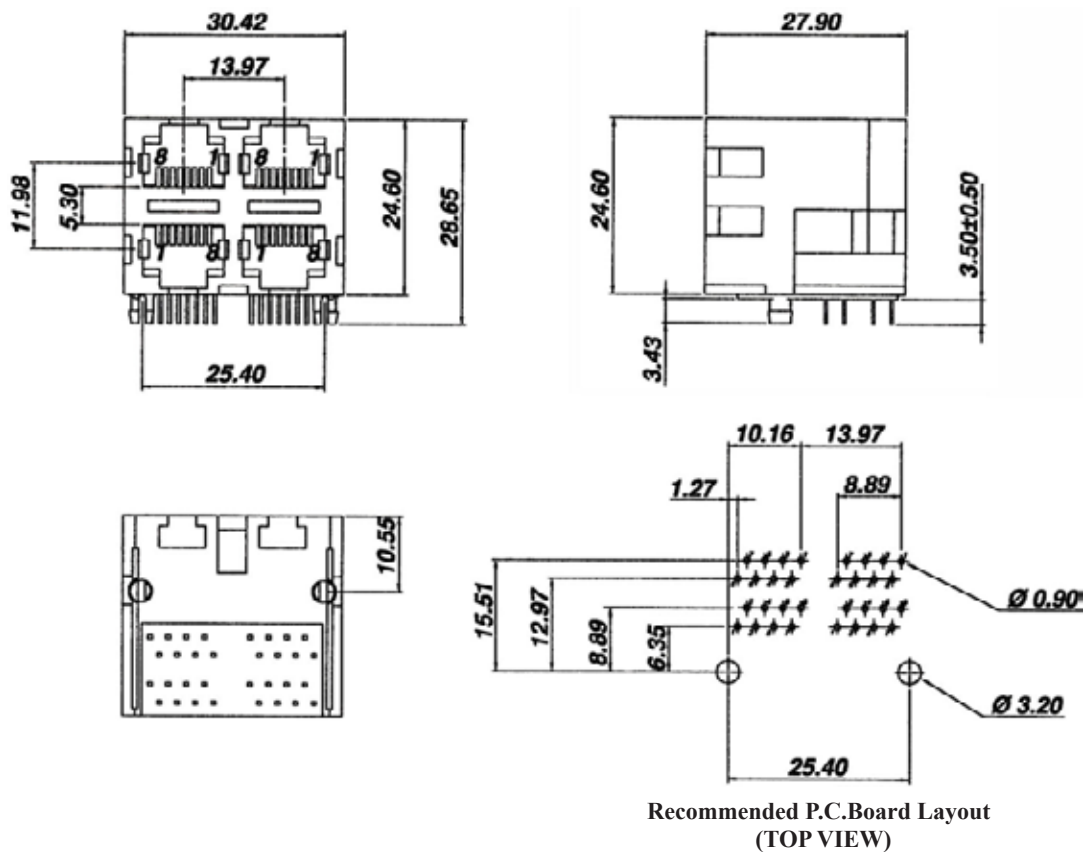
SIDE ENTRY 4-PORT DOUBLE LEVEL MODULAR PCB JACK 8P PROFILE=24.60MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Black
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
***RoHS & REACH compliant.**



ORDERING INFORMATION:

P/N M J D U - $\frac{88}{1} \times \frac{B}{2} \frac{04}{3}$

1. NO. OF POSITIONS & CONTACTS:
"88" 8P8C
2. CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD
3. NO. OF PORTS:
04

NOTE: P/N MJDUHT-88xB04 FOR HIGH TEMP. VERSION

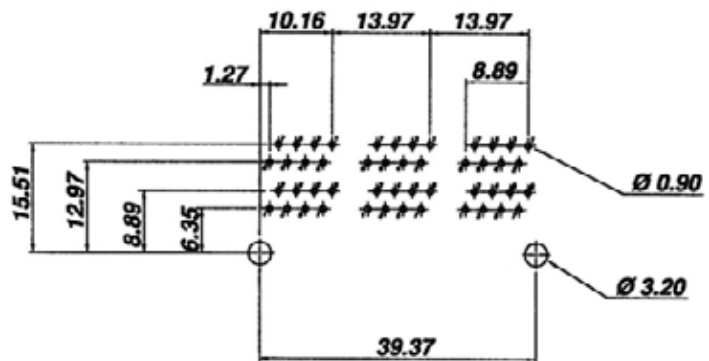
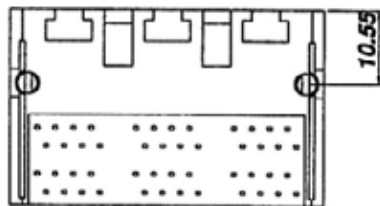
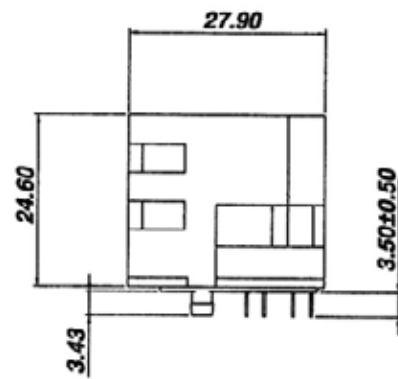
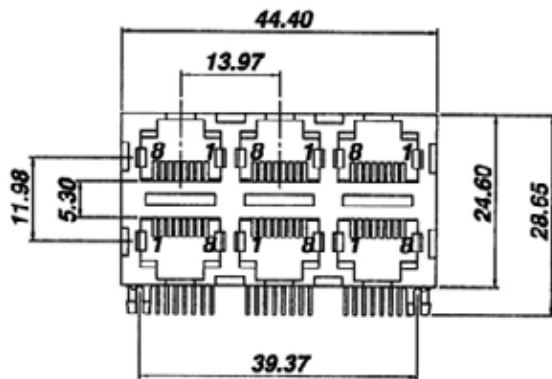
SIDE ENTRY 6-PORT DOUBLE LEVEL MODULAR PCB JACK 8P PROFILE=24.60MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Black
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
***RoHS & REACH compliant.**



Recommended P.C.Board Layout
(TOP VIEW)

ORDERING INFORMATION:

P/N M J D U - $\frac{88}{1} \times \frac{B}{2} \frac{06}{3}$

1. NO. OF POSITIONS & CONTACTS:
"88" 8P8C
2. CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD
3. NO. OF PORTS:
06

NOTE: P/N MJDUHT-88xB06 FOR HIGH TEMP. VERSION

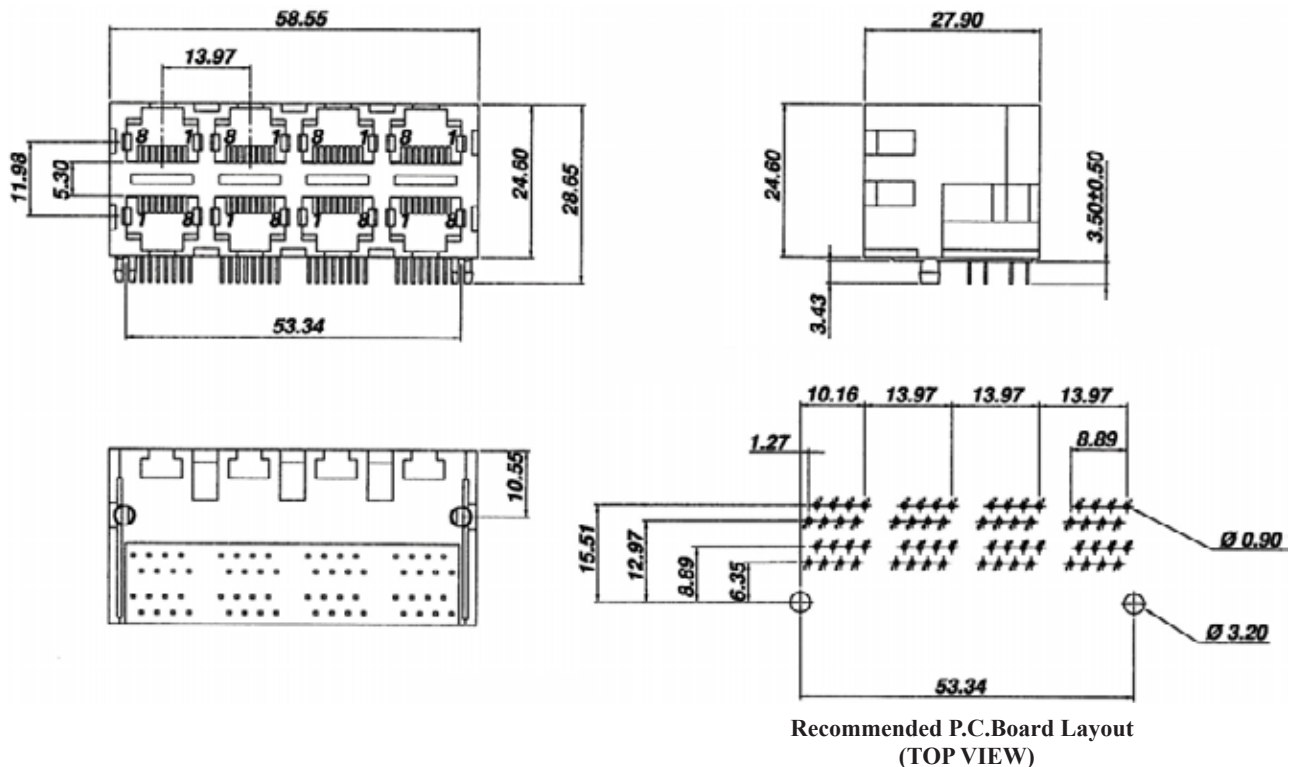
SIDE ENTRY 8-PORT DOUBLE LEVEL MODULAR PCB JACK 8P PROFILE=24.60MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Black
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
***RoHS & REACH compliant.**



ORDERING INFORMATION:

P/N M J D U - $\frac{88}{1} \times \frac{B}{2} \frac{08}{3}$

1. NO. OF POSITIONS & CONTACTS:
"88" 8P8C
2. CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD
3. NO. OF PORTS:
08

NOTE: P/N MJDUHT-88xB08 FOR HIGH TEMP. VERSION

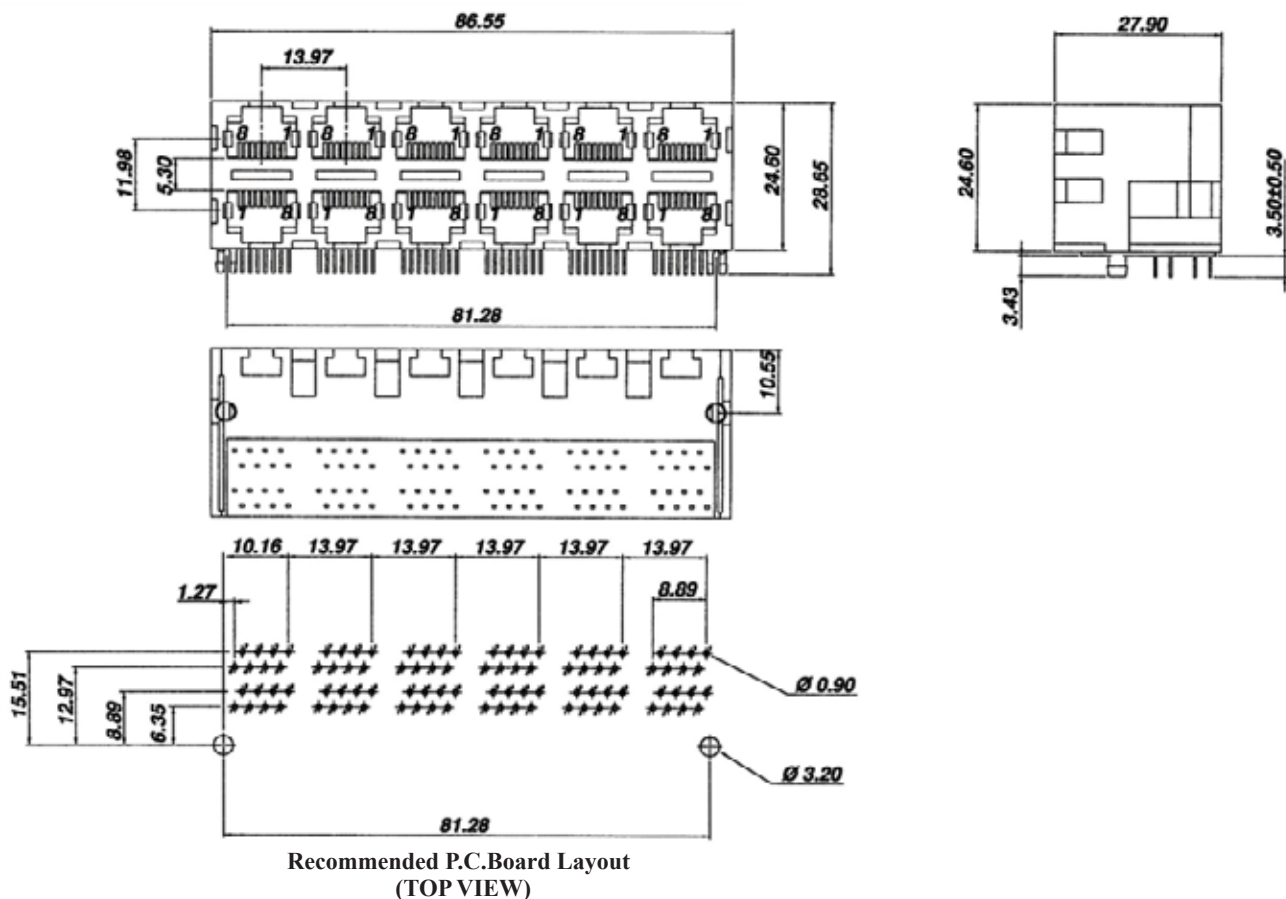
SIDE ENTRY 12-PORT DOUBLE LEVEL MODULAR PCB JACK 8P PROFILE=24.60MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Black
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
***RoHS & REACH compliant.**



ORDERING INFORMATION:

P/N M J D U - $\frac{88}{1} \times \frac{B}{2} \frac{12}{3}$

1. NO. OF POSITIONS & CONTACTS:
"88" 8P8C
2. CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD
3. NO. OF PORTS:
12

NOTE: P/N MJDUHT-88xB12 FOR HIGH TEMP. VERSION

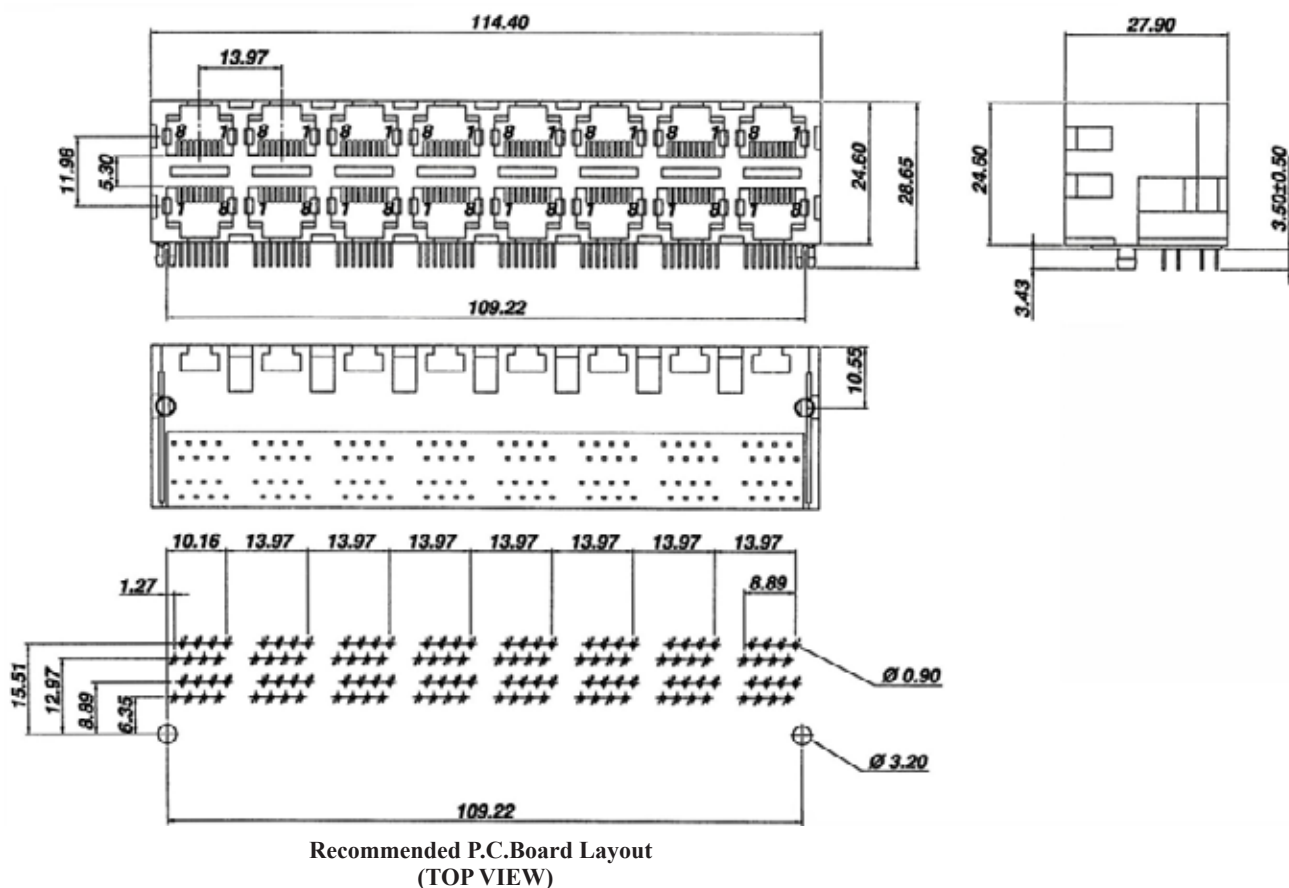
SIDE ENTRY 16-PORT DOUBLE LEVEL MODULAR PCB JACK 8P PROFILE=24.60MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Black
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
***RoHS & REACH compliant.**



ORDERING INFORMATION:

P/N M J D U - $\frac{88}{1} \times \frac{B}{2} \frac{16}{3}$

1. NO. OF POSITIONS & CONTACTS:
"88" 8P8C
2. CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD
3. NO. OF PORTS:
16

NOTE: P/N MJDUHT-88xB16 FOR HIGH TEMP. VERSION

SIDE ENTRY 2-PORT DOUBLE LEVEL MODULAR PCB JACK 6P PROFILE=24.84MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)

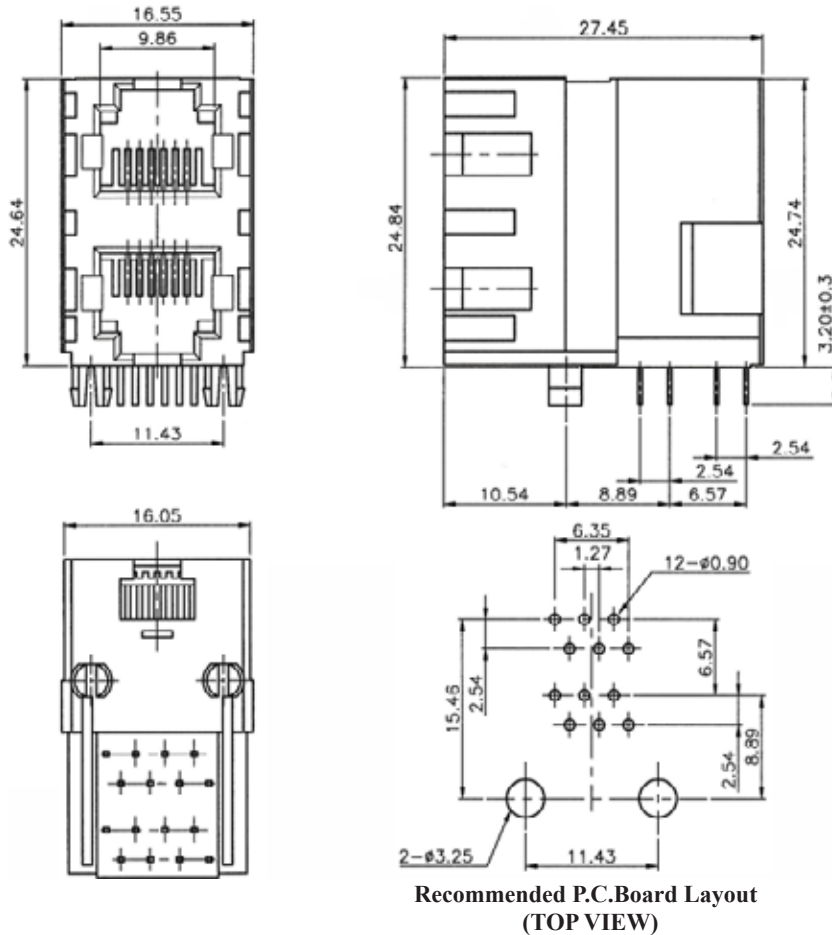
Soldering Temperature: 235°C

Color: Black

Spring Wire: Phosphor Bronze

Gold plating Over Nickel

*RoHS & REACH compliant.



ORDERING INFORMATION:

P/N M J 5 0 - $\frac{66}{1} \times \frac{B}{2} \frac{02}{3}$

1. NO. OF POSITIONS & CONTACTS:
"66" 6P6C
2. CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD
3. NO. OF PORTS:
02

SIDE ENTRY 4-PORT DOUBLE LEVEL MODULAR PCB JACK 6P PROFILE=24.84MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)

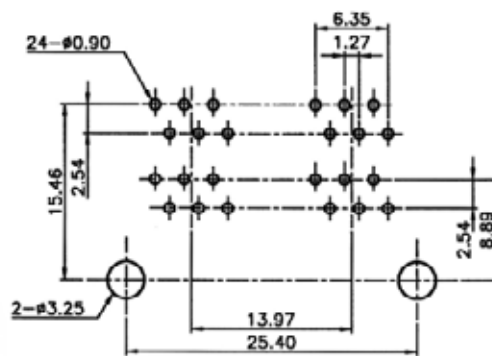
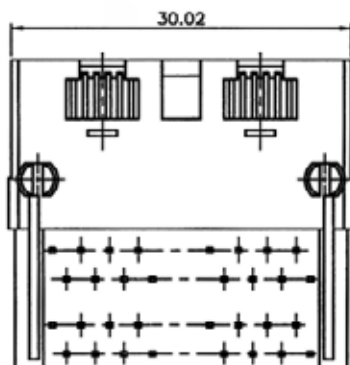
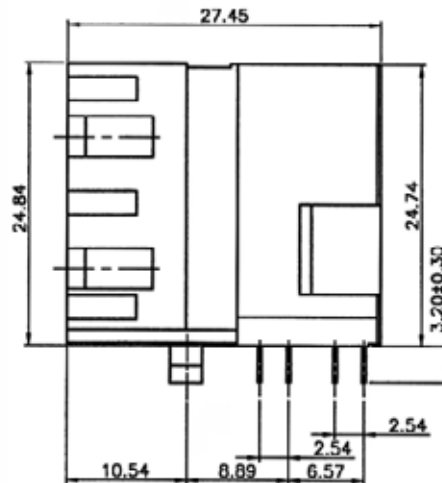
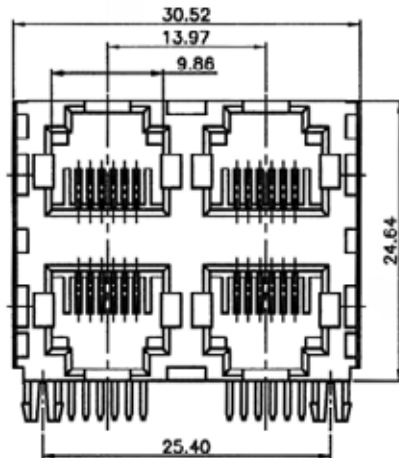
Soldering Temperature: 235°C

Color: Black

Spring Wire: Phosphor Bronze

Gold plating Over Nickel

*RoHS & REACH compliant.



Recommended P.C.Board Layout
(TOP VIEW)

ORDERING INFORMATION:

P/N M J 5 0 - $\frac{66}{1} \times \frac{B}{2} \frac{04}{3}$

1. NO. OF POSITIONS & CONTACTS:

"66" 6P6C

2. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

3. NO. OF PORTS:

04

SIDE ENTRY 6-PORT DOUBLE LEVEL MODULAR PCB JACK 6P PROFILE=24.84MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)

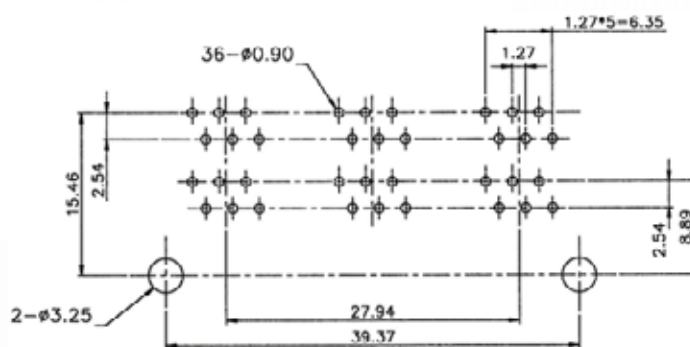
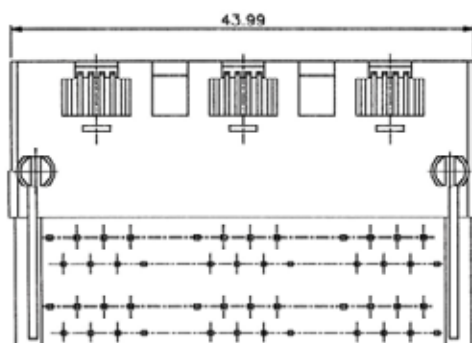
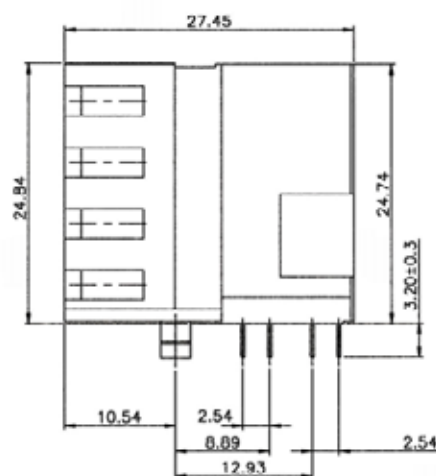
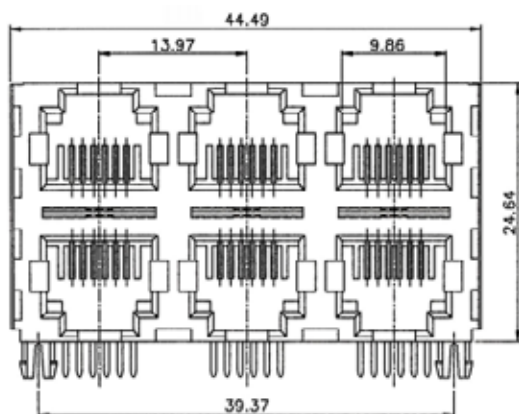
Soldering Temperature: 235°C

Color: Black

Spring Wire: Phosphor Bronze

Gold plating Over Nickel

*RoHS & REACH compliant.



Recommended P.C.Board Layout
(TOP VIEW)

ORDERING INFORMATION:

P/N MJ50 - $\frac{66}{1} \times \frac{B}{2} \frac{06}{3}$

1. NO. OF POSITIONS & CONTACTS:

"66" 6P6C

2. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

3. NO. OF PORTS:

06

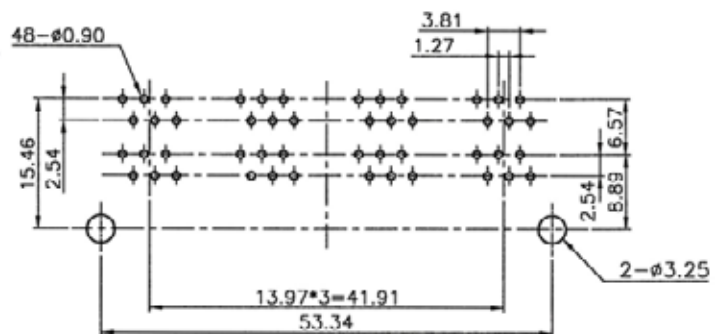
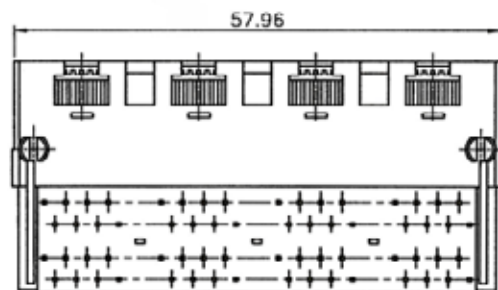
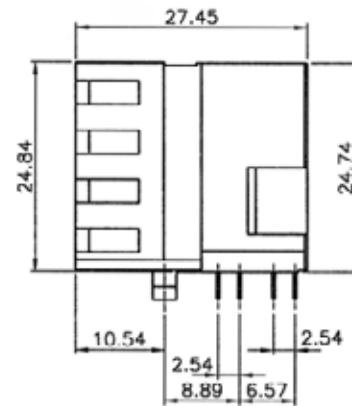
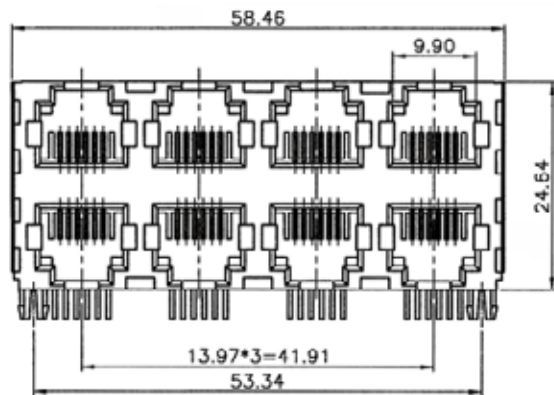
SIDE ENTRY 8-PORT DOUBLE LEVEL MODULAR PCB JACK 6P PROFILE=24.84MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Black
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
***RoHS & REACH compliant.**



Recommended P.C.Board Layout
(TOP VIEW)

ORDERING INFORMATION:

P/N M J 5 0 - $\frac{66}{1} \times \frac{B}{2} \frac{08}{3}$

1. NO. OF POSITIONS & CONTACTS:
"66" 6P6C
2. CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD
3. NO. OF PORTS:
08

SIDE ENTRY 10-PORT DOUBLE LEVEL MODULAR PCB JACK 6P PROFILE=24.84MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)

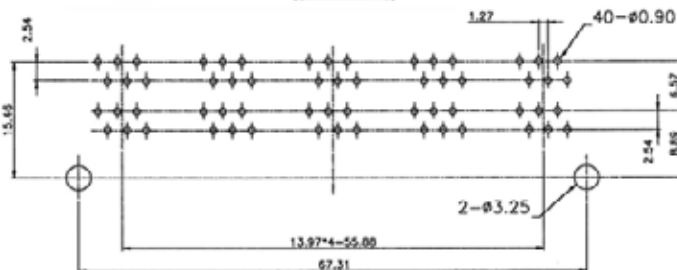
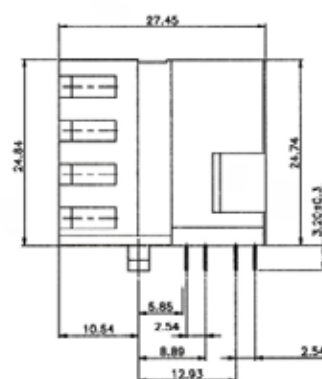
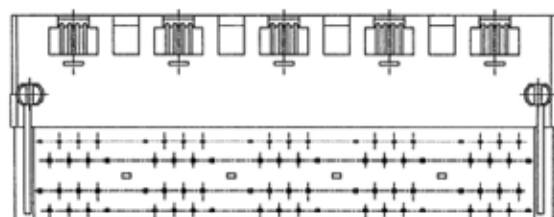
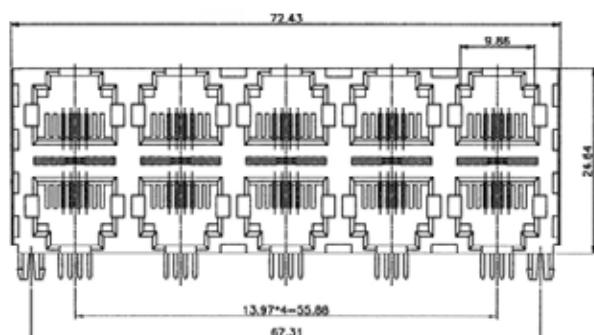
Soldering Temperature: 235°C

Color: Black

Spring Wire: Phosphor Bronze

Gold plating Over Nickel

*RoHS & REACH compliant.



Recommended P.C.Board Layout
(TOP VIEW)

ORDERING INFORMATION:

P/N M J 5 0 - $\frac{66}{1} \times \frac{B}{2} \frac{10}{3}$

1. NO. OF POSITIONS & CONTACTS:

"66" 6P6C

2. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

3. NO. OF PORTS:

10

SIDE ENTRY 2-PORT DOUBLE LEVEL MODULAR PCB JACK 8P PROFILE=24.84MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)

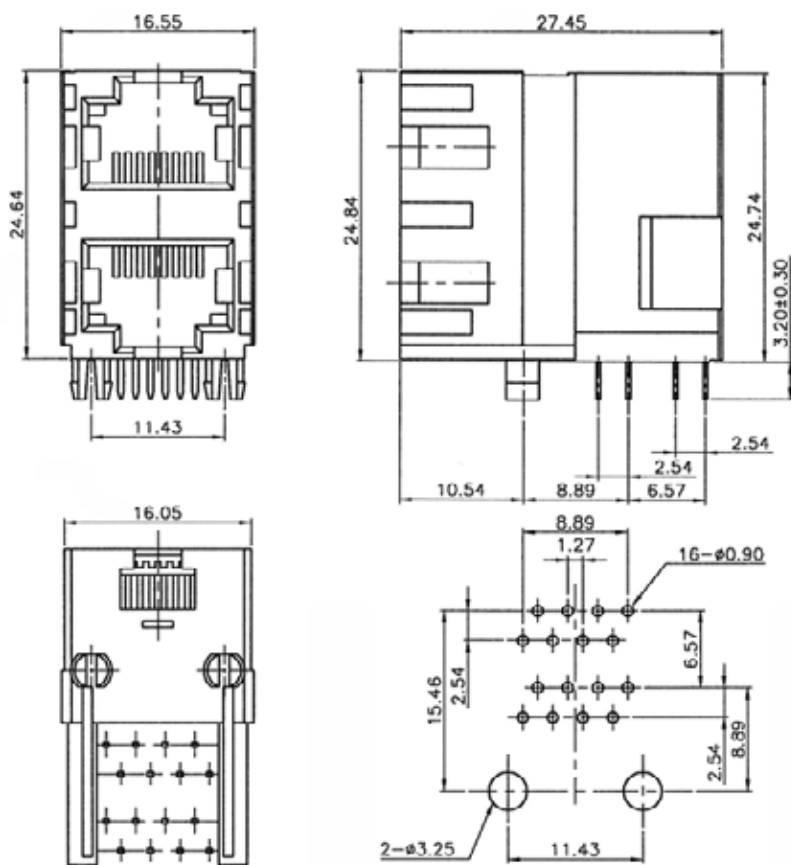
Soldering Temperature: 235°C

Color: Black

Spring Wire: Phosphor Bronze

Gold plating Over Nickel

*RoHS & REACH compliant.



Recommended P.C.Board Layout
(TOP VIEW)

ORDERING INFORMATION:

P/N M J $\frac{XX}{1} - \frac{XXX}{23} B \frac{02}{4}$

1. CATEGORY TYPE:

"50" CAT. 3

"74" CAT. 5

2. NO. OF POSITIONS & CONTACTS:

"88" 8P8C

3. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

4. NO. OF PORTS:

02

SIDE ENTRY 4-PORT DOUBLE LEVEL MODULAR PCB JACK 8P PROFILE=24.84MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)

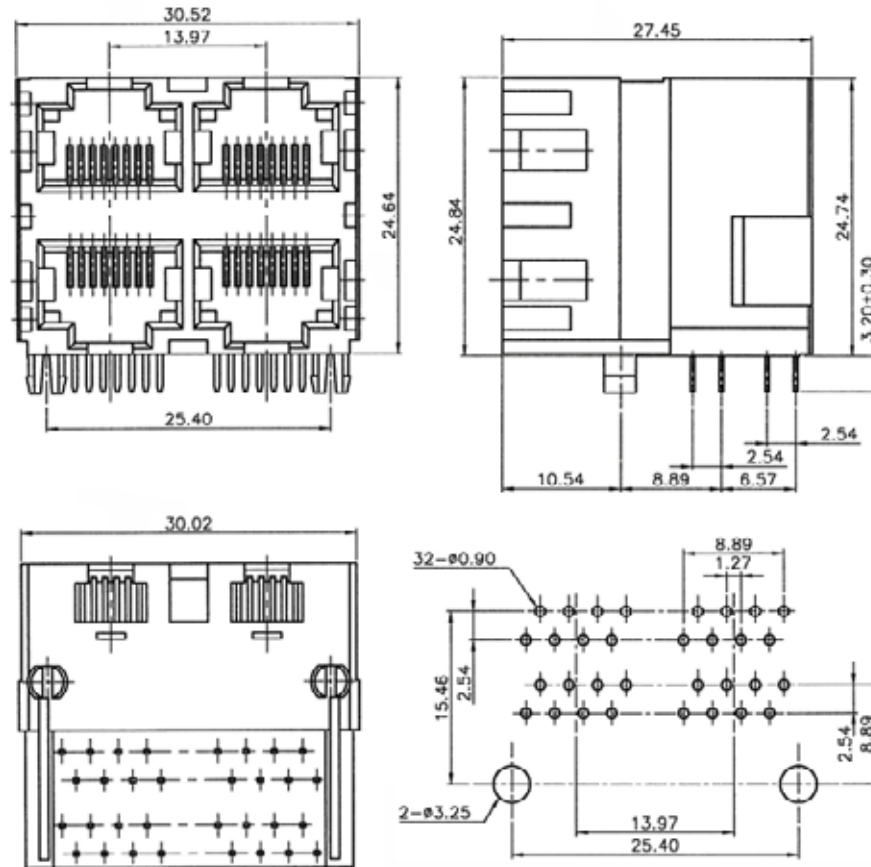
Soldering Temperature: 235°C

Color: Black

Spring Wire: Phosphor Bronze

Gold plating Over Nickel

*RoHS & REACH compliant.



Recommended P.C.Board Layout
(TOP VIEW)

ORDERING INFORMATION:

P/N M J $\frac{XX}{1} - \frac{XXX}{23} B \frac{04}{4}$

1. CATEGORY TYPE:

"50" CAT. 3

"74" CAT. 5

2. NO. OF POSITIONS & CONTACTS:

"88" 8P8C

3. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

4. NO. OF PORTS:

04

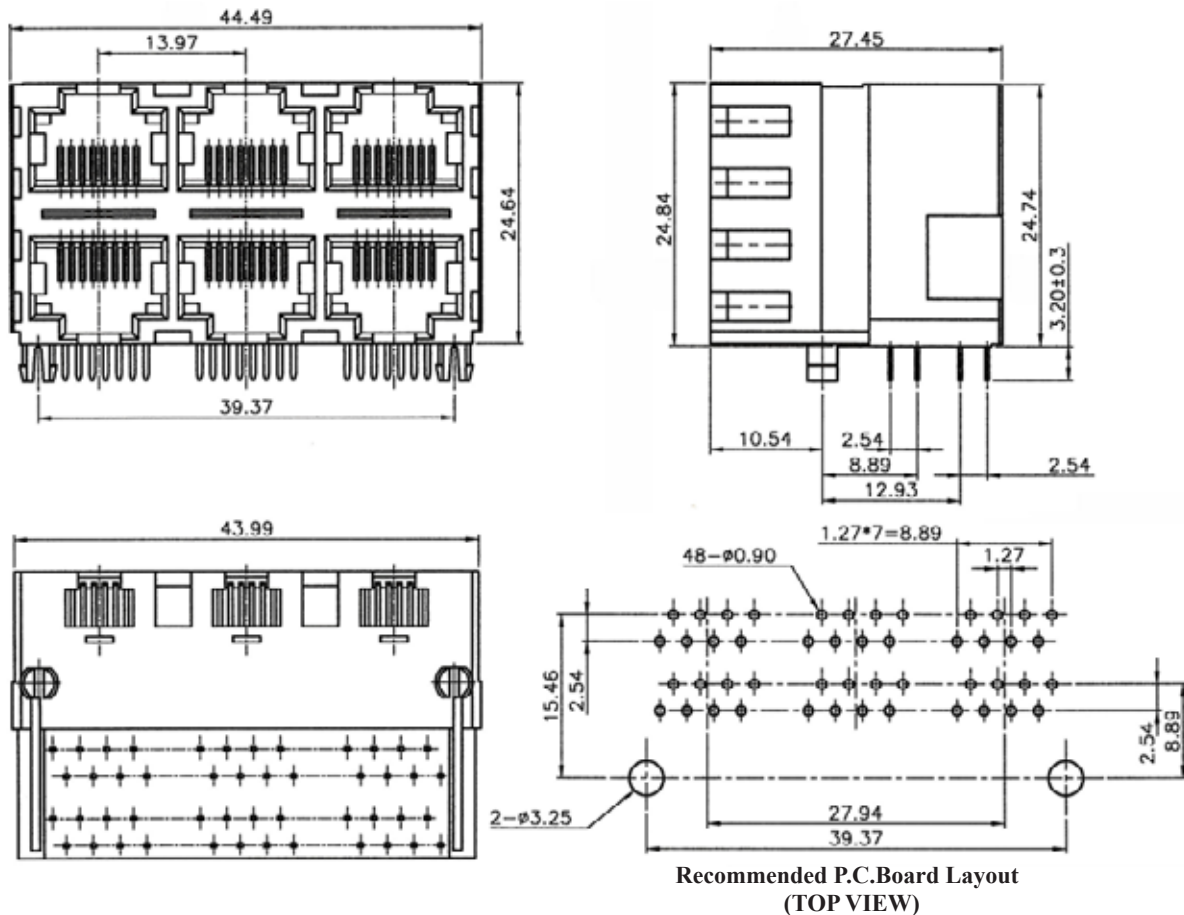
SIDE ENTRY 6-PORT DOUBLE LEVEL MODULAR PCB JACK 8P PROFILE=24.84MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Black
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
***RoHS & REACH compliant.**



ORDERING INFORMATION:

P/N M J $\frac{xx}{1}$ - $\frac{xxx}{23}$ B $\frac{06}{4}$

- CATEGORY TYPE:
 "50" CAT. 3
 "74" CAT. 5
- NO. OF POSITIONS & CONTACTS:
 "88" 8P8C
- CONTACT FINISH:
 "A" 6 MICROINCH GOLD
 "B" 15 MICROINCH GOLD
 "C" 30 MICROINCH GOLD
 "D" 50 MICROINCH GOLD
- NO. OF PORTS:
 06

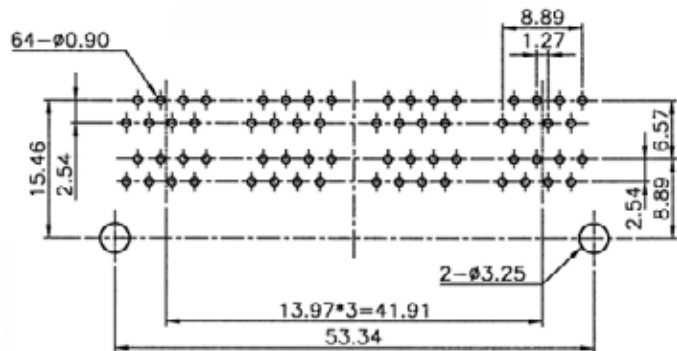
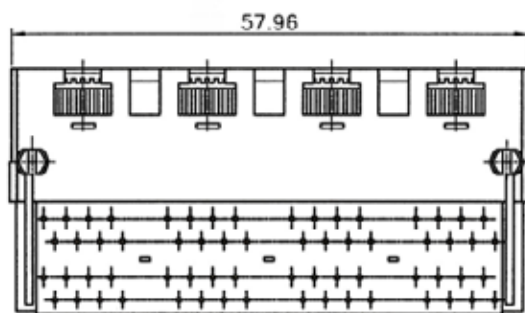
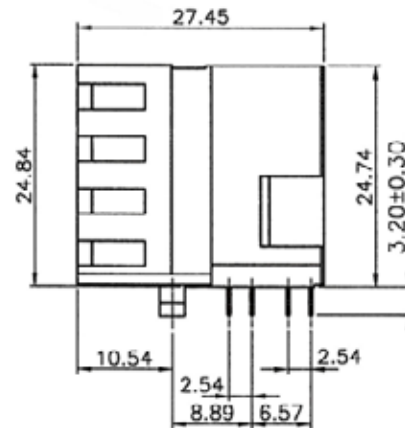
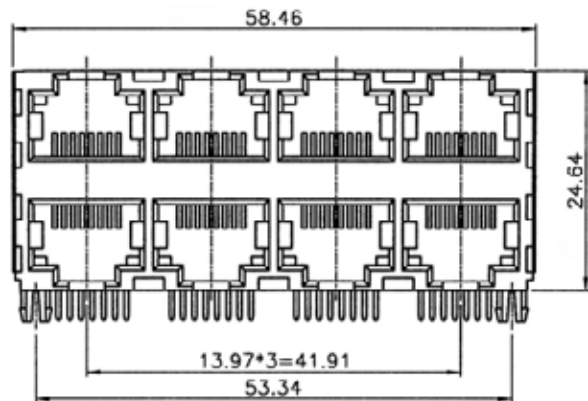
SIDE ENTRY 8-PORT DOUBLE LEVEL MODULAR PCB JACK 8P PROFILE=24.84MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Black
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
***RoHS & REACH compliant.**



Recommended P.C.Board Layout
(TOP VIEW)

ORDERING INFORMATION:

P/N M J $\frac{xx}{1} - \frac{xxx}{23} B \frac{08}{4}$

- CATEGORY TYPE:
"50" CAT. 3
"74" CAT. 5
- NO. OF POSITIONS & CONTACTS:
"88" 8P8C
- CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD
- NO. OF PORTS:
08

SIDE ENTRY 10-PORT DOUBLE LEVEL MODULAR PCB JACK 8P PROFILE=24.84MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)

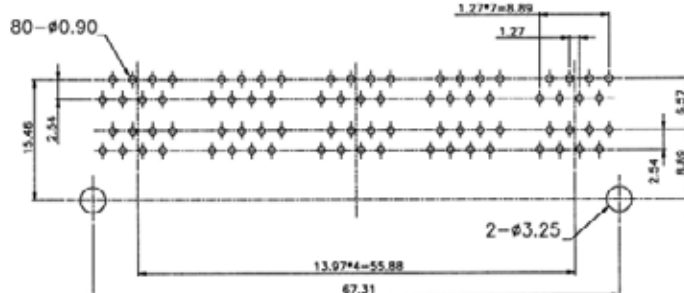
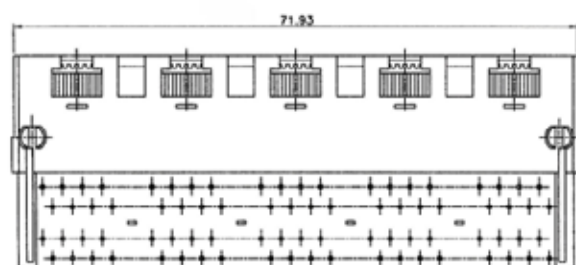
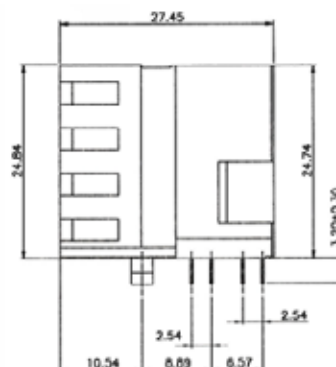
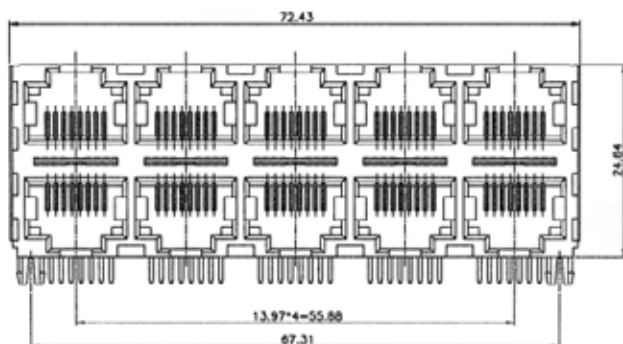
Soldering Temperature: 235°C

Color: Black

Spring Wire: Phosphor Bronze

Gold plating Over Nickel

*RoHS & REACH compliant.



Recommended P.C.Board Layout
(TOP VIEW)

ORDERING INFORMATION:

P/N M J $\frac{xx}{1} - \frac{xxx}{2} \frac{x}{3} B \frac{10}{4}$

1. CATEGORY TYPE:

"50" CAT. 3

"74" CAT. 5

2. NO. OF POSITIONS & CONTACTS:

"88" 8P8C

3. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

4. NO. OF PORTS:

10

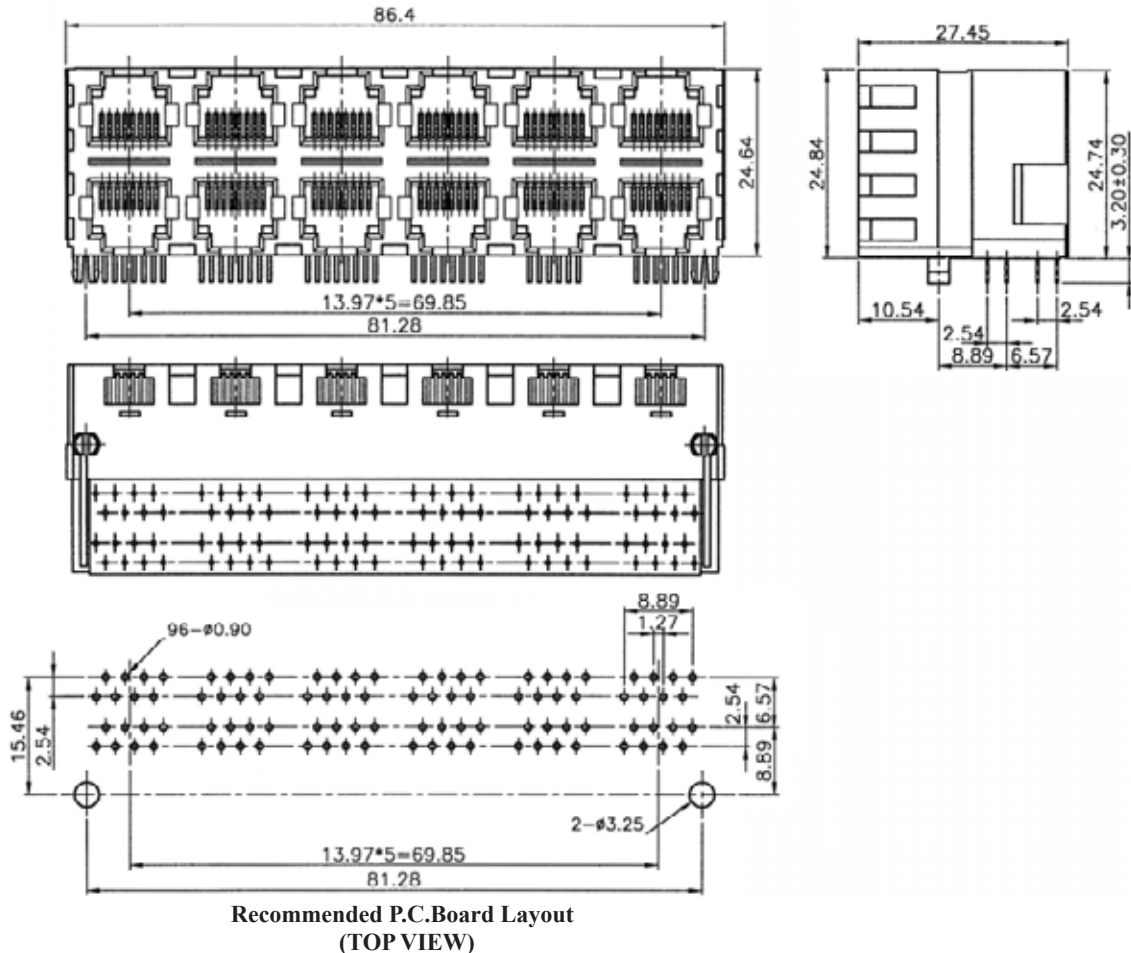
SIDE ENTRY 12-PORT DOUBLE LEVEL MODULAR PCB JACK 8P PROFILE=24.84MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Black
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
***RoHS & REACH compliant.**



ORDERING INFORMATION:

P/N M J $\frac{xx}{1}$ - $\frac{xxx}{23}$ B $\frac{12}{4}$

1. CATEGORY TYPE:
 "50" CAT. 3
 "74" CAT. 5
2. NO. OF POSITIONS & CONTACTS:
 "88" 8P8C
3. CONTACT FINISH:
 "A" 6 MICROINCH GOLD
 "B" 15 MICROINCH GOLD
 "C" 30 MICROINCH GOLD
 "D" 50 MICROINCH GOLD
4. NO. OF PORTS:
 12

SIDE ENTRY 16-PORT DOUBLE LEVEL MODULAR PCB JACK 8P PROFILE=24.84MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)

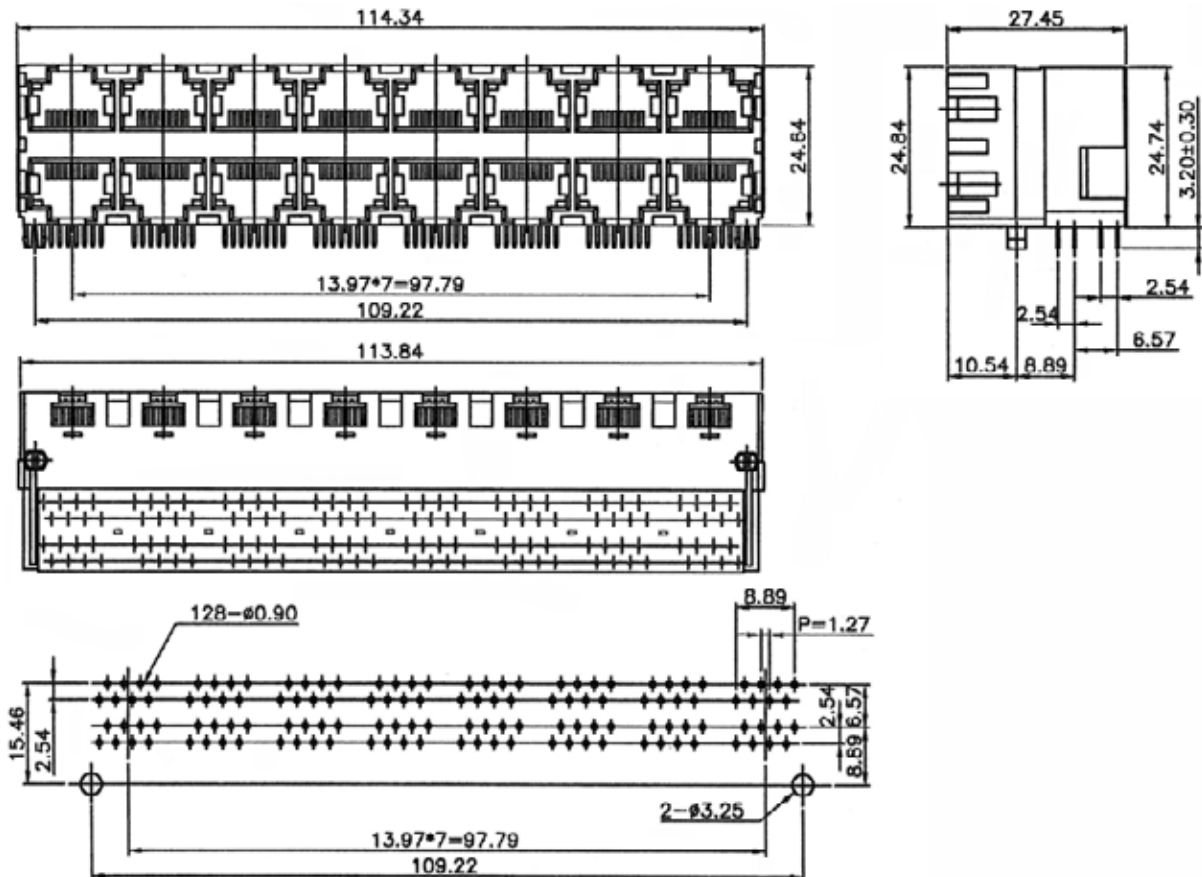
Soldering Temperature: 235°C

Color: Black

Spring Wire: Phosphor Bronze

Gold plating Over Nickel

*RoHS & REACH compliant.



Recommended P.C.Board Layout
(TOP VIEW)

ORDERING INFORMATION:

P/N M J $\frac{xx}{1} - \frac{xxx}{23} B \frac{16}{4}$

1. CATEGORY TYPE:

"50" CAT. 3

"74" CAT. 5

2. NO. OF POSITIONS & CONTACTS:

"88" 8P8C

3. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

4. NO. OF PORTS:

16

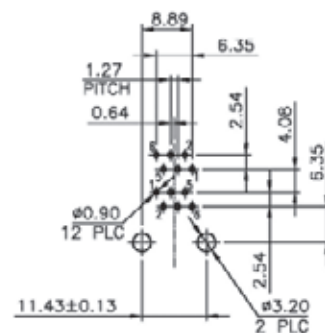
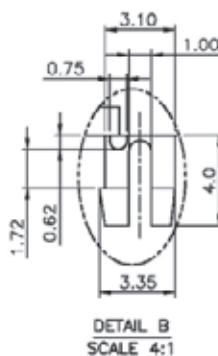
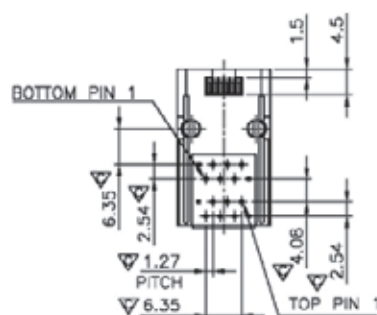
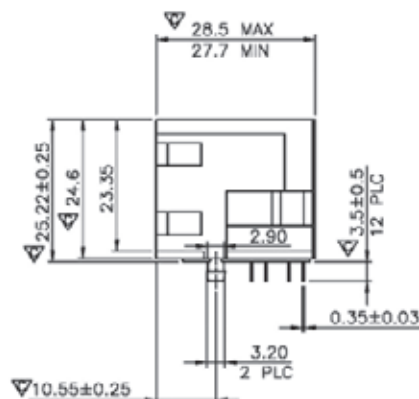
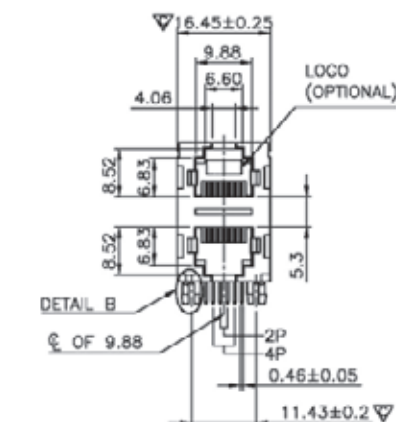
SIDE ENTRY 2-PORT DOUBLE LEVEL MODULAR PCB JACK 6P PROFILE=25.22MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Black
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
***RoHS & REACH compliant.**



Recommended P.C.Board Layout
Recommended PCB Thickness: 1.6mm
(TOP VIEW)

ORDERING INFORMATION:

P/N M J J P - 6 6 x B 0 2
1 2 3 4 5

- MODULAR JACK TYPE:
"JP" UNSHIELDED DOUBLE LEVEL TYPE
- NO. OF POSITIONS & CONTACTS:
"64" 6P4C
"66" 6P6C
- CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD
- HOUSING COLOR:
"B" BLACK
- NO. OF PORTS:
02

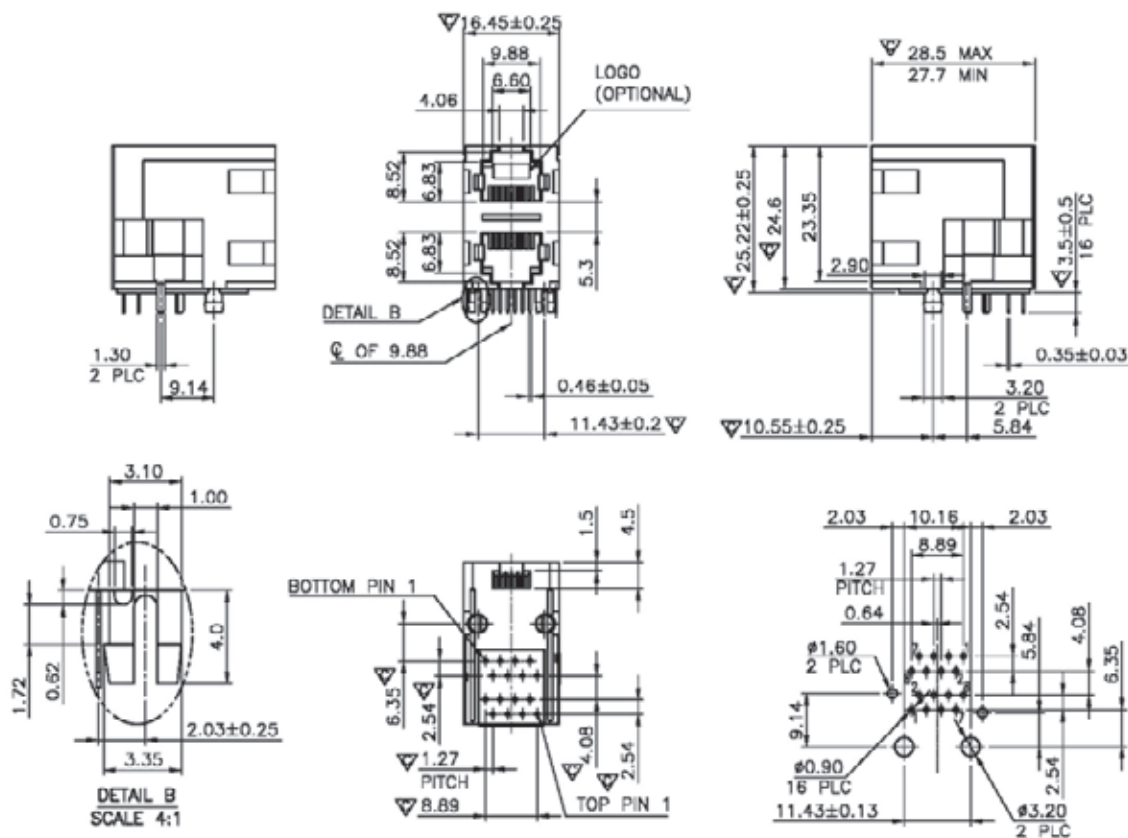
SIDE ENTRY 2-PORT DOUBLE LEVEL MODULAR PCB JACK 8P PROFILE=25.22MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Black
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
***RoHS & REACH compliant.**



Recommended P.C.Board Layout
 Recommended PCB Thickness: 1.6mm
 (TOP VIEW)

ORDERING INFORMATION:

P/N M J J P - 88 x B 02
1 2 3 4 5

- MODULAR JACK TYPE:
"JP" UNSHIELDED DOUBLE LEVEL TYPE
- NO. OF POSITIONS & CONTACTS:
"88" 8P8C
- CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD
- HOUSING COLOR:
"B" BLACK
- NO. OF PORTS:
02

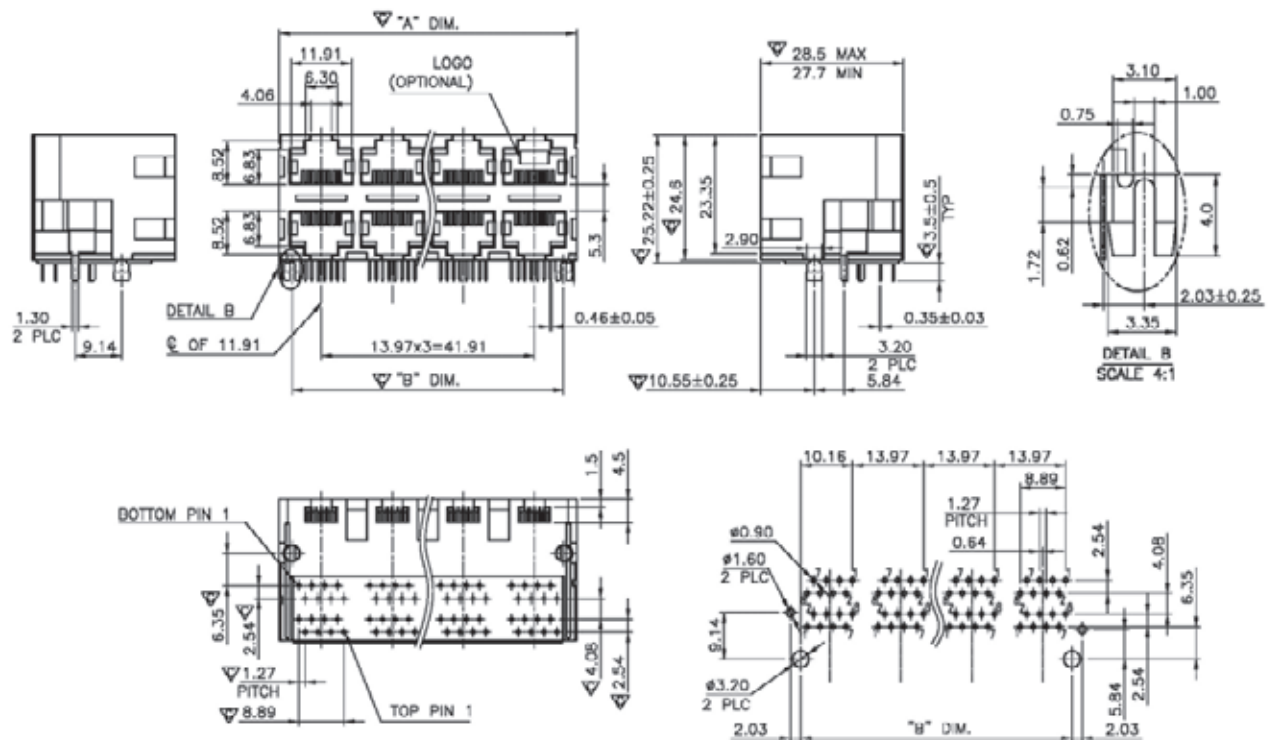
SIDE ENTRY 8-PORT DOUBLE LEVEL MODULAR PCB JACK 8P PROFILE=25.22MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Black
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
***RoHS & REACH compliant.**



Recommended P.C.Board Layout
Recommended PCB Thickness: 1.6mm
(TOP VIEW)

ORDERING INFORMATION:

P/N M J J P - 88 x B 08
1 2 3 4 5

- MODULAR JACK TYPE:
"JP" UNSHIELDED DOUBLE LEVEL TYPE
- NO. OF POSITIONS & CONTACTS:
"88" 8P8C
- CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD
- HOUSING COLOR:
"B" BLACK
- NO. OF PORTS:
08

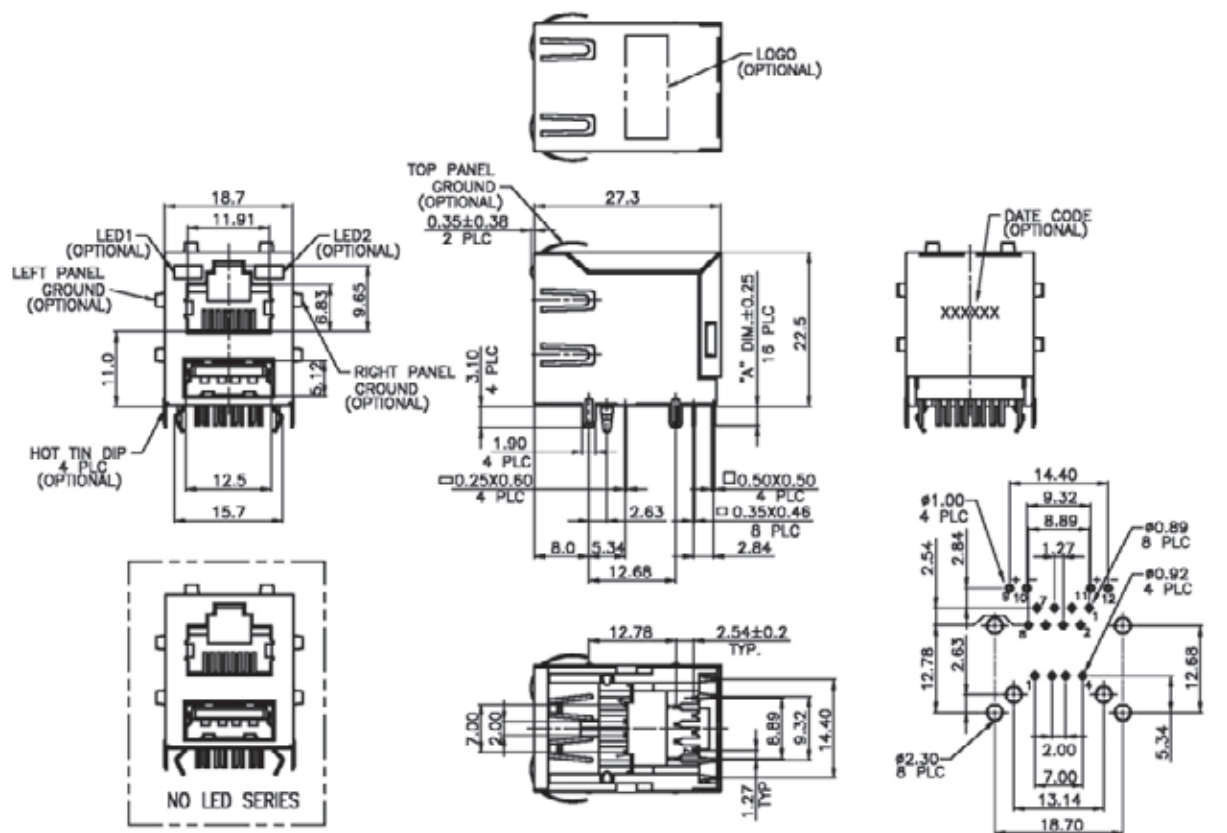
SIDE ENTRY MODULAR PCB JACK 8P+USB WITH LED PROFILE=22.50MM (FULLY SHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Black
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
Shield: Brass plating Nickel Alloy
***RoHS & REACH compliant.**



Recommended P.C.Board Layout

ORDERING INFORMATION:

P/N M J $\frac{xx}{1}$ - 8 U $\frac{x}{2}$ B $\frac{xx}{3}$ $\frac{xx}{4}$ $\frac{xx}{5}$

- MODULAR JACK TYPE:
 "BW" WITH TOP/RIGHT/LEFT SIDE TABS
 "BX" WITH RIGHT/LEFT TABS
 "BY" WITH TOP/BOTTOM SIDE TABS
 "BZ" WITHOUT GROUNDING TABS
- NO. OF POSITIONS & CONTACTS:
 "8U" 8P8C JACK & USB A TYPE FEMALE
- CONTACT FINISH:
 "A" 6 MICROINCH GOLD
 "B" 15 MICROINCH GOLD
 "C" 30 MICROINCH GOLD
 "D" 50 MICROINCH GOLD
- HOUSING COLOR:
 "B" BLACK

- LED COLORS:
 "NN" LED1/2 = GREEN/GREEN
 "NY" LED1/2 = GREEN/YELLOW
 "YN" LED1/2 = YELLOW/GREEN
 "YY" LED1/2 = YELLOW/YELLOW
 "XX" WITHOUT LED

NOTE: OTHER LED COLORS UPON REQUEST!

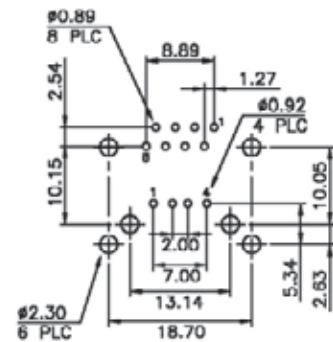
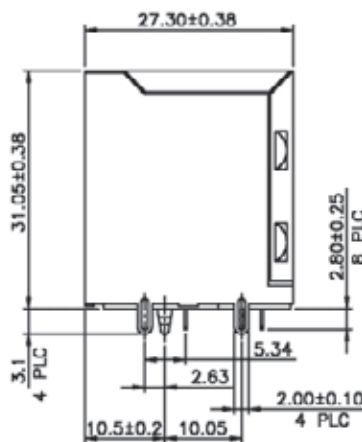
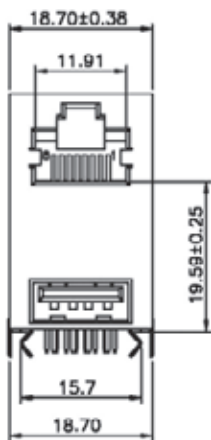
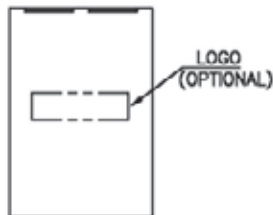
SIDE ENTRY MODULAR PCB JACK 8P+USB WITHOUT LED PROFILE=31.05MM (FULLY SHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Black
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
Shield: Brass plating Nickel Alloy
***RoHS & REACH compliant.**



Recommended P.C.Board Layout

ORDERING INFORMATION:

P/N M J $\frac{N}{1}$ J - $\frac{8}{2}$ U $\frac{x}{3}$ B

- MODULAR JACK TYPE:
"NJ" RJ45 STACKED OVER USB CONNECTOR
- NO. OF POSITIONS & CONTACTS:
"8U" RJ45 JACK & USB A TYPE FEMALE
- CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD
- HOUSING COLOR:
"B" BLACK

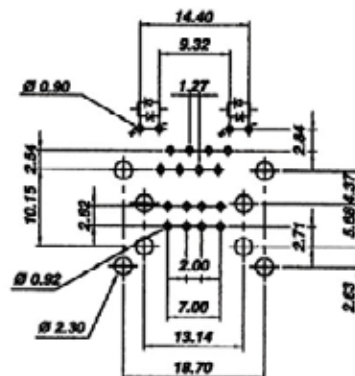
SIDE ENTRY MODULAR PCB JACK & USB JACK WITH LED 8P PROFILE=31.05MM (FULLY SHIELDED)

SPECIFICATIONS

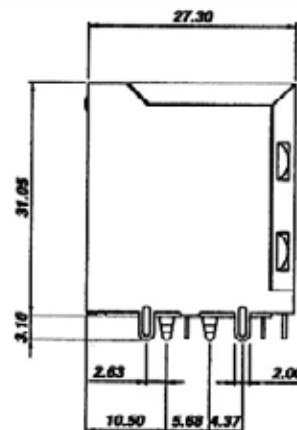
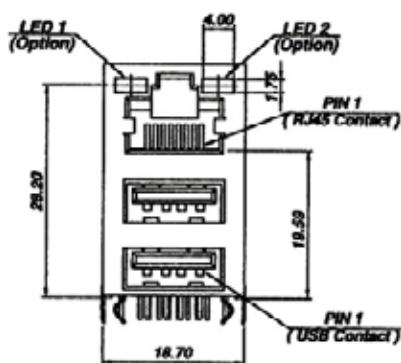
Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Black
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
Shield: Brass plating Nickel Alloy
***RoHS & REACH compliant.**



Recommended P.C.Board Layout
(TOP VIEW)



ORDERING INFORMATION:

P/N MJ4G - $\frac{8U}{T} \frac{x}{2} \frac{B}{3} \frac{x}{4}$

1. NO. OF POSITIONS & CONTACTS:
"8U" RJ45 JACK & 2 USB A TYPE FEMALE
2. CONTACT FINISH:
 "A" 6 MICROINCH GOLD
 "B" 15 MICROINCH GOLD
 "C" 30 MICROINCH GOLD
 "D" 50 MICROINCH GOLD
3. CODE OF LED1 DESIGNATION:
N, M, Y, Z, 8, Q, 1, 2, 5, 6
4. CODE OF LED2 DESIGNATION:
N, M, Y, Z, 8, Q, 1, 2, 5, 6

LED Designation:

Code	+/-	-/+	Code	+/-	-/+
N	Green	—	M	—	Green
Y	Yellow	—	Z	—	Yellow
8	Orange	—	Q	—	Orange
1	Green	Orange	2	Orange	Green
5	Green	Yellow	6	Yellow	Green

NOTE: P/N MJ4GHT-88xBxx FOR HIGH TEMP. VERSION

TOP ENTRY 8-PORT DOUBLE LEVEL MODULAR PCB JACK 8P PROFILE=16.70MM (FULLY SHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)

Soldering Temperature: 235°C

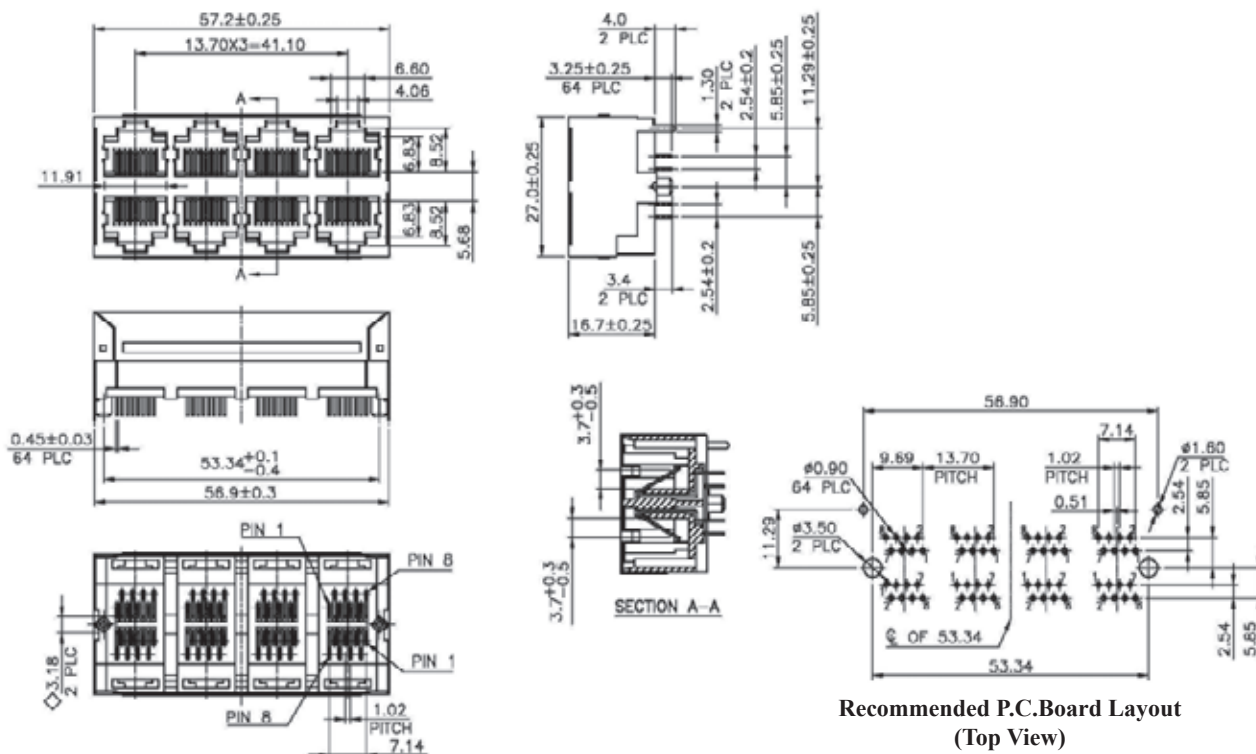
Color: Black

Spring Wire: Phosphor Bronze

Gold plating Over Nickel

Shield: Brass plating Nickel Alloy

*RoHS & REACH compliant.



Recommended P.C.Board Layout
(Top View)

ORDERING INFORMATION:

P/N MJ6Q - 88 x B 08
I 2 3

1. NO. OF POSITIONS & CONTACTS:

"88" 8P8C

2. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

3. NO. OF PORTS:

08

NOTE: P/N MJ6QHT-88xB08 FOR HIGH TEMP. VERSION

SIDE ENTRY MAGNETIC 10/100 BASE-TX JACK WITHOUT LED 8P PROFILE=13.30MM (FULLY SHIELDED)

SPECIFICATIONS

Insulation Resistance: 1000 Vac Rms 60Hz Min.

Contact Resistance: 40mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 125V AC.

Dielectric Strength: 1000 Vac Rms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 750 Mating cycles Min.

MATERIALS

Housing: High Temp Thermoplastic (UL 94V-0)

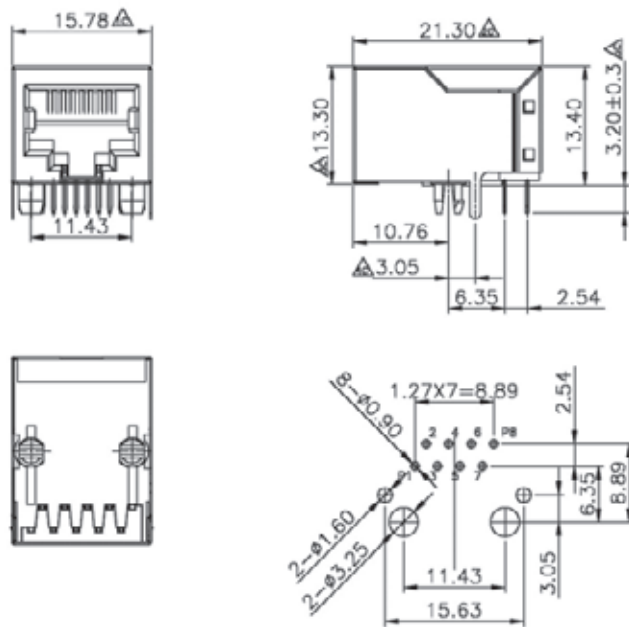
Shield: Brass Plating Nickel Alloy

Plating: Gold Plating Over Nickel In Contact

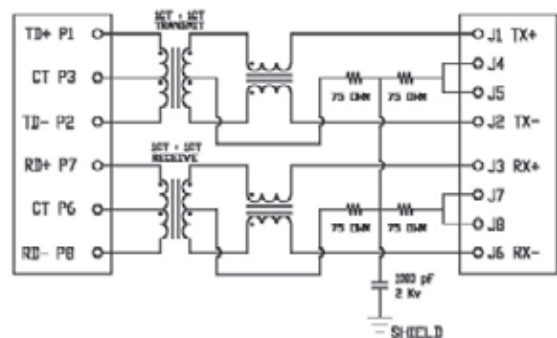
Tin Plating Over Nickel In Solder Area

Contacts: Phosphor Bronze

***RoHS & REACH compliant.**



Recommended P.C.Board Layout



ORDERING INFORMATION:

P/N L T A J - $\frac{88}{12} \times \frac{B01}{3}$

1. NO. OF POSITIONS & CONTACTS:

"88" 8P8C

2. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

3. MAGNETIC SCHEMATICS:

01

SIDE ENTRY MAGNETIC 10/100 BASE-TX JACK WITH LED 8P PROFILE=13.30MM (FULLY SHIELDED)

SPECIFICATIONS

Insulation Resistance: 1000 Vac Rms 60Hz Min.

Contact Resistance: 40mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 125V AC.

Dielectric Strength: 1000 Vac Rms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 750 Mating cycles Min.

MATERIALS

Housing: High Temp Thermoplastic (UL 94V-0)

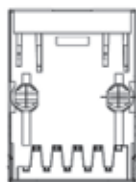
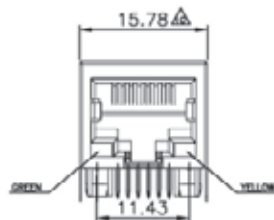
Shield: Brass Plating Nickel Alloy

Plating: Gold Plating Over Nickel In Contact

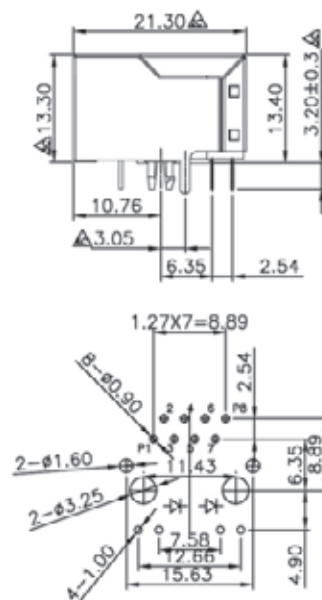
Tin Plating Over Nickel In Solder Area

Contacts: Phosphor Bronze

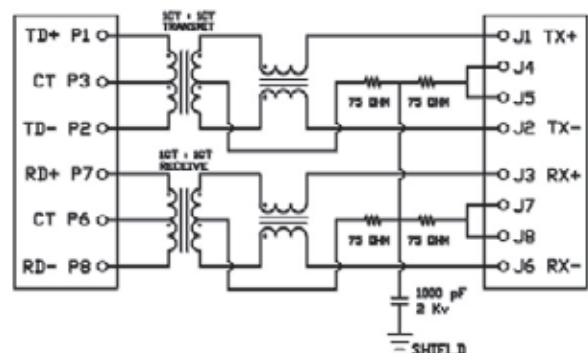
***RoHS & REACH compliant.**



P/N LTAF-88xB01NY



Recommended P.C.Board Layout



ORDERING INFORMATION:

P/N LTAF-88xB01xx
1 2 3 4

1. NO. OF POSITIONS & CONTACTS:

"88" 8P8C

2. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

3. MAGNETIC SCHEMATICS:

01

4. TYPE OF LED POLARITY:

(LED PIN DIRECTION FROM LEFT TO RIGHT)

1N, 1Y, 1Z, 5S, 58, 5Q, 8S, MM, MY, MZ, NS, NN, NY, NZ, QS, Y1, Y2, YM, YN, Z1, Z2, ZM, ZN

LED Designation:

Code	+/-	-/+	Code	+/-	-/+
N	Green	—	M	—	Green
Y	Yellow	—	Z	—	Yellow
8	Orange	—	Q	—	Orange
1	Green	Orange	2	Orange	Green
5	Green	Yellow	6	Yellow	Green

SIDE ENTRY MAGNETIC 10/100 BASE-TX JACK WITH LED 8P PROFILE=13.30MM (FULLY SHIELDED)

SPECIFICATIONS

Insulation Resistance: 1000 Vac Rms 60Hz Min.

Contact Resistance: 40mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 125V AC.

Dielectric Strength: 1000 Vac Rms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 750 Mating cycles Min.

MATERIALS

Housing: High Temp Thermoplastic (UL 94V-0)

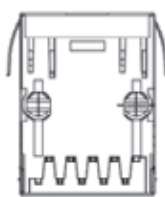
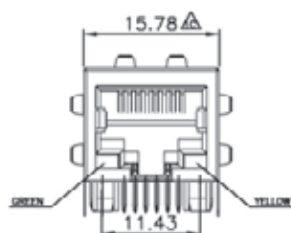
Shield: Brass Plating Nickel Alloy

Plating: Gold Plating Over Nickel In Contact

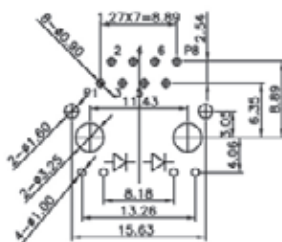
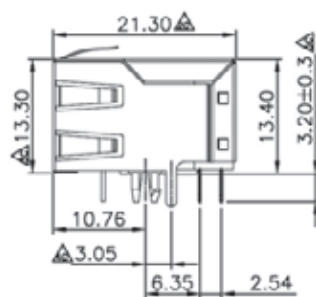
Tin Plating Over Nickel In Solder Area

Contacts: Phosphor Bronze

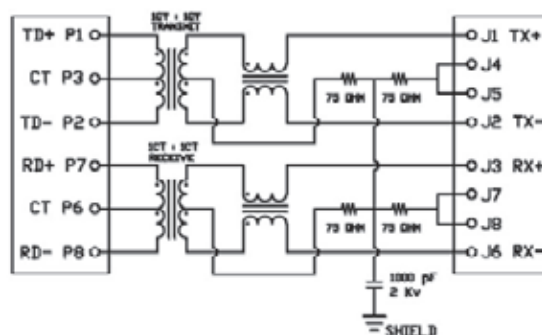
***RoHS & REACH compliant.**



P/N LTAH-88xB01NY



Recommended P.C.Board Layout



ORDERING INFORMATION:

P/N LTAH - 88 x B 01 x x
I 2 3 4

1. NO. OF POSITIONS & CONTACTS:

"88" 8P8C

2. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

3. MAGNETIC SCHEMATICS:

01

4. TYPE OF LED POLARITY:

(LED PIN DIRECTION FROM LEFT TO RIGHT)

1N, 1Y, 1Z, 55, 58, 5Q, 85, MM, MY, MZ, N5, NN, NY, NZ, Q5, Y1, Y2, YM, YN, Z1, Z2, ZM, ZN

LED Designation:

Code	+/-	-/+	Code	+/-	-/+
N	Green	—	M	—	Green
Y	Yellow	—	Z	—	Yellow
8	Orange	—	Q	—	Orange
1	Green	Orange	2	Orange	Green
5	Green	Yellow	6	Yellow	Green

SIDE ENTRY MAGNETIC 10/100 & 10/100/1000 BASE-TX JACK WITH LED 12P PROFILE=11.30MM (FULLY SHIELDED)

MATERIALS

Housing: PBT UL 94V-0, Black

Shell: Brass C2680 T=0.20, 85u"~135u" Ni Plated

RJ45 Terminal: Phosphor Bronze T=0.30mm,

Gold Au Plated on Contact Area

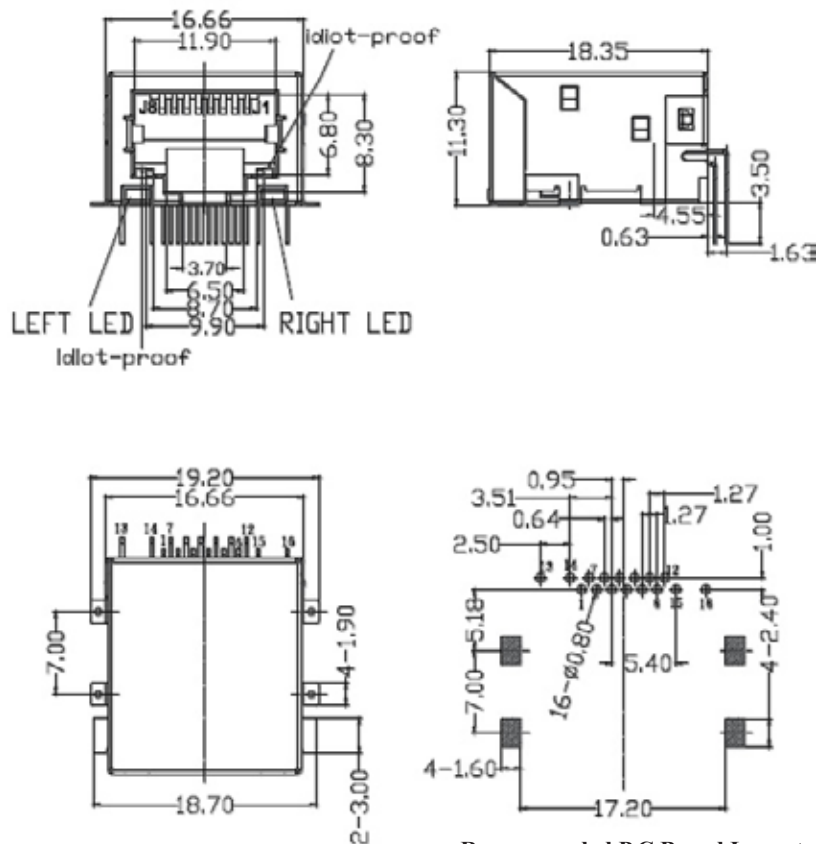
80u"~160u" Tin Plated on Solder Area

50u"~100u" Ni Underplated overall

Other Terminal: Brass T=0.30mm, 80u"~160u" Tin Plated

50u"~100u" Ni Underplated overall

*RoHS & REACH compliant.



Recommended P.C.Board Layout

ORDERING INFORMATION:

P/N L T 1 3 - $\frac{T}{1} \frac{8}{2} \times \frac{B}{3} \frac{x}{4} \frac{x}{4}$

1. NO. OF POSITIONS & CONTACTS:

"T8" 12P8C

2. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

3. MAGNETIC SCHEMATICS:

10/100 BASE-TX

58, 60, 66, 67, 76, 77, 78, 79, 80

10/100/1000 BASE-TX

G5, H4

SEE PAGE N5902~N5906 & N5941~N5943!

4. TYPE OF LED POLARITY:

(LED PIN DIRECTION FROM LEFT TO RIGHT)

1N, 1Y, 1Z, 5S, 58, 5Q, 85, MM, MY, MZ, N5, NN, NY, NZ, Q5, Y1, Y2, YM, YN, Z1, Z2, ZM, ZN

LED Designation:

Code	+/-	-/+	Code	+/-	-/+
N	Green	—	M	—	Green
Y	Yellow	—	Z	—	Yellow
8	Orange	—	Q	—	Orange
1	Green	Orange	2	Orange	Green
5	Green	Yellow	6	Yellow	Green

SIDE ENTRY MAGNETIC 10/100 & 10/100/1000 BASE-TX JACK WITH LED 12P PROFILE=11.30MM (FULLY SHIELDED)

MATERIALS

Housing: PBT UL 94V-0, Black

Shell: Brass C2680 T=0.20, 85u"~135u" Ni Plated

RJ45 Terminal: Phosphor Bronze T=0.30mm,

Gold Au Plated on Contact Area

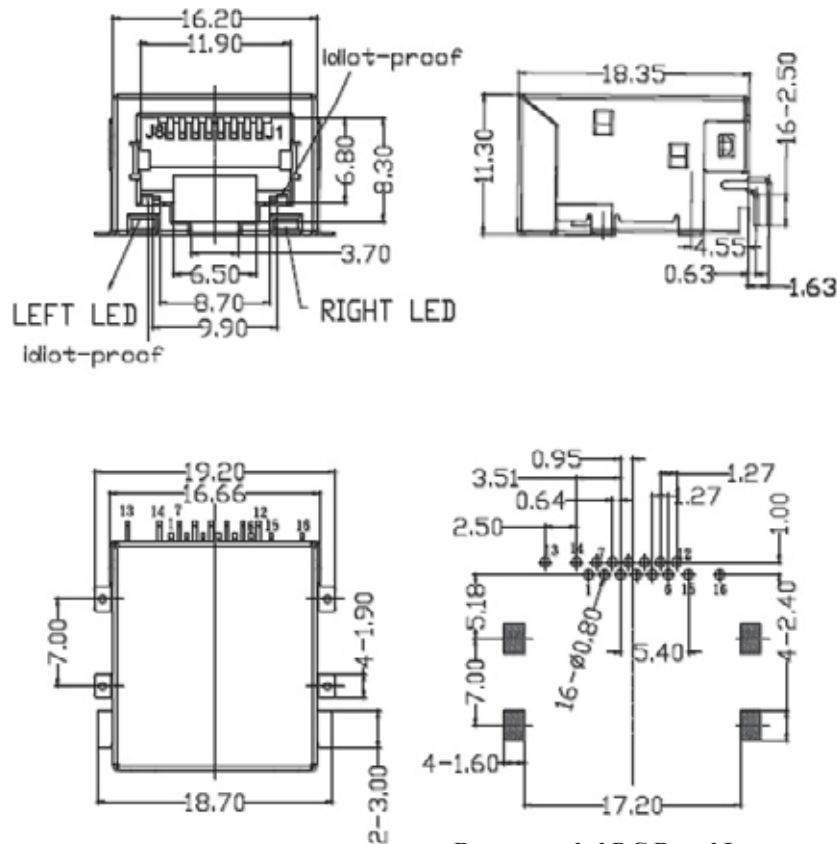
80u"~160u" Tin Plated on Solder Area

50u"~100u" Ni Underplated overall

Other Terminal: Brass T=0.30mm, 80u"~160u" Tin Plated

50u"~100u" Ni Underplated overall

*RoHS & REACH compliant.



Recommended P.C.Board Layout

ORDERING INFORMATION:

P/N L T 1 4 - $\frac{T}{1} \frac{8}{2} \times \frac{B}{3} \times \frac{x}{4} \times x$

1. NO. OF POSITIONS & CONTACTS:

"T8" 12P8C

2. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

3. MAGNETIC SCHEMATICS:

10/100 BASE-TX

58, 60, 66, 67, 76, 77, 78, 79, 80

10/100/1000 BASE-TX

G5, H4

SEE PAGE N5902~N5906 & N5941~N5943!

4. TYPE OF LED POLARITY:

(LED PIN DIRECTION FROM LEFT TO RIGHT)

1N, 1Y, 1Z, 5S, 58, 5Q, 85, MM, MY, MZ, N5, NN, NY, NZ, Q5, Y1, Y2, YM, YN, Z1, Z2, ZM, ZN

LED Designation:

Code	+/-	-/+	Code	+/-	-/+
N	Green	—	M	—	Green
Y	Yellow	—	Z	—	Yellow
8	Orange	—	Q	—	Orange
1	Green	Orange	2	Orange	Green
5	Green	Yellow	6	Yellow	Green

SIDE ENTRY MAGNETIC 10/100 BASE-TX JACK WITH LED 8P PROFILE=13.30MM (FULLY SHIELDED)

SPECIFICATIONS

Insulation Resistance: 1000MΩ Min.

Contact Resistance: 40mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 125V AC.

Dielectric Voltage: 1000 Vac Rms 60Hz 1 Min.

Temperature Range: -40°C To +80°C

Durability: 750 Mating cycles Min.

MATERIALS

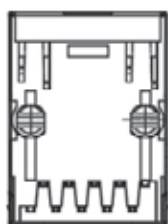
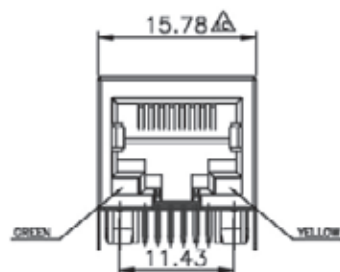
Housing: High Temperature Thermoplastic UL 94V-0

Contacts: Phosphor Bronze

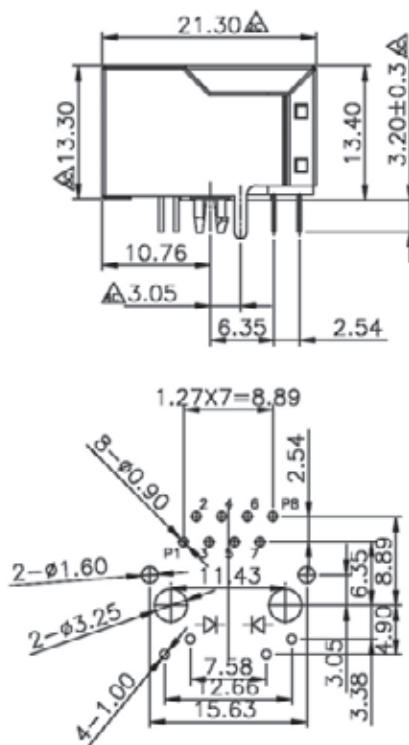
Plating: Gold plating Over Nickel in Contact

Tin plating Over Nickel in Solder Area

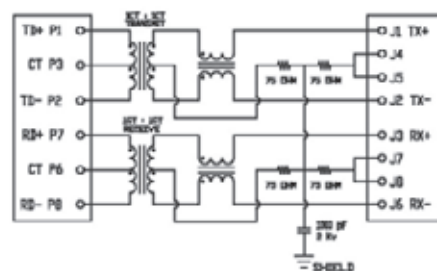
***RoHS & REACH compliant.**



P/N LTAF-88xB01NZ



Recommended P.C.Board Layout



ORDERING INFORMATION:

P/N LTAF-88xB01NZ

1. NO. OF POSITIONS & CONTACTS:

"88" 8P8C

2. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

3. MAGNETIC SCHEMATICS:

01

4. TYPE OF LED POLARITY:

(LED PIN DIRECTION FROM LEFT TO RIGHT)

1N, 1Y, 1Z, 55, 58, 5Q, 85, MM, MY, MZ, N5, NN,

NY, NZ, Q5, Y1, Y2, YM, YN, Z1, Z2, ZM, ZN

LED Designation:

Code	+/-	-/+	Code	+/-	-/+
N	Green	—	M	—	Green
Y	Yellow	—	Z	—	Yellow
8	Orange	—	Q	—	Orange
1	Green	Orange	2	Orange	Green
5	Green	Yellow	6	Yellow	Green

SIDE ENTRY MAGNETIC 10/100/1000 (GIGABIT) BASE-TX JACK WITH LED 10P PROFILE=13.30MM (FULLY SHIELDED)

SPECIFICATIONS

Insulation Resistance: 1000MΩ Min.

Contact Resistance: 40mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 125V AC.

Dielectric Voltage: 1000 Vac Rms 60Hz 1 Min.

Temperature Range: -40°C To +80°C

Durability: 750 Mating cycles Min.

MATERIALS

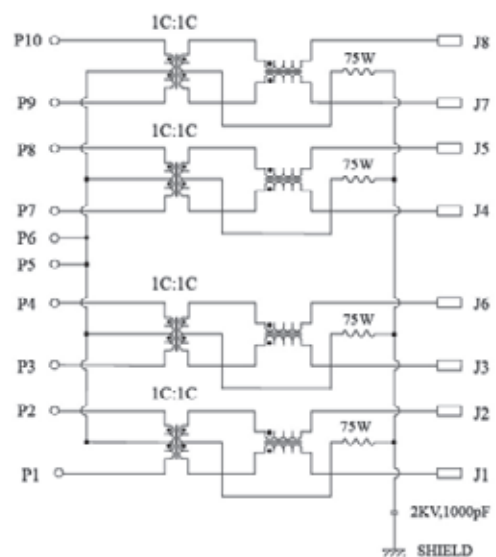
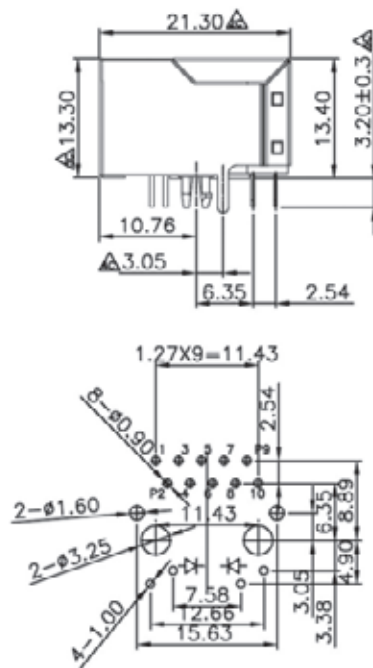
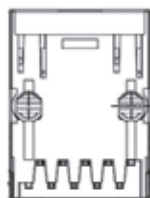
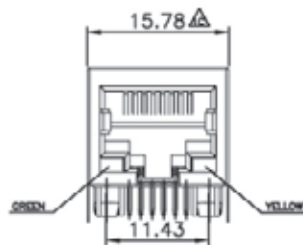
Housing: High Temperature Thermoplastic UL 94V-0

Contacts: Phosphor Bronze

Plating: Gold plating Over Nickel in Contact

Tin plating Over Nickel in Solder Area

***RoHS & REACH compliant.**



P/N LTGD-08xB25NZ

Recommended P.C.Board Layout

ORDERING INFORMATION:

P/N LTGD - 08 x B x x x x
1 2 3 4

1. NO. OF POSITIONS & CONTACTS:

"08" 10P8C

2. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

3. MAGNETIC SCHEMATICS:

25

4. TYPE OF LED POLARITY:

(LED PIN DIRECTION FROM LEFT TO RIGHT)

1N, 1Y, 1Z, 55, 58, 5Q, 85, MM, MY, MZ, N5, NN,

NY, NZ, Q5, Y1, Y2, YM, YN, Z1, Z2, ZM, ZN

LED Designation:

Code	+/-	-/+	Code	+/-	-/+
N	Green	—	M	—	Green
Y	Yellow	—	Z	—	Yellow
8	Orange	—	Q	—	Orange
1	Green	Orange	2	Orange	Green
5	Green	Yellow	6	Yellow	Green

SIDE ENTRY UP LATCH MAGNETIC 10/100 BASE-TX JACK WITHOUT LED 10P PROFILE=13.50MM (FULLY SHIELDED)

MATERIALS

Housing: High Temperature Thermoplastic UL 94V-0, Black

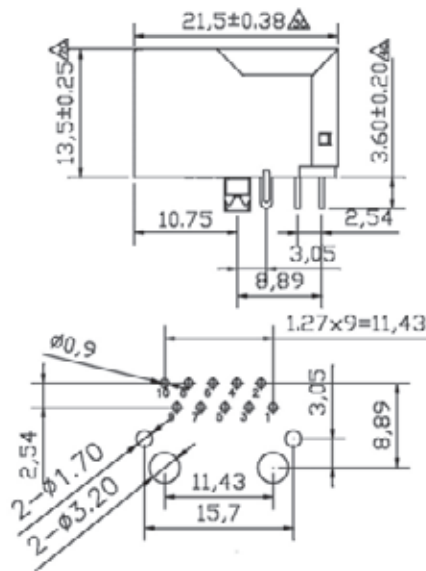
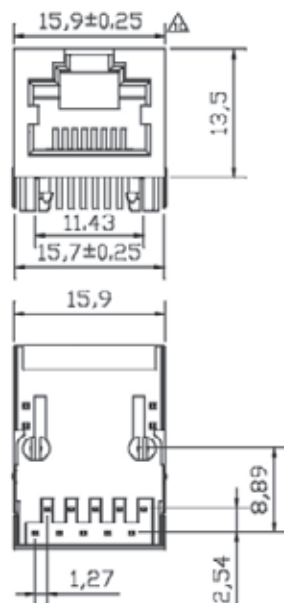
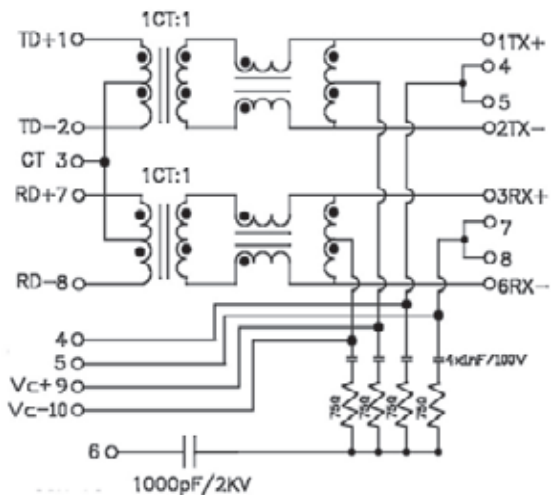
Contacts: 0.35mm Phosphor Bronze Plated,

Gold Plated on Contact Area

Solder Tin in Solder Area

Shield: 0.20mm Copper Alloy with Nickel

*RoHS & REACH compliant.



Recommended P.C.Board Layout

ORDERING INFORMATION:

P/N L T A A - $\frac{08}{1} \times \frac{B}{2} \frac{05}{3}$

1. NO. OF POSITIONS & CONTACTS:
"08" 10P8C
2. CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD
3. MAGNETIC SCHEMATICS:
05

SIDE ENTRY UP LATCH MAGNETIC 10/100 & 10/100/1000 BASE-TX JACK WITHOUT LED 8P PROFILE=13.50MM (FULLY SHIELDED)

MATERIALS

Housing: PBT UL 94V-0, Black

Shell: Brass C2680 T=0.20, 85u"~135u" Ni Plated

RJ45 Terminal: Phosphor Bronze T=0.30mm,

Gold Au Plated on Contact Area

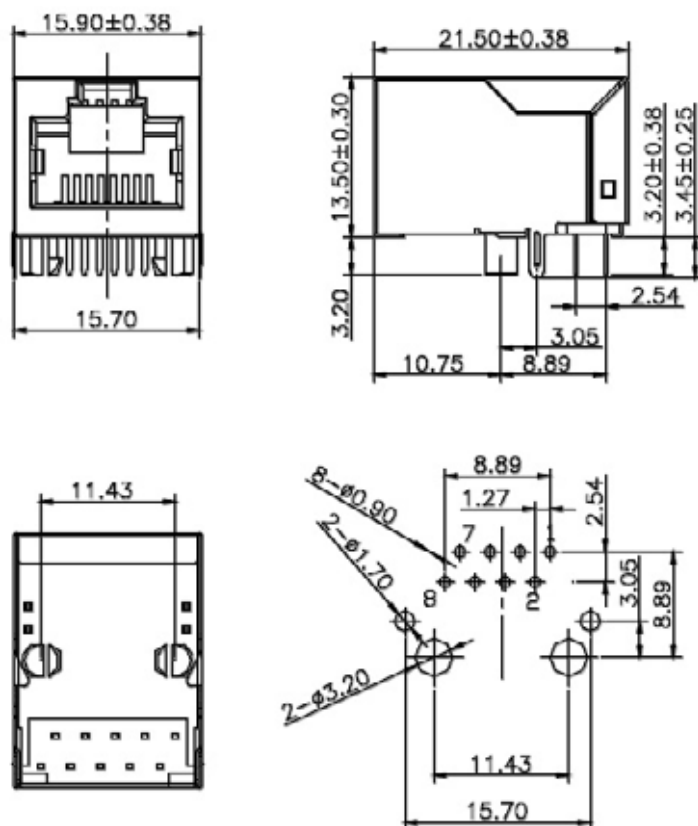
80u"~160u" Tin Plated on Solder Area

50u"~100u" Ni Underplated overall

Other Terminal: Brass T=0.30mm, 80u"~160u" Tin Plated

50u"~100u" Ni Underplated overall

*RoHS & REACH compliant.



Recommended P.C.Board Layout

ORDERING INFORMATION:

P/N L T $\frac{x}{1}$ - $\frac{8}{2}$ $\frac{8}{3}$ B $\frac{x}{4}$

1. TYPE OF PANEL GROUNDS:

"31" NO TAB

"32" TOP TABS

"33" SIDE TABS

"34" TOP TABS & SIDE TABS

2. NO. OF POSITIONS & CONTACTS:

"88" 8P8C

3. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

4. MAGNETIC SCHEMATICS:

10/100 BASE-TX

51, 52, 53, 54, 55, 56, 57, 58, 59, 60,

61, 62, 63, 64, 73

10/100/1000 BASE-TX

G1, G3, G4, G6, G7, G8, G9, H0, J9

SEE PAGE N5902~N5906 & N5941~N5943!

SIDE ENTRY UP LATCH MAGNETIC 10/100 & 10/100/1000 BASE-TX JACK WITH LED 8P PROFILE=13.50MM (FULLY SHIELDED)

MATERIALS

Housing: PBT UL 94V-0, Black

Shell: Brass C2680 T=0.20, 85u"~135u" Ni Plated

RJ45 Terminal: Phosphor Bronze T=0.30mm,

Gold Au Plated on Contact Area

80u"~160u" Tin Plated on Solder Area

50u"~100u" Ni Underplated overall

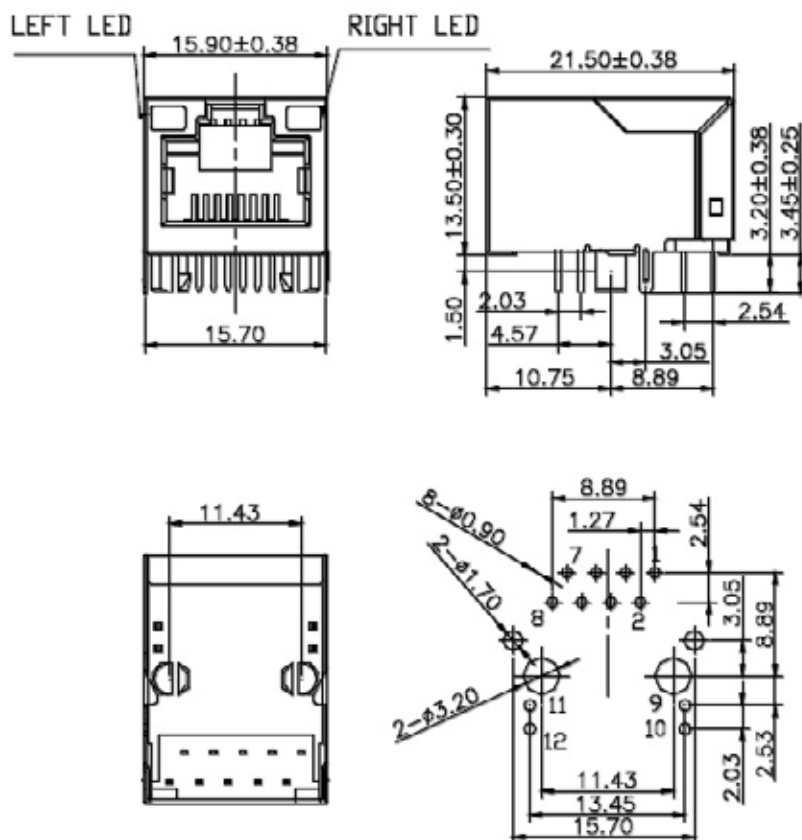
Other Terminal: Brass T=0.30mm, 80u"~160u" Tin Plated

50u"~100u" Ni Underplated overall

*RoHS & REACH compliant.

LED Designation:

Code	+/-	-/+	Code	+/-	-/+
N	Green	—	M	—	Green
Y	Yellow	—	Z	—	Yellow
8	Orange	—	Q	—	Orange
1	Green	Orange	2	Orange	Green
5	Green	Yellow	6	Yellow	Green



Recommended P.C.Board Layout

ORDERING INFORMATION:

P/N L T $\frac{x}{1}$ - $\frac{8}{2}$ $\frac{8}{3}$ B $\frac{x}{4}$ $\frac{x}{5}$

1. TYPE OF PANEL GROUNDS:

"35" NO TAB

"36" TOP TABS

"37" SIDE TABS

"38" TOP TABS & SIDE TABS

2. NO. OF POSITIONS & CONTACTS:

"88" 8P8C

3. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

4. MAGNETIC SCHEMATICS:

10/100 BASE-TX

51, 52, 53, 54, 55, 56, 57, 58, 59, 60, 61, 62, 63, 64, 73

10/100/1000 BASE-TX

G1, G3, G4, G6, G7, G8, G9, H0, J9

SEE PAGE N5902~N5906 & N5941~N5943!

5. TYPE OF LED POLARITY:

(LED PIN DIRECTION FROM LEFT TO RIGHT)

1N, 1Y, 1Z, 55, 58, 5Q, 85, MM, MY, MZ, N5, NN, NY, NZ, Q5, Y1, Y2, YM, YN, Z1, Z2, ZM, ZN

NOTE: LED PINS ARE PARALLEL

SIDE ENTRY UP LATCH MAGNETIC 10/100 & 10/100/1000 BASE-TX JACK WITHOUT LED 10P PROFILE=13.50MM (FULLY SHIELDED)

MATERIALS

Housing: PBT UL 94V-0, Black

Shell: Brass C2680 T=0.20, 85u"~135u" Ni Plated

RJ45 Terminal: Phosphor Bronze T=0.30mm,

Gold Au Plated on Contact Area

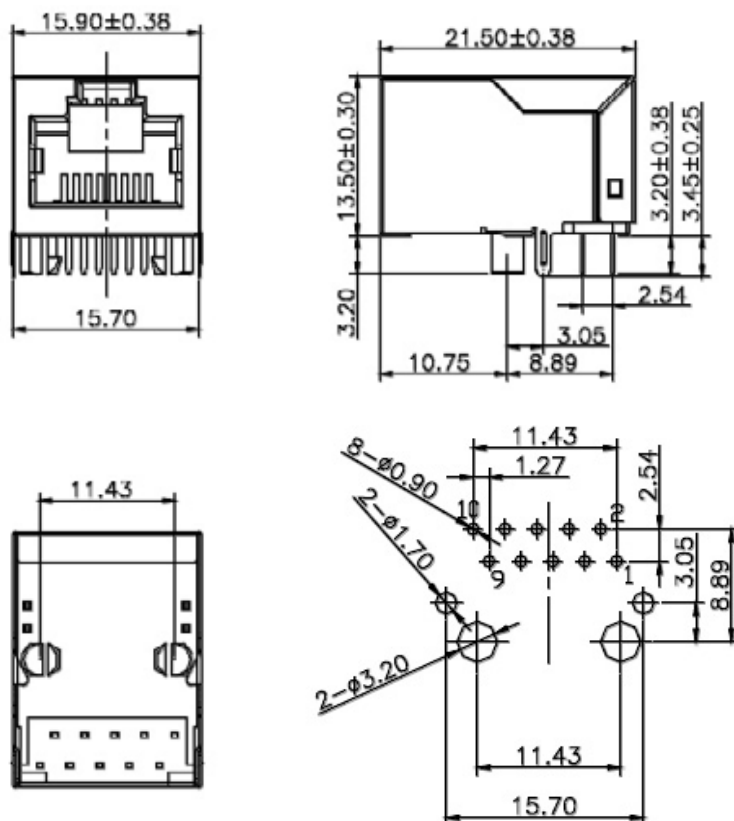
80u"~160u" Tin Plated on Solder Area

50u"~100u" Ni Underplated overall

Other Terminal: Brass T=0.30mm, 80u"~160u" Tin Plated

50u"~100u" Ni Underplated overall

*RoHS & REACH compliant.



Recommended P.C.Board Layout

ORDERING INFORMATION:

P/N L T $\frac{xx}{1}$ - $\frac{08}{2}$ $\frac{x}{3}$ B $\frac{xx}{4}$

1. TYPE OF PANEL GROUNDS:

"31" NO TAB

"32" TOP TABS

"33" SIDE TABS

"34" TOP TABS & SIDE TABS

2. NO. OF POSITIONS & CONTACTS:

"08" 10P8C

3. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

4. MAGNETIC SCHEMATICS:

10/100 BASE-TX

51, 52, 53, 54, 55, 56, 57, 58, 59, 60,

61, 62, 63, 64, 73

10/100/1000 BASE-TX

G1, G3, G4, G6, G7, G8, G9, H0, J9

SEE PAGE N5902~N5906 & N5941~N5943!

SIDE ENTRY UP LATCH MAGNETIC 10/100 & 10/100/1000 BASE-TX JACK WITH LED 10P PROFILE=13.50MM (FULLY SHIELDED)

MATERIALS

Housing: PBT UL 94V-0, Black

Shell: Brass C2680 T=0.20, 85u"~135u" Ni Plated

RJ45 Terminal: Phosphor Bronze T=0.30mm,

Gold Au Plated on Contact Area

80u"~160u" Tin Plated on Solder Area

50u"~100u" Ni Underplated overall

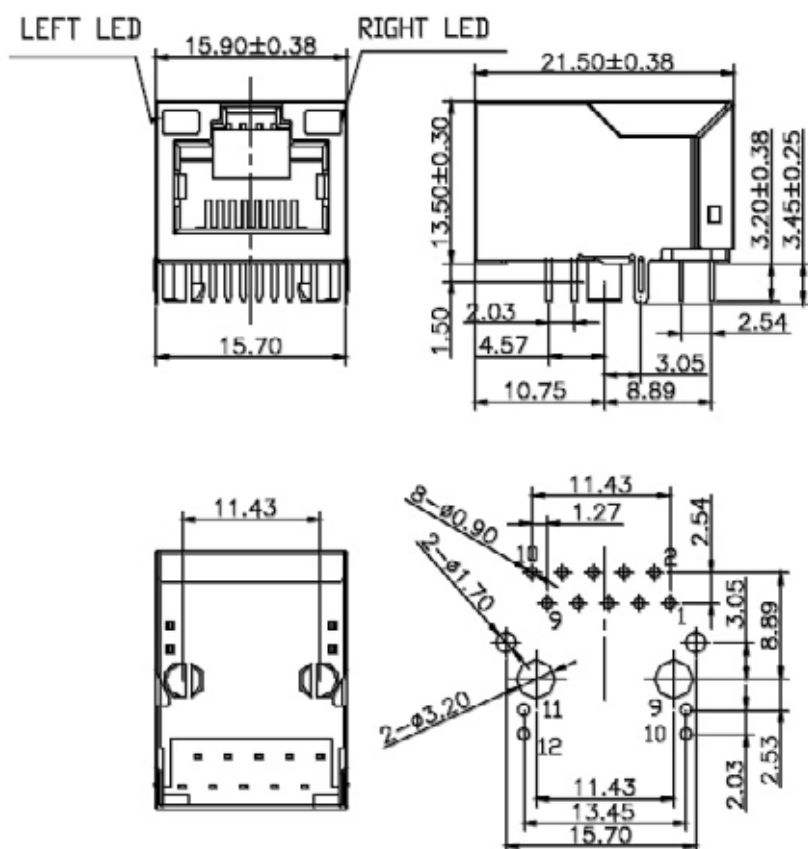
Other Terminal: Brass T=0.30mm, 80u"~160u" Tin Plated

50u"~100u" Ni Underplated overall

*RoHS & REACH compliant.

LED Designation:

Code	+/-	-/+	Code	+/-	-/+
N	Green	—	M	—	Green
Y	Yellow	—	Z	—	Yellow
8	Orange	—	Q	—	Orange
1	Green	Orange	2	Orange	Green
5	Green	Yellow	6	Yellow	Green



Recommended P.C.Board Layout

ORDERING INFORMATION:

P/N L T $\frac{x}{1}$ - $\frac{0.8}{2}$ x $\frac{B}{3}$ $\frac{x}{4}$ $\frac{x}{5}$

1. TYPE OF PANEL GROUNDS:

"35" NO TAB

"36" TOP TABS

"37" SIDE TABS

"38" TOP TABS & SIDE TABS

2. NO. OF POSITIONS & CONTACTS:

"08" 10P8C

3. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

4. MAGNETIC SCHEMATICS:

10/100 BASE-TX

51, 52, 53, 54, 55, 56, 57, 58, 59, 60, 61, 62, 63, 64, 73

10/100/1000 BASE-TX

G1, G3, G4, G6, G7, G8, G9, H0, J9

SEE PAGE N5902~N5906 & N5941~N5943!

5. TYPE OF LED POLARITY:

(LED PIN DIRECTION FROM LEFT TO RIGHT)

1N, 1Y, 1Z, 55, 58, 5Q, 85, MM, MY, MZ, N5, NN, NY, NZ, Q5, Y1, Y2, YM, YN, Z1, Z2, ZM, ZN

NOTE: LED PINS ARE PARALLEL

SIDE ENTRY UP LATCH MAGNETIC 10/100 & 10/100/1000 BASE-TX JACK WITHOUT LED 12P PROFILE=13.50MM (FULLY SHIELDED)

MATERIALS

Housing: PBT UL 94V-0, Black

Shell: Brass C2680 T=0.20, 85u"~135u" Ni Plated

RJ45 Terminal: Phosphor Bronze T=0.30mm,

Gold Au Plated on Contact Area

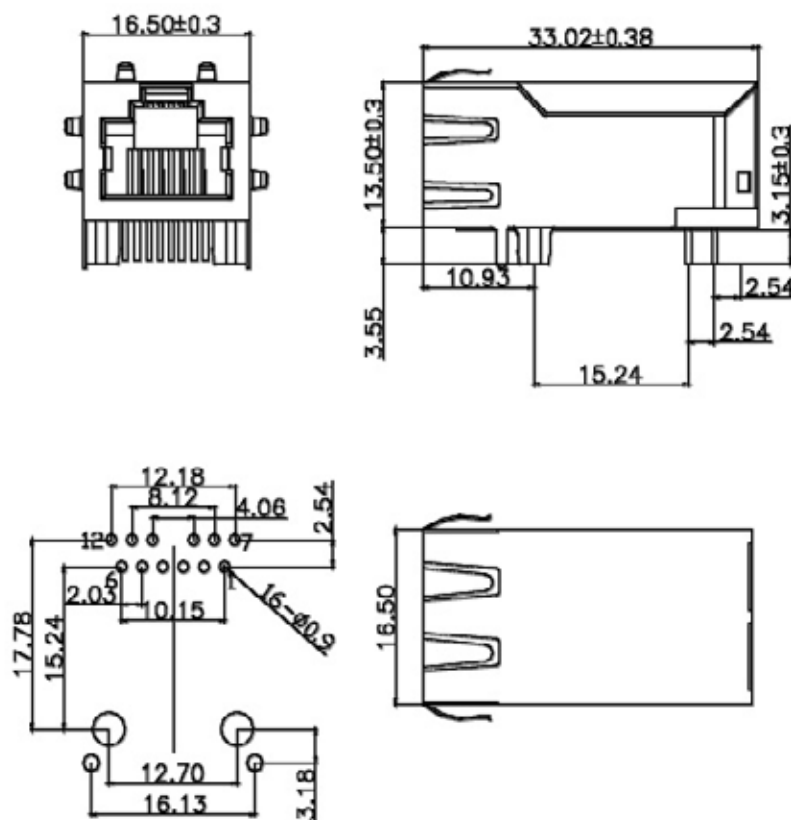
80u"~160u" Tin Plated on Solder Area

50u"~100u" Ni Underplated overall

Other Terminal: Brass T=0.30mm, 80u"~160u" Tin Plated

50u"~100u" Ni Underplated overall

*RoHS & REACH compliant.



Recommended P.C.Board Layout

ORDERING INFORMATION:

P/N L T $\frac{x}{1}$ - $\frac{T}{2}$ 8 $\frac{x}{3}$ B $\frac{x}{4}$

1. TYPE OF PANEL GROUNDS:

"23" NO TAB

"24" TOP TABS

"25" SIDE TABS

"26" TOP TABS & SIDE TABS

2. NO. OF POSITIONS & CONTACTS:

"T8" 12P8C

3. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

4. MAGNETIC SCHEMATICS:

10/100 BASE-TX

51, 52, 53, 54, 55, 56, 58, 59, 60, 61,

62, 63, 64, 73, 74, 81

10/100/1000 BASE-TX

G1, G3, G4, G6, G7, G8, G9, H0, J1,

J2, J3, J9, J0 (10GB)

SEE PAGE N5902~N5906 & N5941~N5943!

SIDE ENTRY UP LATCH MAGNETIC 10/100 & 10/100/1000 BASE-TX JACK WITH LED 12P PROFILE=13.50MM (FULLY SHIELDED)

MATERIALS

Housing: PBT UL 94V-0, Black

Shell: Brass C2680 T=0.20, 85u"~135u" Ni Plated

RJ45 Terminal: Phosphor Bronze T=0.30mm,

Gold Au Plated on Contact Area

80u"~160u" Tin Plated on Solder Area

50u"~100u" Ni Underplated overall

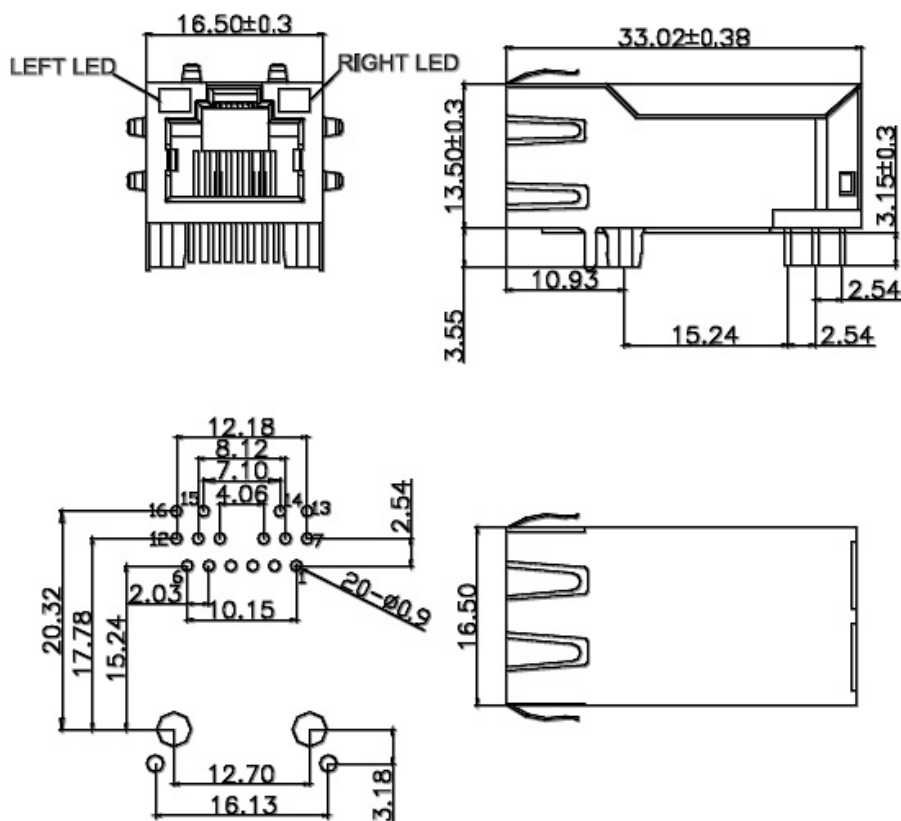
Other Terminal: Brass T=0.30mm, 80u"~160u" Tin Plated

50u"~100u" Ni Underplated overall

*RoHS & REACH compliant.

LED Designation:

Code	+/-	-/+	Code	+/-	-/+
N	Green	—	M	—	Green
Y	Yellow	—	Z	—	Yellow
8	Orange	—	Q	—	Orange
1	Green	Orange	2	Orange	Green
5	Green	Yellow	6	Yellow	Green



Recommended P.C.Board Layout

ORDERING INFORMATION:

P/N L T x x - T 8 x B x x x x
 1 2 3 4 5

1. TYPE OF PANEL GROUNDS:

"27" NO TAB

"28" TOP TABS

"29" SIDE TABS

"30" TOP TABS & SIDE TABS

2. NO. OF POSITIONS & CONTACTS:

"T8" 12P8C

3. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

4. MAGNETIC SCHEMATICS:

10/100 BASE-TX

51, 52, 53, 54, 55, 56, 58, 59, 60, 61, 62,
63, 64, 73, 74, 81

10/100/1000 BASE-TX

G1, G3, G4, G6, G7, G8, G9, H0, J1, J2,
J3, J9, J0 (10GB)

SEE PAGE N5902~N5906 & N5941~N5943!

5. TYPE OF LED POLARITY:

(LED PIN DIRECTION FROM LEFT TO RIGHT)

1N, 1Y, 1Z, 55, 58, 5Q, 85, MM, MY, MZ, N5, NN,
NY, NZ, Q5, Y1, Y2, YM, YN, Z1, Z2, ZM, ZN

NOTE: LED PINS ARE PARALLEL

SIDE ENTRY 2-PORT MAGNETIC 10/100 & 10/100/1000 BASE-TX JACK WITHOUT LED 8P PROFILE=13.55MM (FULLY SHIELDED)

MATERIALS

Housing: PBT UL 94V-0, Black

Shell: Brass C2680 T=0.20, 85u"~135u" Ni Plated

RJ45 Terminal: Phosphor Bronze T=0.30mm,

Gold Au Plated on Contact Area

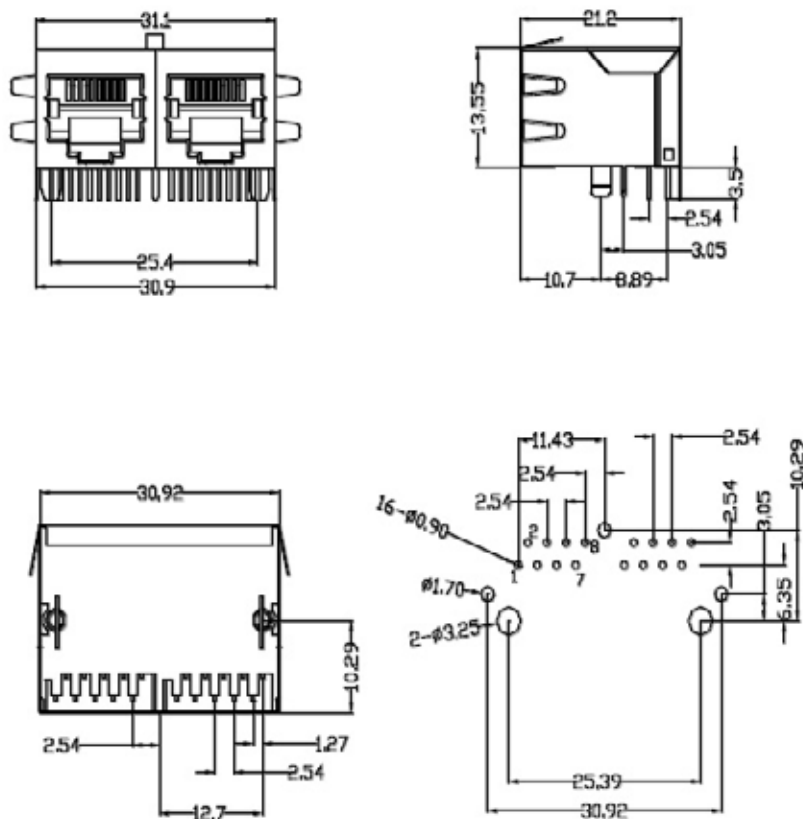
80u"~160u" Tin Plated on Solder Area

50u"~100u" Ni Underplated overall

Other Terminal: Brass T=0.30mm, 80u"~160u" Tin Plated

50u"~100u" Ni Underplated overall

*RoHS & REACH compliant.



Recommended P.C.Board Layout

ORDERING INFORMATION:

P/N L T $\frac{x}{1}$ - $\frac{8}{2}$ $\frac{8}{3}$ B $\frac{x}{4}$ $\frac{0}{5}$

1. TYPE OF PANEL GROUNDS:

"53" NO TAB

"54" TOP TABS

"55" SIDE TABS

"56" TOP TABS & SIDE TABS

2. NO. OF POSITIONS & CONTACTS:

"88" 8P8C

3. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

4. MAGNETIC SCHEMATICS:

10/100 BASE-TX

51, 52, 53, 54, 55, 56, 58, 59, 60, 63

10/100/1000 BASE-TX

G1, G3, G4, G6, G7, G8, G9, H0

SEE PAGE N5902~N5906 & N5941~N5943!

5. NO. OF PORTS:

02

SIDE ENTRY 2-PORT MAGNETIC 10/100 & 10/100/1000 BASE-TX JACK WITH LED 8P PROFILE=13.55MM (FULLY SHIELDED)

MATERIALS

Housing: PBT UL 94V-0, Black

Shell: Brass C2680 T=0.20, 85u"~135u" Ni Plated

RJ45 Terminal: Phosphor Bronze T=0.30mm,

Gold Au Plated on Contact Area

80u"~160u" Tin Plated on Solder Area

50u"~100u" Ni Underplated overall

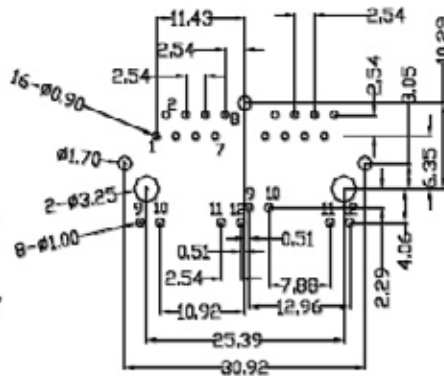
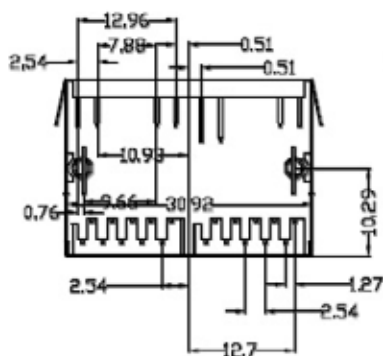
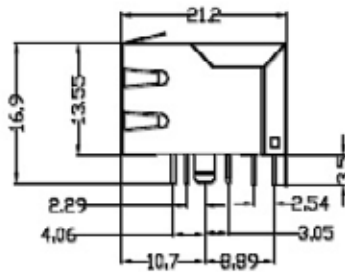
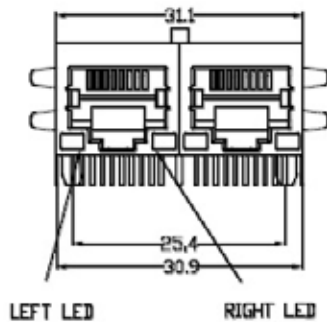
Other Terminal: Brass T=0.30mm, 80u"~160u" Tin Plated

50u"~100u" Ni Underplated overall

*RoHS & REACH compliant.

LED Designation:

Code	+/-	-/+	Code	+/-	-/+
N	Green	—	M	—	Green
Y	Yellow	—	Z	—	Yellow
8	Orange	—	Q	—	Orange
1	Green	Orange	2	Orange	Green
5	Green	Yellow	6	Yellow	Green



Recommended P.C.Board Layout

ORDERING INFORMATION:

P/N L T $\frac{x}{1}$ $\frac{x}{2}$ $\frac{8}{3}$ $\frac{x}{4}$ $\frac{x}{5}$ $\frac{x}{6}$ 0 2

1. TYPE OF PANEL GROUNDS:

"57" NO TAB

"58" TOP TABS

"59" SIDE TABS

"60" TOP TABS & SIDE TABS

2. NO. OF POSITIONS & CONTACTS:

"88" 8P8C

3. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

4. MAGNETIC SCHEMATICS:

10/100 BASE-TX

51, 52, 53, 54, 55, 56, 58, 59, 60, 63

10/100/1000 BASE-TX

G1, G3, G4, G6, G7, G8, G9, H0

SEE PAGE N5902~N5906 & N5941~N5943!

5. TYPE OF LED POLARITY:

(LED PIN DIRECTION FROM LEFT TO RIGHT)

1N, 1Y, 1Z, 55, 58, 5Q, 85, MM, MY, MZ, N5, NN,

NY, NZ, Q5, Y1, Y2, YM, YN, Z1, Z2, ZM, ZN

6. NO. OF PORTS:

02

SIDE ENTRY MAGNETIC 10/100 BASE-TX JACK WITH LED 8P PROFILE=13.60MM(FULLY SHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: Nylon (UL 94V-0)

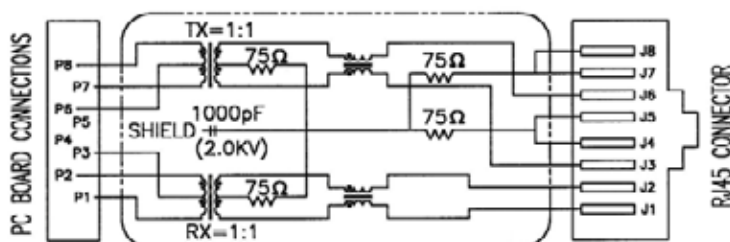
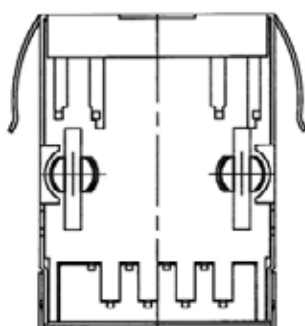
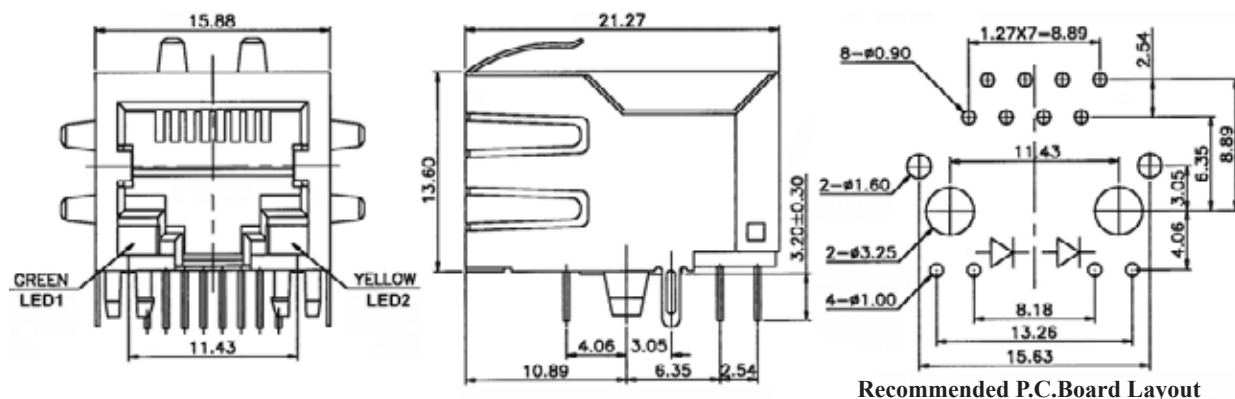
Soldering Temperature: 260°C

Color: Black

Spring Wire: Phosphor Bronze

Gold plating Over Nickel

*RoHS & REACH compliant.



ORDERING INFORMATION:

P/N L T M 1 - $\frac{88}{1} \frac{x}{2} \frac{B}{3} \frac{01}{4} \frac{xx}{4}$

1. NO. OF POSITIONS & CONTACTS:

"88" 8P8C

2. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

3. MAGNETIC SCHEMATICS:

01

4. COLORS OF LED:

"NN" LED1: GREEN & LED2: GREEN

"NY" LED1: GREEN & LED2: YELLOW

"YN" LED1: YELLOW & LED2: GREEN

"YY" LED1: YELLOW & LED2: YELLOW

"XX" W/O LED

OTHER LED COLORS UPON REQUEST!

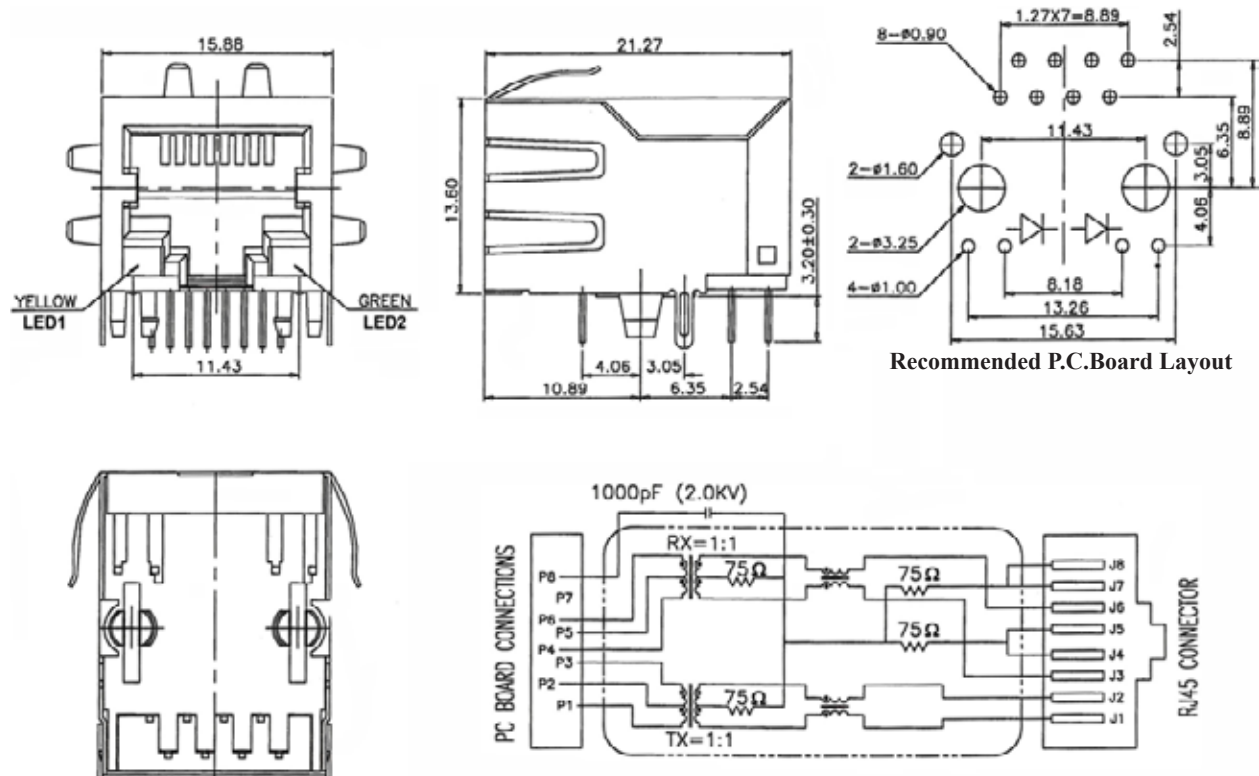
SIDE ENTRY MAGNETIC 10/100 BASE-TX JACK WITH LED 8P PROFILE=13.60MM (FULLY SHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: Nylon (UL 94V-0)
Soldering Temperature: 260°C
Color: Black
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
***RoHS & REACH compliant.**



ORDERING INFORMATION:

P/N L T M 1 - $\frac{88}{1} \frac{x}{2} \frac{B}{3} \frac{02}{4} \frac{xx}{4}$

1. NO. OF POSITIONS & CONTACTS:
"88" 8P8C
2. CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD
3. MAGNETIC SCHEMATICS:
02

4. COLORS OF LED:
"NN" LED1: GREEN & LED2: GREEN
"NY" LED1: GREEN & LED2: YELLOW
"YN" LED1: YELLOW & LED2: GREEN
"YY" LED1: YELLOW & LED2: YELLOW
"XX" W/O LED
OTHER LED COLORS UPON REQUEST!

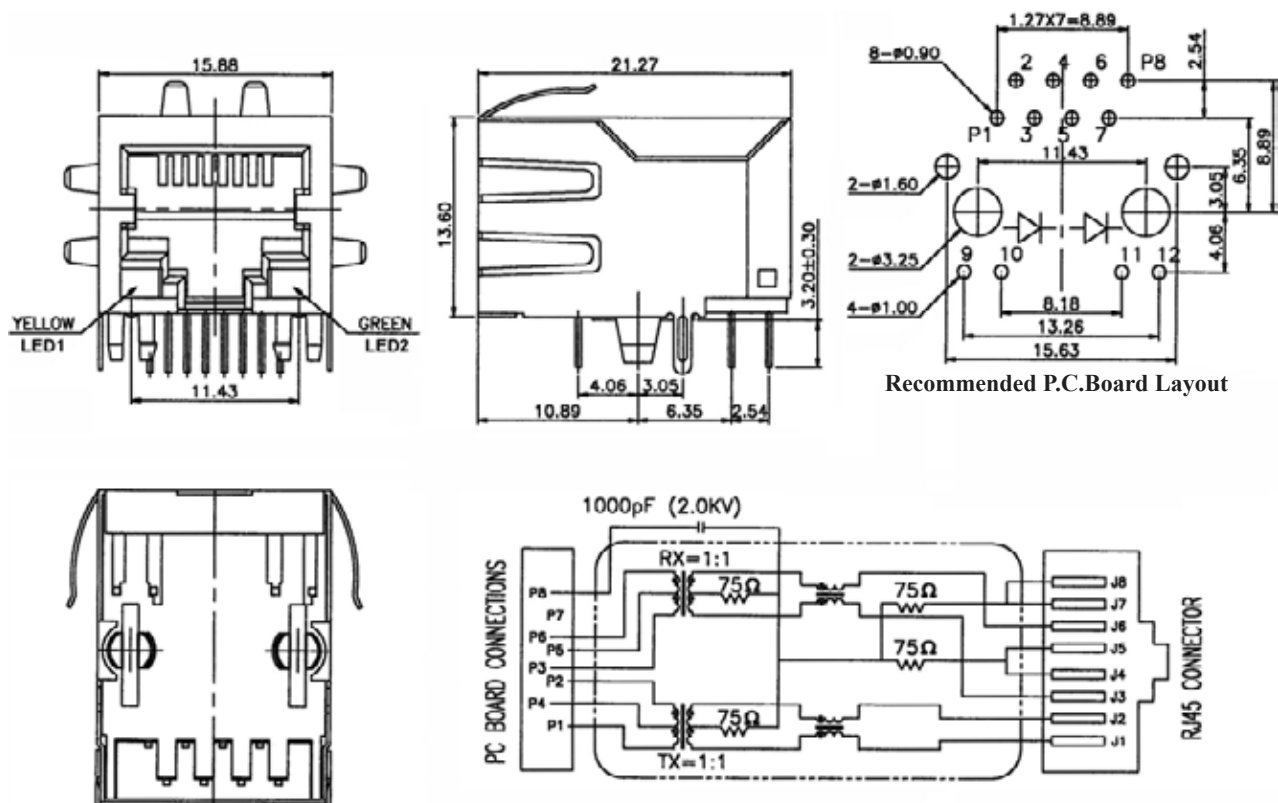
SIDE ENTRY MAGNETIC 10/100 BASE-TX JACK WITH LED 8P PROFILE=13.60MM (FULLY SHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: Nylon (UL 94V-0)
Soldering Temperature: 260°C
Color: Black
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
***RoHS & REACH compliant.**



ORDERING INFORMATION:

P/N L T M 1 - $\frac{88}{1} \frac{x}{2} \frac{B}{3} \frac{0.6}{4} \frac{xx}{4}$

1. NO. OF POSITIONS & CONTACTS:
"88" 8P8C
2. CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD
3. MAGNETIC SCHEMATICS:
06

4. COLORS OF LED:
"NN" LED1: GREEN & LED2: GREEN
"NY" LED1: GREEN & LED2: YELLOW
"YN" LED1: YELLOW & LED2: GREEN
"YY" LED1: YELLOW & LED2: YELLOW
"XX" W/O LED
OTHER LED COLORS UPON REQUEST!

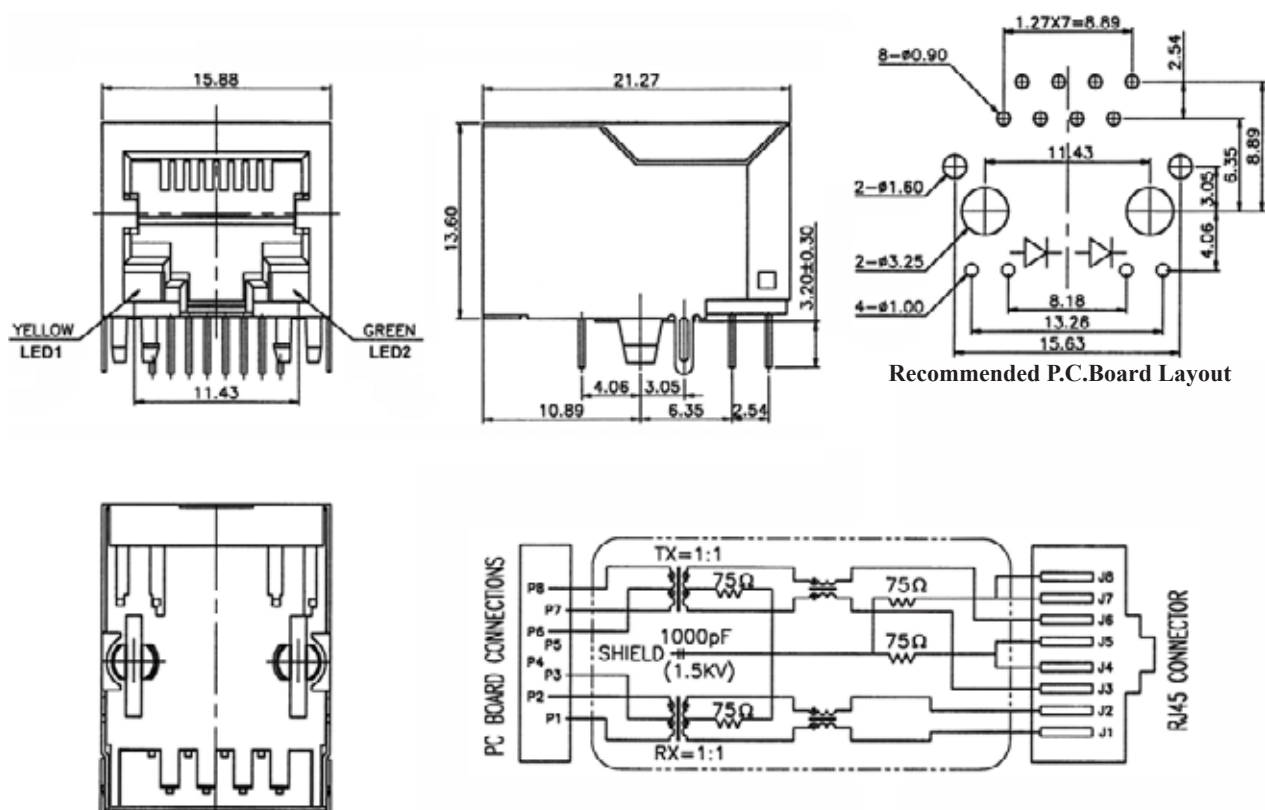
SIDE ENTRY MAGNETIC 10/100 BASE-TX JACK WITH LED 8P PROFILE=13.60MM (FULLY SHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: Nylon (UL 94V-0)
Soldering Temperature: 260°C
Color: Black
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
***RoHS & REACH compliant.**



ORDERING INFORMATION:

P/N L T M 2 - $\frac{88}{1} \frac{x}{2} \frac{B}{3} \frac{01}{4} \frac{xx}{4}$

1. NO. OF POSITIONS & CONTACTS:
"88" 8P8C
2. CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD
3. MAGNETIC SCHEMATICS:
01

4. COLORS OF LED:
"NN" LED1: GREEN & LED2: GREEN
"NY" LED1: GREEN & LED2: YELLOW
"YN" LED1: YELLOW & LED2: GREEN
"YY" LED1: YELLOW & LED2: YELLOW
"XX" W/O LED
OTHER LED COLORS UPON REQUEST!

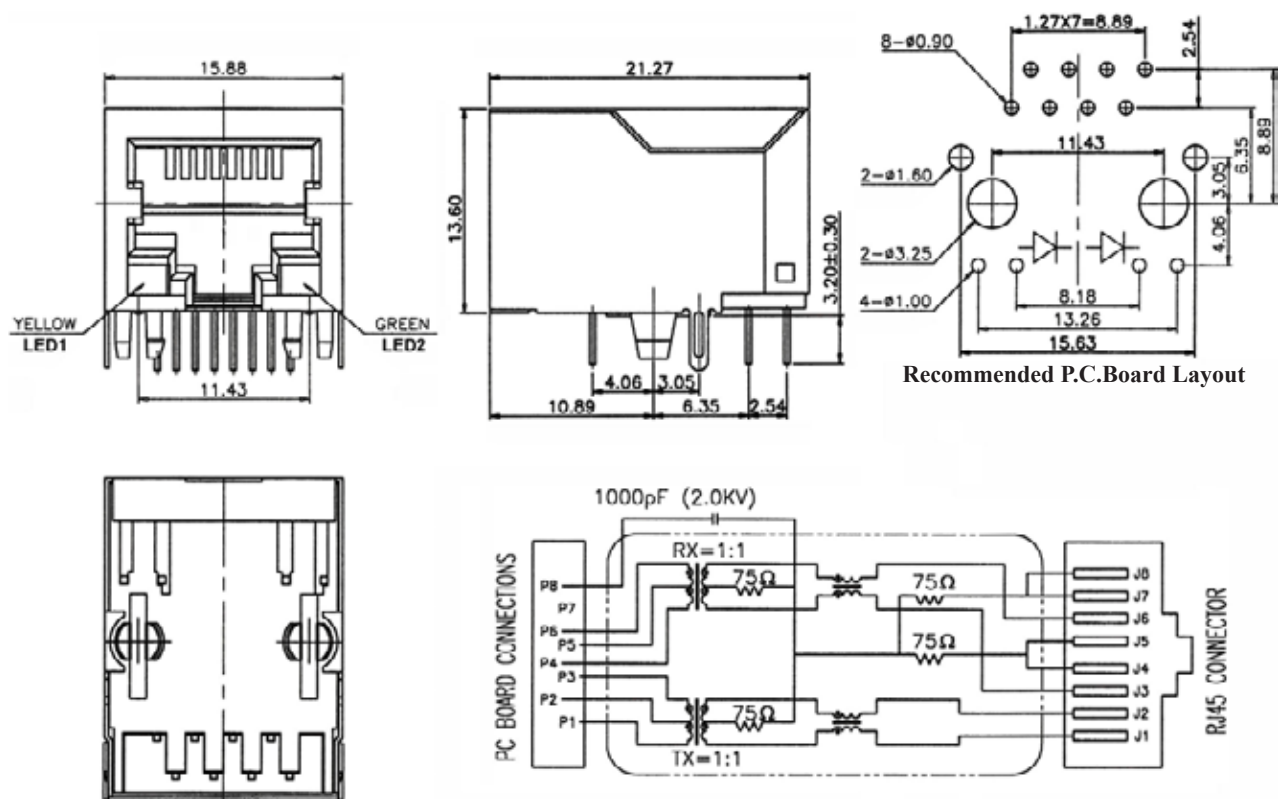
SIDE ENTRY MAGNETIC 10/100 BASE-TX JACK WITH LED 8P PROFILE=13.60MM (FULLY SHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: Nylon (UL 94V-0)
Soldering Temperature: 260°C
Color: Black
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
***RoHS & REACH compliant.**



ORDERING INFORMATION:

P/N L T M 2 - $\frac{88}{1} \frac{x}{2} \frac{B}{3} \frac{02}{4} \frac{xx}{4}$

1. NO. OF POSITIONS & CONTACTS:
"88" 8P8C
2. CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD
3. MAGNETIC SCHEMATICS:
02

4. COLORS OF LED:
"NN" LED1: GREEN & LED2: GREEN
"NY" LED1: GREEN & LED2: YELLOW
"YN" LED1: YELLOW & LED2: GREEN
"YY" LED1: YELLOW & LED2: YELLOW
"XX" W/O LED
OTHER LED COLORS UPON REQUEST!

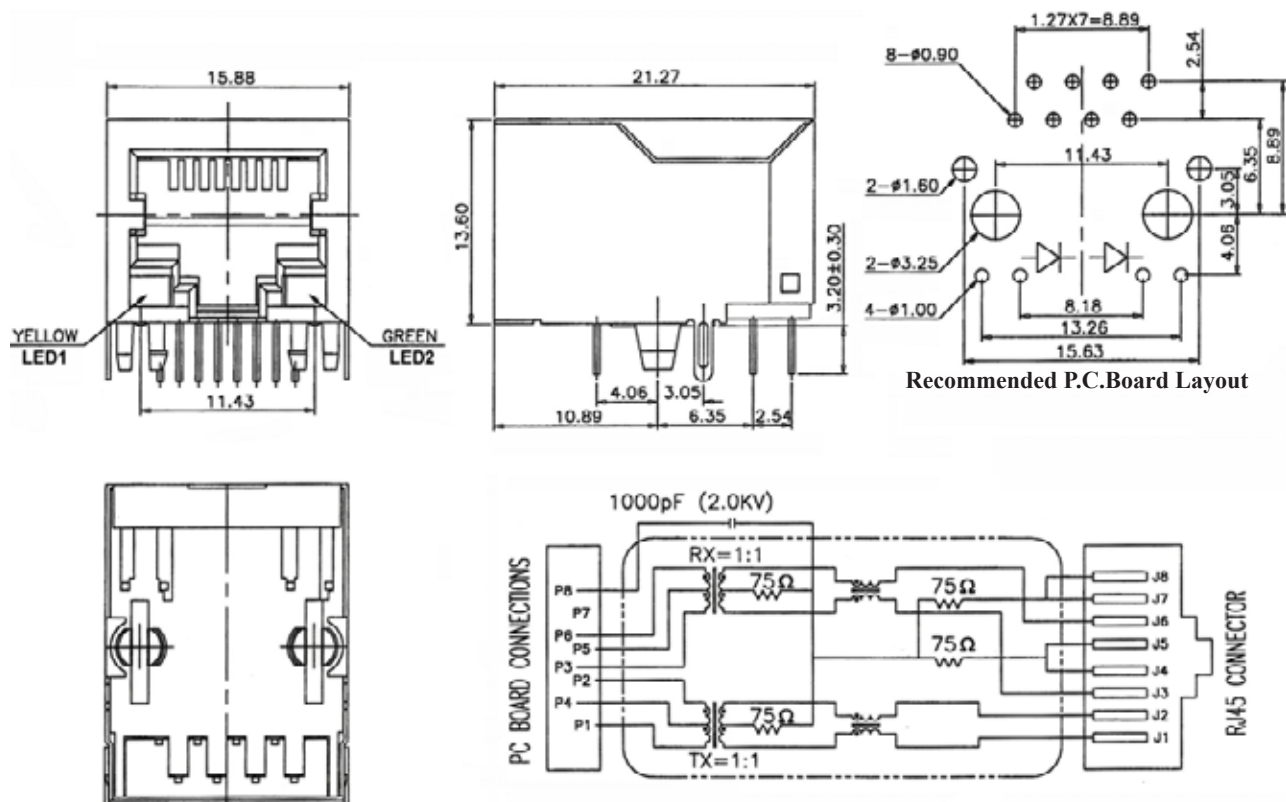
SIDE ENTRY MAGNETIC 10/100 BASE-TX JACK WITH LED 8P PROFILE=13.60MM (FULLY SHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: Nylon (UL 94V-0)
Soldering Temperature: 260°C
Color: Black
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
***RoHS & REACH compliant.**



ORDERING INFORMATION:

P/N L T M 2 - $\frac{88}{12}$ x B $\frac{06}{3}$ x X

- NO. OF POSITIONS & CONTACTS:
"88" 8P8C
- CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD
- MAGNETIC SCHEMATICS:
06

- COLORS OF LED:
"NN" LED1: GREEN & LED2: GREEN
"NY" LED1: GREEN & LED2: YELLOW
"YN" LED1: YELLOW & LED2: GREEN
"YY" LED1: YELLOW & LED2: YELLOW
"XX" W/O LED
OTHER LED COLORS UPON REQUEST!

SIDE ENTRY MAGNETIC 10/100 BASE-TX JACK WITHOUT LED 8P PROFILE=13.60MM (FULLY SHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: Nylon (UL 94V-0)

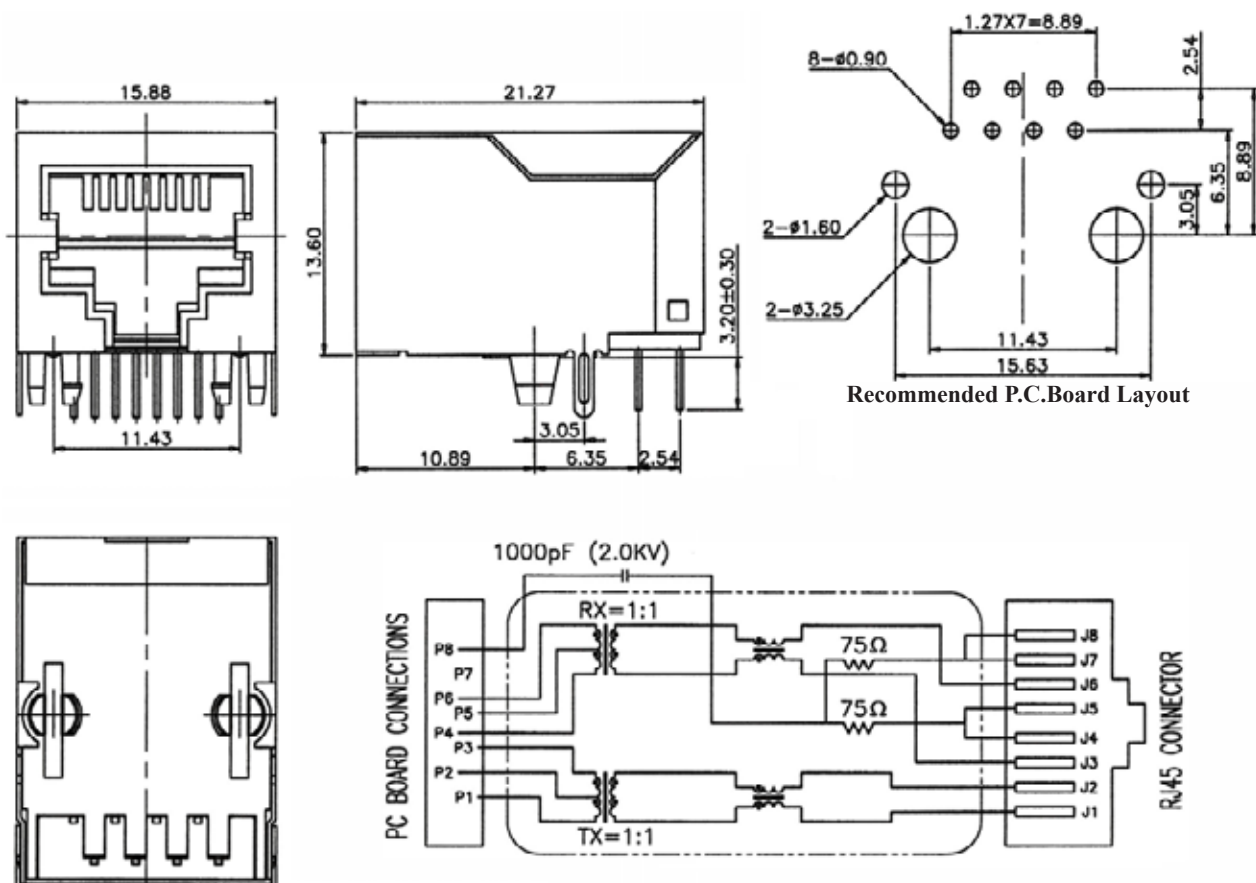
Soldering Temperature: 260°C

Color: Black

Spring Wire: Phosphor Bronze

Gold plating Over Nickel

*RoHS & REACH compliant.



ORDERING INFORMATION:

P/N L T M 2 - $\frac{88}{1} \times \frac{B}{2} \frac{18}{3}$

1. NO. OF POSITIONS & CONTACTS:
"88" 8P8C
2. CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD
3. MAGNETIC SCHEMATICS:
18

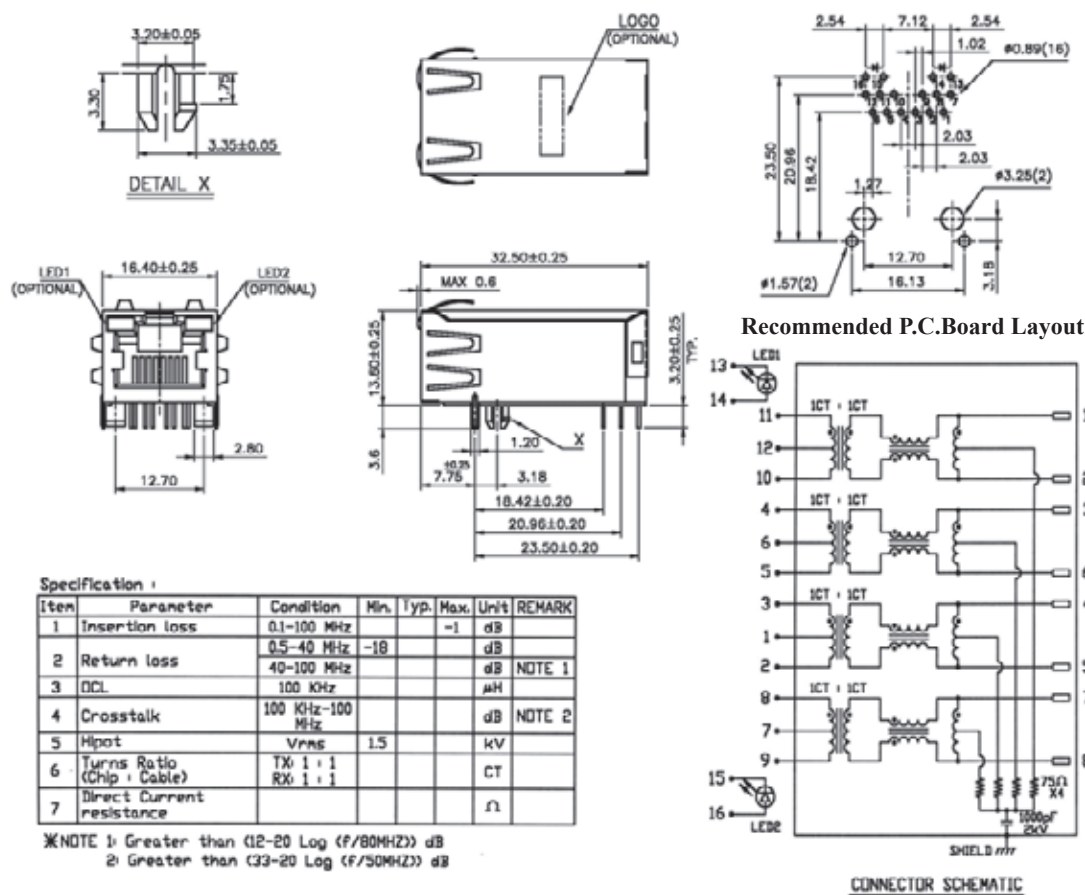
SIDE ENTRY UP LATCH MAGNETIC 10/100/1000 (GIGABIT) BASE-TX RJ45 JACK WITH LED 8P PROFILE=13.60MM (FULLY SHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Black
Spring Wire: Phosphor Bronze
Gold plating Over Nickel
*RoHS & REACH compliant.



TRANSFORMER TYPE T1

ORDERING INFORMATION:

P/N L T G A - $\frac{88}{12} \times \frac{B}{3} \frac{T1}{4} \frac{xx}{4}$

- NO. OF POSITIONS & CONTACTS:
"88" 8P8C
- CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD
- MAGNETIC SCHMATICS:
T1
- TYPE OF LED POLARITY:
(LED PIN DIRECTION FROM LEFT TO RIGHT)
1N, 1Y, 1Z, 5S, 58, 5Q, 8S, MM, MY, MZ, N5, NN,
NY, NZ, Q5, Y1, Y2, YM, YN, Z1, Z2, ZM, ZN

LED Designation:

Code	+/-	-/+	Code	+/-	-/+
N	Green	—	M	—	Green
Y	Yellow	—	Z	—	Yellow
8	Orange	—	Q	—	Orange
1	Green	Orange	2	Orange	Green
5	Green	Yellow	6	Yellow	Green

SIDE ENTRY MAGNETIC 10/100 BASE-TX JACK WITHOUT LED 10P PROFILE=13.60MM (FULLY SHIELDED)

MATERIALS

Housing: High Temperature Thermoplastic UL 94V-0, Black

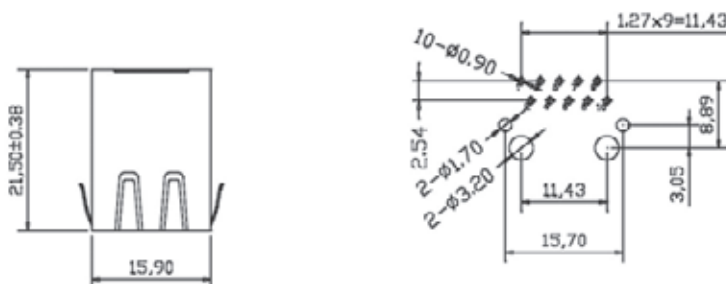
Contacts: 0.35mm Phosphor Bronze Plated,

Gold Plated on Contact Area

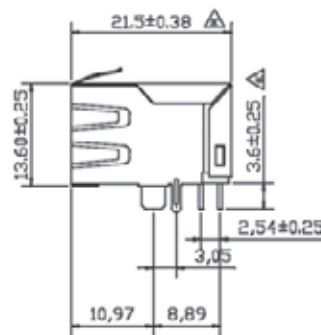
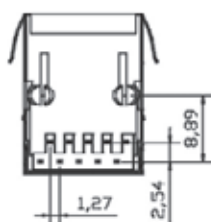
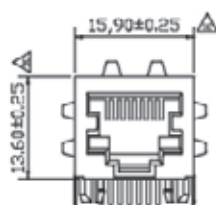
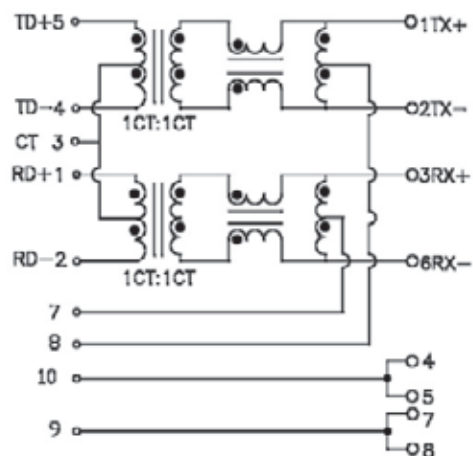
Solder Tin in Solder Area

Shield: 0.20mm Copper Alloy with Nickel

*RoHS & REACH compliant.



Recommended P.C.Board Layout



ORDERING INFORMATION:

P/N L T A B - $\frac{08}{1} \times \frac{B}{2} \frac{99}{3}$

1. NO. OF POSITIONS & CONTACTS:

"08" 10P8C

2. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

"E" GOLD FLASH

3. MAGNETIC SCHEMATICS:

99

SIDE ENTRY MAGNETIC 10/100 & 10/100/1000 BASE-TX JACK WITH LED 8P PROFILE=13.60MM (FULLY SHIELDED)

MATERIALS

Housing: PBT UL 94V-0, Black

Shell: Brass C2680 T=0.20, 85u"~135u" Ni Plated

RJ45 Terminal: Phosphor Bronze T=0.30mm,

Gold Au Plated on Contact Area

80u"~160u" Tin Plated on Solder Area

50u"~100u" Ni Underplated overall

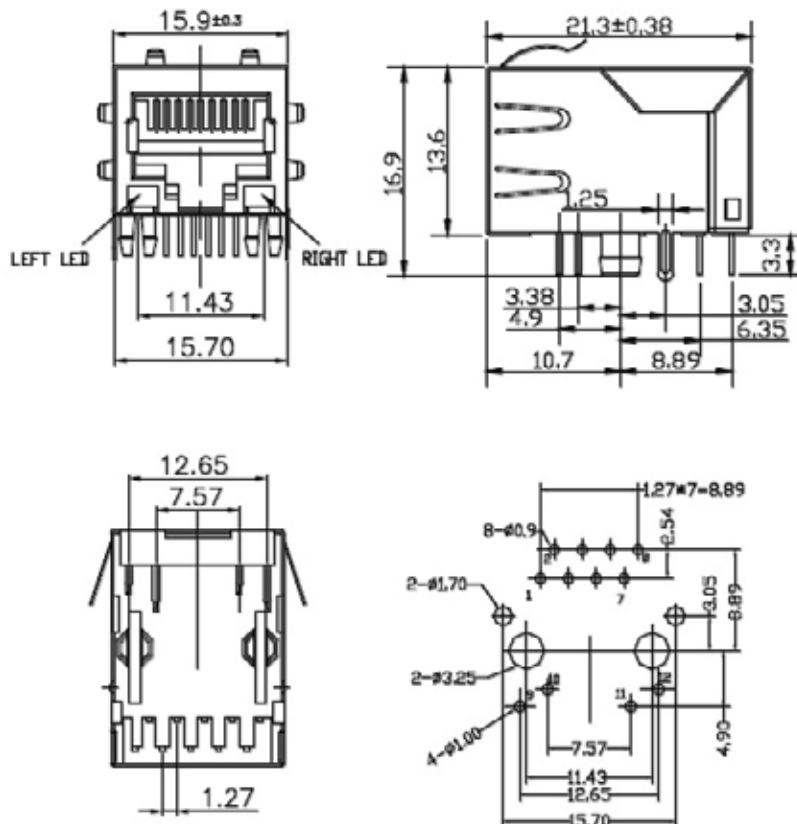
Other Terminal: Brass T=0.30mm, 80u"~160u" Tin Plated

50u"~100u" Ni Underplated overall

*RoHS & REACH compliant.

LED Designation:

Code	+/-	-/+	Code	+/-	-/+
N	Green	—	M	—	Green
Y	Yellow	—	Z	—	Yellow
8	Orange	—	Q	—	Orange
1	Green	Orange	2	Orange	Green
5	Green	Yellow	6	Yellow	Green



Recommended P.C.Board Layout

ORDERING INFORMATION:

P/N L T x x - 8 8 x B x x x x

1. TYPE OF PANEL GROUNDS:

"09" NO TAB

"10" TOP TABS

"11" SIDE TABS

"12" TOP TABS & SIDE TABS

2. NO. OF POSITIONS & CONTACTS:

"88" 8P8C

3. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

4. MAGNETIC SCHEMATICS:

10/100 BASE-TX

51, 52, 53, 54, 55, 56, 57, 58, 59, 60, 61,

62, 63, 64, 65, 66, 67, 68, 69, 70, 73

10/100/1000 BASE-TX

G1, G3, G4, G6, G7, G8, G9, H0

SEE PAGE N5902~N5906 & N5941~N5943!

5. TYPE OF LED POLARITY:

(LED PIN DIRECTION FROM LEFT TO RIGHT)

1N, 1Y, 1Z, 55, 58, 5Q, 85, MM, MY, MZ, N5, NN,

NY, NZ, Q5, Y1, Y2, YM, YN, Z1, Z2, ZM, ZN

NOTE: LED PINS ARE OBLIQUE.

SIDE ENTRY MAGNETIC 10/100 & 10/100/1000 BASE-TX JACK WITH LED 10P PROFILE=13.60MM (FULLY SHIELDED)

MATERIALS

Housing: PBT UL 94V-0, Black

Shell: Brass C2680 T=0.20, 85u"~135u" Ni Plated

RJ45 Terminal: Phosphor Bronze T=0.30mm,

Gold Au Plated on Contact Area

80u"~160u" Tin Plated on Solder Area

50u"~100u" Ni Underplated overall

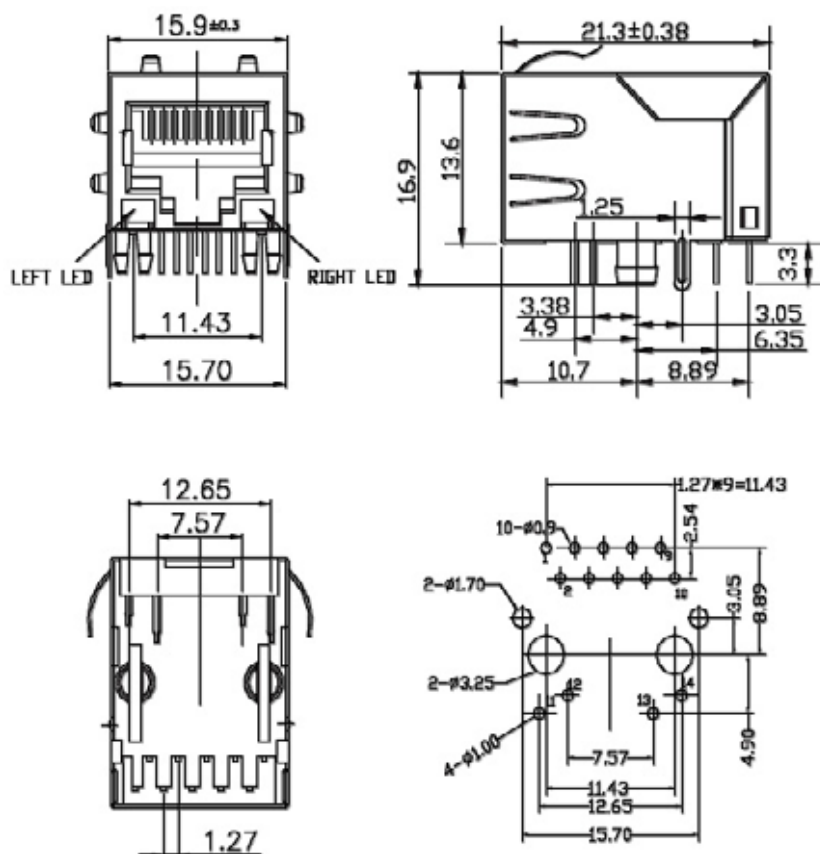
Other Terminal: Brass T=0.30mm, 80u"~160u" Tin Plated

50u"~100u" Ni Underplated overall

*RoHS & REACH compliant.

LED Designation:

Code	+/-	-/+	Code	+/-	-/+
N	Green	—	M	—	Green
Y	Yellow	—	Z	—	Yellow
8	Orange	—	Q	—	Orange
1	Green	Orange	2	Orange	Green
5	Green	Yellow	6	Yellow	Green



Recommended P.C.Board Layout

ORDERING INFORMATION:

P/N L T $\frac{x}{1} - \frac{0.8}{2} \frac{x}{3} B \frac{x}{4} \frac{x}{5}$

1. TYPE OF PANEL GROUNDS:

"09" NO TAB

"10" TOP TABS

"11" SIDE TABS

"12" TOP TABS & SIDE TABS

2. NO. OF POSITIONS & CONTACTS:

"08" 10P8C

3. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

4. MAGNETIC SCHEMATICS:

10/100 BASE-TX

51, 52, 53, 54, 55, 56, 57, 58, 59, 60, 61,
62, 63, 64, 65, 66, 67, 68, 69, 70, 73

10/100/1000 BASE-TX

G1, G3, G4, G6, G7, G8, G9, H0

SEE PAGE N5902~N5906 & N5941~N5943!

5. TYPE OF LED POLARITY:

(LED PIN DIRECTION FROM LEFT TO RIGHT)

1N, 1Y, 1Z, 55, 58, 5Q, 85, MM, MY, MZ, N5, NN,
NY, NZ, Q5, Y1, Y2, YM, YN, Z1, Z2, ZM, ZN

NOTE: LED PINS ARE OBLIQUE.

tel. 02.3361.1626 info@elitaliaweb.it
fax 02.2626.1009 www.elitaliaweb.it

SIDE ENTRY 4-PORT MAGNETIC 10/100 & 10/100/1000 BASE-TX JACK WITHOUT LED 8P PROFILE=13.60MM (FULLY SHIELDED)

MATERIALS

Housing: PBT UL 94V-0, Black

Shell: Brass C2680 T=0.20, 85u"~135u" Ni Plated

RJ45 Terminal: Phosphor Bronze T=0.30mm,

Gold Au Plated on Contact Area

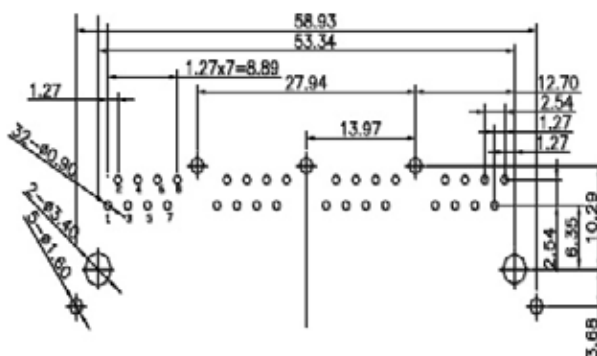
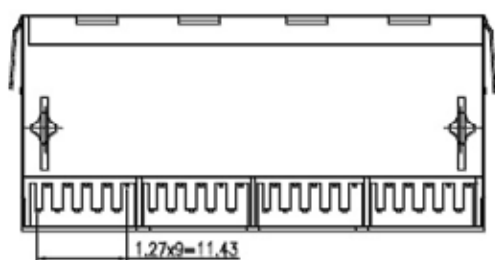
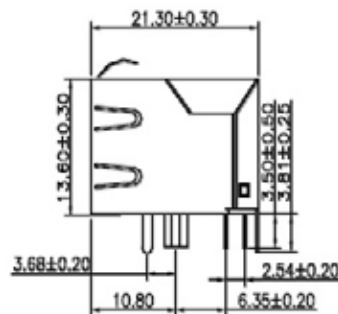
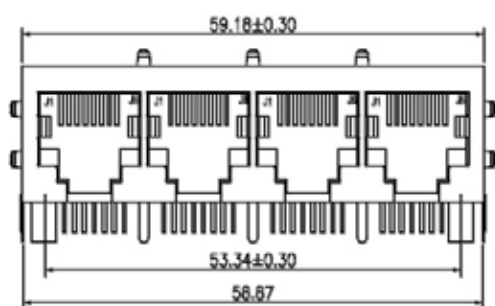
80u"~160u" Tin Plated on Solder Area

50u"~100u" Ni Underplated overall

Other Terminal: Brass T=0.30mm, 80u"~160u" Tin Plated

50u"~100u" Ni Underplated overall

*RoHS & REACH compliant.



Recommended P.C.Board Layout

ORDERING INFORMATION:

P/N L T $\frac{x}{1}$ - $\frac{8}{2}$ $\frac{8}{3}$ B $\frac{x}{4}$ $\frac{0}{5}$

1. TYPE OF PANEL GROUNDS:

"61" NO TAB

"62" TOP TABS

"63" SIDE TABS

"64" TOP TABS & SIDE TABS

2. NO. OF POSITIONS & CONTACTS:

"88" 8P8C

3. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

4. MAGNETIC SCHEMATICS:

10/100 BASE-TX

51, 52, 53, 54, 55, 56, 58, 59, 60, 63

10/100/1000 BASE-TX

G1, G3, G4, G6, G7, G8, G9, H0

SEE PAGE N5902~N5906 & N5941~N5943!

5. NO. OF PORTS:

04

SIDE ENTRY 8-PORT MAGNETIC 10/100 & 10/100/1000 BASE-TX JACK WITHOUT LED 8P PROFILE=13.60MM (FULLY SHIELDED)

MATERIALS

Housing: PBT UL 94V-0, Black

Shell: Brass C2680 T=0.20, 85u"~135u" Ni Plated

RJ45 Terminal: Phosphor Bronze T=0.30mm,

Gold Au Plated on Contact Area

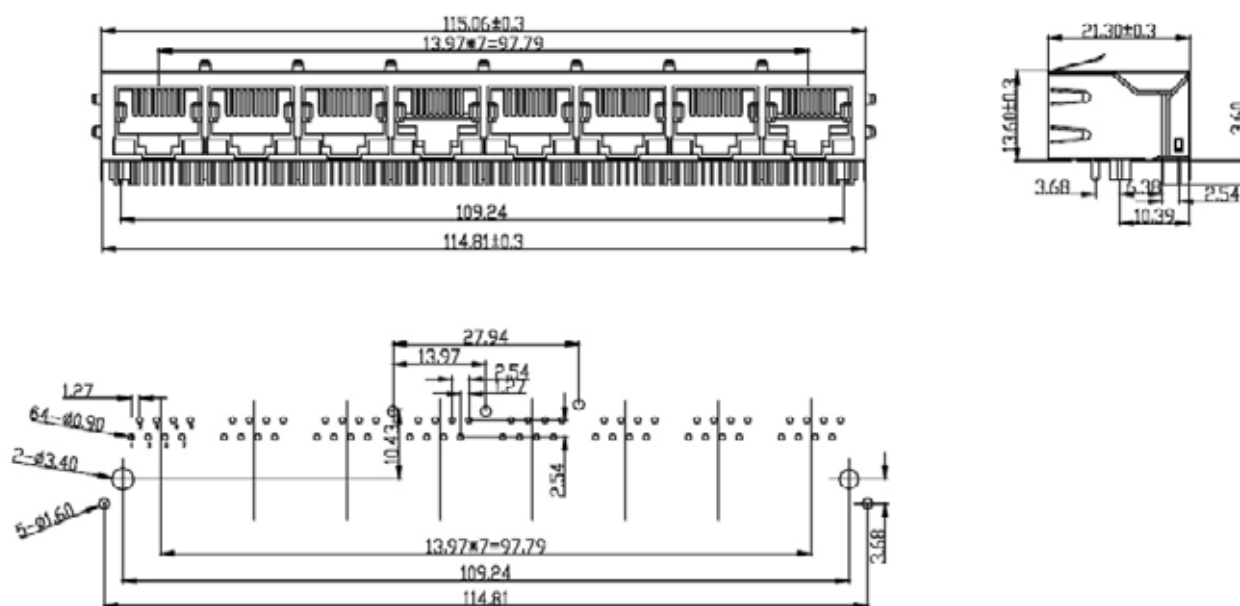
80u"~160u" Tin Plated on Solder Area

50u"~100u" Ni Underplated overall

Other Terminal: Brass T=0.30mm, 80u"~160u" Tin Plated

50u"~100u" Ni Underplated overall

*RoHS & REACH compliant.



Recommended P.C.Board Layout

ORDERING INFORMATION:

P/N L T $\frac{x}{1}$ - $\frac{8}{2}$ $\frac{8}{3}$ B $\frac{x}{4}$ $\frac{0}{5}$

1. TYPE OF PANEL GROUNDS:

"61" NO TAB

"62" TOP TABS

"63" SIDE TABS

"64" TOP TABS & SIDE TABS

2. NO. OF POSITIONS & CONTACTS:

"88" 8P8C

3. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

4. MAGNETIC SCHEMATICS:

10/100 BASE-TX

51, 52, 53, 54, 55, 56, 58, 59, 60, 63

10/100/1000 BASE-TX

G1, G3, G4, G6, G7, G8, G9, H0

SEE PAGE N5902~N5906 & N5941~N5943!

5. NO. OF PORTS:

08

SIDE ENTRY MAGNETIC 10/100 & 10/100/1000 BASE-TX JACK WITHOUT LED 8P PROFILE=13.60MM (FULLY SHIELDED)

MATERIALS

Housing: PBT UL 94V-0, Black

Shell: Brass C2680 T=0.20, 85u"~135u" Ni Plated

RJ45 Terminal: Phosphor Bronze T=0.30mm,

Gold Au Plated on Contact Area

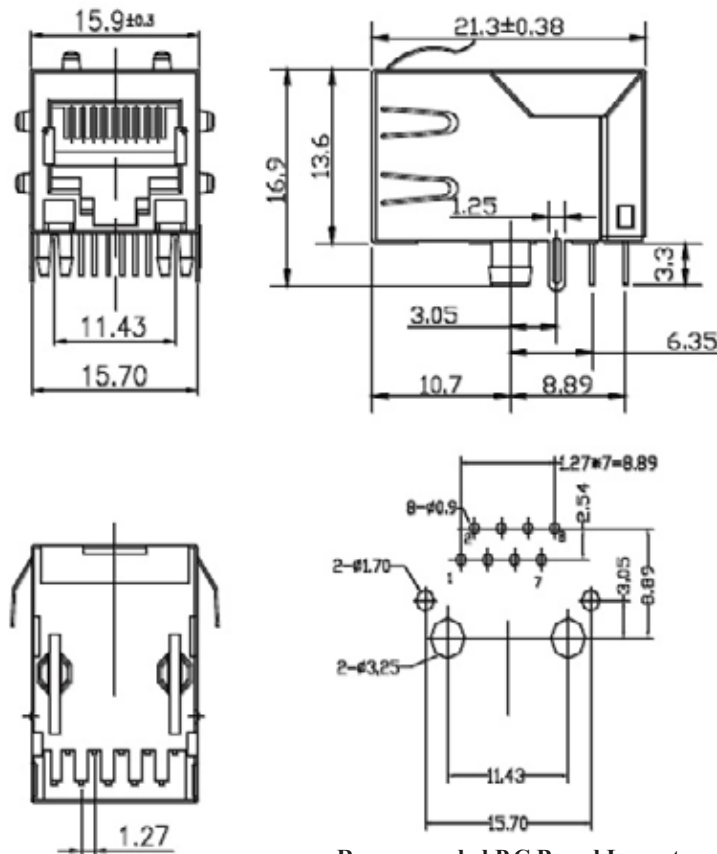
80u"~160u" Tin Plated on Solder Area

50u"~100u" Ni Underplated overall

Other Terminal: Brass T=0.30mm, 80u"~160u" Tin Plated

50u"~100u" Ni Underplated overall

*RoHS & REACH compliant.



Recommended P.C.Board Layout

ORDERING INFORMATION:

P/N L T $\frac{x}{1}$ - $\frac{88}{2}$ $\frac{x}{3}$ B $\frac{x}{4}$

1. TYPE OF PANEL GROUNDS:

"01" NO TAB

"02" TOP TABS

"03" SIDE TABS

"04" TOP TABS & SIDE TABS

2. NO. OF POSITIONS & CONTACTS:

"88" 8P8C

3. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

4. MAGNETIC SCHEMATICS:

10/100 BASE-TX

51, 52, 53, 54, 55, 56, 57, 58, 59, 60, 61,

62, 63, 64, 65, 66, 67, 68, 69, 70, 73

10/100/1000 BASE-TX

G1, G3, G4, G6, G7, G8, G9, H0

SEE PAGE N5902~N5906 & N5941~N5943!

SIDE ENTRY UP LATCH MAGNETIC 10/100 & 10/100/1000 BASE-TX JACK WITH LED 8P PROFILE=13.60MM (FULLY SHIELDED)

MATERIALS

Housing: PBT UL 94V-0, Black

Shell: Brass C2680 T=0.20, 85u"~135u" Ni Plated

RJ45 Terminal: Phosphor Bronze T=0.30mm,

Gold Au Plated on Contact Area

80u"~160u" Tin Plated on Solder Area

50u"~100u" Ni Underplated overall

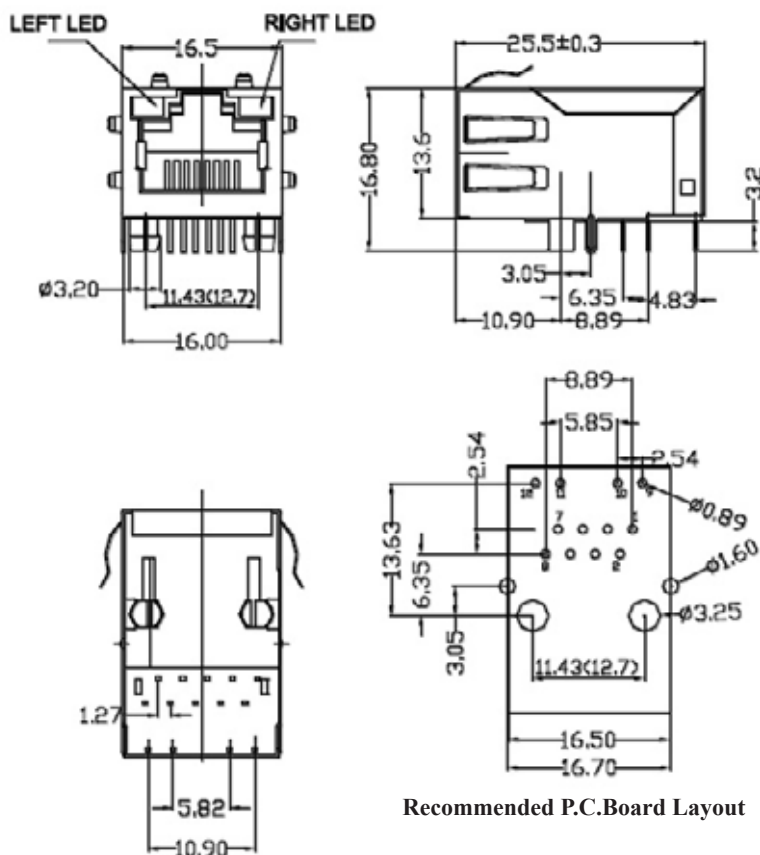
Other Terminal: Brass T=0.30mm, 80u"~160u" Tin Plated

50u"~100u" Ni Underplated overall

*RoHS & REACH compliant.

LED Designation:

Code	+/-	-/+	Code	+/-	-/+
N	Green	—	M	—	Green
Y	Yellow	—	Z	—	Yellow
8	Orange	—	Q	—	Orange
1	Green	Orange	2	Orange	Green
5	Green	Yellow	6	Yellow	Green



Recommended P.C.Board Layout

ORDERING INFORMATION:

P/N L T $\frac{x}{1}$ - $\frac{88}{2}$ $\frac{x}{3}$ B $\frac{x}{4}$ $\frac{x}{5}$

1. TYPE OF PANEL GROUNDS:

"49" NO TAB

"50" TOP TABS

"51" SIDE TABS

"52" TOP TABS & SIDE TABS

2. NO. OF POSITIONS & CONTACTS:

"88" 8P8C

3. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

4. MAGNETIC SCHEMATICS:

10/100 BASE-TX

51, 52, 53, 54, 55, 56, 58, 59, 60, 61, 62,
63, 64, 73, 74, 81

10/100/1000 BASE-TX

G1, G3, G4, G6, G7, G8, G9, H0, J2, J9

SEE PAGE N5902~N5906 & N5941~N5943!

5. TYPE OF LED POLARITY:

(LED PIN DIRECTION FROM LEFT TO RIGHT)

1N, 1Y, 1Z, 55, 58, 5Q, 85, MM, MY, MZ, N5, NN,
NY, NZ, Q5, Y1, Y2, YM, YN, Z1, Z2, ZM, ZN

NOTE: LED PINS ARE PARALLEL.

SIDE ENTRY UP LATCH MAGNETIC 10/100 & 10/100/1000 BASE-TX JACK WITH LED 10P PROFILE=13.60MM (FULLY SHIELDED)

MATERIALS

Housing: PBT UL 94V-0, Black

Shell: Brass C2680 T=0.20, 85u"~135u" Ni Plated

RJ45 Terminal: Phosphor Bronze T=0.30mm,

Gold Au Plated on Contact Area

80u"~160u" Tin Plated on Solder Area

50u"~100u" Ni Underplated overall

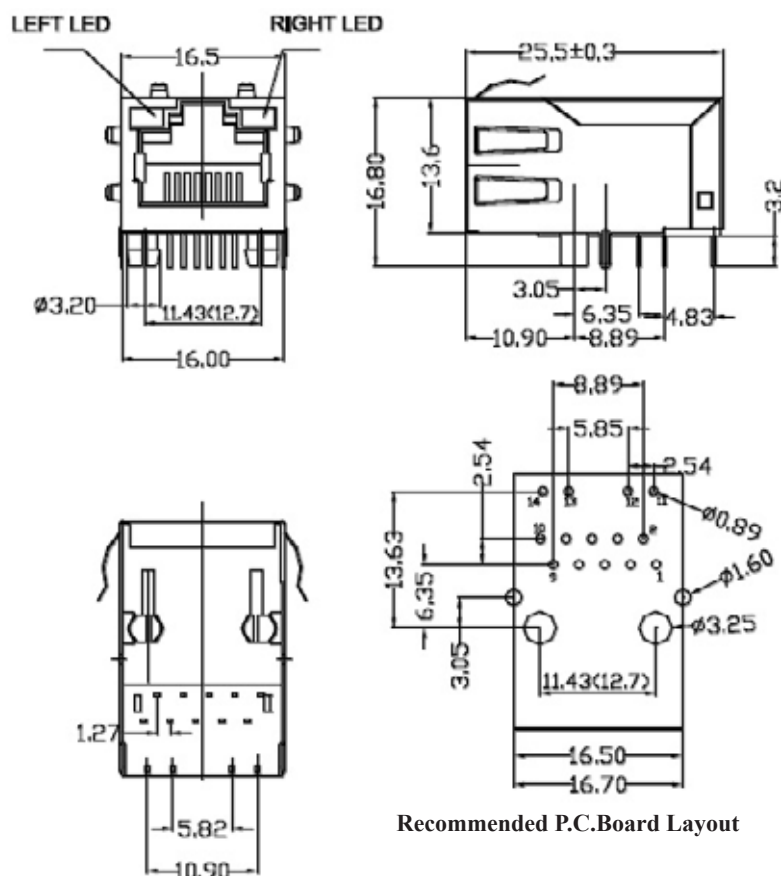
Other Terminal: Brass T=0.30mm, 80u"~160u" Tin Plated

50u"~100u" Ni Underplated overall

*RoHS & REACH compliant.

LED Designation:

Code	+/-	-/+	Code	+/-	-/+
N	Green	—	M	—	Green
Y	Yellow	—	Z	—	Yellow
8	Orange	—	Q	—	Orange
1	Green	Orange	2	Orange	Green
5	Green	Yellow	6	Yellow	Green



Recommended P.C.Board Layout

ORDERING INFORMATION:

P/N L T $\frac{x}{1}$ - $\frac{0.8}{2}$ $\frac{x}{3}$ B $\frac{x}{4}$ $\frac{x}{5}$

1. TYPE OF PANEL GROUNDS:

"49" NO TAB

"50" TOP TABS

"51" SIDE TABS

"52" TOP TABS & SIDE TABS

2. NO. OF POSITIONS & CONTACTS:

"08" 10P8C

3. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

4. MAGNETIC SCHEMATICS:

10/100 BASE-TX

51, 52, 53, 54, 55, 56, 58, 59, 60, 61, 62,
63, 64, 73, 74, 81

10/100/1000 BASE-TX

G1, G3, G4, G6, G7, G8, G9, H0, J2, J9

SEE PAGE N5902~N5906 & N5941~N5943!

5. TYPE OF LED POLARITY:

(LED PIN DIRECTION FROM LEFT TO RIGHT)

1N, 1Y, 1Z, 55, 58, 5Q, 85, MM, MY, MZ, N5, NN,
NY, NZ, Q5, Y1, Y2, YM, YN, Z1, Z2, ZM, ZN

NOTE: LED PINS ARE PARALLEL.

SIDE ENTRY UP LATCH MAGNETIC 10/100 & 10/100/1000 BASE-TX JACK WITH LED 6P PROFILE=13.60MM (FULLY SHIELDED)

MATERIALS

Housing: PBT UL 94V-0, Black

Shell: Brass C2680 T=0.20, 85u"~135u" Ni Plated

RJ45 Terminal: Phosphor Bronze T=0.30mm,

Gold Au Plated on Contact Area

80u"~160u" Tin Plated on Solder Area

50u"~100u" Ni Underplated overall

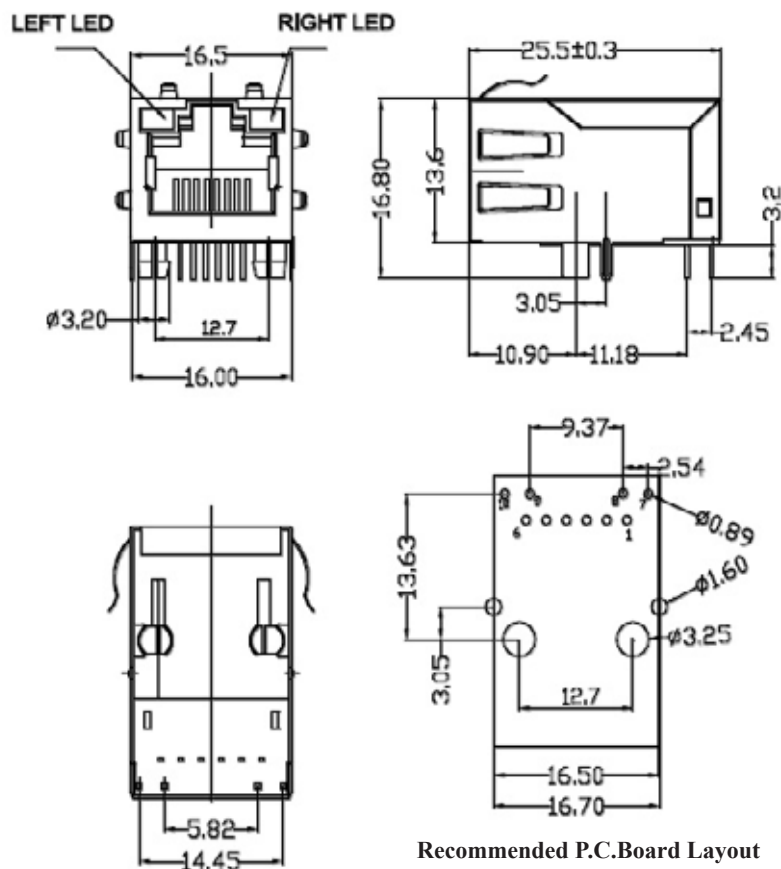
Other Terminal: Brass T=0.30mm, 80u"~160u" Tin Plated

50u"~100u" Ni Underplated overall

*RoHS & REACH compliant.

LED Designation:

Code	+/-	-/+	Code	+/-	-/+
N	Green	—	M	—	Green
Y	Yellow	—	Z	—	Yellow
8	Orange	—	Q	—	Orange
1	Green	Orange	2	Orange	Green
5	Green	Yellow	6	Yellow	Green



Recommended P.C.Board Layout

ORDERING INFORMATION:

P/N L T $\frac{x}{1}$ - $\frac{68}{2}$ x $\frac{3}{3}$ B $\frac{x}{4}$ x $\frac{x}{5}$

1. TYPE OF PANEL GROUNDS:

"49" NO TAB

"50" TOP TABS

"51" SIDE TABS

"52" TOP TABS & SIDE TABS

2. NO. OF POSITIONS & CONTACTS:

"68" 6P8C

3. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

4. MAGNETIC SCHEMATICS:

10/100 BASE-TX

51, 52, 53, 54, 55, 56, 58, 59, 60, 61, 62, 63, 64, 73, 81

10/100/1000 BASE-TX

G1, G3, G4, G6, G7, G8, G9, H0, J2, J9

SEE PAGE N5902~N5906 & N5941~N5943!

5. TYPE OF LED POLARITY:

(LED PIN DIRECTION FROM LEFT TO RIGHT)

1N, 1Y, 1Z, 55, 58, 5Q, 85, MM, MY, MZ, N5, NN, NY, NZ, Q5, Y1, Y2, YM, YN, Z1, Z2, ZM, ZN

NOTE: LED PINS ARE PARALLEL.

tel. 02.3361.1626 info@elitaliaweb.it
fax 02.2626.1009 www.elitaliaweb.it

tel. 02.3361.1626 info@elitaliaweb.it
fax 02.2626.1009 www.elitaliaweb.it

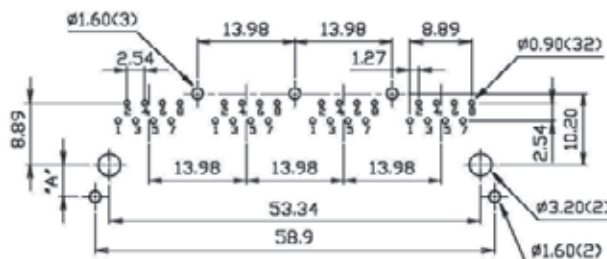
SIDE ENTRY 4-PORT MAGNETIC 10/100 BASE-TX JACK 8P WITHOUT LED PROFILE=13.80MM (FULLY SHIELDED)

SPECIFICATIONS

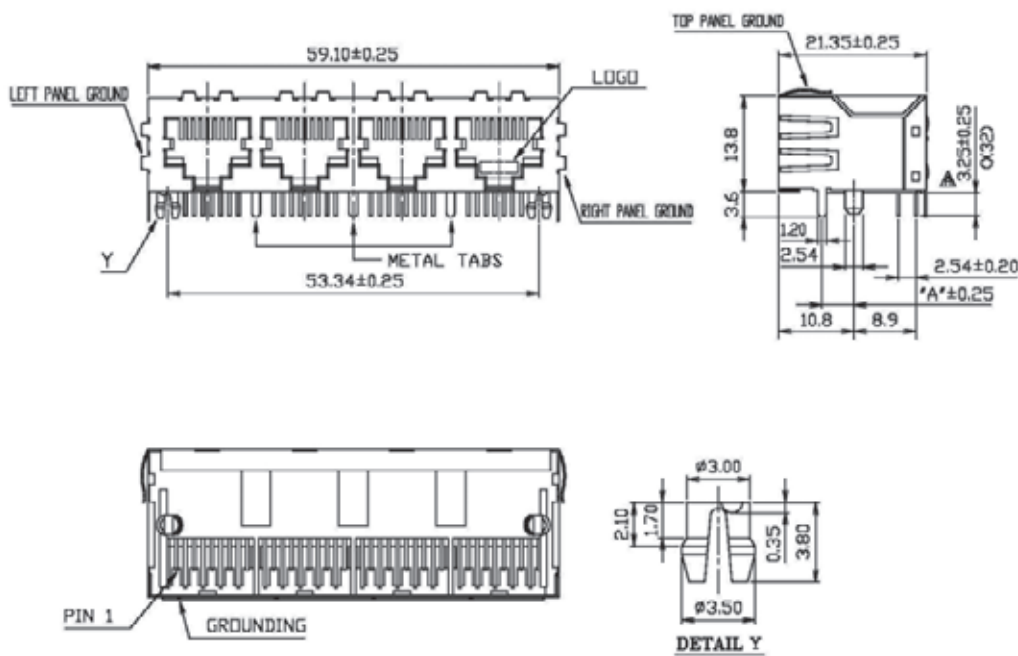
Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Black
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
***RoHS & REACH compliant.**



Recommended P.C.Board Layout



ORDERING INFORMATION:

P/N LT $\frac{xx}{1}$ - 88 $\frac{x}{2}$ $\frac{3}{3}$ B $\frac{xx}{4}$ $\frac{04}{5}$

- MODULAR JACK TYPE:
 "LT" WITH TOP/RIGHT/LEFT SIDE TABS
 "LU" WITH RIGHT/LEFT SIDE TABS
 "LV" WITH TOP SIDE TABS
 "LW" WITHOUT GROUNDING TABS
- NO. OF POSITIONS & CONTACTS:
 "88" 8P8C
- CONTACT FINISH:
 "A" 6 MICROINCH GOLD
 "B" 15 MICROINCH GOLD
 "C" 30 MICROINCH GOLD
 "D" 50 MICROINCH GOLD
- MAGNETIC SCHEMATICS:
 UPON REQUEST! SEE PAGE N5902~N5906!

- NO. OF PORTS:
 04

SIDE ENTRY 4-PORT MAGNETIC 10/100 BASE-TX JACK 8P WITH LED PROFILE=13.80MM (FULLY SHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)

Soldering Temperature: 235°C

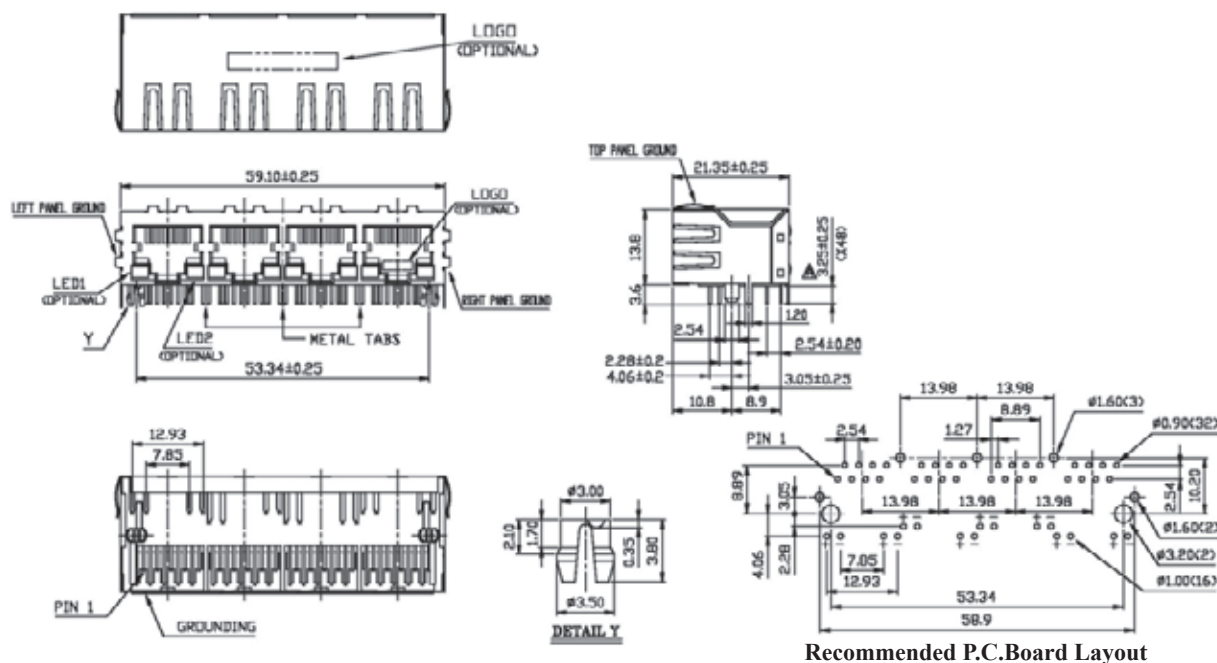
Color: Black

Spring Wire: Phosphor Bronze

Gold plating Over Nickel

Shield: Brass plating Nickel Alloy

*RoHS & REACH compliant.



ORDERING INFORMATION:

P/N L T $\frac{xx}{1}$ - $\frac{88}{2}$ $\frac{x}{3}$ B $\frac{xx}{4}$ $\frac{xx}{5}$ $\frac{04}{6}$

1. TYPE OF PANEL GROUNDS (TABS):

"BJ" NO TABS

"BK" TOP TABS

"BL" SIDE TABS

"BM" TOP TABS & SIDE TABS

2. NO. OF POSITIONS & CONTACTS:

"88" 8P8C

3. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

4. MAGNETIC SHEMATICS:

UPON REQUEST!

SEE PAGE N5902~N5906!

5. COLORS OF LED:

"NN" LED1: GREEN & LED2: GREEN

"NY" LED1: GREEN & LED2: YELLOW

"YN" LED1: YELLOW & LED2: GREEN

"YY" LED1: YELLOW & LED2: YELLOW

"XX" W/O LED

6. NO. OF PORTS:

04

NOTE: OTHER LED COLORS UPON REQUEST!

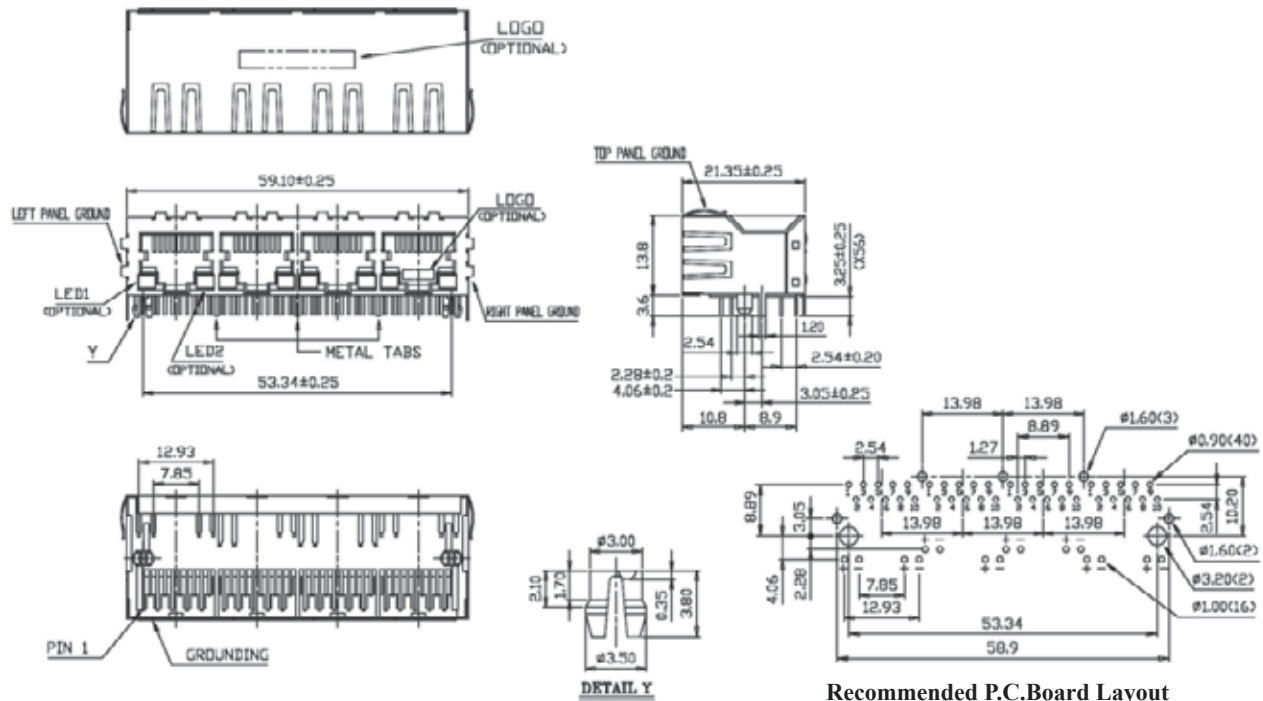
SIDE ENTRY 4-PORT MAGNETIC 10/100 BASE-TX JACK 10P WITH LED PROFILE=13.80MM (FULLY SHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Black
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
Shield: Brass plating Nickel Alloy
***RoHS & REACH compliant.**



ORDERING INFORMATION:

P/N L T $\frac{XX}{1} - \frac{08}{2} \frac{X}{3} B \frac{XX}{4} \frac{XX}{5} \frac{04}{6}$

1. TYPE OF PANEL GROUNDS (TABS):
 "BJ" NO TABS
 "BK" TOP TABS
 "BL" SIDE TABS
 "BM" TOP TABS & SIDE TABS
2. NO. OF POSITIONS & CONTACTS:
 "00" 10P10C
3. CONTACT FINISH:
 "A" 6 MICROINCH GOLD
 "B" 15 MICROINCH GOLD
 "C" 30 MICROINCH GOLD
 "D" 50 MICROINCH GOLD

4. MAGNETIC SHEMATICS:
 UPON REQUEST!
 SEE PAGE N5902~N5906!
5. COLORS OF LED:
 "NN" LED1: GREEN & LED2: GREEN
 "NY" LED1: GREEN & LED2: YELLOW
 "YN" LED1: YELLOW & LED2: GREEN
 "YY" LED1: YELLOW & LED2: YELLOW
 "XX" W/O LED
6. NO. OF PORTS:
 04

NOTE: OTHER LED COLORS UPON REQUEST!

SIDE ENTRY 4-PORT MAGNETIC 10/100 BASE-TX JACK 10P WITHOUT LED 10P PROFILE=13.80MM (FULLY SHIELDED)

SPECIFICATIONS

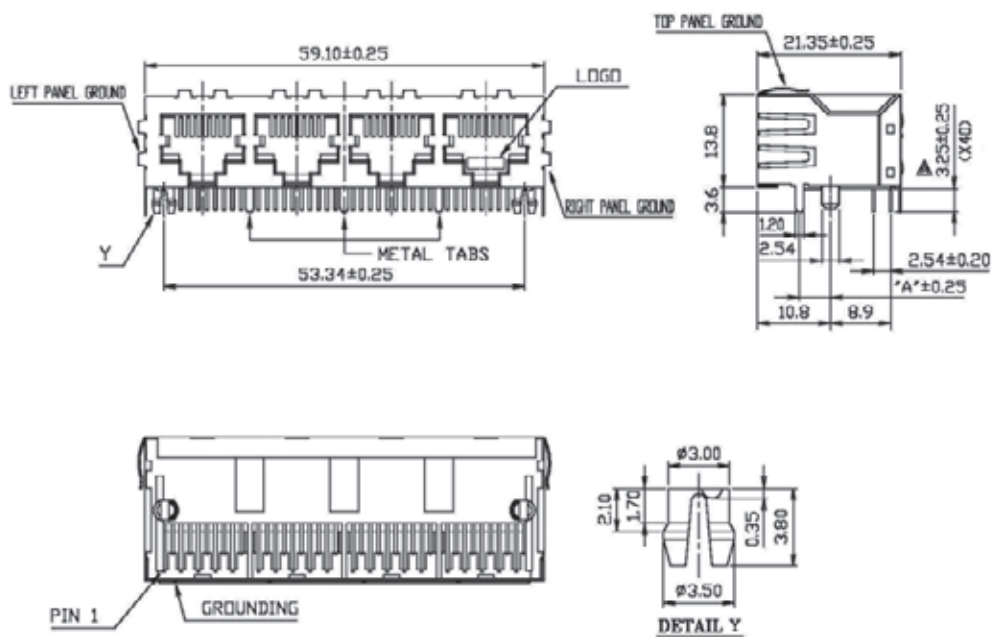
Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Black
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
***RoHS & REACH compliant.**



Recommended P.C.Board Layout



ORDERING INFORMATION:

P/N LT $\frac{x}{1}$ - $\frac{0.8}{2}$ $\frac{x}{3}$ B $\frac{x}{4}$ $\frac{0.4}{5}$

- MODULAR JACK TYPE:
 "LT" WITH TOP/RIGHT/LEFT SIDE TABS
 "LU" WITH RIGHT/LEFT SIDE TABS
 "LV" WITH TOP SIDE TABS
 "LW" WITHOUT GROUNDING TABS
- NO. OF POSITIONS & CONTACTS:
 "08" 10P8C
- CONTACT FINISH:
 "A" 6 MICROINCH GOLD
 "B" 15 MICROINCH GOLD
 "C" 30 MICROINCH GOLD
 "D" 50 MICROINCH GOLD
- MAGNETIC SCHEMATICS:
 UPON REQUEST! SEE PAGE N5902~N5906!

- NO. OF PORTS:
 04

SIDE ENTRY MAGNETIC 10/100 & 10/100/1000 BASE-TX SMT JACK WITH LED 12P PROFILE=11.30MM (FULLY SHIELDED)

MATERIALS

Housing: LCP UL 94V-0, Black

Shell: Brass C2680 T=0.20, 85u"~135u" Ni Plated

RJ45 Terminal: Phosphor Bronze T=0.30mm,

Gold Au Plated on Contact Area

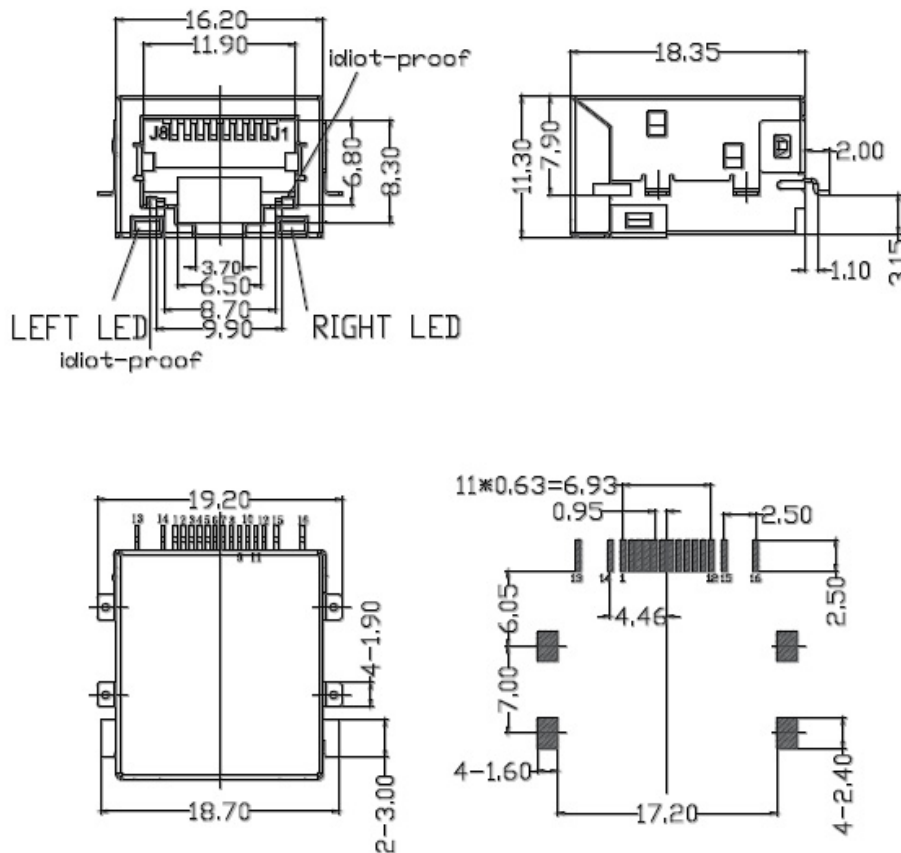
80u"~160u" Tin Plated on Solder Area

50u"~100u" Ni Underplated overall

Other Terminal: Brass T=0.30mm, 80u"~160u" Tin Plated

50u"~100u" Ni Underplated overall

*RoHS & REACH compliant.



Recommended P.C.Board Layout

ORDERING INFORMATION:

P/N LT 15 - $\frac{T}{1} \frac{8}{2} \times \frac{B}{3} \frac{x}{4} \frac{x}{4}$

1. NO. OF POSITIONS & CONTACTS:

"T8" 12P8C

2. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

3. MAGNETIC SCHEMATICS:

10/100 BASE-TX

58, 60, 66, 67, 76, 77, 78, 79, 80

10/100/1000 BASE-TX

G5, H4

SEE PAGE N5902~N5906 & N5941~N5943!

4. TYPE OF LED POLARITY:

(LED PIN DIRECTION FROM LEFT TO RIGHT)

1N, 1Y, 1Z, 55, 58, 5Q, 85, MM, MY, MZ, N5, NN, NY, NZ, Q5, Y1, Y2, YM, YN, Z1, Z2, ZM, ZN

LED Designation:

Code	+/-	-/+	Code	+/-	-/+
N	Green	—	M	—	Green
Y	Yellow	—	Z	—	Yellow
8	Orange	—	Q	—	Orange
1	Green	Orange	2	Orange	Green
5	Green	Yellow	6	Yellow	Green

SIDE ENTRY UP LATCH MAGNETIC 10/100 & 10/100/1000 BASE-TX SMT JACK WITHOUT LED 8P PROFILE=13.40MM (FULLY SHIELDED)

MATERIALS

Housing: LCP UL 94V-0, Black

Shell: Brass C2680 T=0.20, 85u"~135u" Ni Plated

RJ45 Terminal: Phosphor Bronze T=0.30mm,

Gold Au Plated on Contact Area

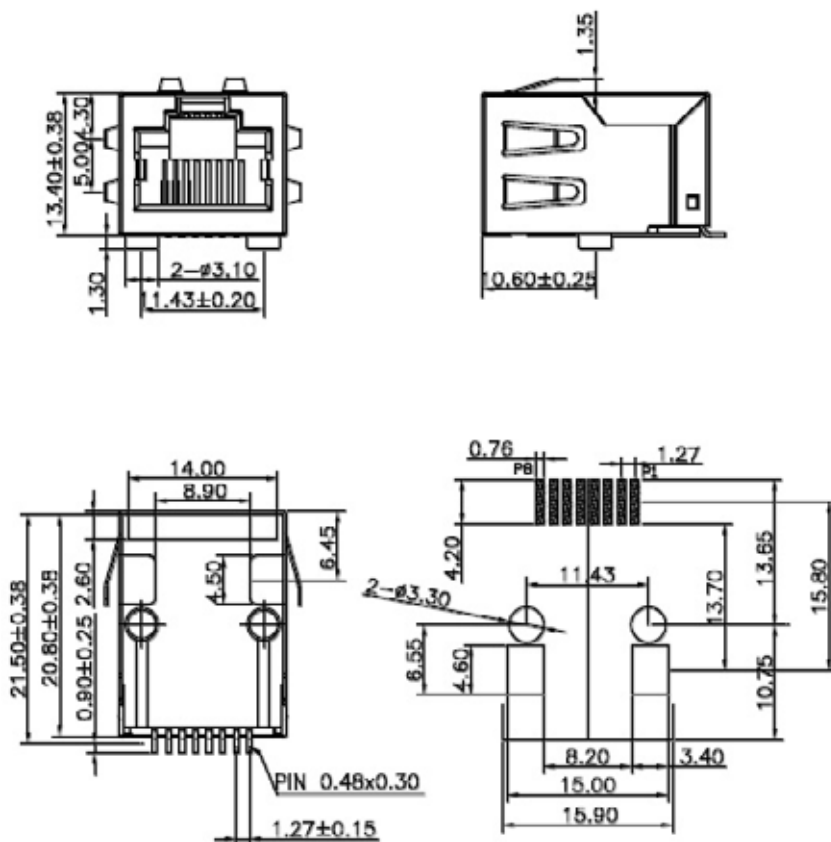
80u"~160u" Tin Plated on Solder Area

50u"~100u" Ni Underplated overall

Other Terminal: Brass T=0.30mm, 80u"~160u" Tin Plated

50u"~100u" Ni Underplated overall

*RoHS & REACH compliant.



Recommended P.C.Board Layout

ORDERING INFORMATION:

P/N L T $\frac{x}{1}$ - 88 $\frac{x}{2}$ B $\frac{x}{3}$ $\frac{x}{4}$

1. TYPE OF PANEL GROUNDS:

"41" NO TAB

"42" TOP TABS

"43" SIDE TABS

"44" TOP TABS & SIDE TABS

2. NO. OF POSITIONS & CONTACTS:

"88" 8P8C

3. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

4. MAGNETIC SCHEMATICS:

10/100 BASE-TX

51, 52, 53, 54, 55, 56, 57, 59, 60, 63

10/100/1000 BASE-TX

G1, G3, G4, G6, G7, G8, G9, H0

SEE PAGE N5902~N5906 & N5941~N5943!

SIDE ENTRY UP LATCH MAGNETIC 10/100 & 10/100/1000 BASE-TX SMT JACK WITH LED 8P PROFILE=13.50MM (FULLY SHIELDED)

MATERIALS

Housing: LCP UL 94V-0, Black

Shell: Brass C2680 T=0.20, 85u"~135u" Ni Plated

RJ45 Terminal: Phosphor Bronze T=0.30mm,

Gold Au Plated on Contact Area

80u"~160u" Tin Plated on Solder Area

50u"~100u" Ni Underplated overall

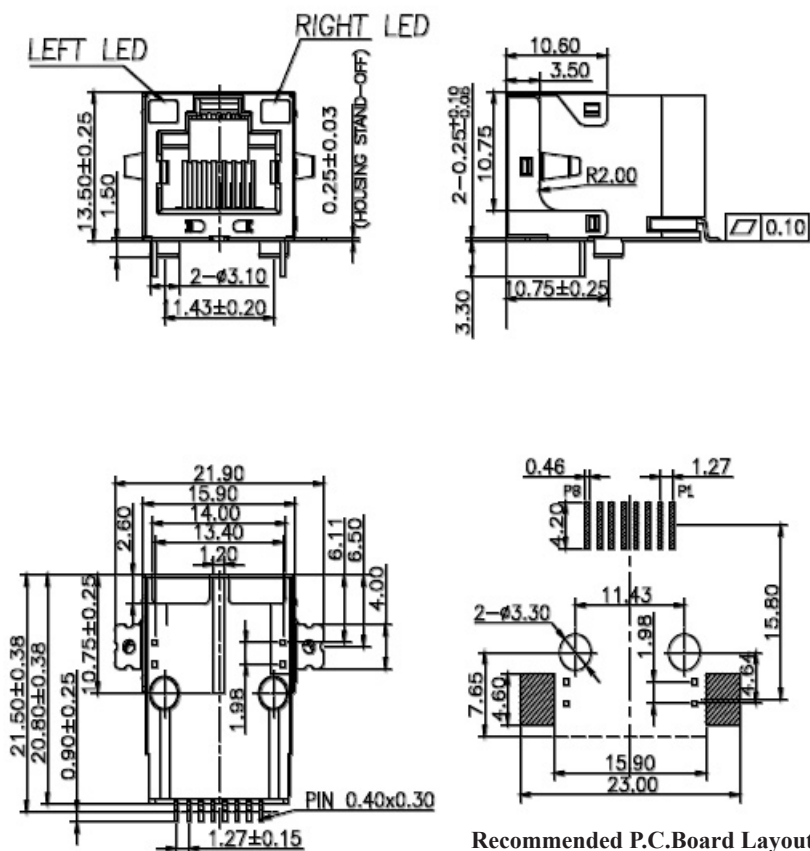
Other Terminal: Brass T=0.30mm, 80u"~160u" Tin Plated

50u"~100u" Ni Underplated overall

*RoHS & REACH compliant.

LED Designation:

Code	+/-	-/+	Code	+/-	-/+
N	Green	—	M	—	Green
Y	Yellow	—	Z	—	Yellow
8	Orange	—	Q	—	Orange
1	Green	Orange	2	Orange	Green
5	Green	Yellow	6	Yellow	Green



Recommended P.C.Board Layout

ORDERING INFORMATION:

P/N L T x x - 8 8 x B x x x x
1 2 3 4 5

1. TYPE OF PANEL GROUNDS:

"45" NO TAB

"46" TOP TABS

"47" SIDE TABS

"48" TOP TABS & SIDE TABS

2. NO. OF POSITIONS & CONTACTS:

"88" 8P8C

3. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

4. MAGNETIC SCHEMATICS:

10/100 BASE-TX

51, 52, 53, 54, 55, 56, 57, 59, 60, 63

10/100/1000 BASE-TX

G1, G3, G4, G6, G7, G8, G9, H0

SEE PAGE N5902~N5906 & N5941~N5943!

5. TYPE OF LED POLARITY:

(LED PIN DIRECTION FROM LEFT TO RIGHT)

1N, 1Y, 1Z, 55, 58, 5Q, 85, MM, MY, MZ, N5, NN,

NY, NZ, Q5, Y1, Y2, YM, YN, Z1, Z2, ZM, ZN

SIDE ENTRY UP LATCH MAGNETIC 10/100 & 10/100/1000 BASE-TX SMT JACK WITHOUT LED 10P PROFILE=13.50MM (FULLY SHIELDED)

MATERIALS

Housing: LCP UL 94V-0, Black

Shell: Brass C2680 T=0.20, 85u"~135u" Ni Plated

RJ45 Terminal: Phosphor Bronze T=0.30mm,

Gold Au Plated on Contact Area

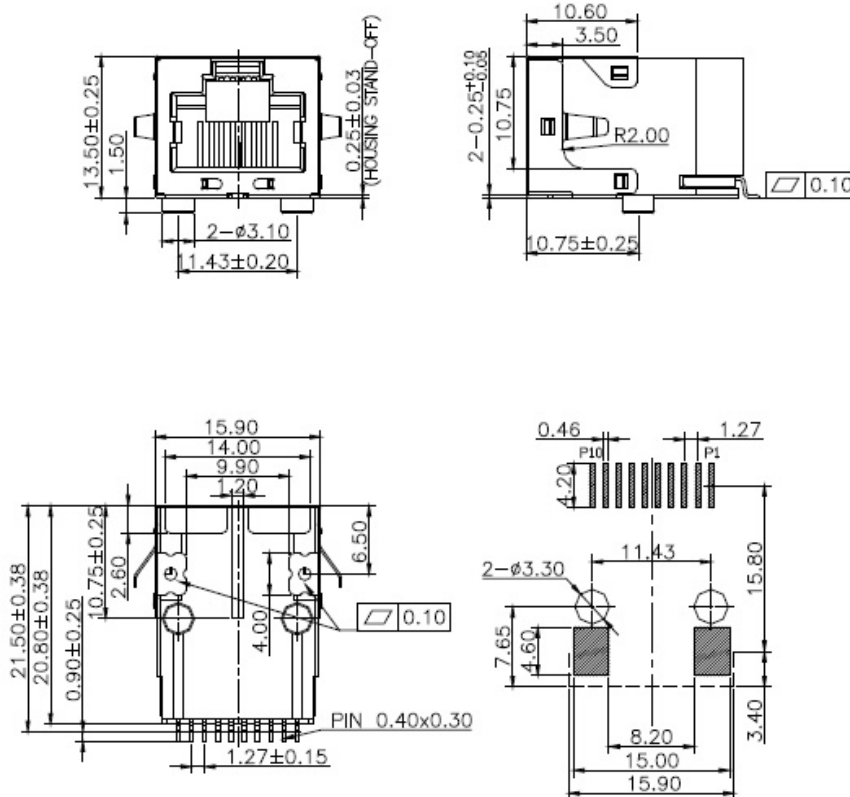
80u"~160u" Tin Plated on Solder Area

50u"~100u" Ni Underplated overall

Other Terminal: Brass T=0.30mm, 80u"~160u" Tin Plated

50u"~100u" Ni Underplated overall

*RoHS & REACH compliant.



Recommended P.C.Board Layout

ORDERING INFORMATION:

P/N L T $\frac{xx}{1}$ - $\frac{08}{2}$ x B $\frac{xx}{3}$ $\frac{xx}{4}$

1. TYPE OF PANEL GROUNDS:

"41" NO TAB

"42" TOP TABS

"43" SIDE TABS

"44" TOP TABS & SIDE TABS

2. NO. OF POSITIONS & CONTACTS:

"08" 10P8C

3. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

4. MAGNETIC SCHEMATICS:

10/100 BASE-TX

51, 52, 53, 54, 55, 56, 57, 59, 60, 63

10/100/1000 BASE-TX

G1, G3, G4, G6, G7, G8, G9, H0

SEE PAGE N5902~N5906 & N5941~N5943!

SIDE ENTRY UP LATCH MAGNETIC 10/100 & 10/100/1000 BASE-TX SMT JACK WITH LED 10P PROFILE=13.50MM (FULLY SHIELDED)

MATERIALS

Housing: LCP UL 94V-0, Black

Shell: Brass C2680 T=0.20, 85u"~135u" Ni Plated

RJ45 Terminal: Phosphor Bronze T=0.30mm,

Gold Au Plated on Contact Area

80u"~160u" Tin Plated on Solder Area

50u"~100u" Ni Underplated overall

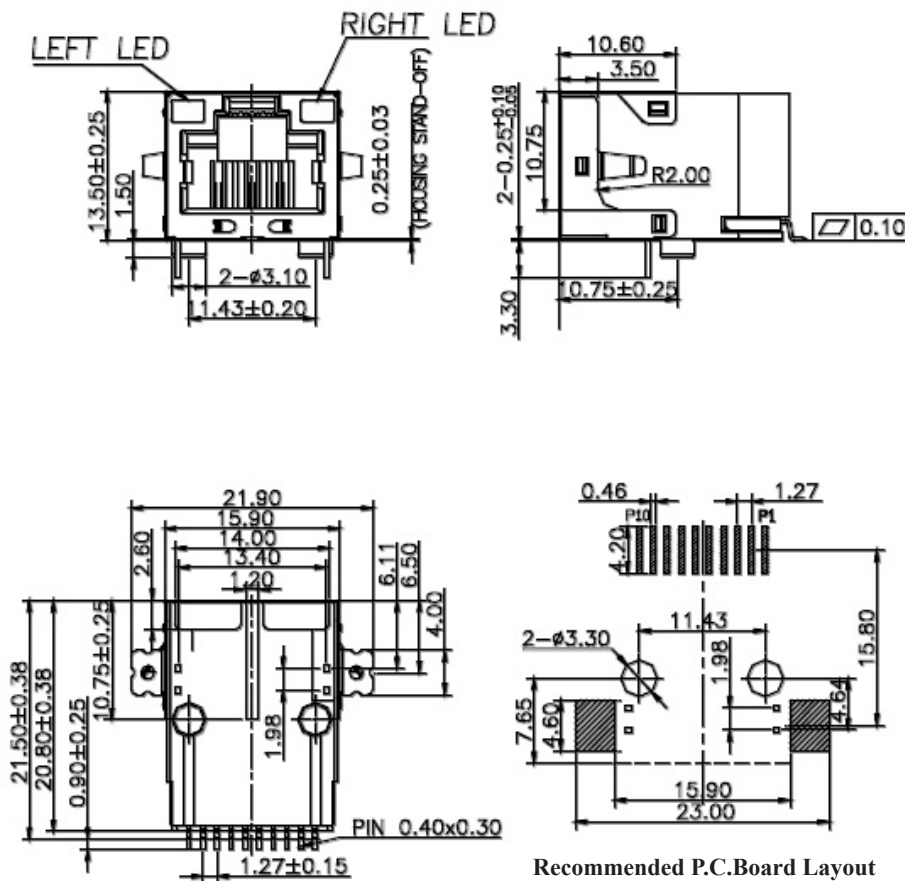
Other Terminal: Brass T=0.30mm, 80u"~160u" Tin Plated

50u"~100u" Ni Underplated overall

*RoHS & REACH compliant.

LED Designation:

Code	+/-	-/+	Code	+/-	-/+
N	Green	—	M	—	Green
Y	Yellow	—	Z	—	Yellow
8	Orange	—	Q	—	Orange
1	Green	Orange	2	Orange	Green
5	Green	Yellow	6	Yellow	Green



Recommended P.C.Board Layout

ORDERING INFORMATION:

P/N L T $\frac{xx}{1} - \frac{08}{2} \frac{x}{3} B \frac{xx}{4} \frac{xx}{5}$

1. TYPE OF PANEL GROUNDS:

"45" NO TAB

"46" TOP TABS

"47" SIDE TABS

"48" TOP TABS & SIDE TABS

2. NO. OF POSITIONS & CONTACTS:

"08" 10P8C

3. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

4. MAGNETIC SCHEMATICS:

10/100 BASE-TX

51, 52, 53, 54, 55, 56, 57, 59, 60, 63

10/100/1000 BASE-TX

G1, G3, G4, G6, G7, G8, G9, H0

SEE PAGE N5902~N5906 & N5941~N5943!

5. TYPE OF LED POLARITY:

(LED PIN DIRECTION FROM LEFT TO RIGHT)

1N, 1Y, 1Z, 55, 58, 5Q, 85, MM, MY, MZ, N5, NN,

NY, NZ, Q5, Y1, Y2, YM, YN, Z1, Z2, ZM, ZN

SIDE ENTRY MAGNETIC 10/100 BASE-TX JACK SMT TYPE WITH LED 10P PROFILE=13.95MM (FULLY SHIELDED)

MATERIALS

Housing: Glass Filled UL 94V-0, Black

Contacts: Phosphor Bronze

Shield: 0.25mm Brass Plating Nickel

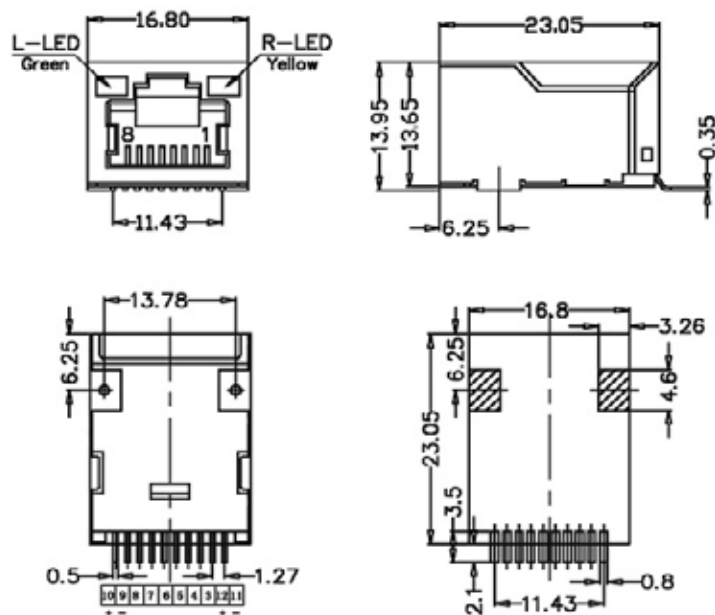
RJ Terminal: UL 94V-0, Black 0.35mm Phos Bronze

Plating Nickel 40u"~60u" for all and Sn 100%
and Gold Plating

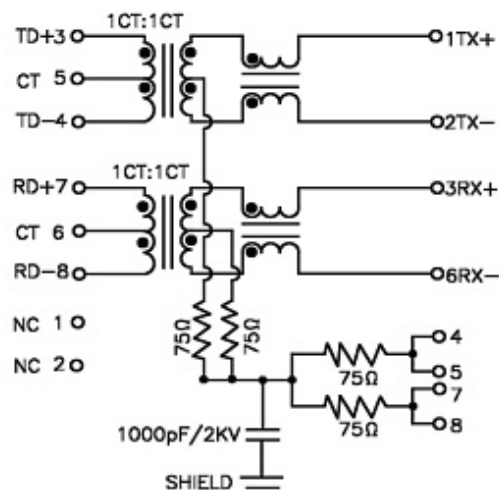
Input Terminal: Glass Filled UL 94V-0, Black

0.35mm Phos Bronze Plating Nickel
40u"~60u" for all and Sn 100%

*RoHS & REACH compliant.



Recommended P.C.Board Layout



ORDERING INFORMATION:

P/N L T A G - 0 8 x B x x x x
 1 2 3 4

1. NO. OF POSITIONS & CONTACTS:

"08" 10P8C

2. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

3. MAGNETIC SCHEMATICS:

99

4. TYPE OF LED POLARITY:

(LED PIN DIRECTION FROM LEFT TO RIGHT)

1N, 1Y, 1Z, 5S, 58, 5Q, 8S, MM, MY, MZ, N5, NN,

NY, NZ, Q5, Y1, Y2, YM, YN, Z1, Z2, ZM, ZN

LED Designation:

Code	+/-	-/+	Code	+/-	-/+
N	Green	—	M	—	Green
Y	Yellow	—	Z	—	Yellow
8	Orange	—	Q	—	Orange
1	Green	Orange	2	Orange	Green
5	Green	Yellow	6	Yellow	Green

SIDE ENTRY 4-PORT DOUBLE LEVEL MAGNETIC 10/100 & 10/100/1000 BASE-TX JACK WITHOUT LED 8P PROFILE=23.35MM (FULLY SHIELDED)

MATERIALS

Housing: PBT UL 94V-0, Black

Shell: Brass C2680 T=0.20, 85u"~135u" Ni Plated

RJ45 Terminal: Phosphor Bronze T=0.30mm,

Gold Au Plated on Contact Area

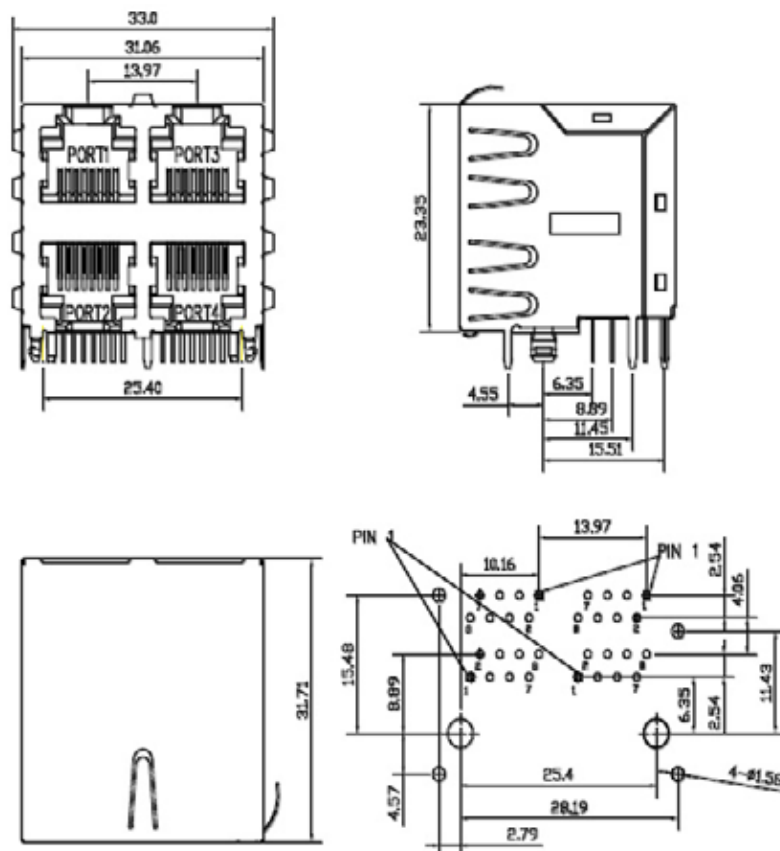
80u"~160u" Tin Plated on Solder Area

50u"~100u" Ni Underplated overall

Other Terminal: Brass T=0.30mm, 80u"~160u" Tin Plated

50u"~100u" Ni Underplated overall

*RoHS & REACH compliant.



Recommended P.C.Board Layout

ORDERING INFORMATION:

P/N L T $\frac{x}{1}$ - $\frac{8}{2}$ $\frac{8}{3}$ B $\frac{x}{4}$ $\frac{0}{5}$

1. TYPE OF PANEL GROUNDS:

"77" NO TAB

"78" TOP TABS

"79" SIDE TABS

"80" TOP TABS & SIDE TABS

2. NO. OF POSITIONS & CONTACTS:

"88" 8P8C

3. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

4. MAGNETIC SCHEMATICS:

10/100 BASE-TX

51, 52, 53, 54, 55, 56, 58, 59, 60, 63

10/100/1000 BASE-TX

G1, G3, G4, G6, G7, G8, G9, H0

SEE PAGE N5902~N5906 & N5941~N5943!

5. NO. OF PORTS:

04

SIDE ENTRY 4-PORT DOUBLE LEVEL MAGNETIC 10/100 & 10/100/1000 BASE-TX JACK WITHOUT LED 10P PROFILE=23.35MM (FULLY SHIELDED)

MATERIALS

Housing: PBT UL 94V-0, Black

Shell: Brass C2680 T=0.20, 85u"~135u" Ni Plated

RJ45 Terminal: Phosphor Bronze T=0.30mm,

Gold Au Plated on Contact Area

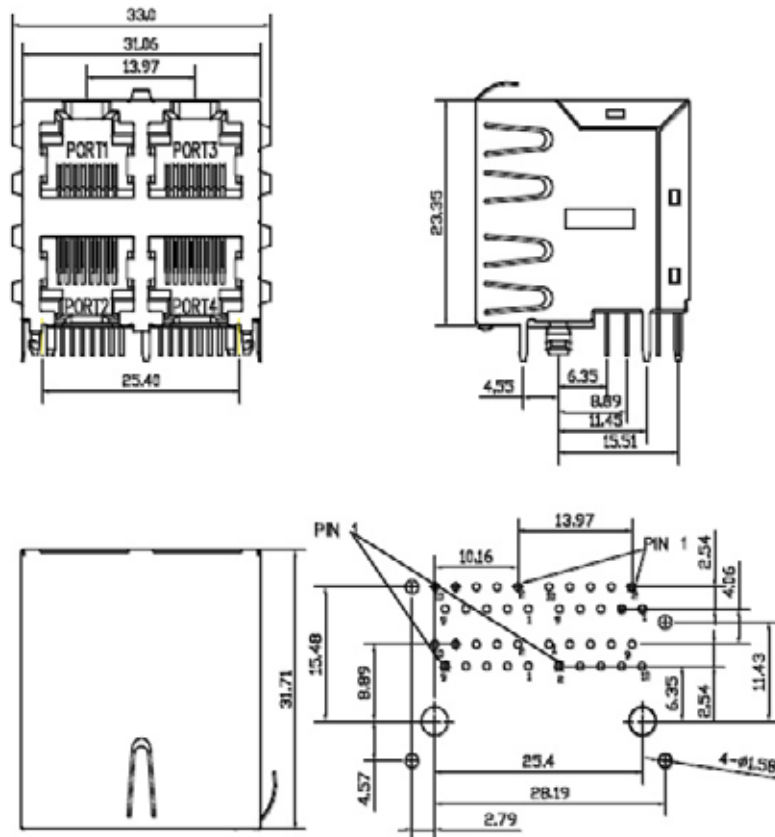
80u"~160u" Tin Plated on Solder Area

50u"~100u" Ni Underplated overall

Other Terminal: Brass T=0.30mm, 80u"~160u" Tin Plated

50u"~100u" Ni Underplated overall

*RoHS & REACH compliant.



Recommended P.C.Board Layout

ORDERING INFORMATION:

P/N L T $\frac{x}{1}$ - $\frac{0.8}{2}$ $\frac{x}{3}$ B $\frac{x}{4}$ $\frac{0.4}{5}$

1. TYPE OF PANEL GROUNDS:

"77" NO TAB

"78" TOP TABS

"79" SIDE TABS

"80" TOP TABS & SIDE TABS

2. NO. OF POSITIONS & CONTACTS:

"08" 10P8C

3. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

4. MAGNETIC SCHEMATICS:

10/100 BASE-TX

51, 52, 53, 54, 55, 56, 58, 59, 60, 63

10/100/1000 BASE-TX

G1, G3, G4, G6, G7, G8, G9, H0

SEE PAGE N5902~N5906 & N5941~N5943!

5. NO. OF PORTS:

04

SIDE ENTRY 12-PORT DOUBLE LEVEL MAGNETIC 10/100 BASE-TX JACK WITHOUT LED 8P PROFILE=25.14MM (FULLY SHIELDED)

MATERIALS

Housing: High Temperature Thermoplastic UL 94V-0, Black

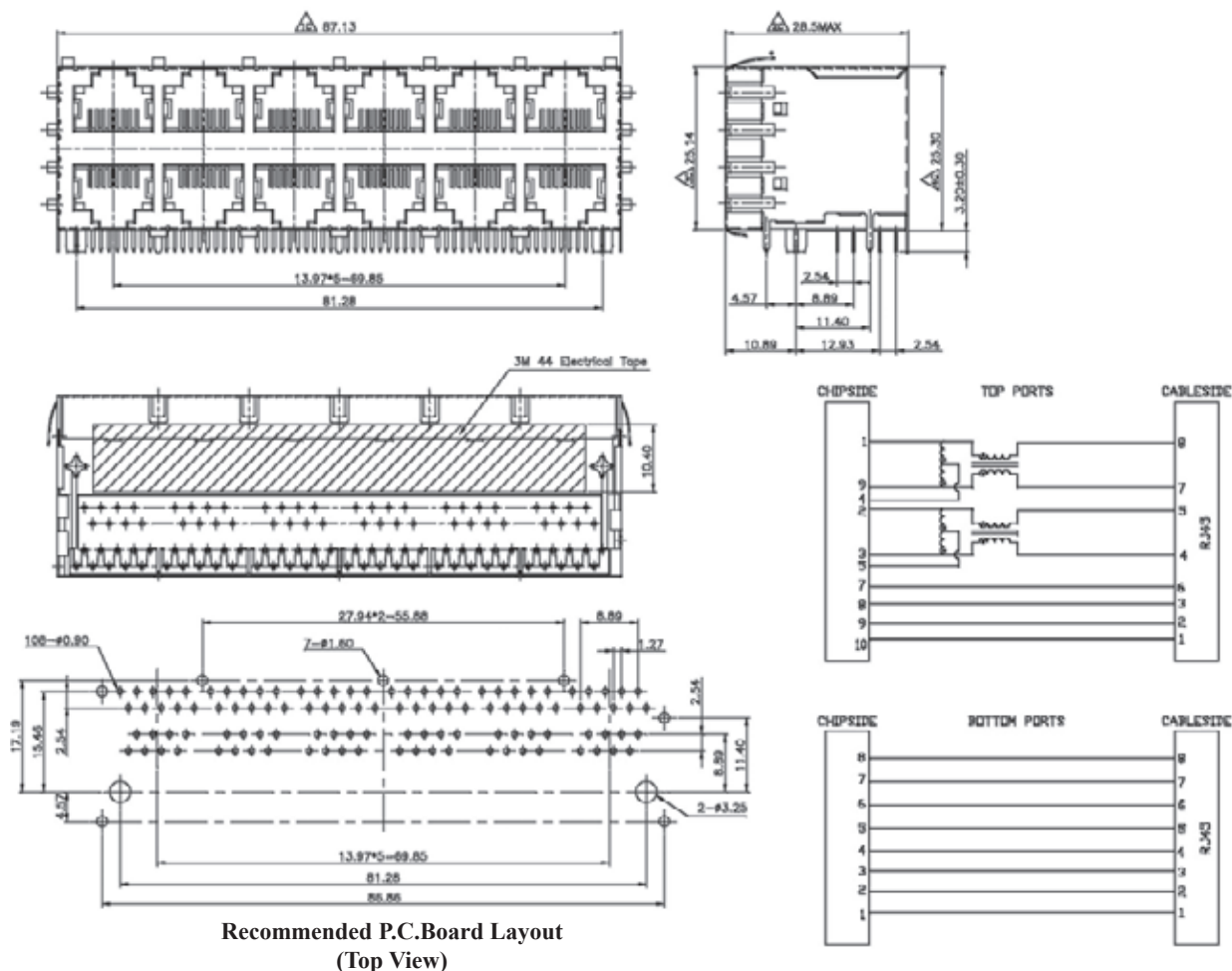
Contacts: 0.35mm Phosphor Bronze Plated,

Gold Plated on Contact Area

Solder Tin in Solder Area

Shield: 0.20mm Copper Alloy with Nickel

*RoHS & REACH compliant.



ORDERING INFORMATION:

P/N LTAD - $\frac{88}{1} \times \frac{B}{2} \frac{99}{3} \frac{12}{4}$

1. NO. OF POSITIONS & CONTACTS:

"88" 8P8C

2. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

"E" GOLD FLASH

3. MAGNETIC SCHEMATICS:

99

4. NO. OF PORTS:

12

NOTE: THERE IS NO MAGNETIC ON LOWER LEVEL.

SIDE ENTRY 2-PORT DOUBLE LEVEL MAGNETIC 10/100 & 10/100/1000 BASE-TX JACK WITHOUT LED 8P PROFILE=25.25MM (FULLY SHIELDED)

MATERIALS

Housing: PBT UL 94V-0, Black

Shell: Brass C2680 T=0.20, 85u"~135u" Ni Plated

RJ45 Terminal: Phosphor Bronze T=0.30mm,

Gold Au Plated on Contact Area

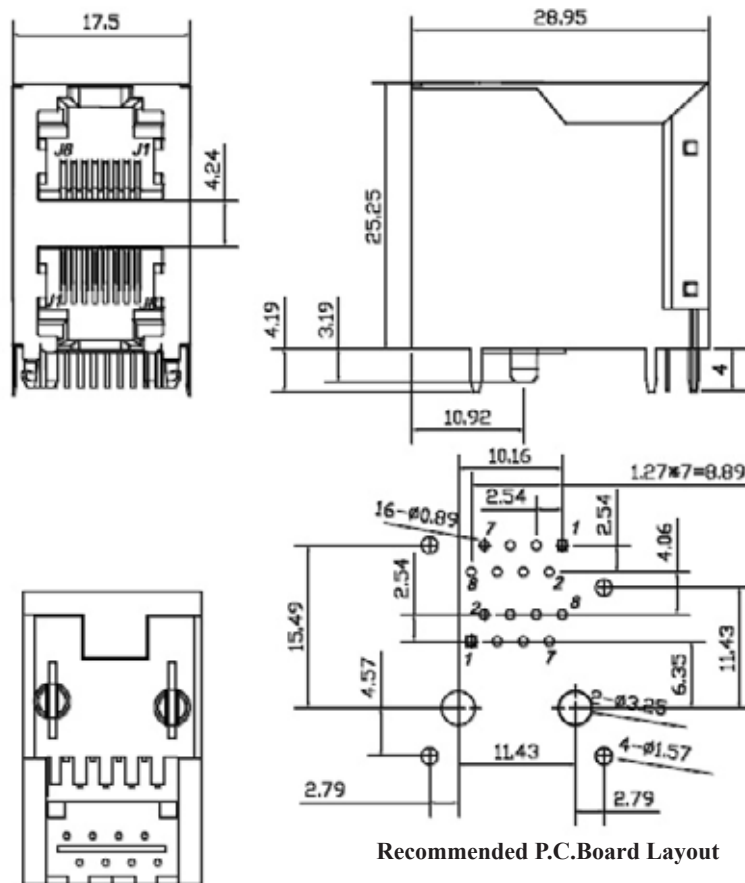
80u"~160u" Tin Plated on Solder Area

50u"~100u" Ni Underplated overall

Other Terminal: Brass T=0.30mm, 80u"~160u" Tin Plated

50u"~100u" Ni Underplated overall

*RoHS & REACH compliant.



Recommended P.C.Board Layout

ORDERING INFORMATION:

P/N L T $\frac{x}{1}$ - $\frac{88}{2}$ $\frac{x}{3}$ B $\frac{x}{4}$ $\frac{02}{5}$

1. TYPE OF PANEL GROUNDS:

"77" NO TAB

"78" TOP TABS

"79" SIDE TABS

"80" TOP TABS & SIDE TABS

2. NO. OF POSITIONS & CONTACTS:

"88" 8P8C

3. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

4. MAGNETIC SCHEMATICS:

10/100 BASE-TX

51, 52, 53, 54, 55, 56, 58, 59, 60, 63

10/100/1000 BASE-TX

G1, G3, G4, G6, G7, G8, G9, H0

SEE PAGE N5902~N5906 & N5941~N5943!

5. NO. OF PORTS:

02

SIDE ENTRY 2-PORT DOUBLE LEVEL MAGNETIC 10/100 & 10/100/1000 BASE-TX JACK WITHOUT LED 10P PROFILE=25.25MM (FULLY SHIELDED)

MATERIALS

Housing: PBT UL 94V-0, Black

Shell: Brass C2680 T=0.20, 85u"~135u" Ni Plated

RJ45 Terminal: Phosphor Bronze T=0.30mm,

Gold Au Plated on Contact Area

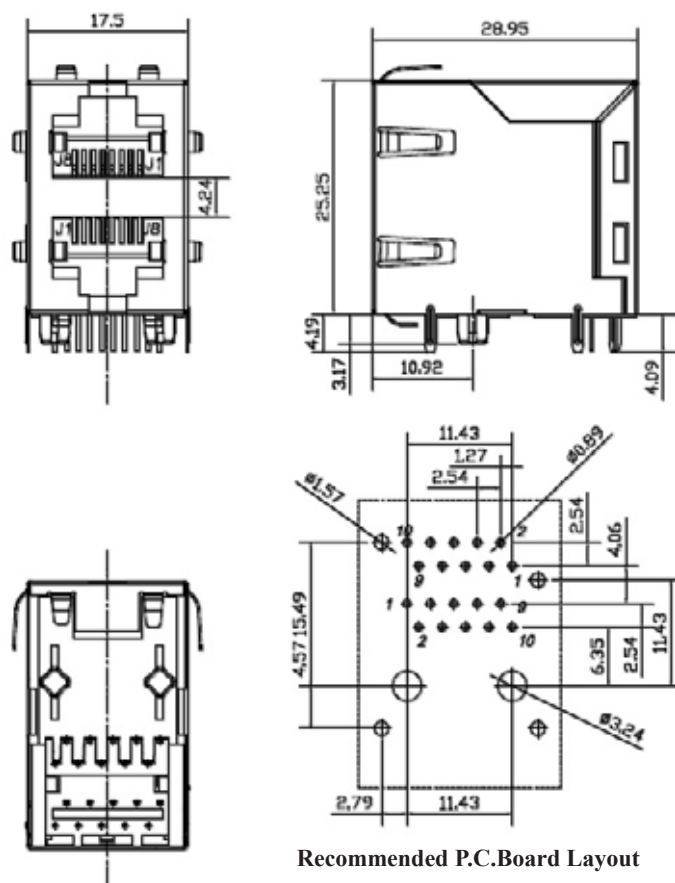
80u"~160u" Tin Plated on Solder Area

50u"~100u" Ni Underplated overall

Other Terminal: Brass T=0.30mm, 80u"~160u" Tin Plated

50u"~100u" Ni Underplated overall

*RoHS & REACH compliant.



Recommended P.C.Board Layout

ORDERING INFORMATION:

P/N L T $\frac{x}{1}$ - $\frac{0.8}{2}$ x $\frac{B}{3}$ $\frac{x}{4}$ $\frac{0.2}{5}$

1. TYPE OF PANEL GROUNDS:

"77" NO TAB

"78" TOP TABS

"79" SIDE TABS

"80" TOP TABS & SIDE TABS

2. NO. OF POSITIONS & CONTACTS:

"08" 10P8C

3. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

4. MAGNETIC SCHEMATICS:

10/100 BASE-TX

51, 52, 53, 54, 55, 56, 58, 59, 60, 63

10/100/1000 BASE-TX

G1, G3, G4, G6, G7, G8, G9, H0

SEE PAGE N5902~N5906 & N5941~N5943!

5. NO. OF PORTS:

02

SIDE ENTRY 4-PORT DOUBLE LEVEL MAGNETIC 10/100 & 10/100/1000 BASE-TX JACK WITH LED 10P PROFILE=25.30MM (FULLY SHIELDED)

MATERIALS

Housing: PBT UL 94V-0, Black

Shell: Brass C2680 T=0.20, 85u"~135u" Ni Plated

RJ45 Terminal: Phosphor Bronze T=0.30mm,

Gold Au Plated on Contact Area

80u"~160u" Tin Plated on Solder Area

50u"~100u" Ni Underplated overall

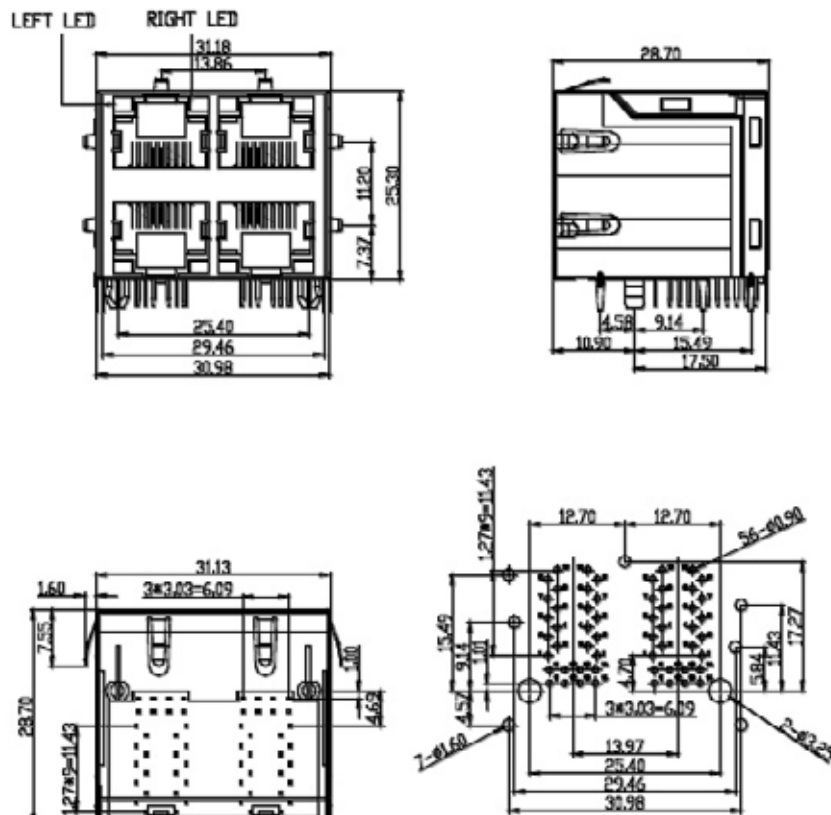
Other Terminal: Brass T=0.30mm, 80u"~160u" Tin Plated

50u"~100u" Ni Underplated overall

*RoHS & REACH compliant.

LED Designation:

Code	+/-	-/+	Code	+/-	-/+
N	Green	—	M	—	Green
Y	Yellow	—	Z	—	Yellow
8	Orange	—	Q	—	Orange
1	Green	Orange	2	Orange	Green
5	Green	Yellow	6	Yellow	Green



Recommended P.C.Board Layout

ORDERING INFORMATION:

P/N L T $\frac{x}{1}$ $\frac{x}{2}$ $\frac{0.8}{3}$ $\frac{x}{4}$ $\frac{x}{5}$ $\frac{x}{6}$ 0.4

1. TYPE OF PANEL GROUNDS:

"69" NO TAB

"70" TOP TABS

"71" SIDE TABS

"72" TOP TABS & SIDE TABS

2. NO. OF POSITIONS & CONTACTS:

"08" 10P8C

3. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

4. MAGNETIC SCHEMATICS:

10/100 BASE-TX

51, 52, 53, 54, 55, 56, 58, 59, 60, 62, 63, 73, 75, 81

10/100/1000 BASE-TX

G1, G3, G4, G6, G7, G8, G9, H0, J1, J2, J4

SEE PAGE N5902~N5906 & N5941~N5943!

5. TYPE OF LED POLARITY:

(LED PIN DIRECTION FROM LEFT TO RIGHT)

1N, 1Y, 1Z, 5S, 58, 5Q, 85, MM, MY, MZ, N5, NN,

NY, NZ, Q5, Y1, Y2, YM, YN, Z1, Z2, ZM, ZN

6. NO. OF PORTS:

04

SIDE ENTRY 12-PORT DOUBLE LEVEL MAGNETIC 10/100 & 10/100/1000 BASE-TX JACK WITH LED 10P PROFILE=25.30MM (FULLY SHIELDED)

MATERIALS

Housing: PBT UL 94V-0, Black

Shell: Brass C2680 T=0.20, 85u"~135u" Ni Plated

RJ45 Terminal: Phosphor Bronze T=0.30mm,

Gold Au Plated on Contact Area

80u"~160u" Tin Plated on Solder Area

50u"~100u" Ni Underplated overall

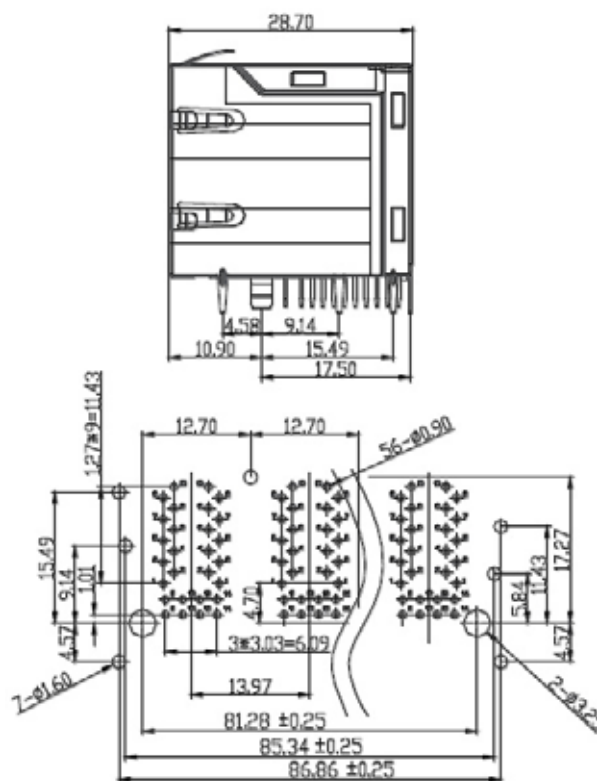
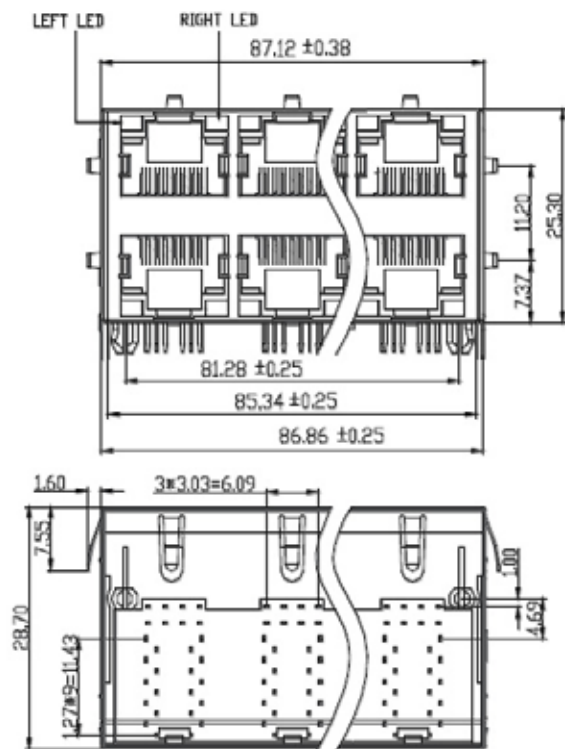
Other Terminal: Brass T=0.30mm, 80u"~160u" Tin Plated

50u"~100u" Ni Underplated overall

*RoHS & REACH compliant.

LED Designation:

Code	+/-	-/+	Code	+/-	-/+
N	Green	—	M	—	Green
Y	Yellow	—	Z	—	Yellow
8	Orange	—	Q	—	Orange
1	Green	Orange	2	Orange	Green
5	Green	Yellow	6	Yellow	Green



Recommended P.C.Board Layout

ORDERING INFORMATION:

P/N L T $\frac{x}{1}$ $\frac{x}{2}$ - $\frac{0.8}{3}$ $\frac{x}{4}$ $\frac{x}{5}$ $\frac{x}{6}$ B $\frac{x}{1}$ $\frac{x}{2}$ $\frac{x}{3}$ $\frac{x}{4}$ $\frac{x}{5}$ $\frac{x}{6}$ 1 2

1. TYPE OF PANEL GROUNDS:

"69" NO TAB

"70" TOP TABS

"71" SIDE TABS

"72" TOP TABS & SIDE TABS

2. NO. OF POSITIONS & CONTACTS:

"08" 10P8C

3. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

4. MAGNETIC SCHEMATICS:

10/100 BASE-TX

51, 52, 53, 54, 55, 56, 58, 59, 60, 62, 63, 73, 75, 81

10/100/1000 BASE-TX

G1, G3, G4, G6, G7, G8, G9, H0, J1, J2, J4

SEE PAGE N5902~N5906 & N5941~N5943!

5. TYPE OF LED POLARITY:

(LED PIN DIRECTION FROM LEFT TO RIGHT)

1N, 1Y, 1Z, 5S, 58, 5Q, 85, MM, MY, MZ, N5, NN,

NY, NZ, Q5, Y1, Y2, YM, YN, Z1, Z2, ZM, ZN

6. NO. OF PORTS:

12

SIDE ENTRY 16-PORT DOUBLE LEVEL MAGNETIC 10/100 & 10/100/1000 BASE-TX JACK WITH LED 10P PROFILE=25.30MM (FULLY SHIELDED)

MATERIALS

Housing: PBT UL 94V-0, Black

Shell: Brass C2680 T=0.20, 85u"~135u" Ni Plated

RJ45 Terminal: Phosphor Bronze T=0.30mm,

Gold Au Plated on Contact Area

80u"~160u" Tin Plated on Solder Area

50u"~100u" Ni Underplated overall

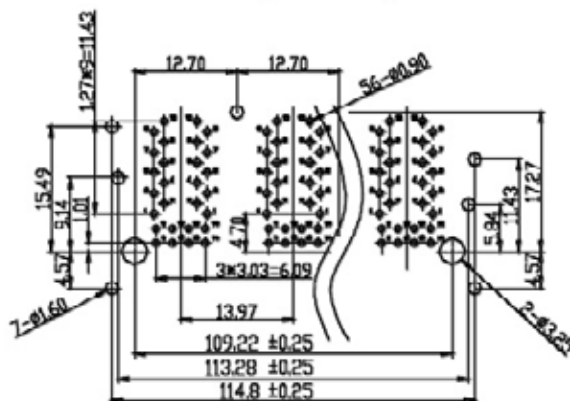
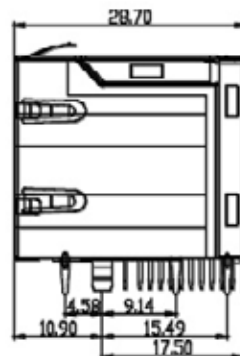
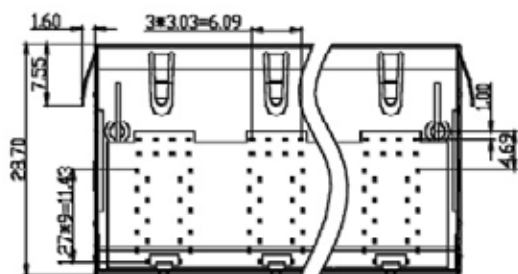
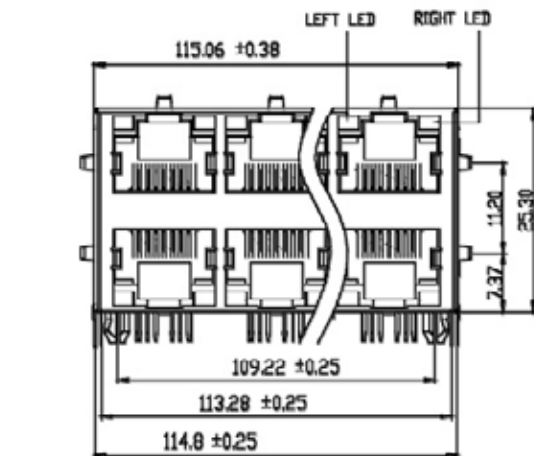
Other Terminal: Brass T=0.30mm, 80u"~160u" Tin Plated

50u"~100u" Ni Underplated overall

*RoHS & REACH compliant.

LED Designation:

Code	+/-	-/+	Code	+/-	-/+
N	Green	—	M	—	Green
Y	Yellow	—	Z	—	Yellow
8	Orange	—	Q	—	Orange
1	Green	Orange	2	Orange	Green
5	Green	Yellow	6	Yellow	Green



Recommended P.C.Board Layout

ORDERING INFORMATION:

P/N L T $\frac{x}{1} \frac{x}{2} \frac{-0.8}{3} \frac{x}{4} \frac{B}{5} \frac{x}{6} \frac{x}{5} \frac{x}{4} \frac{1.6}{6}$

1. TYPE OF PANEL GROUNDS:

"69" NO TAB

"70" TOP TABS

"71" SIDE TABS

"72" TOP TABS & SIDE TABS

2. NO. OF POSITIONS & CONTACTS:

"08" 10P8C

3. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

4. MAGNETIC SCHEMATICS:

10/100 BASE-TX

51, 52, 53, 54, 55, 56, 58, 59, 60, 62, 63, 73, 75, 81

10/100/1000 BASE-TX

G1, G3, G4, G6, G7, G8, G9, H0, J1, J2, J4

SEE PAGE N5902~N5906 & N5941~N5943!

5. TYPE OF LED POLARITY:

(LED PIN DIRECTION FROM LEFT TO RIGHT)

1N, 1Y, 1Z, 5S, 58, 5Q, 85, MM, MY, MZ, N5, NN,

NY, NZ, Q5, Y1, Y2, YM, YN, Z1, Z2, ZM, ZN

6. NO. OF PORTS:

16

SIDE ENTRY 8-PORT DOUBLE LEVEL MAGNETIC 10/100 & 10/100/1000 BASE-TX JACK WITHOUT LED 8P PROFILE=25.30MM (FULLY SHIELDED)

MATERIALS

Housing: PBT UL 94V-0, Black

Shell: Brass C2680 T=0.20, 85u"~135u" Ni Plated

RJ45 Terminal: Phosphor Bronze T=0.30mm,

Gold Au Plated on Contact Area

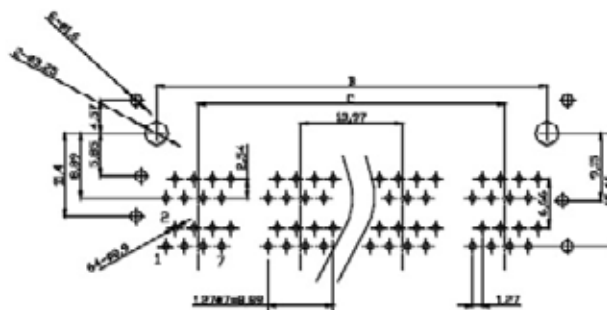
80u"~160u" Tin Plated on Solder Area

50u"~100u" Ni Underplated overall

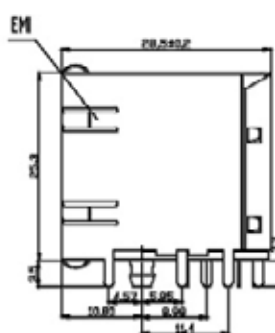
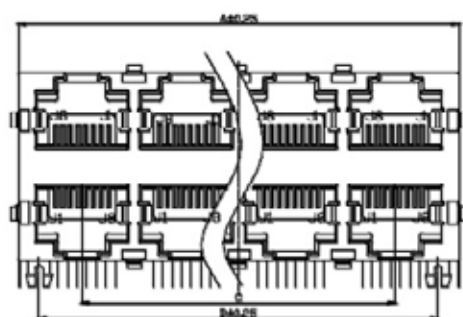
Other Terminal: Brass T=0.30mm, 80u"~160u" Tin Plated

50u"~100u" Ni Underplated overall

*RoHS & REACH compliant.



Recommended P.C.Board Layout



	2X4
"A" ±0.25	59.2
"B" ±0.25	53.34
"C" ±0.25	41.91

ORDERING INFORMATION:

P/N L T $\frac{x}{1}$ - $\frac{88}{2}$ $\frac{x}{3}$ B $\frac{x}{4}$ $\frac{08}{5}$

1. TYPE OF PANEL GROUNDS:

"81" NO TAB

"82" TOP TABS

"83" SIDE TABS

"84" TOP TABS & SIDE TABS

2. NO. OF POSITIONS & CONTACTS:

"88" 8P8C

3. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

4. MAGNETIC SCHEMATICS:

10/100 BASE-TX

51, 52, 53, 54, 55, 56, 58, 59, 60, 63

10/100/1000 BASE-TX

G1, G3, G4, G6, G7, G8, G9, H0

SEE PAGE N5902~N5906 & N5941~N5943!

5. NO. OF PORTS:

08

SIDE ENTRY 8-PORT DOUBLE LEVEL MAGNETIC 10/100 & 10/100/1000 BASE-TX JACK WITH LED 10P PROFILE=25.43MM (FULLY SHIELDED)

MATERIALS

Housing: PBT UL 94V-0, Black

Shell: Brass C2680 T=0.20, 85u"~135u" Ni Plated

RJ45 Terminal: Phosphor Bronze T=0.30mm,

Gold Au Plated on Contact Area

80u"~160u" Tin Plated on Solder Area

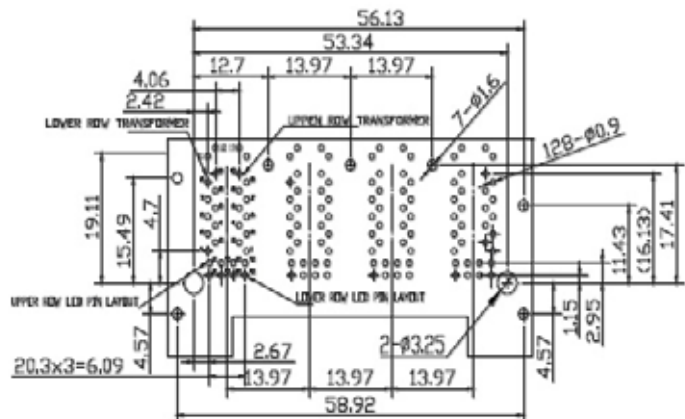
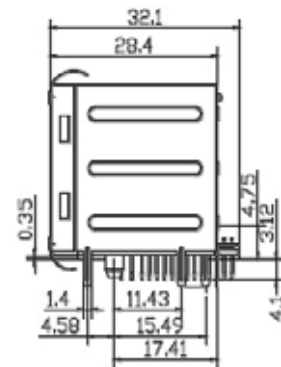
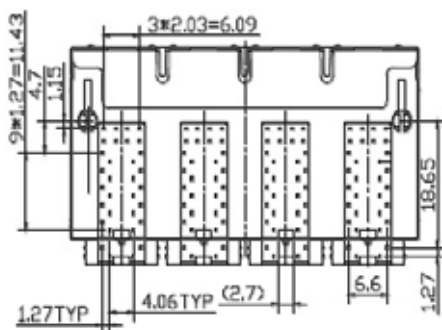
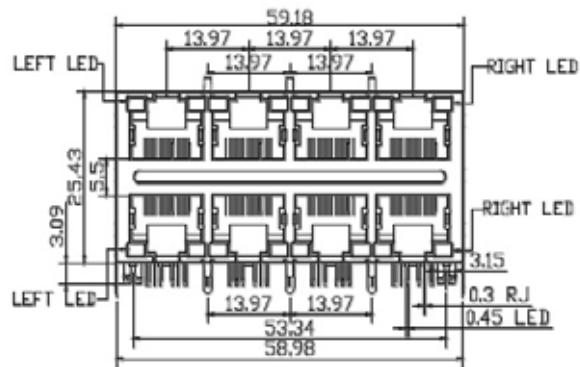
50u"~100u" Ni Underplated overall

Other Terminal: Brass T=0.30mm, 80u"~160u" Tin Plated

50u"~100u" Ni Underplated overall

***RoHS & REACH compliant.**

LED Designation:					
Code	+/-	-/+	Code	+/-	-/+
N	Green	—	M	—	Green
Y	Yellow	—	Z	—	Yellow
8	Orange	—	Q	—	Orange
1	Green	Orange	2	Orange	Green
5	Green	Yellow	6	Yellow	Green



Recommended P.C.Board Layout

ORDERING INFORMATION:

$$\mathbf{P/N} \quad \mathbf{L} \quad \mathbf{T} \quad \frac{\mathbf{x} \mathbf{x}}{\mathbf{1}} - \frac{\mathbf{0} \mathbf{8}}{\mathbf{2}} \frac{\mathbf{x}}{\mathbf{3}} \mathbf{B} \frac{\mathbf{x} \mathbf{x}}{\mathbf{4}} \frac{\mathbf{x} \mathbf{x}}{\mathbf{5}} \frac{\mathbf{0} \mathbf{8}}{\mathbf{6}}$$

- ### 1. TYPE OF PANEL GROUNDS:

"73" NO TAB

"74" TOP TABS

"75" SIDE TABS

"76" TOP TABS & SIDE TABS

2. NO. OF POSITIONS & CONTACTS:

"08" 10P8C

- ### 3. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

- #### 4. MAGNETIC SCHEMATICS:

10/100 BASE-TX

51, 52, 53, 54, 55, 56, 58, 59, 60, 62, 63, 73, 75, 81

10/100/1000 BASE-TX

G1, G3, G4, G6, G8, G9, H0, J1, J2, J4

SEE PAGE N5902~N5906 & N5941~N5943!

- ### 5. TYPE OF LED POLARITY:

(LED PIN DIRECTION FROM LEFT TO RIGHT)

1N, 1Y, 1Z, 55, 58, 5Q, 85, MM, MY, MZ, N5, N

NY, NZ, Q5, Y1, Y2, YM, YN, Z1, Z2, ZM, ZN

6. NO. OF PORTS:

08

SIDE ENTRY 8-PORT DOUBLE LEVEL MAGNETIC 10/100/1000 (GIGABIT) BASE-TX JACK WITHOUT LED 10P PROFILE=25.75MM (FULLY SHIELDED)

MATERIALS

Housing: High Temperature Thermoplastic UL 94V-0, Black

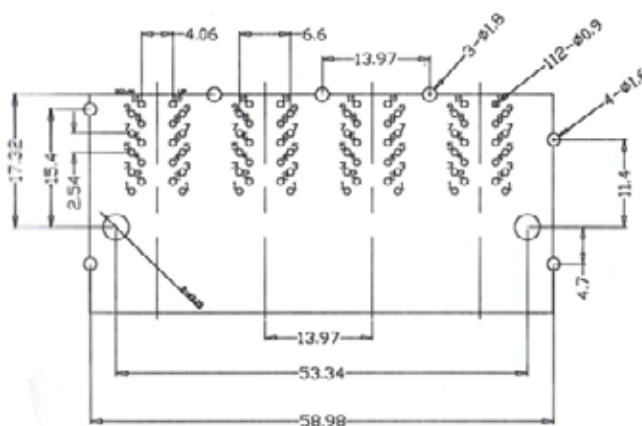
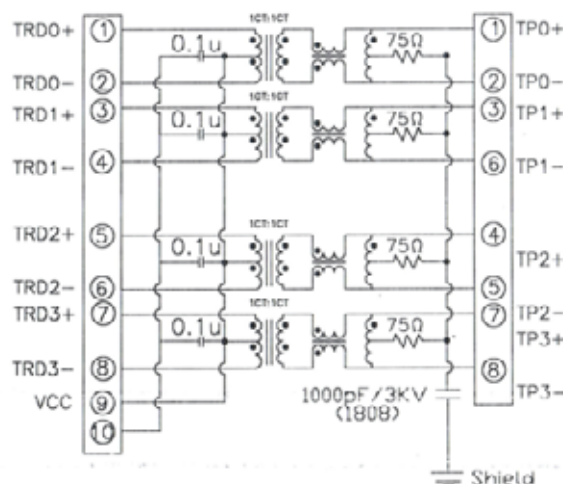
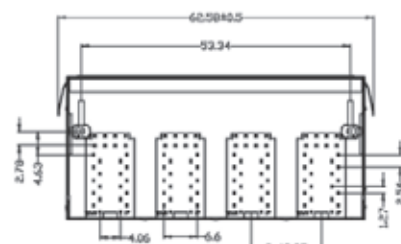
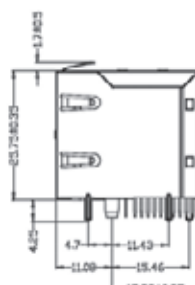
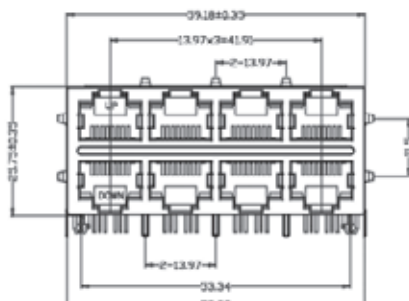
Contacts: 0.35mm Phosphor Bronze Plated,

Gold Plated on Contact Area

Solder Tin in Solder Area

Shield: 0.20mm Copper Alloy with Nickel

*RoHS & REACH compliant.



Recommended P.C.Board Layout
(Component Side)

ORDERING INFORMATION:

P/N LTGC - 08 x B G 3 0 8
1 2 3 4

1. NO. OF POSITIONS & CONTACTS:

"08" 10P8C

2. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

3. MAGNETIC SCHEMATICS:

G3

4. NO. OF PORTS:

08

SIDE ENTRY MAGNETIC 10/100 BASE-TX JACK OVER SINGLE USB WITHOUT LED 8P6C PROFILE=20.85MM (FULLY SHIELDED)

MATERIALS

Housing: Thermoplastic

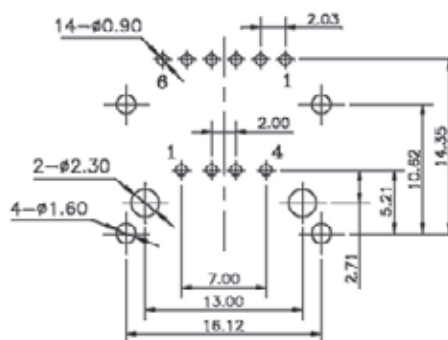
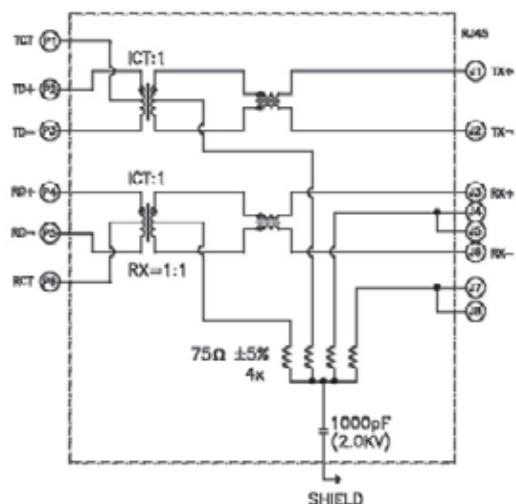
Contacts: Phosphor Bronze

Plating: Gold plating Over Nickel in Contact

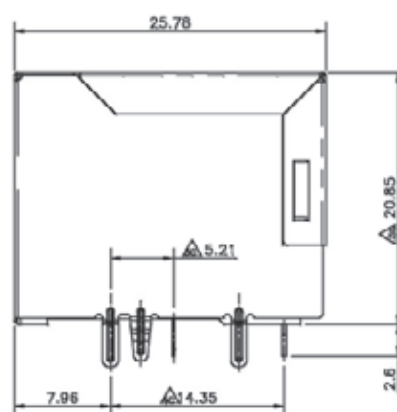
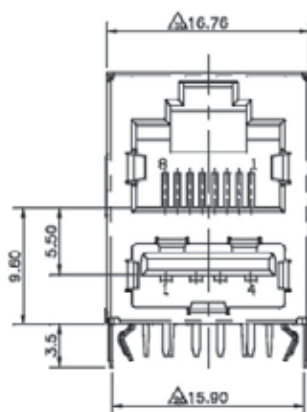
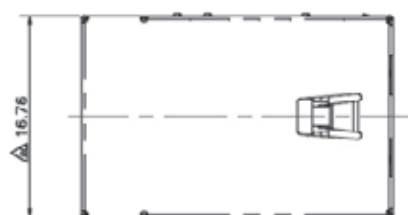
Tin plating Over Nickel in Solder Area

Shield: Brass Plating Nickel

*RoHS & REACH compliant.



Recommended P.C.Board Layout
(Top View)



ORDERING INFORMATION:

P/N L T U A - $\frac{6U}{1} \times \frac{B}{2} \frac{6V}{3}$

1. NO. OF POSITIONS & CONTACTS:
"6U" 8P6C + USB
2. CONTACT FINISH:
"A" 6 MICROINCH GOLD
"E" 3 MICROINCH GOLD
* USB CONTACT PLATING: 3 MICROINCH GOLD
3. MAGNETIC SCHEMATICS:
6V

SIDE ENTRY MAGNETIC 10/100 BASE-TX JACK OVER SINGLE USB WITH LED 8P6C PROFILE=20.85MM (FULLY SHIELDED)

MATERIALS

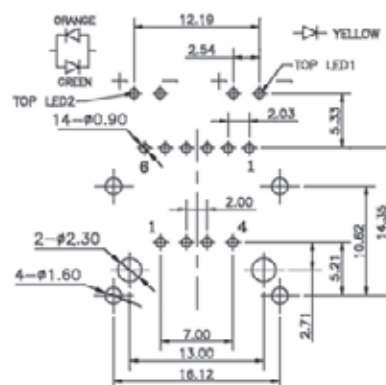
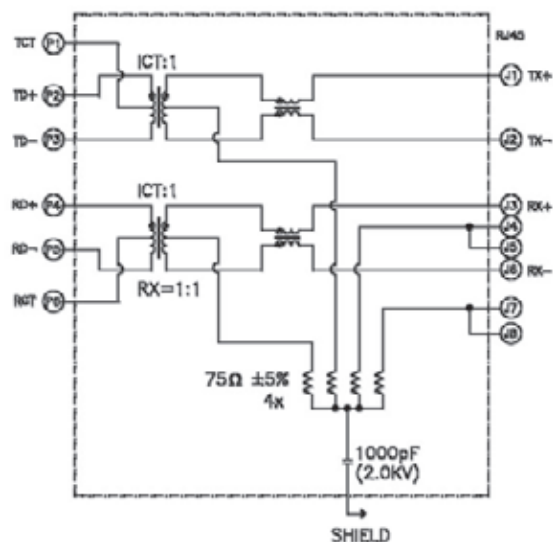
Housing: Thermoplastic

Contacts: Phosphor Bronze

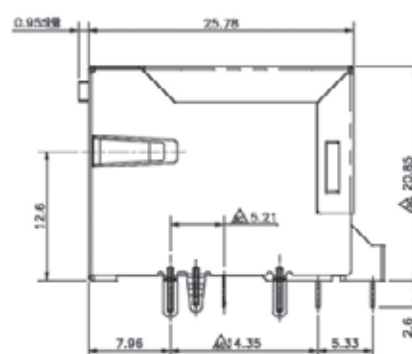
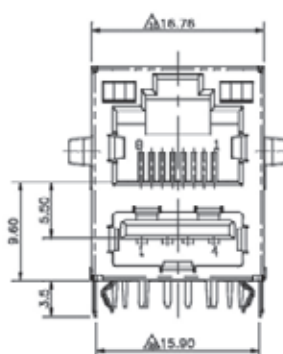
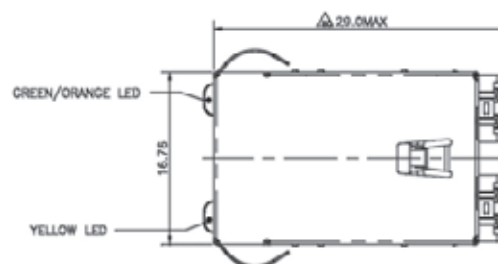
Plating: Gold plating Over Nickel in Contact
Tin plating Over Nickel in Solder Area

Shield: Brass Plating Nickel

*RoHS & REACH compliant.



Recommended P.C.Board Layout
(Top View)



ORDERING INFORMATION:

P/N L T U B - $\frac{6}{1} \frac{U}{2} \times \frac{B}{3} \frac{6}{4} \frac{V}{1} \frac{Y}{4}$

1. NO. OF POSITIONS & CONTACTS:
"6U" 6P8C + USB
2. CONTACT FINISH:
"A" 6 MICROINCH GOLD
"E" 3 MICROINCH GOLD
* USB CONTACT PLATING: 3 MICROINCH GOLD
3. MAGNETIC SCHEMATICS:
6V
4. TYPE OF LED POLARITY:
"1Y" LEFT LED = GREEN/ORANGE &
RIGHT LED = YELLOW

SIDE ENTRY MAGNETIC 10/100 BASE-TX JACK OVER SINGLE USB WITH LED 8P8C PROFILE=20.85MM (FULLY SHIELDED)

MATERIALS

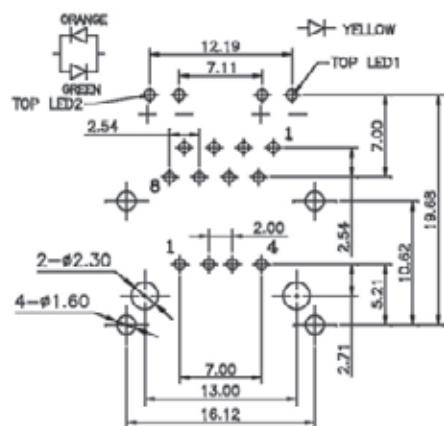
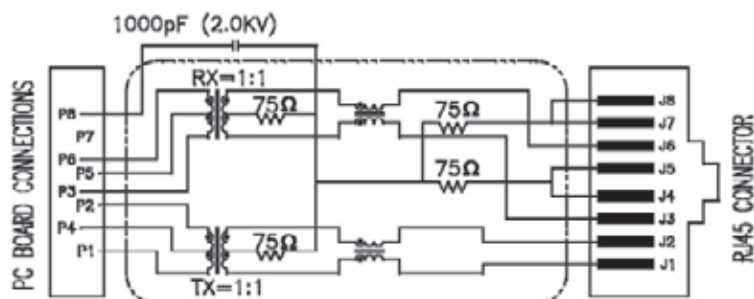
Housing: Thermoplastic

Contacts: Phosphor Bronze

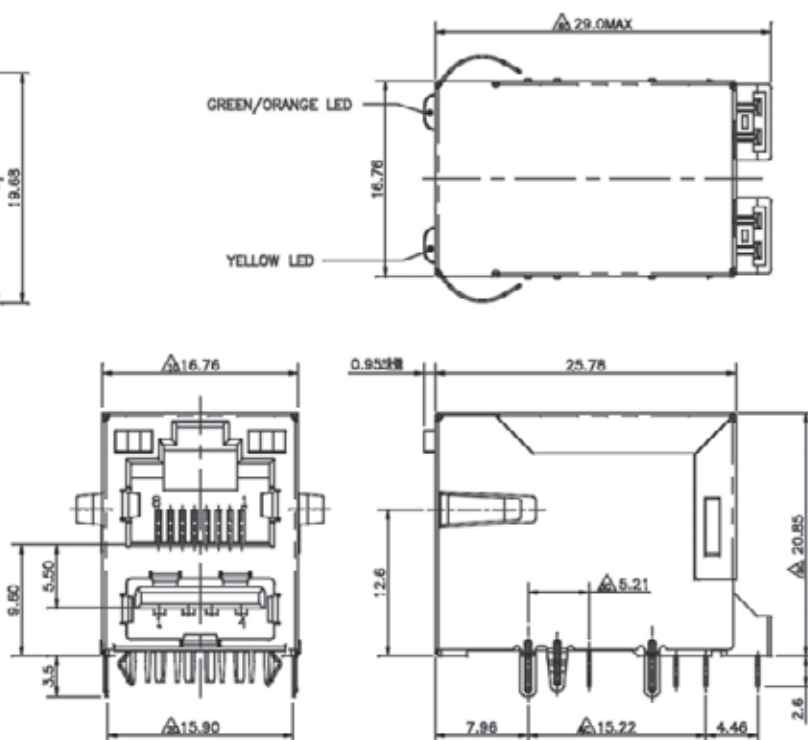
Plating: Gold plating Over Nickel in Contact
Tin plating Over Nickel in Solder Area

Shield: Brass Plating Nickel

*RoHS & REACH compliant.



Recommended P.C.Board Layout
(Top View)



ORDERING INFORMATION:

P/N LTUC - $\frac{8}{1} \frac{U}{2} \times \frac{B}{3} \frac{0.6}{4} \frac{1}{4} \frac{Y}{4}$

1. NO. OF POSITIONS & CONTACTS:
"8U" 8P8C + USB
2. CONTACT FINISH:
"A" 6 MICROINCH GOLD
"E" 3 MICROINCH GOLD
* USB CONTACT PLATING: 3 MICROINCH GOLD
3. MAGNETIC SCHEMATICS:
06
4. TYPE OF LED POLARITY:
"1Y" LEFT LED = GREEN/ORANGE &
RIGHT LED = YELLOW

SIDE ENTRY MAGNETIC 10/100/1000 (GIGABIT) BASE-TX JACK OVER SINGLE USB WITH LED 10P8C PROFILE=20.85MM (FULLY SHIELDED)

MATERIALS

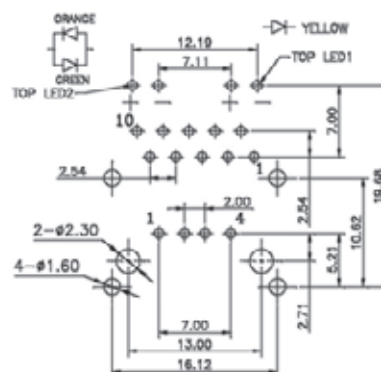
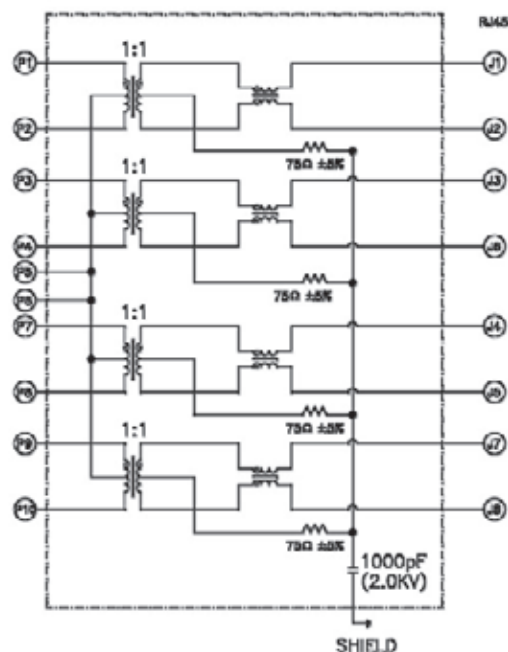
Housing: Thermoplastic

Contacts: Phosphor Bronze

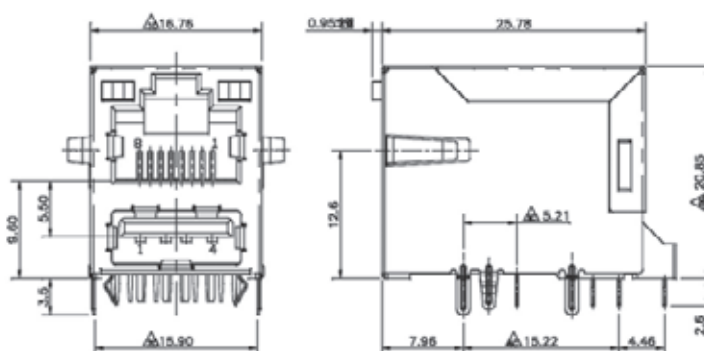
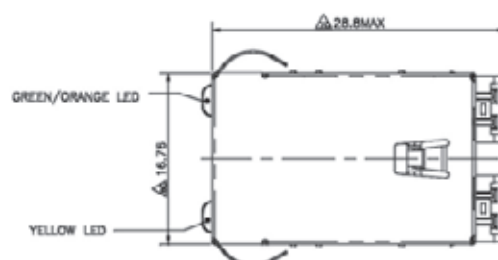
Plating: Gold plating Over Nickel in Contact
Tin plating Over Nickel in Solder Area

Shield: Brass Plating Nickel

*RoHS & REACH compliant.



Recommended P.C.Board Layout
(Top View)



ORDERING INFORMATION:

P/N LTGF-0UxB8V1Y
1 2 3 4

1. NO. OF POSITIONS & CONTACTS:
"0U" 10P8C + USB
2. CONTACT FINISH:
"A" 6 MICROINCH GOLD
"E" 3 MICROINCH GOLD
* USB CONTACT PLATING: 3 MICROINCH GOLD
3. MAGNETIC SCHEMATICS:
8V
4. TYPE OF LED POLARITY:
"1Y" LEFT LED = GREEN/ORANGE &
RIGHT LED = YELLOW

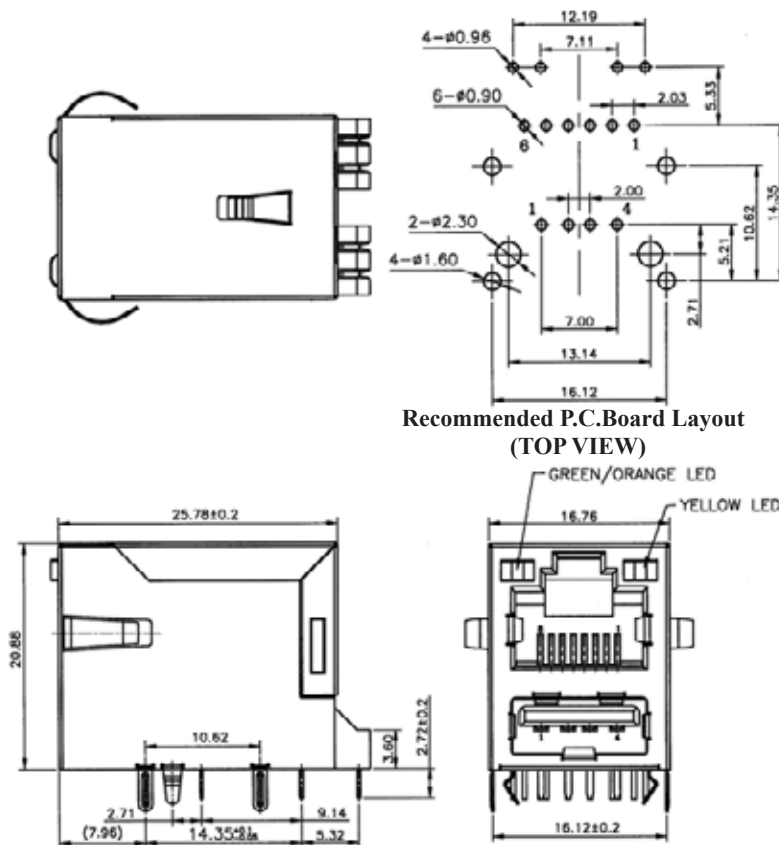
SIDE ENTRY MAGNETIC MODULAR PCB JACK WITH USB & LED 8P PROFILE=20.88MM (FULLY SHIELDED)

SPECIFICATIONS

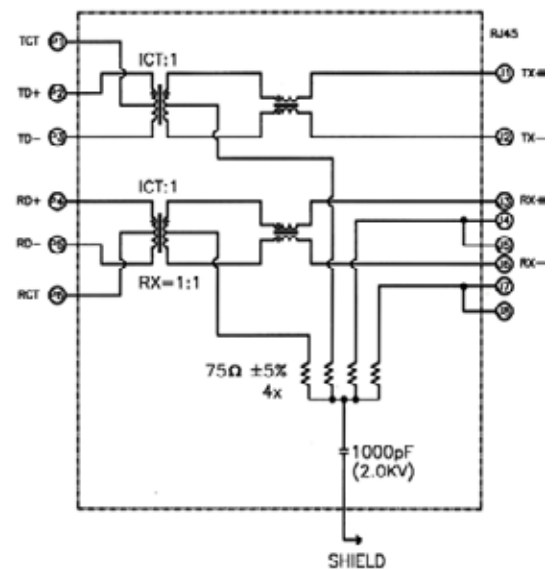
Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Black
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
Shield: Brass plating Nickel Alloy
***RoHS & REACH compliant.**



Recommended P.C.Board Layout
(TOP VIEW)



P/N LT1G-88xB991Y

ORDERING INFORMATION:

P/N LT1G-88EB991Y
 1 2 3 4

1. NO. OF POSITIONS & CONTACTS:
"88" 8P8C
2. CONTACT FINISH:
"E" GOLD FLASH
3. SCHEMATIC TYPE:
99
4. LED COLOR:
"1Y" LEFT LED = GREEN/ORANGE &
RIGHT LED = YELLOW

SIDE ENTRY UP LATCH MAGNETIC 10/100 & 10/100/1000 BASE-TX JACK WITH LED 6P & USB2.0 PROFILE=21.08MM (FULLY SHIELDED)

MATERIALS

Housing: PBT UL 94V-0, Black

Shell: Brass C2680 T=0.20, 85u"~135u" Ni Plated

RJ45 Terminal: Phosphor Bronze T=0.30mm,

Gold Au Plated on Contact Area

80u"~160u" Tin Plated on Solder Area

50u"~100u" Ni Underplated overall

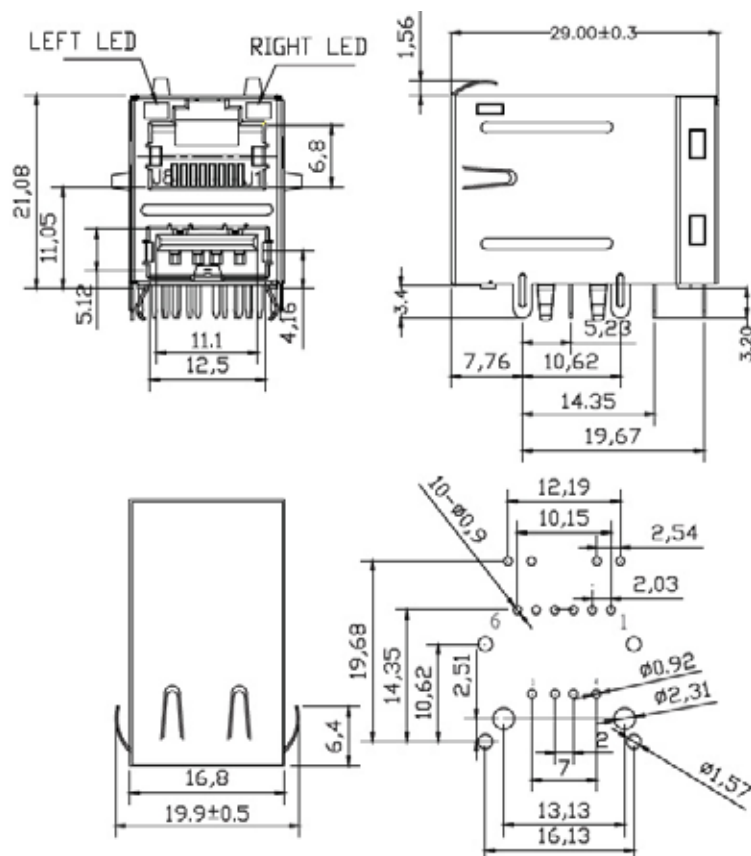
Other Terminal: Brass T=0.30mm, 80u"~160u" Tin Plated

50u"~100u" Ni Underplated overall

*RoHS & REACH compliant.

LED Designation:

Code	+/-	-/+	Code	+/-	-/+
N	Green	—	M	—	Green
Y	Yellow	—	Z	—	Yellow
8	Orange	—	Q	—	Orange
1	Green	Orange	2	Orange	Green
5	Green	Yellow	6	Yellow	Green



Recommended P.C.Board Layout

ORDERING INFORMATION:

P/N L T $\frac{xx}{1}$ - $\frac{6U}{2}$ $\frac{x}{3}$ B $\frac{xx}{4}$ $\frac{xx}{5}$

1. TYPE OF PANEL GROUNDS:

"87" NO TAB

"88" TOP TABS

"89" SIDE TABS

"90" TOP TABS & SIDE TABS

2. NO. OF POSITIONS & CONTACTS:

"6U" 6P8C + USB2.0

3. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

4. MAGNETIC SCHEMATICS:

10/100 BASE-TX

51, 52, 53, 54, 55, 56, 58, 59, 60, 63

10/100/1000 BASE-TX

G1, G3, G4, G6, G7, G8, G9, H0

SEE PAGE N5902~N5906 & N5941~N5943!

5. TYPE OF LED POLARITY:

(LED PIN DIRECTION FROM LEFT TO RIGHT)

1N, 1Y, 1Z, 5S, 58, 5Q, 8S, MM, MY, MZ, N5, NN,

NY, NZ, Q5, Y1, Y2, YM, YN, Z1, Z2, ZM, ZN

SIDE ENTRY UP LATCH MAGNETIC 10/100 & 10/100/1000 BASE-TX JACK WITH LED 12P & USB2.0 PROFILE=21.08MM (FULLY SHIELDED)

MATERIALS

Housing: PBT UL 94V-0, Black

Shell: Brass C2680 T=0.20, 85u"~135u" Ni Plated

RJ45 Terminal: Phosphor Bronze T=0.30mm,

Gold Au Plated on Contact Area

80u"~160u" Tin Plated on Solder Area

50u"~100u" Ni Underplated overall

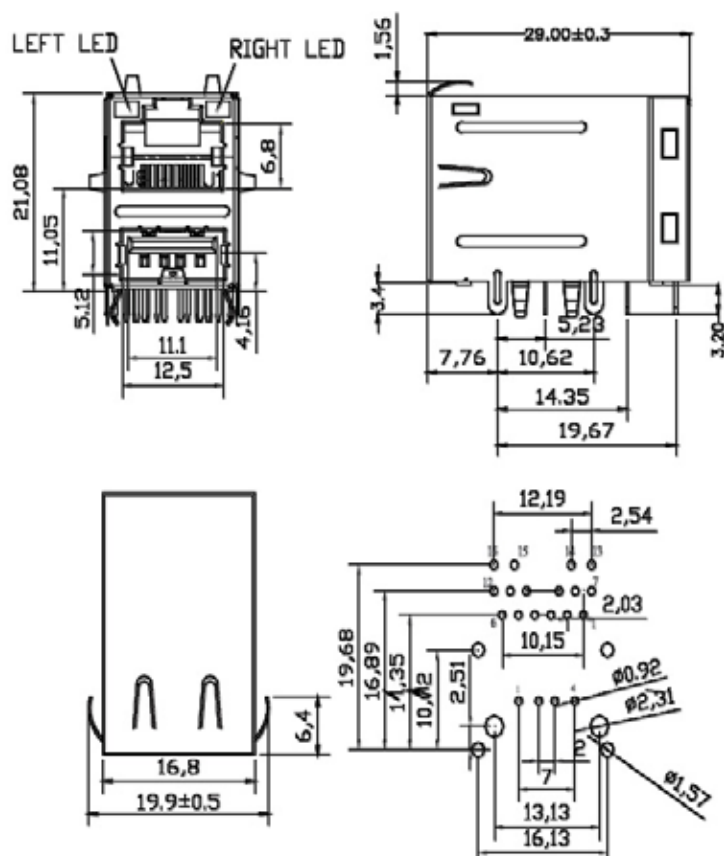
Other Terminal: Brass T=0.30mm, 80u"~160u" Tin Plated

50u"~100u" Ni Underplated overall

*RoHS & REACH compliant.

LED Designation:

Code	+/-	-/+	Code	+/-	-/+
N	Green	—	M	—	Green
Y	Yellow	—	Z	—	Yellow
8	Orange	—	Q	—	Orange
1	Green	Orange	2	Orange	Green
5	Green	Yellow	6	Yellow	Green



Recommended P.C.Board Layout

ORDERING INFORMATION:

P/N L T x x - T U x B x x x x
 1 2 3 4 5

1. TYPE OF PANEL GROUNDS:

"87" NO TAB

"88" TOP TABS

"89" SIDE TABS

"90" TOP TABS & SIDE TABS

2. NO. OF POSITIONS & CONTACTS:

"TU" 12P8C + USB2.0

3. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

4. MAGNETIC SCHEMATICS:

10/100 BASE-TX

51, 52, 53, 54, 55, 56, 58, 59, 60, 63

10/100/1000 BASE-TX

G1, G3, G4, G6, G7, G8, G9, H0

SEE PAGE N5902~N5906 & N5941~N5943!

5. TYPE OF LED POLARITY:

(LED PIN DIRECTION FROM LEFT TO RIGHT)

1N, 1Y, 1Z, 5S, 58, 5Q, 8S, MM, MY, MZ, N5, NN,

NY, NZ, Q5, Y1, Y2, YM, YN, Z1, Z2, ZM, ZN

SIDE ENTRY MAGNETIC 10/100 BASE-TX JACK OVER DUAL USB WITH LED 8P6C PROFILE=30.50MM (FULLY SHIELDED)

MATERIALS

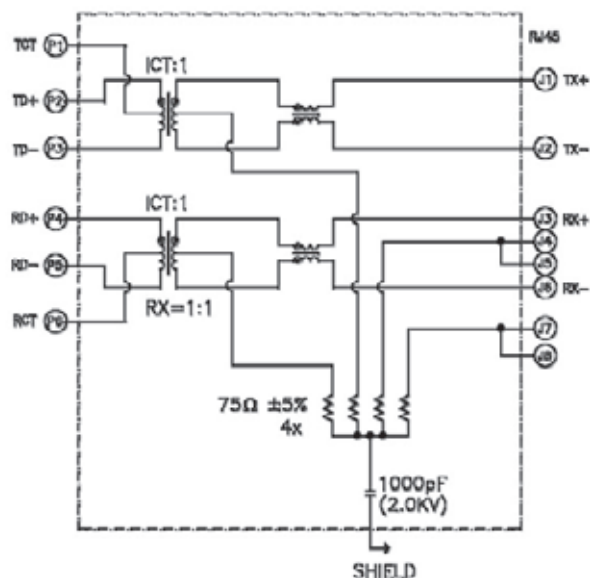
Housing: Thermoplastic

Contacts: Phosphor Bronze

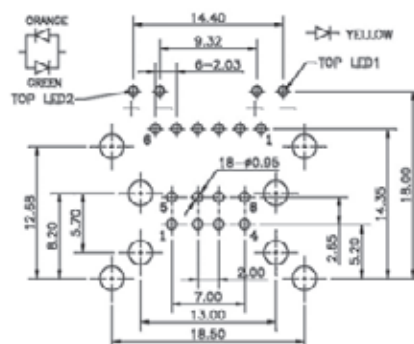
Plating: Gold plating Over Nickel in Contact
Tin plating Over Nickel in Solder Area

Shield: Brass Plating Nickel

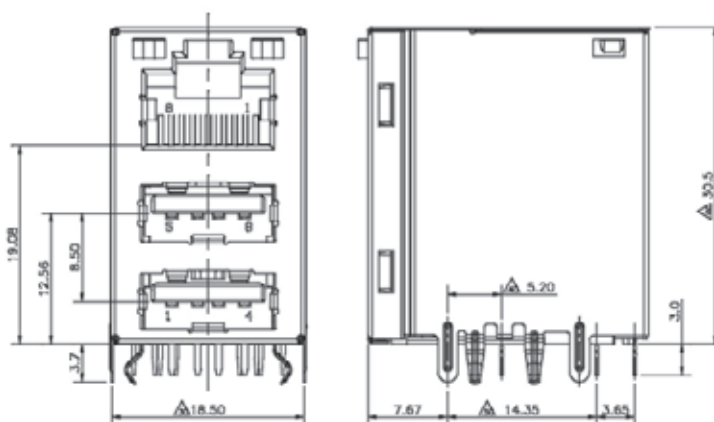
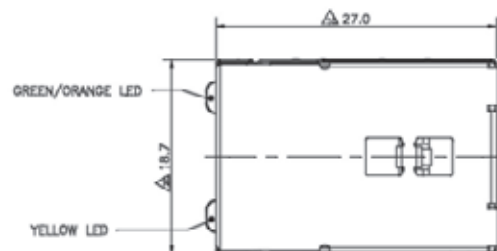
*RoHS & REACH compliant.



P/N LTUD-6UxB6V1Y



**Recommended P.C.Board Layout
(Top View)**



ORDERING INFORMATION:

P/N LTUD - $\frac{6}{1} \frac{U}{2} \times \frac{B}{3} \frac{6}{4} \frac{V}{1} \frac{1}{4} \frac{Y}{4}$

1. NO. OF POSITIONS & CONTACTS:
"6U" 8P6C + USB
2. CONTACT FINISH:
"A" 6 MICROINCH GOLD
"E" 3 MICROINCH GOLD
* USB CONTACT PLATING: 3 MICROINCH GOLD
3. MAGNETIC SCHEMATICS:
6V
4. TYPE OF LED POLARITY:
"1Y" LEFT LED = GREEN/ORANGE &
RIGHT LED = YELLOW

SIDE ENTRY MAGNETIC 10/100 BASE-TX JACK OVER DUAL USB WITH LED 8P8C PROFILE=30.50MM (FULLY SHIELDED)

MATERIALS

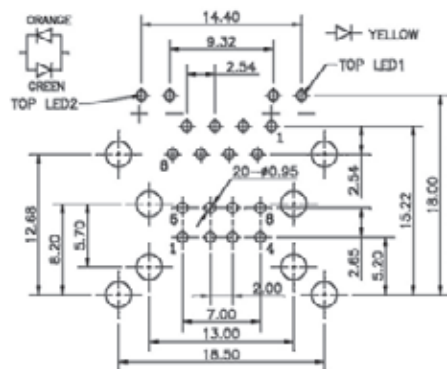
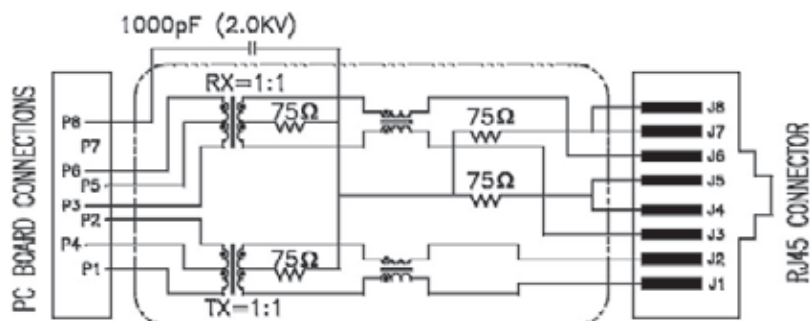
Housing: Thermoplastic

Contacts: Phosphor Bronze

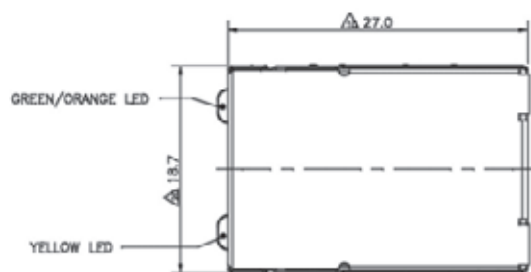
Plating: Gold plating Over Nickel in Contact
Tin plating Over Nickel in Solder Area

Shield: Brass Plating Nickel

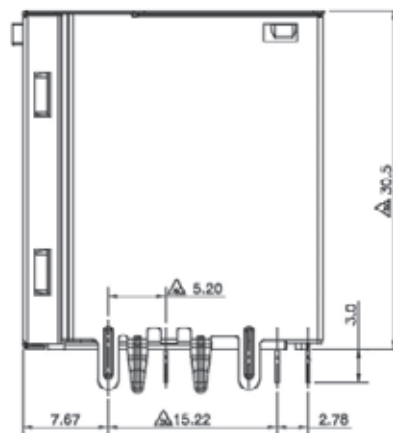
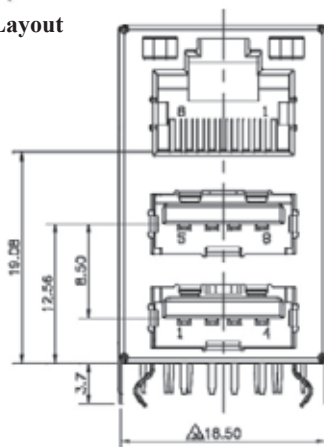
*RoHS & REACH compliant.



Recommended P.C. Board Layout
(Top View)



P/N LTUD-8UxB6V1Y



ORDERING INFORMATION:

P/N LTUE - $\frac{8U}{1} \times \frac{B061Y}{2 \quad 3 \quad 4}$

1. NO. OF POSITIONS & CONTACTS:
"8U" 8P8C + USB
2. CONTACT FINISH:
"A" 6 MICROINCH GOLD
"E" 3 MICROINCH GOLD
* USB CONTACT PLATING: 3 MICROINCH GOLD
3. MAGNETIC SCHEMATICS:
06
4. TYPE OF LED POLARITY:
"1Y" LEFT LED = GREEN/ORANGE &
RIGHT LED = YELLOW

SIDE ENTRY MAGNETIC 10/100/1000 (GIGABIT) BASE-TX JACK OVER DUAL USB WITH LED 10P8C PROFILE=30.50MM (FULLY SHIELDED)

MATERIALS

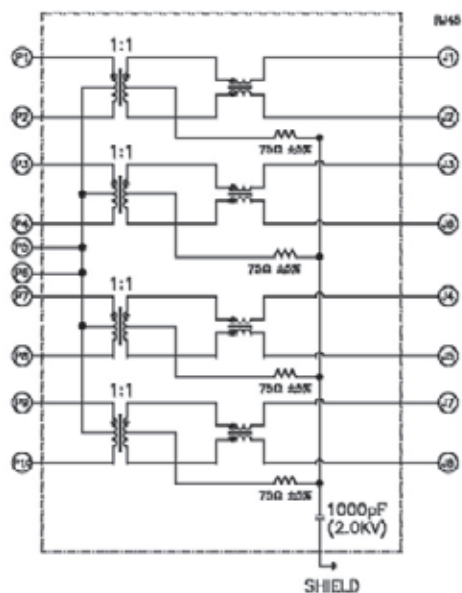
Housing: Thermoplastic

Contacts: Phosphor Bronze

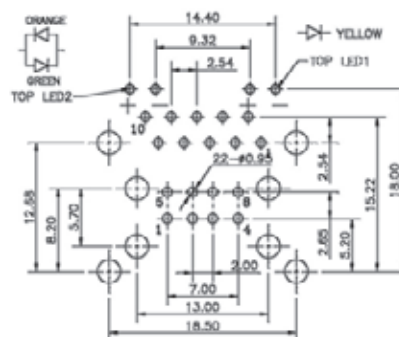
Plating: Gold plating Over Nickel in Contact
Tin plating Over Nickel in Solder Area

Shield: Brass Plating Nickel

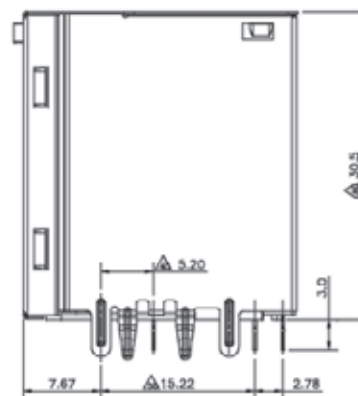
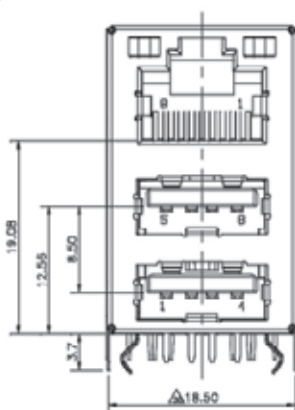
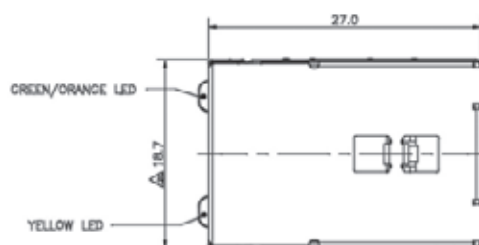
*RoHS & REACH compliant.



P/N LTGG-0UxB8V1Y



**Recommended P.C.Board Layout
(Top View)**



ORDERING INFORMATION:

P/N LTGG - $\frac{0}{1} \frac{U}{2} \times \frac{B}{3} \frac{8}{4} \frac{V}{1} \frac{Y}{4}$

1. NO. OF POSITIONS & CONTACTS:
"0U" 10P8C + USB
2. CONTACT FINISH:
"A" 6 MICROINCH GOLD
"E" 3 MICROINCH GOLD
* USB CONTACT PLATING: 3 MICROINCH GOLD
3. MAGNETIC SCHEMATICS:
8V
4. TYPE OF LED POLARITY:
"1Y" LEFT LED = GREEN/ORANGE &
RIGHT LED = YELLOW

SIDE ENTRY MAGNETIC 10/100 BASE-TX JACK WITH 2xUSB JACKS PROFILE=30.50MM (FULLY SHIELDED)

MATERIALS

Housing: High Temperature Thermoplastic UL 94V-0, Black

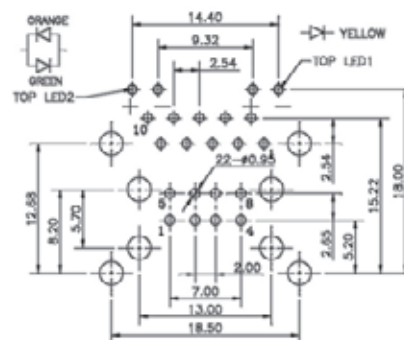
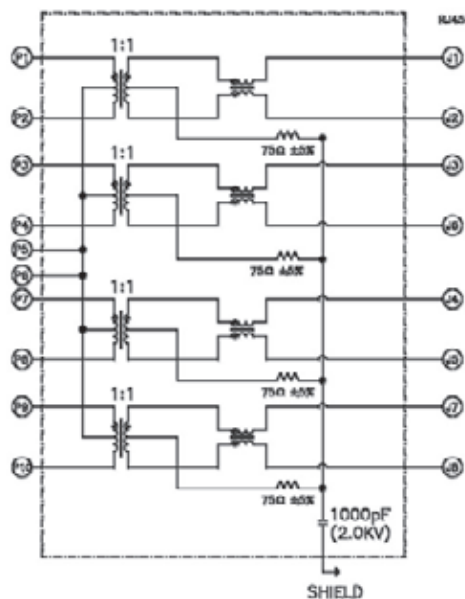
Contacts: 0.35mm Phosphor Bronze Plated,

Gold Plated on Contact Area

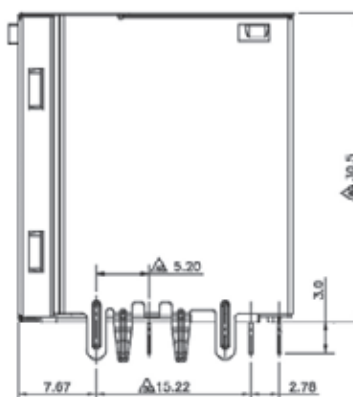
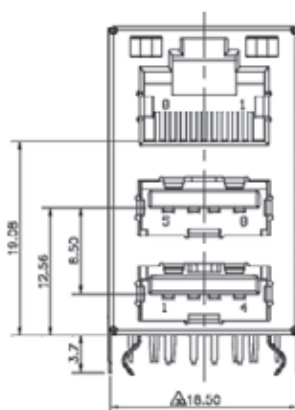
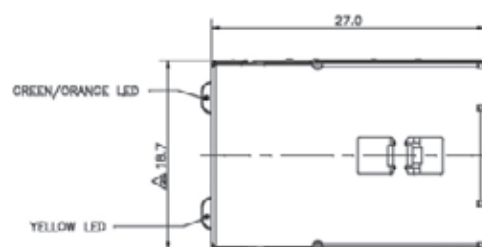
Solder Tin in Solder Area

Shield: 0.20mm Copper Alloy with Nickel

*RoHS & REACH compliant.



Recommended P.C.Board Layout
(Top View)



ORDERING INFORMATION:

P/N L T A E - $\frac{8U}{1} \times \frac{B}{2} \times \frac{x}{3}$

1. NO. OF POSITIONS & CONTACTS:

"8U" 8P8C + 2 x USB

2. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

"E" 3 MICROINCH GOLD

3. MAGNETIC SCHEMATICS:

99

SIDE ENTRY UP LATCH MAGNETIC 10/100 & 10/100/1000 BASE-TX JACK WITH LED 8P & USB2.0 PROFILE=30.55MM (FULLY SHIELDED)

MATERIALS

Housing: PBT UL 94V-0, Black

Shell: Brass C2680 T=0.20, 85u"~135u" Ni Plated

RJ45 Terminal: Phosphor Bronze T=0.30mm,

Gold Au Plated on Contact Area

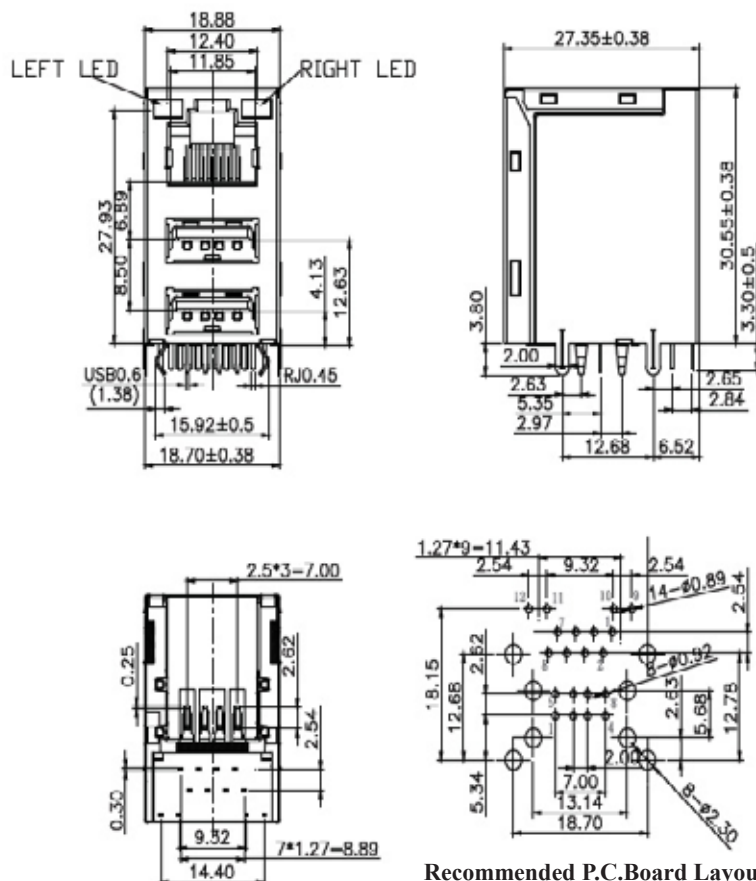
80u"~160u" Tin Plated on Solder Area

50u"~100u" Ni Underplated overall

Other Terminal: Brass T=0.30mm, 80u"~160u" Tin Plated

50u"~100u" Ni Underplated overall

*RoHS & REACH compliant.



Recommended P.C.Board Layout

ORDERING INFORMATION:

P/N LT 85 - 8U x B x x x x
I 2 3 4

1. NO. OF POSITIONS & CONTACTS:

"8U" 8P8C + USB2.0

2. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

3. MAGNETIC SCHEMATICS:

10/100 BASE-TX

51, 52, 53, 54, 55, 56, 58, 59, 60, 61, 62, 63, 64, 73, 81

10/100/1000 BASE-TX

G1, G3, G4, G6, G7, G8, G9, H0, J1, J2, J4

SEE PAGE N5902~N5906 & N5941~N5943!

4. TYPE OF LED POLARITY:

(LED PIN DIRECTION FROM LEFT TO RIGHT)

1N, 1Y, 1Z, 5S, 58, 5Q, 85, MM, MY, MZ, N5, NN, NY, NZ, Q5, Y1, Y2, YM, YN, Z1, Z2, ZM, ZN

LED Designation:

Code	+/-	-/+	Code	+/-	-/+
N	Green	—	M	—	Green
Y	Yellow	—	Z	—	Yellow
8	Orange	—	Q	—	Orange
1	Green	Orange	2	Orange	Green
5	Green	Yellow	6	Yellow	Green

SIDE ENTRY UP LATCH MAGNETIC 10/100 & 10/100/1000 BASE-TX JACK WITH LED 10P & USB2.0 PROFILE=30.55MM (FULLY SHIELDED)

MATERIALS

Housing: PBT UL 94V-0, Black

Shell: Brass C2680 T=0.20, 85u"~135u" Ni Plated

RJ45 Terminal: Phosphor Bronze T=0.30mm,

Gold Au Plated on Contact Area

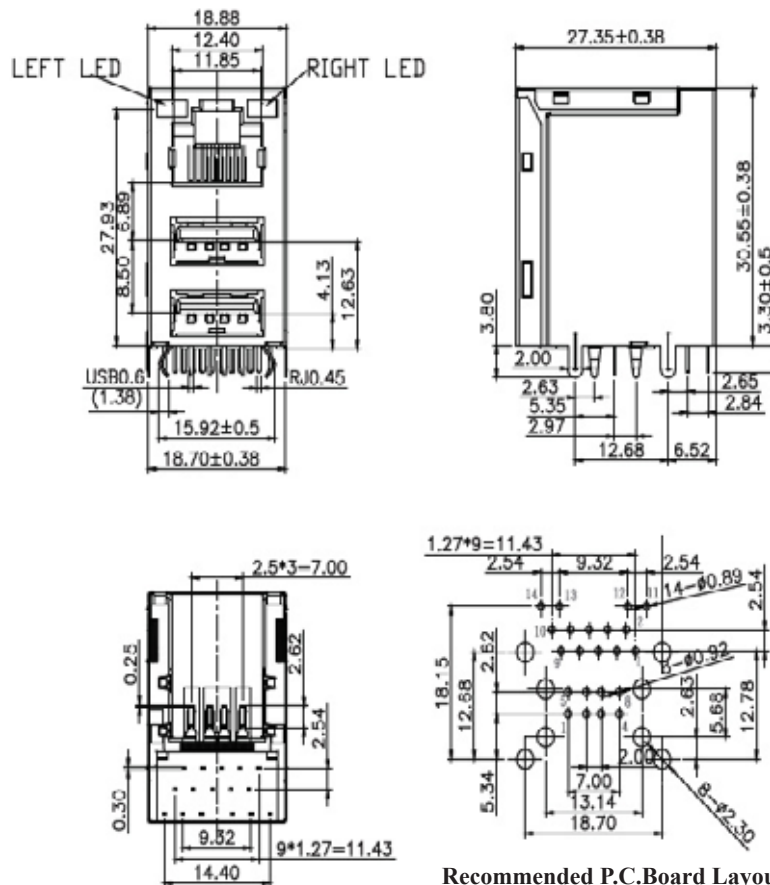
80u"~160u" Tin Plated on Solder Area

50u"~100u" Ni Underplated overall

Other Terminal: Brass T=0.30mm, 80u"~160u" Tin Plated

50u"~100u" Ni Underplated overall

*RoHS & REACH compliant.



Recommended P.C.Board Layout

ORDERING INFORMATION:

P/N LT 85 - 0U x B x x x x
I 2 3 4

1. NO. OF POSITIONS & CONTACTS:

"0U" 10P8C + USB2.0

2. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

3. MAGNETIC SCHEMATICS:

10/100 BASE-TX

51, 52, 53, 54, 55, 56, 58, 59, 60, 61, 62, 63, 64, 73, 81

10/100/1000 BASE-TX

G1, G3, G4, G6, G7, G8, G9, H0, J1, J2, J4

SEE PAGE N5902~N5906 & N5941~N5943!

4. TYPE OF LED POLARITY:

(LED PIN DIRECTION FROM LEFT TO RIGHT)

1N, 1Y, 1Z, 5S, 58, 5Q, 8S, MM, MY, MZ, N5, NN, NY, NZ, Q5, Y1, Y2, YM, YN, Z1, Z2, ZM, ZN

LED Designation:

Code	+/-	-/+	Code	+/-	-/+
N	Green	—	M	—	Green
Y	Yellow	—	Z	—	Yellow
8	Orange	—	Q	—	Orange
1	Green	Orange	2	Orange	Green
5	Green	Yellow	6	Yellow	Green

SIDE ENTRY UP LATCH MAGNETIC 10/100/1000 (GIGABIT) BASE-TX JACK WITH LED 10P & USB3.0 PROFILE=30.55MM (FULLY SHIELDED)

MATERIALS

Housing: PBT UL 94V-0, Black

Shell: Brass C2680 T=0.20, 85u"~135u" Ni Plated

RJ45 Terminal: Phosphor Bronze T=0.30mm,

Gold Au Plated on Contact Area

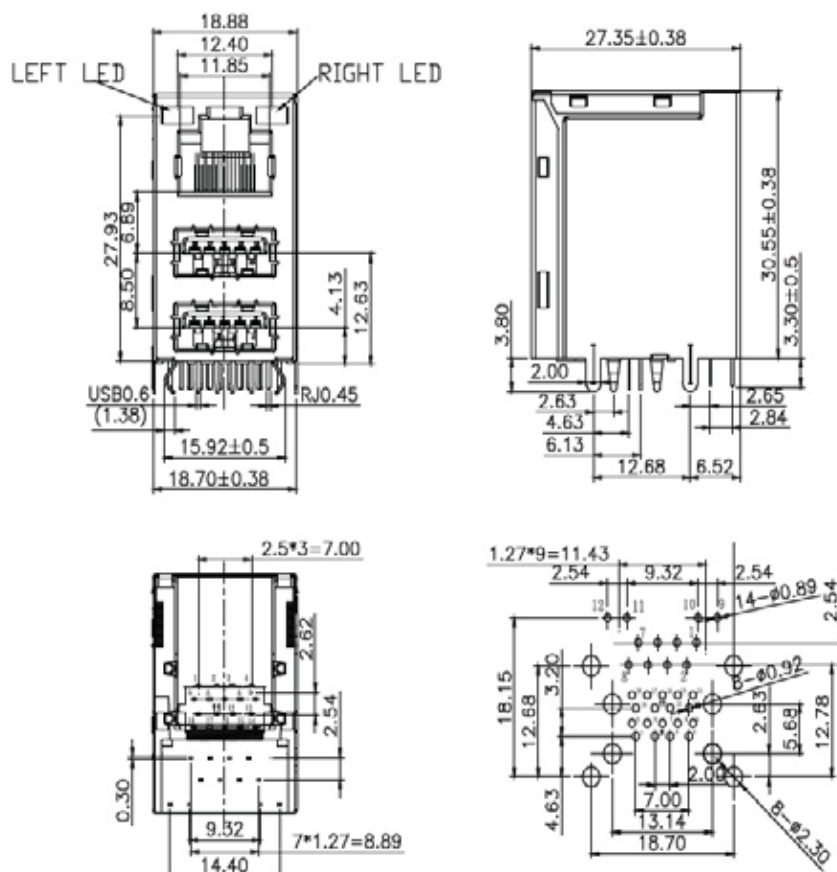
80u"~160u" Tin Plated on Solder Area

50u"~100u" Ni Underplated overall

Other Terminal: Brass T=0.30mm, 80u"~160u" Tin Plated

50u"~100u" Ni Underplated overall

*RoHS & REACH compliant.



Recommended P.C.Board Layout

ORDERING INFORMATION:

P/N LT 9 1 - 0 U x B x x x x
I 2 3 4

1. NO. OF POSITIONS & CONTACTS:

"0U" 10P8C + USB3.0

2. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

3. MAGNETIC SCHEMATICS:

10/100/1000 BASE-TX

G1, G2, G3, G6, G7, G8, G9, H0

SEE PAGE N5941~N5943!

4. TYPE OF LED POLARITY:

(LED PIN DIRECTION FROM LEFT TO RIGHT)

1N, 1Y, 1Z, 5S, 58, 5Q, 8S, MM, MY, MZ, N5, NN, NY, NZ, Q5, Y1, Y2, YM, YN, Z1, Z2, ZM, ZN

LED Designation:

Code	+/-	-/+	Code	+/-	-/+
N	Green	—	M	—	Green
Y	Yellow	—	Z	—	Yellow
8	Orange	—	Q	—	Orange
1	Green	Orange	2	Orange	Green
5	Green	Yellow	6	Yellow	Green

SIDE ENTRY 4-PORT MAGNETIC 10/100 BASE-TX JACK WITH LED 8P PROFILE=12.60MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: Nylon (UL 94V-0)

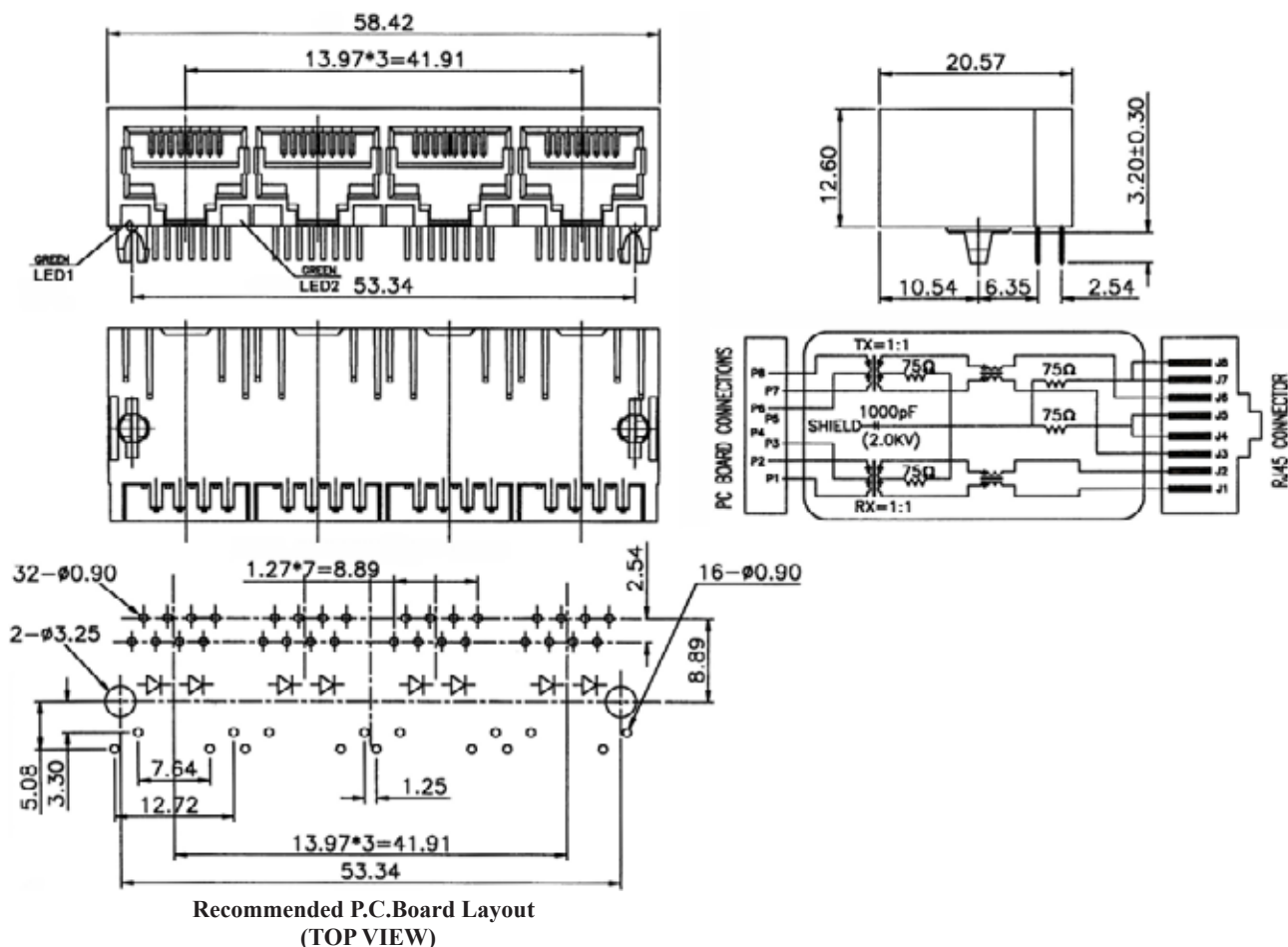
Soldering Temperature: 260°C

Color: Black

Spring Wire: Phosphor Bronze

Gold plating Over Nickel

*RoHS & REACH compliant.



ORDERING INFORMATION:

P/N L T M 8 - $\frac{8}{1} \frac{8}{2} \frac{x}{3} \frac{B}{4} \frac{0}{5} \frac{1}{4} \frac{x}{4} \frac{x}{4} \frac{0}{4} \frac{4}{5}$

1. NO. OF POSITIONS & CONTACTS:

"88" 8P8C

2. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

3. MAGNETIC SCHEMATICS:

01

4. COLORS OF LED:

"XX" W/O LED

"NN" LED1: GREEN & LED2: GREEN

"NY" LED1: GREEN & LED2: YELLOW

"YN" LED1: YELLOW & LED2: GREEN

"YY" LED1: YELLOW & LED2: YELLOW

OTHER LED COLORS UPON REQUEST!

5. NO. OF PORTS:

04

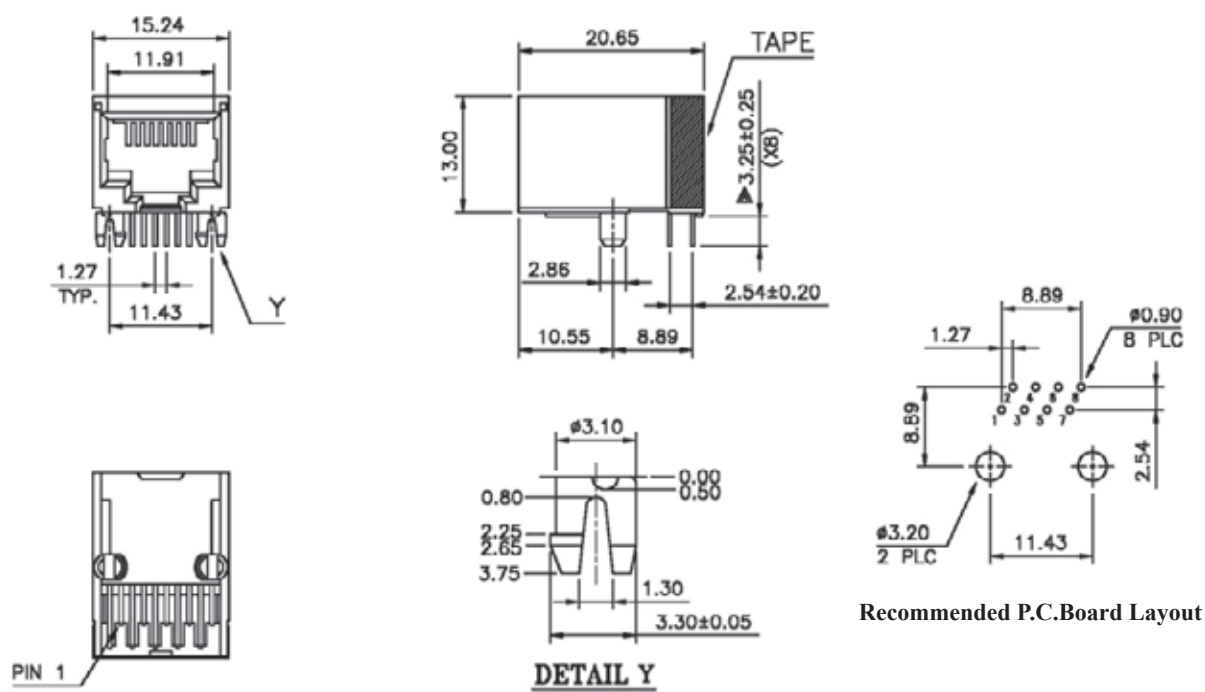
SIDE ENTRY MAGNETIC 10/100 BASE-TX JACK WITHOUT LED PROFILE=13.00MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Black
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
***RoHS & REACH compliant.**



ORDERING INFORMATION:

P/N M J Q T - $\frac{88}{1} \frac{x}{2} \frac{B}{3} \frac{x}{3}$

1. NO. OF POSITIONS & CONTACTS:
"88" 8P8C
2. CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD
3. MAGNETIC SCHEMATICS:
(UPON REQUEST!)

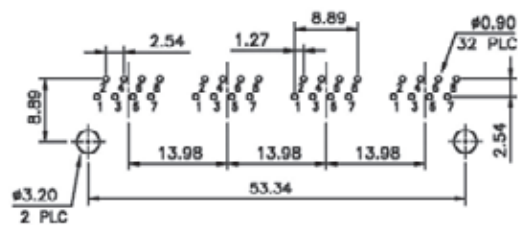
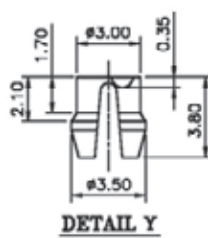
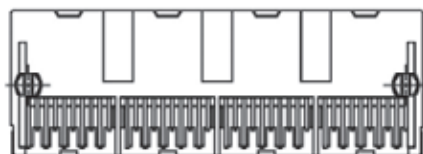
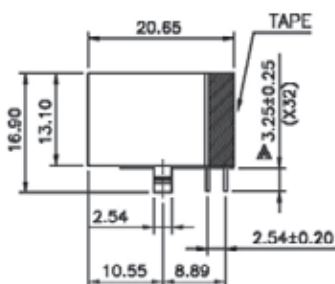
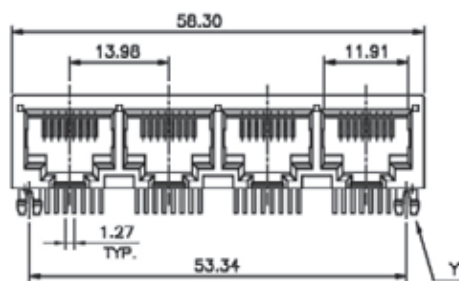
SIDE ENTRY 4-PORT MAGNETIC 10/100 BASE-T JACK WITHOUT LED PROFILE=13.10MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Black
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
***RoHS & REACH compliant.**



Recommended P.C.Board Layout

ORDERING INFORMATION:

P/N M J Q T - $\frac{88}{1} \times \frac{B}{2} \times \frac{04}{3}$

1. NO. OF POSITIONS & CONTACTS:
"88" 8P8C
2. CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD
3. MAGNETIC SCHEMATICS:
(UPON REQUEST!)
4. NO. OF PORTS:
04

TOP ENTRY MAGNETIC 10/100 & 10/100/1000 BASE-TX JACK WITHOUT LED 8P PROFILE=16.85MM (FULLY SHIELDED)

MATERIALS

Housing: PBT UL 94V-0, Black

Shell: Brass C2680 T=0.20, 85u"~135u" Ni Plated

RJ45 Terminal: Phosphor Bronze T=0.30mm,

Gold Au Plated on Contact Area

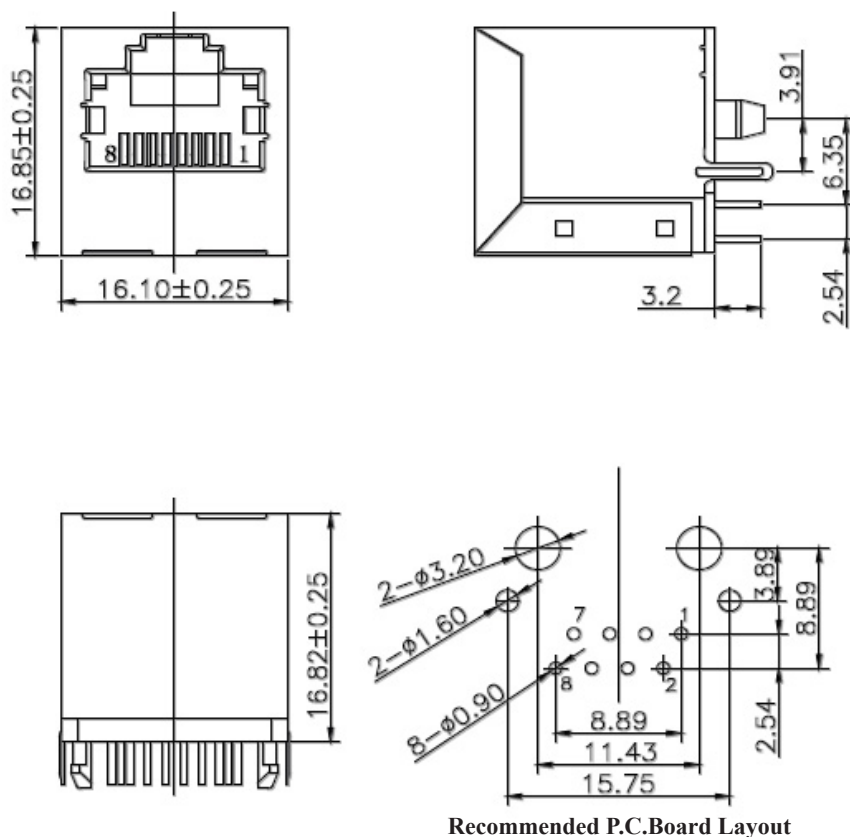
80u"~160u" Tin Plated on Solder Area

50u"~100u" Ni Underplated overall

Other Terminal: Brass T=0.30mm, 80u"~160u" Tin Plated

50u"~100u" Ni Underplated overall

*RoHS & REACH compliant.



Recommended P.C.Board Layout

ORDERING INFORMATION:

P/N LT 2 1 - $\frac{88}{1} \times \frac{B}{2} \times \frac{x}{3}$

1. NO. OF POSITIONS & CONTACTS:

"88" 8P8C

2. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

3. MAGNETIC SCHEMATICS:

10/100 BASE-TX

51, 52, 53, 54, 55, 56, 57, 58, 59, 60, 62, 64, 73

10/100/1000 BASE-TX

G1, G3, G4, G6, G7, G8, G9, H0, J1, J9

SEE PAGE N5902~N5906 & N5941~N5943!

TOP ENTRY MAGNETIC 10/100 & 10/100/1000 BASE-TX JACK WITH LED 8P PROFILE=16.85MM (FULLY SHIELDED)

MATERIALS

Housing: PBT UL 94V-0, Black

Shell: Brass C2680 T=0.20, 85u"~135u" Ni Plated

RJ45 Terminal: Phosphor Bronze T=0.30mm,

Gold Au Plated on Contact Area

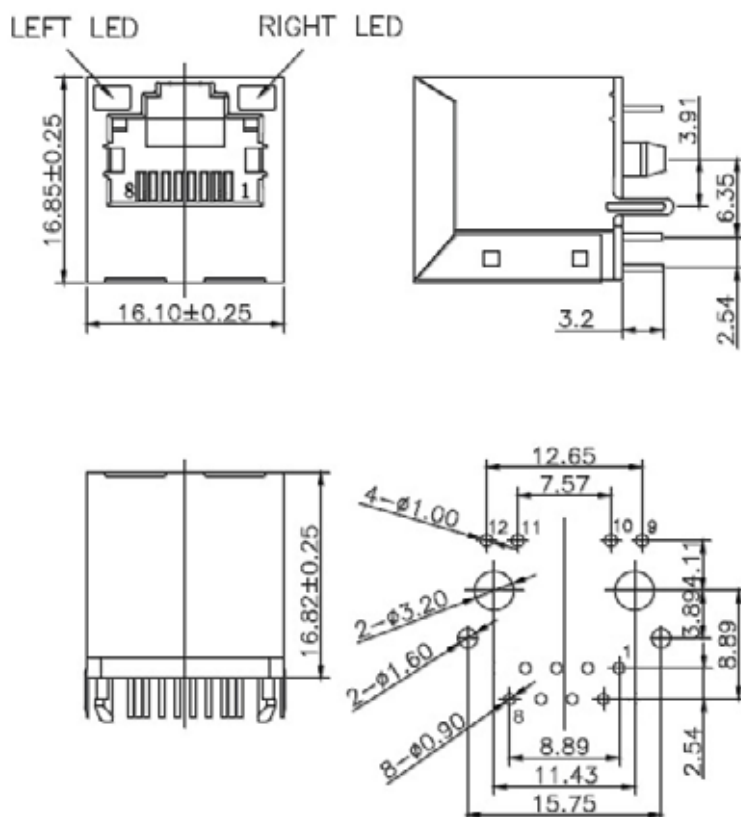
80u"~160u" Tin Plated on Solder Area

50u"~100u" Ni Underplated overall

Other Terminal: Brass T=0.30mm, 80u"~160u" Tin Plated

50u"~100u" Ni Underplated overall

*RoHS & REACH compliant.



Recommended P.C.Board Layout

ORDERING INFORMATION:

P/N L T 2 2 - $\frac{88}{12}$ x B $\frac{x}{3}$ x x x

1. NO. OF POSITIONS & CONTACTS:

"88" 8P8C

2. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

3. MAGNETIC SCHEMATICS:

10/100 BASE-TX

51, 52, 53, 54, 55, 56, 57, 58, 59, 60, 62, 64, 73

10/100/1000 BASE-TX

G1, G3, G4, G6, G7, G8, G9, H0, J1, J9

SEE PAGE N5902~N5906 & N5941~N5943!

4. TYPE OF LED POLARITY:

(LED PIN DIRECTION FROM LEFT TO RIGHT)

1N, 1Y, 1Z, 5S, 58, 5Q, 8S, MM, MY, MZ, N5, NN, NY, NZ, Q5, Y1, Y2, YM, YN, Z1, Z2, ZM, ZN

LED Designation:

Code	+/-	-/+	Code	+/-	-/+
N	Green	—	M	—	Green
Y	Yellow	—	Z	—	Yellow
8	Orange	—	Q	—	Orange
1	Green	Orange	2	Orange	Green
5	Green	Yellow	6	Yellow	Green

NOTE: LED PINS ARE PARALLEL.

TOP ENTRY MAGNETIC 10/100 & 10/100/1000 BASE-TX JACK WITHOUT LED 10P PROFILE=16.85MM (FULLY SHIELDED)

MATERIALS

Housing: PBT UL 94V-0, Black

Shell: Brass C2680 T=0.20, 85u"~135u" Ni Plated

RJ45 Terminal: Phosphor Bronze T=0.30mm,

Gold Au Plated on Contact Area

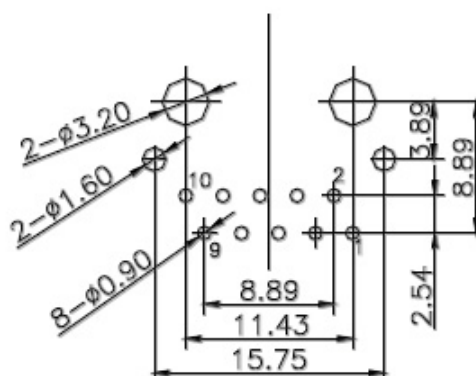
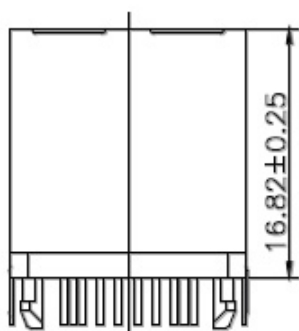
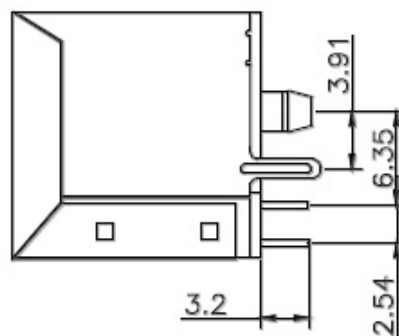
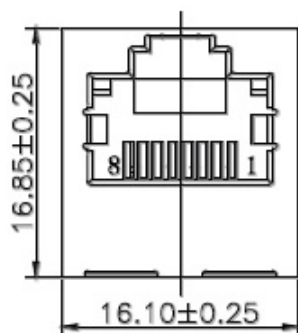
80u"~160u" Tin Plated on Solder Area

50u"~100u" Ni Underplated overall

Other Terminal: Brass T=0.30mm, 80u"~160u" Tin Plated

50u"~100u" Ni Underplated overall

*RoHS & REACH compliant.



Recommended P.C.Board Layout

ORDERING INFORMATION:

P/N L T 2 1 - $\frac{08}{1} \times \frac{B}{2} \times \frac{x}{3}$

1. NO. OF POSITIONS & CONTACTS:

"08" 10P8C

2. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

3. MAGNETIC SCHEMATICS:

10/100 BASE-TX

51, 52, 53, 54, 55, 56, 57, 58, 59, 60, 62, 64, 73

10/100/1000 BASE-TX

G1, G3, G4, G6, G7, G8, G9, H0, J1, J9

SEE PAGE N5902~N5906 & N5941~N5943!

TOP ENTRY MAGNETIC 10/100 & 10/100/1000 BASE-TX JACK WITH LED 10P PROFILE=16.85MM (FULLY SHIELDED)

MATERIALS

Housing: PBT UL 94V-0, Black

Shell: Brass C2680 T=0.20, 85u"~135u" Ni Plated

RJ45 Terminal: Phosphor Bronze T=0.30mm,

Gold Au Plated on Contact Area

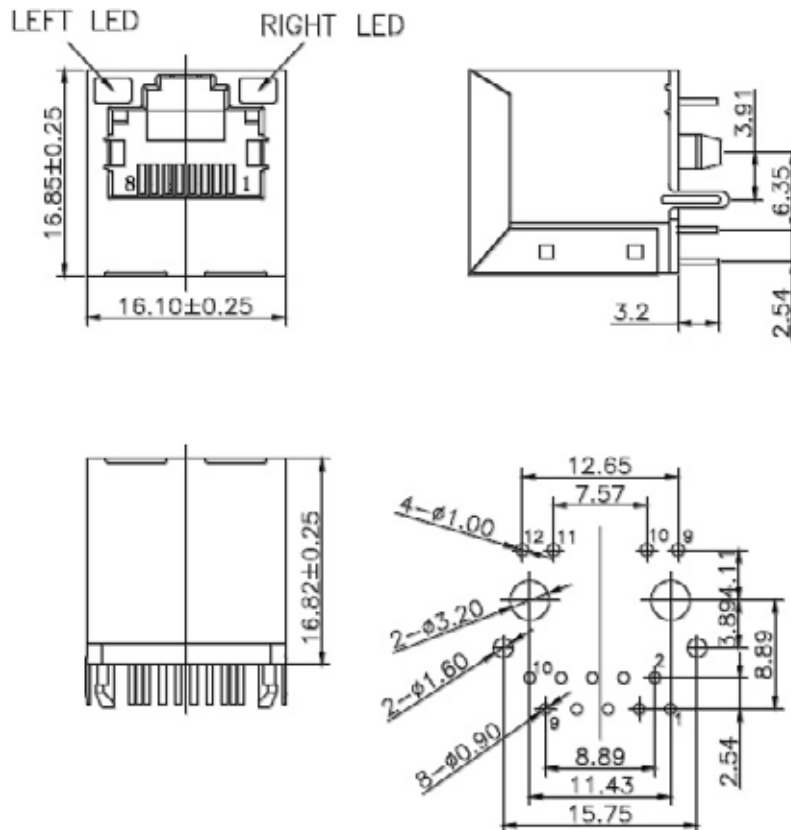
80u"~160u" Tin Plated on Solder Area

50u"~100u" Ni Underplated overall

Other Terminal: Brass T=0.30mm, 80u"~160u" Tin Plated

50u"~100u" Ni Underplated overall

*RoHS & REACH compliant.



Recommended P.C.Board Layout

ORDERING INFORMATION:

P/N L T 2 2 - $\frac{08}{1} \times \frac{2}{2}$ B $\frac{x}{3} \times \frac{x}{3} \times \frac{x}{4}$

1. NO. OF POSITIONS & CONTACTS:

"08" 10P8C

2. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

3. MAGNETIC SCHEMATICS:

10/100 BASE-TX

51, 52, 53, 54, 55, 56, 57, 58, 59, 60, 62, 64, 73

10/100/1000 BASE-TX

G1, G3, G4, G6, G7, G8, G9, H0, J1, J9

SEE PAGE N5902~N5906 & N5941~N5943!

4. TYPE OF LED POLARITY:

(LED PIN DIRECTION FROM LEFT TO RIGHT)

1N, 1Y, 1Z, 55, 58, 5Q, 85, MM, MY, MZ, N5, NN, NY, NZ, Q5, Y1, Y2, YM, YN, Z1, Z2, ZM, ZN

LED Designation:

Code	+/-	-/+	Code	+/-	-/+
N	Green	—	M	—	Green
Y	Yellow	—	Z	—	Yellow
8	Orange	—	Q	—	Orange
1	Green	Orange	2	Orange	Green
5	Green	Yellow	6	Yellow	Green

NOTE: LED PINS ARE PARALLEL.

TOP ENTRY MAGNETIC 10/100 BASE-TX JACK WITHOUT LED 8P PROFILE=17.10MM (FULLY SHIELDED)

MATERIALS

Housing: High Temperature Thermoplastic UL 94V-0, Black

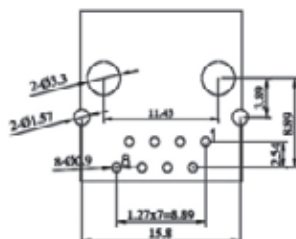
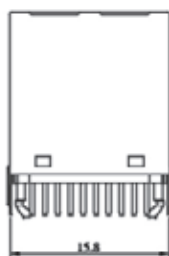
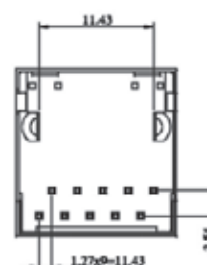
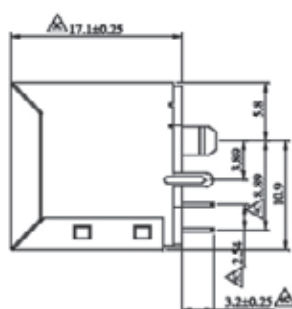
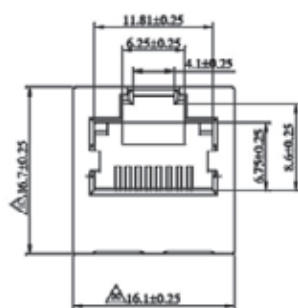
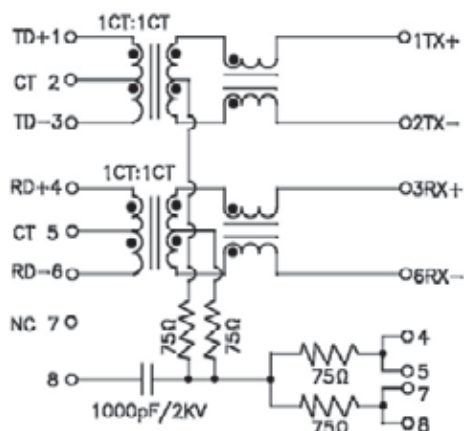
Contacts: 0.35mm Phosphor Bronze Plated,

Gold Plated on Contact Area

Solder Tin in Solder Area

Shield: 0.20mm Copper Alloy with Nickel

*RoHS & REACH compliant.



Recommended P.C.Board Layout

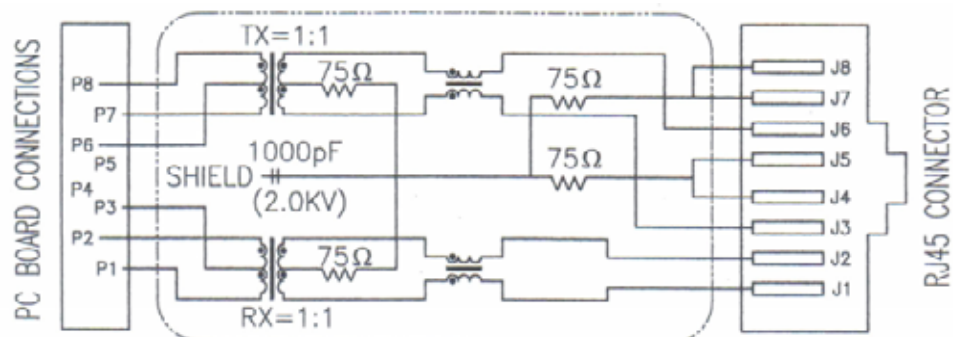
ORDERING INFORMATION:

P/N LTAC - $\frac{88}{1} \times \frac{B}{2} \frac{53}{3}$

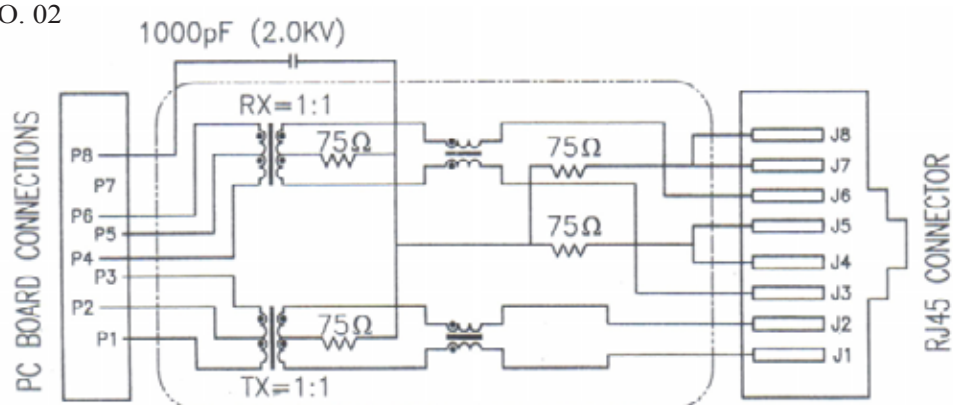
1. NO. OF POSITIONS & CONTACTS:
"88" 8P8C
2. CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD
3. MAGNETIC SCHEMATICS:
53

MAGNETIC SCHEMATICS 10/100 BASE-TX TYPES

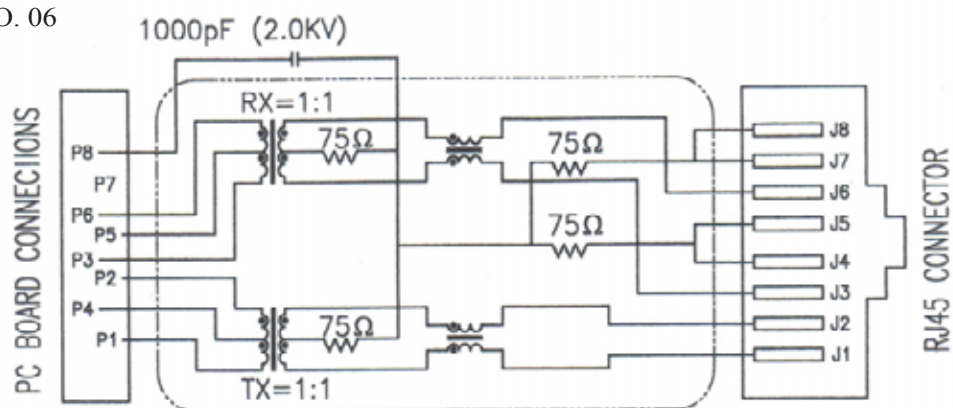
SCHEMATIC NO. 01



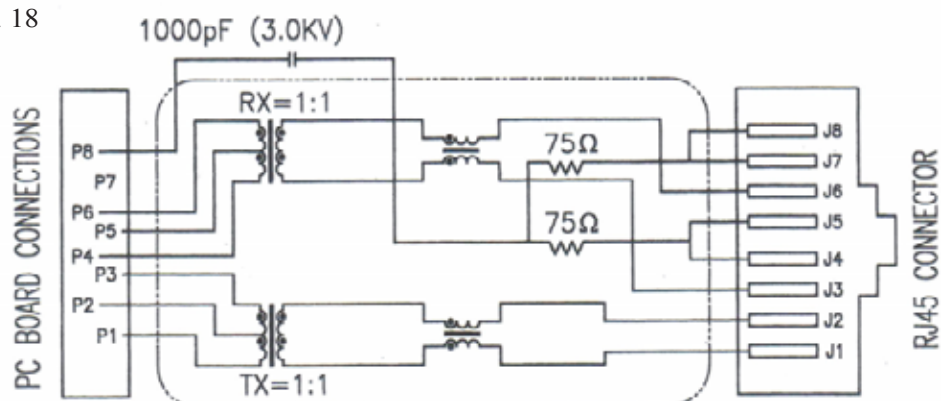
SCHEMATIC NO. 02



SCHEMATIC NO. 06

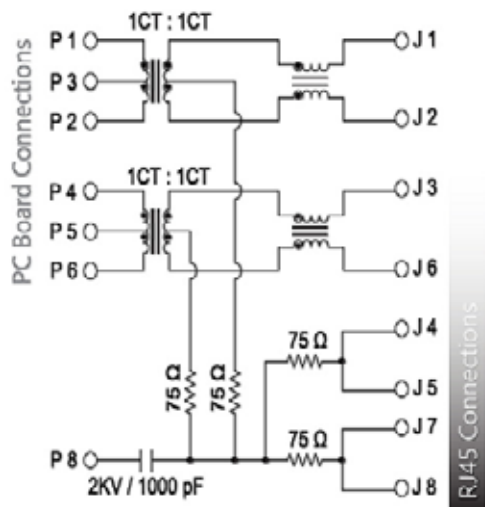


SCHEMATIC NO. 18

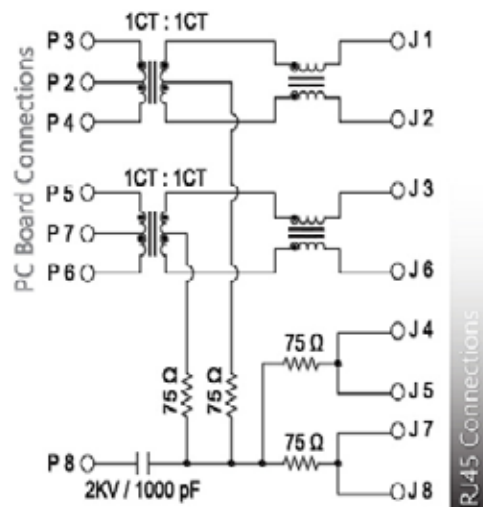


MAGNETIC SCHEMATICS 10/100 BASE-TX TYPES

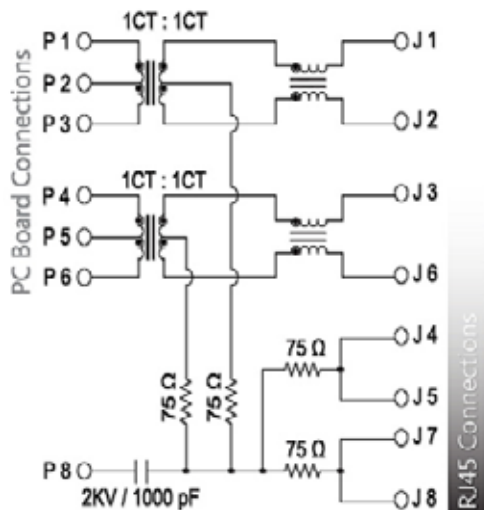
SCHEMATIC NO. 51



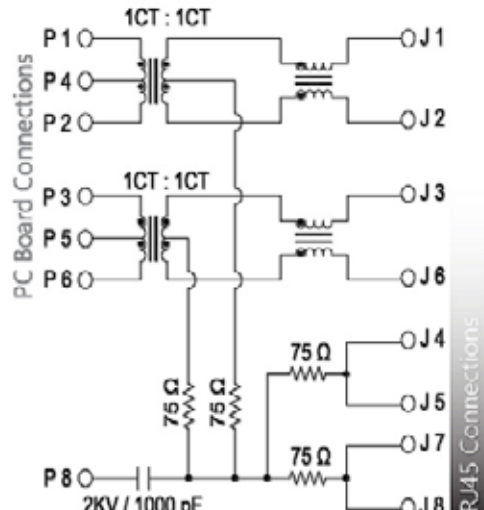
SCHEMATIC NO. 52



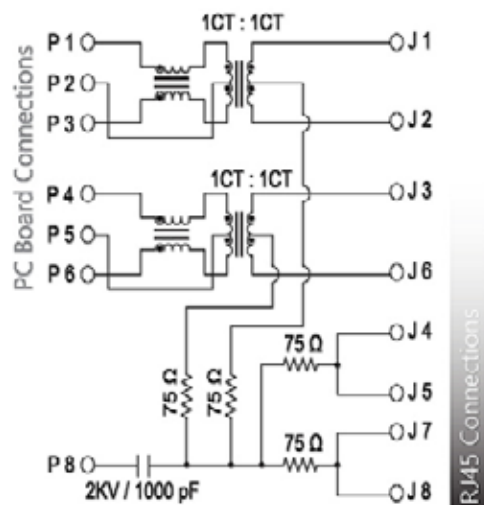
SCHEMATIC NO. 53



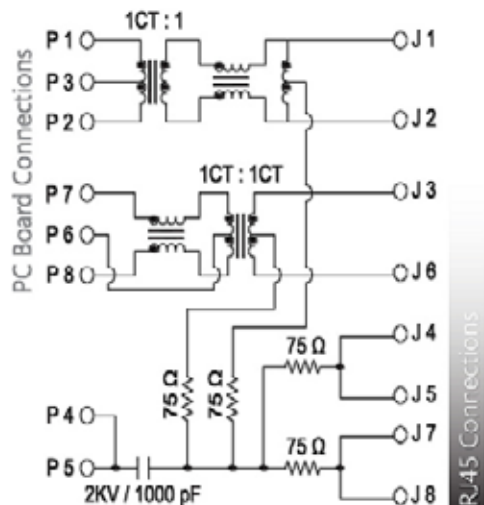
SCHEMATIC NO. 54



SCHEMATIC NO. 55

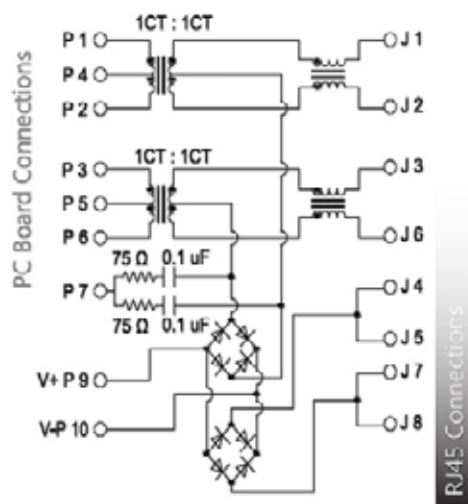


SCHEMATIC NO. 56

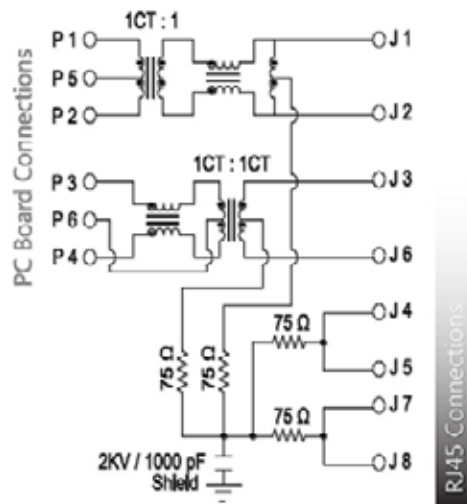


MAGNETIC SCHEMATICS 10/100 BASE-TX TYPES

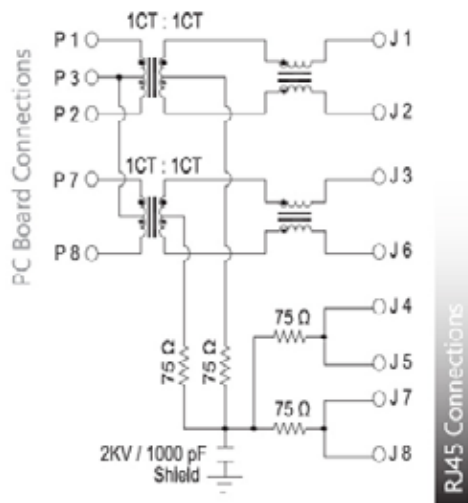
SCHEMATIC NO. 57 (POE)



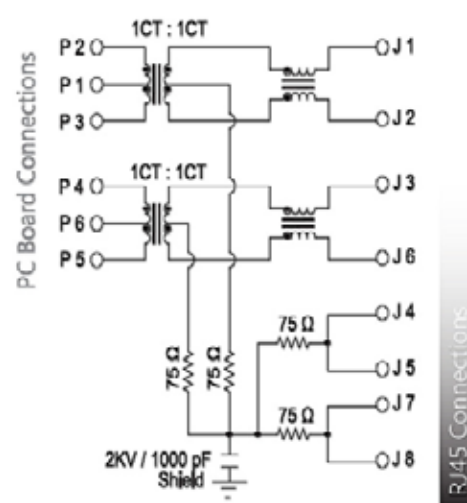
SCHEMATIC NO. 58



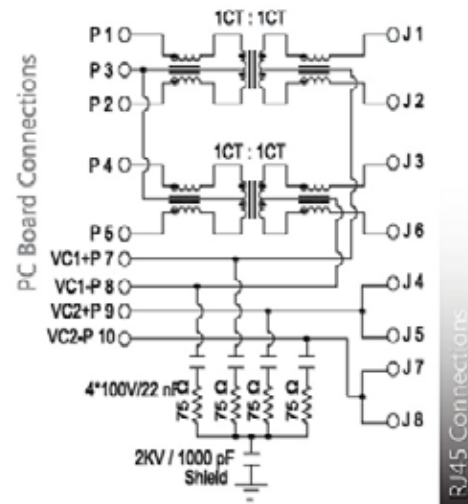
SCHEMATIC NO. 59



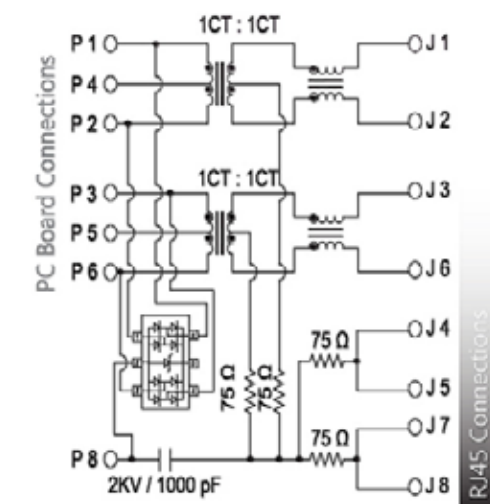
SCHEMATIC NO. 60



SCHEMATIC NO. 61 (POE)

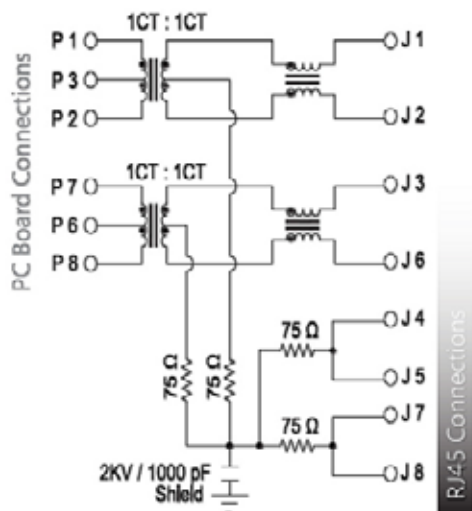


SCHEMATIC NO. 62 (SURGE)

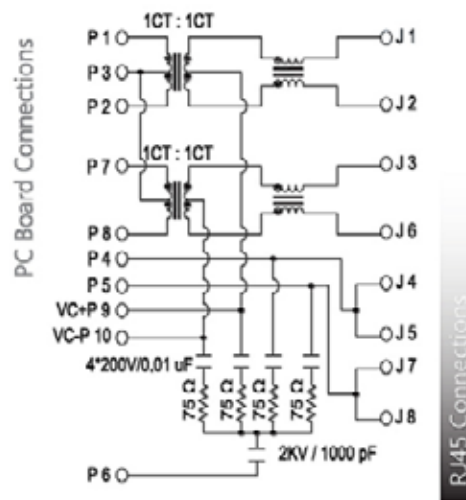


MAGNETIC SCHEMATICS 10/100 BASE-TX TYPES

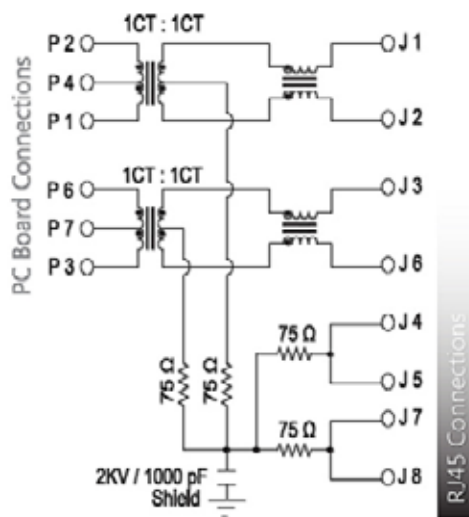
SCHEMATIC NO. 63



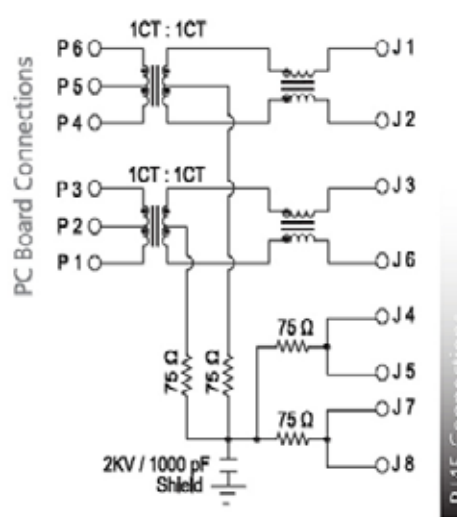
SCHEMATIC NO. 64 (POE)



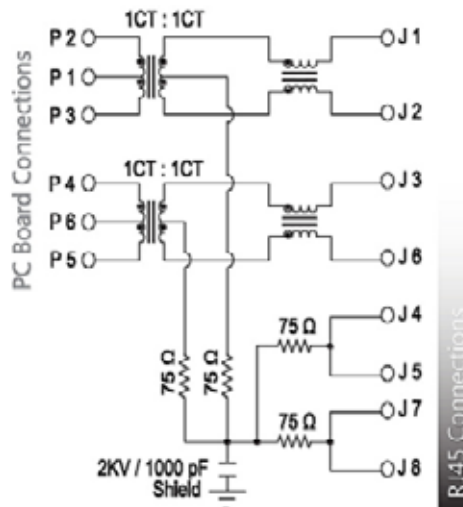
SCHEMATIC NO. 65



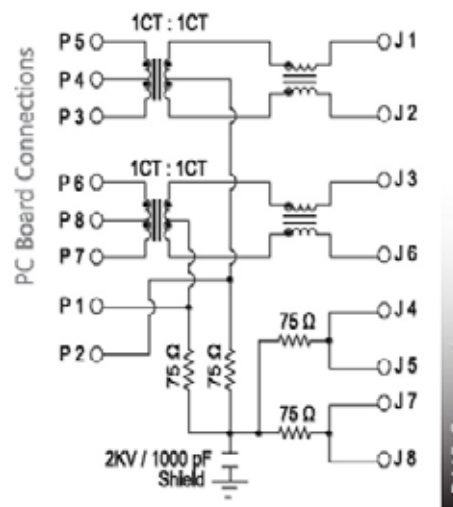
SCHEMATIC NO. 66 (POE)



SCHEMATIC NO. 67

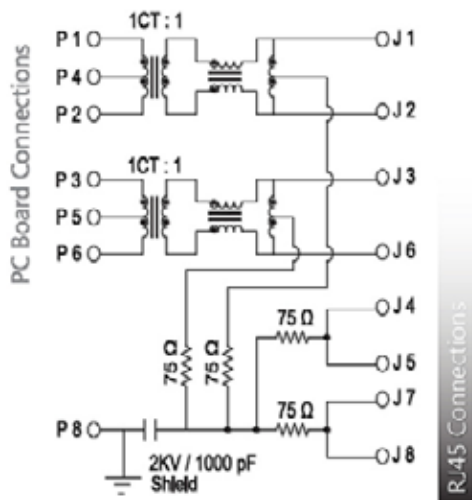


SCHEMATIC NO. 68

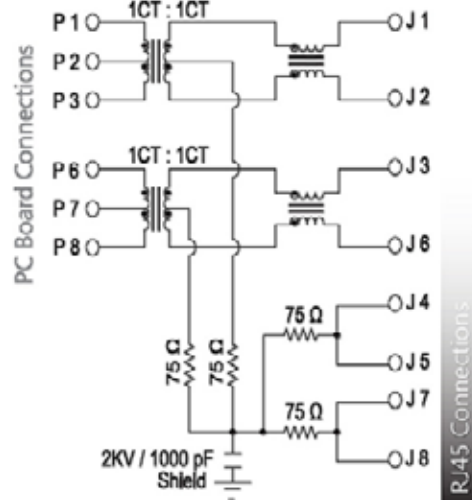


MAGNETIC SCHEMATICS 10/100 BASE-TX TYPES

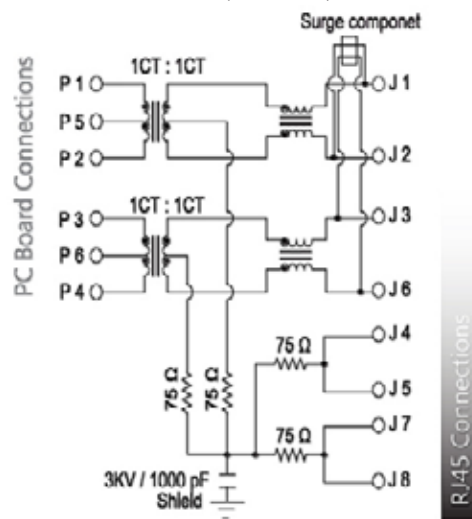
SCHEMATIC NO. 69



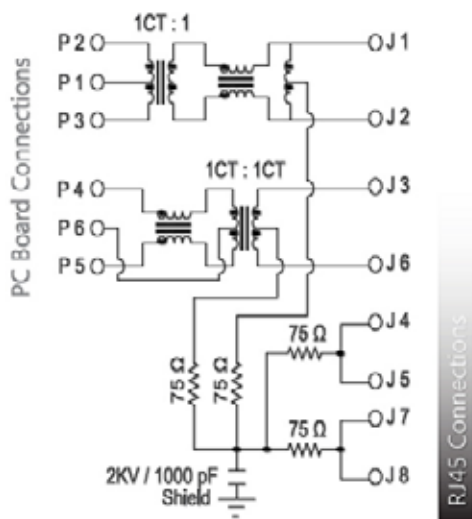
SCHEMATIC NO. 70



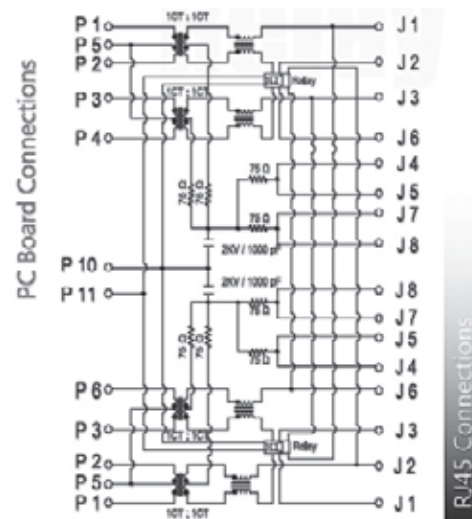
SCHEMATIC NO. 73 (SURGE)



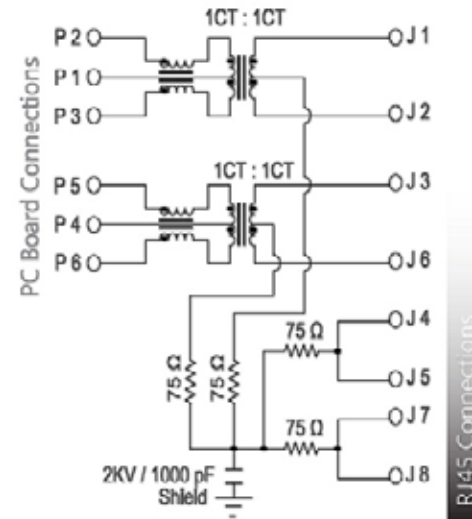
SCHEMATIC NO. 74



SCHEMATIC NO. 75

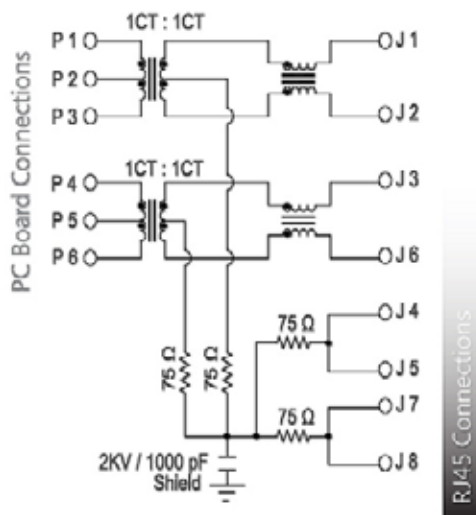


SCHEMATIC NO. 76

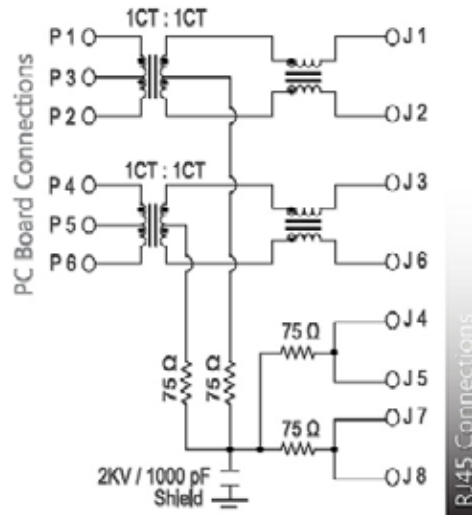


MAGNETIC SCHEMATICS 10/100 BASE-TX TYPES

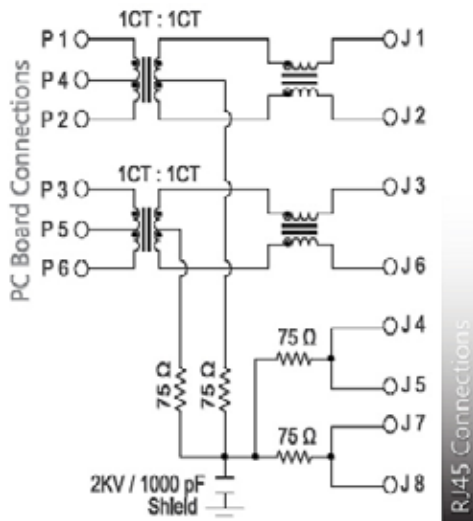
SCHEMATIC NO. 77



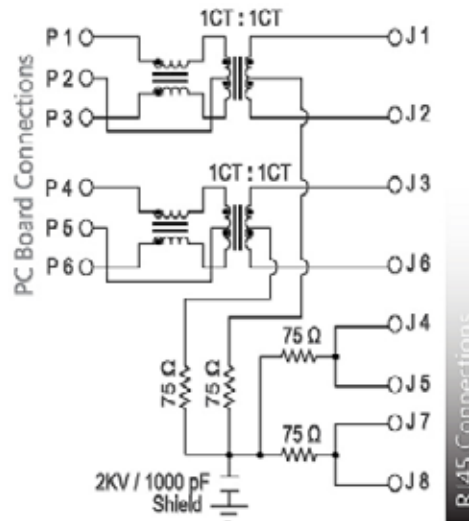
SCHEMATIC NO. 78



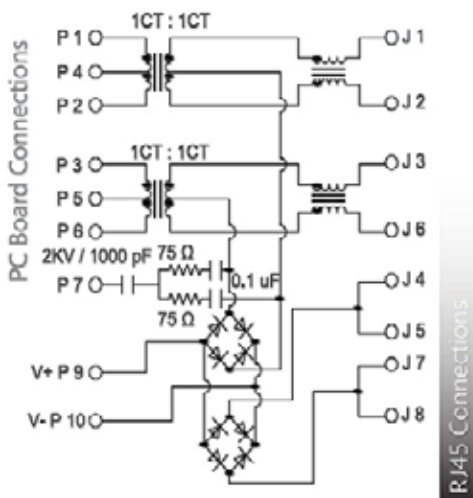
SCHEMATIC NO. 79



SCHEMATIC NO. 80

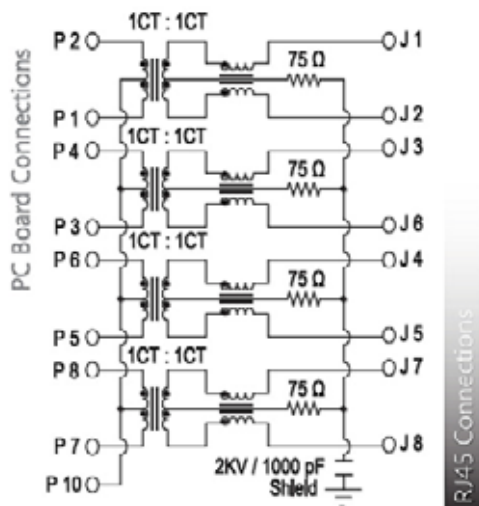


SCHEMATIC NO. 81 (POE)

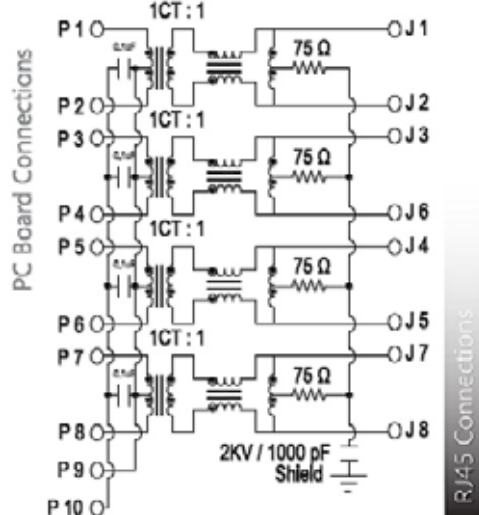


MAGNETIC SCHEMATICS 10/100/1000 GIGABIT BASE-TX TYPES

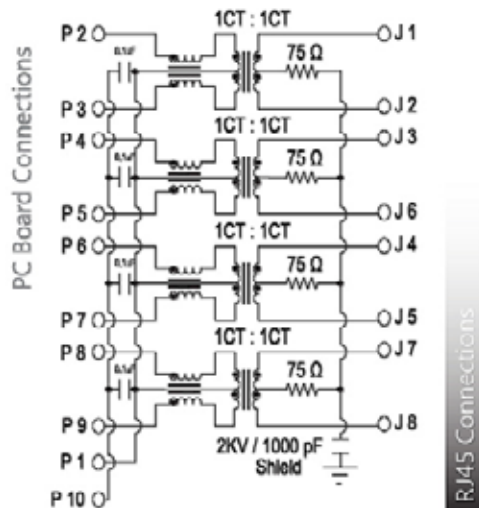
SCHEMATIC NO. G1



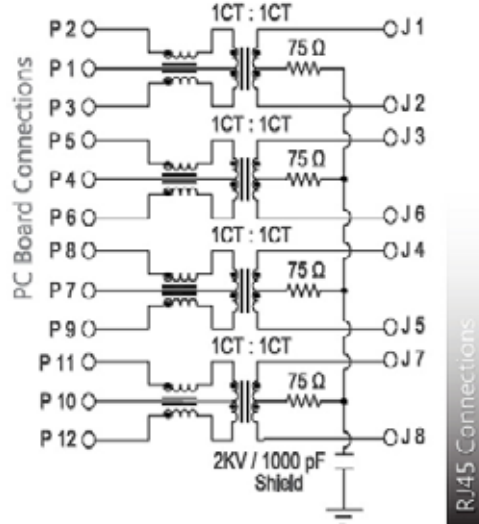
SCHEMATIC NO. G3



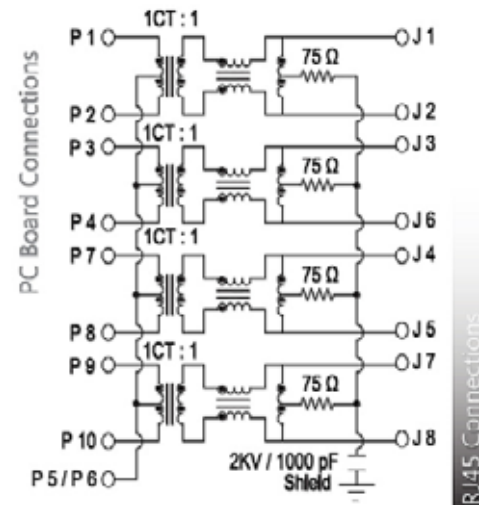
SCHEMATIC NO. G4



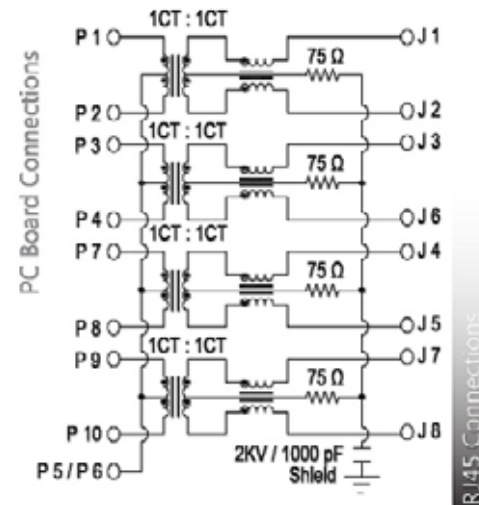
SCHEMATIC NO. G5



SCHEMATIC NO. G6

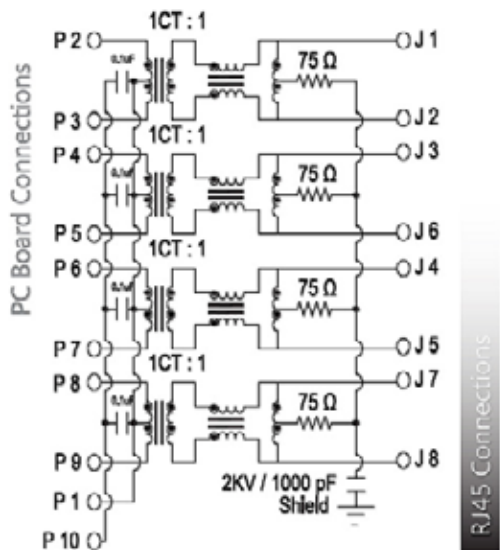


SCHEMATIC NO. G7

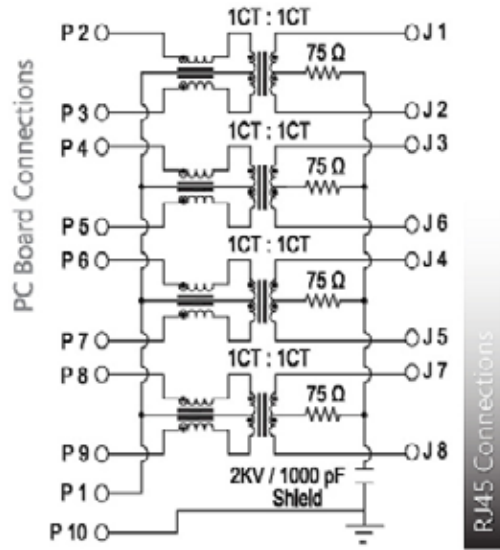


MAGNETIC SCHEMATICS 10/100/1000 GIGABIT BASE-TX TYPES

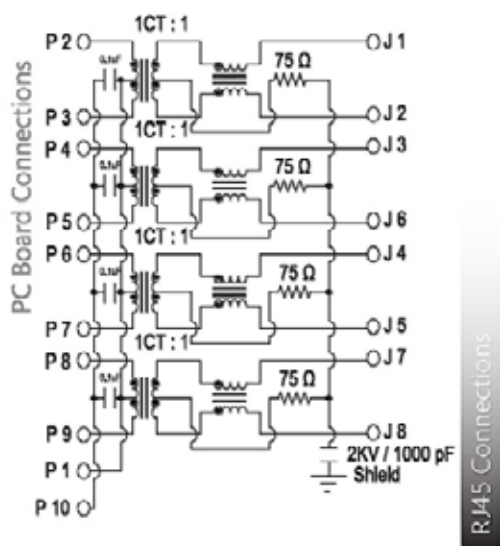
SCHEMATIC NO. G8



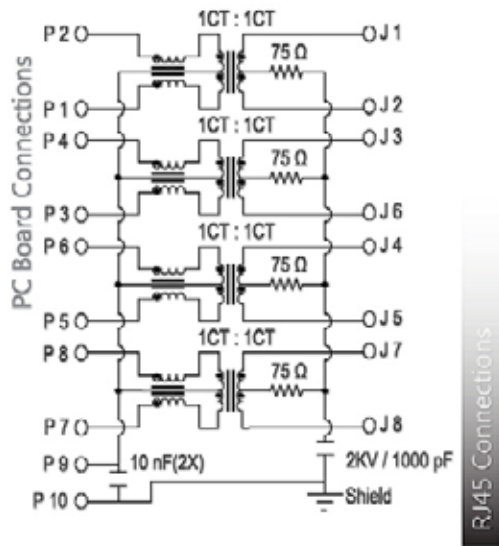
SCHEMATIC NO. G9



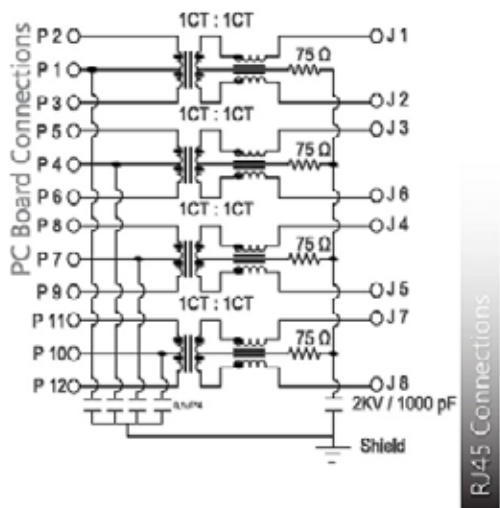
SCHEMATIC NO. H0



SCHEMATIC NO. H4

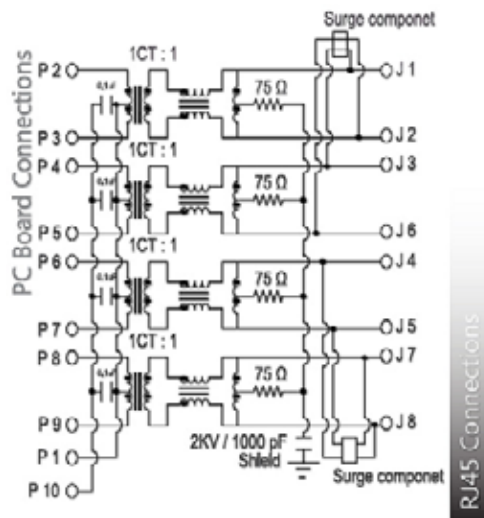


SCHEMATIC NO. J0 (10GB)

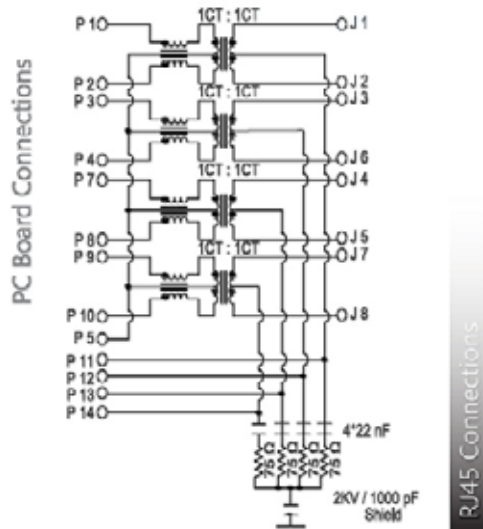


MAGNETIC SCHEMATICS 10/100/1000 GIGABIT BASE-TX TYPES

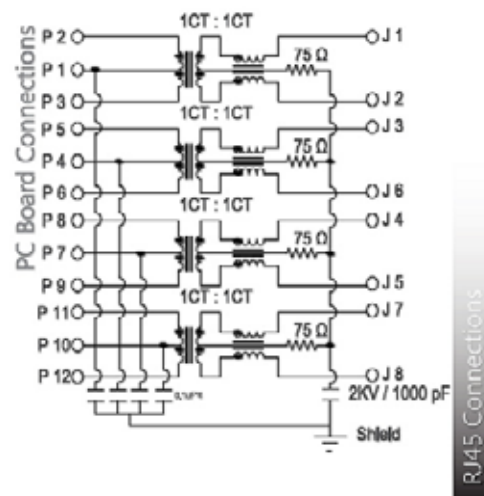
SCHEMATIC NO. J1 (SURGE)



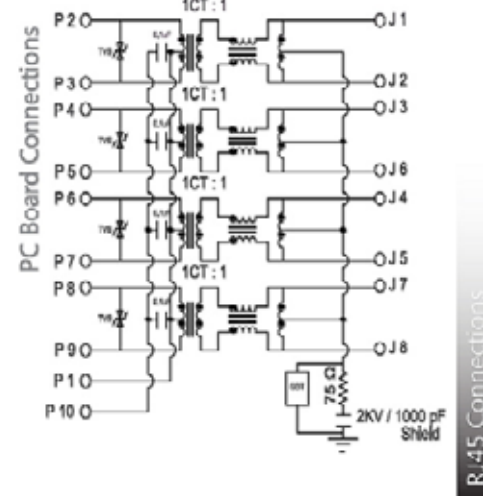
SCHEMATIC NO. J2 (POE)



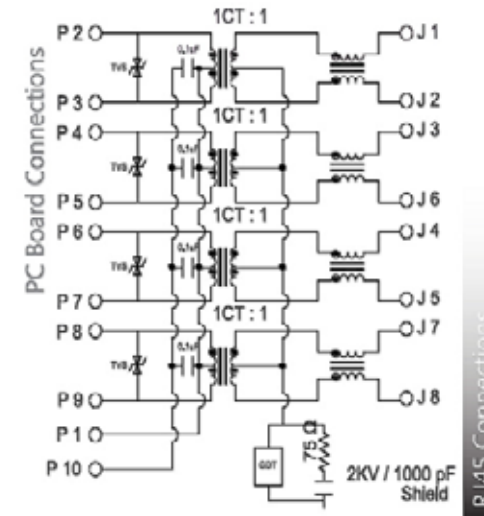
SCHEMATIC NO. J3



SCHEMATIC NO. J4



SCHEMATIC NO. J9 (SURGE)



TOP ENTRY MODULAR PCB JACK 8P PROFILE=13.00MM (FULLY SHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)

Soldering Temperature: 235°C

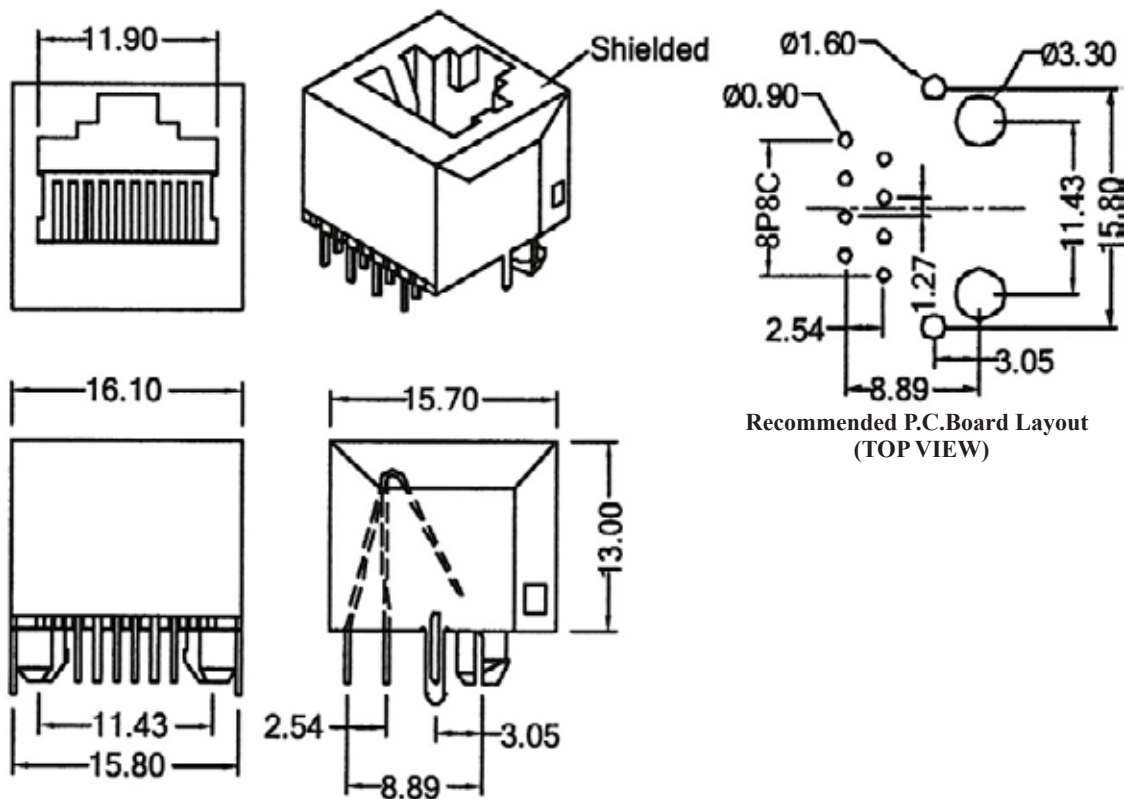
Color: Black

Spring Wire: Phosphor Bronze

Gold plating Over Nickel

Shield: Brass plating Nickel Alloy

*RoHS & REACH compliant.



ORDERING INFORMATION:

P/N M J T 9 - $\frac{88}{1} \times \frac{B}{2}$

1. NO. OF POSITIONS & CONTACTS:

"88" 8P8C

2. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

TOP ENTRY CAT.5 MODULAR PCB JACK 8P PROFILE=14.00MM (FULLY SHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)

Soldering Temperature: 235°C

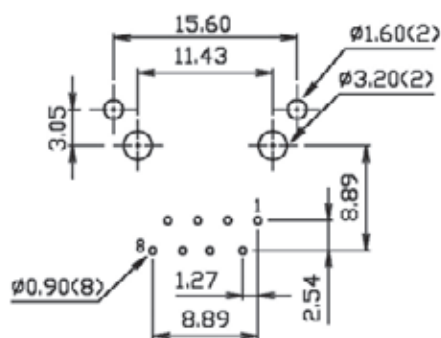
Color: Black

Spring Wire: Phosphor Bronze

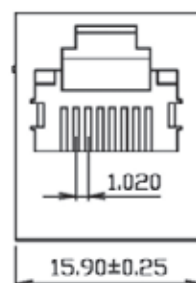
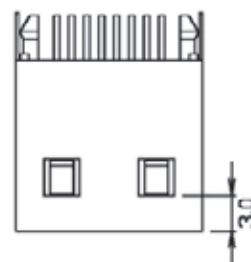
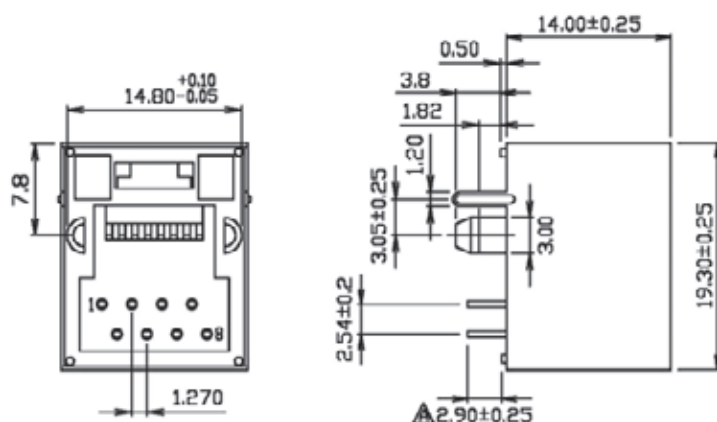
Gold plating Over Nickel

Shield: Brass plating Nickel Alloy

*RoHS & REACH compliant.



Recommended P.C.Board Layout



ORDERING INFORMATION:

P/N M J G G - 8 8 x B
1 2 3 4

1. MODULAR JACK TYPE:
"GG" CAT.5 RJ45 JACK
2. NO. OF POSITIONS & CONTACTS:
"88" 8P8C
3. CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD
4. HOUSING COLOR:
"B" BLACK

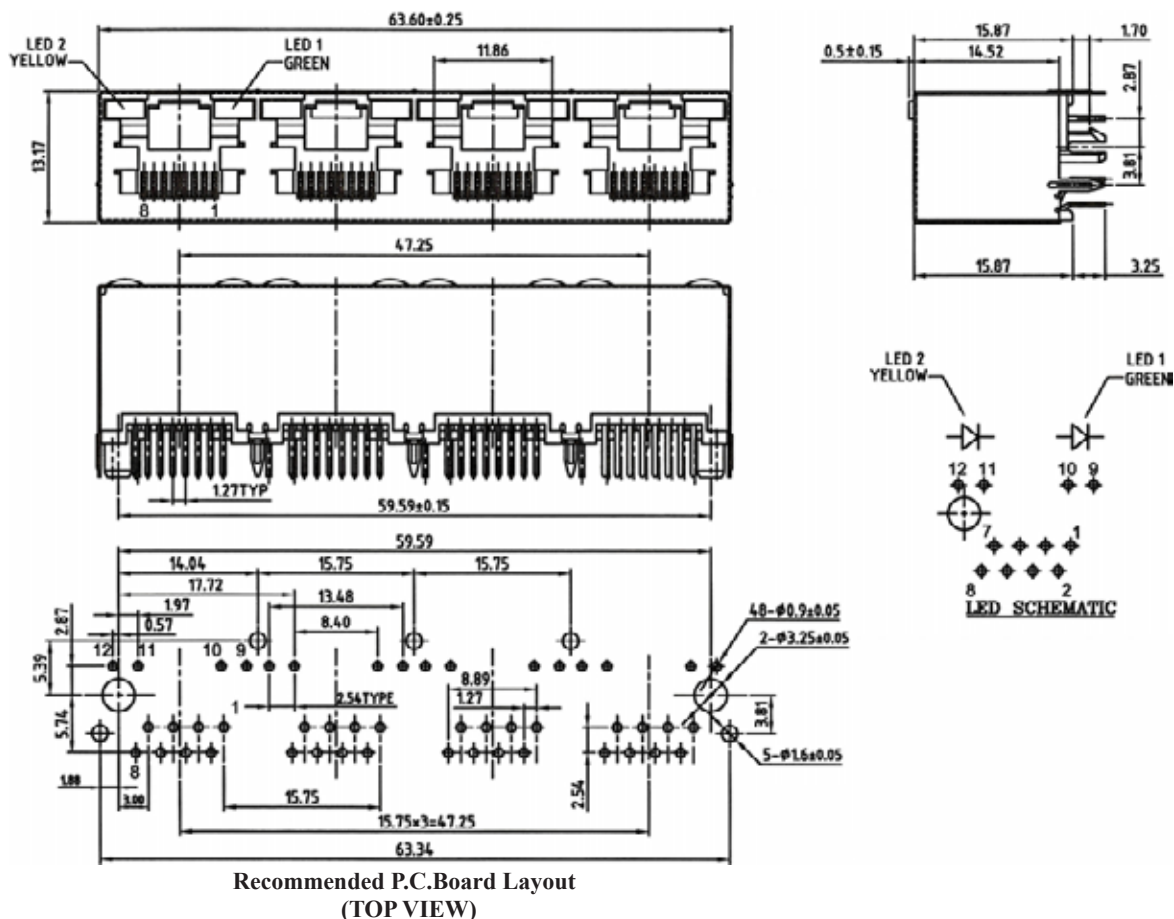
TOP ENTRY 4-PORT MODULAR PCB JACK WITH LED 8P PROFILE=14.52MM (FULLY SHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Black
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
Shield: Brass plating Nickel Alloy
***RoHS & REACH compliant.**



ORDERING INFORMATION:

P/N M J A 9 - $\frac{88}{1} \frac{x}{2} \frac{B}{3} \frac{x}{4} \frac{04}{5}$

1. NO. OF POSITIONS & CONTACTS:
"88" 8P8C
2. CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD
3. CODE OF LED1 DESIGNATION:
N, M, Y, Z, 8, Q, 1, 2, 5, 6
4. CODE OF LED2 DESIGNATION:
N, M, Y, Z, 8, Q, 1, 2, 5, 6
5. NO. OF PORTS:
04

LED Designation:

Code	+/-	-/+	Code	+/-	-/+
N	Green	—	M	—	Green
Y	Yellow	—	Z	—	Yellow
8	Orange	—	Q	—	Orange
1	Green	Orange	2	Orange	Green
5	Green	Yellow	6	Yellow	Green

NOTE: LED1= RIGHT LED &
LED2= LEFT LED

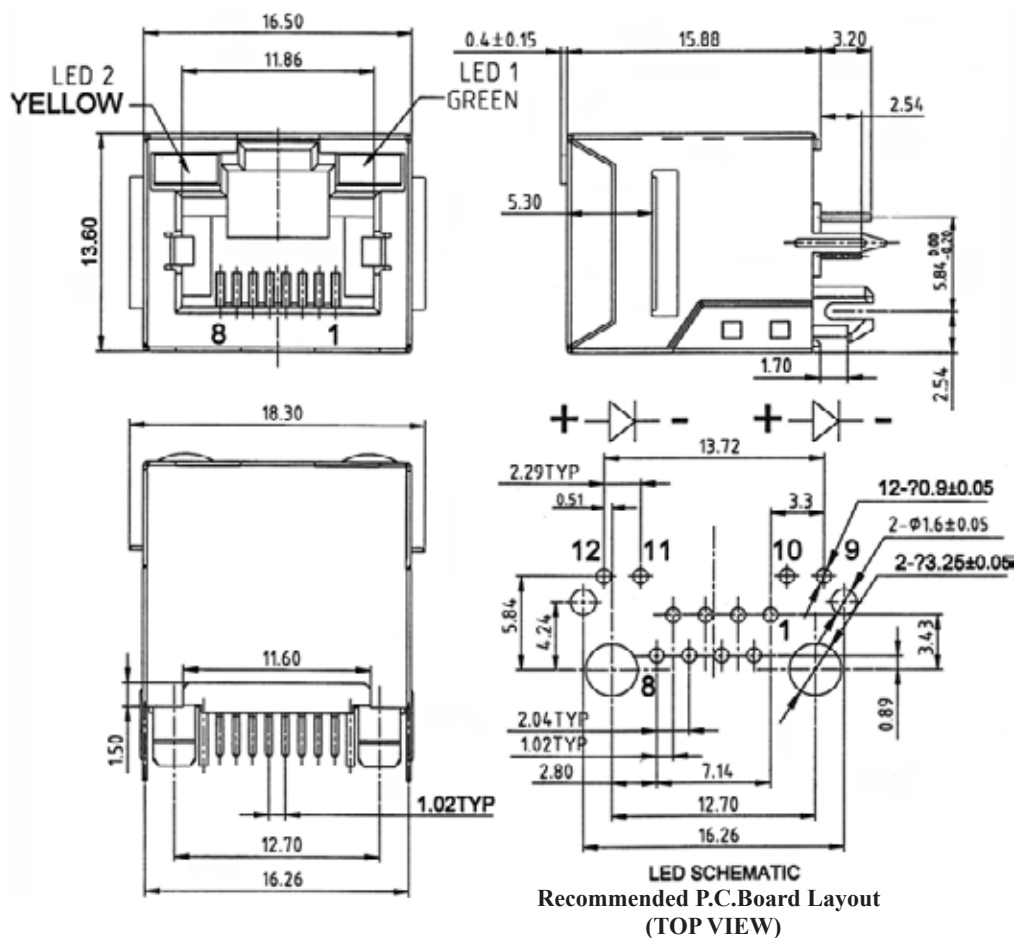
TOP ENTRY MODULAR PCB JACK WITH LED 8P PROFILE=15.88MM (FULLY SHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Black
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
Shield: Brass plating Nickel Alloy
***RoHS & REACH compliant.**



ORDERING INFORMATION:

P/N M J B 2 - $\frac{88}{1} \frac{x}{2} \frac{B}{3} \frac{x}{4}$

1. NO. OF POSITIONS & CONTACTS:
"88" 8P8C
2. CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD
3. CODE OF LED1 DESIGNATION:
N, M, Y, Z, 8, Q, 1, 2, 5, 6
4. CODE OF LED2 DESIGNATION:
N, M, Y, Z, 8, Q, 1, 2, 5, 6

LED Designation:

Code	+/-	-/+	Code	+/-	-/+
N	Green	—	M	—	Green
Y	Yellow	—	Z	—	Yellow
8	Orange	—	Q	—	Orange
1	Green	Orange	2	Orange	Green
5	Green	Yellow	6	Yellow	Green

NOTE: LED1= RIGHT LED &
 LED2= LEFT LED

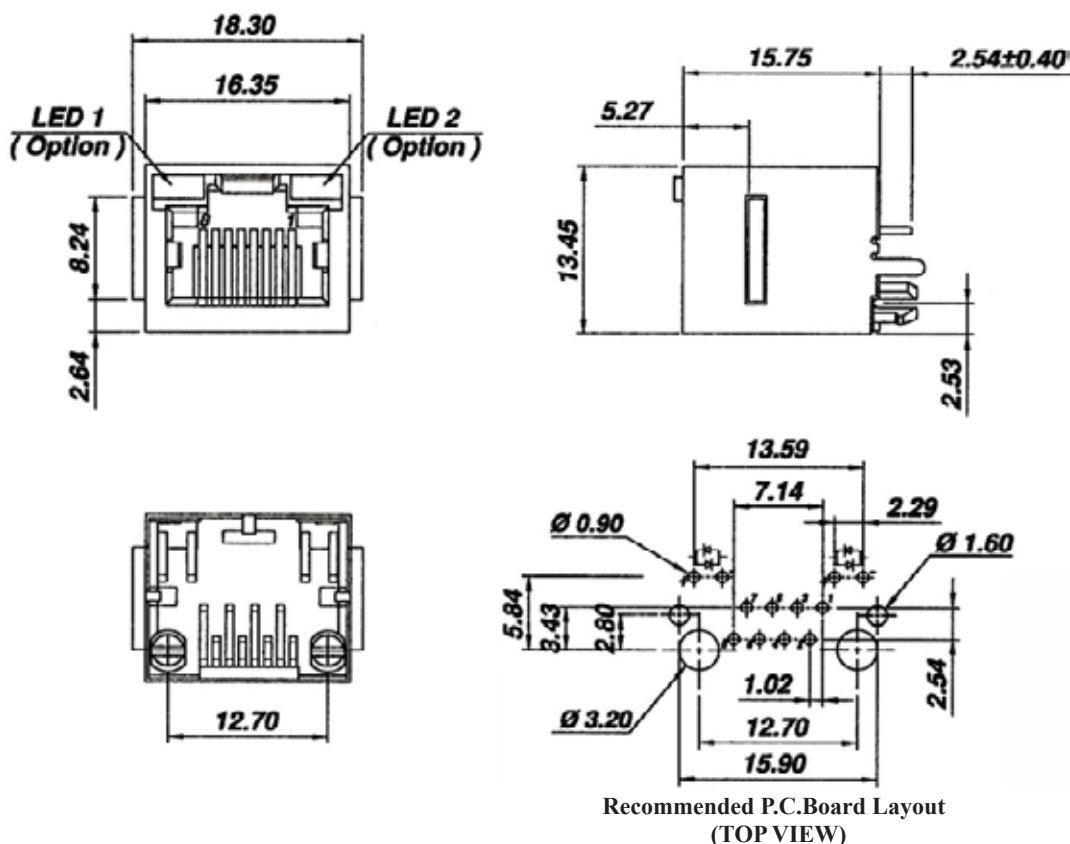
TOP ENTRY MODULAR PCB JACK WITH LED 8P PROFILE=15.75MM (FULLY SHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: Nylon (UL 94V-0)
Soldering Temperature: 260°C
Color: Black
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
Shield: Brass plating Nickel Alloy
***RoHS & REACH compliant.**



ORDERING INFORMATION:

P/N M J T H - $\frac{88}{T} \times \frac{B}{2} \times \frac{X}{3} \times \frac{X}{4}$

1. NO. OF POSITIONS & CONTACTS:
"88" 8P8C
2. CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD
3. CODE OF LED1 DESIGNATION:
N, M, Y, Z, 8, Q, 1, 2, 5, 6
4. CODE OF LED2 DESIGNATION:
N, M, Y, Z, 8, Q, 1, 2, 5, 6

LED Designation:

Code	+/-	-/+	Code	+/-	-/+
N	Green	—	M	—	Green
Y	Yellow	—	Z	—	Yellow
8	Orange	—	Q	—	Orange
1	Green	Orange	2	Orange	Green
5	Green	Yellow	6	Yellow	Green

NOTE: LED1= RIGHT LED &
LED2= LEFT LED

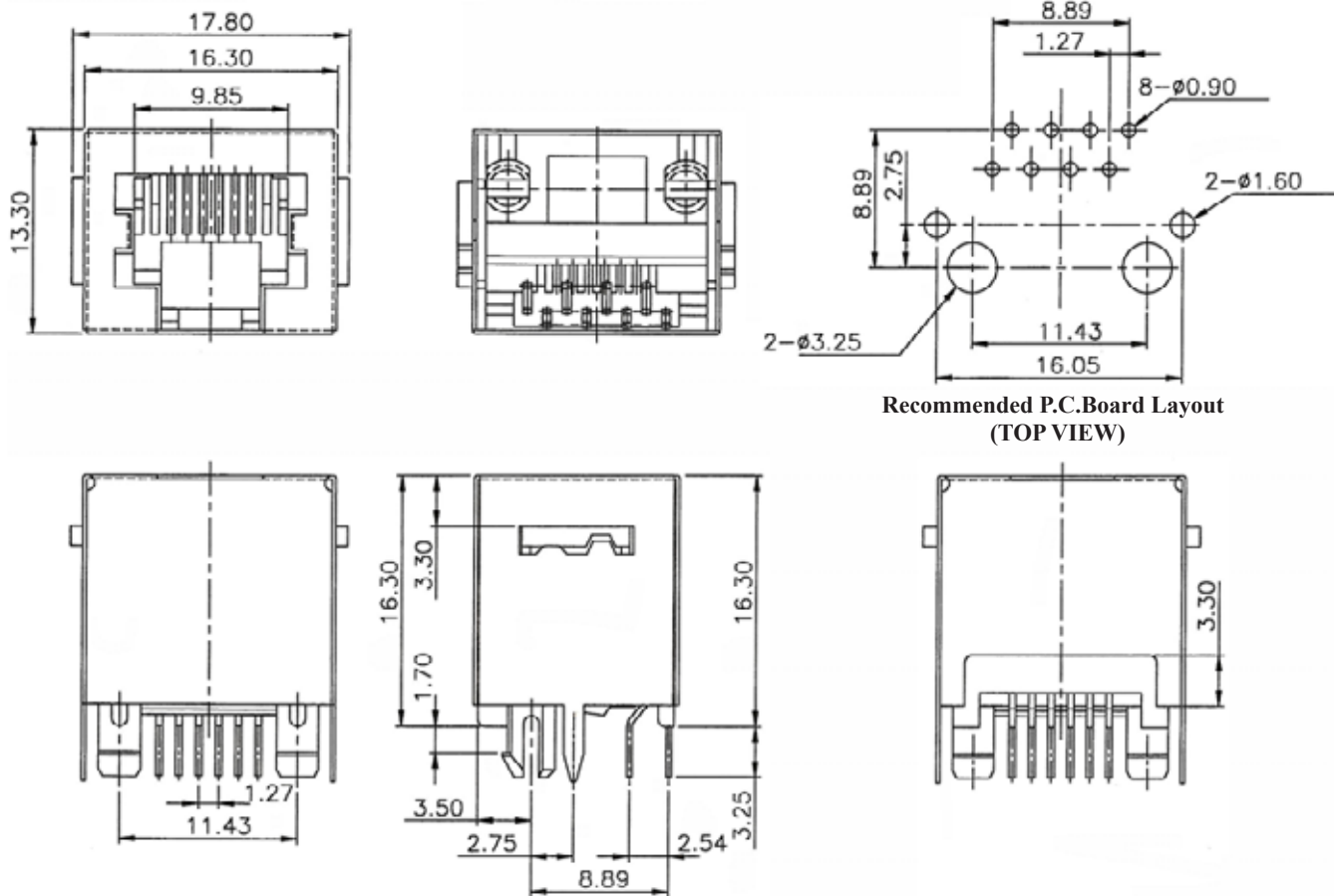
TOP ENTRY MODULAR PCB JACK 8P PROFILE=16.30MM (FULLY SHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Black
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
Shield: Brass plating Nickel Alloy
***RoHS & REACH compliant.**



Recommended P.C.Board Layout
(TOP VIEW)

ORDERING INFORMATION:

P/N MJ38 - $\frac{xx}{1} \frac{xx}{2} B \frac{x}{3}$

1. NO. OF POSITIONS & CONTACTS:
 "88" 8P8C
 "84" 8P4C
2. CONTACT FINISH:
 "A" 6 MICROINCH GOLD
 "B" 15 MICROINCH GOLD
 "C" 30 MICROINCH GOLD
 "D" 50 MICROINCH GOLD
3. KEYWAY OPTION:
 " " W/O KEYWAY
 "K" WITH KEYWAY

NOTE: P/N MJ38HT-8xxB FOR HIGH TEMP. VERSION

TOP ENTRY MODULAR PCB JACK 8P PROFILE=16.30MM (FULLY SHIELDED)

SPECIFICATIONS

Electrical:

Voltage Rating: 125 Vac Rms.

Current Rating: 1.5 Amp.

Contact Resistance: 40 Milliohms Max.

Insulation Resistance: 1000 Megohms Min @500 Vdc.

Dielectric Strength: 1000 Vac Rms 60Hz, 1Min.

Mechanical:

Operating: 750 Cycles Min.

Environmental:

Storage: -40°C To +85°C.

Operation: -40°C To +80°C.

MATERIALS

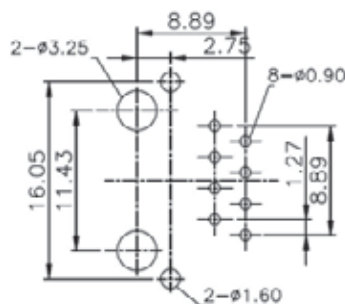
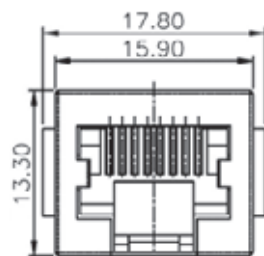
Plastic Housing: Engineering Thermoplastic
Flammability Rating UL 94V-0.

Contacts: Phosphor Bronze

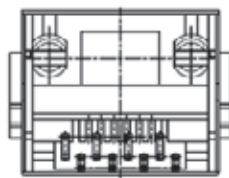
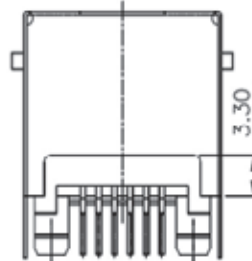
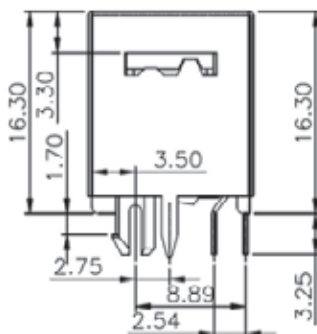
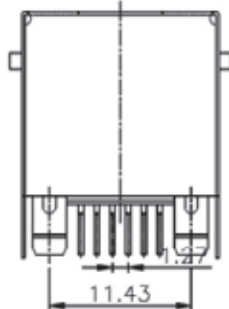
Plating: Gold Plating Over Nickel In Contact,
Tin Plating Over Nickel In Solder Area.

Solder: Brass With Nickel Plated.

* RoHS & REACH compliant.



Recommended P.C.Board Layout
(TOP VIEW)



ORDERING INFORMATION:

P/N **MJ 38 K - 88 x B**
 1 2 3

1. MODULAR JACK TYPE:
"38K" WITH PANEL STOP W=15.90MM
2. NO. OF POSITIONS & CONTACTS:
"88" 8P8C
3. CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD

NOTE: IT CAN BE USED FOR REPLACING P/N MJ38-88xB.

TOP ENTRY MODULAR PCB JACK 8P PROFILE=16.30MM (FULLY SHIELDED)

SPECIFICATIONS

Electrical:

Voltage Rating: 125 Vac Rms.

Current Rating: 1.5 Amp.

Contact Resistance: 40 Milliohms Max.

Insulation Resistance: 1000 Megohms Min @500 Vdc.

Dielectric Strength: 1000 Vac Rms 60Hz, 1Min.

Mechanical:

Operating: 750 Cycles Min.

Environmental:

Storage: -40°C To +85°C.

Operation: -40°C To +80°C.

MATERIALS

Plastic Housing: High Temp Thermoplastic

Flammability Rating UL 94V-0.

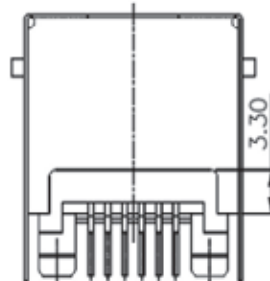
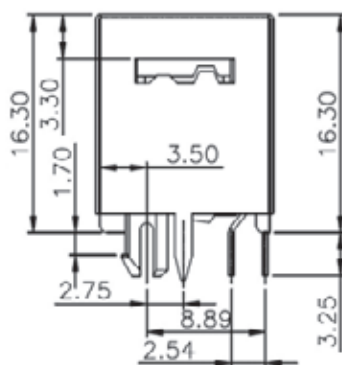
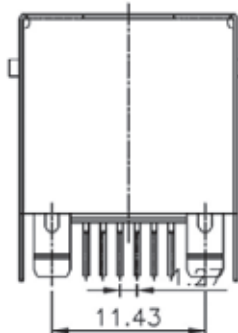
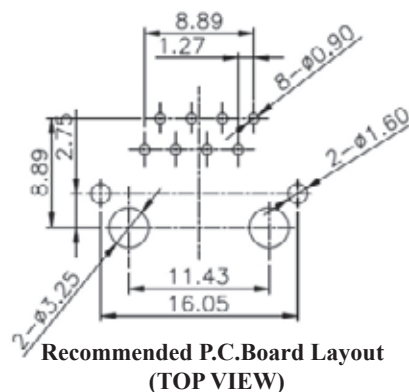
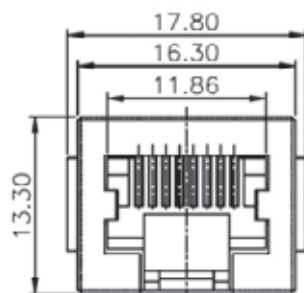
Contacts: Phosphor Bronze

Plating: Gold Plating Over Nickel In Contact,

Tin Plating Over Nickel In Solder Area.

Solder: Brass With Nickel Plated.

* RoHS & REACH compliant.



ORDERING INFORMATION:

P/N MJ $\frac{38J}{1} - \frac{88x}{23} B$

1. MODULAR JACK TYPE:
"38J" WITH PANEL STOP W=16.30MM
2. NO. OF POSITIONS & CONTACTS:
"88" 8P8C
3. CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD

NOTE: IT CAN BE USED FOR REPLACING P/N MJ38-88xB.

TOP ENTRY MODULAR PCB JACK 8P PROFILE=16.30MM (FULLY SHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)

Soldering Temperature: 235°C

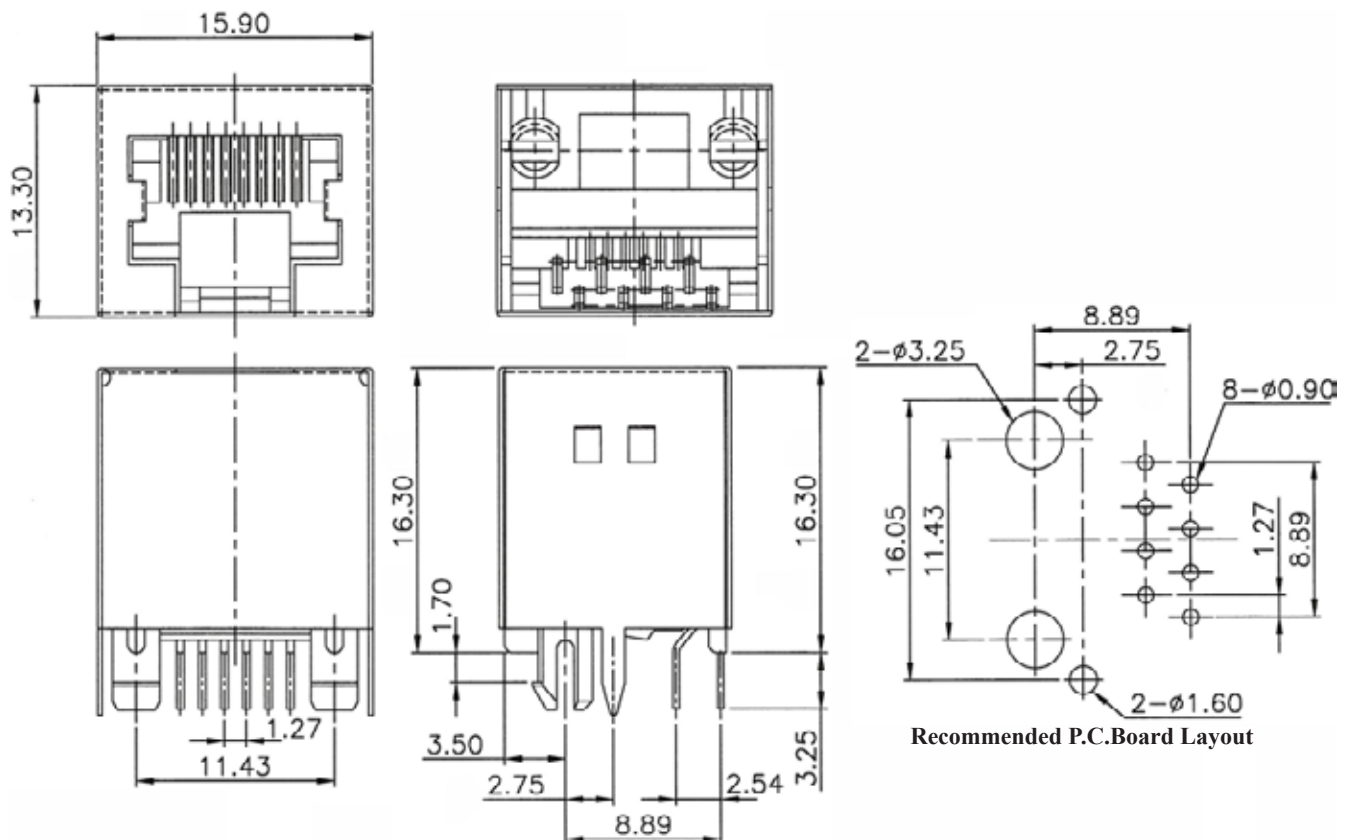
Color: Black

Spring Wire: Phosphor Bronze

Gold plating Over Nickel

Shield: Brass plating Nickel Alloy

***RoHS & REACH compliant.**



ORDERING INFORMATION:

P/N M J 6 0 - $\frac{88}{1} \frac{x}{2}$ B $\frac{x}{3}$

1. NO. OF POSITIONS & CONTACTS:
"88" 8P8C
2. CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD
3. KEYWAY OPTION:
" " W/O KEYWAY
"K" WITH KEYWAY

NOTE: P/N MJ60HT-88xB FOR HIGH TEMP. VERSION

TOP ENTRY MODULAR PCB JACK 8P PROFILE=16.30MM (FULLY SHIELDED)

SPECIFICATIONS

Electrical:

1. **Voltage Rating:** 125 Vac Rms.
2. **Current Rating:** 1.5 Amp.
3. **Contact Resistance:** 40 Milliohms Max.
4. **Insulation Resistance:** 1000 Megohms Min @500 Vdc.
5. **Dielectric Strength:** 1000 Vac Rms 60Hz, 1Min.

Mechanical:

1. **Operating:** 750 Cycles Min.

Environmental:

1. **Storage:** -40°C To +85°C.
2. **Operation:** -40°C To +80°C.

MATERIALS

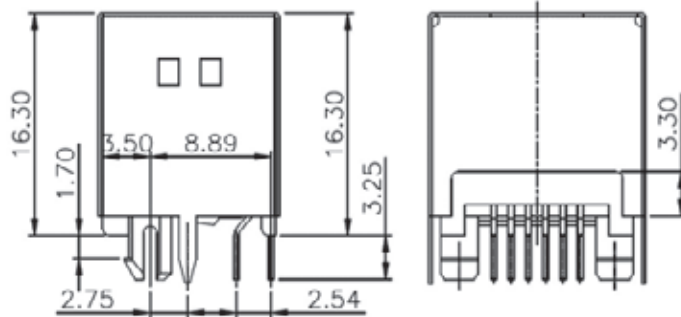
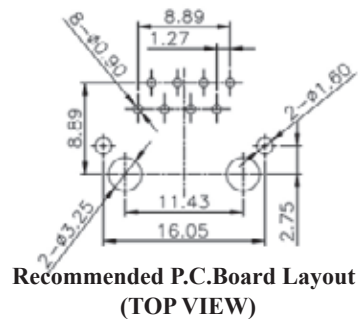
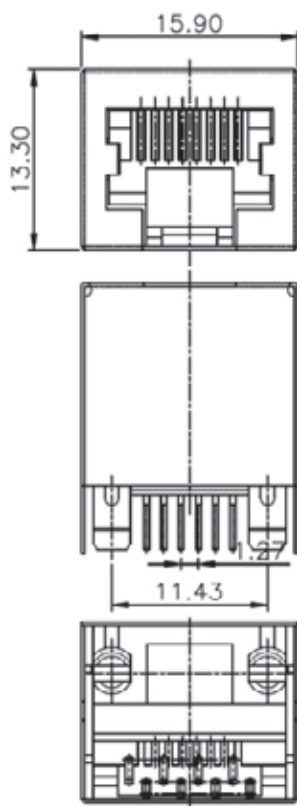
Plastic Housing: Engineering Thermoplastic
Flammability Rating UL 94V-0.

Contacts: Phosphor Bronze

Plating: Gold Plating Over Nickel In Contact,
Tin Plating Over Nickel In Solder Area.

Shield: Brass Plating Nickel Alloy.

* RoHS & REACH compliant.



ORDERING INFORMATION:

P/N **MJ 60J - 88 x B**
1 2 3

1. MODULAR JACK TYPE:
"60J" W/O PANEL STOP
2. NO. OF POSITIONS & CONTACTS:
"88" 8P8C
3. CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD

NOTE: IT CAN BE USED FOR REPLACING P/N MJ60-88xB.

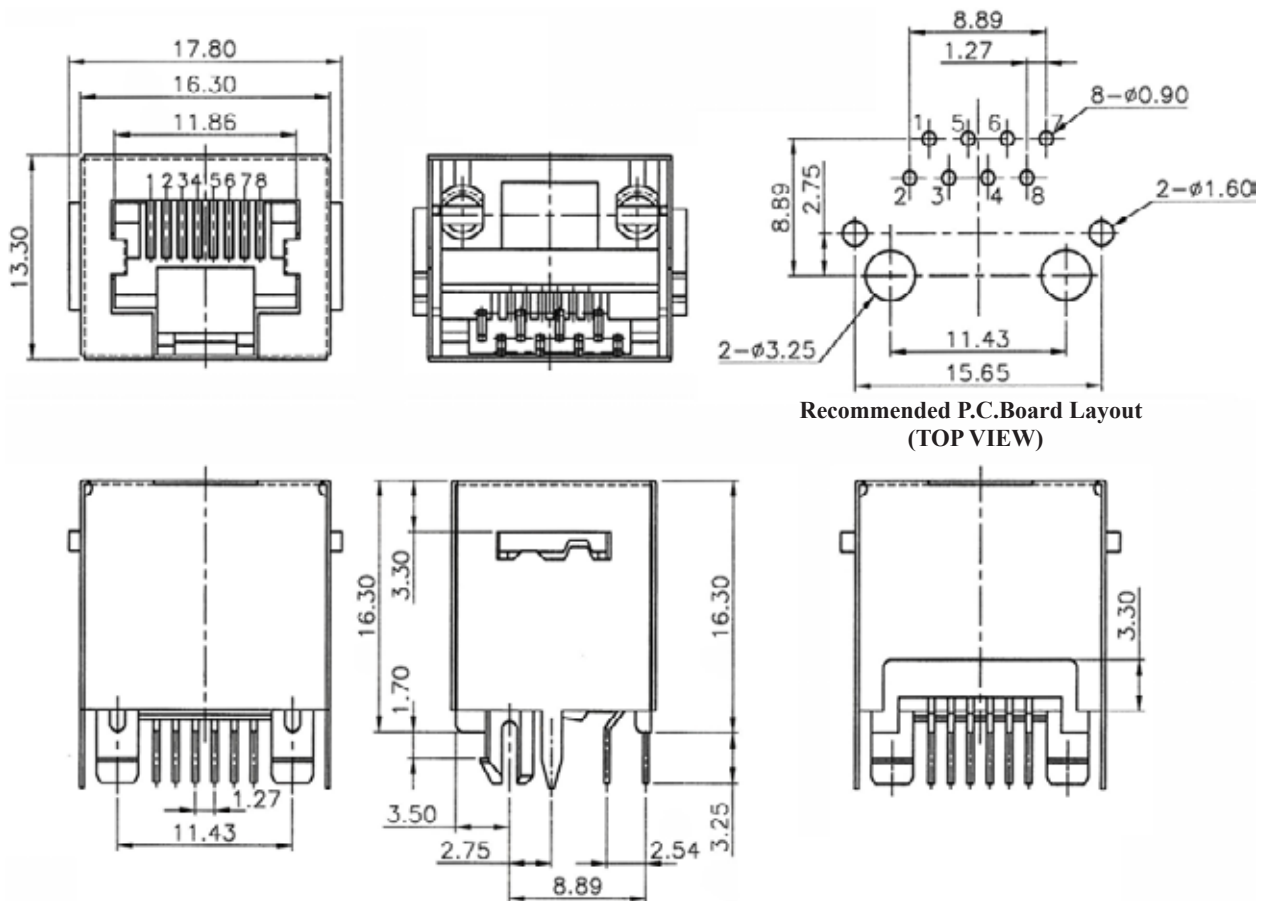
TOP ENTRY CAT. 5 MODULAR PCB JACK 8P PROFILE=16.30MM (FULLY SHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Black
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
Shield: Brass plating Nickel Alloy
***RoHS & REACH compliant.**



ORDERING INFORMATION:

P/N MJ5A- $\frac{88}{1} \times \frac{A}{23}$

1. NO. OF POSITIONS & CONTACTS:
"88" 8P8C
2. CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD
3. HOUSING COLOR:
"A" GRAY

NOTE: WITH PANEL STOP

TOP ENTRY CAT. 5 MODULAR PCB JACK 8P PROFILE=16.30MM (FULLY SHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)

Soldering Temperature: 235°C

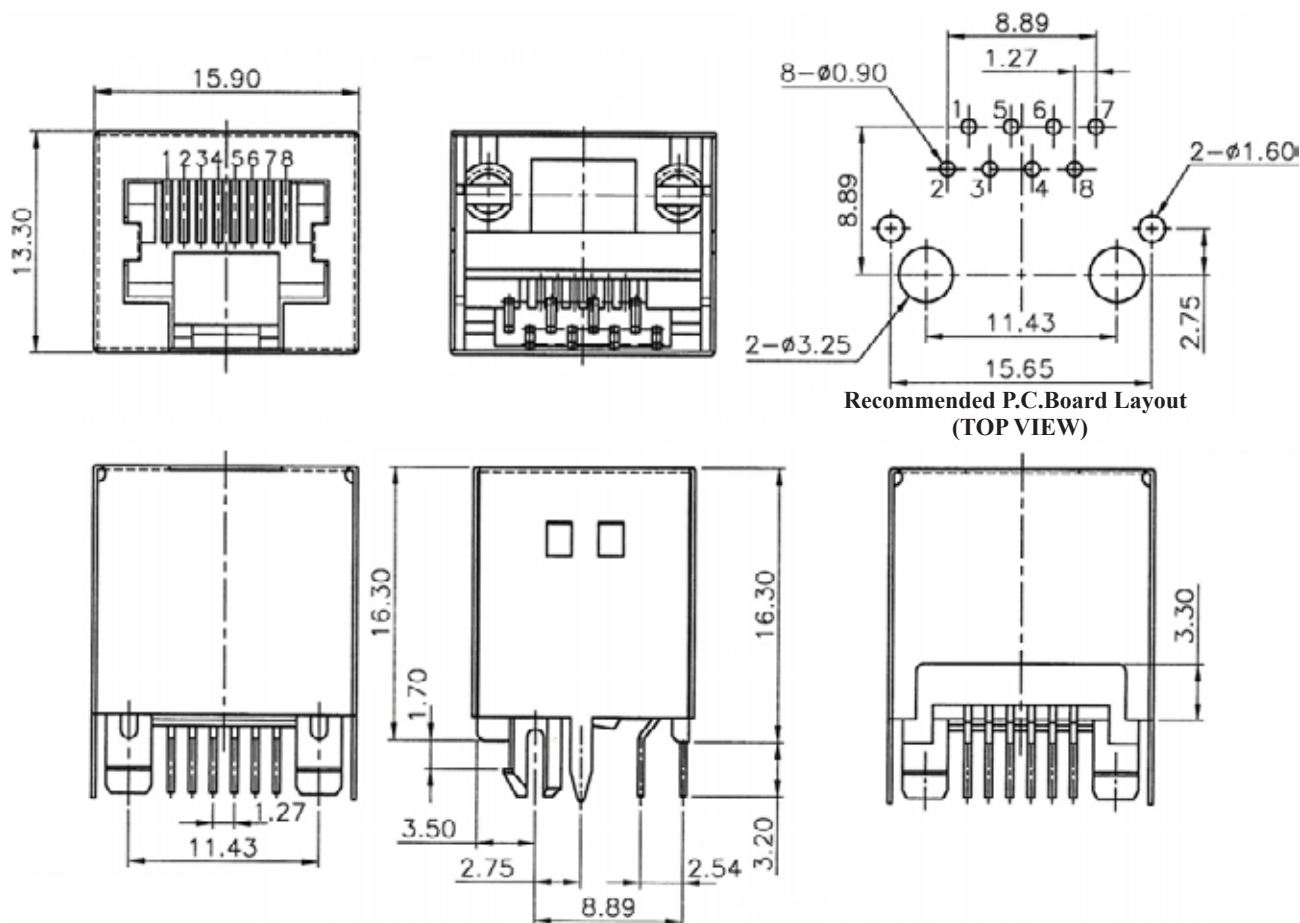
Color: Black

Spring Wire: Phosphor Bronze

Gold plating Over Nickel

Shield: Brass plating Nickel Alloy

***RoHS & REACH compliant.**



ORDERING INFORMATION:

P/N MJ5B- $\frac{88}{1} \times \frac{A}{23}$

1. NO. OF POSITIONS & CONTACTS:

"88" 8P8C

2. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

3. HOUSING COLOR:

"A" GRAY

NOTE: WITHOUT PANEL STOP

TOP ENTRY MODULAR PCB JACK PRESS-FIT TYPE 8P PROFILE=16.30MM (FULLY SHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)

Soldering Temperature: 235°C

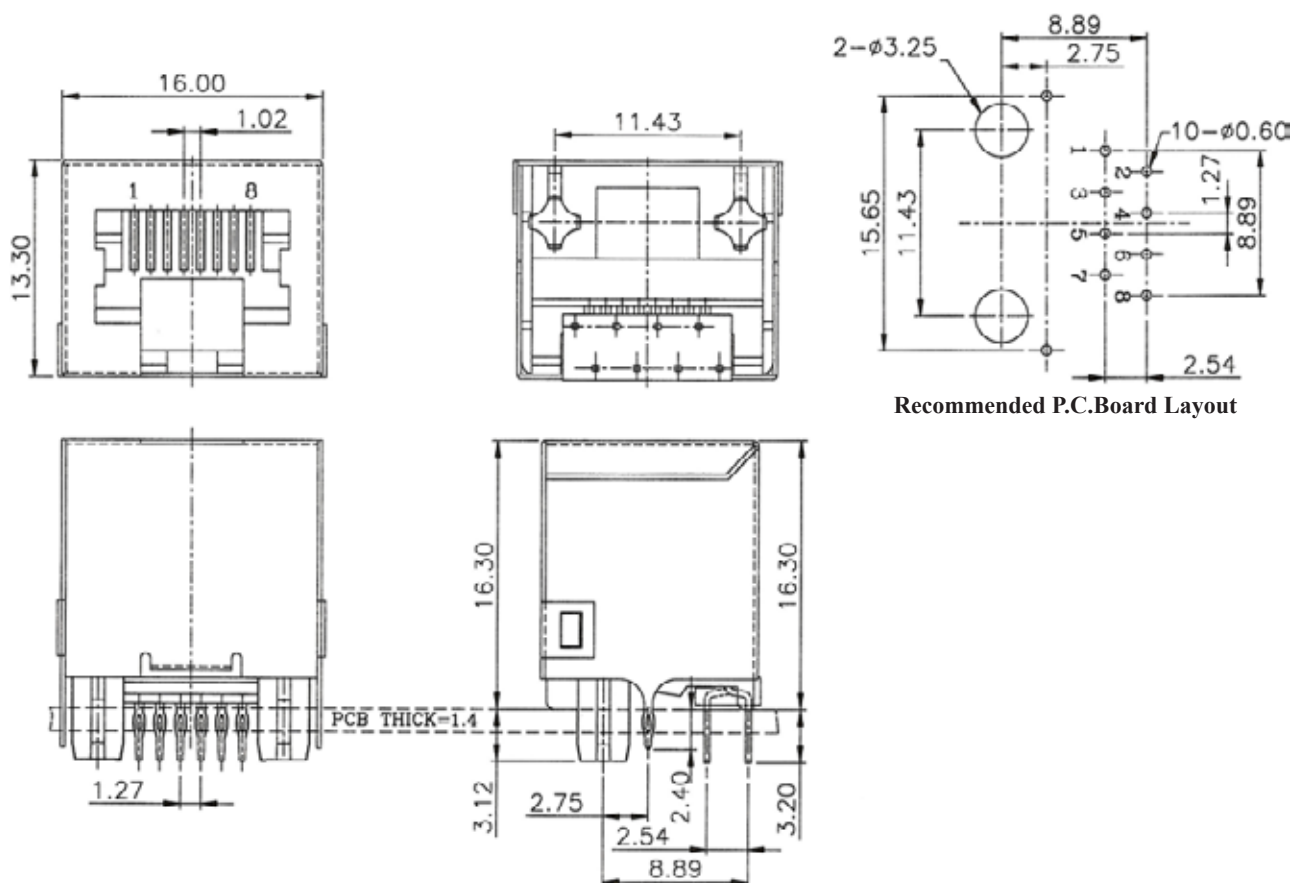
Color: Black

Spring Wire: Phosphor Bronze

Gold plating Over Nickel

Shield: Brass plating Nickel Alloy

*RoHS & REACH compliant.



Recommended P.C.Board Layout

ORDERING INFORMATION:

P/N M J 4 V - $\frac{x}{1} \frac{x}{2} \frac{x}{3} B \frac{x}{3}$

1. NO. OF POSITIONS & CONTACTS:

"88" 8P8C

"84" 8P4C

2. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

3. KEYWAY OPTION:

" " W/O KEYWAY

"K" WITH KEYWAY

TOP ENTRY MODULAR PCB JACK 6P PROFILE=16.50MM (FULLY SHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)

Soldering Temperature: 235°C

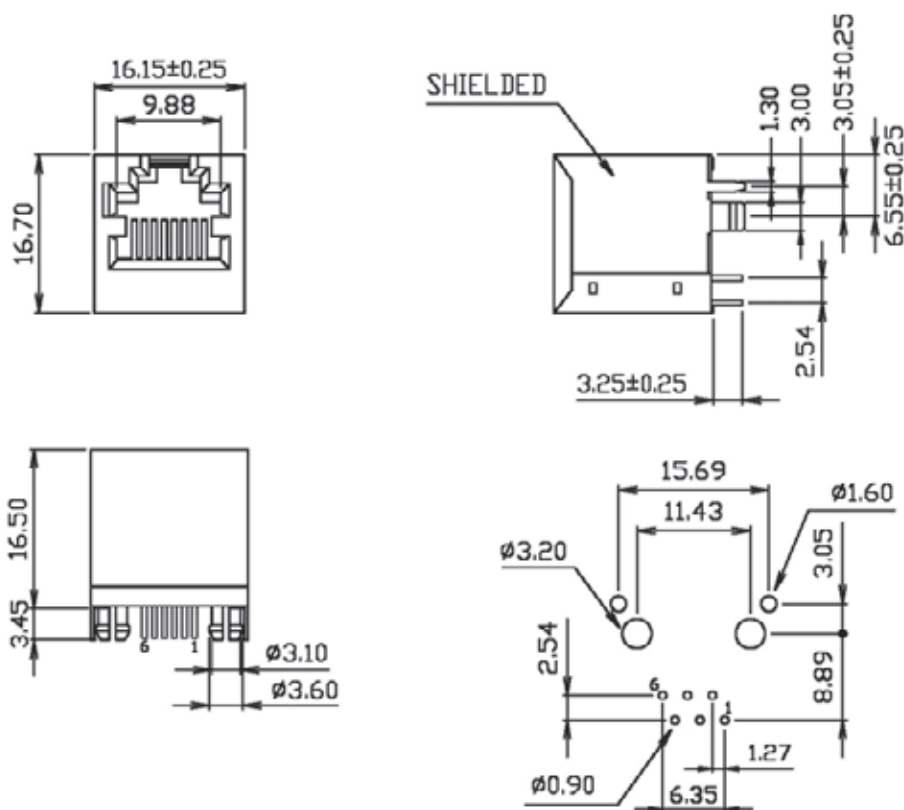
Color: Black

Spring Wire: Phosphor Bronze

Gold plating Over Nickel

Shield: Brass plating Nickel Alloy

***RoHS & REACH compliant.**



Recommended P.C.Board Layout

ORDERING INFORMATION:

P/N M J G E - x x x B
1 2 3 4

1. MODULAR JACK TYPE:
"GE" STRAIGHT DIP TYPE
2. NO. OF POSITIONS & CONTACTS:
"66" 6P6C
"64" 6P4C
3. CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD
4. HOUSING COLOR:
"B" BLACK

TOP ENTRY MODULAR PCB JACK 8P PROFILE=16.50MM (FULLY SHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)

Soldering Temperature: 235°C

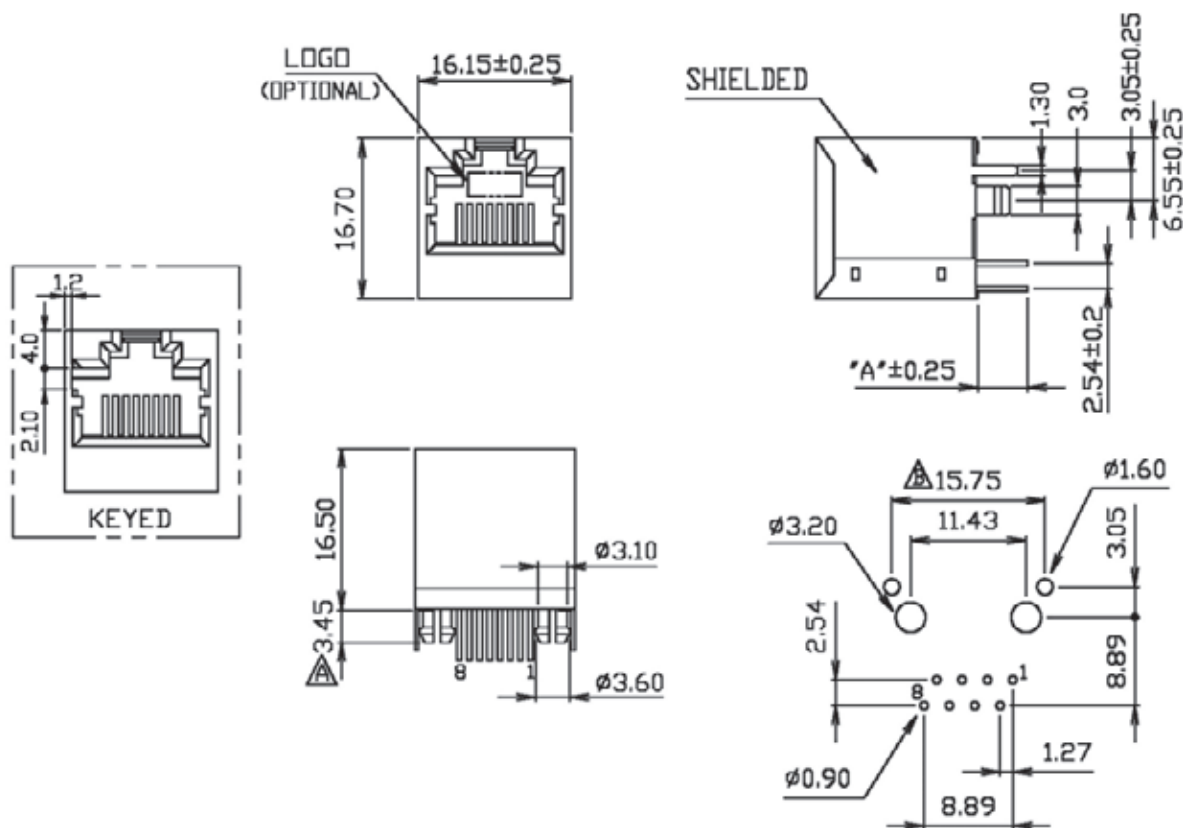
Color: Black

Spring Wire: Phosphor Bronze

Gold plating Over Nickel

Shield: Brass plating Nickel Alloy

***RoHS & REACH compliant.**



Recommended P.C.Board Layout

ORDERING INFORMATION:

P/N M J GE - 88 x B x
1 2 3 4 5

1. MODULAR JACK TYPE:
"GE" STRAIGHT DIP TYPE
2. NO. OF POSITIONS & CONTACTS:
"88" 8P8C
3. CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD
4. HOUSING COLOR:
"B" BLACK

5. KEY OPTION:
" " NON-KEYED
"K" KEYED

TOP ENTRY MODULAR PCB JACK 8P PROFILE=16.50MM (FULLY SHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)

Soldering Temperature: 235°C

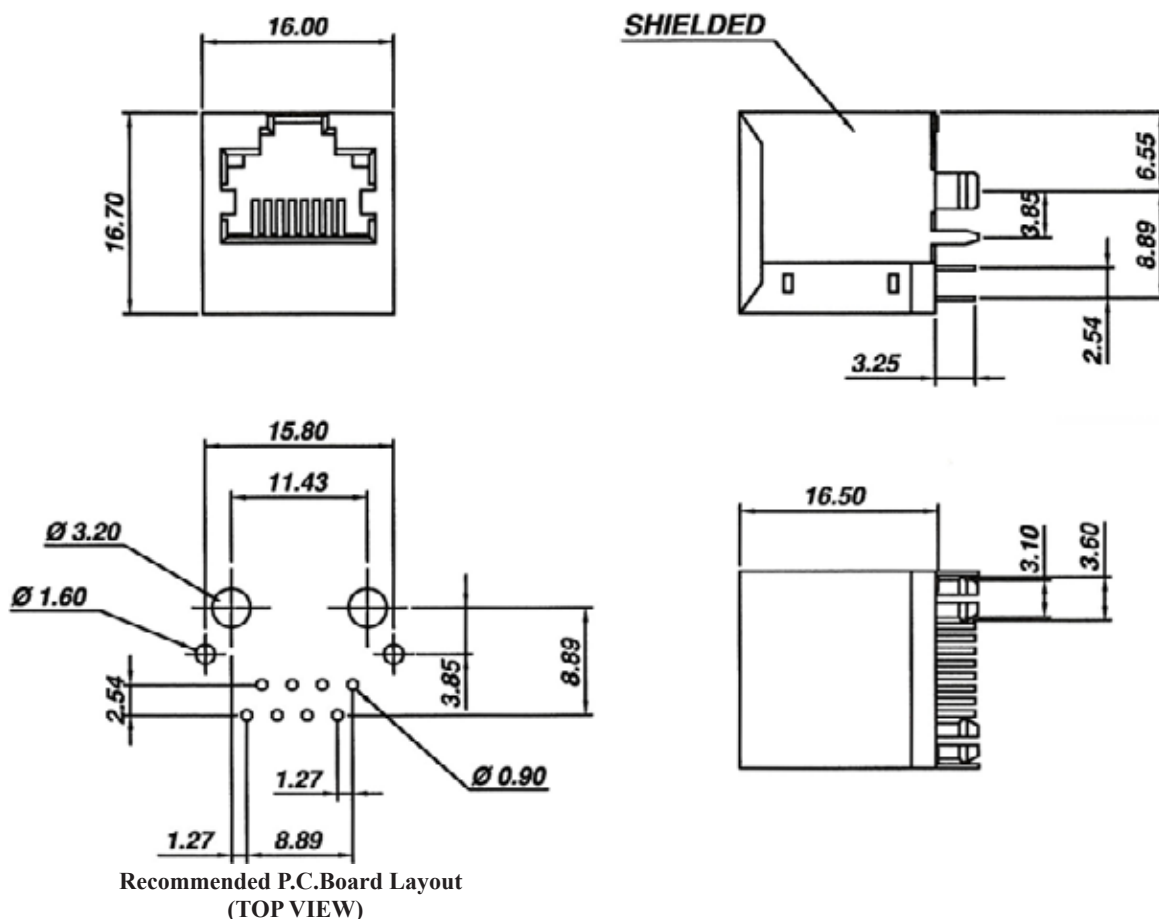
Color: Black

Spring Wire: Phosphor Bronze

Gold plating Over Nickel

Shield: Brass plating Nickel Alloy

*RoHS & REACH compliant.



ORDERING INFORMATION:

P/N M J T C - $\frac{x x x}{T 2}$ B

1. NO. OF POSITIONS & CONTACTS:

"88" 8P8C

2. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

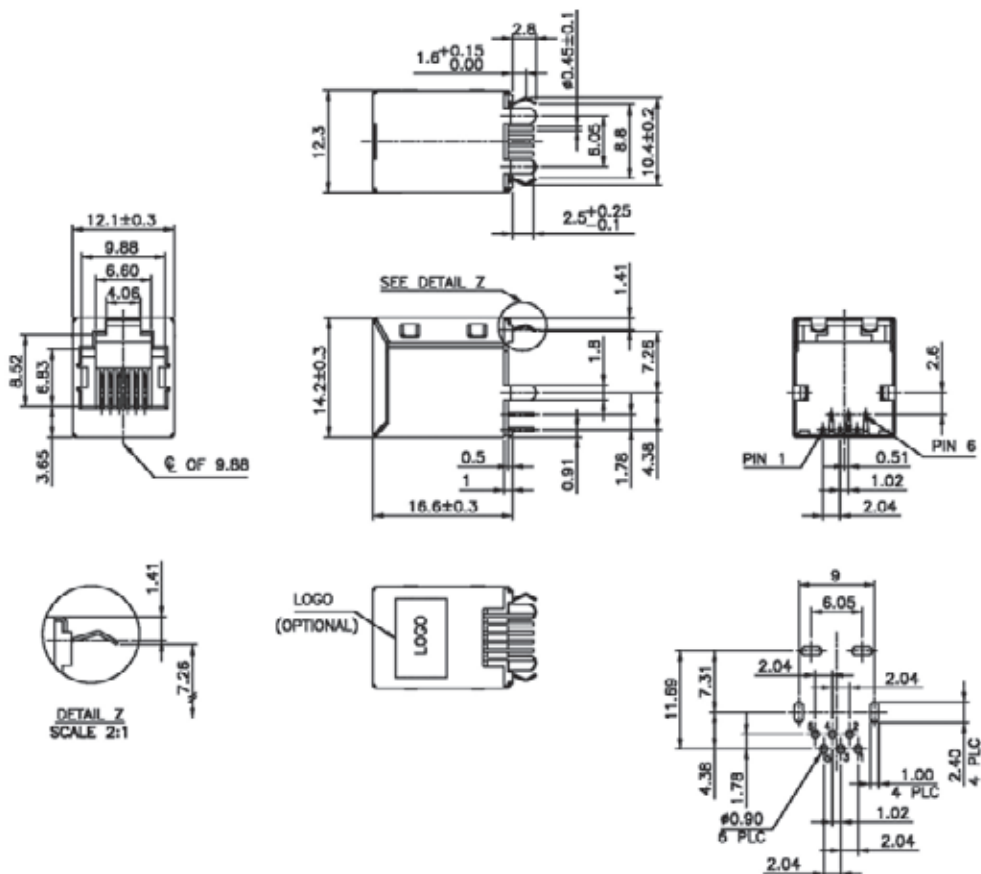
TOP ENTRY MODULAR PCB JACK 6P PROFILE=16.60MM (FULLY SHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Black
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
Shield: Brass plating Nickel Alloy
***RoHS & REACH compliant.**



Recommended P.C.Board Layout
(TOP VIEW)

ORDERING INFORMATION:

P/N M J G F - x x x B
 1 2 3 4

- MODULAR JACK TYPE:
"GF" STRAIGHT DIP TYPE
- NO. OF POSITIONS & CONTACTS:
"66" 6P6C
"64" 6P4C
- CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD
- HOUSING COLOR:
"B" BLACK

TOP ENTRY MODULAR PCB JACK 8P PROFILE=16.50MM (FULLY SHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)

Soldering Temperature: 235°C

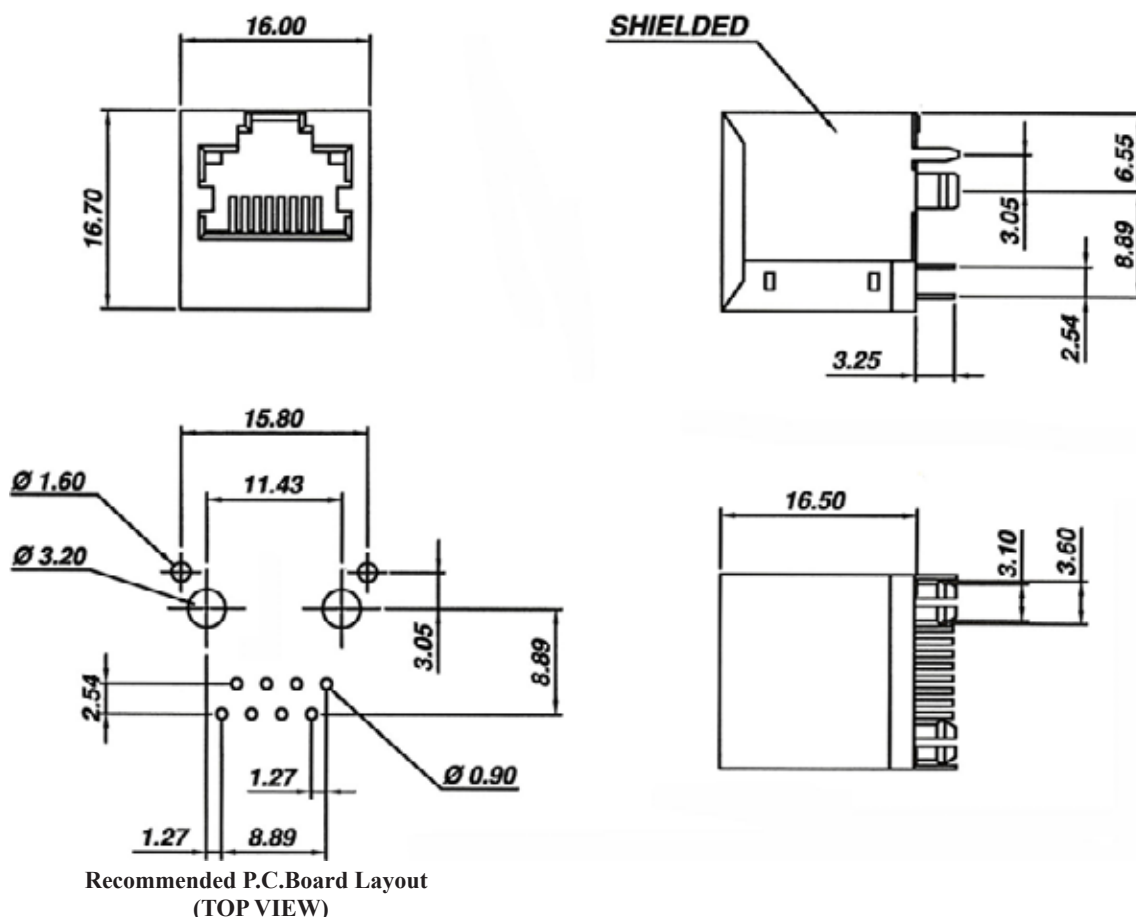
Color: Black

Spring Wire: Phosphor Bronze

Gold plating Over Nickel

Shield: Brass plating Nickel Alloy

*RoHS & REACH compliant.



ORDERING INFORMATION:

P/N M J 7 Y - $\frac{x}{1} \frac{x}{2} B$

1. NO. OF POSITIONS & CONTACTS:

"88" 8P8C

2. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

TOP ENTRY 4-PORT MODULAR PCB JACK 8P PROFILE=16.60MM (FULLY SHIELDED)

SPECIFICATIONS

Current Rating: 1.5 Amp Max.

Dielectric Withstanding: 500 Vac For 1 Min.

Contact Resistance: 30m Ohms Max.

Insulation Resistance: 1000 Megohms Min @500 Vdc..

Operation Temperature: -40°C To +85°C.

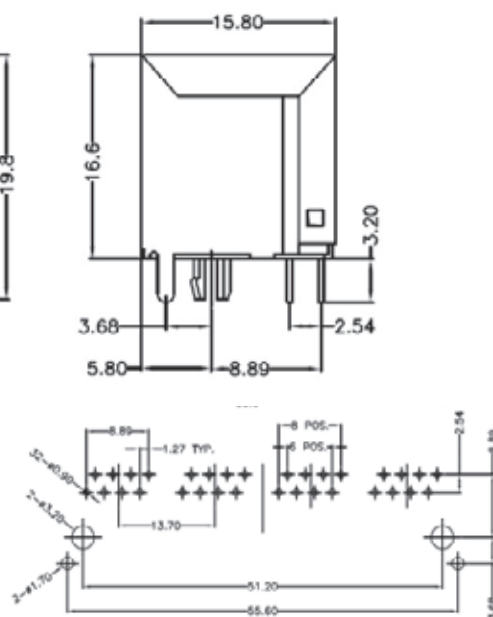
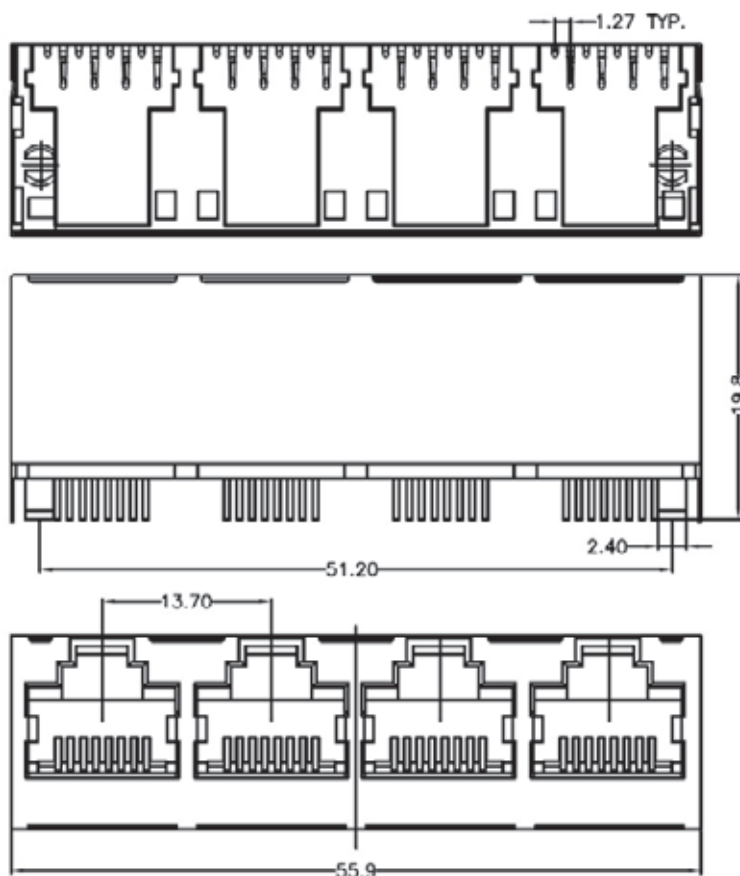
MATERIALS

Housing: PBT(UL 94V-0)

Shell: Copper Alloy, Nickel Plating

Terminal: Copper Alloy, Gold Plated

* RoHS & REACH compliant.



Recommended P.C.Board Layout
(TOP VIEW)

ORDERING INFORMATION:

P/N M J 8 W - $\frac{88}{1} \times \frac{23}{2} \times \frac{04}{4}$

1. NO. OF POSITIONS & CONTACTS:

"88" 8P8C

2. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

"E" GOLD FLASH

3. HOUSING COLOR:

"B" BLACK

"W" WHITE

4. NO. OF PORTS:

04

TOP ENTRY MODULAR PCB JACK 8P PROFILE=16.58MM (FULLY SHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)

Soldering Temperature: 235°C

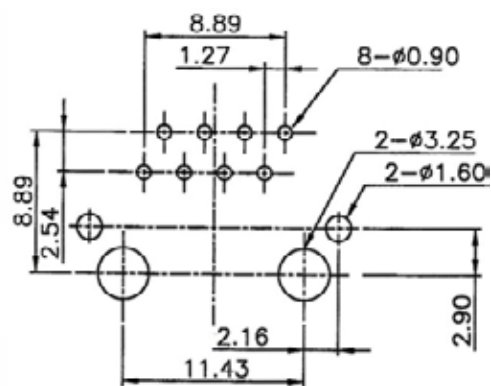
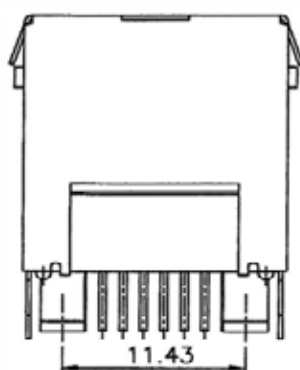
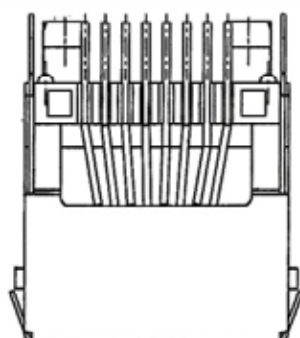
Color: Black

Spring Wire: Phosphor Bronze

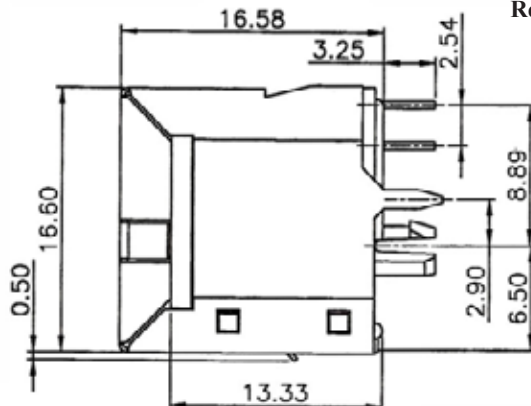
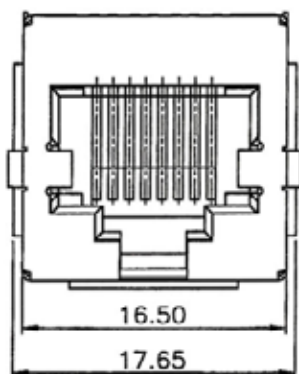
Gold plating Over Nickel

Shield: Brass plating Nickel Alloy

***RoHS & REACH compliant.**



Recommended P.C.Board Layout (TOP VIEW)



ORDERING INFORMATION:

P/N M J 3 S - x x x B

1. NO. OF POSITIONS & CONTACTS:

"88" 8P8C

"84" 8P4C

- ## 2. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

TOP ENTRY MODULAR PCB JACK 8P PROFILE=16.59MM (FULLY SHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)

Soldering Temperature: 235°C

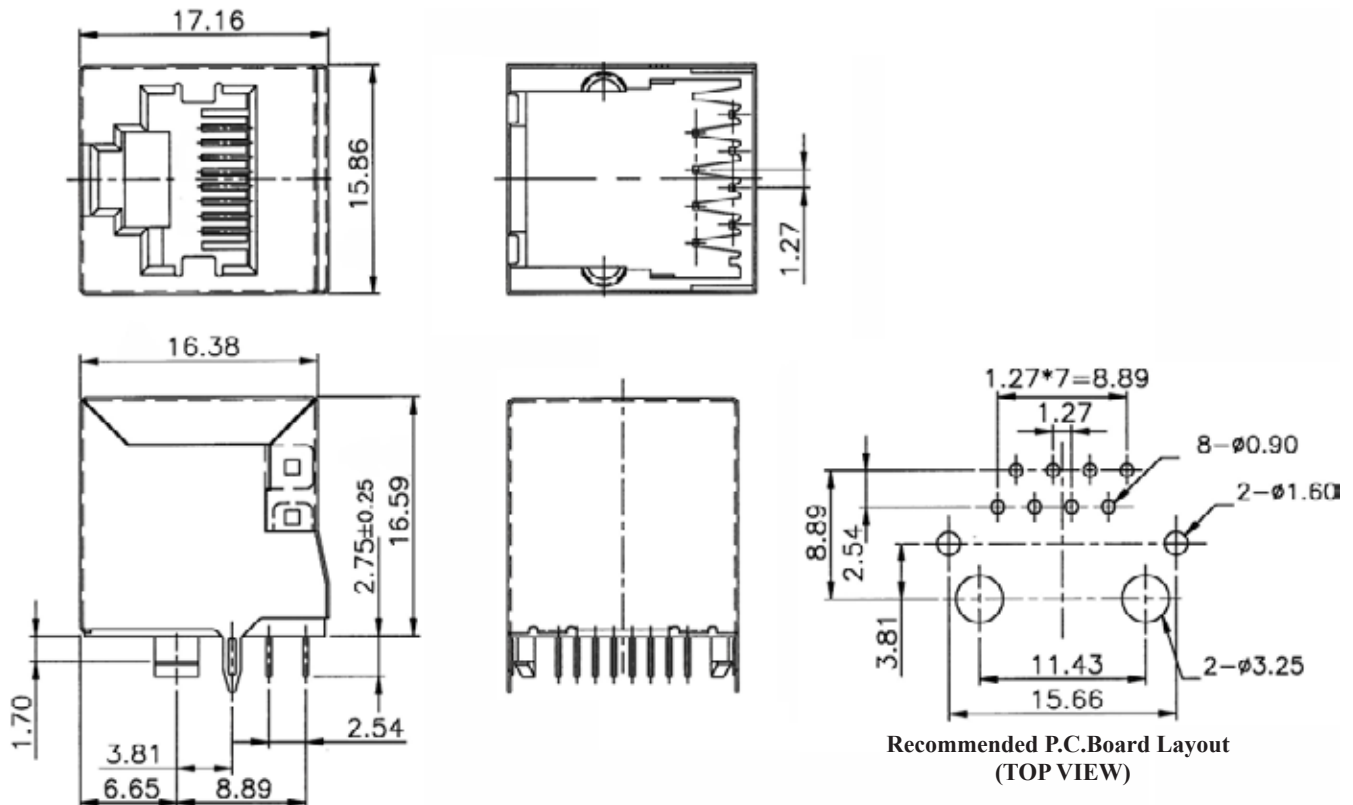
Color: Black

Spring Wire: Phosphor Bronze

Gold plating Over Nickel

Shield: Brass plating Nickel Alloy

***RoHS & REACH compliant.**



ORDERING INFORMATION:

P/N MJ35 - $\frac{x}{T} \frac{x}{2} B$

1. NO. OF POSITIONS & CONTACTS:

"88" 8P8C

"84" 8P4C

2. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

NOTE: P/N MJ35HT-88xB FOR HIGH TEMP. VERSION

TOP ENTRY MODULAR PCB JACK 10P PROFILE=16.59MM (FULLY SHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)

Soldering Temperature: 235°C

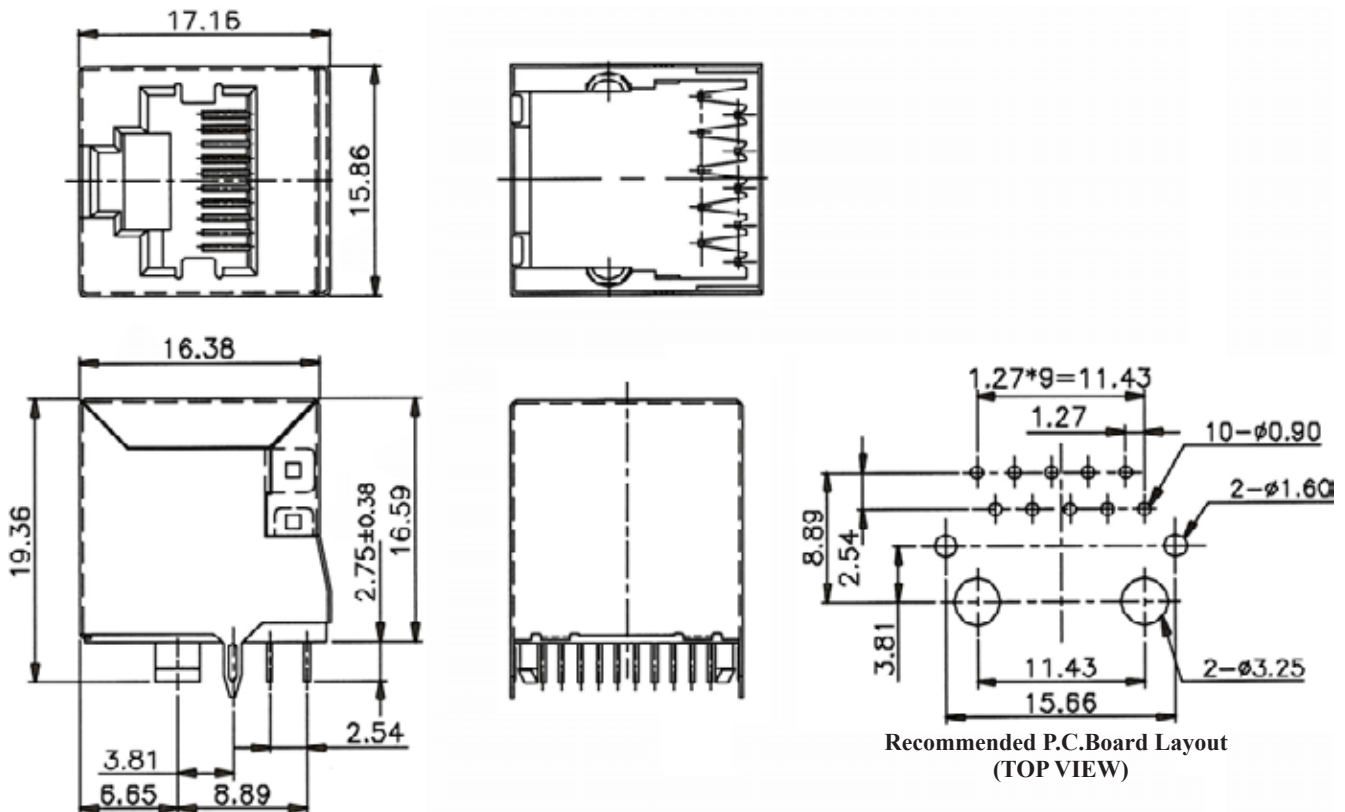
Color: Black

Spring Wire: Phosphor Bronze

Gold plating Over Nickel

Shield: Brass plating Nickel Alloy

***RoHS & REACH compliant.**



ORDERING INFORMATION:

P/N MJ35 - $\frac{x}{T} \frac{x}{2} B$

1. NO. OF POSITIONS & CONTACTS:

"00" 10P10C

"08" 10P8C

2. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

TOP ENTRY MODULAR PCB JACK 8P PROFILE=16.59MM (FULLY SHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)

Soldering Temperature: 235°C

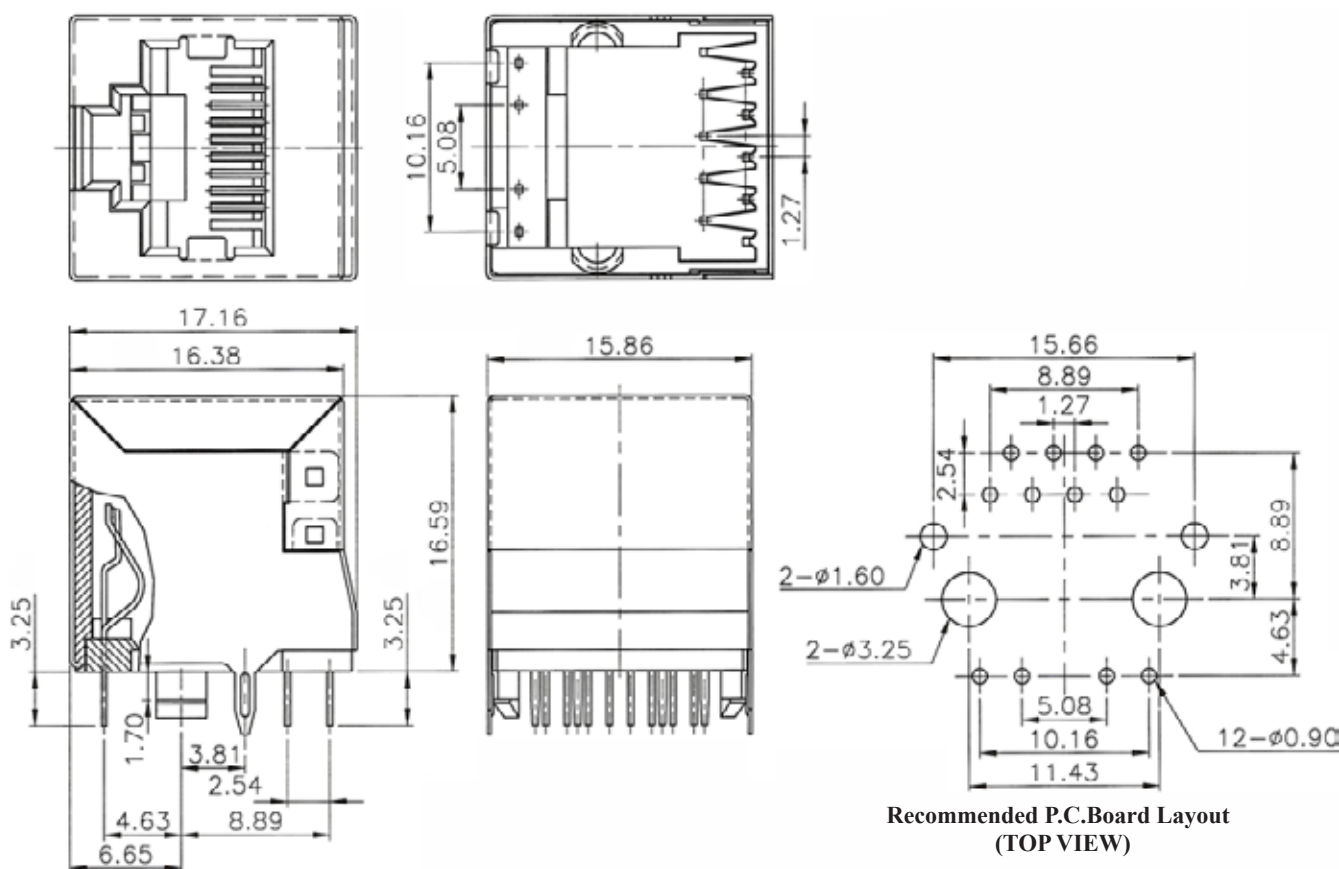
Color: Black

Spring Wire: Phosphor Bronze

Gold plating Over Nickel

Shield: Brass plating Nickel Alloy

***RoHS & REACH compliant.**



Recommended P.C.Board Layout
(TOP VIEW)

ORDERING INFORMATION:

P/N MJ8R - $\frac{xx}{T} \frac{x}{2} B$

1. NO. OF POSITIONS & CONTACTS:

"88" 8P8C

"84" 8P4C

2. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

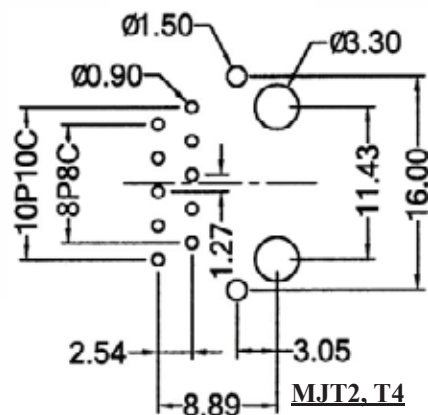
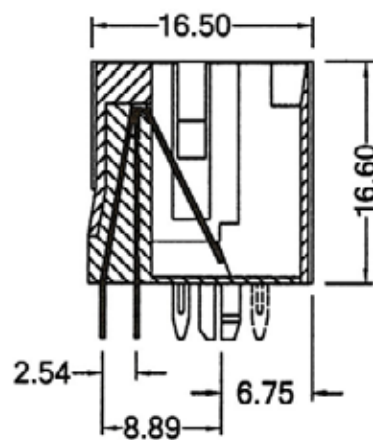
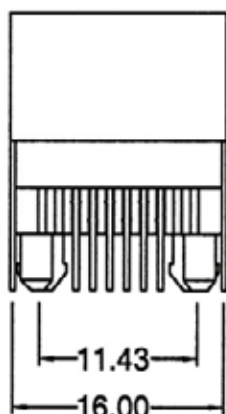
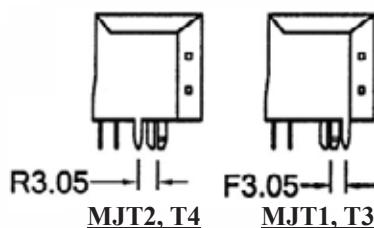
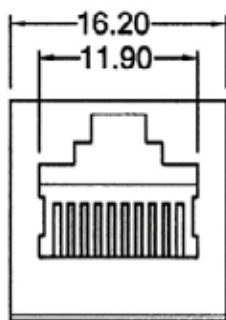
TOP ENTRY MODULAR PCB JACK 8P+10P PROFILE=16.60MM (FULLY SHIELDED)

SPECIFICATIONS

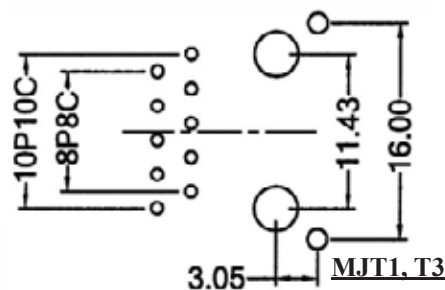
Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Black
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
Shield: Brass plating Nickel Alloy
***RoHS & REACH compliant.**



Recommended P.C.Board Layout
(TOP VIEW)



Recommended P.C.Board Layout
(TOP VIEW)

ORDERING INFORMATION:

P/N M J $\frac{xx}{1} - \frac{xx}{2} \frac{xx}{3} B$

- PANEL STOP & SPACING OPTION:
 "T1" F3.05 WITH PANEL STOP
 "T2" R3.05 WITH PANEL STOP
 "T3" F3.05 W/O PANEL STOP
 "T4" R3.05 W/O PANEL STOP
- NO. OF POSITIONS & CONTACTS:
 "88" 8P8C
 "00" 10P10C
- CONTACT FINISH:
 "A" 6 MICROINCH GOLD
 "B" 15 MICROINCH GOLD
 "C" 30 MICROINCH GOLD
 "D" 50 MICROINCH GOLD

TOP ENTRY MODULAR PCB JACK 8P PROFILE=16.90MM (FULLY SHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)

Soldering Temperature: 235°C

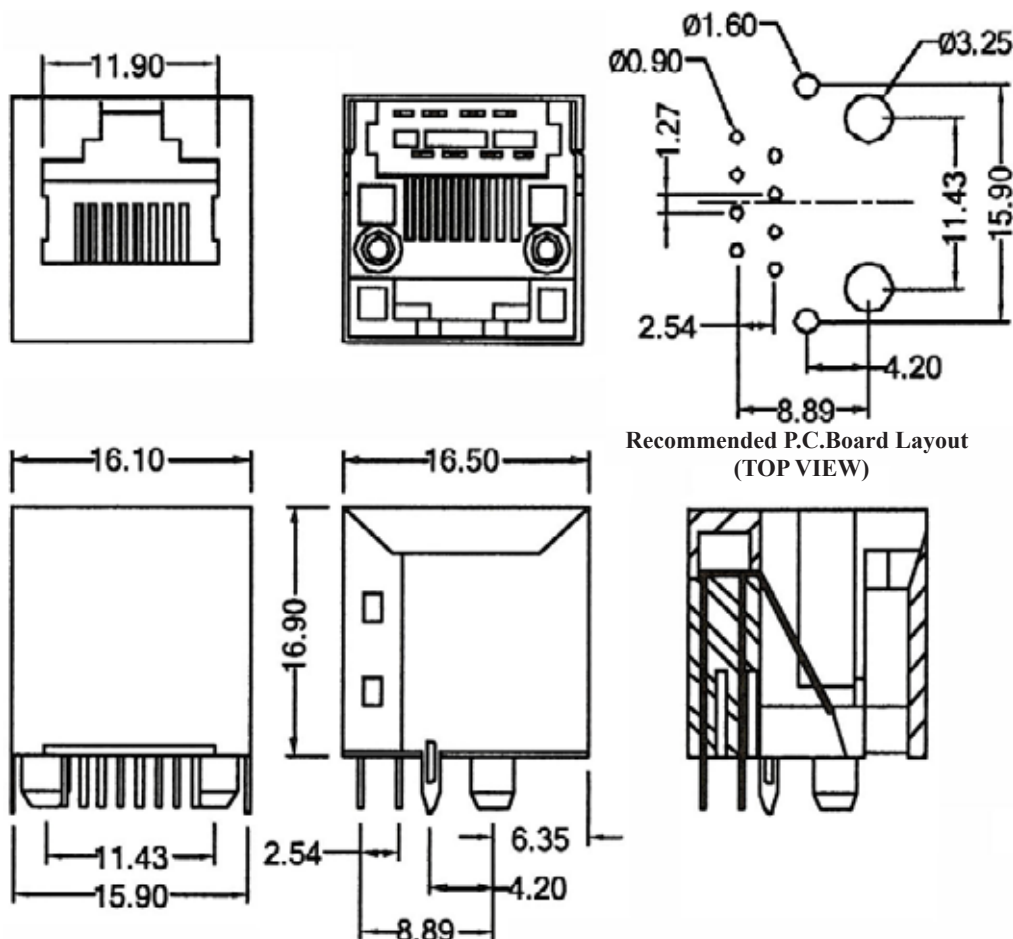
Color: Black

Spring Wire: Phosphor Bronze

Gold plating Over Nickel

Shield: Brass plating Nickel Alloy

***RoHS & REACH compliant.**



ORDERING INFORMATION:

P/N M J 7 X - 88₁x₂ B

1. NO. OF POSITIONS & CONTACTS:
"88" 8P8C
2. CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD

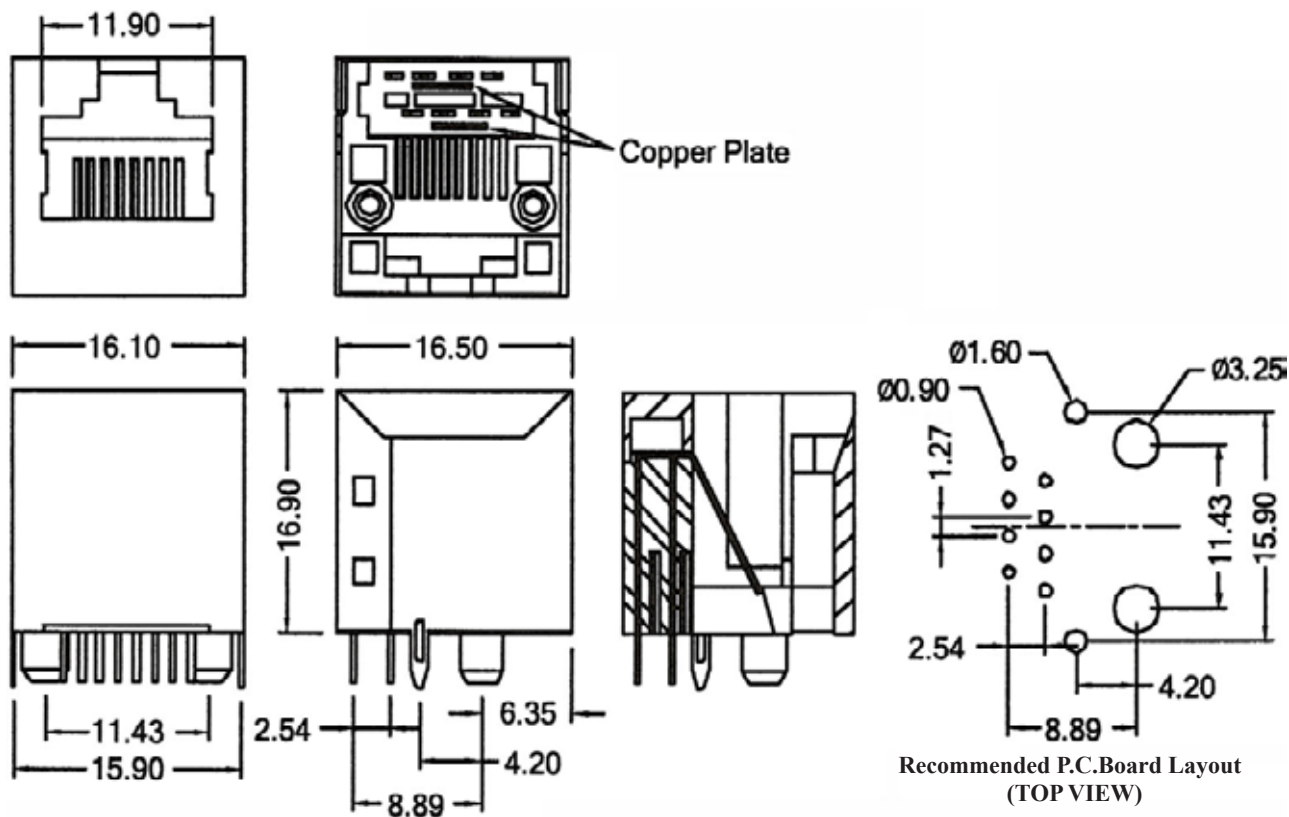
TOP ENTRY MODULAR PCB JACK WITH COPPER PLATE 8P PROFILE=16.90MM (FULLY SHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Black
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
Shield: Brass plating Nickel Alloy
***RoHS & REACH compliant.**



ORDERING INFORMATION:

P/N M J 7 D - $\frac{88}{T} \times \frac{B}{2}$

1. NO. OF POSITIONS & CONTACTS:
"88" 8P8C
2. CONTACT FINISH:
 "A" 6 MICROINCH GOLD
 "B" 15 MICROINCH GOLD
 "C" 30 MICROINCH GOLD
 "D" 50 MICROINCH GOLD

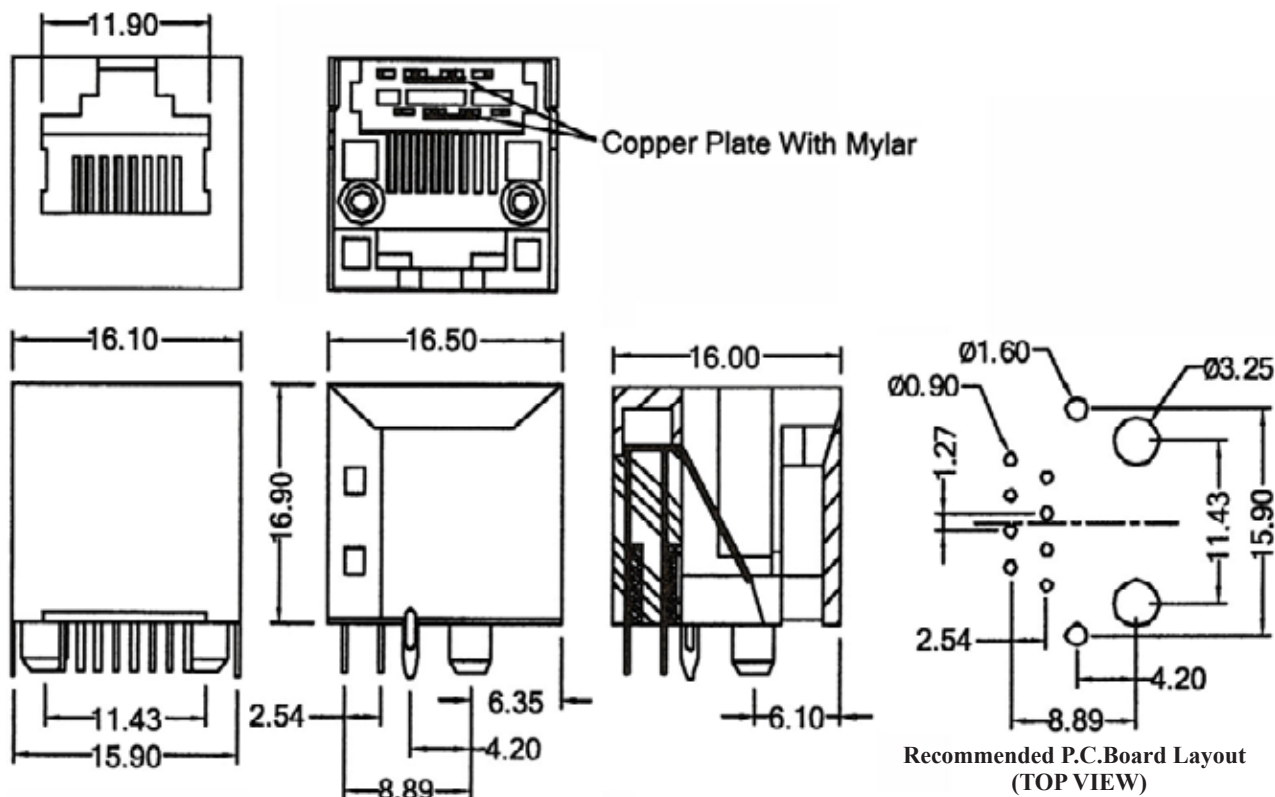
TOP ENTRY MODULAR PCB JACK WITH FILM (MYLAR) 8P PROFILE=16.90MM (FULLY SHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Black
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
Shield: Brass plating Nickel Alloy
***RoHS & REACH compliant.**



ORDERING INFORMATION:

P/N M J 7 S - 88 $\frac{x}{2}$ B

1. NO. OF POSITIONS & CONTACTS:
"88" 8P8C
2. CONTACT FINISH:
 "A" 6 MICROINCH GOLD
 "B" 15 MICROINCH GOLD
 "C" 30 MICROINCH GOLD
 "D" 50 MICROINCH GOLD

TOP ENTRY MODULAR SMT JACK WITH SOLDER PAD 8P PROFILE=13.10MM (FULLY SHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: Nylon (UL 94V-0)

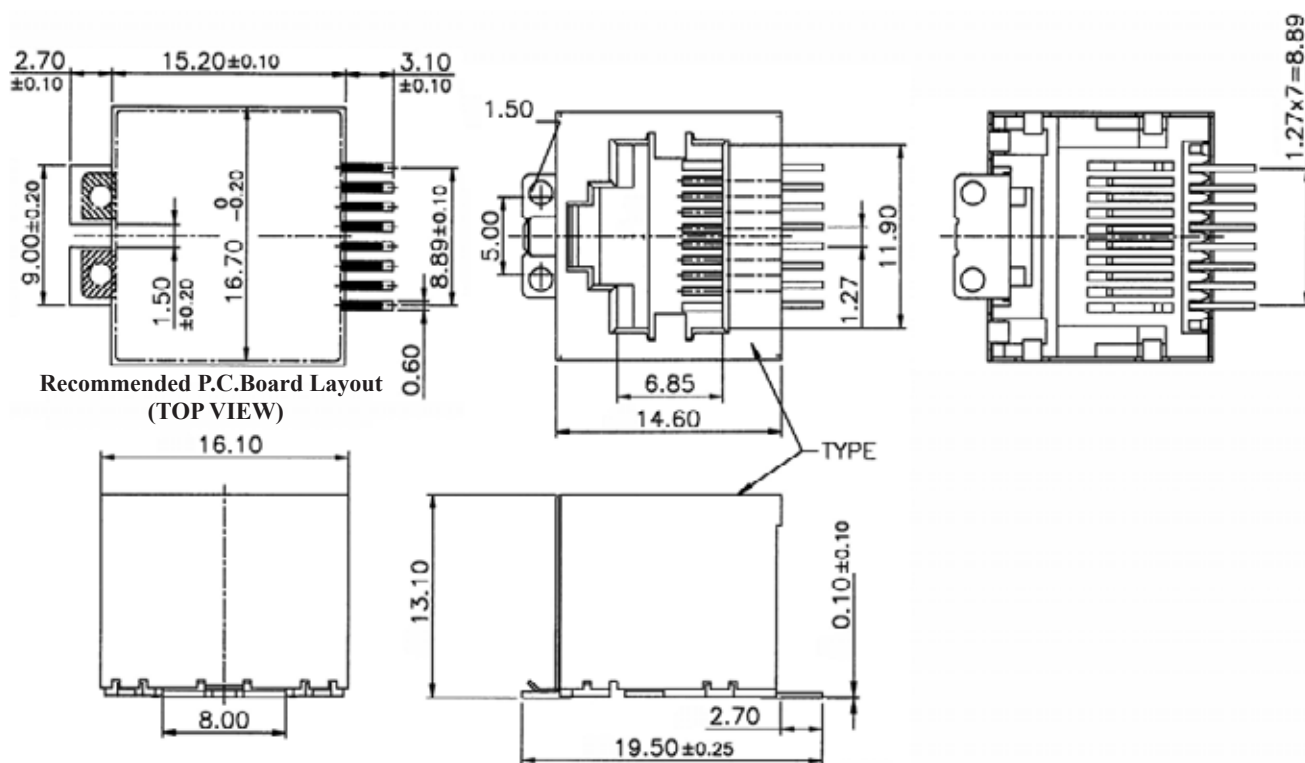
Soldering Temperature: 260°C

Color: Black

Spring Wire: Phosphor Bronze

Gold plating Over Nickel

*RoHS & REACH compliant.



ORDERING INFORMATION:

P/N M J B 6 - $\frac{x}{1} \frac{x}{2} \frac{x}{3}$ B - $\frac{x}{3}$

1. NO. OF POSITIONS & CONTACTS:

"88" 8P8C

"84" 8P4C

2. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

3. PACKAGE OPTION:

" " TRAY

"R" TAPE & REEL

TOP ENTRY MODULAR PCB JACK 8P PRESS FIT TYPE PROFILE=16.59MM (FULLY SHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)

Soldering Temperature: 235°C

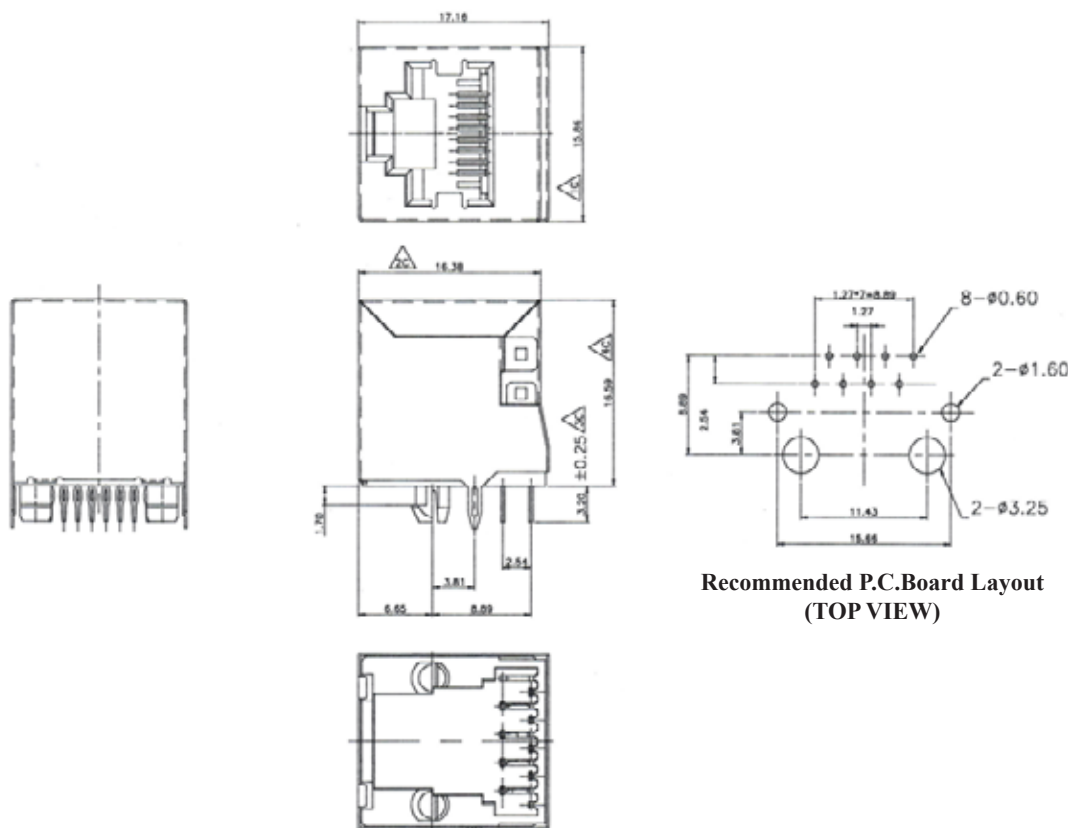
Color: Black

Spring Wire: Phosphor Bronze

Gold plating Over Nickel

Shield: Brass plating Nickel Alloy

***RoHS & REACH compliant.**



Recommended P.C.Board Layout
(TOP VIEW)

ORDERING INFORMATION:

P/N M J $\frac{P}{1}$ G - $\frac{8}{2}$ $\frac{8}{3}$ $\frac{B}{4}$

1. MODULAR JACK TYPE:
"PG" PRESS FIT TYPE
2. NO. OF POSITIONS & CONTACTS:
"88" 8P8C
3. CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD
4. HOUSING COLOR:
"B" BLACK

TOP ENTRY MODULAR PCB JACK 8P PRESS FIT TYPE PROFILE=16.82MM (FULLY SHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C to +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)

Soldering Temperature: 235°C

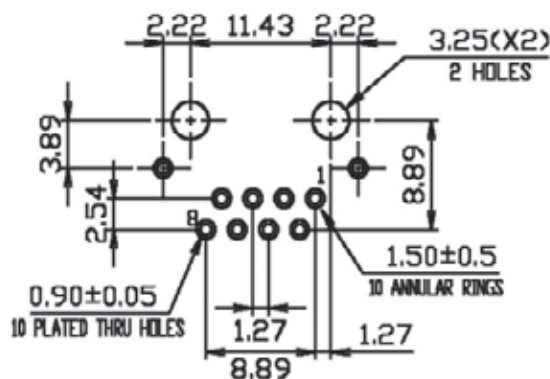
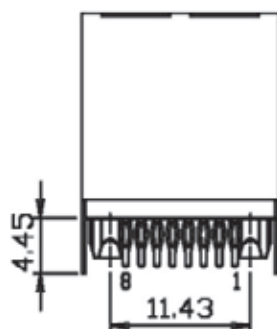
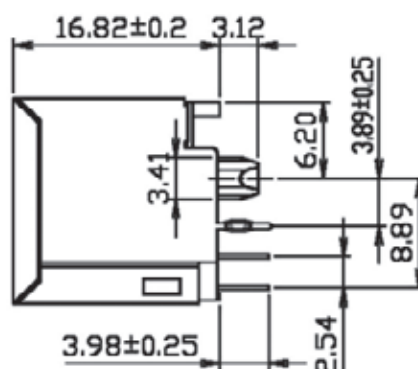
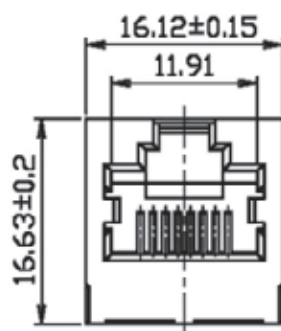
Color: Black

Spring Wire: Phosphor Bronze

Gold plating Over Nickel

Shield: Brass plating Nickel Alloy

*RoHS & REACH compliant.



Recommended P.C.Board Layout

ORDERING INFORMATION:

P/N M J PJ - 88 x B
 1 2 3 4

- MODULAR JACK TYPE:
"PJ" PRESS FIT TYPE
- NO. OF POSITIONS & CONTACTS:
"88" 8P8C
- CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD
- HOUSING COLOR:
"B" BLACK

TOP ENTRY MODULAR PCB JACK 8P PROFILE=12.70MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)

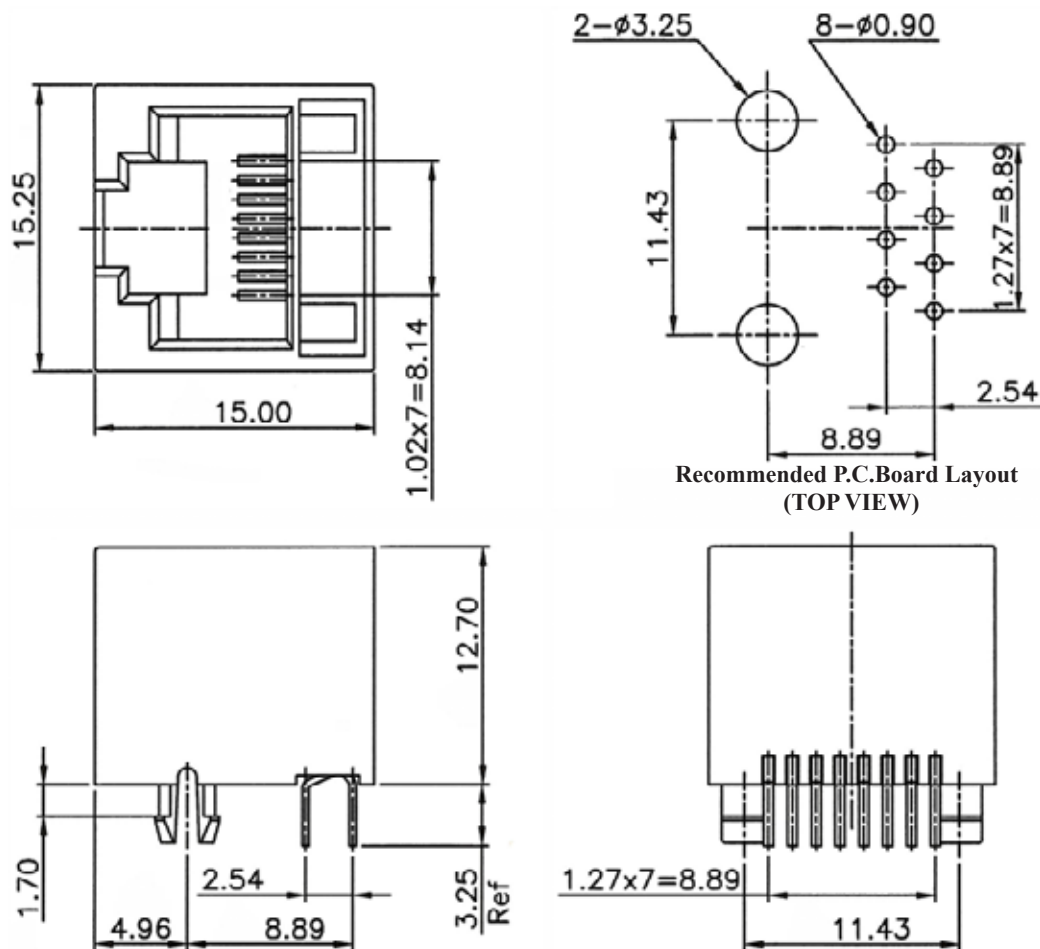
Soldering Temperature: 235°C

Color: Black

Spring Wire: Phosphor Bronze

Gold plating Over Nickel

*RoHS & REACH compliant.



ORDERING INFORMATION:

P/N M J 4 0 - $\frac{x}{T} \frac{x}{2} B$

1. NO. OF POSITIONS & CONTACTS:

"88" 8P8C

"84" 8P4C

2. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

TOP ENTRY MODULAR PCB JACK 8P PROFILE=12.70MM (UNSHIELDED)

SPECIFICATIONS

Electrical:

1. **Voltage Rating:** 125 Vac Rms.
2. **Current Rating:** 1.5 Amp.
3. **Contact Resistance:** 40 Milliohms Max.
4. **Insulation Resistance:** 1000 Megohms Min @500 Vdc.
5. **Dielectric Strength:** 1000 Vac Rms 60Hz, 1Min.

Mechanical:

1. **Operating:** 750 Cycles Min.

Environmental:

1. **Storage:** -40°C To +85°C.
2. **Operation:** -40°C To +80°C.

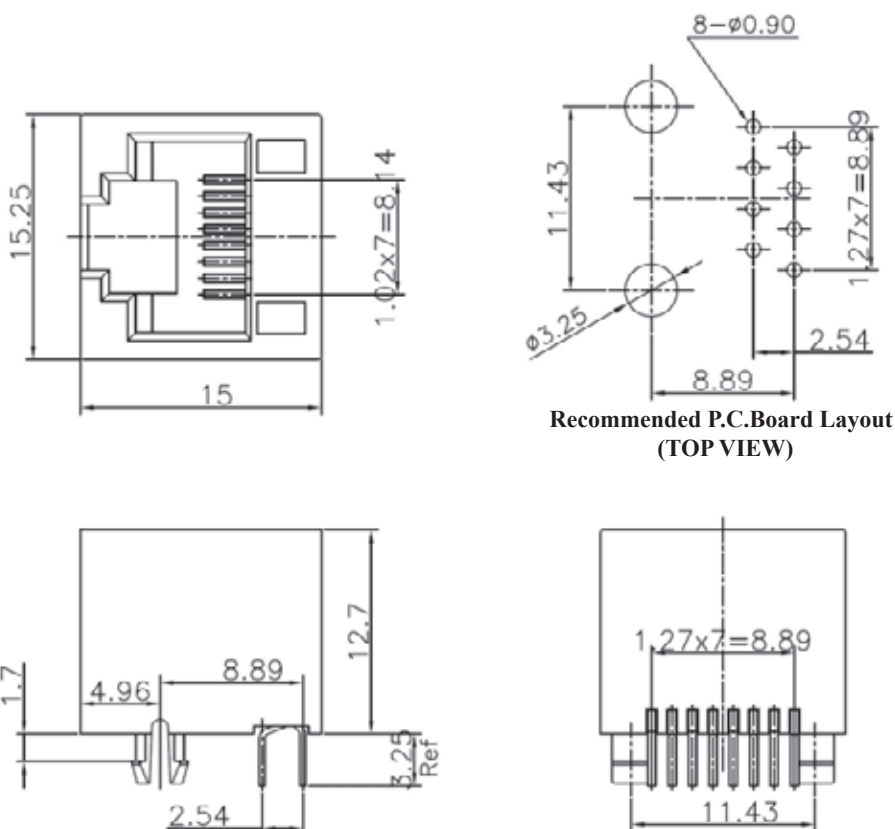
MATERIALS

Plastic Housing: Engineering Thermoplastic
Flammability Rating UL 94V-0.

Contacts: Phosphor Bronze

Plating: Gold Plating Over Nickel In Contact,
Tin Plating Over Nickel In Solder Area.

* RoHS & REACH compliant.



ORDERING INFORMATION:

P/N **MJ 40 J - 88 x B**
1 2 3

1. MODULAR JACK TYPE:
"40J" W/O STEP
2. NO. OF POSITIONS & CONTACTS:
"88" 8P8C
3. CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD

NOTE: IT CAN BE USED FOR REPLACING P/N MJ40-88xB.

TOP ENTRY CAT.5 MODULAR PCB JACK 8P PROFILE=12.70MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)

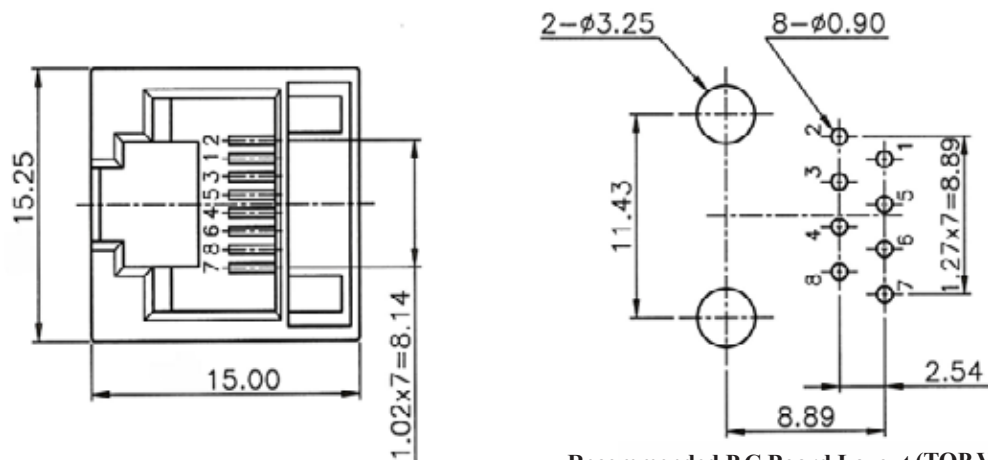
Soldering Temperature: 235°C

Color: Black

Spring Wire: Phosphor Bronze

Gold plating Over Nickel

*RoHS & REACH compliant.



Recommended P.C.Board Layout (TOP VIEW)

ORDERING INFORMATION:

P/N MJ5R - $\frac{88}{12}$ B

1. NO. OF POSITIONS & CONTACTS:

"88" 8P8C

2. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

NOTE: CATEGORY 5 VERSION

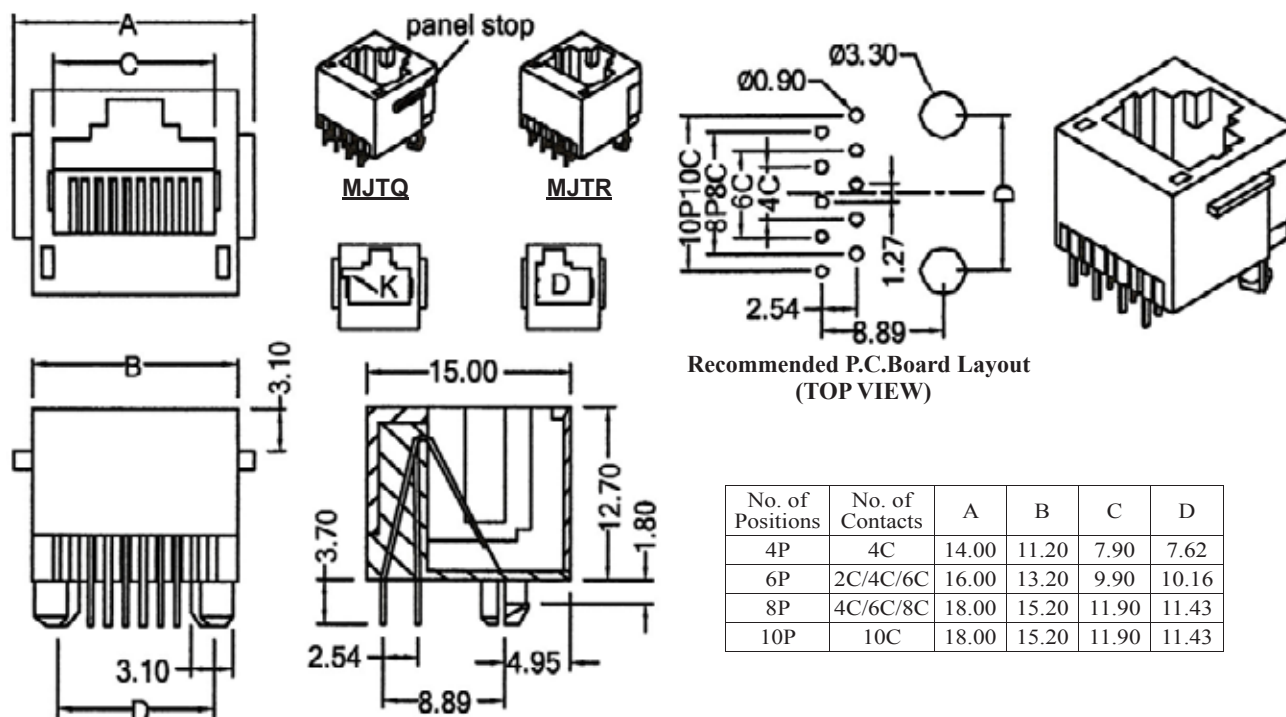
TOP ENTRY MODULAR PCB JACK 4P+6P+8P+10P PROFILE=12.70MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Black
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
***RoHS & REACH compliant.**



Recommended P.C.Board Layout
(TOP VIEW)

No. of Positions	No. of Contacts	A	B	C	D
4P	4C	14.00	11.20	7.90	7.62
6P	2C/4C/6C	16.00	13.20	9.90	10.16
8P	4C/6C/8C	18.00	15.20	11.90	11.43
10P	10C	18.00	15.20	11.90	11.43

ORDERING INFORMATION:

P/N M J $\frac{xx}{1} - \frac{xx}{2} \frac{x}{3} B \frac{x}{4}$

- PANEL STOP OPTION:
 "TQ" WITH PANEL STOP
 "TR" W/O PANEL STOP
- NO. OF POSITIONS & CONTACTS:
 "66" 6P6C
 "64" 6P4C
 "88" 8P8C
 "00" 10P10C
 "44" 4P4C

- CONTACT FINISH:
 "A" 6 MICROINCH GOLD
 "B" 15 MICROINCH GOLD
 "C" 30 MICROINCH GOLD
 "D" 50 MICROINCH GOLD
- KEYWAY & OFFSET OPTION:
 " " W/O KEYWAY & W/O OFFSET LATCH
 "K" WITH KEYWAY (for 8P & 10P)
 "D" WITH DEC (OFFSET) (for 6P ONLY)

TOP ENTRY CAT.5 MODULAR PCB JACK 8P PROFILE=13.60MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)

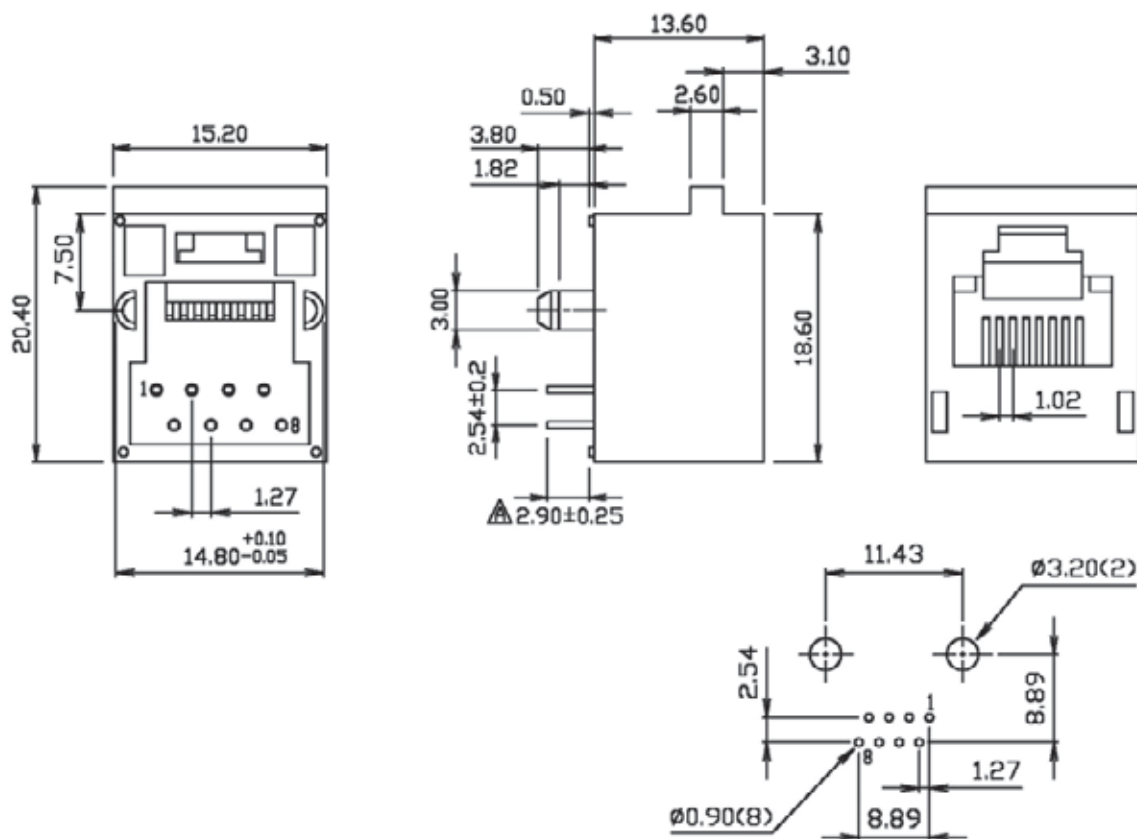
Soldering Temperature: 235°C

Color: Black

Spring Wire: Phosphor Bronze

Gold plating Over Nickel

*RoHS & REACH compliant.



Recommended P.C.Board Layout

ORDERING INFORMATION:

P/N M J G K - 8 8 x B
1 2 3 4

1. MODULAR JACK TYPE:

"GK" CAT.5 JACK

2. NO. OF POSITIONS & CONTACTS:

"88" 8P8C

3. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

4. HOUSING COLOR:

"B" BLACK

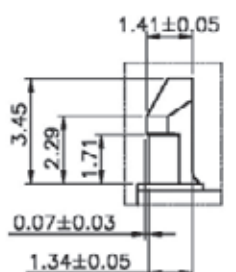
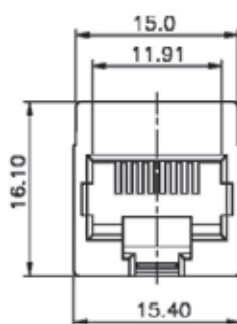
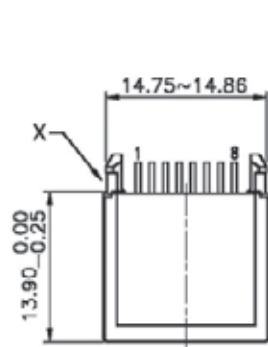
TOP ENTRY MODULAR PCB JACK 8P PROFILE=13.90MM (UNSHIELDED)

SPECIFICATIONS

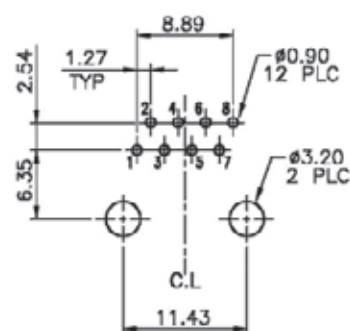
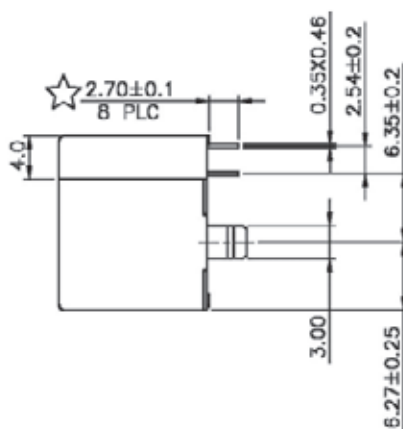
Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Black
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
***RoHS & REACH compliant.**



DETAIL X



Recommended P.C.Board Layout

ORDERING INFORMATION:

P/N M J GL - 88 x B
1 2 3 4

- MODULAR JACK TYPE:
"GL" STRAIGHT DIP TYPE
- NO. OF POSITIONS & CONTACTS:
"88" 8P8C
- CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD
- HOUSING COLOR:
"B" BLACK

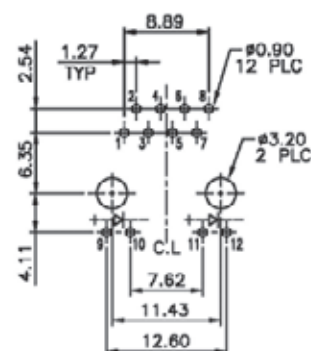
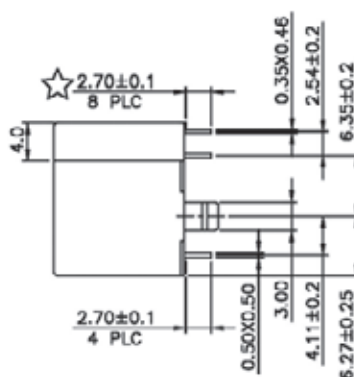
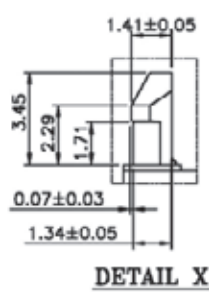
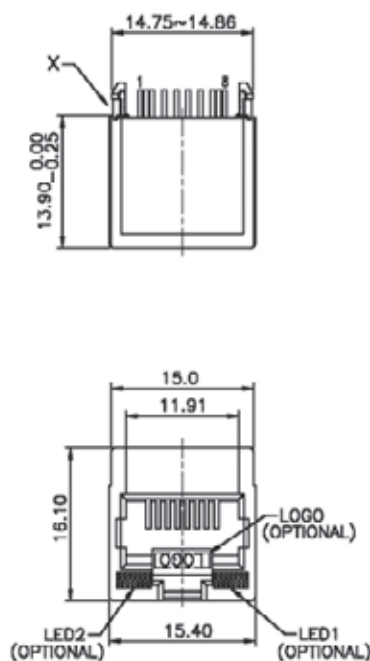
TOP ENTRY MODULAR PCB JACK 8P WITH LED PROFILE=13.90MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Black
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
***RoHS & REACH compliant.**



Recommended P.C.Board Layout
(TOP VIEW)

ORDERING INFORMATION:

P/N M J G T - 8 8 x B x x

- MODULAR JACK TYPE:
"GT" STRAIGHT DIP TYPE
- NO. OF POSITIONS & CONTACTS:
"88" 8P8C
- CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD
- HOUSING COLOR:
"B" BLACK

- COLORS OF LED:
"NN" LED1: GREEN & LED2: GREEN
"NY" LED1: GREEN & LED2: YELLOW
"YN" LED1: YELLOW & LED2: GREEN
"YY" LED1: YELLOW & LED2: YELLOW

NOTE: OTHER LED COLORS UPON REQUEST!

TOP ENTRY MODULAR PCB JACK 8P PROFILE=15.00MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)

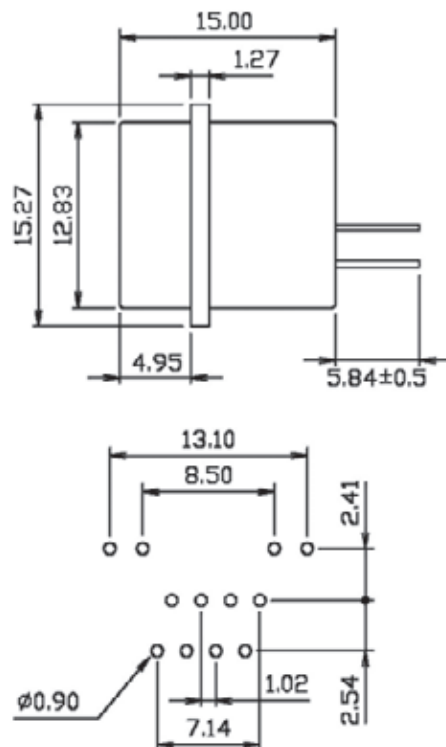
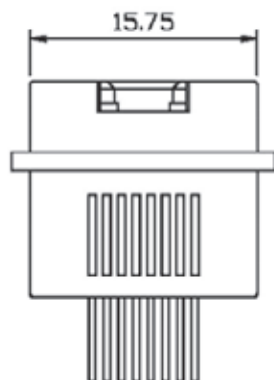
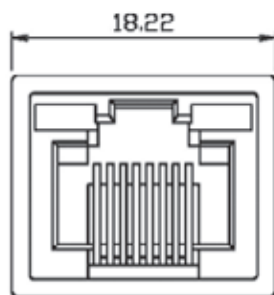
Soldering Temperature: 235°C

Color: Black

Spring Wire: Phosphor Bronze

Gold plating Over Nickel

***RoHS & REACH compliant.**



Recommended P.C.Board Layout

ORDERING INFORMATION:

P/N M J G H - 8 8 x B
1 2 3 4

1. MODULAR JACK TYPE:
"GH" HIGH SPEED PCB JACK
2. NO. OF POSITIONS & CONTACTS:
"88" 8P8C
3. CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD
4. HOUSING COLOR:
"B" BLACK

TOP ENTRY MODULAR PCB JACK 4P PROFILE=15.00MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)

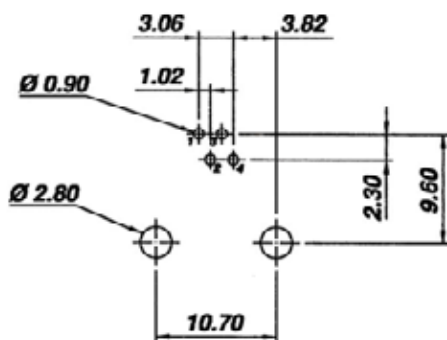
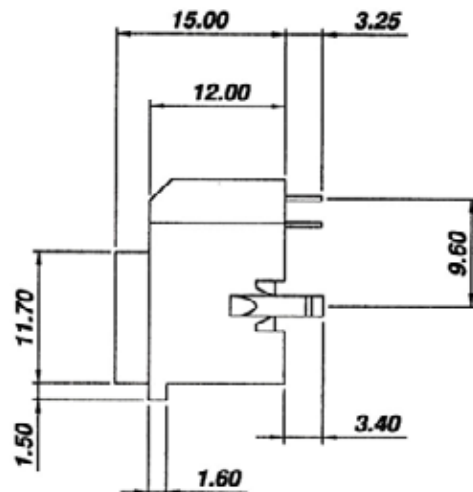
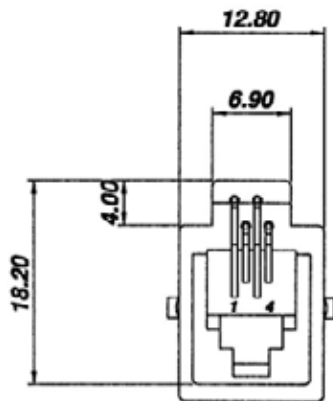
Soldering Temperature: 235°C

Color: Black

Spring Wire: Phosphor Bronze

Gold plating Over Nickel

*RoHS & REACH compliant.



Recommended P.C.Board Layout
(TOP VIEW)

ORDERING INFORMATION:

P/N M J T J - 4 4 x B
T 2

1. NO. OF POSITIONS & CONTACTS:

"44" 4P4C

2. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

NOTE: P/N MJTJHT-44xB FOR HIGH TEMP. VERSION

TOP ENTRY MODULAR PCB JACK 4P PROFILE=15.00MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)

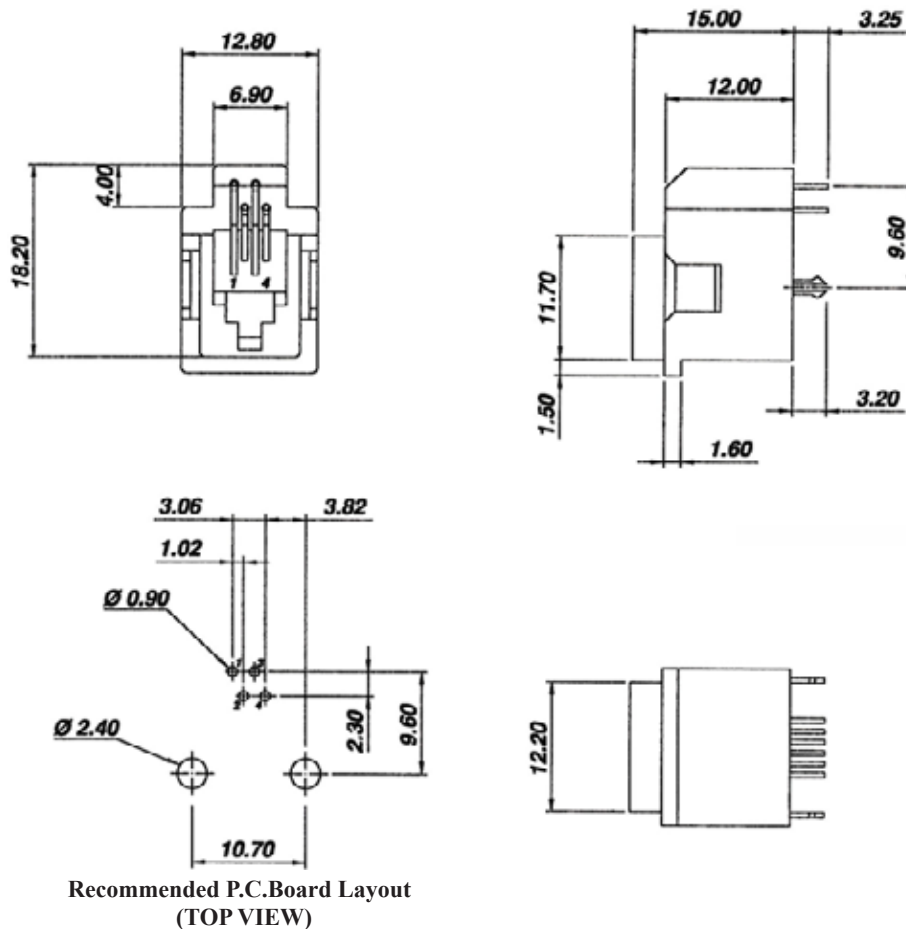
Soldering Temperature: 235°C

Color: Black

Spring Wire: Phosphor Bronze

Gold plating Over Nickel

*RoHS & REACH compliant.



ORDERING INFORMATION:

P/N MJTK - 44 x B
T 2

1. NO. OF POSITIONS & CONTACTS:

"44" 4P4C

2. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

NOTE: P/N MJTKHT-44xB FOR HIGH TEMP. VERSION

TOP ENTRY MODULAR PCB JACK 6P PROFILE=15.00MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)

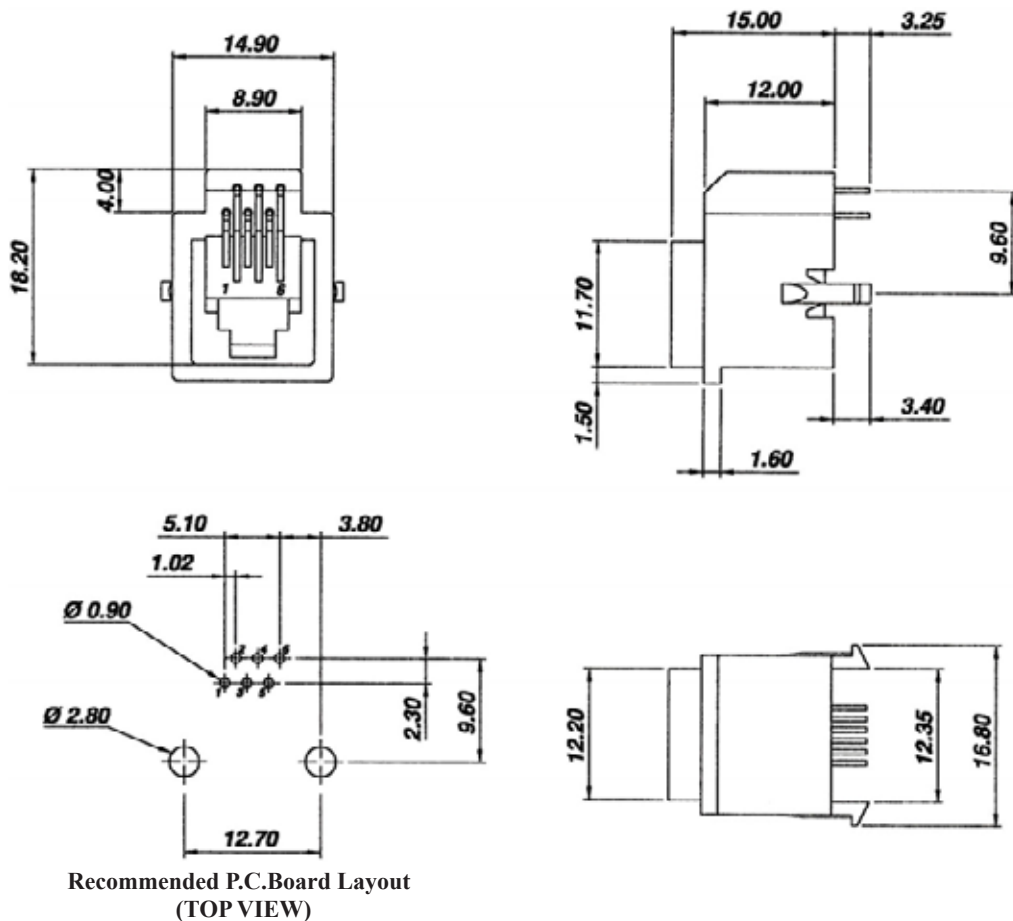
Soldering Temperature: 235°C

Color: Black

Spring Wire: Phosphor Bronze

Gold plating Over Nickel

*RoHS & REACH compliant.



ORDERING INFORMATION:

P/N M J T J - $\frac{x x x}{1 2}$ B

1. NO. OF POSITIONS & CONTACTS:

"66" 6P6C

"64" 6P4C

2. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

NOTE: P/N MJTJHT-xxx B FOR HIGH TEMP. VERSION

TOP ENTRY MODULAR PCB JACK 6P PROFILE=15.00MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)

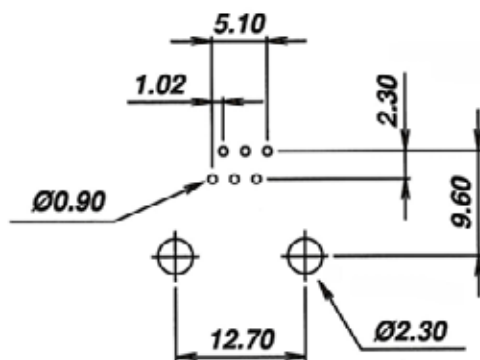
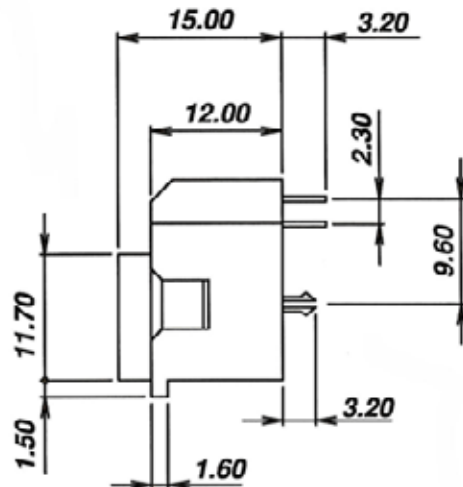
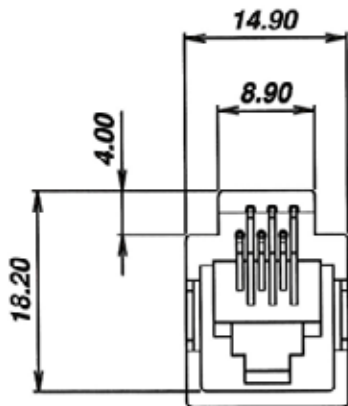
Soldering Temperature: 235°C

Color: Black

Spring Wire: Phosphor Bronze

Gold plating Over Nickel

*RoHS & REACH compliant.



Recommended P.C.Board Layout
(TOP VIEW)

ORDERING INFORMATION:

P/N M J T K - $\frac{xx}{T} \frac{xx}{2}$ B

1. NO. OF POSITIONS & CONTACTS:

"66" 6P6C

"64" 6P4C

2. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

TOP ENTRY MODULAR PCB JACK WITH LED 8P PROFILE=15.00MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: Nylon (UL 94V-0)

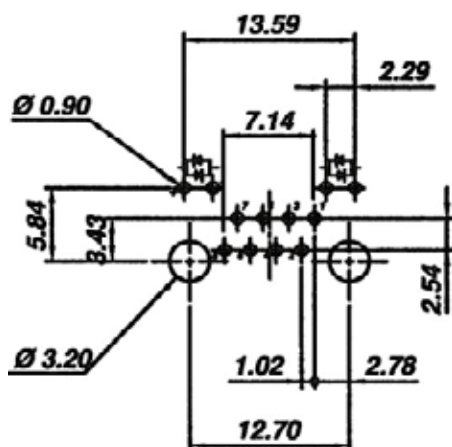
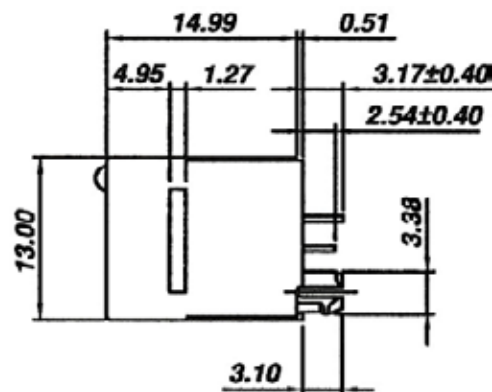
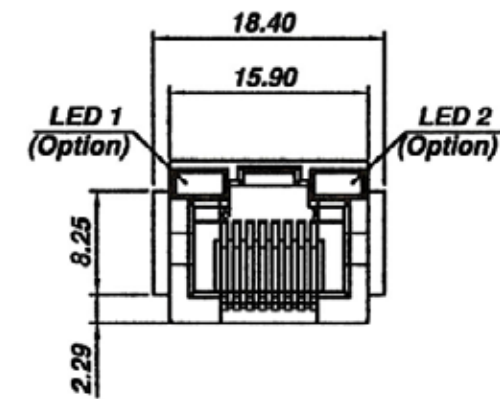
Soldering Temperature: 260°C

Color: Black

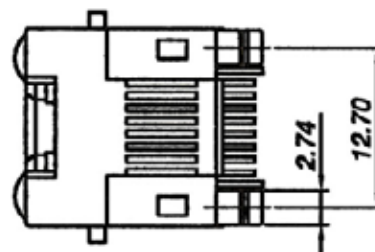
Spring Wire: Phosphor Bronze

Gold plating Over Nickel

*RoHS & REACH compliant.



Recommended P.C. Board Layout
(TOP VIEW)



ORDERING INFORMATION:

P/N M J T G - $\frac{88}{1} \times \frac{B}{2} \times \frac{X}{3} \times \frac{X}{4}$

1. NO. OF POSITIONS & CONTACTS:

"88" 8P8C

2. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

3. CODE OF LED1 DESIGNATION:

N, M, Y, Z, 8, Q, 1, 2, 5, 6

4. CODE OF LED2 DESIGNATION:

N, M, Y, Z, 8, Q, 1, 2, 5, 6

LED Designation:

Code	+/-	-/+	Code	+/-	-/+
N	Green	—	M	—	Green
Y	Yellow	—	Z	—	Yellow
8	Orange	—	Q	—	Orange
1	Green	Orange	2	Orange	Green
5	Green	Yellow	6	Yellow	Green

TOP ENTRY 1-PORT MODULAR PCB JACK WITH METAL PEGS 8P PROFILE=15.40MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)

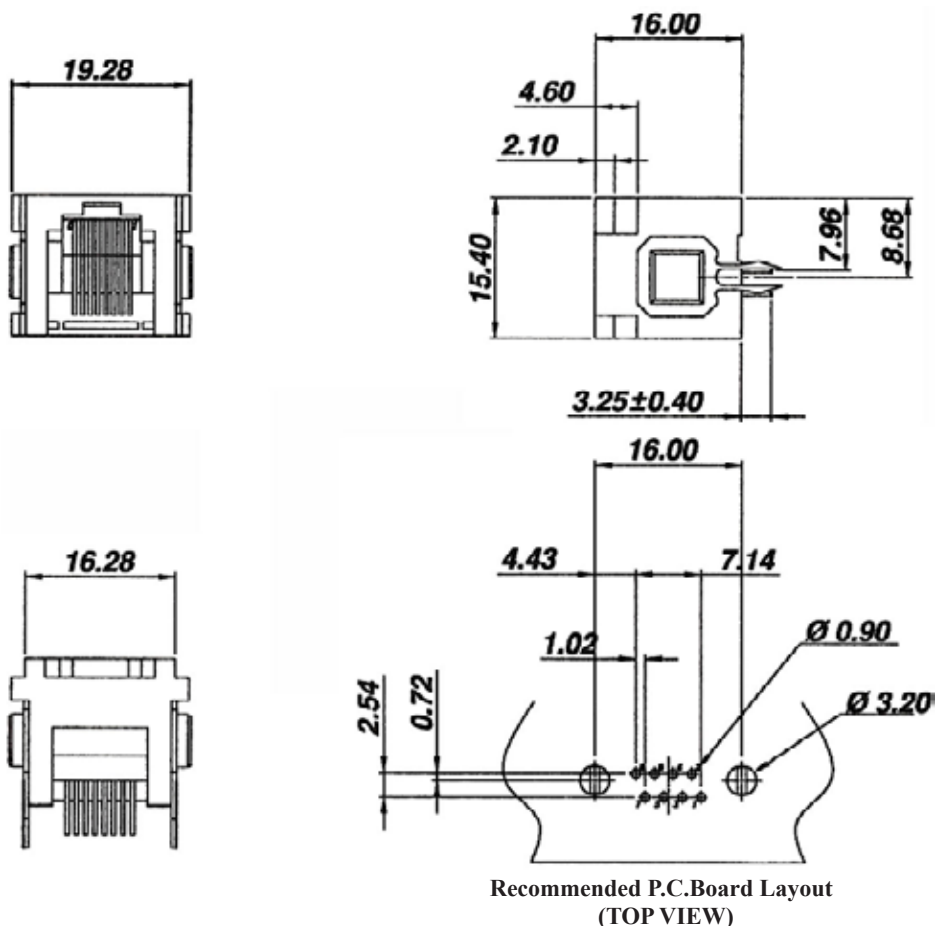
Soldering Temperature: 235°C

Color: Black & Gray

Spring Wire: Phosphor Bronze

Gold plating Over Nickel

*RoHS & REACH compliant.



ORDERING INFORMATION:

P/N MJ6M - $\frac{88}{1} \times \frac{x}{2} \times \frac{01}{34}$

1. NO. OF POSITIONS & CONTACTS:

"88" 8P8C

2. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

3. HOUSING COLOR:

"A" GRAY

"B" BLACK

4. NO. OF PORTS:

01

NOTE: P/N MJ6MHT-88xx01 FOR HIGH TEMP. VERSION

TOP ENTRY 2-PORT MODULAR PCB JACK WITH METAL PEGS 8P PROFILE=15.40MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)

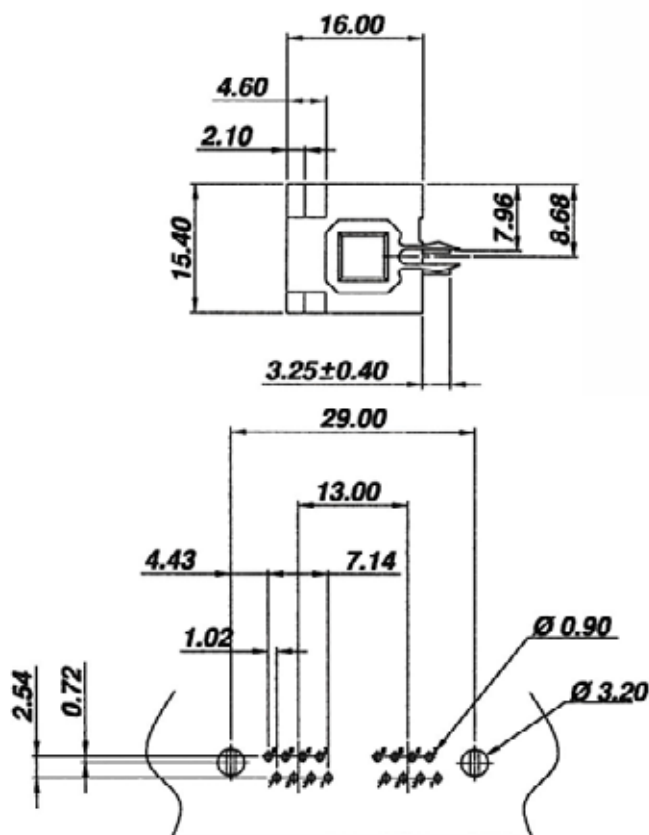
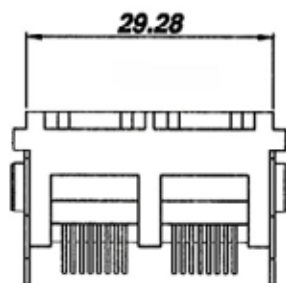
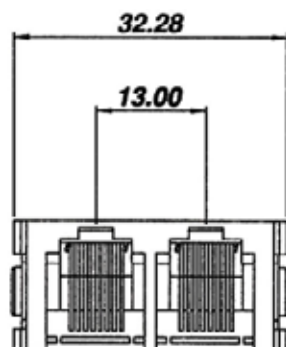
Soldering Temperature: 235°C

Color: Black & Gray

Spring Wire: Phosphor Bronze

Gold plating Over Nickel

*RoHS & REACH compliant.



Recommended P.C.Board Layout
(TOP VIEW)

ORDERING INFORMATION:

P/N MJ6M - $\frac{88}{1} \times \frac{02}{34}$

1. NO. OF POSITIONS & CONTACTS:

"88" 8P8C

2. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

3. HOUSING COLOR:

"A" GRAY

"B" BLACK

4. NO. OF PORTS:

02

NOTE: P/N MJ6MHT-88xx02 FOR HIGH TEMP. VERSION

TOP ENTRY 3-PORT MODULAR PCB JACK WITH METAL PEGS 8P PROFILE=15.40MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)

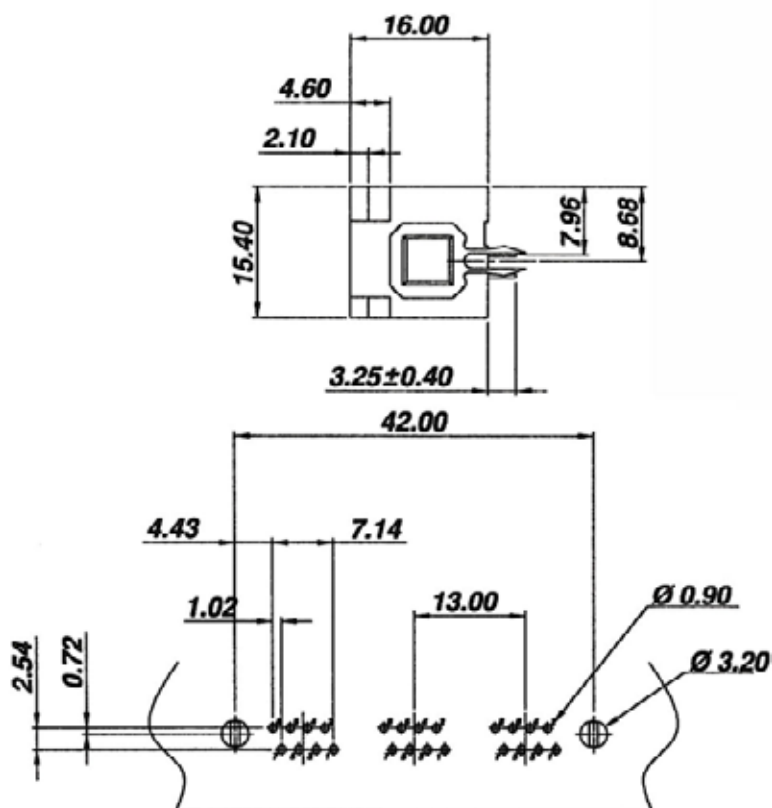
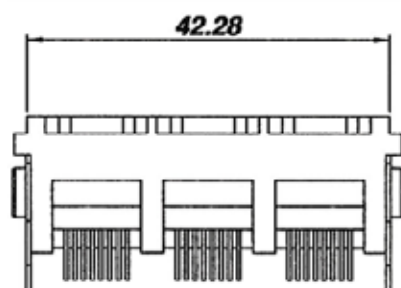
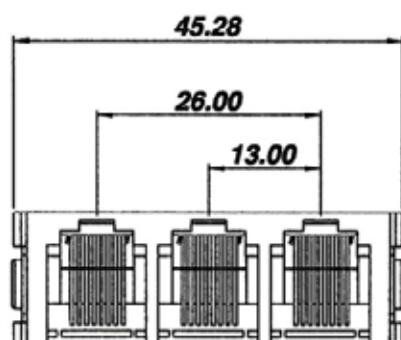
Soldering Temperature: 235°C

Color: Black & Gray

Spring Wire: Phosphor Bronze

Gold plating Over Nickel

*RoHS & REACH compliant.



Recommended P.C.Board Layout
(TOP VIEW)

ORDERING INFORMATION:

P/N MJ6M - $\frac{88}{1} \times \frac{23}{3} \times \frac{03}{4}$

1. NO. OF POSITIONS & CONTACTS:

"88" 8P8C

2. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

3. HOUSING COLOR:

"A" GRAY

"B" BLACK

4. NO. OF PORTS:

03

NOTE: P/N MJ6MHT-88xx03 FOR HIGH TEMP. VERSION

TOP ENTRY MODULAR PCB JACK WITH LED 8P PROFILE=15.50MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)

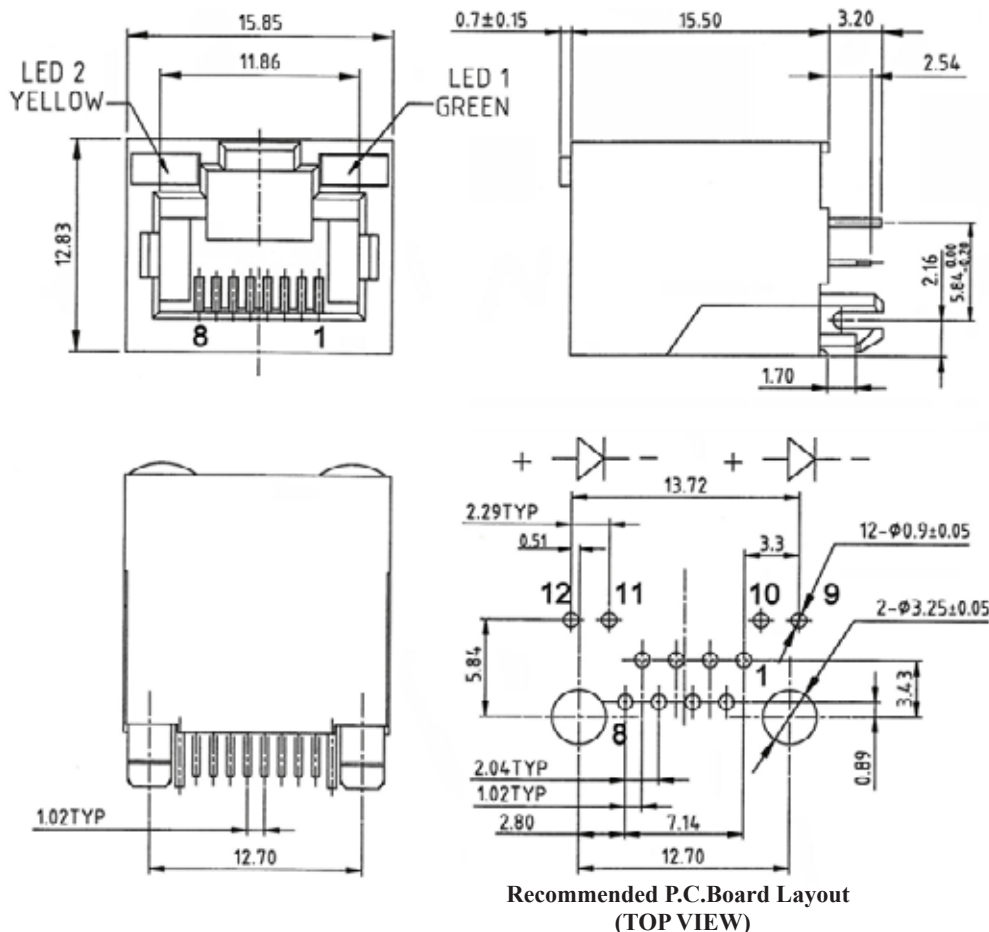
Soldering Temperature: 235°C

Color: Black

Spring Wire: Phosphor Bronze

Gold plating Over Nickel

*RoHS & REACH compliant.



ORDERING INFORMATION:

P/N M J B 1 - $\frac{88}{1} \frac{x}{2} \frac{B}{3} \frac{x}{4}$

1. NO. OF POSITIONS & CONTACTS:

"88" 8P8C

2. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

3. CODE OF LED1 DESIGNATION:

N, M, Y, Z, 8, Q, 1, 2, 5, 6

4. CODE OF LED2 DESIGNATION:

N, M, Y, Z, 8, Q, 1, 2, 5, 6

LED Designation:

Code	+/-	-/+	Code	+/-	-/+
N	Green	—	M	—	Green
Y	Yellow	—	Z	—	Yellow
8	Orange	—	Q	—	Orange
1	Green	Orange	2	Orange	Green
5	Green	Yellow	6	Yellow	Green

NOTE: LED 1 = RIGHT LED &
LED 2 = LEFT LED

TOP ENTRY MODULAR PCB JACK 6P PROFILE=15.56MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)

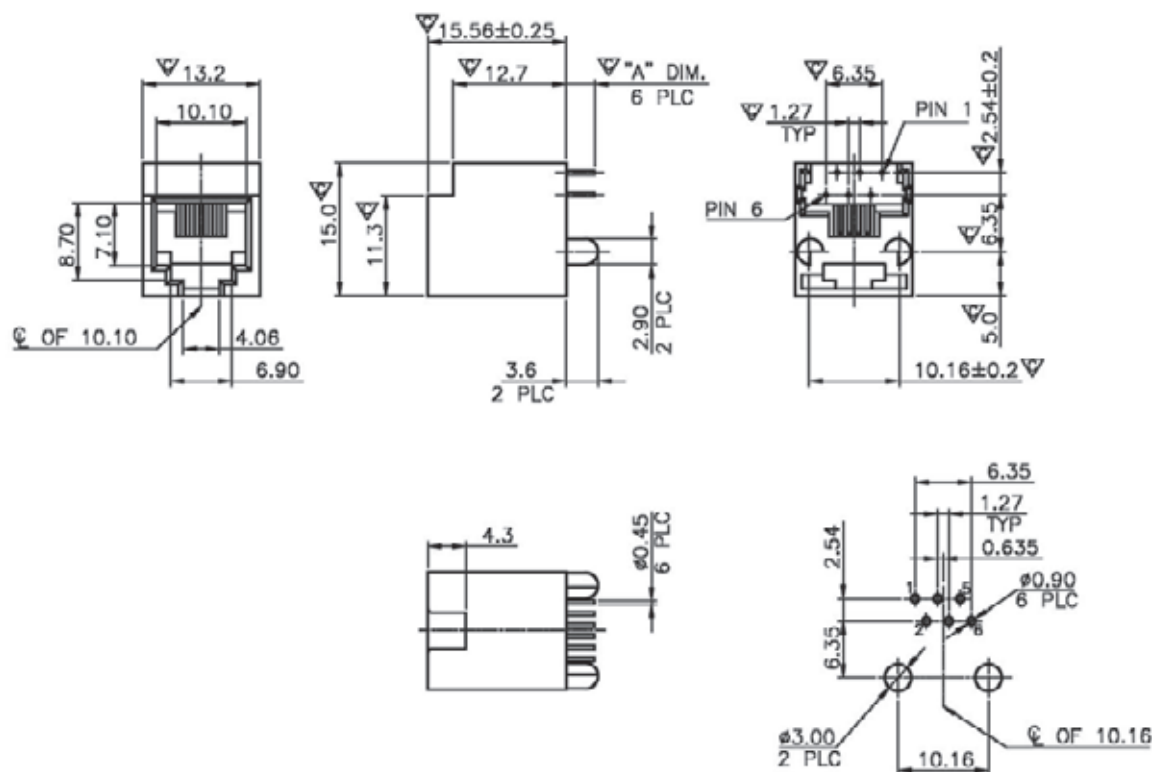
Soldering Temperature: 235°C

Color: Black

Spring Wire: Phosphor Bronze

Gold plating Over Nickel

*RoHS & REACH compliant.



Recommended P.C.Board Layout
Recommended PCB Thickness: 1.6mm
(TOP VIEW)

ORDERING INFORMATION:

P/N M J GM - 66 x B
1 2 3 4

1. MODULAR JACK TYPE:
"GM" L PEG TYPE
2. NO. OF POSITIONS & CONTACTS:
"66" 6P6C
"64" 6P4C
3. CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD
4. HOUSING COLOR:
"B" BLACK

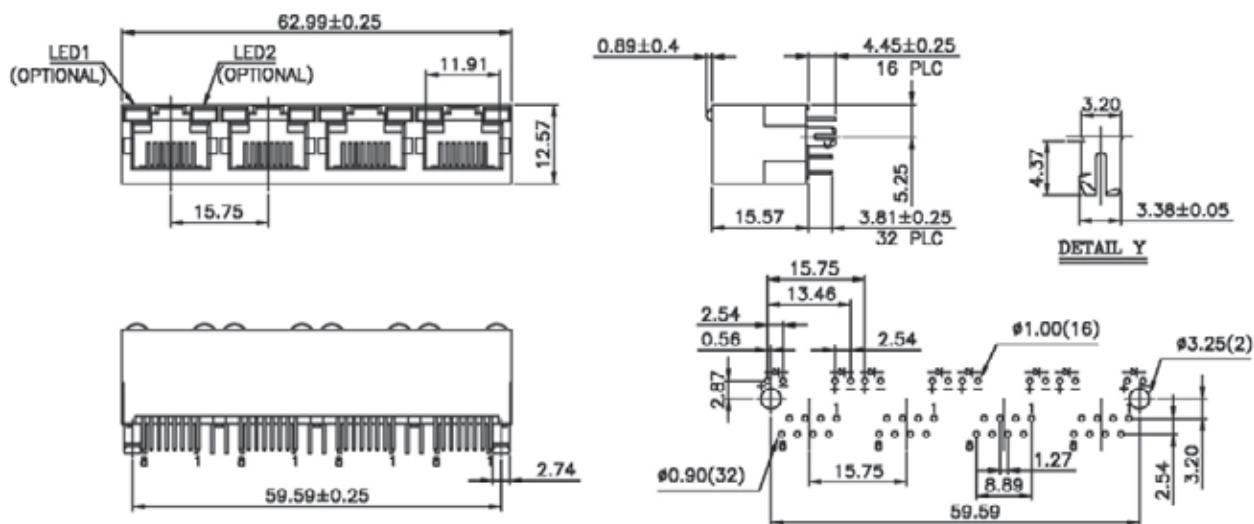
TOP ENTRY 4-PORT MODULAR PCB JACK 8P WITH LED PROFILE=15.57MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Black
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
***RoHS & REACH compliant.**



Recommended P.C.Board Layout

ORDERING INFORMATION:

P/N M J G S - 8 8 x B x x 0 4
 1 2 3 4 5 6

- MODULAR JACK TYPE:
"GS" STRAIGHT DIP TYPE
- NO. OF POSITIONS & CONTACTS:
"88" 8P8C
- CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD
- HOUSING COLOR:
"B" BLACK

- COLORS OF LED:
"NN" LED1: GREEN & LED2: GREEN
"NY" LED1: GREEN & LED2: YELLOW
"YN" LED1: YELLOW & LED2: GREEN
"YY" LED1: YELLOW & LED2: YELLOW
- NO. OF PORTS:
04

NOTE: OTHER LED COLORS UPON REQUEST!

TOP ENTRY 5-PORT MODULAR PCB JACK 8P PROFILE=15.57MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)

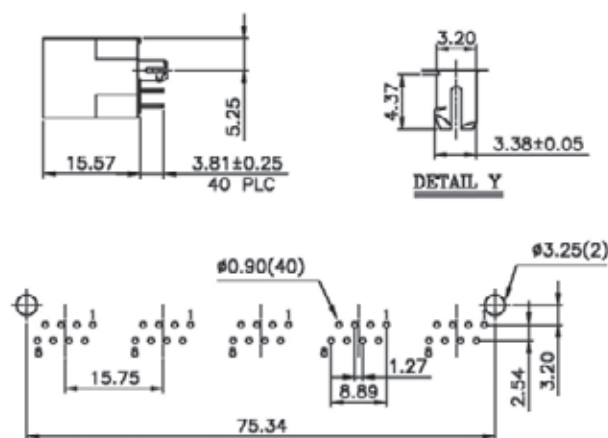
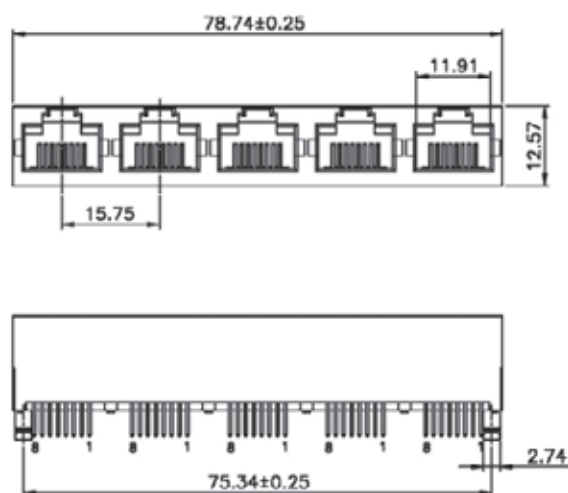
Soldering Temperature: 235°C

Color: Black

Spring Wire: Phosphor Bronze

Gold plating Over Nickel

*RoHS & REACH compliant.



Recommended P.C.Board Layout

ORDERING INFORMATION:

P/N M J G S - 8 8 x B 0 5
 1 2 3 4 5

1. MODULAR JACK TYPE:
"GS" STRAIGHT DIP TYPE
2. NO. OF POSITIONS & CONTACTS:
"88" 8P8C
3. CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD
4. HOUSING COLOR:
"B" BLACK
5. NO. OF PORTS:
04

TOP ENTRY 4-PORT MODULAR PCB JACK 8P PROFILE=15.57MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)

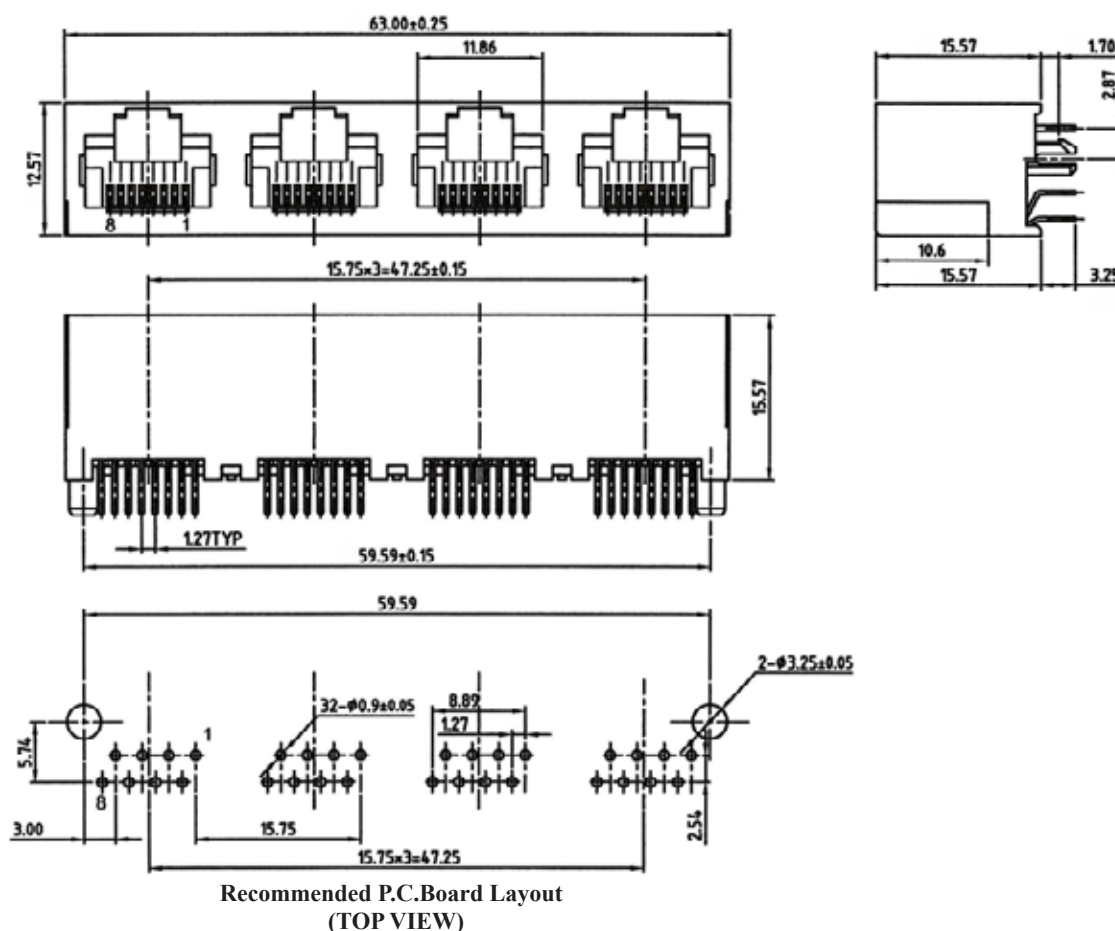
Soldering Temperature: 235°C

Color: Black

Spring Wire: Phosphor Bronze

Gold plating Over Nickel

*RoHS & REACH compliant.



ORDERING INFORMATION:

P/N M J A 8 - $\frac{x}{1} \frac{x}{2} B \frac{x}{3} \frac{x}{4} 04$

1. NO. OF POSITIONS & CONTACTS:

"88" 8P8C

"84" 8P4C

2. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

3. LED OPTION:

"XX" W/O LED

4. NO. OF PORTS:

04

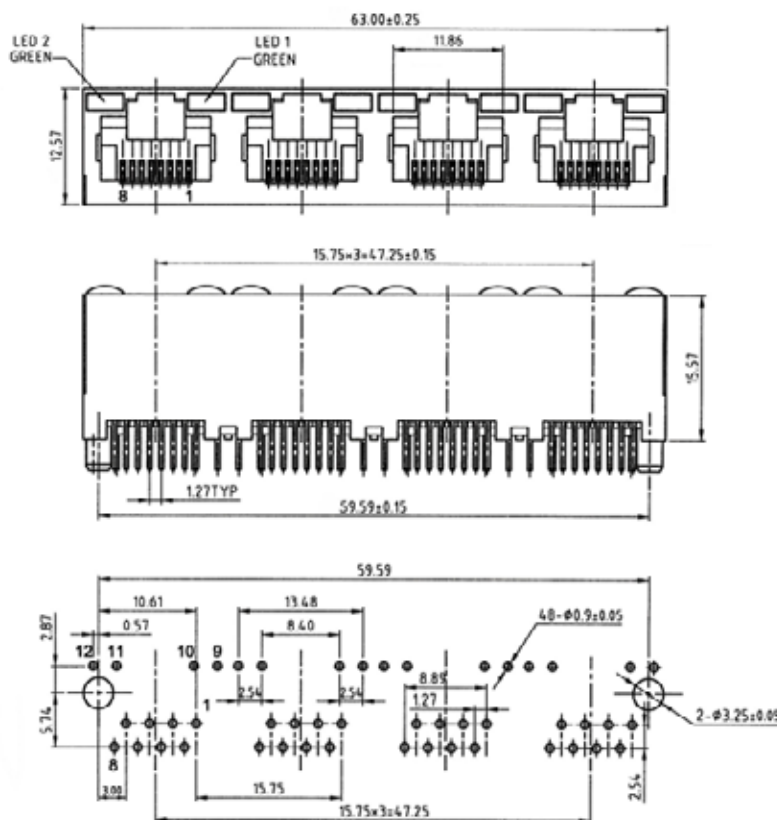
TOP ENTRY 4-PORT MODULAR PCB JACK WITH LED 8P PROFILE=15.57MM (UNSHIELDED)

SPECIFICATIONS

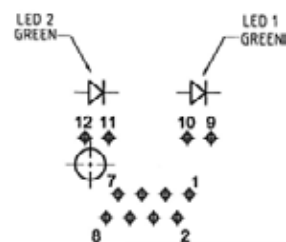
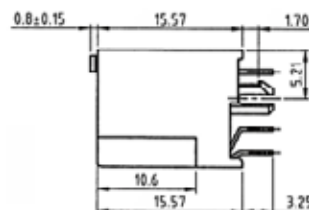
Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Black
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
***RoHS & REACH compliant.**



Recommended P.C. Board Layout
(TOP VIEW)



LED SCHEMATIC

ORDERING INFORMATION:

P/N M J A 8 - $\frac{x}{1} \frac{x}{2} \frac{x}{3} \frac{x}{4} \frac{0}{5}$ B $\frac{x}{3} \frac{x}{4} \frac{0}{5}$

1. NO. OF POSITIONS & CONTACTS:
"88" 8P8C
2. CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD
3. CODE OF LED1 DESIGNATION:
N, M, Y, Z, 8, Q, 1, 2, 5, 6
4. CODE OF LED2 DESIGNATION:
N, M, Y, Z, 8, Q, 1, 2, 5, 6
5. NO. OF PORTS:
04

LED Designation:

Code	+/-	-/+	Code	+/-	-/+
N	Green	—	M	—	Green
Y	Yellow	—	Z	—	Yellow
8	Orange	—	Q	—	Orange
1	Green	Orange	2	Orange	Green
5	Green	Yellow	6	Yellow	Green

NOTE: LED1= RIGHT LED &
LED2= LEFT LED

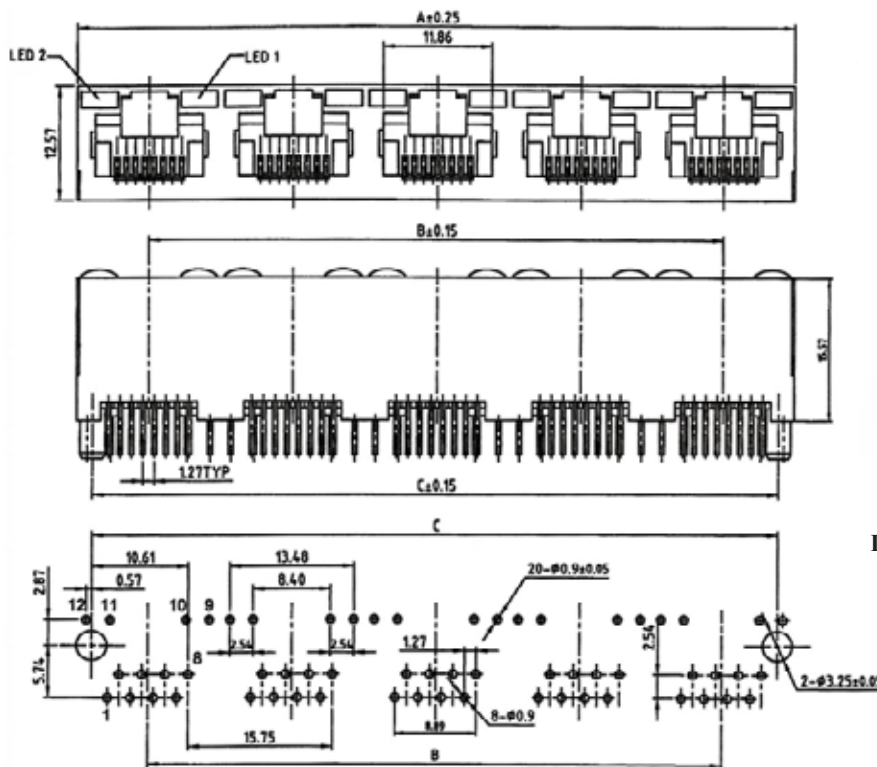
TOP ENTRY MULTI-PORT MODULAR PCB JACK WITH LED 8P PROFILE=15.57MM (UNSHIELDED)

SPECIFICATIONS

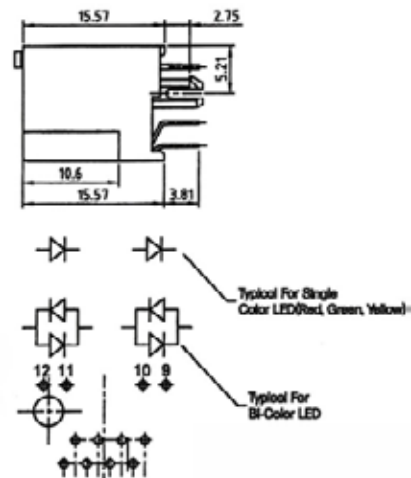
Insulation Resistance: 500MΩ Min.
 Contact Resistance: 20mΩ Max.
 Rating Current: 1.5A Max.
 Rating Voltage: 120V AC.
 Dielectric Voltage: 1000 Vrms 60 Sec. Min.
 Temperature Range: -40°C / +85°C
 Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
 Soldering Temperature: 235°C
 Color: Black
 Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
 *RoHS & REACH compliant.



Recommended P.C.Board Layout



LED SCHEMATIC

No. of Ports	Dimensions		
	A	B	C
04	63.00	47.25	59.59
05	78.75	63.00	75.34
06	94.50	78.75	91.10
08	126.00	110.25	122.60

ORDERING INFORMATION:

P/N M J A 8 - $\frac{88}{1} \frac{x}{2} \frac{B}{3} \frac{x}{4} \frac{x}{5}$

1. NO. OF POSITIONS & CONTACTS:
"88" 8P8C
2. CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD
3. CODE OF LED1 DESIGNATION:
N, M, Y, Z, 8, Q, 1, 2, 5, 6
4. CODE OF LED2 DESIGNATION:
N, M, Y, Z, 8, Q, 1, 2, 5, 6
5. NO. OF PORTS:
04, 05, 06, 08

LED Designation:

Code	+/-	-/+	Code	+/-	-/+
N	Green	—	M	—	Green
Y	Yellow	—	Z	—	Yellow
8	Orange	—	Q	—	Orange
1	Green	Orange	2	Orange	Green
5	Green	Yellow	6	Yellow	Green

NOTE: LED1= RIGHT LED &
 LED2= LEFT LED

TOP ENTRY MODULAR PCB JACK 4P PROFILE=15.70MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)

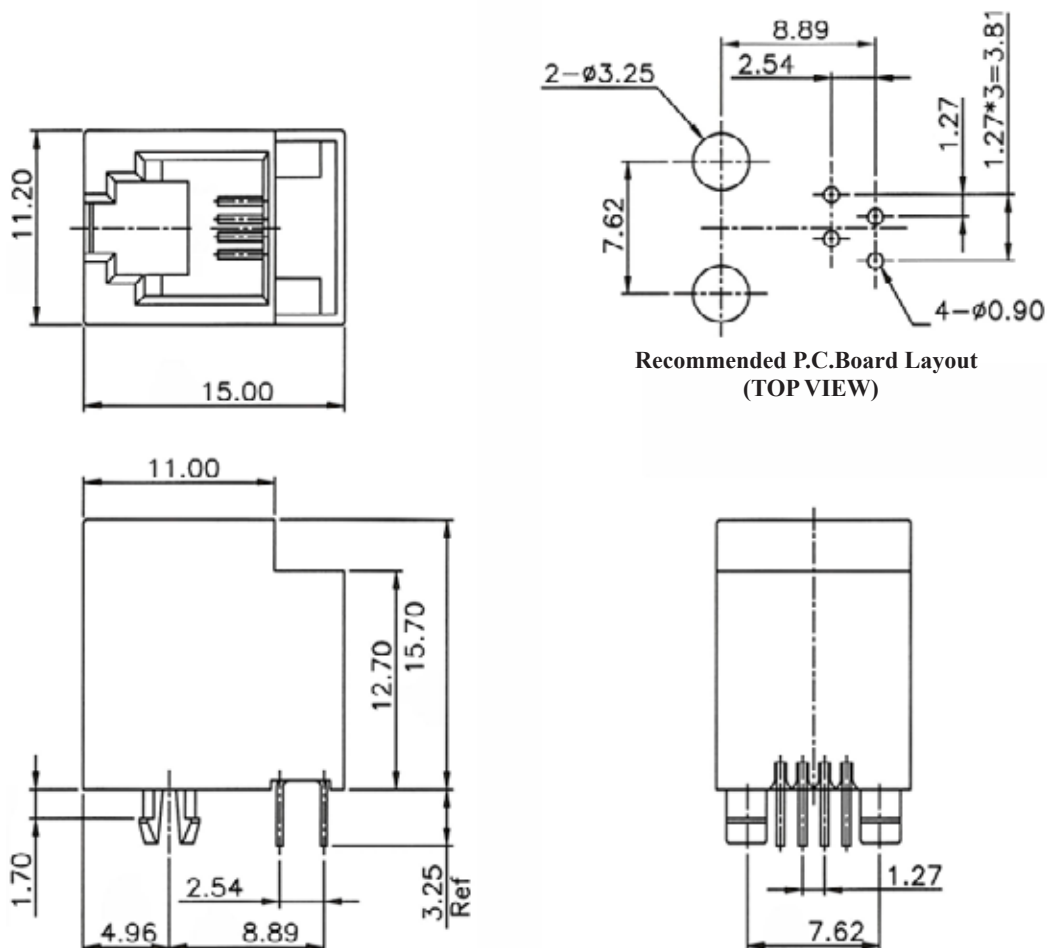
Soldering Temperature: 235°C

Color: Black

Spring Wire: Phosphor Bronze

Gold plating Over Nickel

*RoHS & REACH compliant.



ORDERING INFORMATION:

P/N M J 8 A - $\frac{44}{1} \times \frac{B}{2}$

1. NO. OF POSITIONS & CONTACTS:

"44" 4P4C

2. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

"E" GOLD FLASH

TOP ENTRY MODULAR PCB JACK 6P PROFILE=15.70MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)

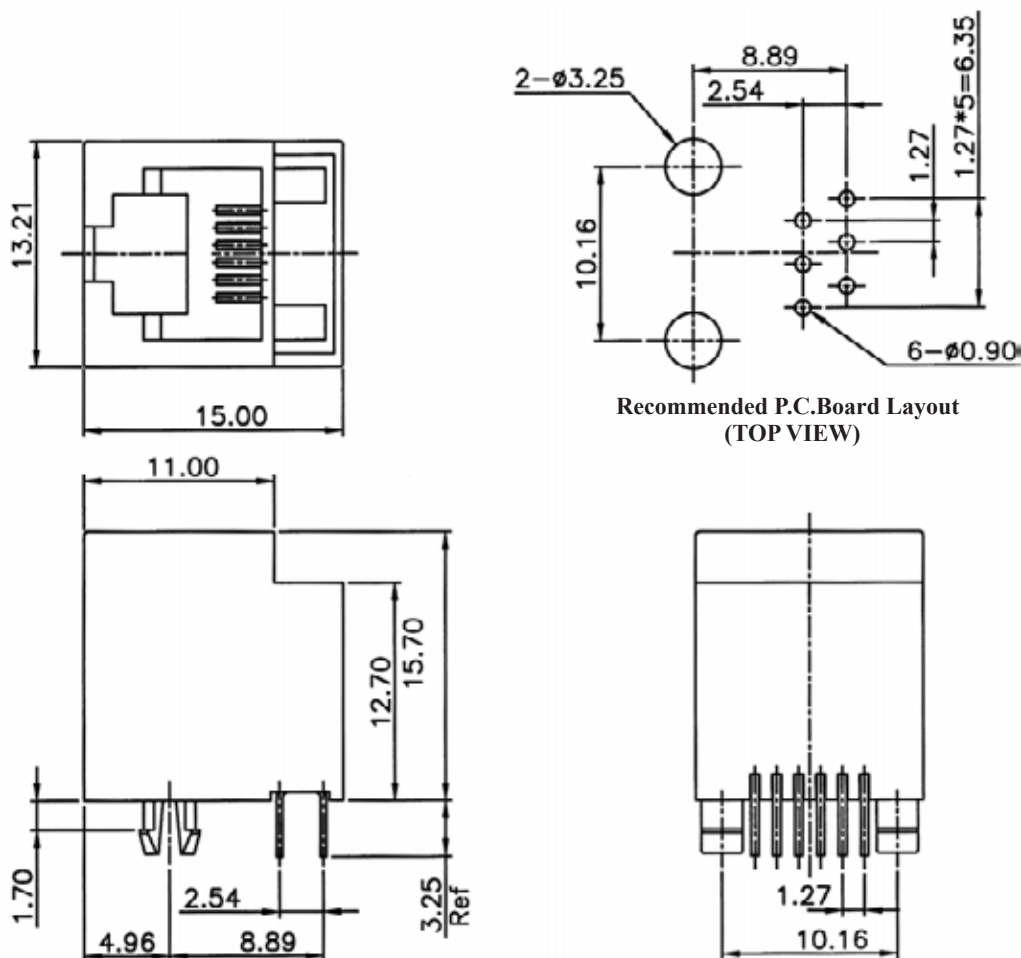
Soldering Temperature: 235°C

Color: Black

Spring Wire: Phosphor Bronze

Gold plating Over Nickel

*RoHS & REACH compliant.



ORDERING INFORMATION:

P/N M J 8 A - $\frac{x}{1} \frac{x}{2} B$

1. NO. OF POSITIONS & CONTACTS:

"66" 6P6C

"64" 6P4C

2. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

TOP ENTRY MODULAR PCB JACK 8P PROFILE=15.70MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)

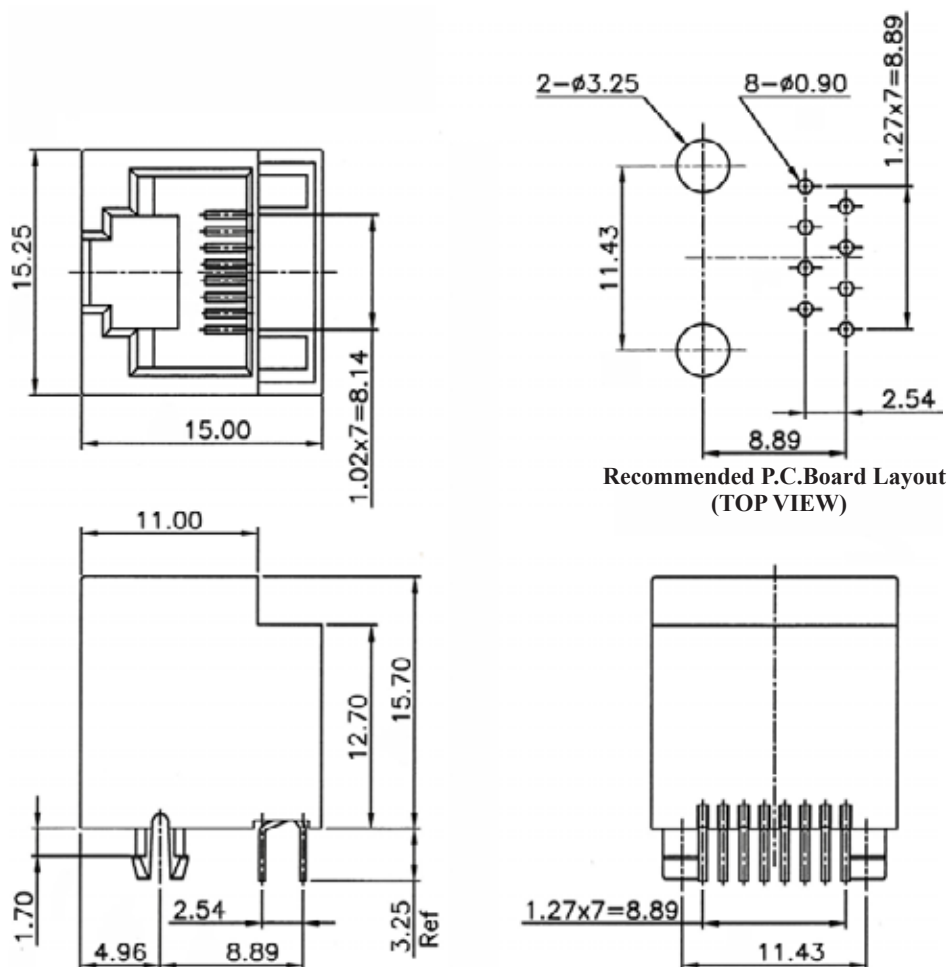
Soldering Temperature: 235°C

Color: Black

Spring Wire: Phosphor Bronze

Gold plating Over Nickel

*RoHS & REACH compliant.



ORDERING INFORMATION:

P/N M J 8 A - $\frac{x}{1} \frac{x}{2}$ B

1. NO. OF POSITIONS & CONTACTS:

"88" 8P8C

"84" 8P4C

2. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

TOP ENTRY MODULAR PCB JACK 4P+6P+8P+10P PROFILE=15.70MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)

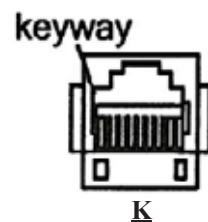
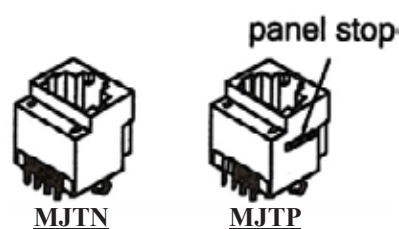
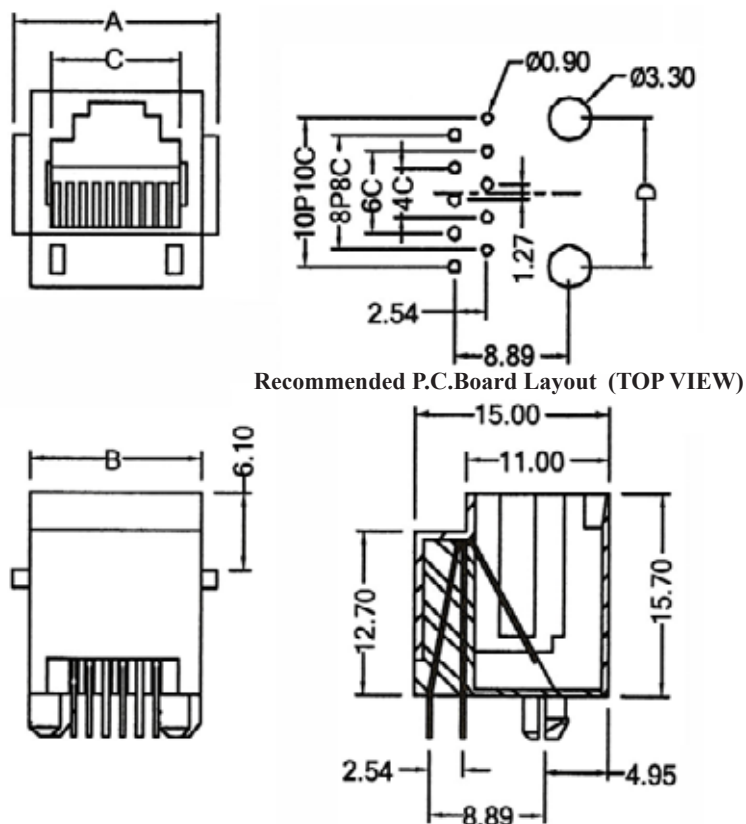
Soldering Temperature: 235°C

Color: Black

Spring Wire: Phosphor Bronze

Gold plating Over Nickel

*RoHS & REACH compliant.



Position	Conductor	A	B	C	D
4P	4C	13.80	11.20	7.90	7.62
6P	2C/4C/6C	15.80	13.20	10.00	10.16
8P	8C	18.00	15.20	11.80	11.43
10P	10C	18.00	15.20	11.80	11.43

ORDERING INFORMATION:

P/N M J $\frac{xx}{1} - \frac{xxx}{23} B \frac{x}{4}$

1. PANEL STOP OPTION:

"TP" WITH PANEL STOP
"TN" W/O PANEL STOP

2. NO. OF POSITIONS & CONTACTS:

"66" 6P6C
"64" 6P4C
"88" 8P8C
"00" 10P10C
"44" 4P4C

3. CONTACT FINISH:

"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD

4. KEYWAY OPTION:

" " W/O KEYWAY
"K" WITH KEYWAY (FOR 8P & 10P ONLY)

TOP ENTRY MODULAR PCB JACK 6P PROFILE=16.00MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)

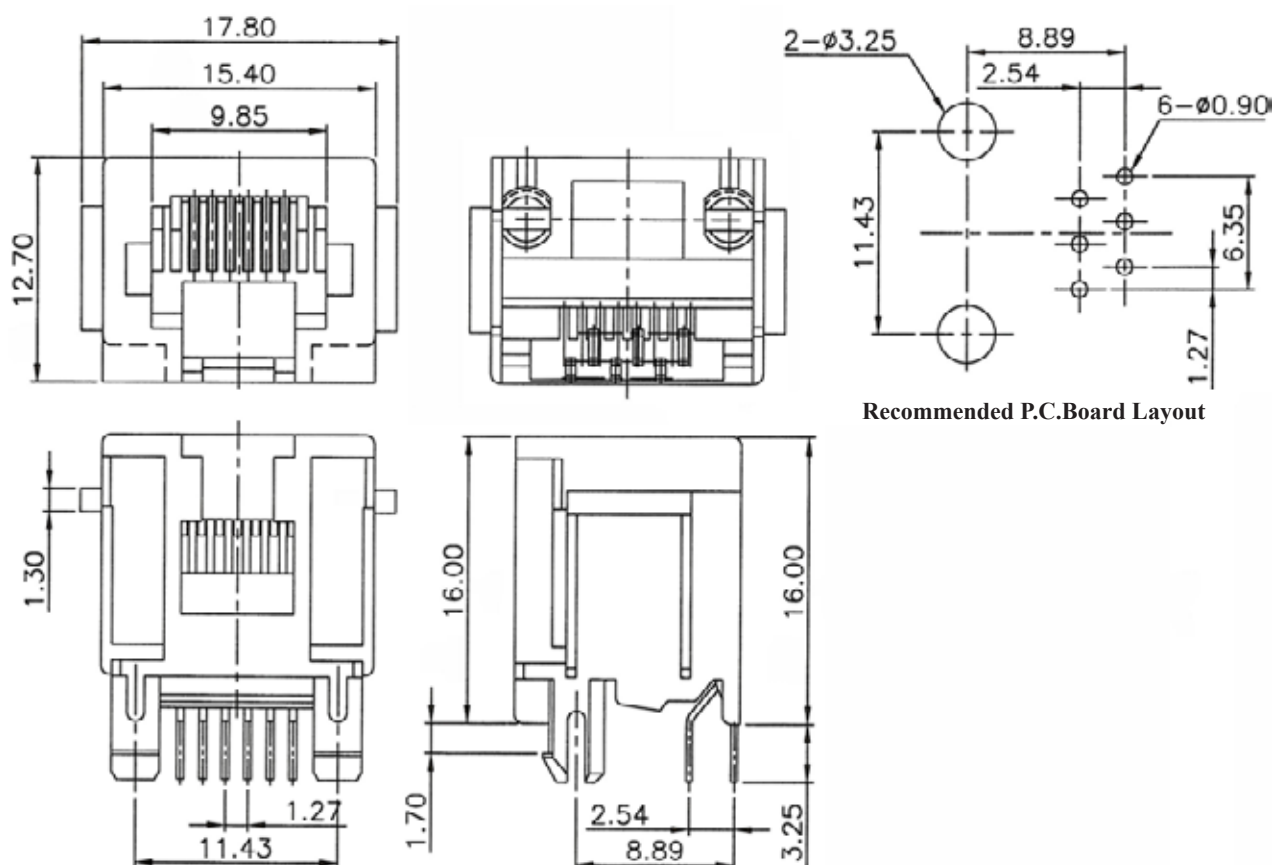
Soldering Temperature: 235°C

Color: Black

Spring Wire: Phosphor Bronze

Gold plating Over Nickel

***RoHS & REACH compliant.**



Recommended P.C.Board Layout

ORDERING INFORMATION:

P/N M J 3 6 - $\frac{x}{T} \frac{x}{2} B$

1. NO. OF POSITIONS & CONTACTS:

"66" 6P6C

"64" 6P4C

2. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

NOTE: WITH PANEL STOP

TOP ENTRY MODULAR PCB JACK 8P PROFILE=16.00MM (UNSHIELDED)

SPECIFICATIONS

Electrical:

Voltage Rating: 125 Vac Rms.

Current Rating: 1.5 Amp.

Contact Resistance: 40 Milliohms Max.

Insulation Resistance: 1000 Megohms Min @500 Vdc.

Dielectric Strength: 1000 Vac Rms 60Hz, 1Min.

Mechanical:

Operating: 750 Cycles Min.

Environmental:

Storage: -40°C To +85°C.

Operation: -40°C To +80°C.

MATERIALS

Plastic Housing: Engineering Thermoplastic

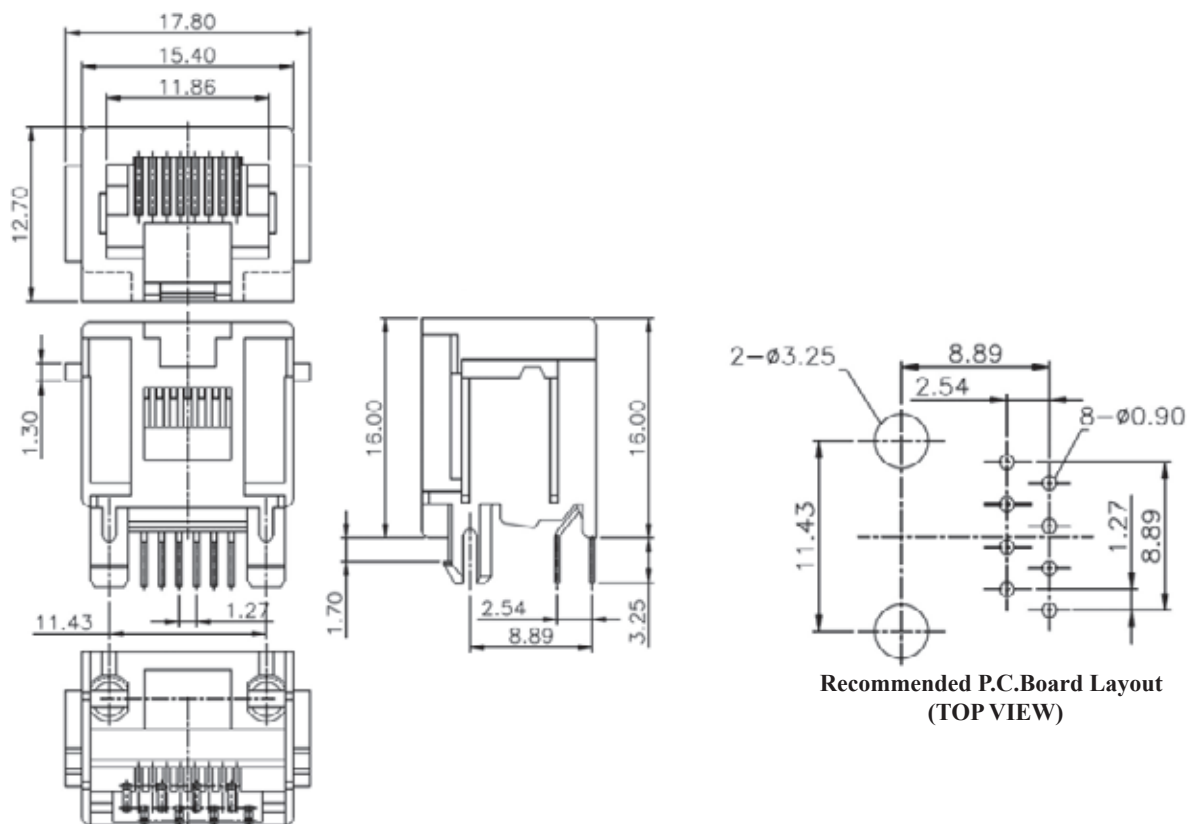
Flammability Rating UL 94V-0.

Contacts: Phosphor Bronze

Plating: Gold Plating Over Nickel In Contact,

Tin Plating Over Nickel In Solder Area.

* RoHS & REACH compliant.



ORDERING INFORMATION:

P/N MJ $\frac{36J}{1} - \frac{88}{2} \times B$

1. MODULAR JACK TYPE:
"36J" WITH PANEL STOP
2. NO. OF POSITIONS & CONTACTS:
"88" 8P8C
3. CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD

NOTE: IT CAN BE USED FOR REPLACING P/N MJ36-88xB.

TOP ENTRY MODULAR PCB JACK 6P PROFILE=16.00MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)

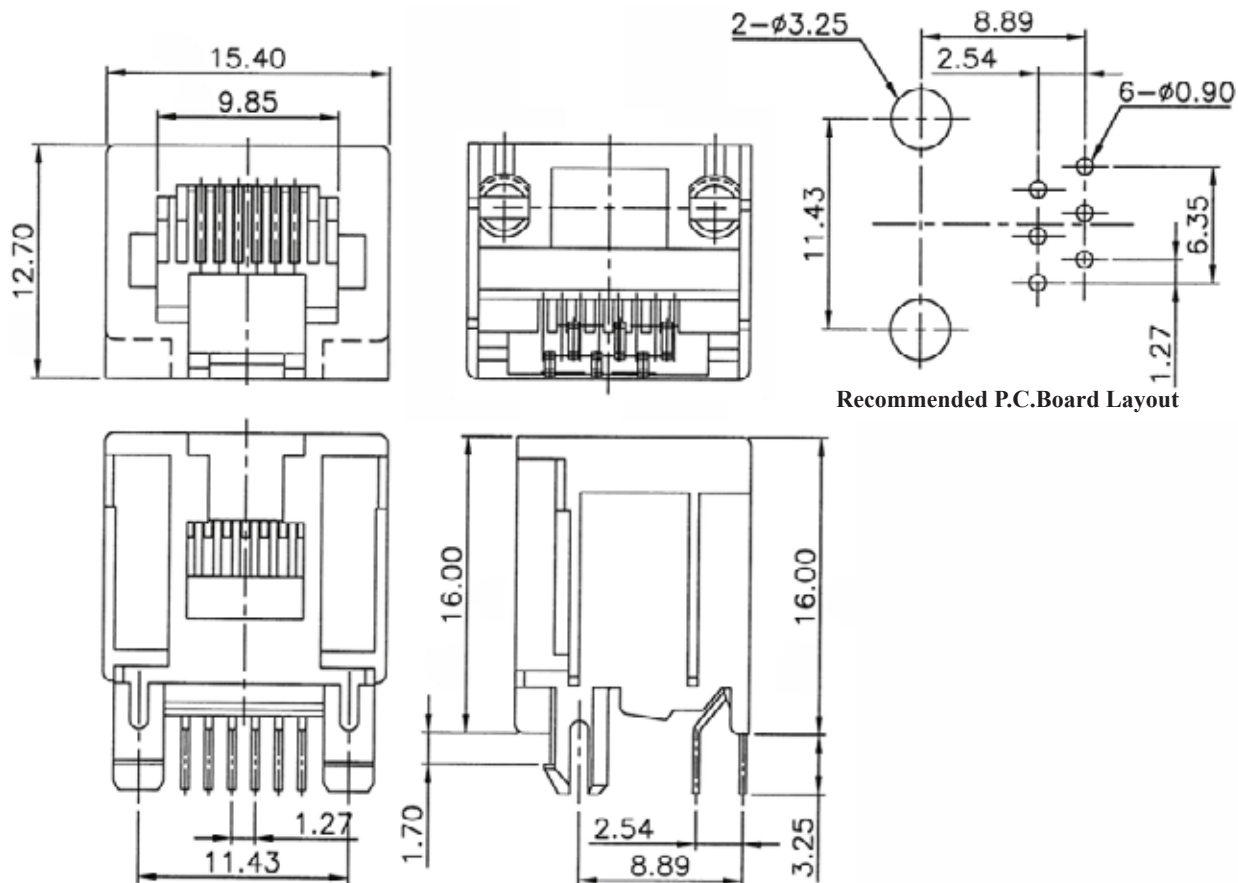
Soldering Temperature: 235°C

Color: Black

Spring Wire: Phosphor Bronze

Gold plating Over Nickel

*RoHS & REACH compliant.



ORDERING INFORMATION:

P/N M J 3 7 - $\frac{x x}{T 2}$ B

1. NO. OF POSITIONS & CONTACTS:

"66" 6P6C

"64" 6P4C

2. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

NOTE: WITHOUT PANEL STOP

TOP ENTRY MODULAR PCB JACK 8P PROFILE=16.00MM (UNSHIELDED)

SPECIFICATIONS

Electrical:

Voltage Rating: 125 Vac Rms.

Current Rating: 1.5 Amp.

Contact Resistance: 40 Milliohms Max.

Insulation Resistance: 1000 Megohms Min @500 Vdc.

Dielectric Strength: 1000 Vac Rms 60Hz, 1Min.

Mechanical:

Operating: 750 Cycles Min.

Environmental:

Storage: -40°C To +85°C.

Operation: -40°C To +80°C.

MATERIALS

Plastic Housing: Engineering Thermoplastic

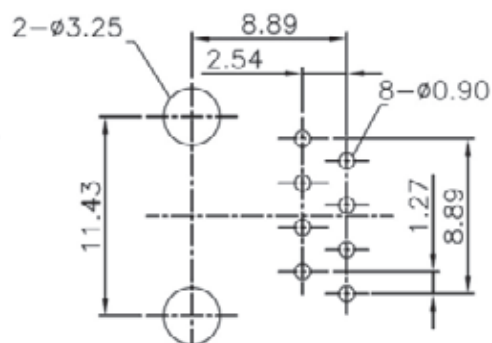
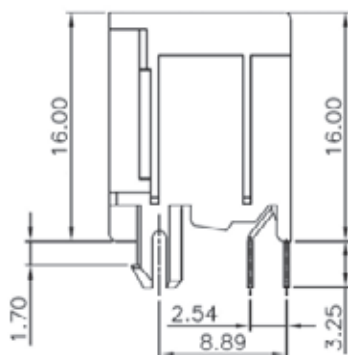
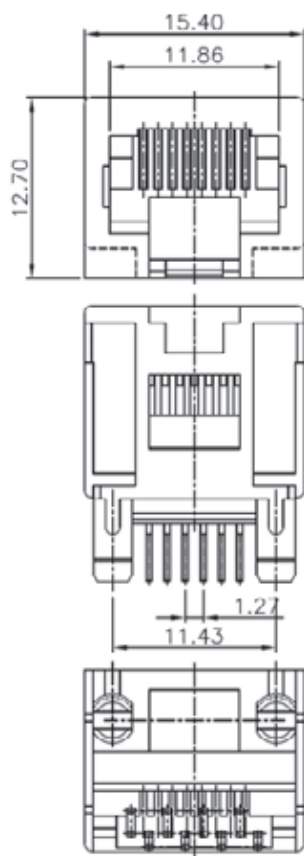
Flammability Rating UL 94V-0.

Contacts: Phosphor Bronze

Plating: Gold Plating Over Nickel In Contact,

Tin Plating Over Nickel In Solder Area.

* RoHS & REACH compliant.



Recommended P.C.Board Layout
(TOP VIEW)

ORDERING INFORMATION:

P/N MJ $\frac{37J}{1} - \frac{88}{2} \times \frac{B}{3}$

1. MODULAR JACK TYPE:
"37J" W/O PANEL STOP
2. NO. OF POSITIONS & CONTACTS:
"88" 8P8C
3. CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD

NOTE: IT CAN BE USED FOR REPLACING P/N MJ37-88xB.

TOP ENTRY CAT.5 MODULAR PCB JACK 8P PROFILE=16.00MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)

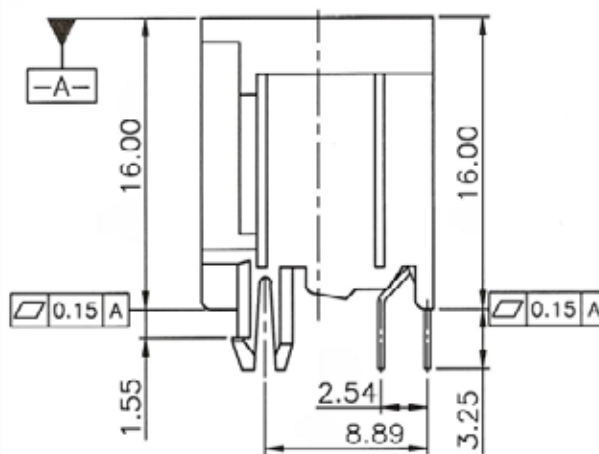
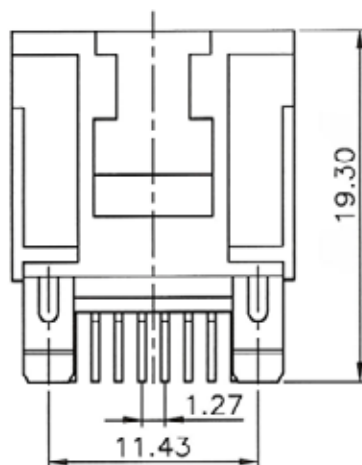
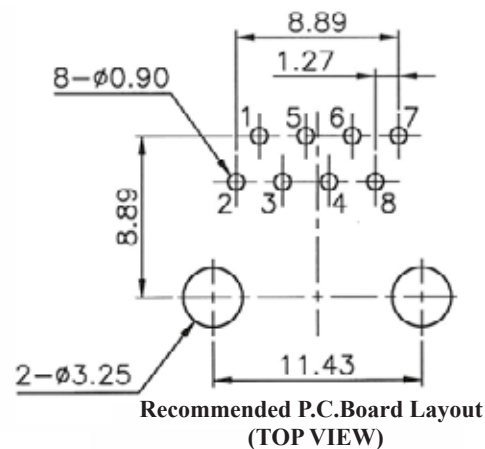
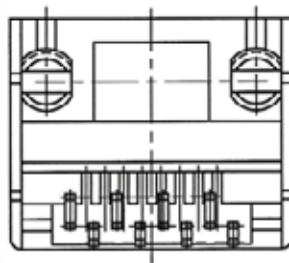
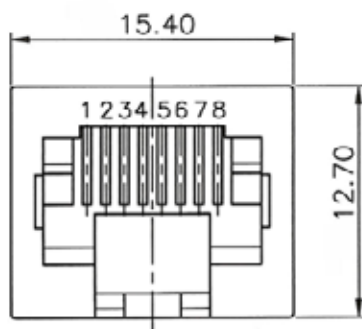
Soldering Temperature: 235°C

Color: Black

Spring Wire: Phosphor Bronze

Gold plating Over Nickel

***RoHS & REACH compliant.**



ORDERING INFORMATION:

P/N M J 5 D - $\frac{88}{1} \times \frac{B}{23}$

1. NO. OF POSITIONS & CONTACTS:
"88" 8P8C
2. CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD
3. HOUSING COLOR:
"B" BLACK

NOTE: CATEGORY 5 VERSION

TOP ENTRY MODULAR PCB JACK 8P4C PROFILE=16.00MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)

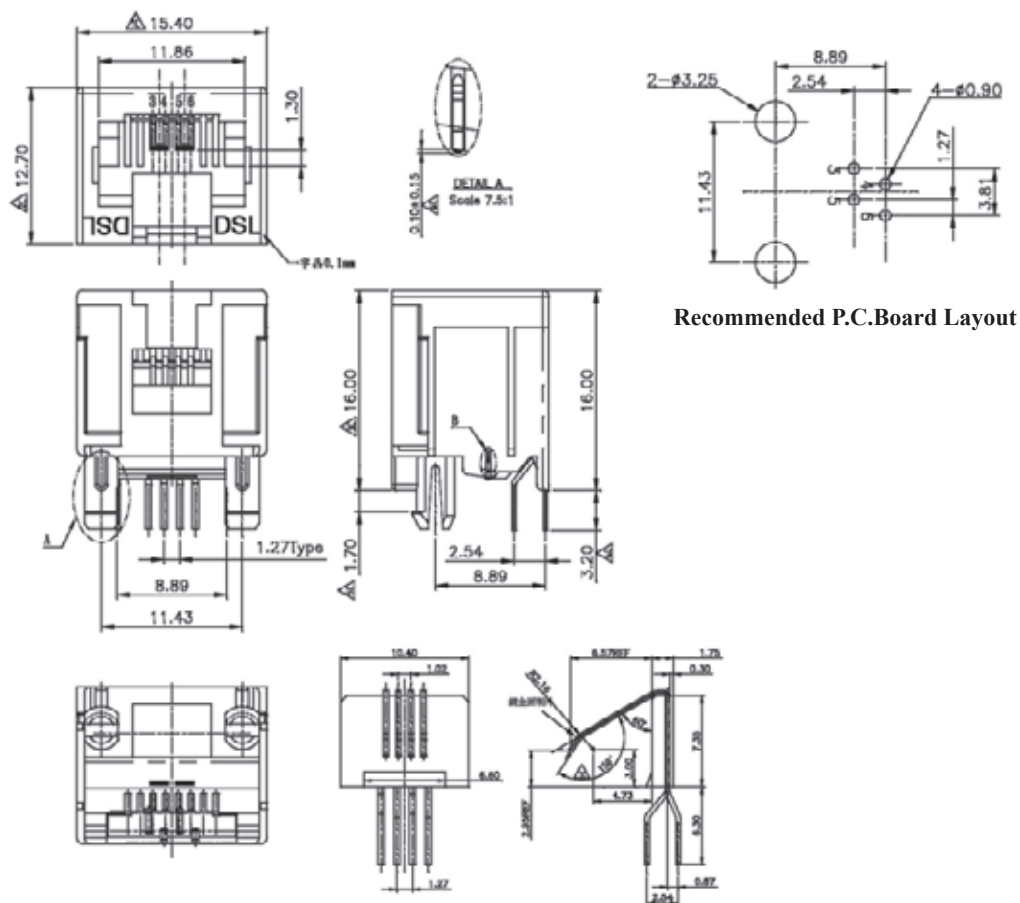
Soldering Temperature: 235°C

Color: Black

Spring Wire: Phosphor Bronze

Gold plating Over Nickel

*RoHS & REACH compliant.



Recommended P.C.Board Layout

ORDERING INFORMATION:

P/N M J 3 7 - 8 4 x U
1 2 3

1. NO. OF POSITIONS & CONTACTS:

"84" 8P4C

2. CONTACT FINISH:

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

3. HOUSING COLOR:

"U" PANTONE BLUE 285C

NOTE: PIN# 3, 4 & 5, 6 SHORTED

TOP ENTRY 2-PORT MODULAR PCB JACK 8P WITH METAL PEG PROFILE=16.00MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)

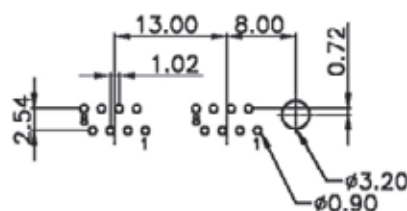
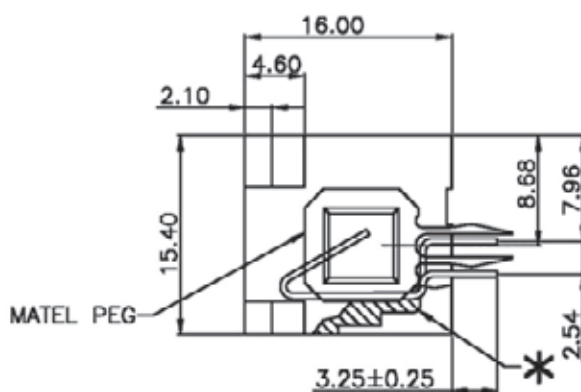
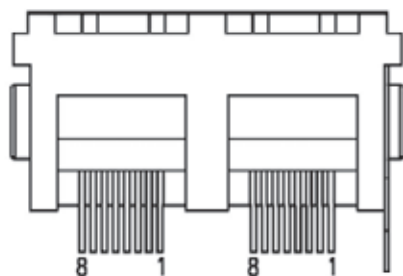
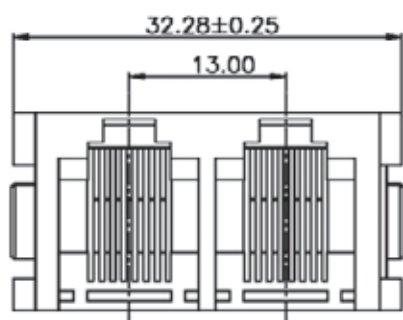
Soldering Temperature: 235°C

Color: Black

Spring Wire: Phosphor Bronze

Gold plating Over Nickel

*RoHS & REACH compliant.



Recommended P.C.Board Layout

ORDERING INFORMATION:

P/N M J FY - 88 x B 02
1 2 3 4 5

1. MODULAR JACK TYPE:
"FY" TOP ENTRY WITH ONE METAL PEG
2. NO. OF POSITIONS & CONTACTS:
"88" 8P8C
3. CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD
4. HOUSING COLOR:
"B" BLACK
5. NO. OF PORTS:
02

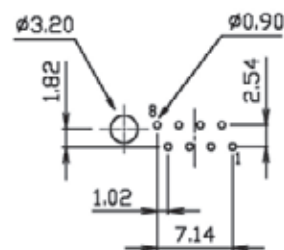
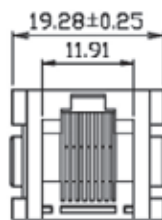
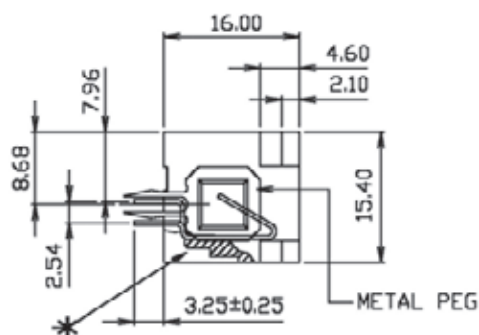
TOP ENTRY MODULAR PCB JACK 8P WITH METAL PEG PROFILE=16.00MM (UNSHIELDED)

SPECIFICATIONS

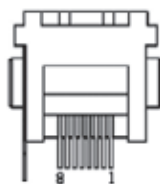
Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Black
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
***RoHS & REACH compliant.**



Recommended P.C.Board Layout



ORDERING INFORMATION:

P/N M J FY - 88 x B
1 2 3 4

1. MODULAR JACK TYPE:
"FY" TOP ENTRY WITH ONE METAL PEG
2. NO. OF POSITIONS & CONTACTS:
"88" 8P8C
3. CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD
4. HOUSING COLOR:
"B" BLACK

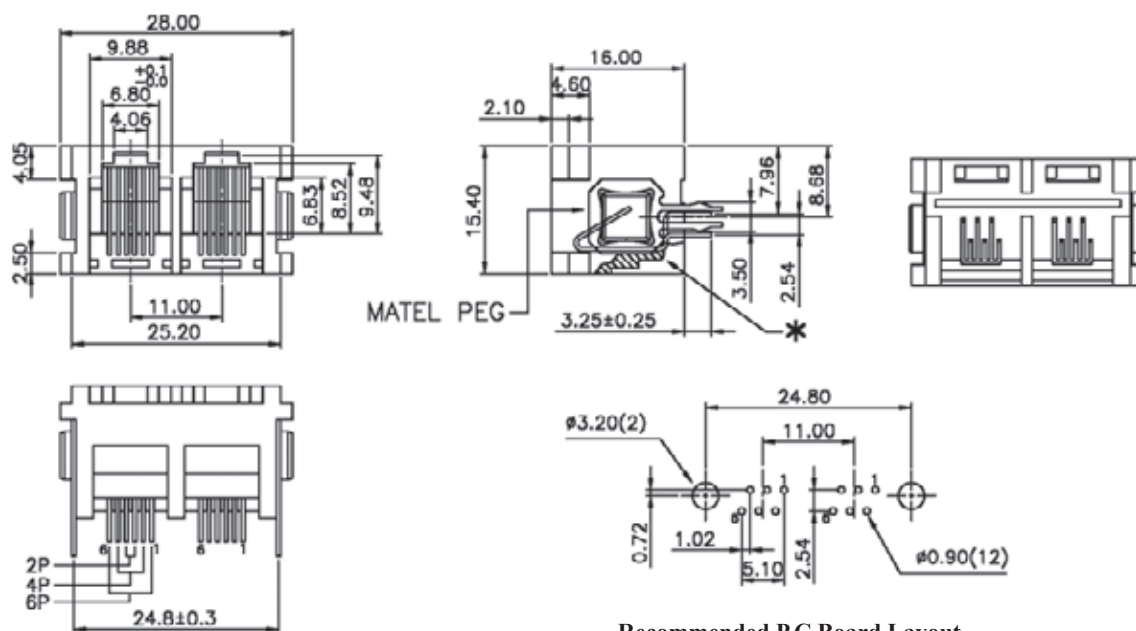
TOP ENTRY 2-PORT MODULAR PCB JACK 6P WITH METAL PEGS PROFILE=16.00MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Black
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
***RoHS & REACH compliant.**



Recommended P.C.Board Layout

ORDERING INFORMATION:

P/N M J FX - 66 x B 02
1 2 3 4 5

- MODULAR JACK TYPE:
"FX" TOP ENTRY WITH METAL PEGS
- NO. OF POSITIONS & CONTACTS:
"66" 6P6C
- CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD
- HOUSING COLOR:
"B" BLACK
- NO. OF PORTS:
02

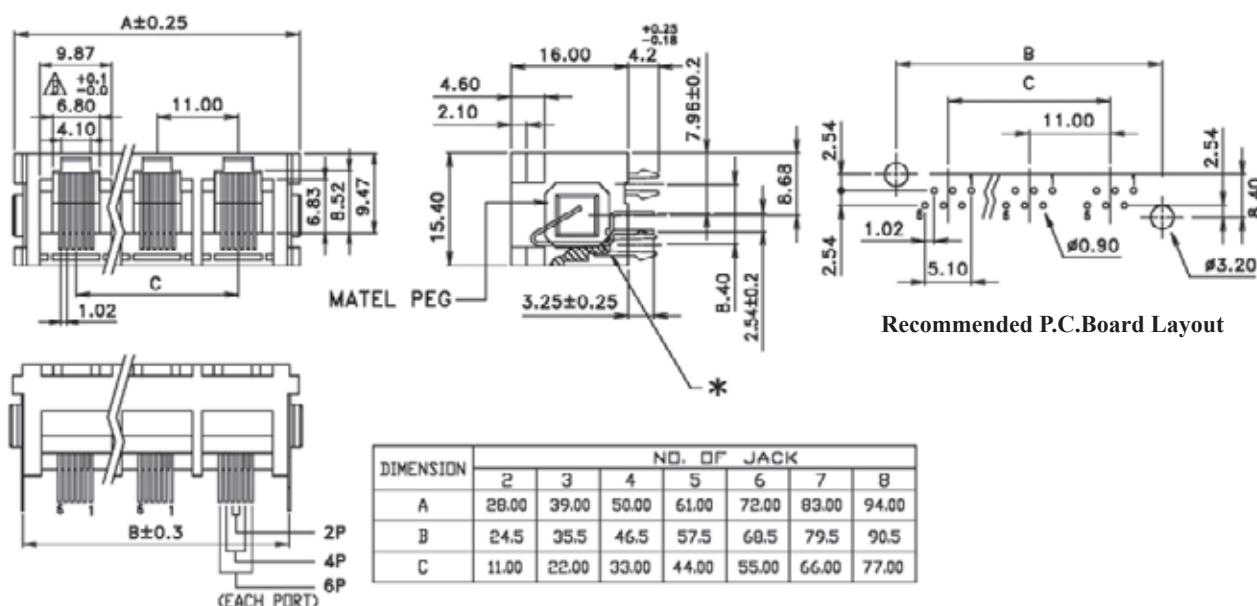
TOP ENTRY MULTI-PORT MODULAR PCB JACK 6P WITH METAL PEGS PROFILE=16.00MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Black
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
***RoHS & REACH compliant.**



ORDERING INFORMATION:

P/N M J $\frac{GU}{1}$ - $\frac{66}{2}$ x $\frac{B}{34}$ x $\frac{x}{5}$

- MODULAR JACK TYPE:
"GU" TOP ENTRY WITH METAL PEGS
- NO. OF POSITIONS & CONTACTS:
"66" 6P6C
- CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD
- HOUSING COLOR:
"B" BLACK
- NO. OF PORTS:
02, 03, 04, 05, 06, 07, 08

TOP ENTRY MODULAR PCB JACK 6P WITH METAL PEGS PROFILE=16.20MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)

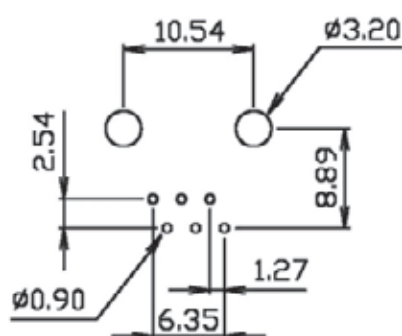
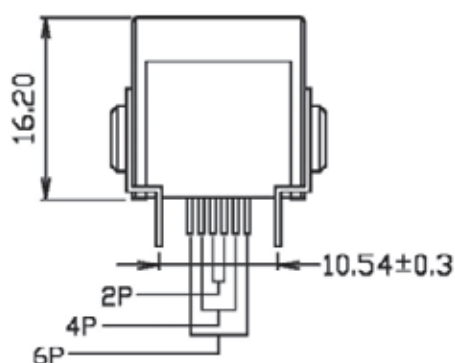
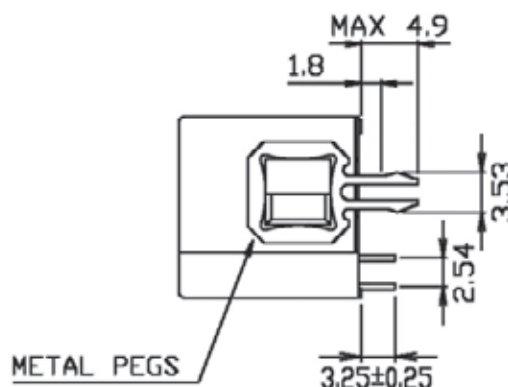
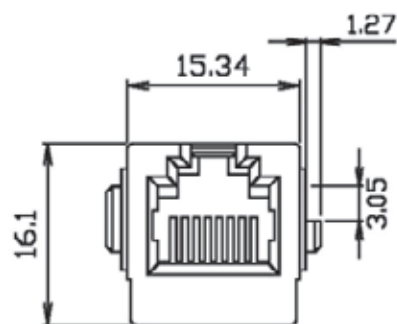
Soldering Temperature: 235°C

Color: Black

Spring Wire: Phosphor Bronze

Gold plating Over Nickel

*RoHS & REACH compliant.



Recommended P.C.Board Layout

ORDERING INFORMATION:

P/N M J F Z - 6 6 x B
1 2 3 4

1. MODULAR JACK TYPE:
"FZ" TOP ENTRY WITH METAL PEGS
2. NO. OF POSITIONS & CONTACTS:
"66" 6P6C
3. CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD
4. HOUSING COLOR:
"B" BLACK

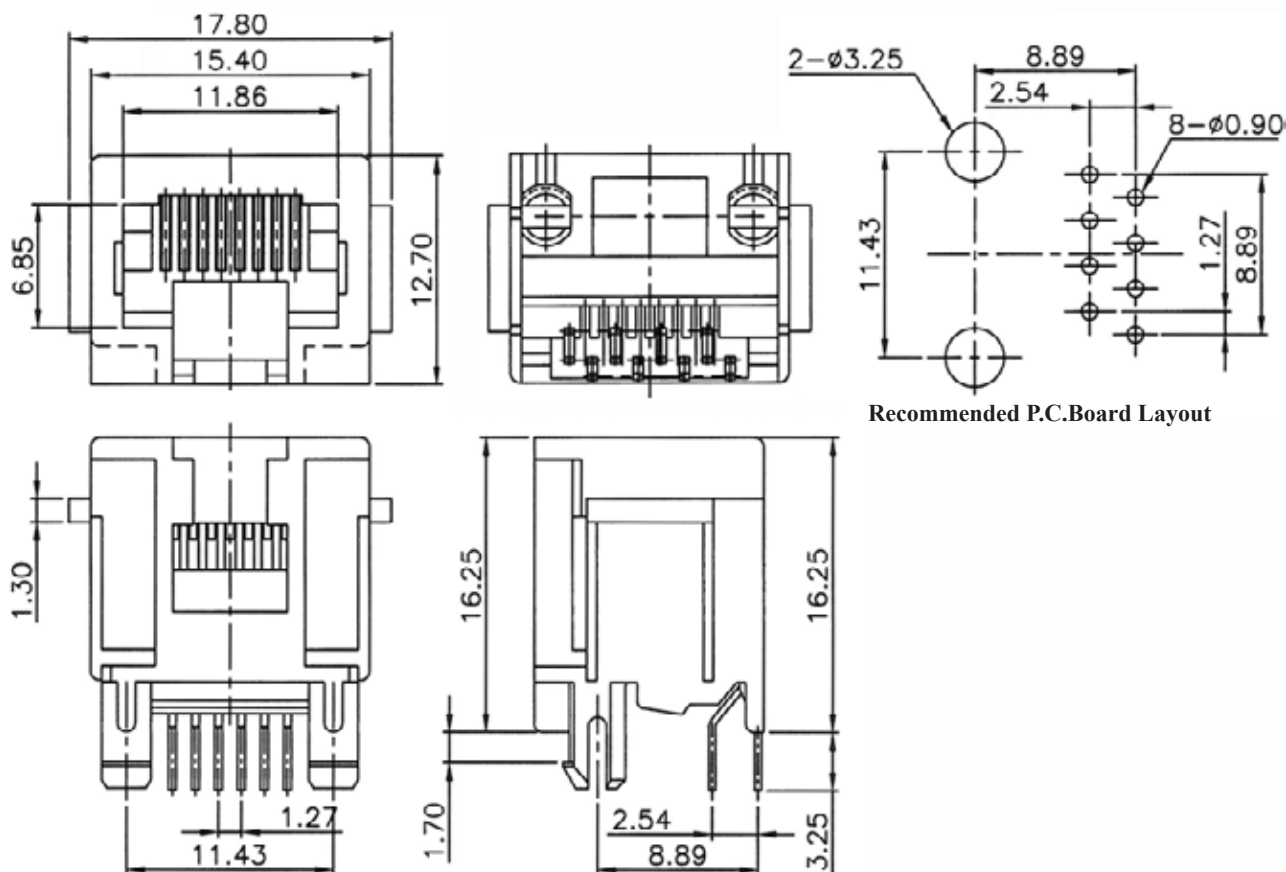
TOP ENTRY MODULAR PCB JACK 8P PROFILE=16.25MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Black
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
***RoHS & REACH compliant.**



ORDERING INFORMATION:

P/N M J 3 6 - $\frac{x}{1} \frac{x}{2} \frac{x}{3} B \frac{x}{3}$

1. NO. OF POSITIONS & CONTACTS:
"88" 8P8C
2. CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD
3. KEY OPTION:
" " NON-KEYED
"K" KEYED

NOTE: WITH PANEL STOP

TOP ENTRY MODULAR PCB JACK 8P PROFILE=16.25MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)

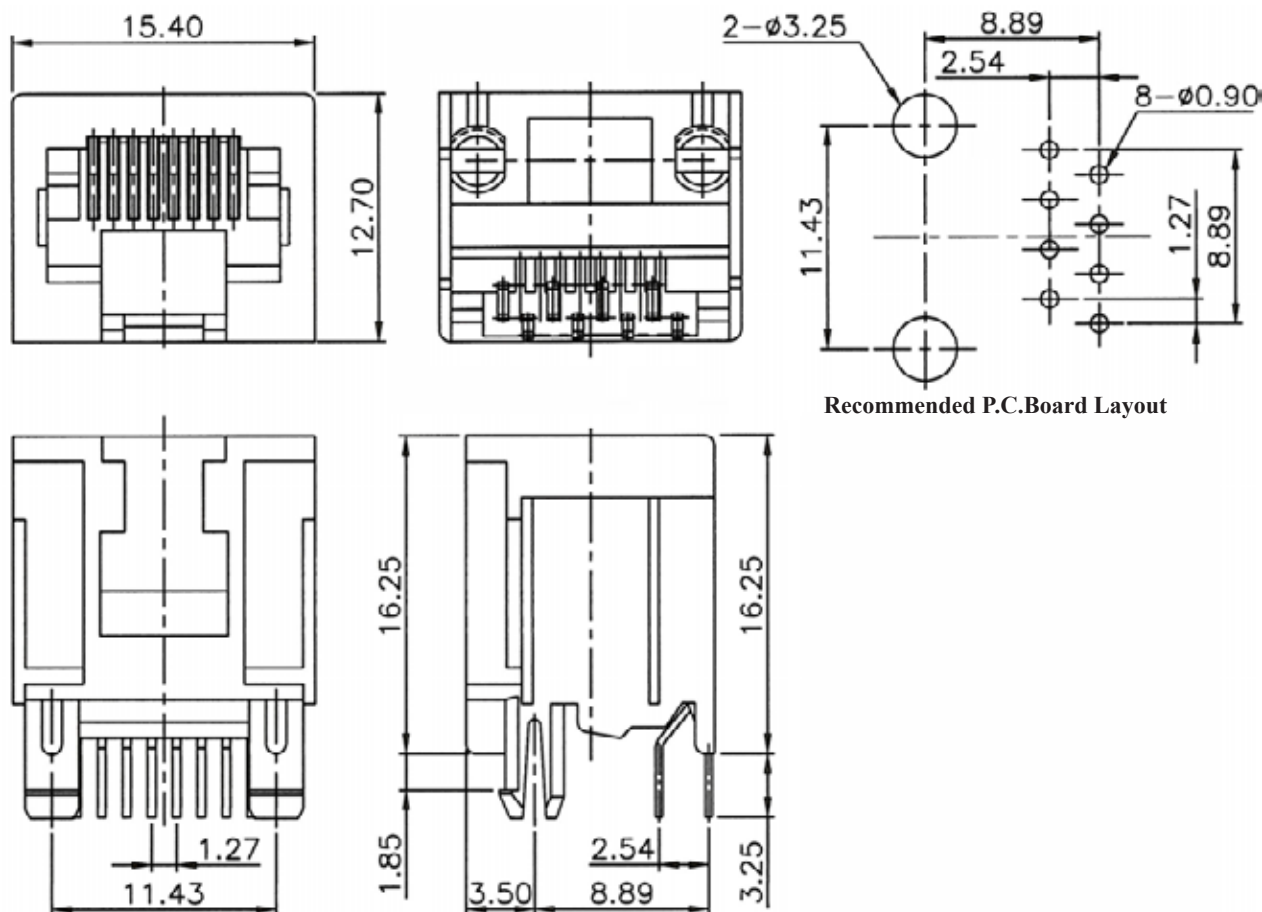
Soldering Temperature: 235°C

Color: Black

Spring Wire: Phosphor Bronze

Gold plating Over Nickel

*RoHS & REACH compliant.



ORDERING INFORMATION:

P/N M J 3 7 - $\frac{x}{1} \frac{x}{2} \frac{x}{3} B \frac{x}{3}$

1. NO. OF POSITIONS & CONTACTS:

"8" 8P8C

2. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

3. KEY OPTION:

" " NON-KEYED

"K" KEYED

NOTE: WITHOUT PANEL STOP

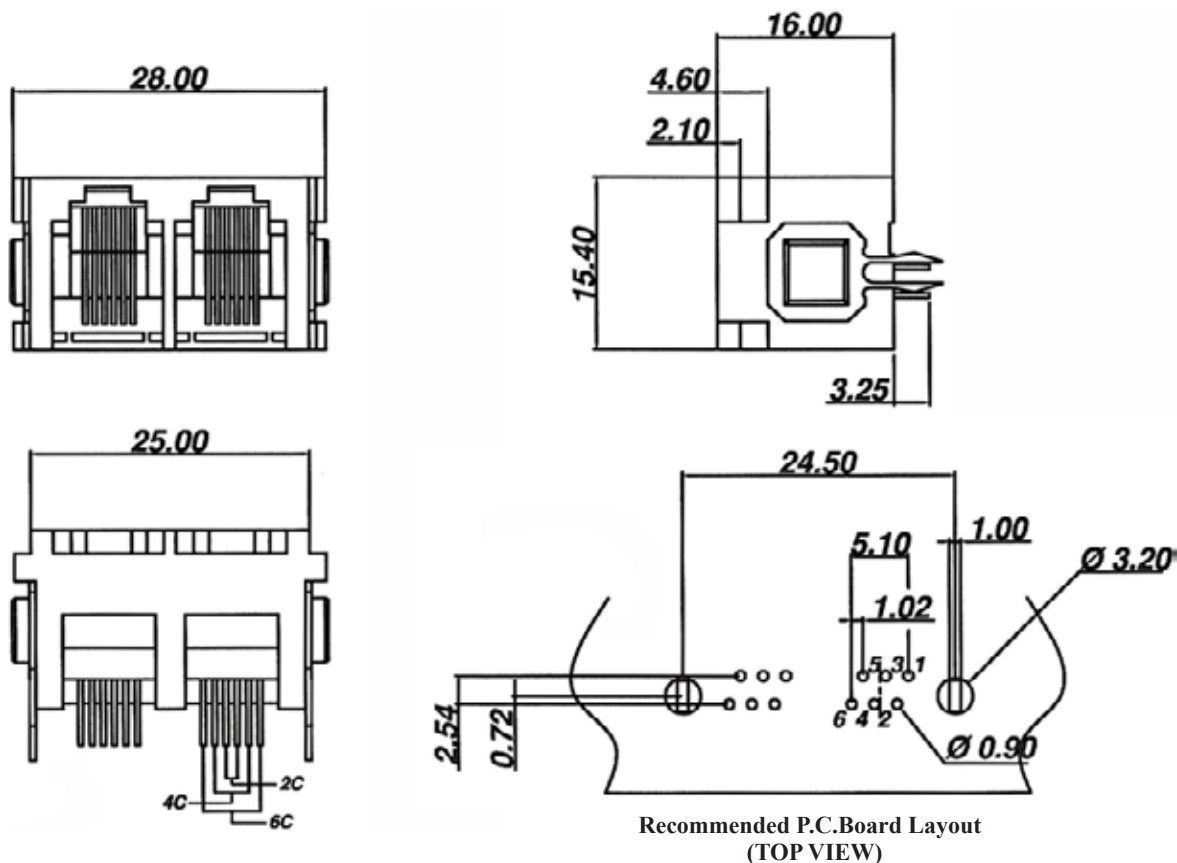
TOP ENTRY 2-PORT MODULAR PCB JACK WITH METAL PEGS 6P PROFILE=16.00MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Gray
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
***RoHS & REACH compliant.**



ORDERING INFORMATION:

P/N MJ62 - $\frac{xx}{1} \frac{xx}{2} \frac{xx}{3} \frac{02}{4}$

1. NO. OF POSITIONS & CONTACTS:

"66" 6P6C

"64" 6P4C

2. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

3. COLOR OF HOUSING:

"A" GRAY

"B" BLACK

4. NO. OF PORTS:

02

NOTE: P/N MJ62HT-xxxx02 FOR HIGH TEMP. VERSION

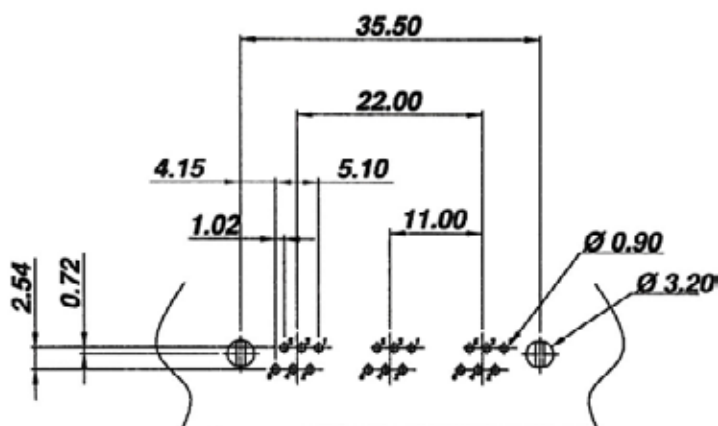
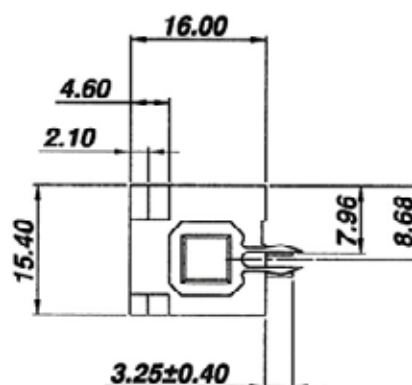
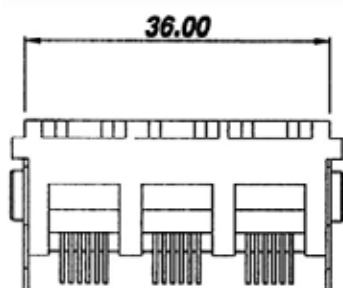
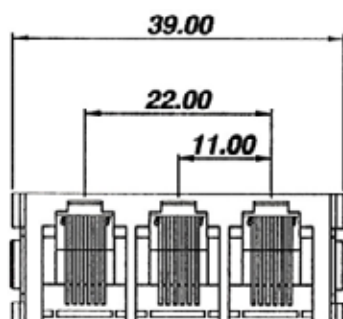
TOP ENTRY 3-PORT MODULAR PCB JACK WITH METAL PEGS 6P PROFILE=16.00MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Black
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
***RoHS & REACH compliant.**



Recommended P.C.Board Layout
(TOP VIEW)

ORDERING INFORMATION:

P/N MJ62 - $\frac{\text{X X X X}}{\text{1 2 3 4}} \frac{03}{4}$

1. NO. OF POSITIONS & CONTACTS:

"66" 6P6C

"64" 6P4C

2. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

3. HOUSING COLOR:

"A" GRAY

"B" BLACK

4. NO. OF PORTS:

03

NOTE: P/N MJ62HT-xxxx03 FOR HIGH TEMP. VERSION

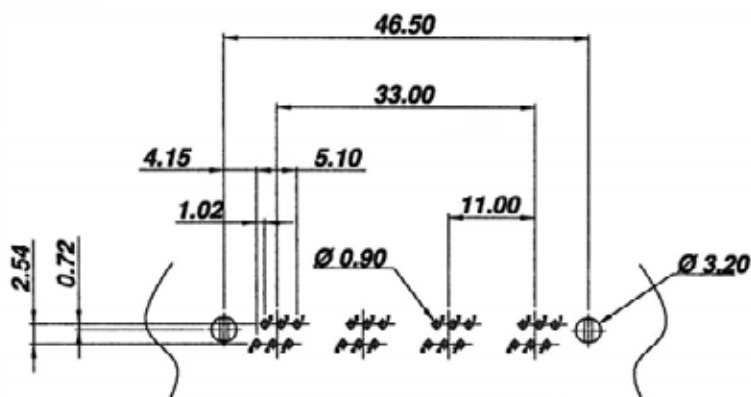
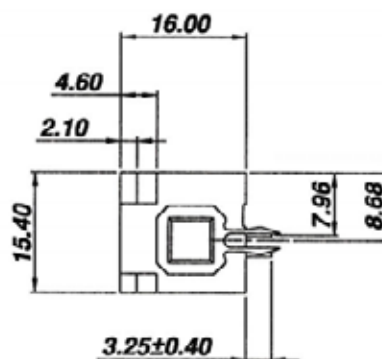
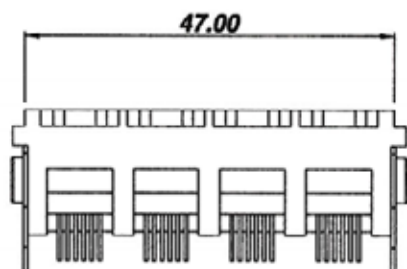
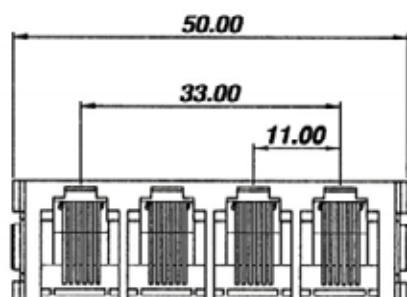
TOP ENTRY 4-PORT MODULAR PCB JACK WITH METAL PEGS 6P PROFILE=16.00MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Black
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
***RoHS & REACH compliant.**



Recommended P.C.Board Layout
(TOP VIEW)

ORDERING INFORMATION:

P/N MJ62 - $\frac{xx}{1} \frac{xx}{2} \frac{xx}{3} \frac{04}{4}$

1. NO. OF POSITIONS & CONTACTS:

"66" 6P6C

"64" 6P4C

2. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

3. HOUSING COLOR:

"A" GRAY

"B" BLACK

4. NO. OF PORTS:

04

NOTE: P/N MJ62HT-xxxx04 FOR HIGH TEMP. VERSION

TOP ENTRY 5-PORT MODULAR PCB JACK WITH METAL PEGS 6P PROFILE=16.00MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)

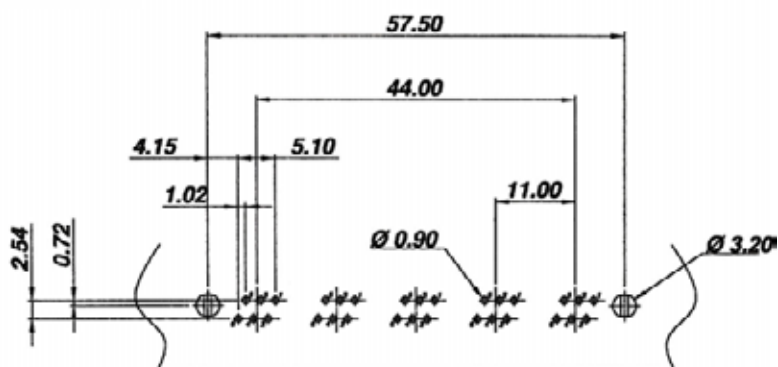
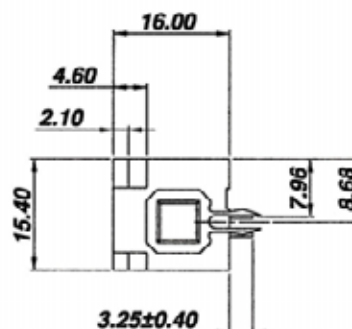
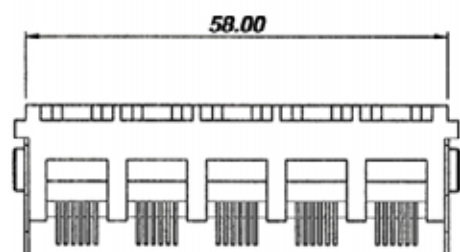
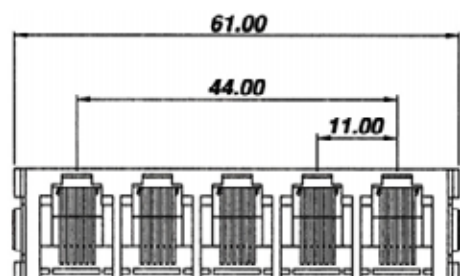
Soldering Temperature: 235°C

Color: Black

Spring Wire: Phosphor Bronze

Gold plating Over Nickel

*RoHS & REACH compliant.



Recommended P.C.Board Layout
(TOP VIEW)

ORDERING INFORMATION:

P/N MJ62 - $\frac{xx}{1} \frac{xx}{2} \frac{xx}{3} \frac{05}{4}$

1. NO. OF POSITIONS & CONTACTS:

"66" 6P6C

"64" 6P4C

2. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

3. HOUSING COLOR:

"A" GRAY

"B" BLACK

4. NO. OF PORTS:

05

NOTE: P/N MJ62HT-xxxx05 FOR HIGH TEMP. VERSION

TOP ENTRY 6-PORT MODULAR PCB JACK WITH METAL PEGS 6P PROFILE=16.00MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)

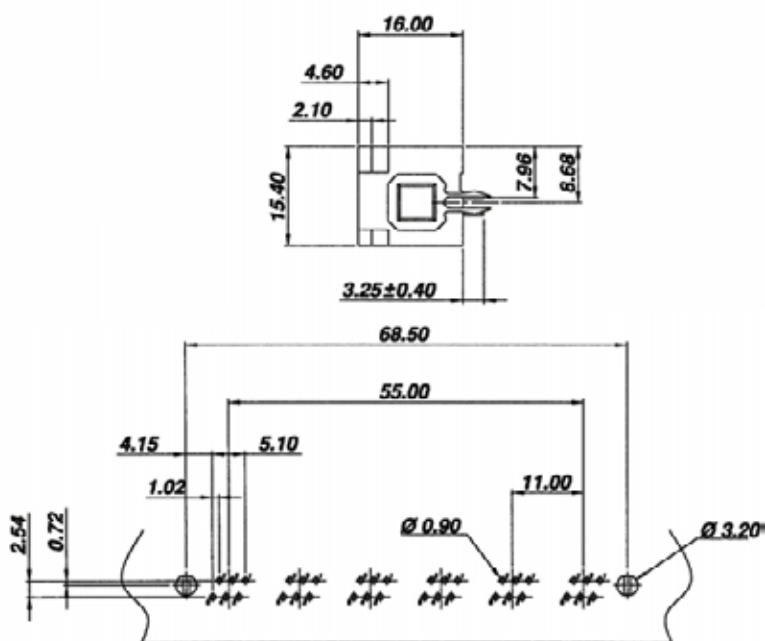
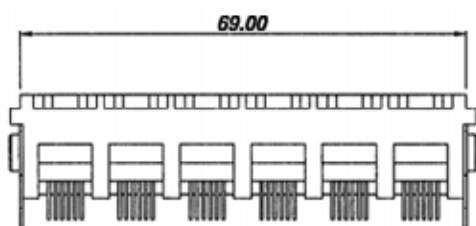
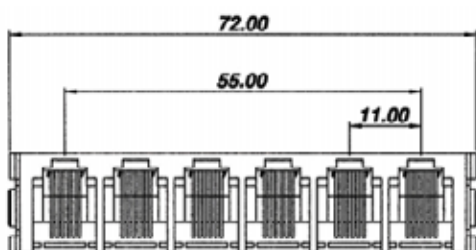
Soldering Temperature: 235°C

Color: Gray

Spring Wire: Phosphor Bronze

Gold plating Over Nickel

*RoHS & REACH compliant.



Recommended P.C.Board Layout
(TOP VIEW)

ORDERING INFORMATION:

P/N MJ62 - $\frac{xx}{1} \frac{xx}{2} \frac{xx}{3} \frac{06}{4}$

1. NO. OF POSITIONS & CONTACTS:

"66" 6P6C

"64" 6P4C

2. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

3. HOUSING COLOR:

"A" GRAY

"B" BLACK

4. NO. OF PORTS:

06

NOTE: P/N MJ62HT-xxxx06 FOR HIGH TEMP. VERSION

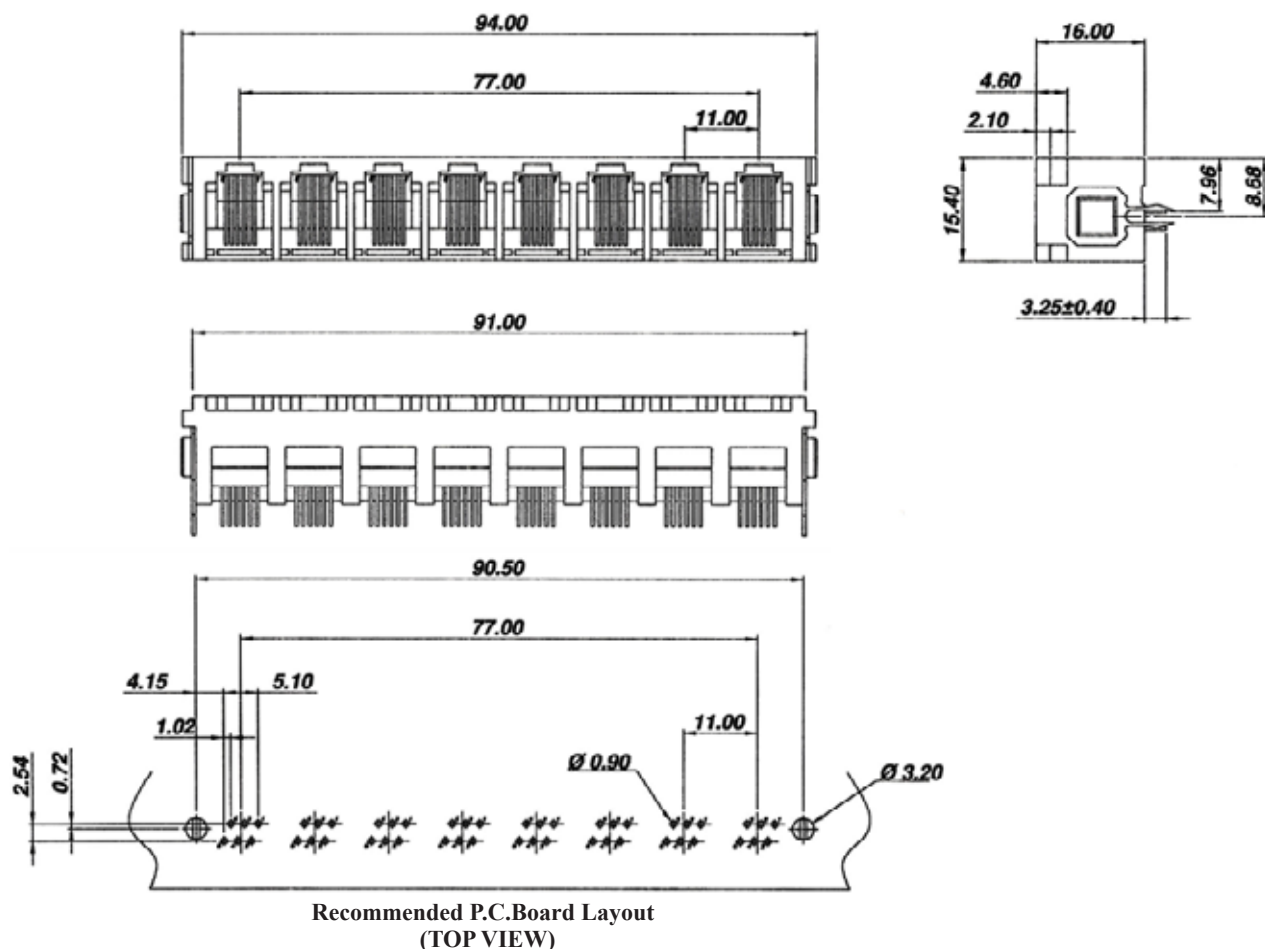
TOP ENTRY 8-PORT MODULAR PCB JACK WITH METAL PEGS 6P PROFILE=16.00MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Black
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
***RoHS & REACH compliant.**



ORDERING INFORMATION:

P/N MJ62 - $\frac{\text{xx xx 08}}{\text{1 2 3 4}}$

1. NO. OF POSITIONS & CONTACTS:

"66" 6P6C

"64" 6P4C

2. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

3. HOUSING COLOR:

"A" GRAY

"B" BLACK

4. NO. OF PORTS:

08

NOTE: P/N MJ62HT-xxxx08 FOR HIGH TEMP. VERSION

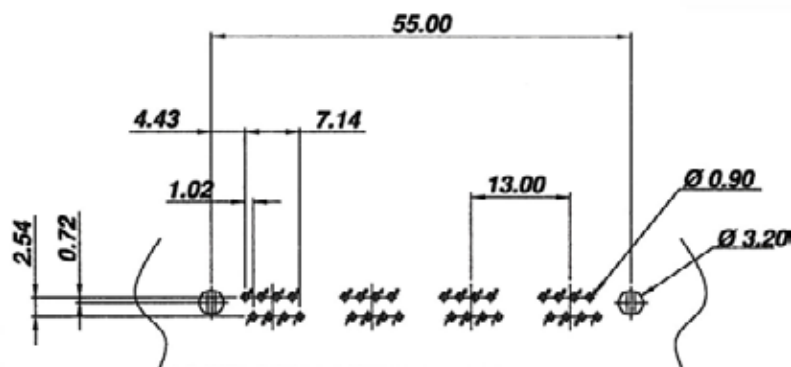
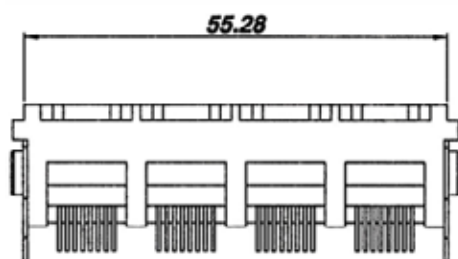
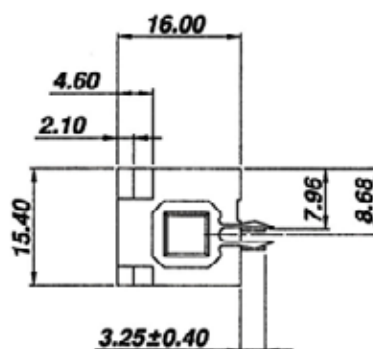
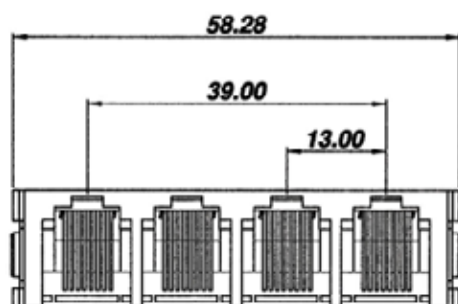
TOP ENTRY 4-PORT MODULAR PCB JACK WITH METAL PEGS 8P PROFILE=16.00MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Black & Gray
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
***RoHS & REACH compliant.**



Recommended P.C.Board Layout
(TOP VIEW)

ORDERING INFORMATION:

P/N MJ6M - $\frac{88}{1} \times \frac{04}{4}$

1. NO. OF POSITIONS & CONTACTS:
"88" 8P8C
2. CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD
3. HOUSING COLOR:
"A" GRAY
"B" BLACK
4. NO. OF PORTS:
04

NOTE: P/N MJ6MHT-88xx04 FOR HIGH TEMP. VERSION

TOP ENTRY MODULAR PCB JACK 6P PROFILE=16.20MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)

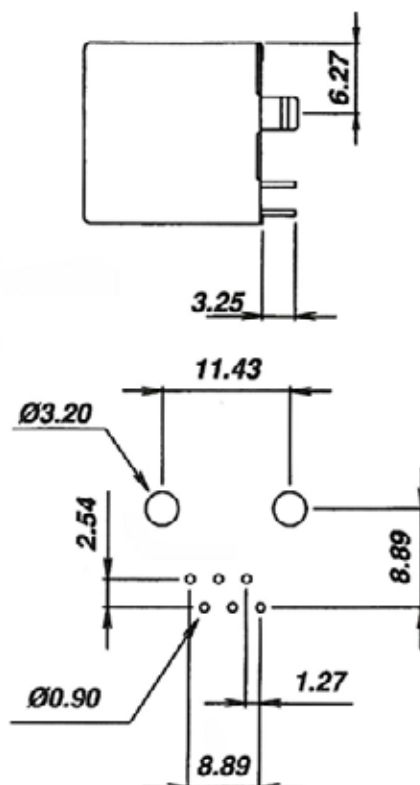
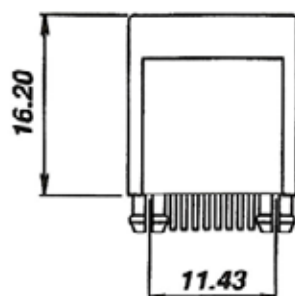
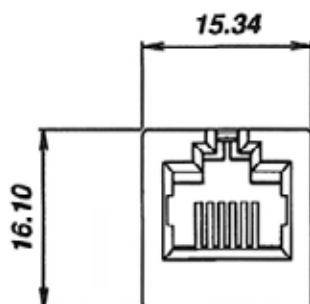
Soldering Temperature: 235°C

Color: Black

Spring Wire: Phosphor Bronze

Gold plating Over Nickel

*RoHS & REACH compliant.



Recommended P.C.Board Layout
(TOP VIEW)

ORDERING INFORMATION:

P/N M J T A - $\frac{x \times x}{T} \frac{x}{2}$ B

1. NO. OF POSITIONS & CONTACTS:

"66" 6P6C

"64" 6P4C

2. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

TOP ENTRY MODULAR PCB JACK WITH LED 8P PROFILE=16.20MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)

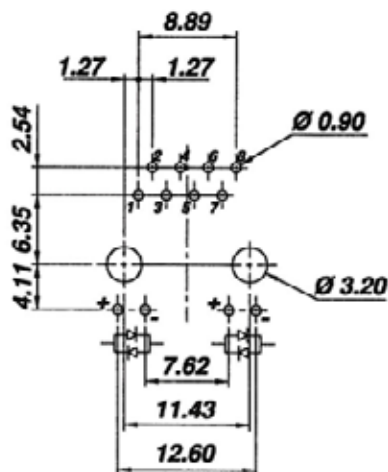
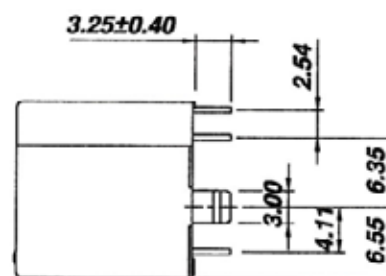
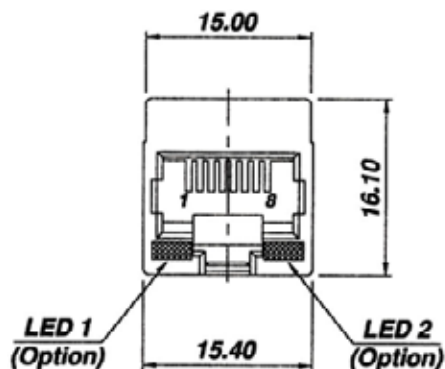
Soldering Temperature: 235°C

Color: Black

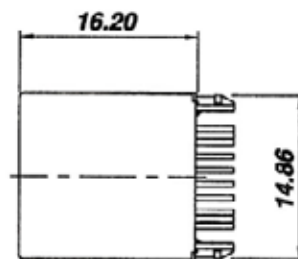
Spring Wire: Phosphor Bronze

Gold plating Over Nickel

*RoHS & REACH compliant.



Recommended P.C.Board Layout
(TOP VIEW)



ORDERING INFORMATION:

P/N M J T B - $\frac{88}{12} \frac{B}{34}$

1. NO. OF POSITIONS & CONTACTS:

"88" 8P8C

2. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

3. CODE OF LED1 DESIGNATION:

N, M, Y, Z, 8, Q, 1, 2, 5, 6

4. CODE OF LED2 DESIGNATION:

N, M, Y, Z, 8, Q, 1, 2, 5, 6

LED Designation:

Code	+/-	-/+	Code	+/-	-/+
N	Green	—	M	—	Green
Y	Yellow	—	Z	—	Yellow
8	Orange	—	Q	—	Orange
1	Green	Orange	2	Orange	Green
5	Green	Yellow	6	Yellow	Green

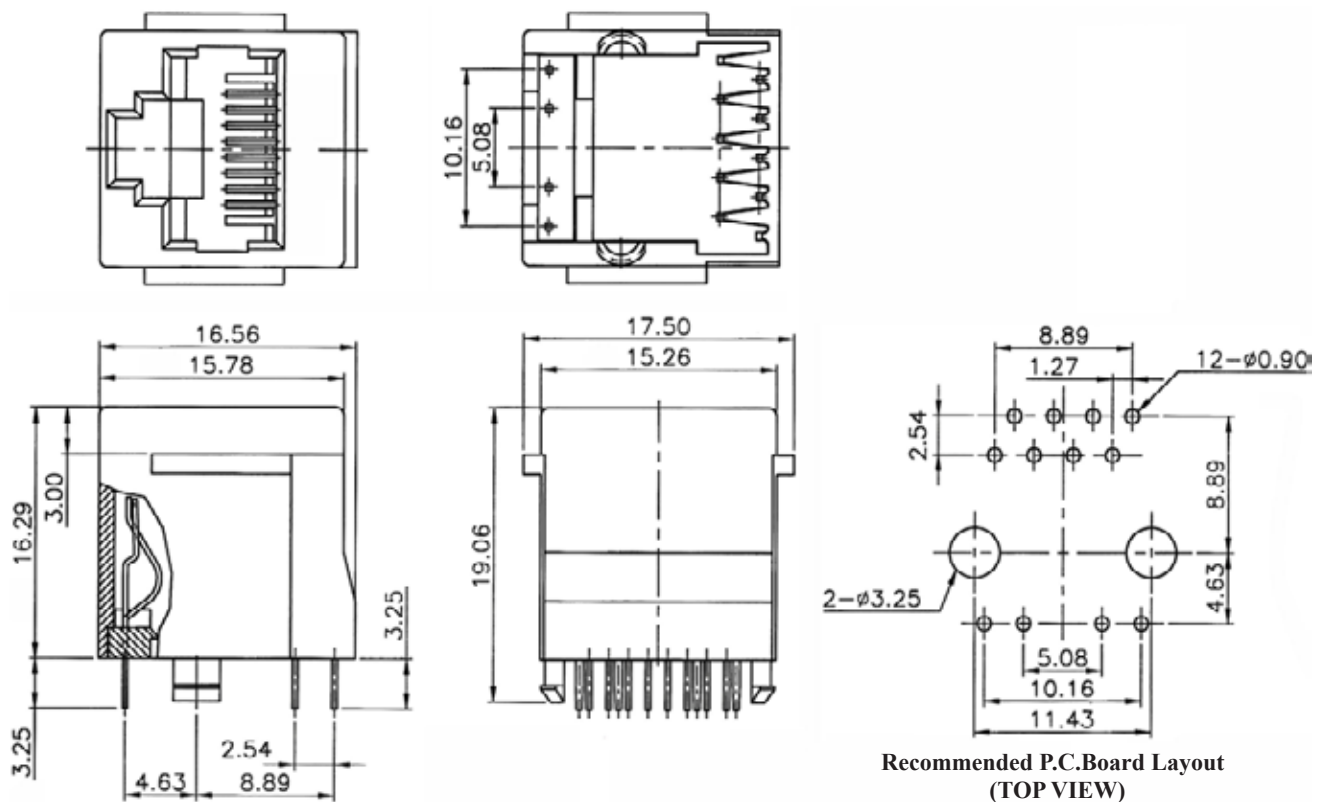
TOP ENTRY MODULAR PCB JACK 8P PROFILE=16.29MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Black
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
***RoHS & REACH compliant.**



ORDERING INFORMATION:

P/N M J 8 P - $\frac{x}{1} \frac{x}{2} \frac{x}{3} B \frac{x}{3}$

1. NO. OF POSITIONS & CONTACTS:
 "88" 8P8C
 "84" 8P4C
2. CONTACT FINISH:
 "A" 6 MICROINCH GOLD
 "B" 15 MICROINCH GOLD
 "C" 30 MICROINCH GOLD
 "D" 50 MICROINCH GOLD
3. KEYWAY OPTION:
 " " W/O KEYWAY
 "K" WITH KEYWAY

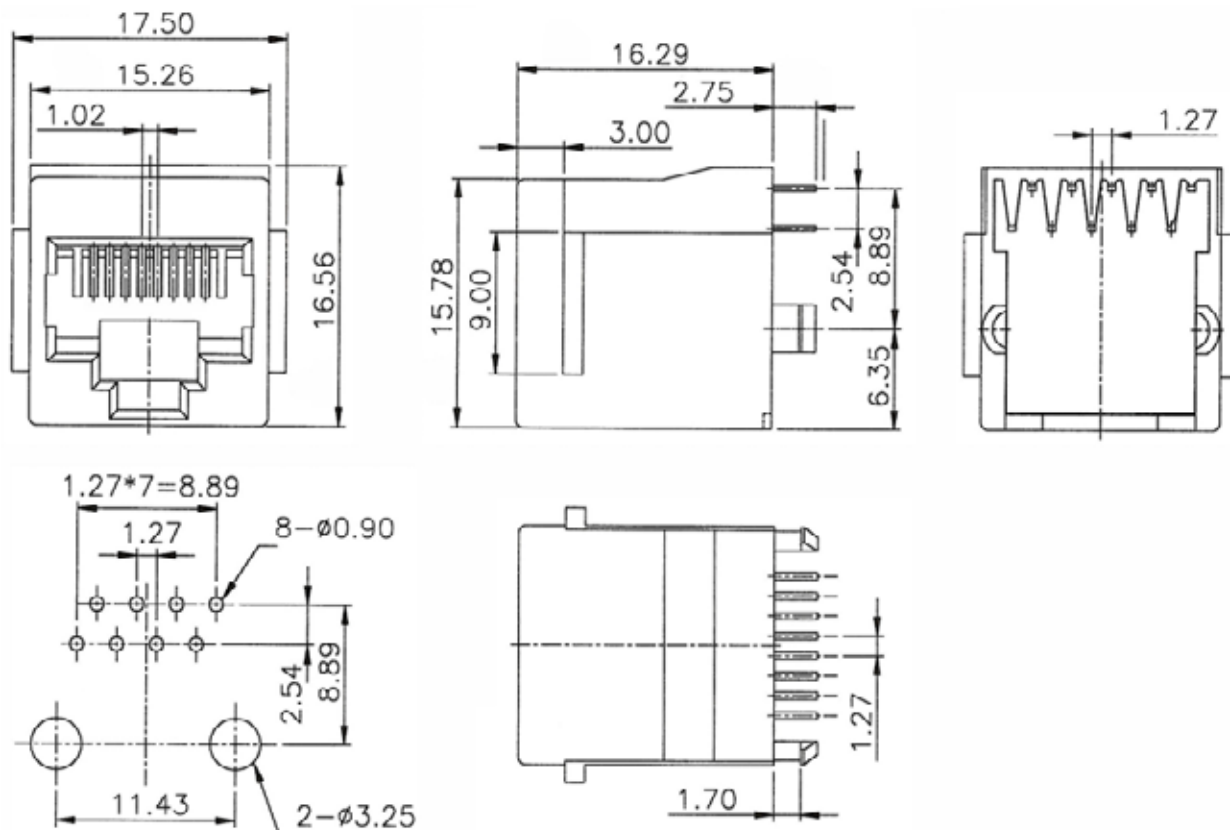
TOP ENTRY CAT.5 MODULAR PCB JACK 8P PROFILE=16.29MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Black
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
***RoHS & REACH compliant.**



Recommended P.C.Board Layout
(TOP VIEW)

ORDERING INFORMATION:

P/N M J 5 G - $\frac{88}{1} \frac{x}{2} \frac{B}{3}$

1. NO. OF POSITIONS & CONTACTS:
"88" 8P8C
2. CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD
3. KEYWAY OPTION:
" " W/O KEYWAY
"K" WITH KEYWAY

NOTE: CAT. 5 WITH PANEL STOP

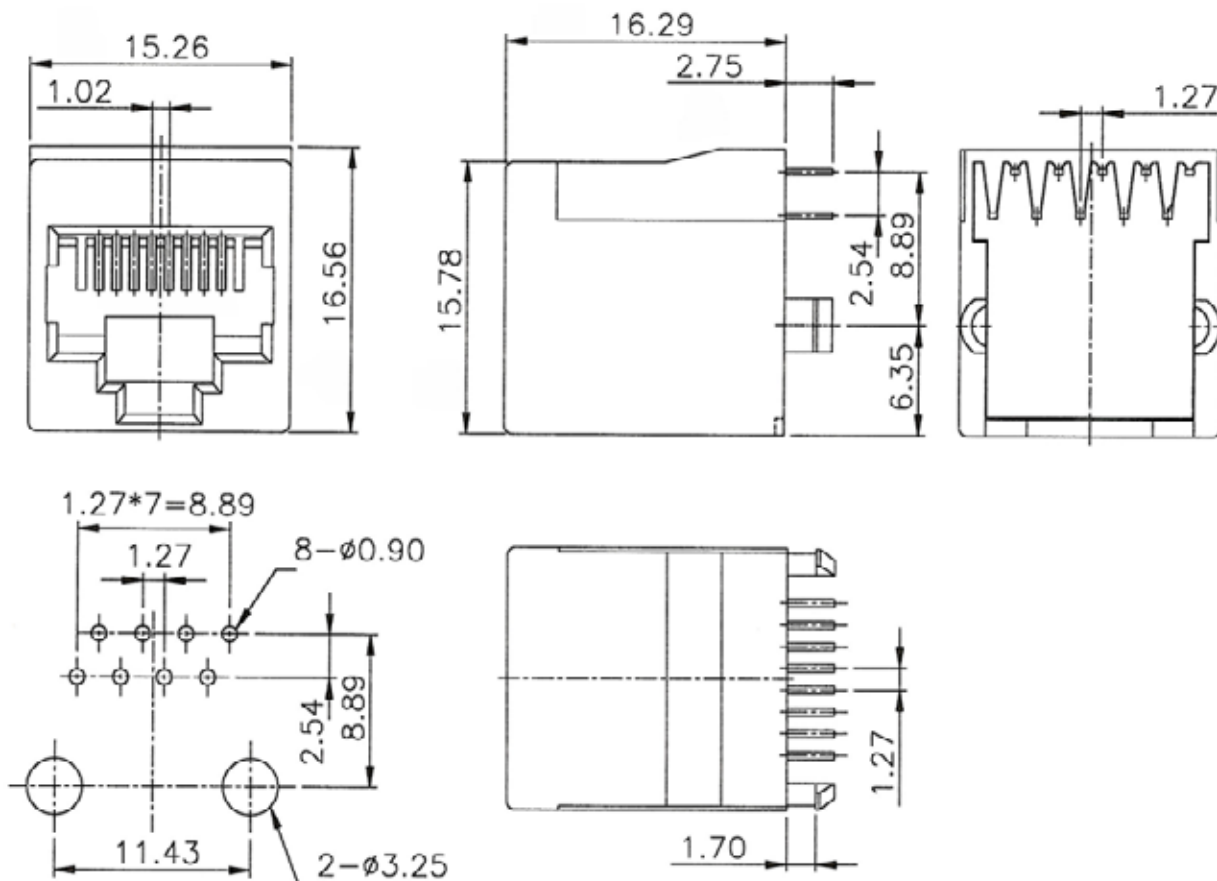
TOP ENTRY CAT.5 MODULAR PCB JACK 8P PROFILE=16.29MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Black
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
***RoHS & REACH compliant.**



Recommended P.C.Board Layout
(TOP VIEW)

ORDERING INFORMATION:

P/N M J 5 H - $\frac{88}{T} \frac{x}{2} \frac{B}{3}$

1. NO. OF POSITIONS & CONTACTS:
"88" 8P8C
2. CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD
3. KEYWAY OPTION:
" " W/O KEYWAY
"K" WITH KEYWAY

NOTE: CAT. 5 WITHOUT PANEL STOP

TOP ENTRY MODULAR PCB JACK WITH PIN #3 & #6 CROSSING 8P PROFILE=16.30MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)

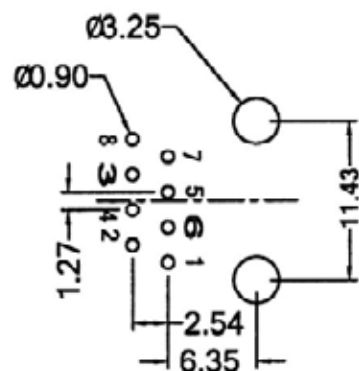
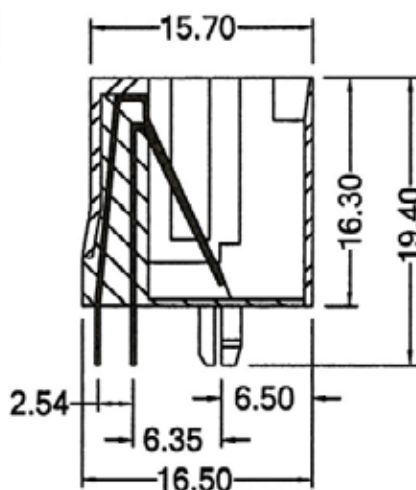
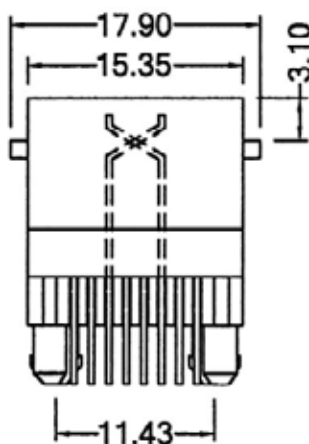
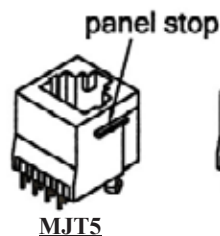
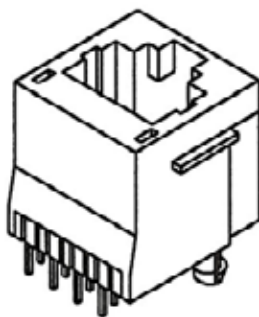
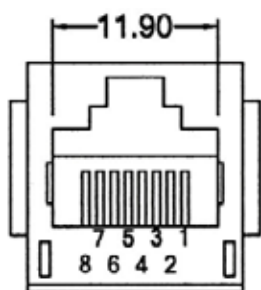
Soldering Temperature: 235°C

Color: Black

Spring Wire: Phosphor Bronze

Gold plating Over Nickel

*RoHS & REACH compliant.



Recommended P.C.Board Layout
(TOP VIEW)

ORDERING INFORMATION:

P/N M J $\frac{x}{1}$ $\frac{x}{2}$ - 88 $\frac{x}{3}$ B

1. PANEL STOP OPTION:
"T5" WITH PANEL STOP
"T6" W/O PANEL STOP
2. NO. OF POSITIONS & CONTACTS:
"88" 8P8C
3. CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD

NOTE: PIN #3 & PIN #6 CROSSING

TOP ENTRY MODULAR PCB JACK 4P PROFILE=16.38MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)

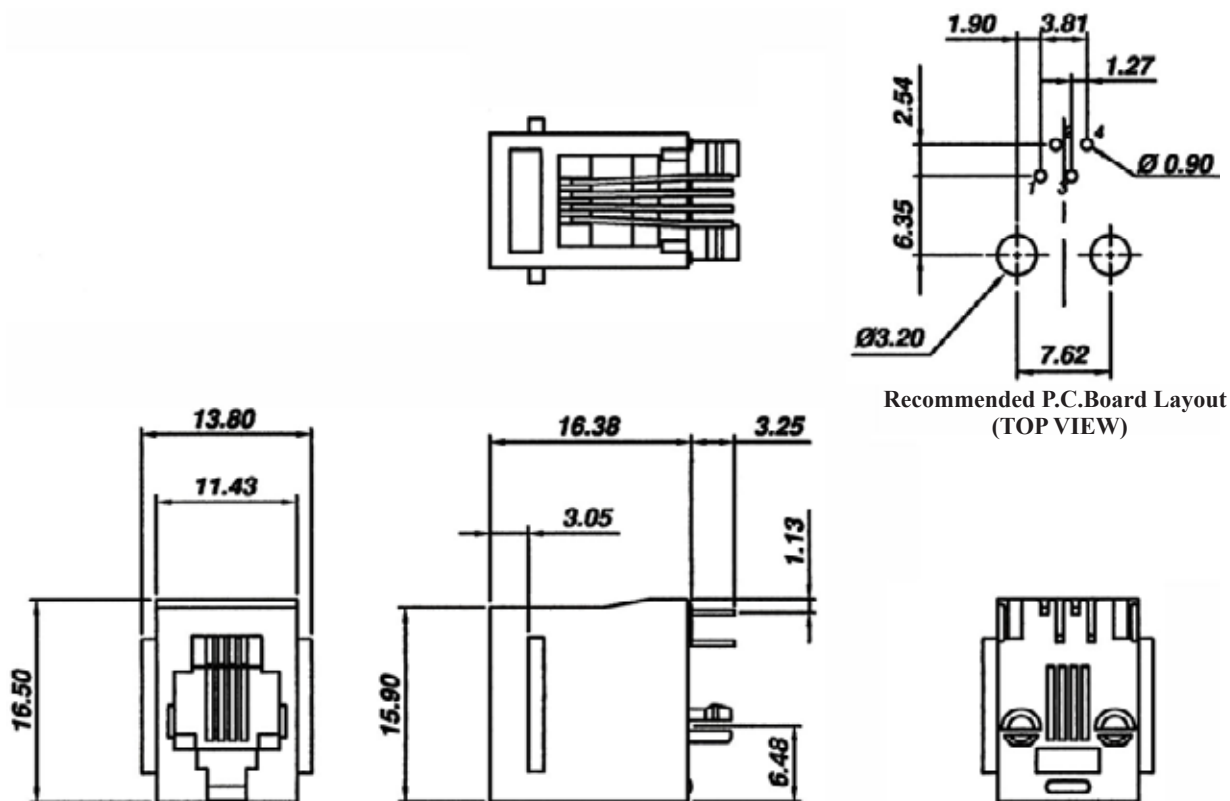
Soldering Temperature: 235°C

Color: Black

Spring Wire: Phosphor Bronze

Gold plating Over Nickel

*RoHS & REACH compliant.



ORDERING INFORMATION:

P/N M J $\frac{90}{1}$ - $\frac{44}{2}$ x $\frac{3}{3}$ B

1. TYPE OF HOUSING:
"90" WITH PANEL STOP (FLANGED)
2. NO. OF POSITIONS & CONTACTS:
"44" 4P4C
3. CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD

TOP ENTRY MODULAR PCB JACK 6P PROFILE=16.38MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500M Ω Min.

Contact Resistance: 20m Ω Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)

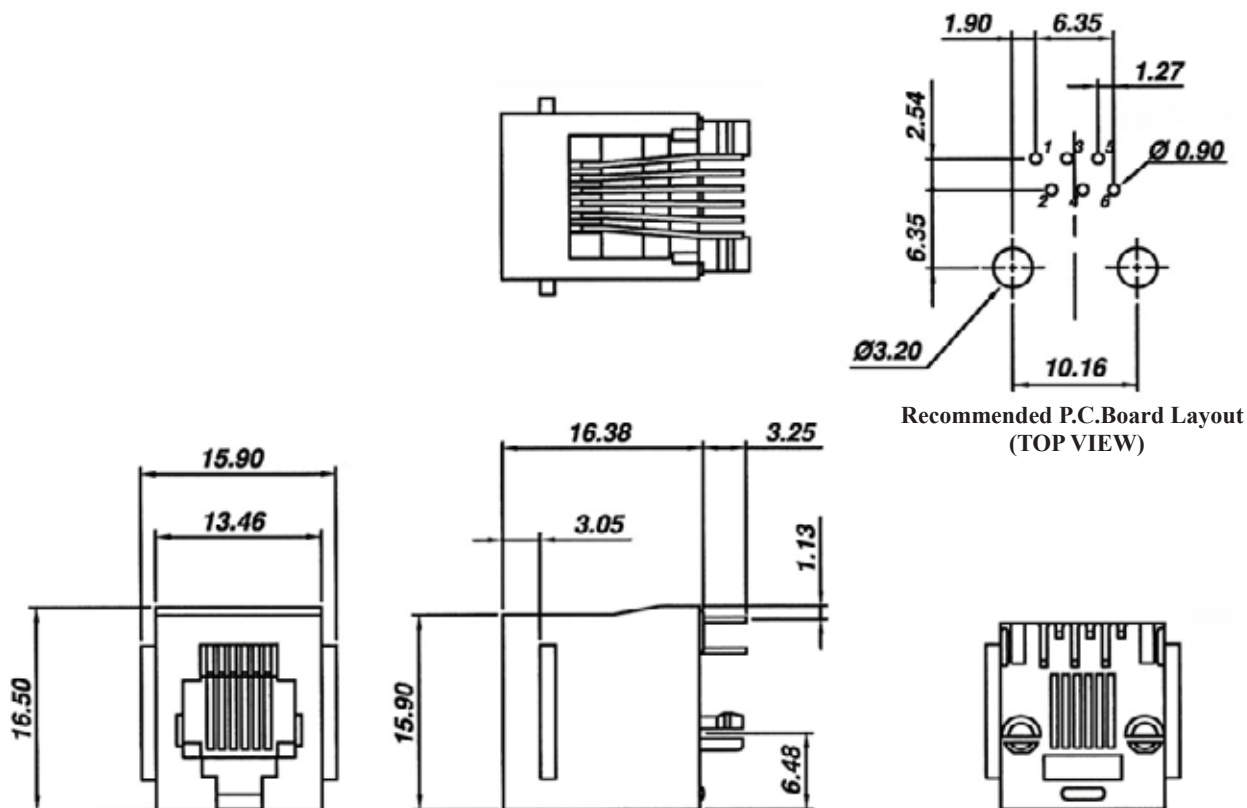
Soldering Temperature: 235°C

Color: Black

Spring Wire: Phosphor Bronze

Gold plating Over Nickel

*RoHS & REACH compliant.



ORDERING INFORMATION:

P/N M J $\frac{90}{1}$ - $\frac{xx}{2}$ $\frac{x}{3}$ B

1. TYPE OF HOUSING:
"90" WITH PANEL STOP (FLANGED)
2. NO. OF POSITIONS & CONTACTS:
"66" 6P6C
"64" 6P4C
3. CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD

TOP ENTRY MODULAR PCB JACK 8P PROFILE=16.38MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500M Ω Min.

Contact Resistance: 20m Ω Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)

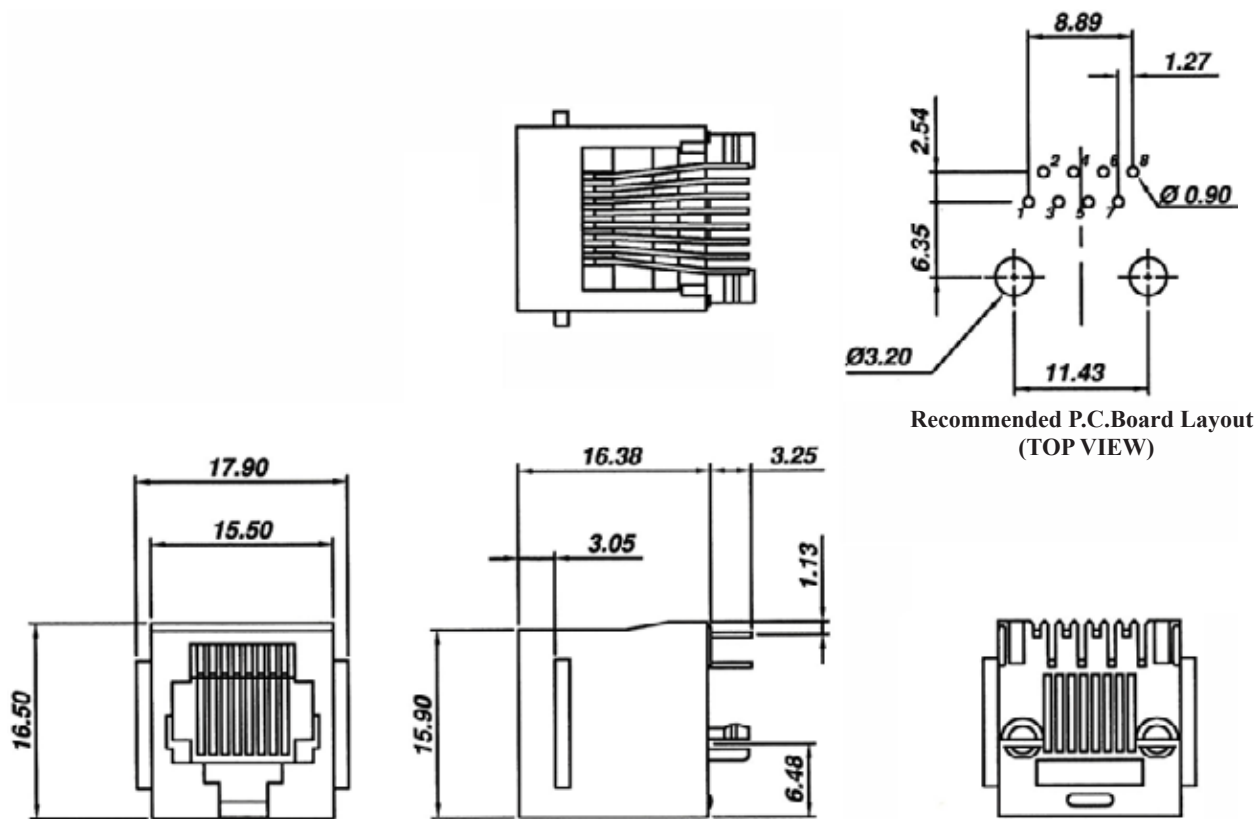
Soldering Temperature: 235°C

Color: Black

Spring Wire: Phosphor Bronze

Gold plating Over Nickel

*RoHS & REACH compliant.



ORDERING INFORMATION:

P/N M J $\frac{90}{1}$ - $\frac{xx}{2}$ $\frac{x}{3}$ B

1. TYPE OF HOUSING:
"90" WITH PANEL STOP (FLANGED)
2. NO. OF POSITIONS & CONTACTS:
"88" 8P8C
"84" 8P4C
3. CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD

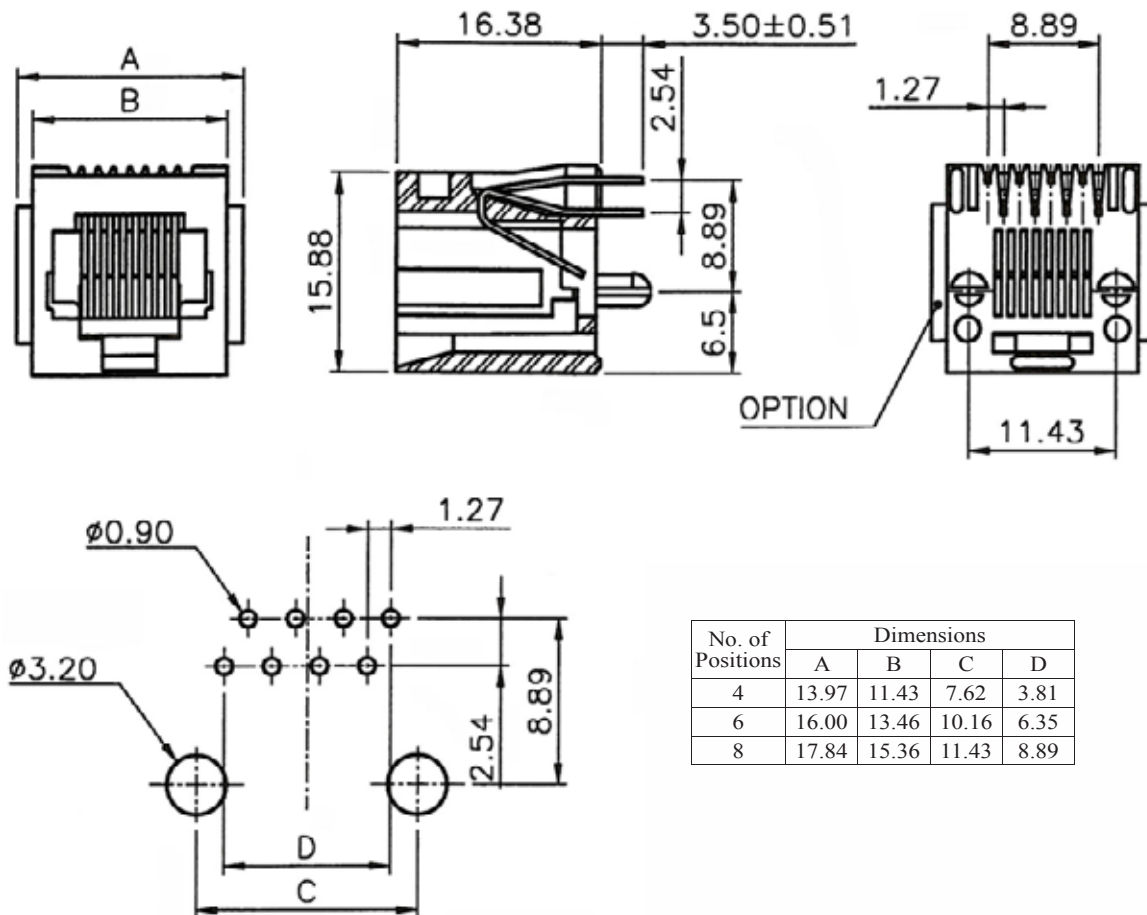
TOP ENTRY MODULAR PCB JACK WITH SPLIT FOOT 4P+6P+8P PROFILE=16.38MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Black
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
***RoHS & REACH compliant.**



Recommended P.C.Board Layout

No. of Positions	Dimensions			
	A	B	C	D
4	13.97	11.43	7.62	3.81
6	16.00	13.46	10.16	6.35
8	17.84	15.36	11.43	8.89

ORDERING INFORMATION:

P/N M J $\frac{xx}{1} - \frac{xx}{2} \frac{x}{3} B$

- PANEL STOP OPTION:
 "90" WITH PANEL STOP
 "49" W/O PANEL STOP
- NO. OF POSITIONS & CONTACTS:
 "66" 6P6C
 "64" 6P4C
 "88" 8P8C
 "44" 4P4C
- CONTACT FINISH:
 "A" 6 MICROINCH GOLD
 "B" 15 MICROINCH GOLD
 "C" 30 MICROINCH GOLD
 "D" 50 MICROINCH GOLD

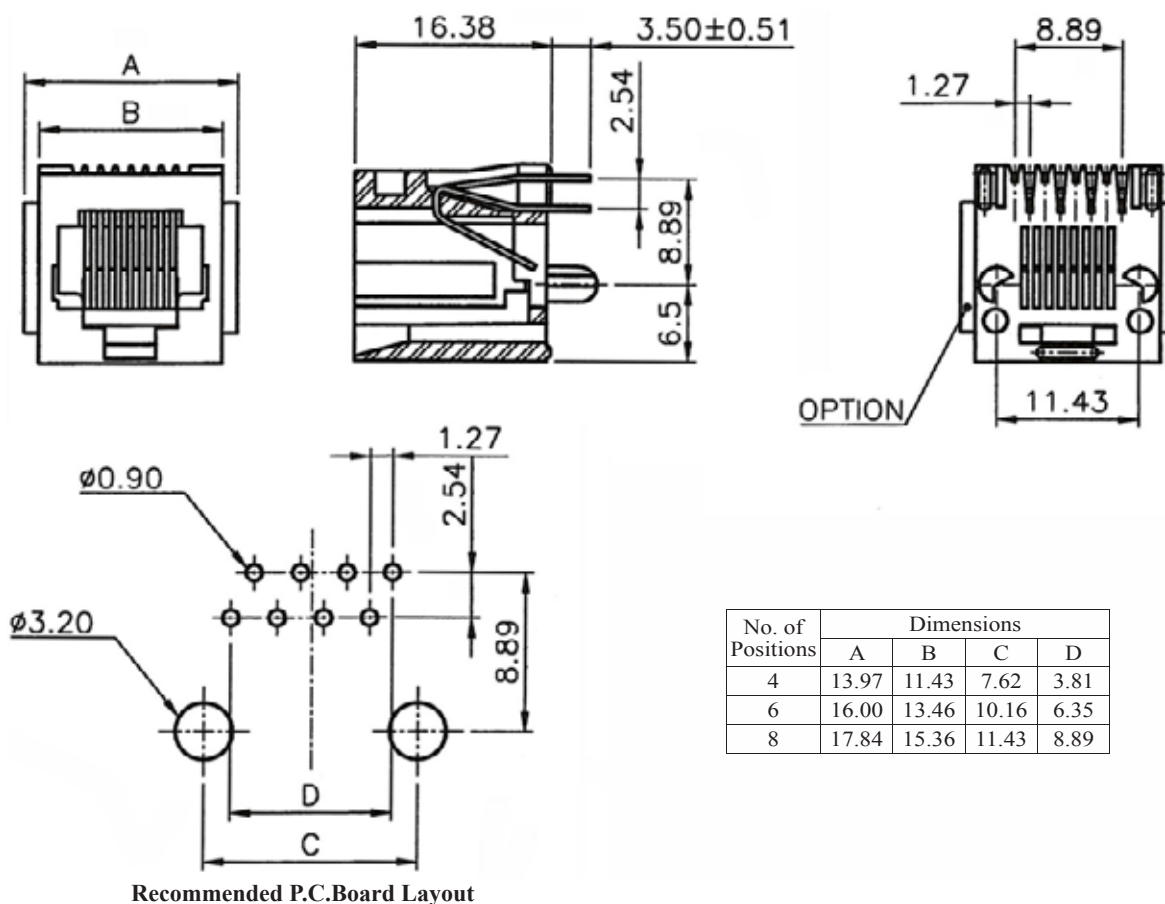
TOP ENTRY MODULAR PCB JACK WITH HALF ROUND FOOT 4P+6P+8P PROFILE=16.38MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Black
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
***RoHS & REACH compliant.**



No. of Positions	Dimensions			
	A	B	C	D
4	13.97	11.43	7.62	3.81
6	16.00	13.46	10.16	6.35
8	17.84	15.36	11.43	8.89

ORDERING INFORMATION:

P/N M J $\frac{xx}{1} - \frac{xxx}{2} \frac{x}{3} B$

- PANEL STOP OPTION:
 "31" WITH PANEL STOP
 "32" W/O PANEL STOP
- NO. OF POSITIONS & CONTACTS:
 "66" 6P6C
 "64" 6P4C
 "88" 8P8C
 "44" 4P4C
- CONTACT FINISH:
 "A" 6 MICROINCH GOLD
 "B" 15 MICROINCH GOLD
 "C" 30 MICROINCH GOLD
 "D" 50 MICROINCH GOLD

TOP ENTRY MODULAR PCB JACK 6P PROFILE=16.38MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)

Soldering Temperature: 235°C

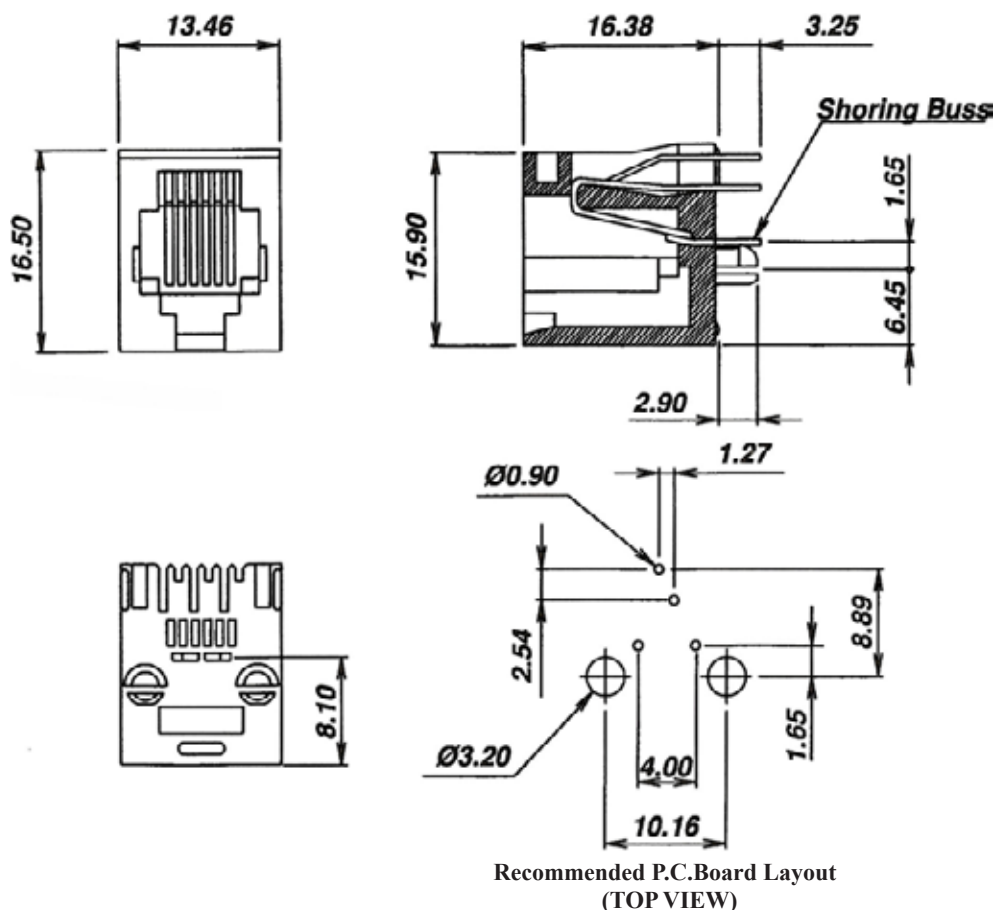
Color: Black

Spring Wire: Phosphor Bronze

Gold plating Over Nickel

Shield: Brass plating Nickel Alloy

*RoHS & REACH compliant.



ORDERING INFORMATION:

P/N M J T E - $\frac{62}{T} \times B$

1. NO. OF POSITIONS & CONTACTS:

"62" 6P2C

2. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

TOP ENTRY MODULAR PCB JACK 4P+6P+8P+10P PROFILE=16.40MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)

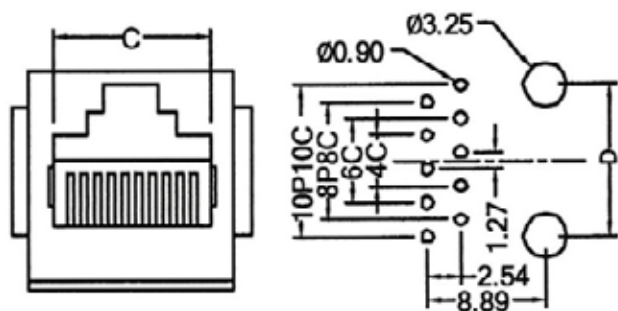
Soldering Temperature: 235°C

Color: Black

Spring Wire: Phosphor Bronze

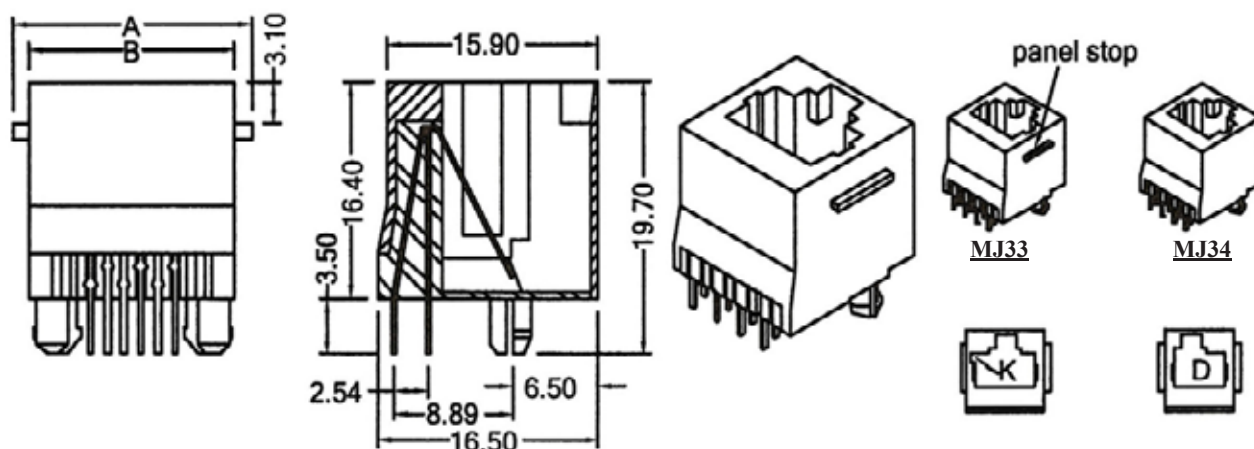
Gold plating Over Nickel

*RoHS & REACH compliant.



Recommended P.C.Board Layout
(TOP VIEW)

No. of Positions	No. of Contacts	A	B	C	D
4P	4C	13.97	11.43	7.90	7.62
6P	2C/4C/6C	16.00	13.46	10.00	10.16
8P	4C/6C/8C	18.03	15.49	11.90	11.43
10P	10C	18.03	15.49	11.90	11.43



ORDERING INFORMATION:

P/N M J $\frac{xx}{1}$ - $\frac{xxx}{2}$ $\frac{B}{3}$ $\frac{x}{4}$

1. PANEL STOP OPTION:

- "33" WITH PANEL STOP
- "34" W/O PANEL STOP

2. NO. OF POSITIONS & CONTACTS:

- "66" 6P6C
- "64" 6P4C
- "88" 8P8C
- "84" 8P4C
- "00" 10P10C
- "44" 4P4C

3. CONTACT FINISH:

- "A" 6 MICROINCH GOLD
- "B" 15 MICROINCH GOLD
- "C" 30 MICROINCH GOLD
- "D" 50 MICROINCH GOLD

4. KEYWAY & OFFSET OPTION:

- " " W/O KEYWAY & W/O OFFSET LATCH
- "K" WITH KEYWAY (8P & 10P ONLY)
- "D" WITH OFFSET LATCH (6P ONLY)

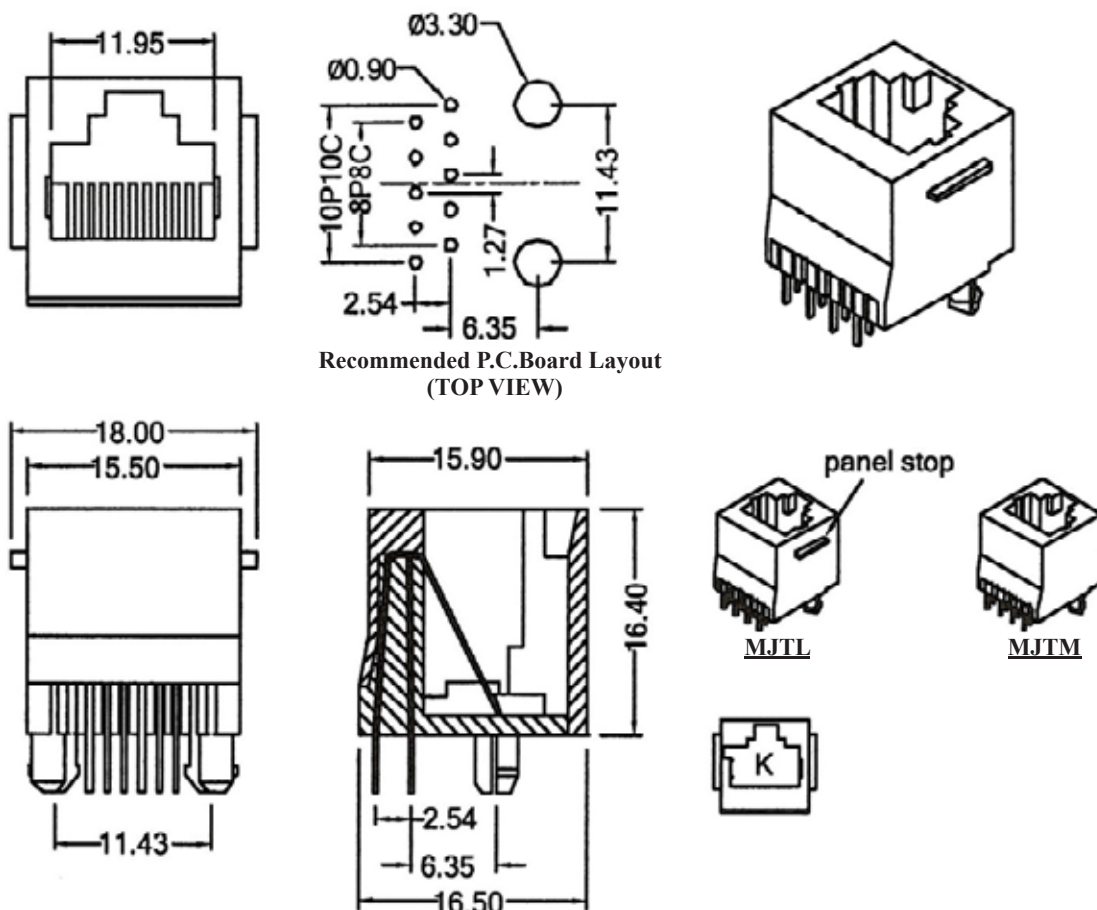
TOP ENTRY MODULAR PCB JACK 8P+10P PROFILE=16.40MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Black
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
***RoHS & REACH compliant.**



ORDERING INFORMATION:

P/N M J $\frac{xx}{1}$ - $\frac{xxx}{2}$ B $\frac{x}{4}$

- PANEL STOP OPTION:
 "TL" WITH PANEL STOP
 "TM" W/O PANEL STOP
- NO. OF POSITIONS & CONTACTS:
 "88" 8P8C
 "00" 10P10C
- CONTACT FINISH:
 "A" 6 MICROINCH GOLD
 "B" 15 MICROINCH GOLD
 "C" 30 MICROINCH GOLD
 "D" 50 MICROINCH GOLD

- KEYWAY OPTION:
 " " W/O KEYWAY
 "K" WITH KEYWAY

tel. 02.3361.1626 info@elitaliaweb.it
fax 02.2626.1009 www.elitaliaweb.it

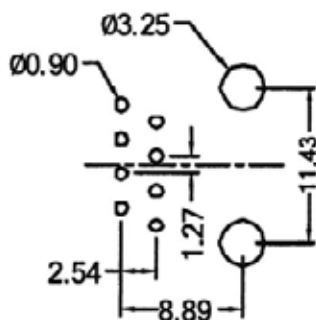
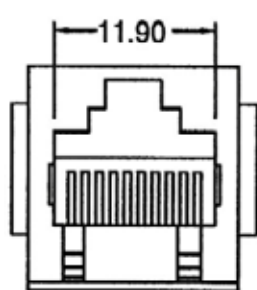
TOP ENTRY MODULAR PCB JACK WITH DUST COVER 8P PROFILE=16.40MM (UNSHIELDED)

SPECIFICATIONS

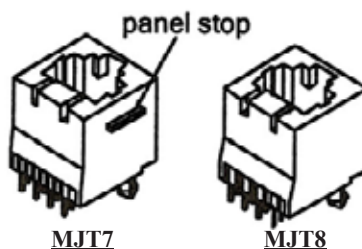
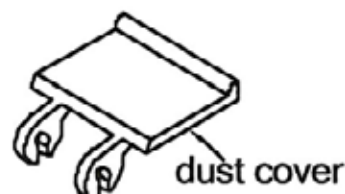
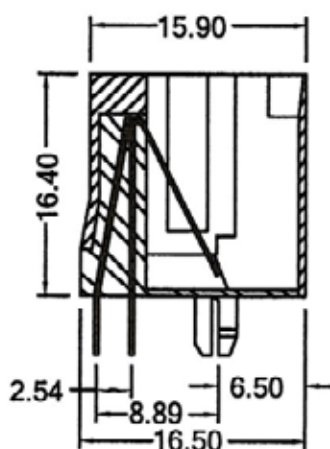
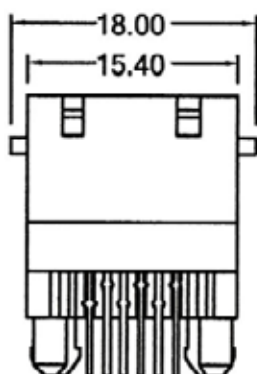
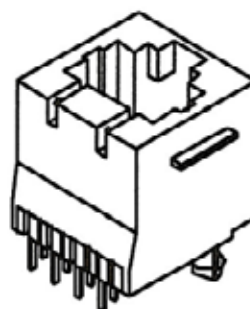
Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Black
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
***RoHS & REACH compliant.**



Recommended P.C.Board Layout
(TOP VIEW)



ORDERING INFORMATION:

P/N M J $\frac{xx}{1}$ - $\frac{88}{2}$ $\frac{x}{3}$ B

- PANEL STOP OPTION:
 "T7" WITH PANEL STOP
 "T8" W/O PANEL STOP
- NO. OF POSITIONS & CONTACTS:
 "88" 8P8C
- CONTACT FINISH:
 "A" 6 MICROINCH GOLD
 "B" 15 MICROINCH GOLD
 "C" 30 MICROINCH GOLD
 "D" 50 MICROINCH GOLD

TOP ENTRY MODULAR PCB JACK 8P PROFILE=16.70MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)

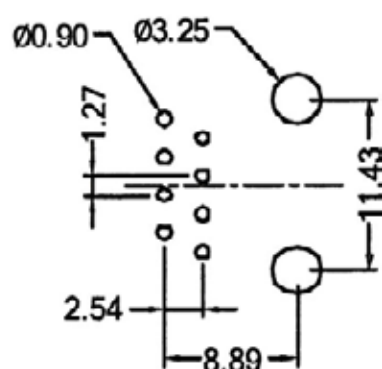
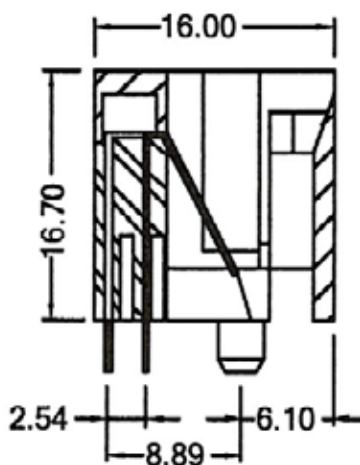
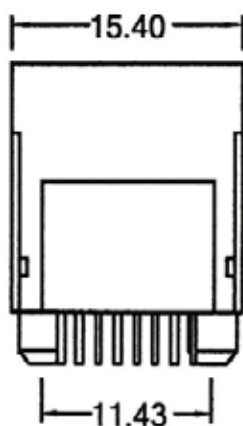
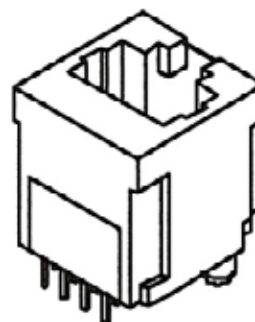
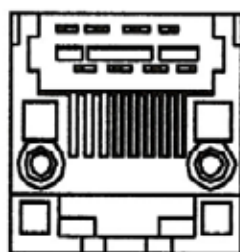
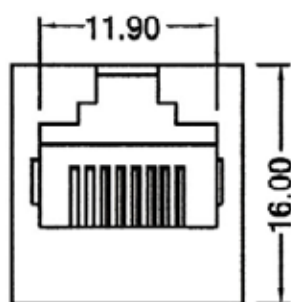
Soldering Temperature: 235°C

Color: Black

Spring Wire: Phosphor Bronze

Gold plating Over Nickel

*RoHS & REACH compliant.



Recommended P.C.Board Layout
(TOP VIEW)

ORDERING INFORMATION:

P/N M J 7 W - $\frac{88}{1} \times \frac{B}{2}$

1. NO. OF POSITIONS & CONTACTS:

"88" 8P8C

2. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

TOP ENTRY MODULAR PCB JACK WITH COPPER PLATE & FILM (MYLAR) 8P PROFILE=16.70MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)

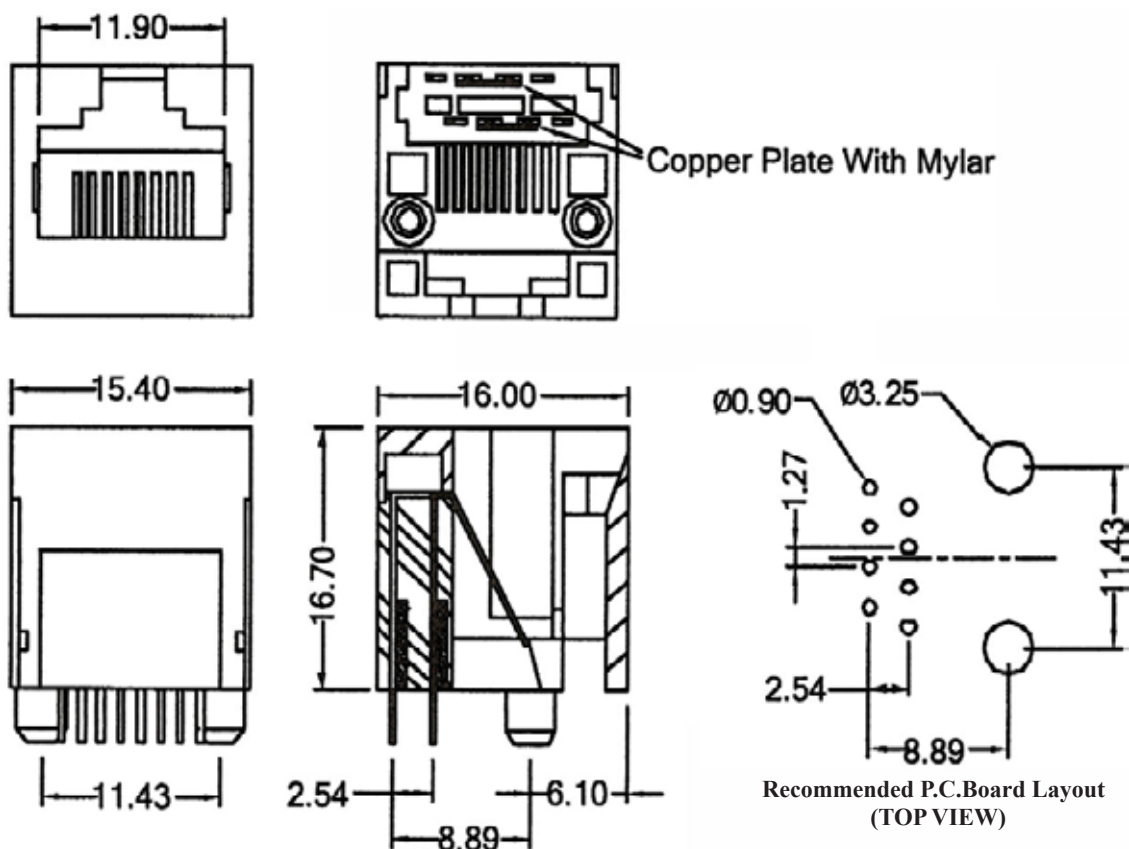
Soldering Temperature: 235°C

Color: Black

Spring Wire: Phosphor Bronze

Gold plating Over Nickel

*RoHS & REACH compliant.



ORDERING INFORMATION:

P/N M J 7 U - $\frac{88}{T} \frac{x}{2}$ B

1. NO. OF POSITIONS & CONTACTS:

"88" 8P8C

2. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

TOP ENTRY MODULAR PCB JACK WITH COPPER PLATE 8P PROFILE=16.70MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)

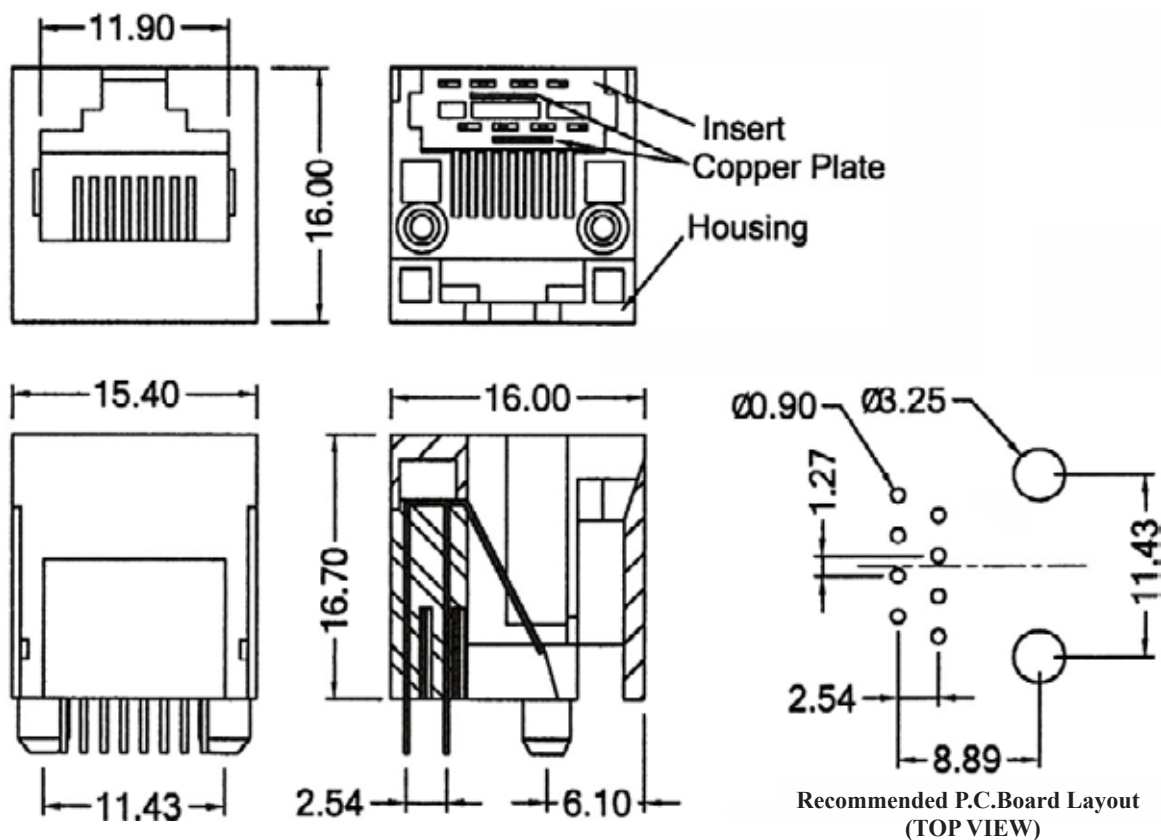
Soldering Temperature: 235°C

Color: Black

Spring Wire: Phosphor Bronze

Gold plating Over Nickel

*RoHS & REACH compliant.



ORDERING INFORMATION:

P/N M J 7 C - $\frac{88}{T} \frac{x}{2}$ B

1. NO. OF POSITIONS & CONTACTS:

"88" 8P8C

2. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

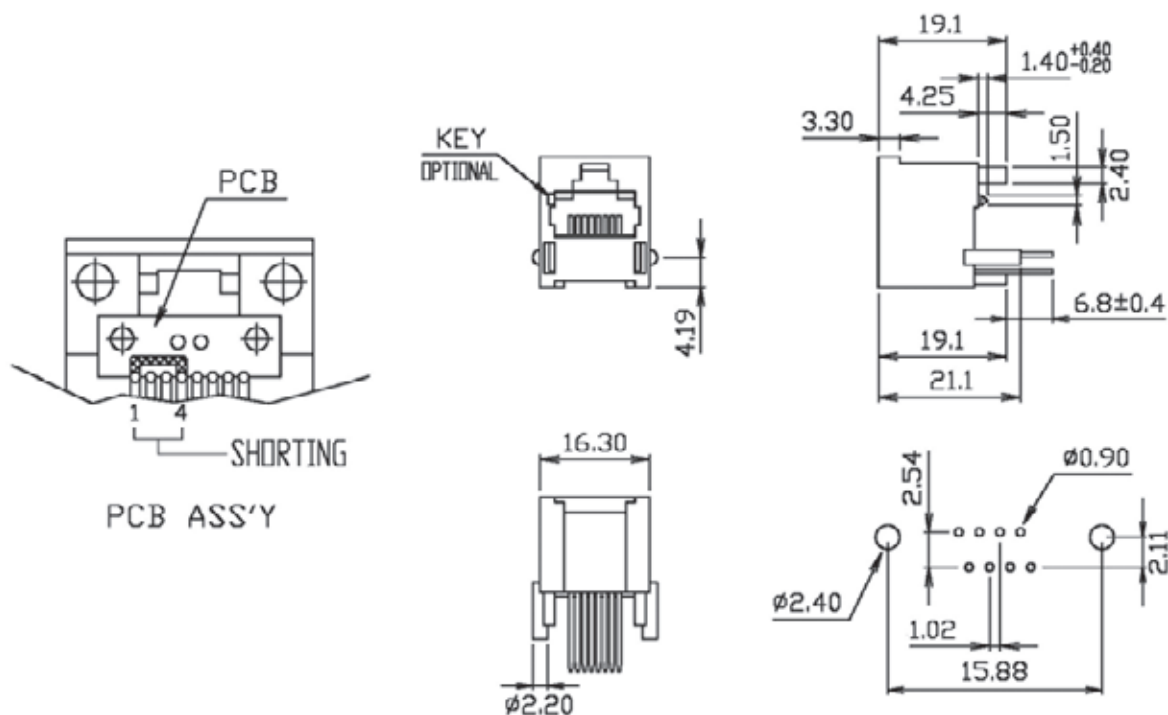
TOP ENTRY MODULAR PCB JACK 8P PROFILE=21.10MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Black
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
***RoHS & REACH compliant.**



Recommended P.C.Board Layout

ORDERING INFORMATION:

P/N M J G Q - 88 x B
1 2 3 4

- MODULAR JACK TYPE:
"GQ" DIP=6.8MM FLANGELESS
- NO. OF POSITIONS & CONTACTS:
"88" 8P8C
- CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD
- HOUSING COLOR:
"B" BLACK

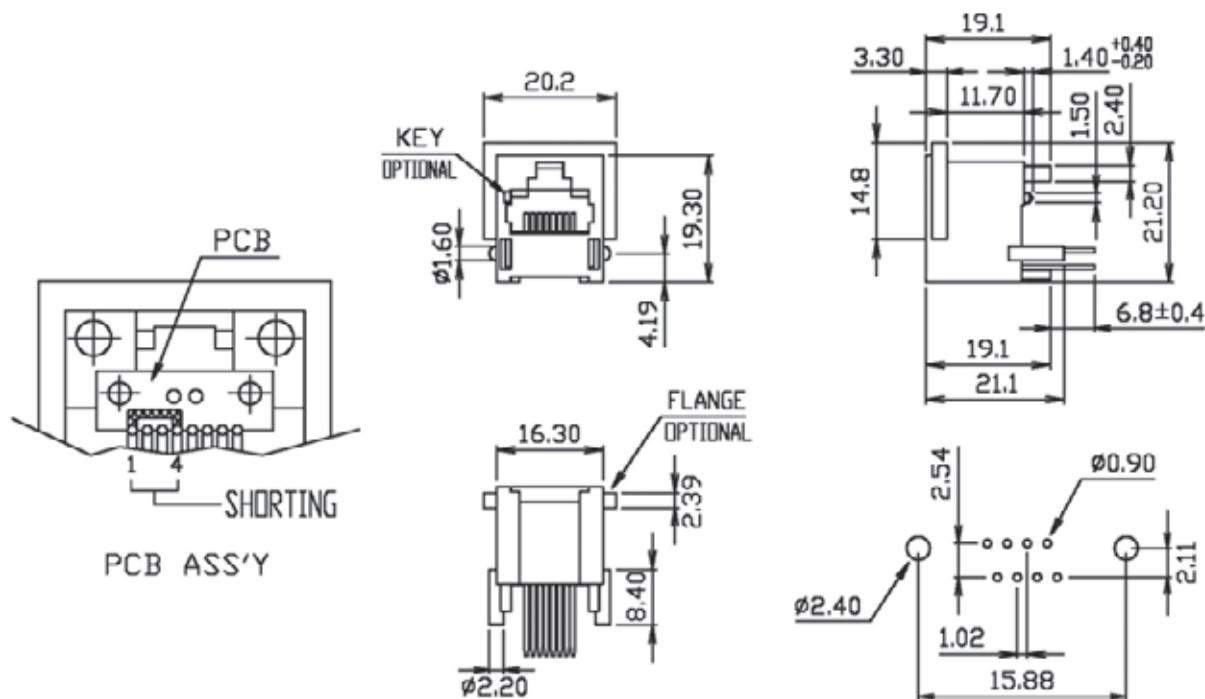
TOP ENTRY MODULAR PCB JACK 8P PROFILE=21.10MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Black
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
***RoHS & REACH compliant.**



Recommended P.C.Board Layout

ORDERING INFORMATION:

P/N M J $\frac{GP}{1}$ - $\frac{88}{2}$ $\frac{x}{3}$ $\frac{B}{4}$

- MODULAR JACK TYPE:
"GP" DIP=6.8MM FLANGED
- NO. OF POSITIONS & CONTACTS:
"88" 8P8C
- CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD
- HOUSING COLOR:
"B" BLACK

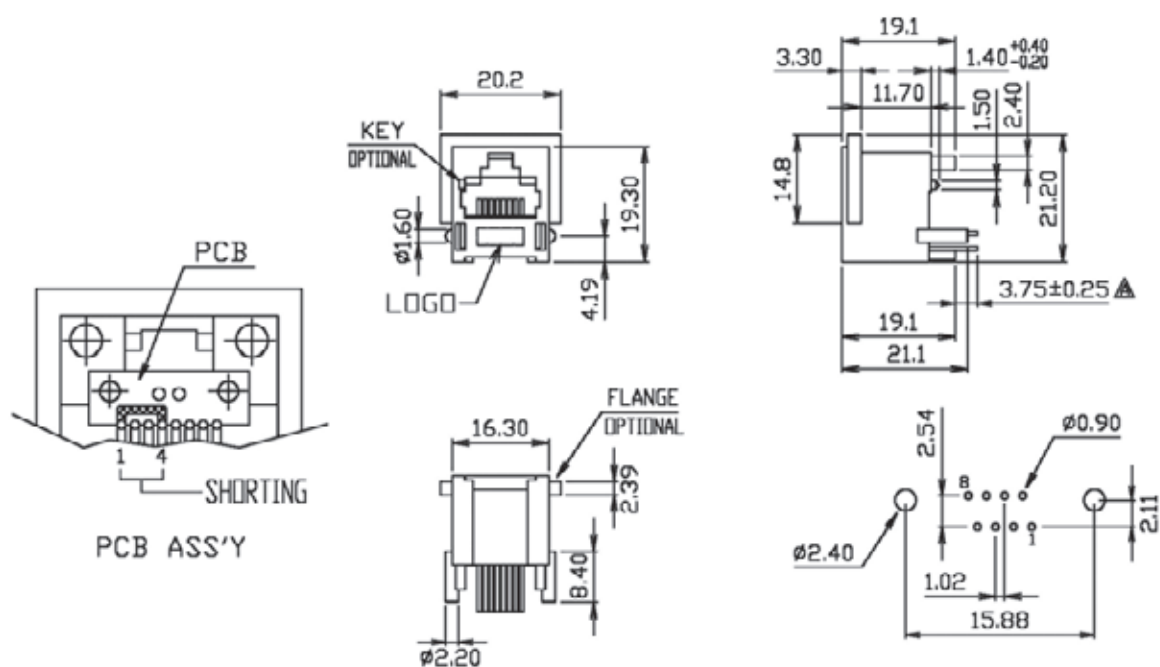
TOP ENTRY MODULAR PCB JACK 8P PROFILE=21.10MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Black
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
***RoHS & REACH compliant.**



Recommended P.C.Board Layout

ORDERING INFORMATION:

P/N M J GN - 88 x B
1 2 3 4

- MODULAR JACK TYPE:
"GN" DIP=3.75MM FLANGED
- NO. OF POSITIONS & CONTACTS:
"88" 8P8C
- CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD
- HOUSING COLOR:
"B" BLACK

TOP ENTRY MODULAR PCB JACK 6P PROFILE=22.00MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)

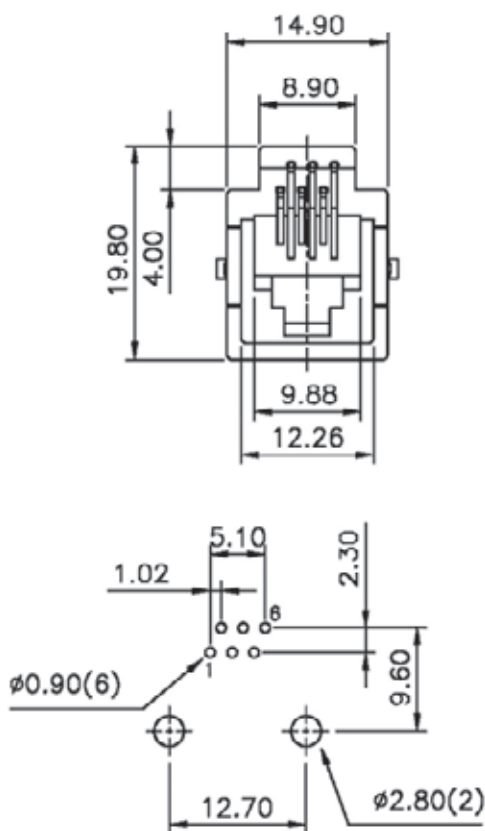
Soldering Temperature: 235°C

Color: Black

Spring Wire: Phosphor Bronze

Gold plating Over Nickel

*RoHS & REACH compliant.



Recommended P.C.Board Layout

ORDERING INFORMATION:

P/N M J G R - 6 6 x B
1 2 3 4

- MODULAR JACK TYPE:
"GR" STRAIGHT DIP TYPE
- NO. OF POSITIONS & CONTACTS:
"64" 6P4C
"66" 6P6C
- CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD
- HOUSING COLOR:
"B" BLACK

TOP ENTRY 4-PORT MODULAR PCB JACK 8P PROFILE=16.10MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)

Soldering Temperature: 235°C

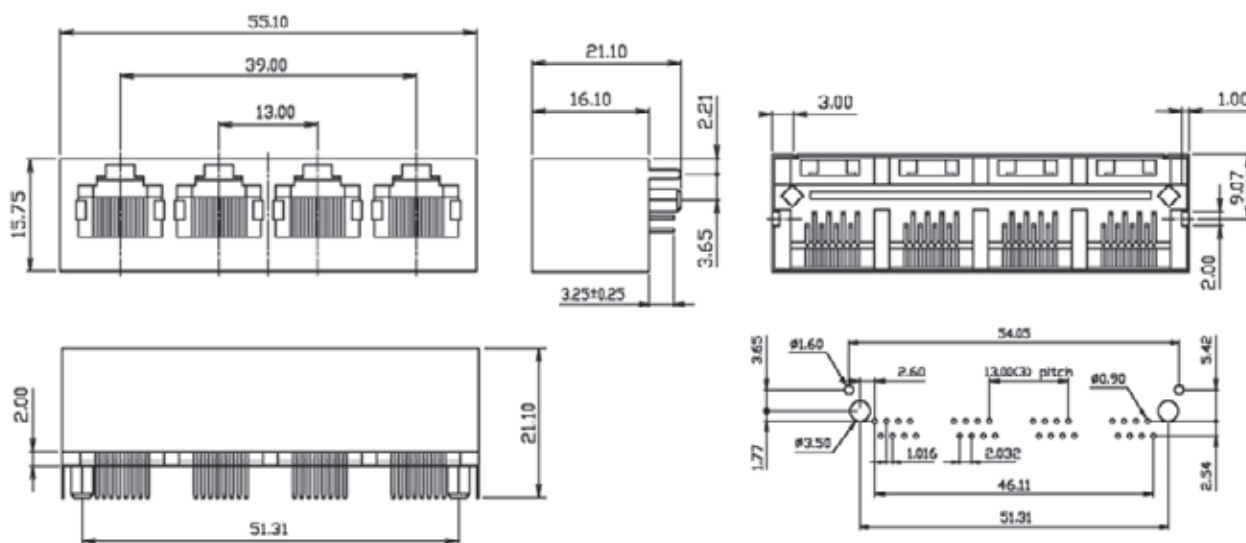
Color: Black

Spring Wire: Phosphor Bronze

Gold plating Over Nickel

Shield: Brass plating Nickel Alloy

***RoHS & REACH compliant.**



Recommended P.C.Board Layout

ORDERING INFORMATION:

P/N M J G J - 8 8 x B 0 4
1 2 3 4 5

1. MODULAR JACK TYPE:

"GJ" STRAIGHT GANGED JACK

2. NO. OF POSITIONS & CONTACTS:

"88" 8P8C

3. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

4. HOUSING COLOR:

"B" BLACK

5. NO. OF PORTS:

04

TOP ENTRY MODULAR SMT JACK 4P PROFILE=12.80MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: Nylon (UL 94V-0)

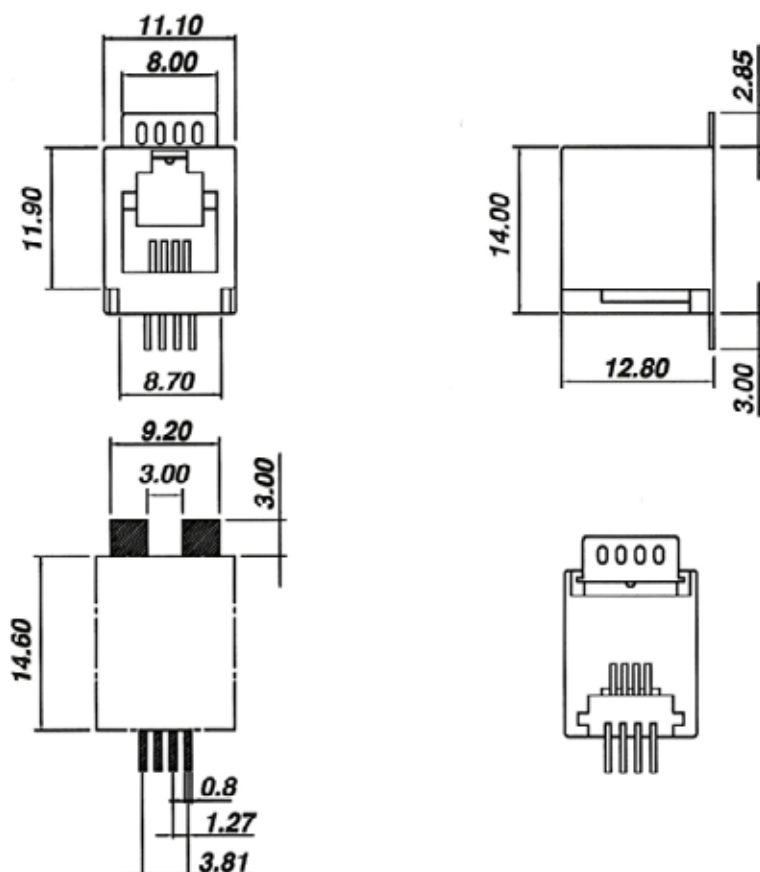
Soldering Temperature: 260°C

Color: Black

Spring Wire: Phosphor Bronze

Gold plating Over Nickel

*RoHS & REACH compliant.



Recommended P.C.Board Layout
(TOP VIEW)

ORDERING INFORMATION:

P/N M J T F - $\frac{4}{1} \frac{4}{2} \frac{x}{3} B - \frac{x}{3}$

1. NO. OF POSITIONS & CONTACTS:

"44" 4P4C

2. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

3. PACKAGE OPTION:

" " TRAY

"R" TAPE & REEL

"G" WITH FILM IN TAPE & REEL

TOP ENTRY MODULAR SMT JACK 6P PROFILE=12.80MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: Nylon (UL 94V-0)

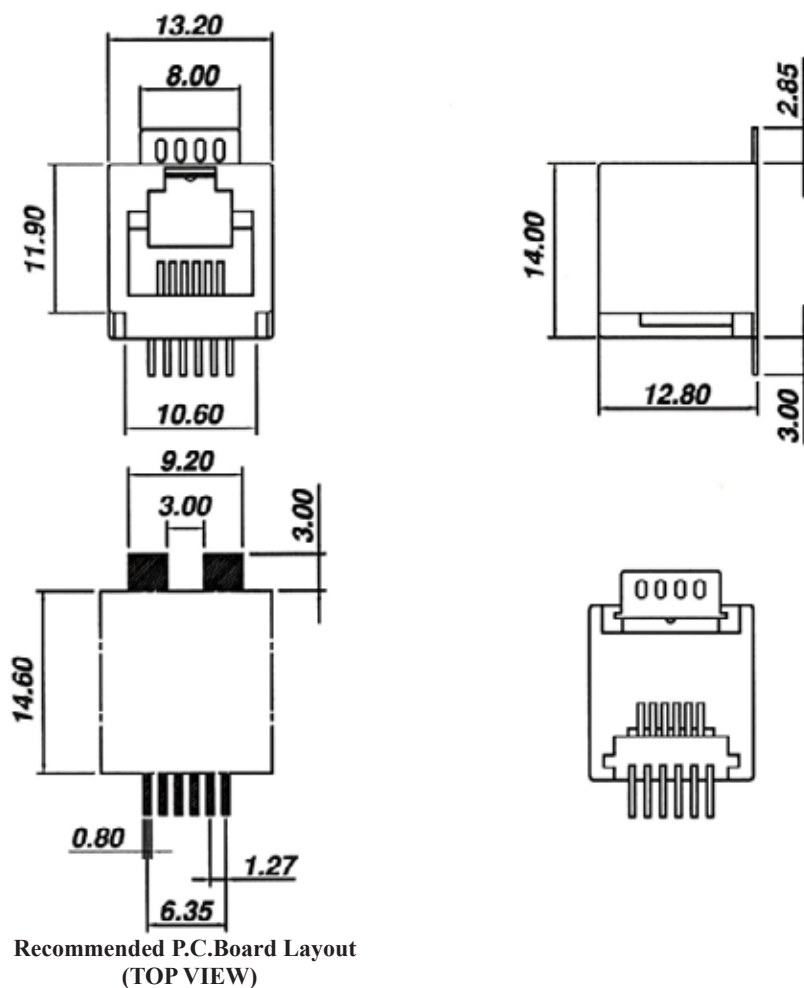
Soldering Temperature: 260°C

Color: Black

Spring Wire: Phosphor Bronze

Gold plating Over Nickel

*RoHS & REACH compliant.



ORDERING INFORMATION:

P/N M J T F - $\frac{x}{1} \frac{x}{2} B - \frac{x}{3}$

1. NO. OF POSITIONS & CONTACTS:

"66" 6P6C

"64" 6P4C

2. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

3. PACKAGE OPTION:

" " TRAY

"R" TAPE & REEL

"G" WITH FILM IN TAPE & REEL

TOP ENTRY MODULAR SMT JACK 8P PROFILE=12.80MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: Nylon (UL 94V-0)

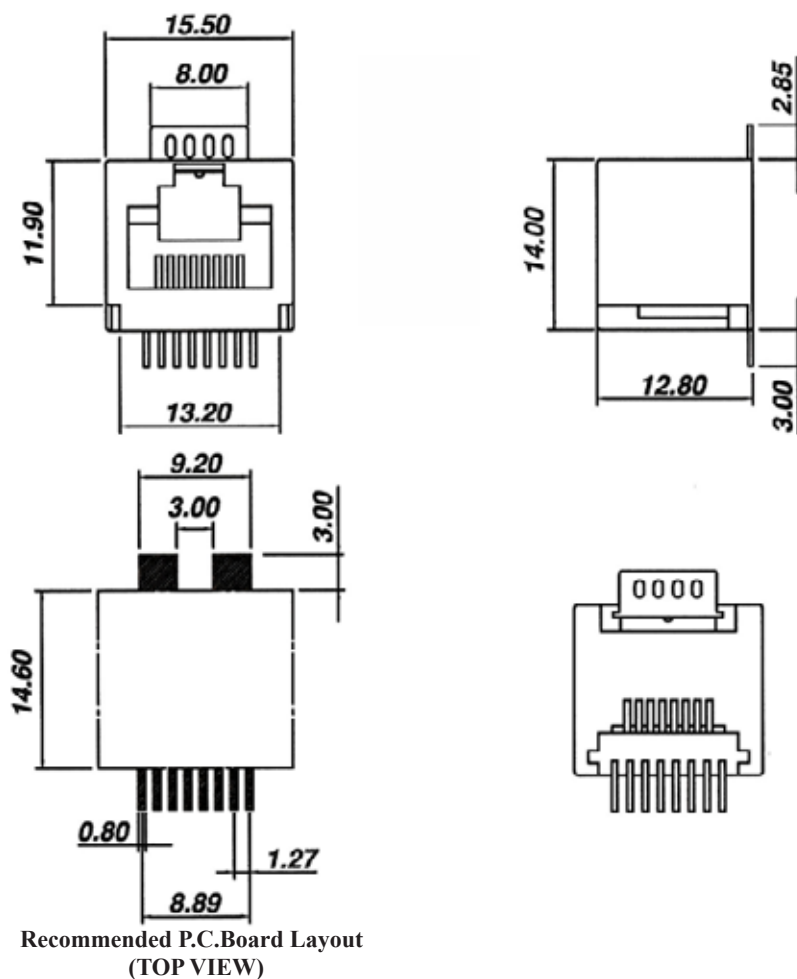
Soldering Temperature: 260°C

Color: Black

Spring Wire: Phosphor Bronze

Gold plating Over Nickel

*RoHS & REACH compliant.



ORDERING INFORMATION:

P/N M J T F - $\frac{88}{1} \frac{x}{2}$ B - $\frac{x}{3}$

1. NO. OF POSITIONS & CONTACTS:

"88" 8P8C

2. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

3. PACKAGE OPTION:

" " TRAY

"R" TAPE & REEL

"G" WITH FILM IN TAPE & REEL

TOP ENTRY MODULAR SMT JACK WITH SOLDER PAD 4P+6P+8P+10P PROFILE=12.80MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: Nylon (UL 94V-0)

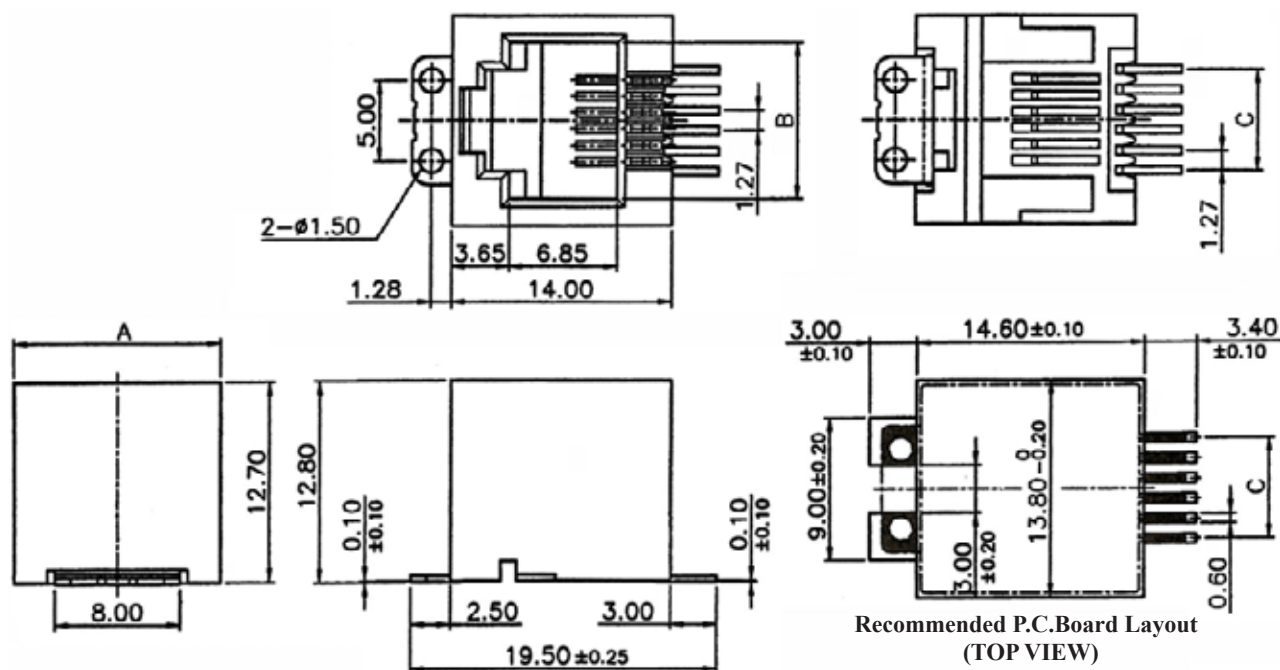
Soldering Temperature: 260°C

Color: Black

Spring Wire: Phosphor Bronze

Gold plating Over Nickel

***RoHS & REACH compliant.**



No. of Positions	Dimensions		
	A	B	C
4	13.21	7.82	3.81
6	13.21	9.85	6.35
8/10	15.50	11.85	8.89/11.43

ORDERING INFORMATION:

P/N M J 4 Y - $\frac{x}{1} \frac{x}{2} \frac{x}{3} B - \frac{x}{3}$

1. NO. OF POSITIONS & CONTACTS:

- "66" 6P6C
- "64" 6P4C
- "88" 8P8C
- "00" 10P10C
- "44" 4P4C

2. CONTACT FINISH:

- "A" 6 MICROINCH GOLD
- "B" 15 MICROINCH GOLD
- "C" 30 MICROINCH GOLD
- "D" 50 MICROINCH GOLD

3. PACKAGE OPTION:

- " " TRAY
- "R" TAPE & REEL

TOP ENTRY MODULAR SMT JACK 8P PROFILE=12.70MM (UNSHIELDED)

SPECIFICATIONS

Electrical:

Voltage Rating: 125 Vac Rms.

Current Rating: 1.5 Amp.

Contact Resistance: 40 Milliohms Max.

Insulation Resistance: 1000 Megohms Min @500 Vdc.

Dielectric Strength: 1000 Vac Rms 60Hz, 1Min.

Mechanical:

Operating: 750 Cycles Min.

Environmental:

Storage: -40°C To +85°C.

Operation: -40°C To +80°C.

IR Reflow Soldering Temperature: 255°C To 265°C(5~10 Seconds)

MATERIALS

Plastic Housing: High Temp Thermoplastic

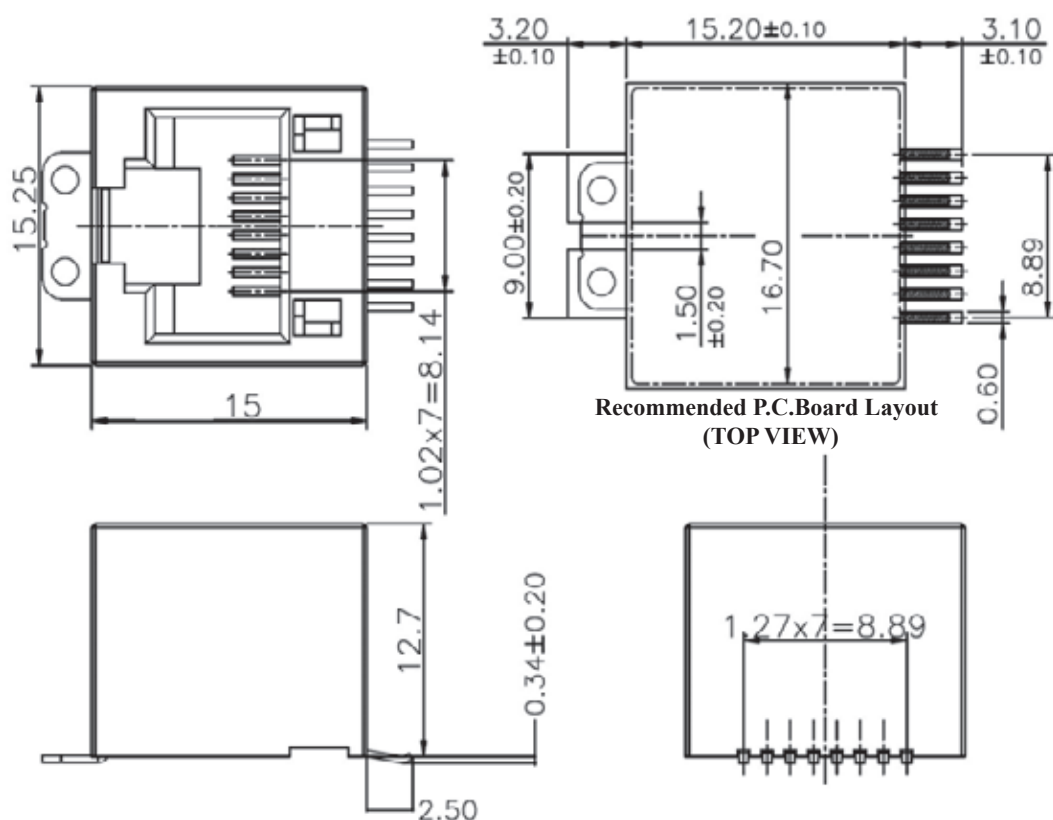
Flammability Rating UL 94V-0.

Contacts: Phosphor Bronze

Plating: Gold Plating Over Nickel In Contact,
Tin Plating Over Nickel In Solder Area.

Solder Pad: Brass With Tin Plating Over Nickel.

* RoHS & REACH compliant.



ORDERING INFORMATION:

P/N MJ $\frac{4}{1}$ YJ - $\frac{88}{2}$ $\frac{x}{3}$ B - $\frac{x}{4}$

1. MODULAR JACK TYPE:
"4YJ" WITH SOLDER PAD
2. NO. OF POSITIONS & CONTACTS:
"88" 8P8C
3. CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD
4. PACKAGE OPTION:
" " TRAY
"R" TAPE & REEL

NOTE: IT CAN BE USED FOR REPLACING P/N MJ4Y-88xB-x.

TOP ENTRY MODULAR SMT JACK 6P PROFILE=15.70MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: Nylon (UL 94V-0)

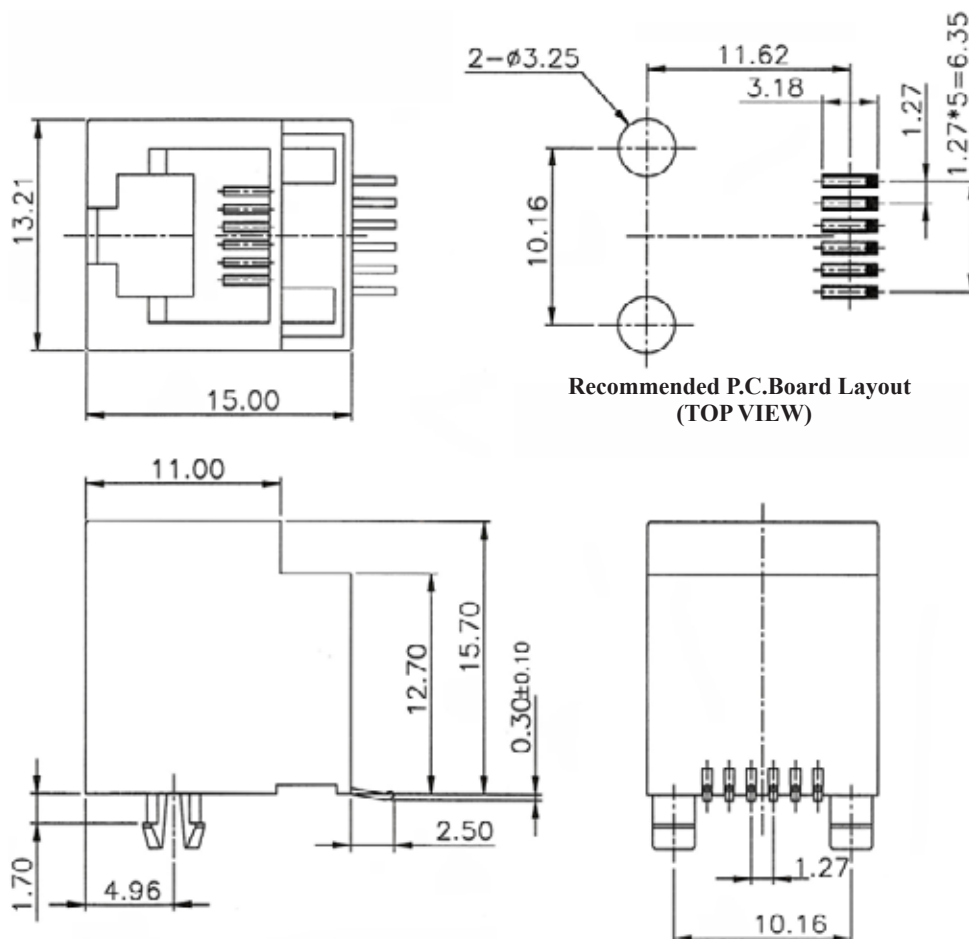
Soldering Temperature: 260°C

Color: Black

Spring Wire: Phosphor Bronze

Gold plating Over Nickel

*RoHS & REACH compliant.



Recommended P.C.Board Layout
(TOP VIEW)

ORDERING INFORMATION:

P/N M J 4 2 - $\frac{x}{1} \frac{x}{2} \frac{x}{3} B - \frac{x}{3}$

1. NO. OF POSITIONS & CONTACTS:

"66" 6P6C

"64" 6P4C

2. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

3. PACKAGE OPTION:

" " TRAY

"R" TAPE & REEL

TOP ENTRY MODULAR SMT JACK 8P PROFILE=15.70MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: Nylon (UL 94V-0)

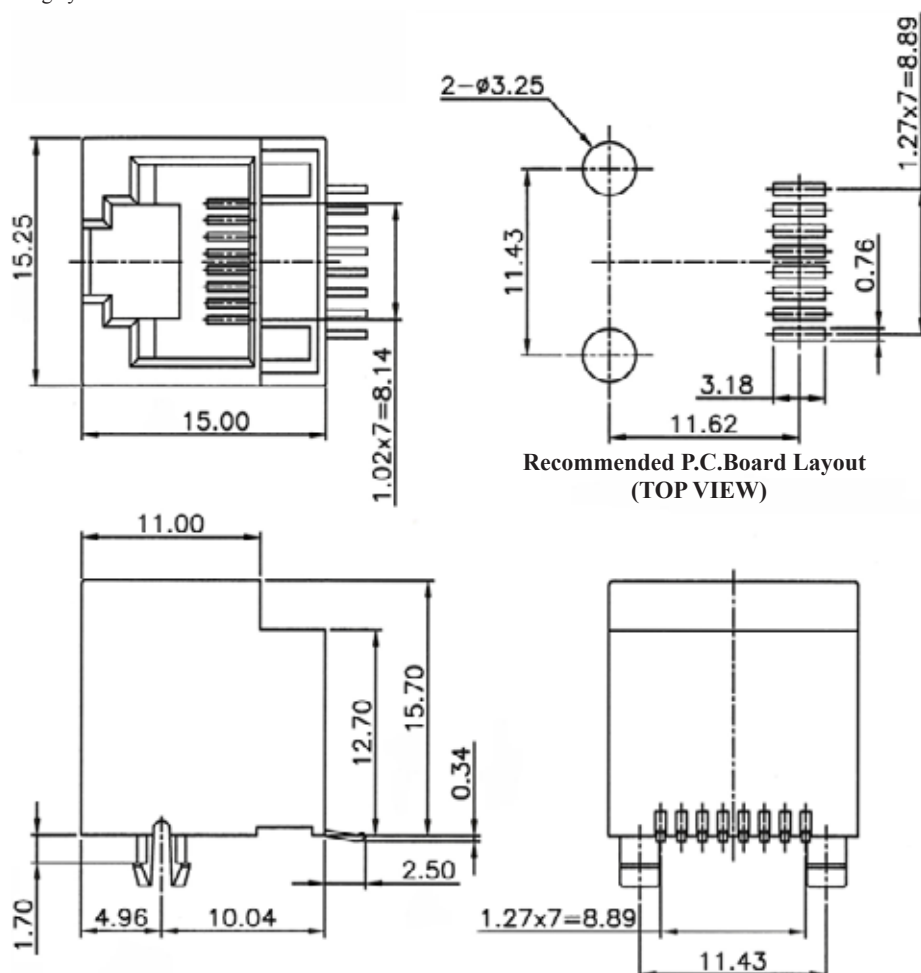
Soldering Temperature: 260°C

Color: Black

Spring Wire: Phosphor Bronze

Gold plating Over Nickel

***RoHS & REACH compliant.**



ORDERING INFORMATION:

P/N M J 4 2 - $\frac{x}{1} \frac{x}{2}$ B - $\frac{x}{3}$

1. NO. OF POSITIONS & CONTACTS:
"88" 8P8C
"84" 8P4C
2. CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD
3. PACKAGE OPTION:
" " TRAY
"R" TAPE & REEL

TOP ENTRY MODULAR SMT JACK 8P PROFILE=15.70MM (UNSHIELDED)

SPECIFICATIONS

Electrical:

Voltage Rating: 125 Vac Rms.

Current Rating: 1.5 Amp.

Contact Resistance: 40 Milliohms Max.

Insulation Resistance: 1000 Megohms Min @500 Vdc.

Dielectric Strength: 1000 Vac Rms 60Hz, 1Min.

Mechanical:

Operating: 750 Cycles Min.

Environmental:

Storage: -40°C To +85°C.

Operation: -40°C To +80°C.

IR Reflow Soldering Temperature: 255°C To 265°C(5~10 Seconds)

MATERIALS

Plastic Housing: High Temp. Thermoplastic

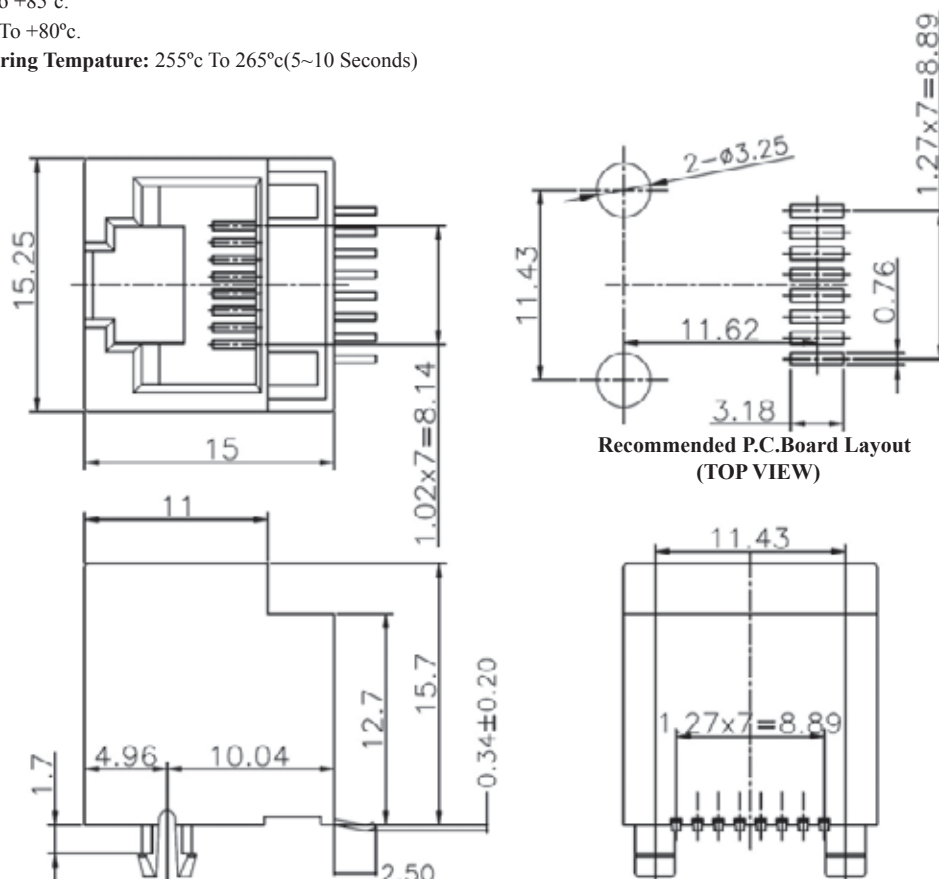
Flammability Rating UL 94V-0.

Contacts: Phosphor Bronze

Plating: Gold Plating Over Nickel In Contact,

Tin Plating Over Nickel In Solder Area.

* RoHS & REACH compliant.



ORDERING INFORMATION:

P/N MJ $\frac{42J}{1}$ - $\frac{88}{2}$ x $\frac{B}{3}$ - $\frac{x}{4}$

1. MODULAR JACK TYPE:
"42J" WITH STEP
2. NO. OF POSITIONS & CONTACTS:
"88" 8P8C
3. CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD
4. PACKAGE OPTION:
" " TRAY
"R" TAPE & REEL

NOTE: IT CAN BE USED FOR REPLACING P/N MJ42-88xB-x.

TOP ENTRY MODULAR SMT JACK 4P PROFILE=15.90MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: Nylon (UL 94V-0)

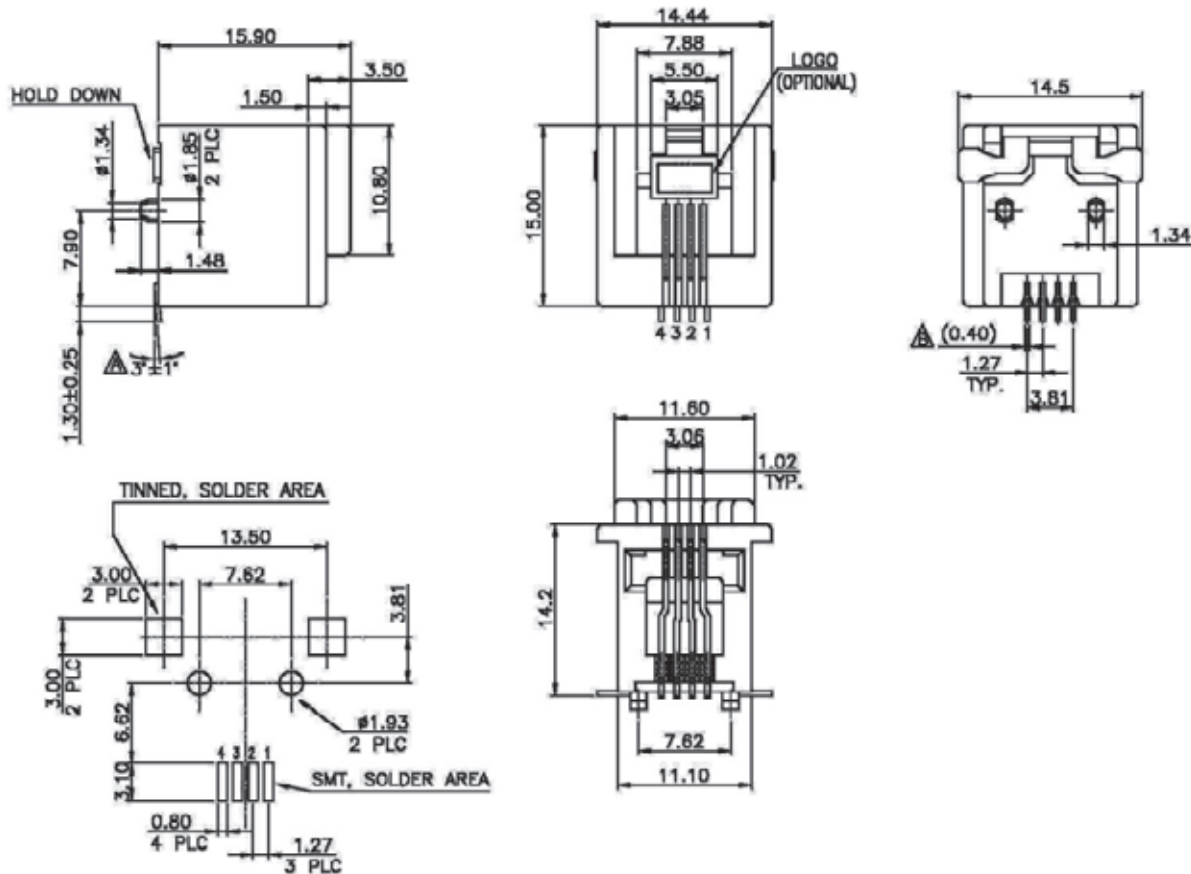
Soldering Temperature: 260°C

Color: Black

Spring Wire: Phosphor Bronze

Gold plating Over Nickel

* RoHS & REACH compliant.



Recommended P.C.Board Layout

ORDERING INFORMATION:

P/N M J $\frac{GA}{1}$ - $\frac{44}{2}$ $\frac{x}{3}$ $\frac{B}{4}$ - $\frac{x}{5}$

1. MODULAR JACK TYPE:
"GA" SMT TYPE
2. NO. OF POSITIONS & CONTACTS:
"44" 4P4C
3. CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD
4. HOUSINH COLOR:
"B" BLACK
5. PACKAGE TYPE:
" " TRAY
"R" TAPE & REEL

TOP ENTRY MODULAR SMT JACK 6P PROFILE=15.90MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: Nylon (UL 94V-0)

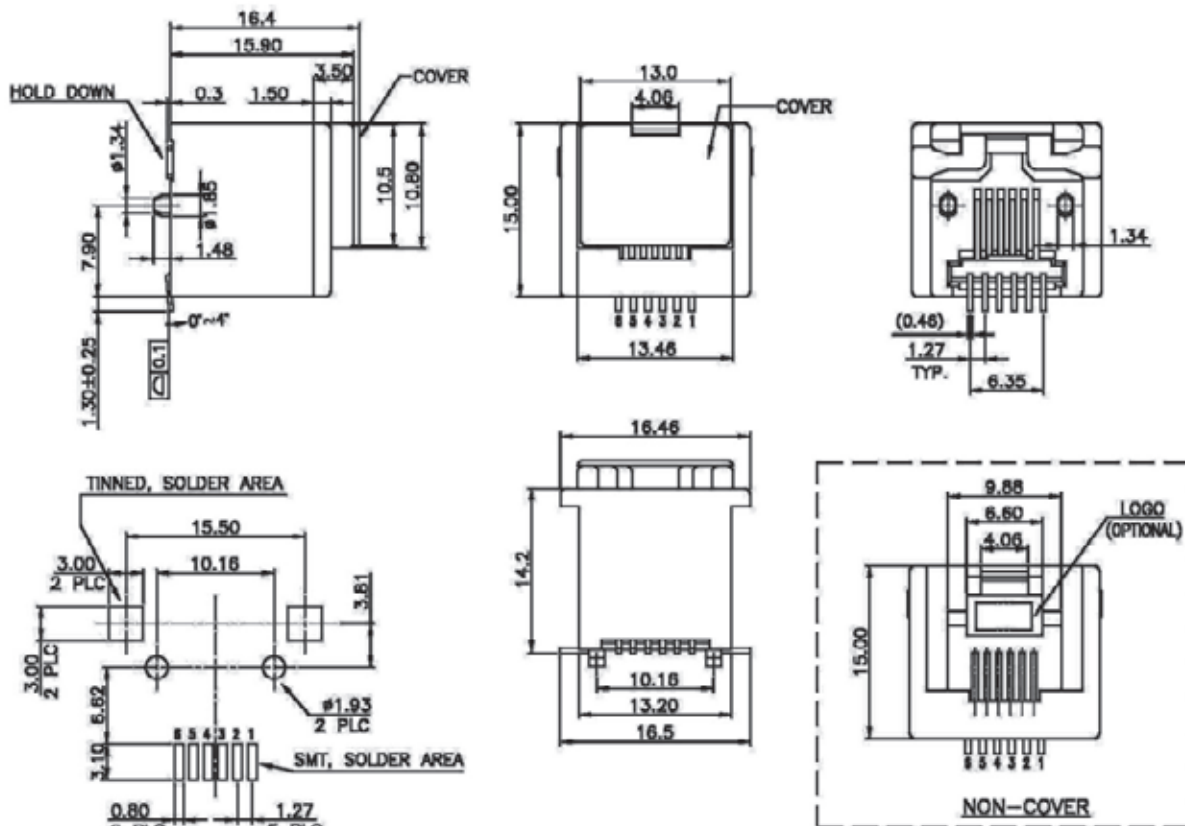
Soldering Temperature: 260°C

Color: Black

Spring Wire: Phosphor Bronze

Gold plating Over Nickel

* RoHS & REACH compliant.



Recommended P.C.Board Layout

ORDERING INFORMATION:

P/N M J $\frac{x}{1}$ - $\frac{66}{2}$ $\frac{x}{3}$ $\frac{B}{4}$ - $\frac{x}{5}$

- MODULAR JACK TYPE:
"GA" SMT TYPE WITHOUT COVER
"GB" SMT TYPE WITH COVER
- NO. OF POSITIONS & CONTACTS:
"66" 6P6C
- CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD
- HOUSING COLOR:
"B" BLACK

- PACKAGE TYPE:
" " TRAY
"R" TAPE & REEL

TOP ENTRY MODULAR SMT JACK 8P KEYED PROFILE=15.90MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: Nylon (UL 94V-0)

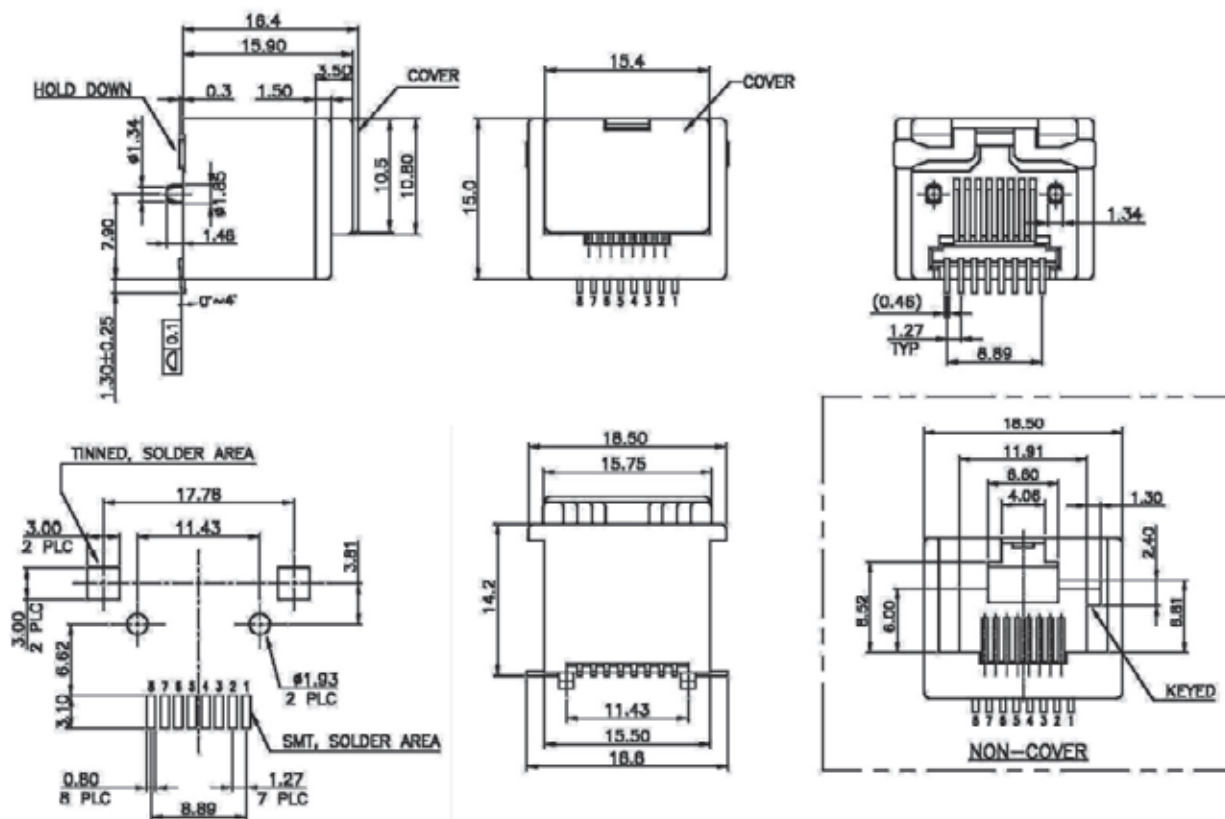
Soldering Temperature: 260°C

Color: Black

Spring Wire: Phosphor Bronze

Gold plating Over Nickel

* RoHS & REACH compliant.



Recommended P.C.Board Layout

ORDERING INFORMATION:

P/N M J $\frac{XX}{1}$ - $\frac{88}{2}$ $\frac{XB}{34}$ - $\frac{X}{5}$

1. MODULAR JACK TYPE:

"GA" SMT TYPE WITHOUT COVER

"GB" SMT TYPE WITH COVER

2. NO. OF POSITIONS & CONTACTS:

"88" 8P8C

3. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

4. HOUSING COLOR:

"B" BLACK

5. PACKAGE TYPE:

" " TRAY

"R" TAPE & REEL

tel. 02.3361.1626 info@elitaliaweb.it
fax 02.2626.1009 www.elitaliaweb.it

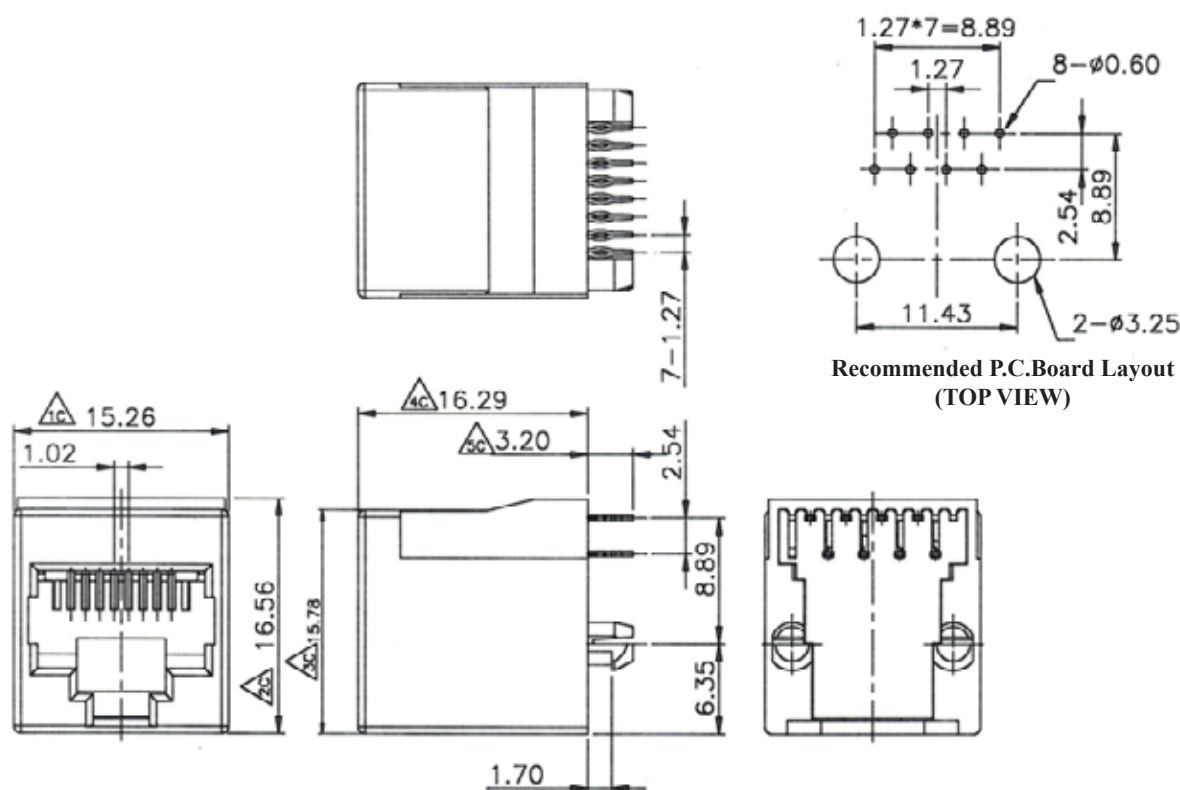
TOP ENTRY MODULAR PCB JACK 8P PRESS FIT TYPE PROFILE=16.29MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Black
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
***RoHS & REACH compliant.**



ORDERING INFORMATION:

P/N M J P H - $\frac{88}{2} \times \frac{B}{34}$

- MODULAR JACK TYPE:
"PH" PRESS FIT TYPE
- NO. OF POSITIONS & CONTACTS:
"88" 8P8C
- CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD
- HOUSING COLOR:
"B" BLACK

NOTE: PIN SPACING = 2 x 1.27 = 2.54MM

TOP ENTRY MODULAR PCB JACK PRESS FIT TYPE 8P PROFILE=16.29MM (UNSHIELDED)

SPECIFICATIONS

Electrical:

Voltage Rating: 125 Vac Rms.

Current Rating: 1.5 Amp.

Contact Resistance: 40 Milliohms Max.

Insulation Resistance: 1000 Megohms Min @500 Vdc.

Dielectric Strength: 1000 Vac Rms 60Hz, 1Min.

Mechanical:

Operating: 750 Cycles Min.

Environmental:

Storage: -40°C To +85°C.

Operation: -40°C To +80°C.

IR Reflow Soldering Temperature: 255°C To 265°C (5~10 Seconds)

MATERIALS

Plastic Housing: Engineering Thermoplastic

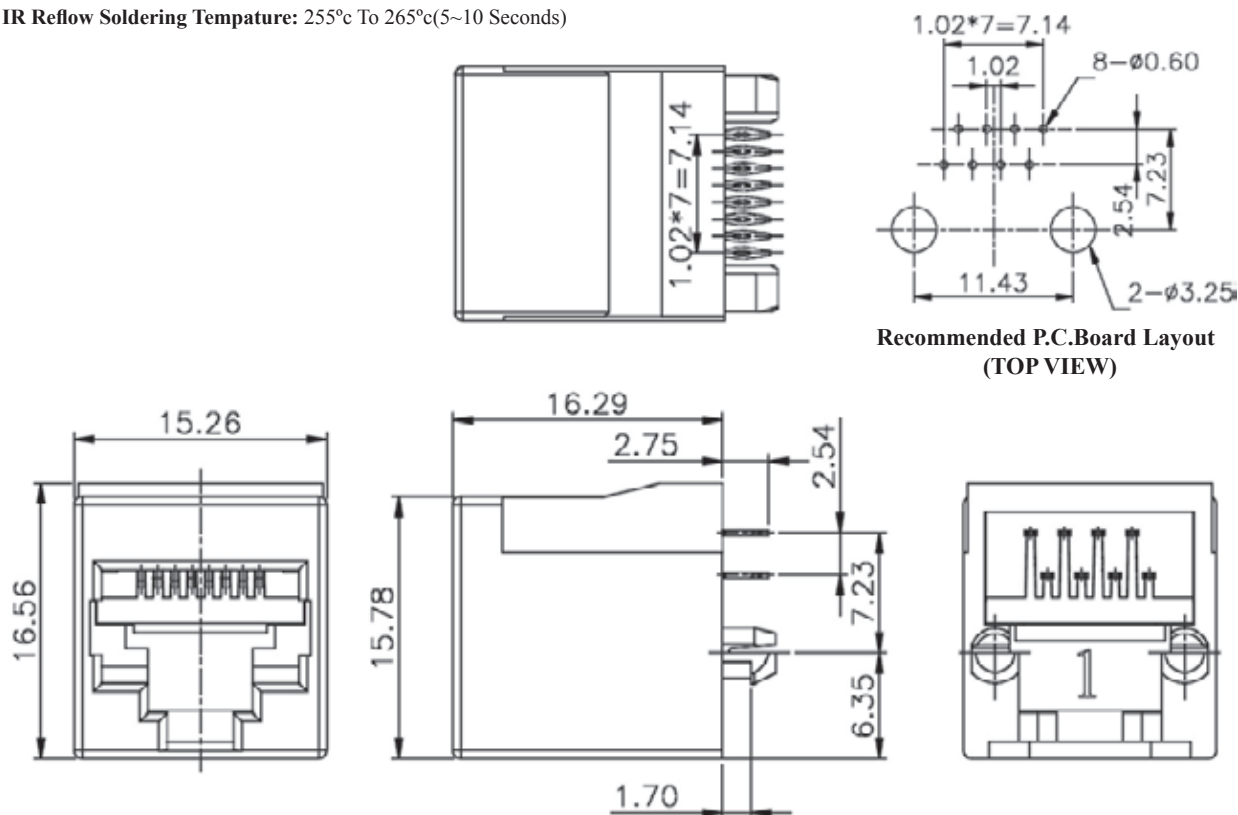
Flammability Rating UL 94V-0.

Contacts: 0.35mm Thickness Phosphor Bronze

Plating: Gold Plating Over Nickel In Contact,

Tin Plating Over Nickel In Solder Area.

* RoHS & REACH compliant.



Recommended P.C.Board Layout
(TOP VIEW)

ORDERING INFORMATION:

P/N M J P F - 8 8 A B
1 2 3 4

1. MODULAR JACK TYPE:
"PF" PRESS FIT TYPE
2. NO. OF POSITIONS & CONTACTS:
"88" 8P8C
3. CONTACT FINISH:
"A" 6 MICROINCH GOLD
4. HOUSING COLOR:
"B" BLACK

NOTE: PIN SPACING = 2 x 1.02 = 2.04MM

45 DEGREE ENTRY MODULAR PCB JACK 8P (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)

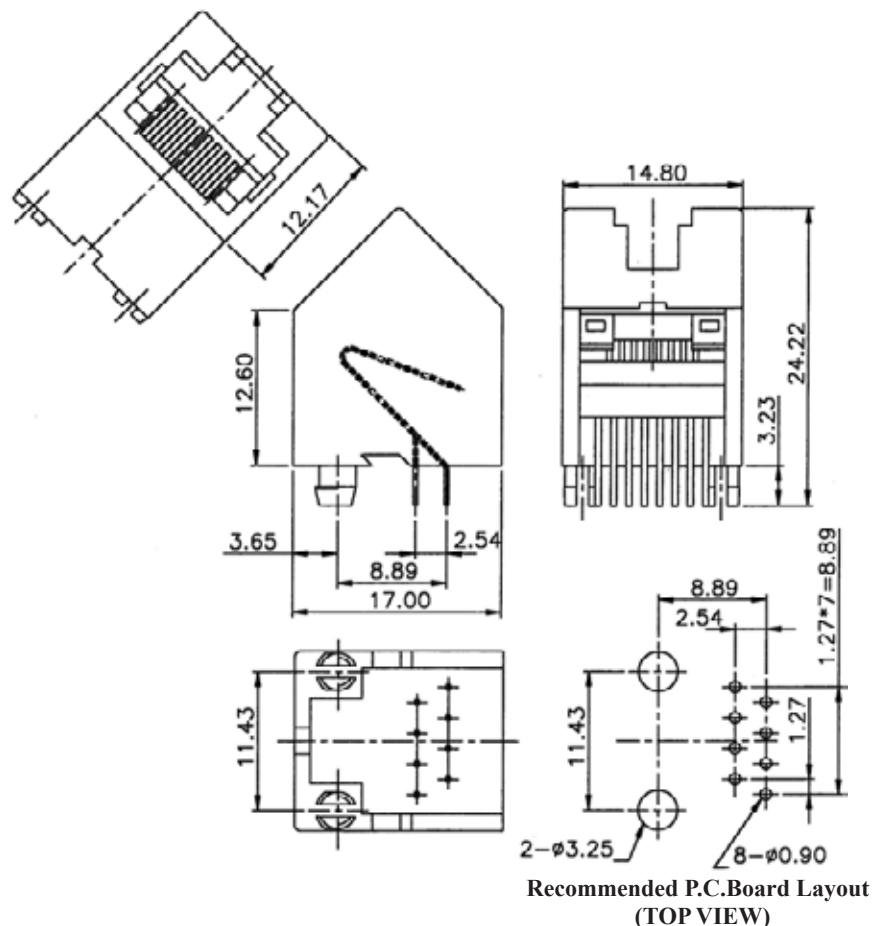
Soldering Temperature: 235°C

Color: Black & White

Spring Wire: Phosphor Bronze

Gold plating Over Nickel

***RoHS & REACH compliant.**



ORDERING INFORMATION:

P/N MJ71 - $\frac{xx}{T} \frac{xx}{23}$

1. NO. OF POSITIONS & CONTACTS:

"88" 8P8C

"84" 8P4C

2. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

3. HOUSING COLOR:

"W" WHITE (STANDARD)

"B" BLACK

NOTE: P/N MJ71HT-8xxW FOR HIGH TEMP. VERSION

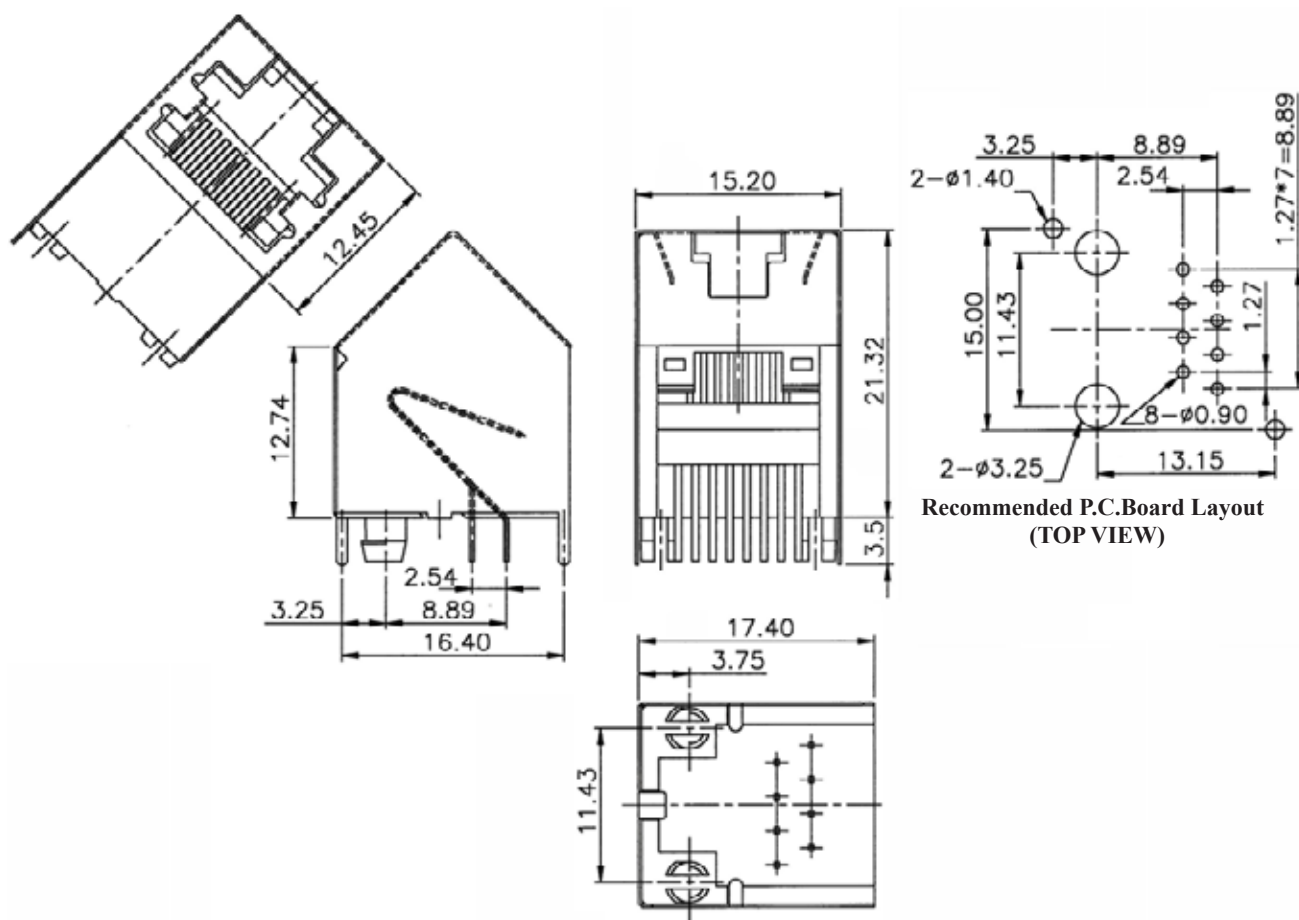
45 DEGREE ENTRY CAT. 3 & CAT. 5 MODULAR PCB JACK 8P (FULLY SHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: White
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
Shield: Brass plating Nickel Alloy
***RoHS & REACH compliant.**



ORDERING INFORMATION:

P/N M J $\frac{XX}{1} - \frac{XXXX}{234}$

1. CATEGORY TYPE:
 "72" CAT. 3
 "EE" CAT.5
2. NO. OF POSITIONS & CONTACTS:
 "88" 8P8C
 "84" 8P4C
3. CONTACT FINISH:
 "A" 6 MICROINCH GOLD
 "B" 15 MICROINCH GOLD
 "C" 30 MICROINCH GOLD
 "D" 50 MICROINCH GOLD

4. INSULATOR COLOR:
 "W" WHITE (STANDARD)
 "B" BLACK

NOTE: P/N MJ72HT-xxxW FOR HIGH TEMP. VERSION

MINI 45 DEGREE ENTRY MODULAR PCB JACK 8P (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)

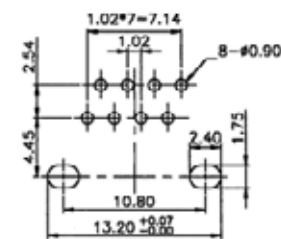
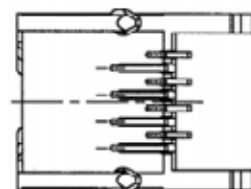
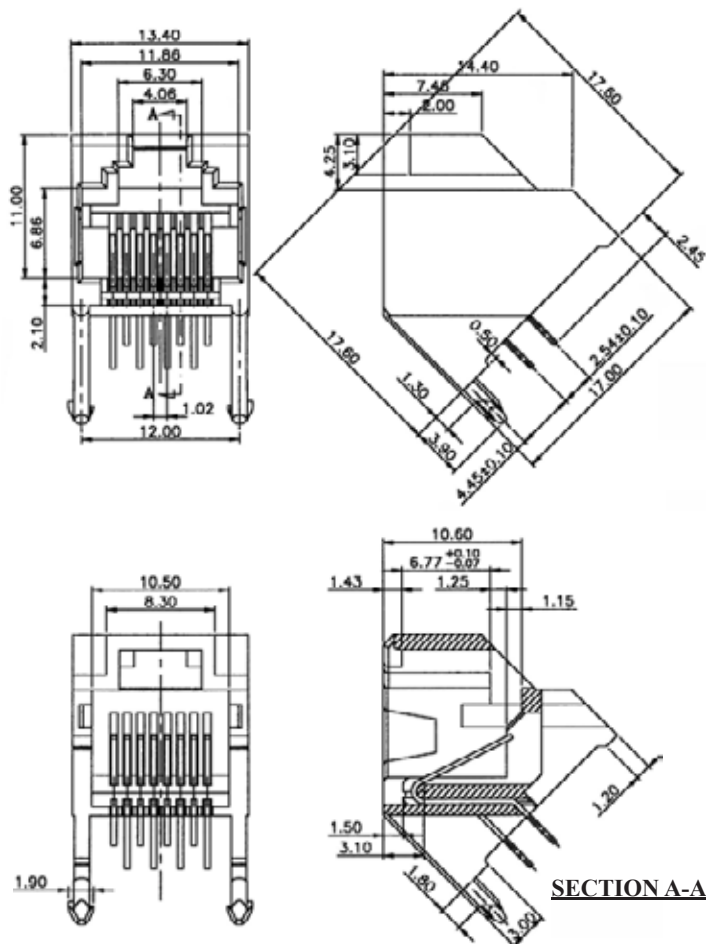
Soldering Temperature: 235°C

Color: White

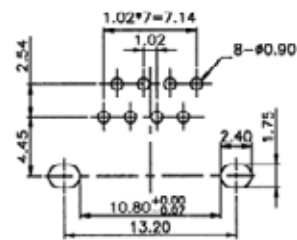
Spring Wire: Phosphor Bronze

Gold plating Over Nickel

*RoHS & REACH compliant.



PCB THICKNESS=1.0
Recommended P.C.Board Layout
(TOP VIEW)



PCB THICKNESS=1.6
Recommended P.C.Board Layout
(TOP VIEW)

ORDERING INFORMATION:

P/N M J 2 M - $\frac{x}{1} \frac{x}{2} \frac{W}{3}$

1. NO. OF POSITIONS & CONTACTS:

"88" 8P8C

"84" 8P4C

2. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

3. HOUSING COLOR:

"W" WHITE

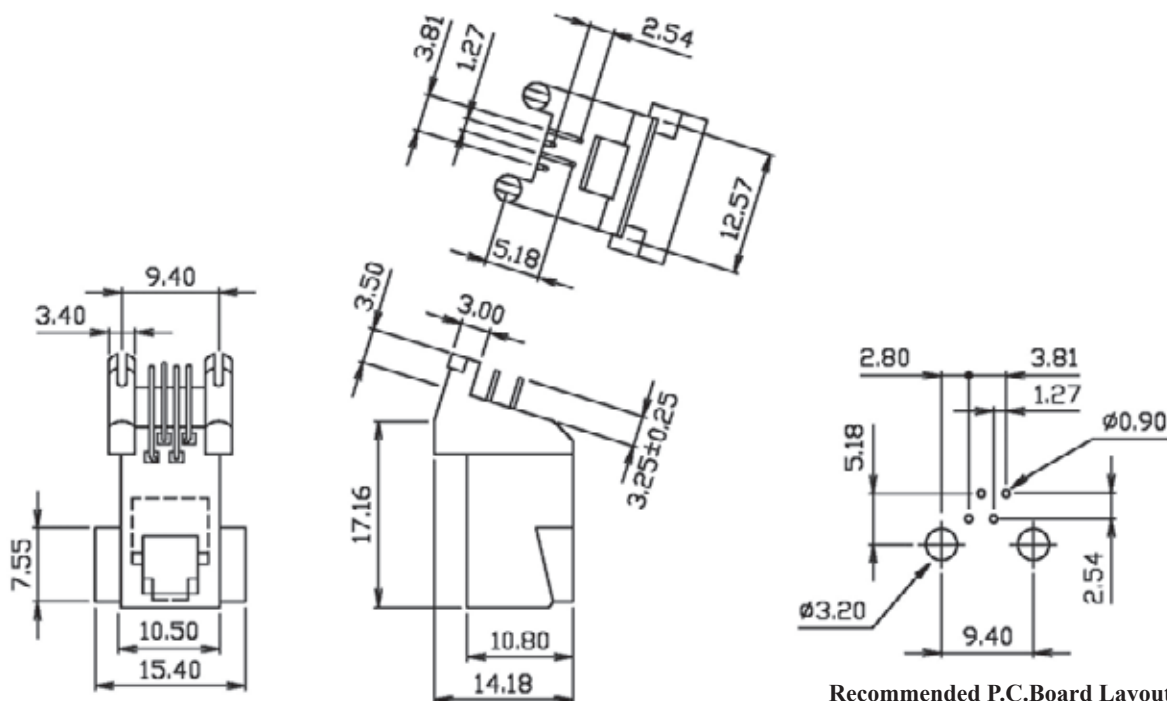
45 DEGREE ENTRY MODULAR PCB JACK 4P PROFILE=17.16MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Black
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
***RoHS & REACH compliant.**



Recommended P.C.Board Layout

ORDERING INFORMATION:

P/N M J G X - 4 4 x B
1 2 3 4

- MODULAR JACK TYPE:
"GX" 45 DEGREE ENTRY TYPE
- NO. OF POSITIONS & CONTACTS:
"44" 4P4C
- CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD
- HOUSING COLOR:
"B" BLACK

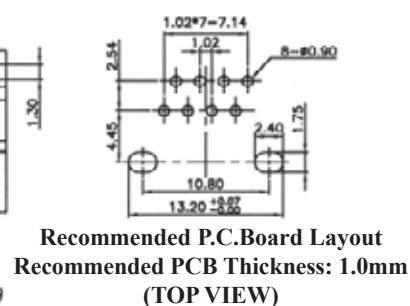
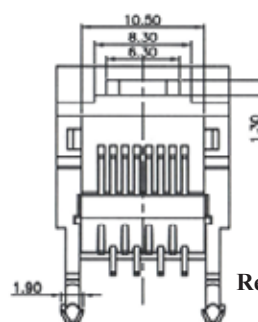
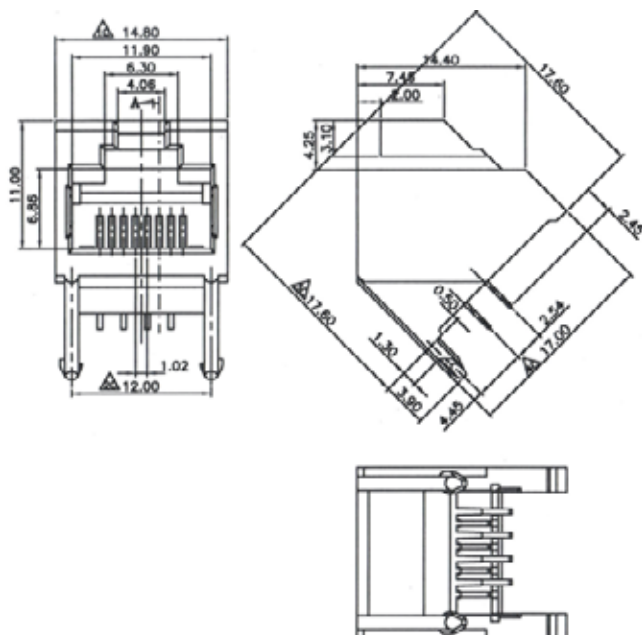
45 DEGREE ENTRY MODULAR PCB JACK 8P (UNSHIELDED)

SPECIFICATIONS

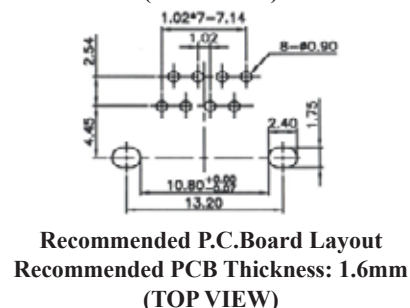
Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Black
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
***RoHS & REACH compliant.**



Recommended P.C. Board Layout
Recommended PCB Thickness: 1.0mm
(TOP VIEW)



Recommended P.C. Board Layout
Recommended PCB Thickness: 1.6mm
(TOP VIEW)

ORDERING INFORMATION:

P/N M J Y H - 8 8 x B

- MODULAR JACK TYPE:
"YH" 45 DEGREE ENTRY JACK
- NO. OF POSITIONS & CONTACTS:
"88" 8P8C
- CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD
- HOUSING COLOR:
"B" BLACK

70 DEGREE ENTRY MODULAR PCB JACK 8P (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: Nylon (UL 94V-0)

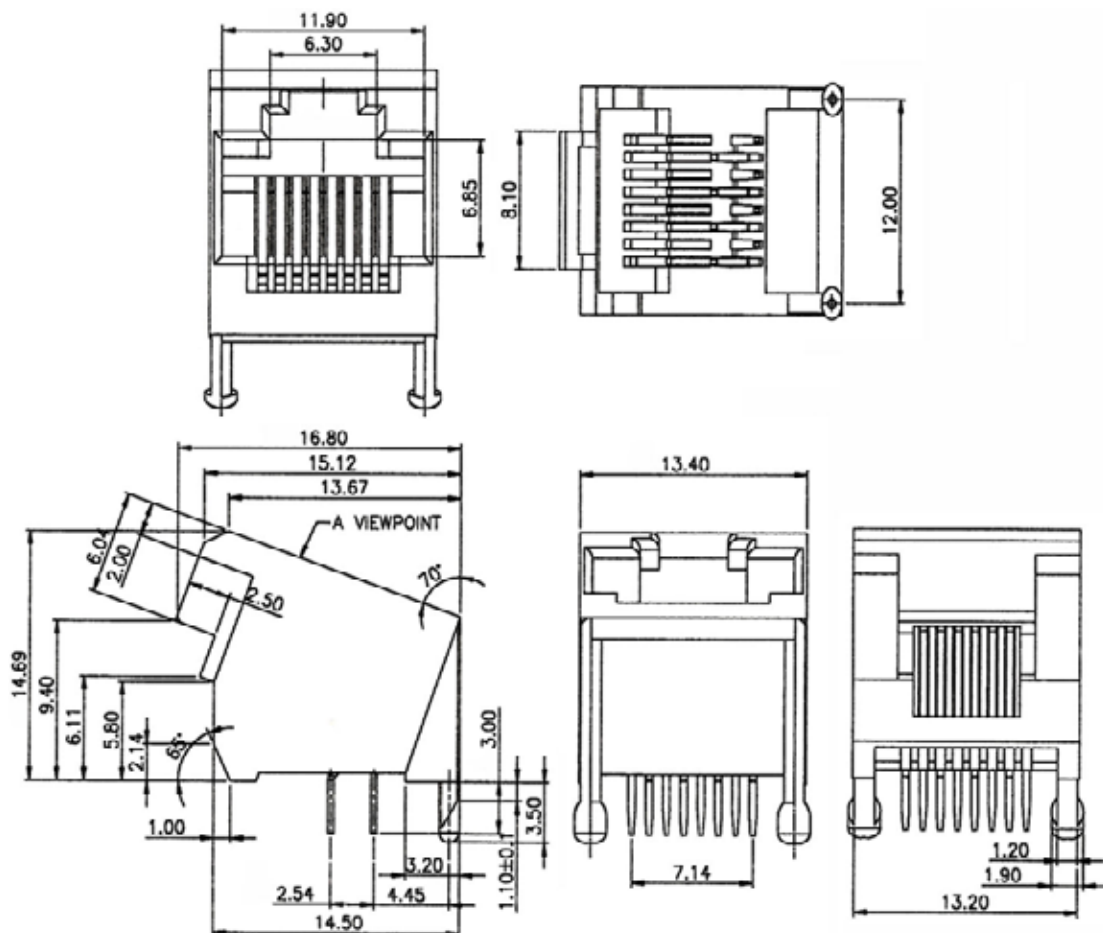
Soldering Temperature: 260°C

Color: White

Spring Wire: Phosphor Bronze

Gold plating Over Nickel

***RoHS & REACH compliant.**



ORDERING INFORMATION:

P/N M J 7 0 - $\frac{88}{1} \times \frac{2}{2} \frac{W}{3}$

1. NO. OF POSITIONS & CONTACTS:

"88" 8P8C

2. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

3. HOUSING COLOR:

"W" WHITE

BOTTOM ENTRY MODULAR PCB JACK 4P+6P+8P PROFILE=12.00MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)

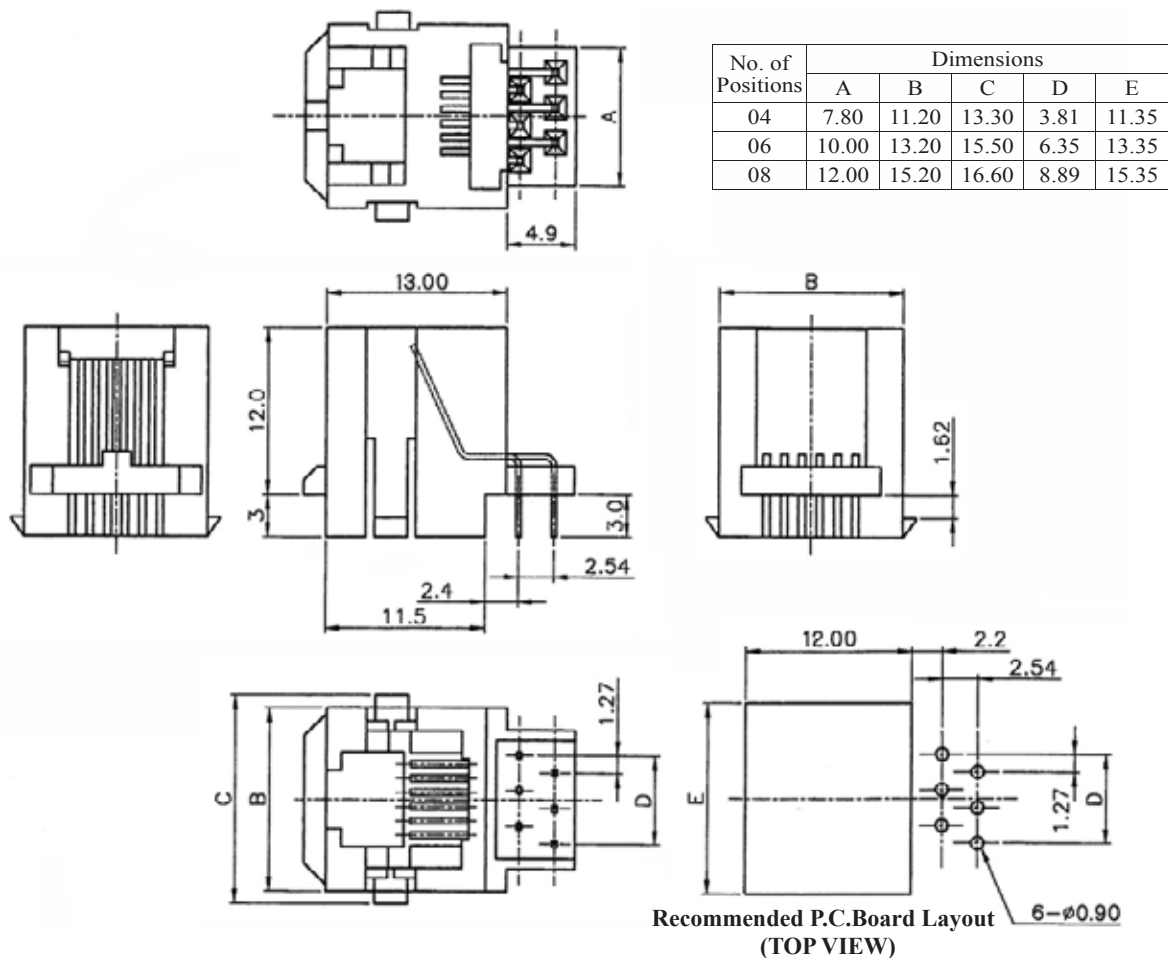
Soldering Temperature: 235°C

Color: Black

Spring Wire: Phosphor Bronze

Gold plating Over Nickel

***RoHS & REACH compliant.**



ORDERING INFORMATION:

P/N M J $\frac{XX}{1} - \frac{XXX}{2} \frac{B}{3}$

1. DUST COVER OPTION:
"51" W/O DUST COVER
"9C" WITH DUST COVER
2. NO. OF POSITIONS & CONTACTS:
"66" 6P6C
"64" 6P4C
"88" 8P8C
"44" 4P4C
3. CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD

BOTTOM ENTRY MODULAR PCB JACK 4P PROFILE=12.50MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)

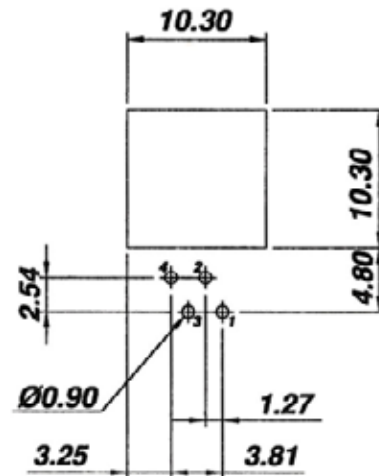
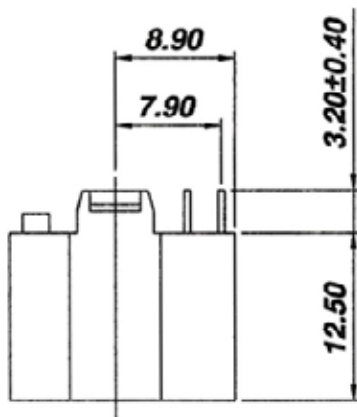
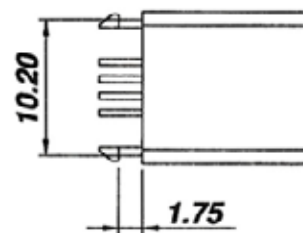
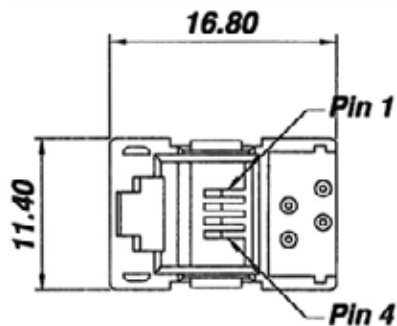
Soldering Temperature: 235°C

Color: Black

Spring Wire: Phosphor Bronze

Gold plating Over Nickel

*RoHS & REACH compliant.



Recommended P.C. Board Layout
(BOTTOM VIEW)

ORDERING INFORMATION:

P/N MJ7Z - $\frac{44}{1} \times \frac{B}{2}$

1. NO. OF POSITIONS & CONTACTS:

"44" 4P4C

2. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

NOTE: P/N MJ7ZHT-44xB FOR HIGH TEMP. VERSION

BOTTOM ENTRY MODULAR PCB JACK 6P PROFILE=12.50MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)

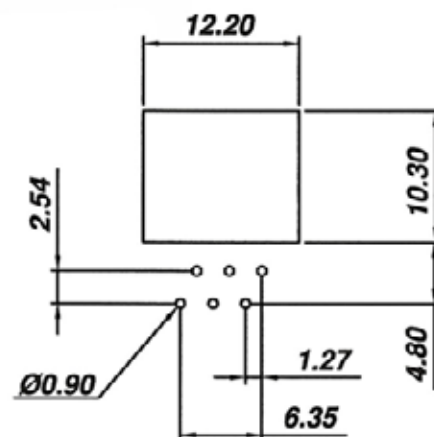
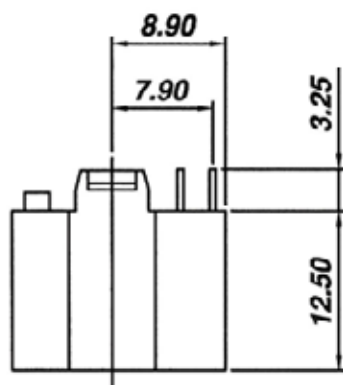
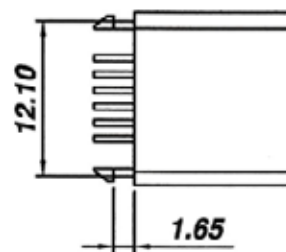
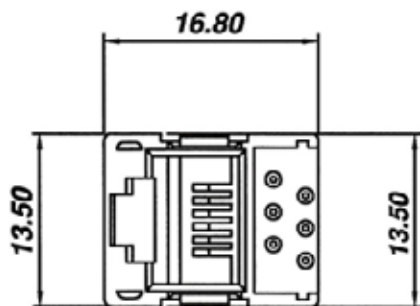
Soldering Temperature: 235°C

Color: Black

Spring Wire: Phosphor Bronze

Gold plating Over Nickel

*RoHS & REACH compliant.



Recommended P.C.Board Layout
(BOTTOM VIEW)

ORDERING INFORMATION:

P/N M J 7 Z - $\frac{x x x}{1 2}$ B

1. NO. OF POSITIONS & CONTACTS:

"66" 6P6C

"64" 6P4C

2. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

BOTTOM ENTRY MODULAR PCB JACK 6P PROFILE=12.80MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)

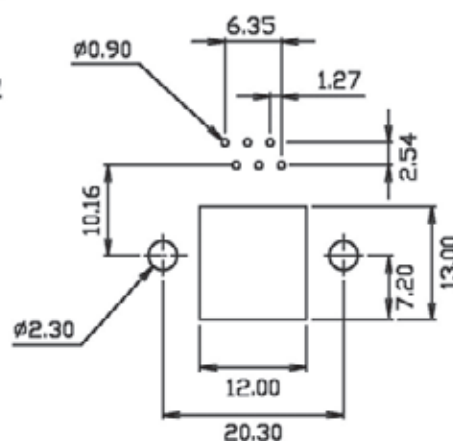
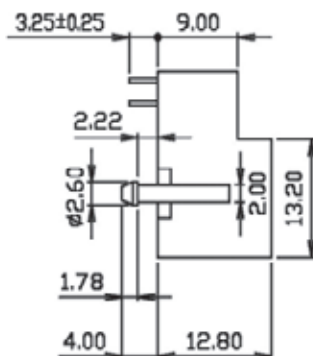
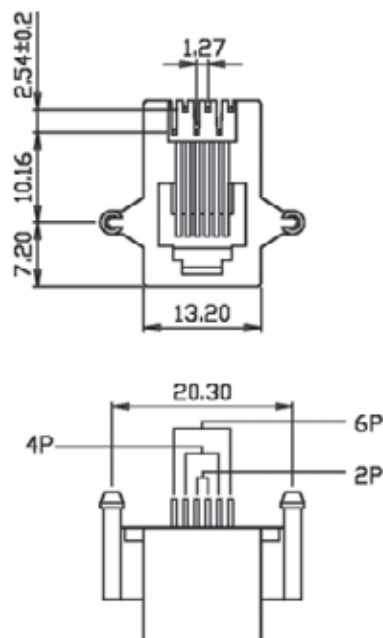
Soldering Temperature: 235°C

Color: Black

Spring Wire: Phosphor Bronze

Gold plating Over Nickel

*RoHS & REACH compliant.



Recommended P.C.Board Layout

ORDERING INFORMATION:

P/N M J GY - 66 x B
I 2 3 4

1. MODULAR JACK TYPE:
"GY" BOTTOM ENTRY RJ12 JACK
2. NO. OF POSITIONS & CONTACTS:
"66" 6P6C
3. CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD
4. HOUSING COLOR:
"B" BLACK

BOTTOM ENTRY MODULAR PCB JACK 6P PROFILE=13.20MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)

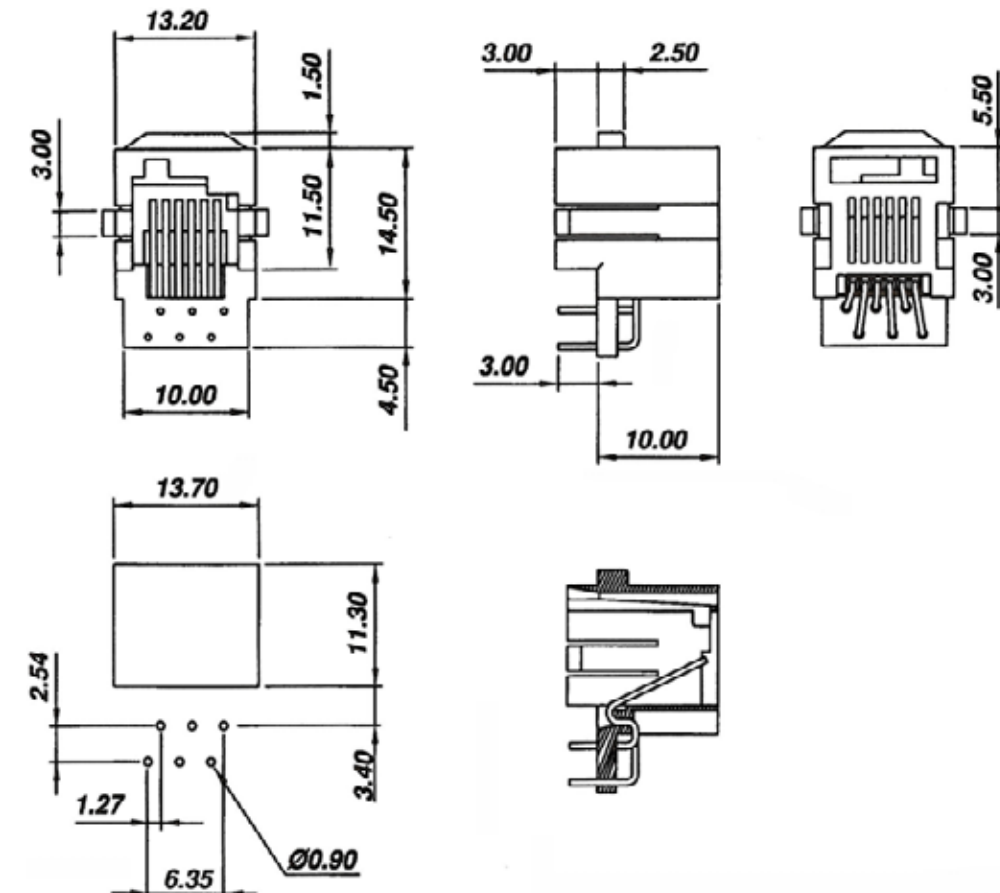
Soldering Temperature: 235°C

Color: Black

Spring Wire: Phosphor Bronze

Gold plating Over Nickel

*RoHS & REACH compliant.



Recommended P.C.Board Layout
(BOTTOM VIEW)

ORDERING INFORMATION:

P/N M J 9 E - $\frac{x x x}{1 2}$ B

1. NO. OF POSITIONS & CONTACTS:

"66" 6P6C

"64" 6P4C

2. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

BOTTOM ENTRY MODULAR PCB JACK 8P PROFILE=13.10MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.

Contact Resistance: 20mΩ Max.

Rating Current: 1.5A Max.

Rating Voltage: 120V AC.

Dielectric Voltage: 1000 Vrms 60 Sec. Min.

Temperature Range: -40°C / +85°C

Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)

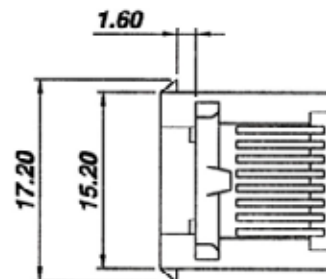
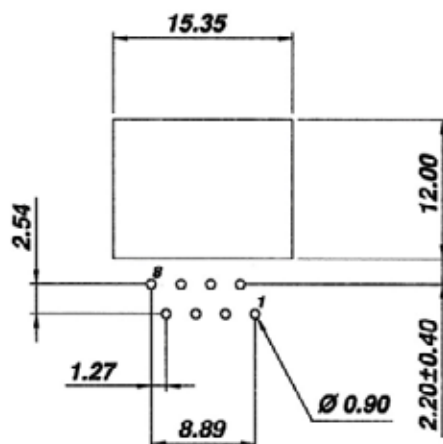
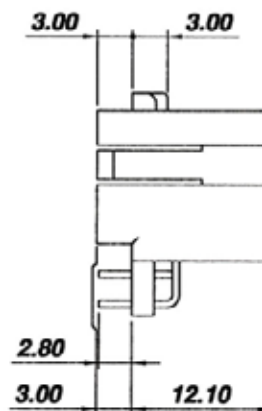
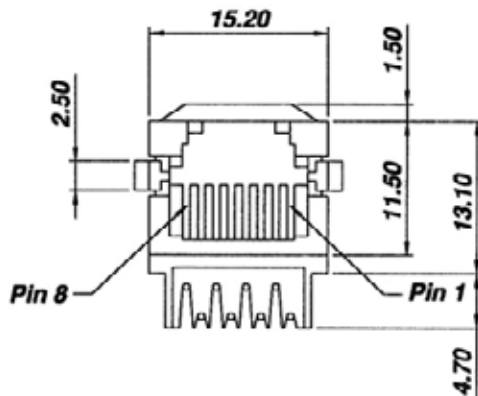
Soldering Temperature: 235°C

Color: Black

Spring Wire: Phosphor Bronze

Gold plating Over Nickel

*RoHS & REACH compliant.



Recommended P.C.Board Layout
(BOTTOM VIEW)

ORDERING INFORMATION:

P/N MJ9E - 88 x B
T 2

1. NO. OF POSITIONS & CONTACTS:

"88" 8P8C

2. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

NOTE: P/N MJ9EHT-88xB FOR HIGH TEMP. VERSION